

# MITSUBISHI 1985 SEMICONDUCTORS

## MICROPROCESSORS AND PERIPHERAL CIRCUITS

# DATA BOOK

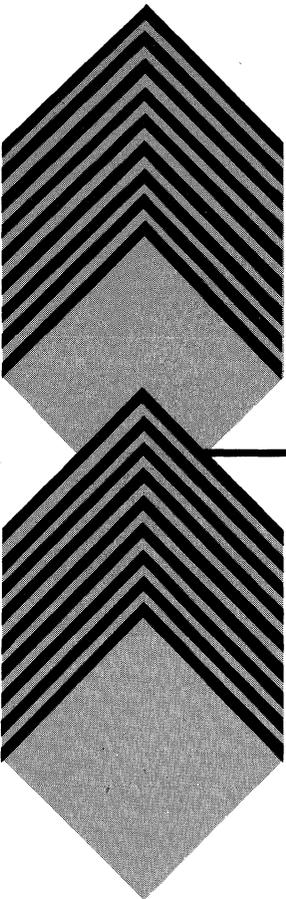


1985

MITSUBISHI  
SEMICONDUCTORS

MICROPROCESSORS AND  
PERIPHERAL CIRCUITS

 MITSUBISHI ELECTRIC



# **mitsubishi** 1985 **SEMICONDUCTORS**

**MICROPROCESSORS AND  
PERIPHERAL CIRCUITS**

DATA  
BOOK

All values shown in this catalogue are subject to change for product improvement.

The information, diagrams and all other data included herein are believed to be correct and reliable. However, no responsibility is assumed by Mitsubishi Electric Corporation for their use, nor for any infringements of patents or other rights belonging to third parties which may result from their use.

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**GUIDANCE**

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**1**

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**MELPS 85 MICROPROCESSORS**

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**2**

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**MELPS 86 MICROPROCESSORS**

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**3**

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**NMOS PERIPHERAL CIRCUITS**

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**4**

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**CMOS PERIPHERAL CIRCUITS**

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**5**

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**APPLICATION**

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**6**



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# MITSUBISHI LSIs

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1

Type	Circuit function and organization	Structure	Supply voltage (V)	Electrical characteristics				Package	Interchangeable products	Page
				Typ pwr dissipation (mW)	Max. access time (ns)	Min. cycle time (ns)	Max. frequency (MHz)			

### ■MELPS 85 MICROPROCESSORS

M5L8085AP	8-Bit Parallel Microprocessor	N,Si,ED	5±5%	600	—	—	3	40P4	i8085A	2—3
M5L8212P	8-Bit Input/Output Port with 3-State Output	B,LS	5±5%	450	30☆	—	—	24P4	i8212	2—17
M5L8216P	4-Bit Parallel Bidirectional Bus Driver (Non Inverting)	B,LS	5±5%	475	30☆	—	—	16P4	i8216	2—21
M5L8226P	4-Bit Parallel Bidirectional Bus Driver (Inverting)	B,LS	5±5%	425	25☆	—	—	16P4	i8226	2—21

### ■MELPS 86 MICROPROCESSORS

M5L8282P	Octal Latch (Non Inverting)	B,LS	5±10%	250	—	—	—	20P4	i8282	3—3
M5L8283P	Octal Latch (Inverting)	B,LS	5±10%	250	—	—	—	20P4	i8283	3—3
M5L8284AP	Clock Generator and Driver for 8086/8088/8089 Processors	B,LS	5±10%	490	—	—	—	18P4	i8284	3—7
M5L8286P	Octal Bus Transceiver (Non Inverting)	B,LS	5±10%	400	—	—	—	20P4	i8286	3—16
M5L8287P	Octal Bus Transceiver (Inverting)	B,LS	5±10%	400	—	—	—	20P4	i8287	3—16
M5L8288S	Bus Controller for 8086/8088/8089 Processors	B,LS	5±10%	500	—	—	—	20S1	i8288	3—20
M5L8289P	Bus Arbiter for 8086/8088/8089 Processors	B,LS	5±10%	350	—	—	—	20P4	i8289	3—28

### ■NMOS PERIPHERAL CIRCUITS

M5L8155P	2048-Bit Static RAM with I/O Ports and Timer ( $\overline{CE}$ ="L" active)	N,Si,ED	5±5%	500	—	—	—	40P4	i8155	4—3
M5L8156P	2048-Bit Static RAM with I/O Ports and Timer ( $\overline{CE}$ ="H" active)	N,Si,ED	5±5%	500	—	—	—	40P4	i8156	4—11
M5L8251AP-5	Programmable Communication Interface	N,Si,ED	5±5%	300	—	—	3	28P4	i8251A	4—19
M5L8253P-5	Programmable Interval Timer	N,Si,ED	5±10%	300	—	—	2	24P4	i8253-5	4—36
M5L8255AP-5	Programmable Peripheral Interface	N,Si,ED	5±5%	250	—	—	—	40P4	i8255A-5	4—44
M5L8257P-5	Programmable DMA Controller	N,Si,ED	5±5%	300	—	—	3	40P4	i8257-5	4—62
M5L8259AP	Programmable Interrupt Controller	N,Si,ED	5±10%	275	—	—	—	28P4	i8259A	4—72
M5L8279P-5	Programmable Keyboard/Display Interface	N,Si,ED	5±10%	650	—	—	3	40P4	i8279-5	4—86

B = Bipolar.                      C = CMOS.                      ED = Enhancement depletion mode.  
 N = N-channel.                  Si = Silicon gate.  
 ☆Indicates propagation time.



# ORDERING INFORMATION

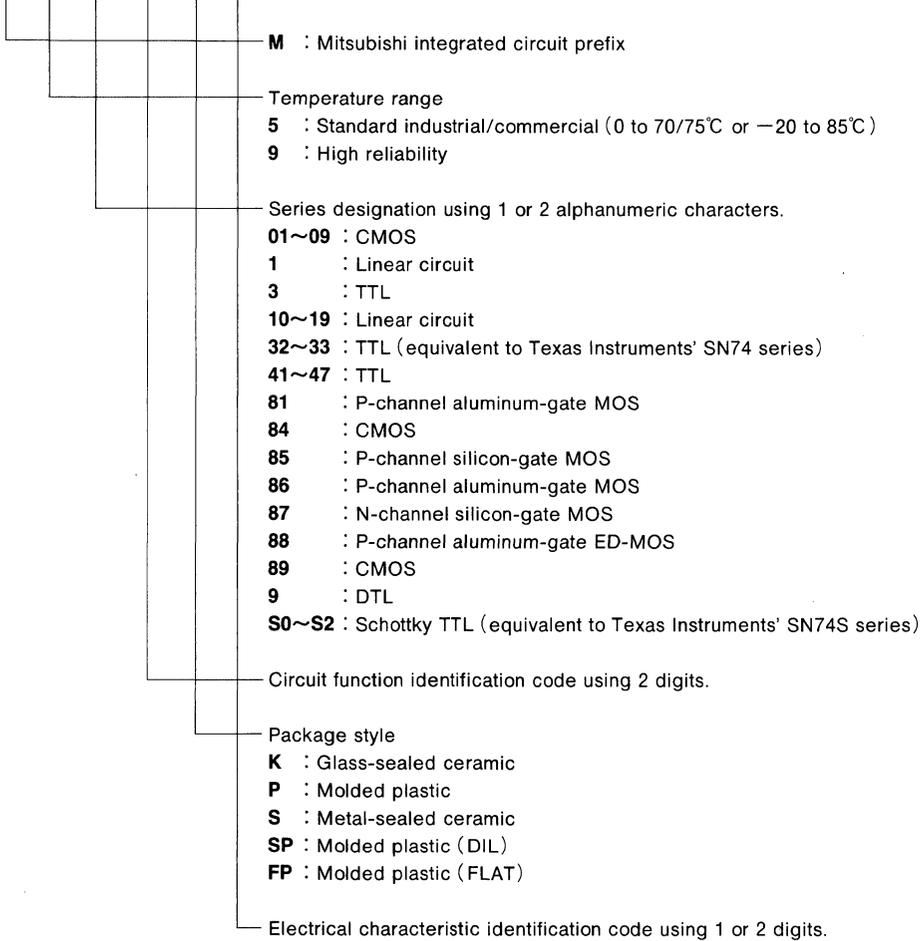
## FUNCTION CODE

Mitsubishi integrated circuits may be ordered using the following simplified alphanumeric type-codes which define the function of the ICs and the package style.

1

### For Mitsubishi Original Products

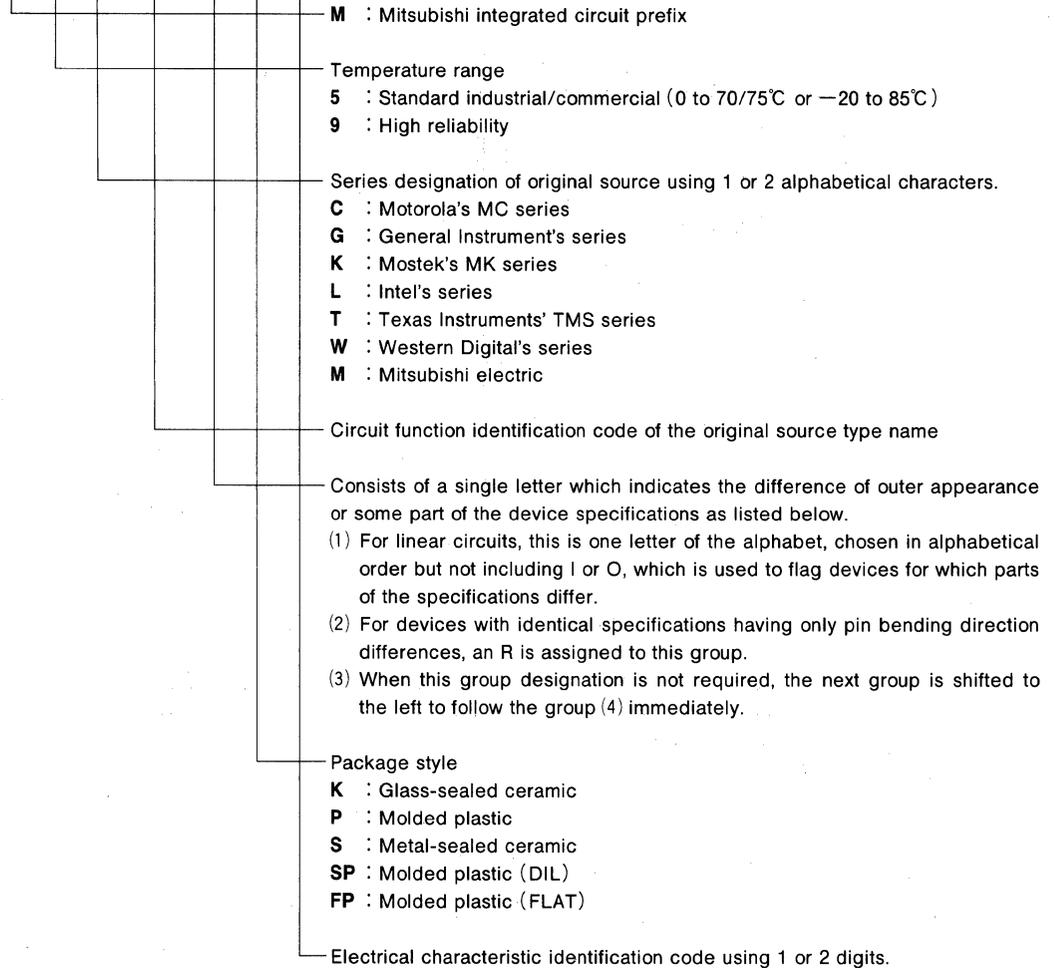
Example : **M 5 89 90 P - 1**



# ORDERING INFORMATION

## For Second Source Products

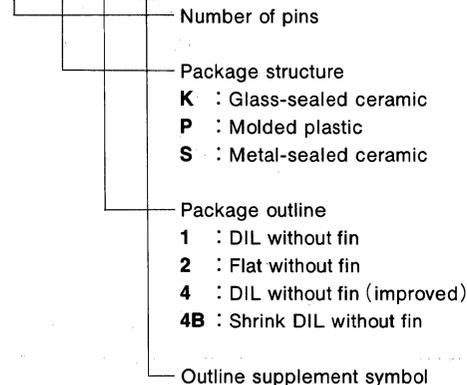
Example : **M 5 L 8251 A P - 5**



## PACKAGE CODE

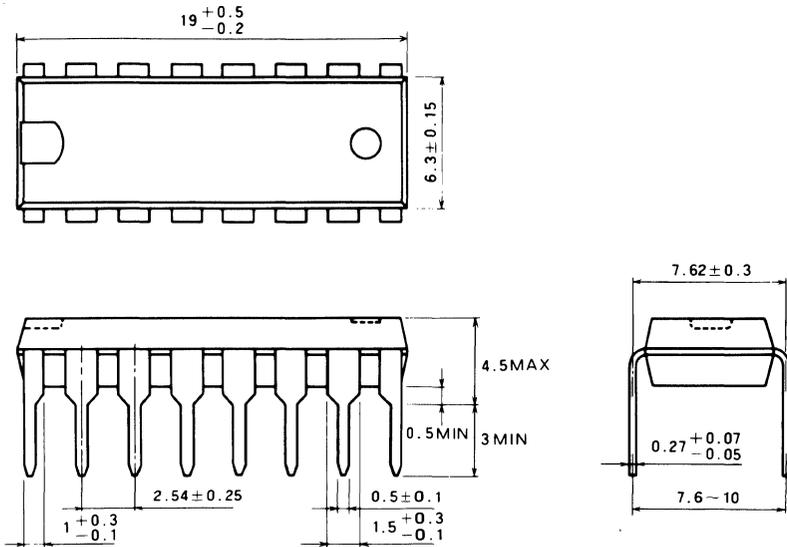
Package style may be specified by using the following simplified alphanumeric code.

Example : **40 P 2 R**



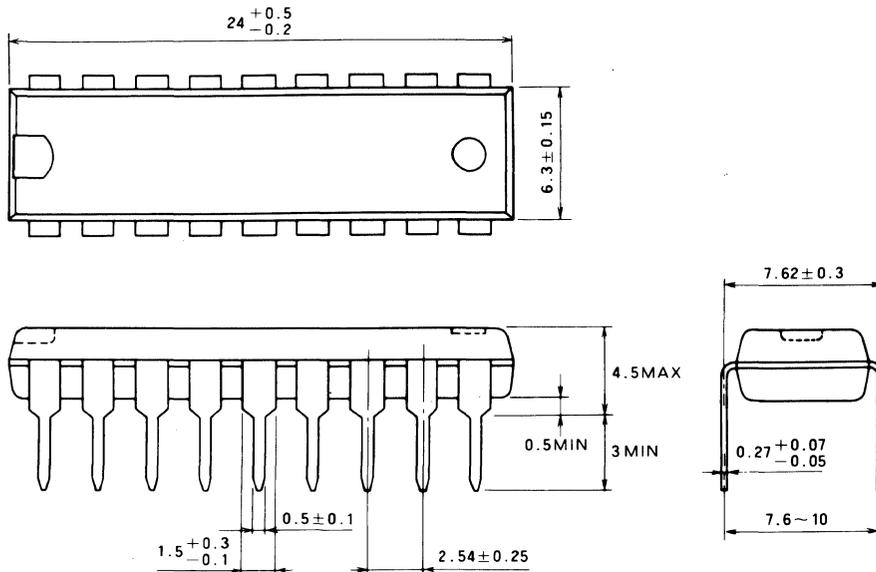
**TYPE 16P4 16-PIN MOLDED PLASTIC DIL**

Dimension in mm



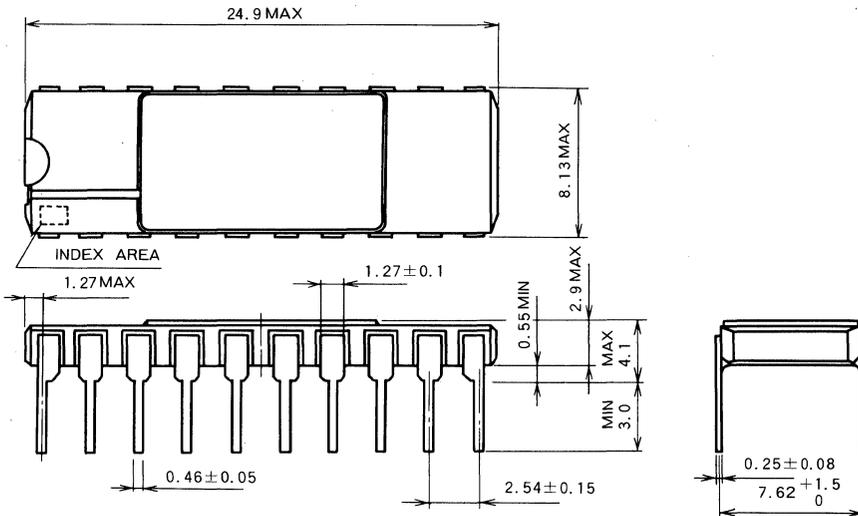
**TYPE 18P4 18-PIN MOLDED PLASTIC DIL**

Dimension in mm



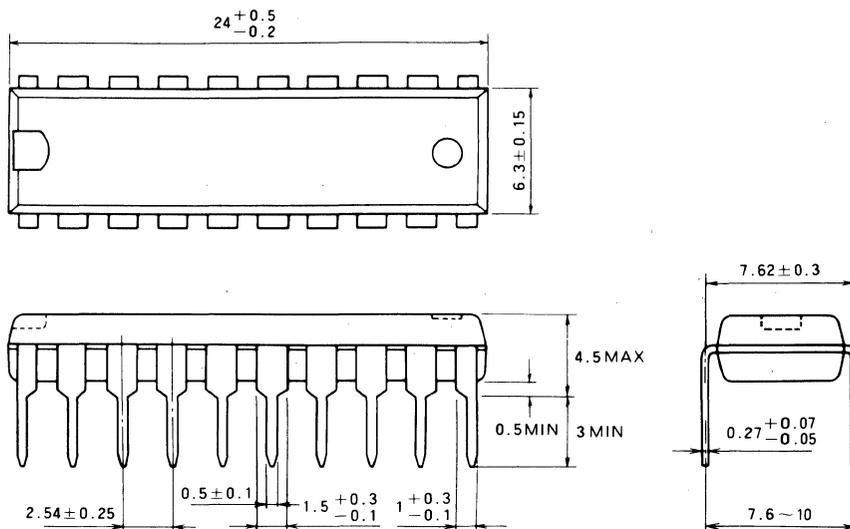
**TYPE 20S1 20-PIN METAL-SEALED CERAMIC DIL**

Dimension in mm.



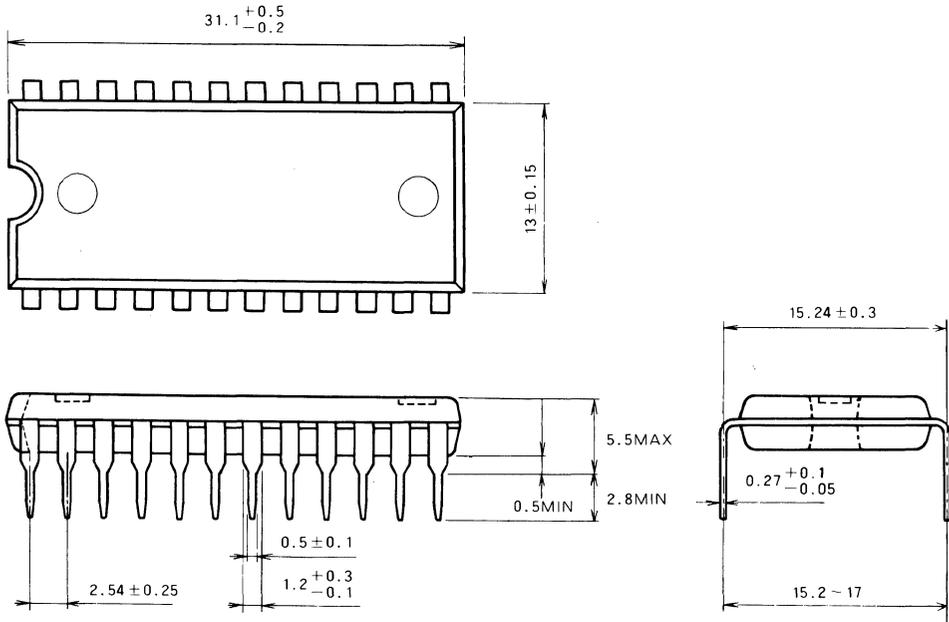
**TYPE 20P4 20-PIN MOLDED PLASTIC DIL**

Dimension in mm



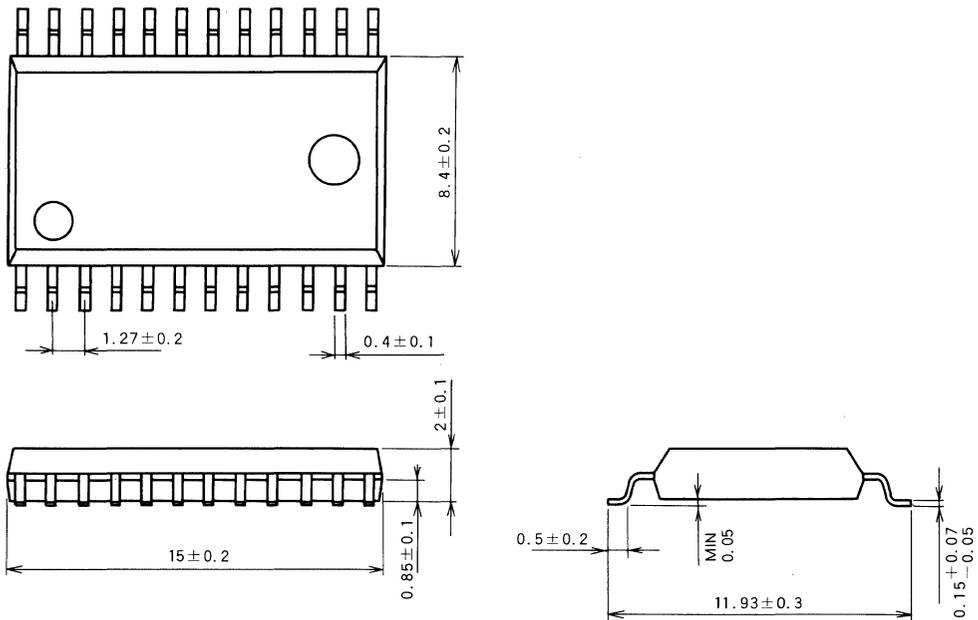
**TYPE 24P4 24-PIN MOLDED PLASTIC DIL**

Dimension in mm



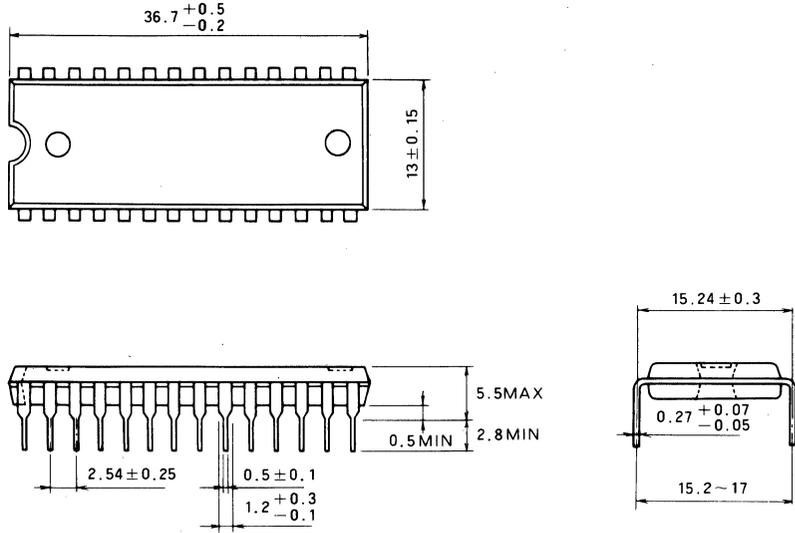
**TYPE 24P2W 24-PIN MOLDED PLASTIC FLAT**

Dimension in mm



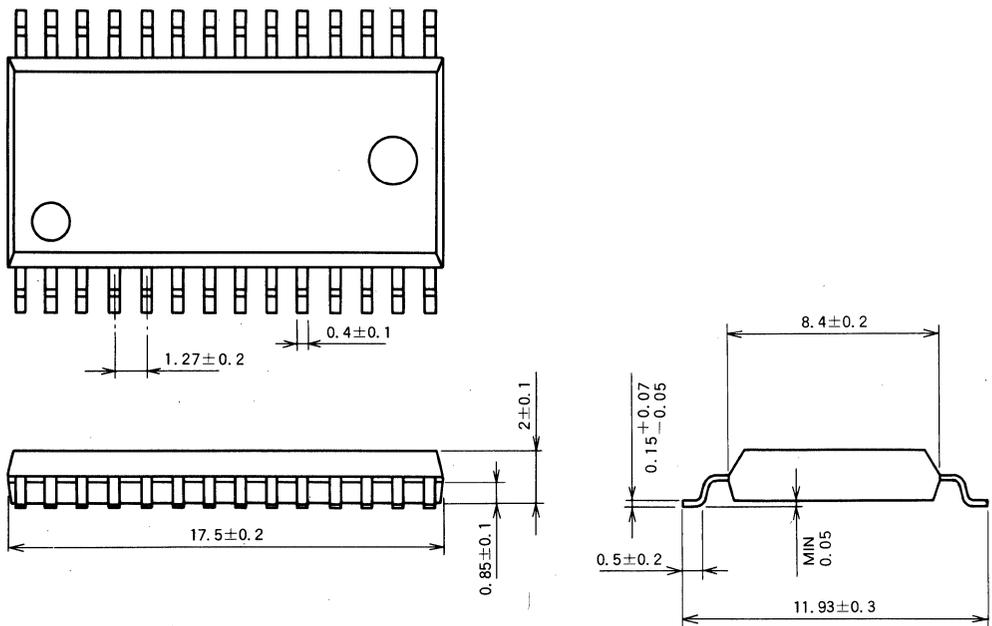
**TYPE 28P4 28-PIN MOLDED PLASTIC DIL**

Dimension in mm



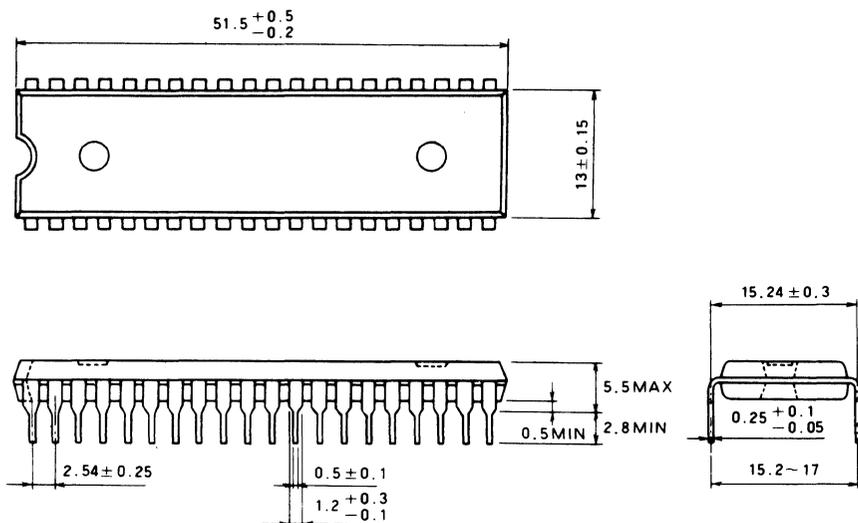
**TYPE 28P2W 28-PIN MOLDED PLASTIC FLAT**

Dimension in mm



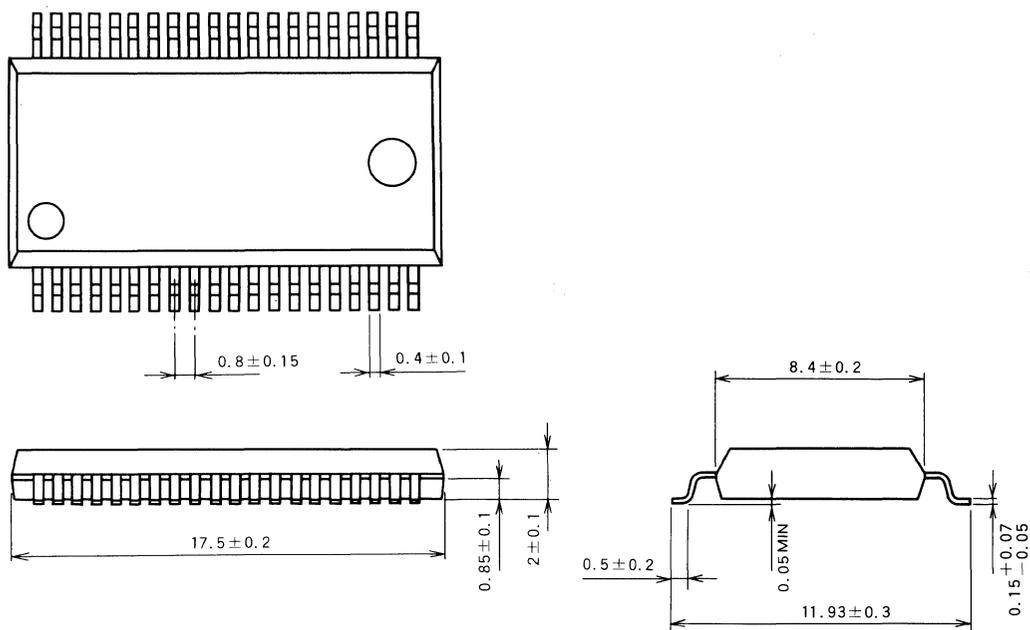
**TYPE 40P4 40-PIN MOLDED PLASTIC DIL**

Dimension in mm



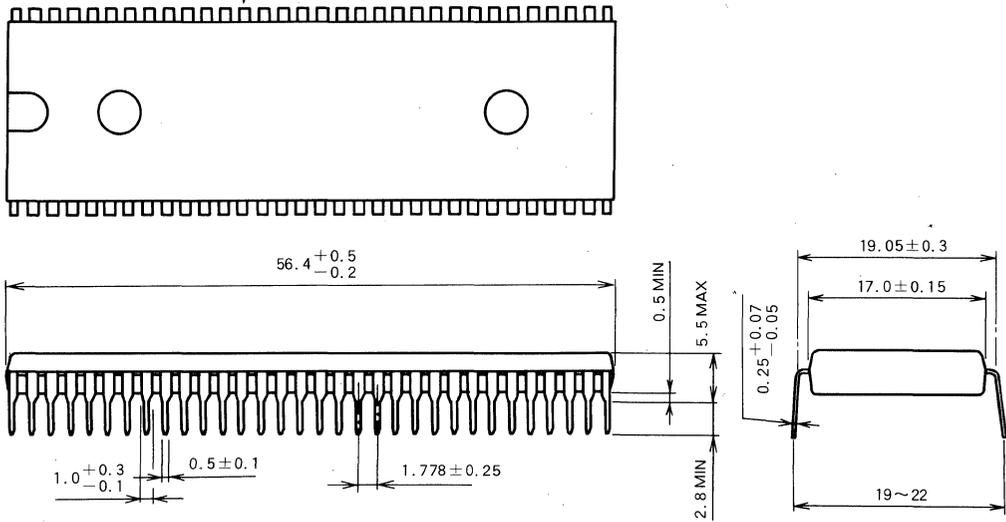
**TYPE 40P2R 40-PIN MOLDED PLASTIC FLAT**

Dimension in mm



TYPE 64P4B 64-PIN MOLDED PLASTIC DIL(LEAD PITCH 1.78mm)

Dimension in mm



# LETTER SYMBOLS FOR THE DYNAMIC PARAMETERS

## 1. INTRODUCTION

A system of letter symbols to be used to represent the dynamic parameters of integrated circuit memories and other sequential circuits especially for single-chip microcomputers, microprocessors and LSIs for peripheral circuits has been discussed internationally in the TC47 of the International Electrotechnical Committee (IEC). Finally the IEC has decided on the meeting of TC47 in February 1980 that this system of letter symbols will be a Central Office document and circulated to all countries to vote which means this system of letter symbols will be an international standard.

The system is applied in this LSI data book for the new products only. Future editions of this data book will be applied this system. The IEC document which describes "Letter symbols for dynamic parameters of sequential integrated circuits, including memories" is introduced below. In this data book, the dynamic parameters in the IEC document are applied to timing requirements and switching characteristics.

## 2. LETTER SYMBOLS

The system of letter symbols outlined in this document enables symbols to be generated for the dynamic parameters of complex sequential circuits, including memories, and also allows these symbols to be abbreviated to simple mnemonic symbols when no ambiguity is likely to arise.

### 2.1. General Form

The dynamic parameters are represented by a general symbol of the form:

$$t_{A(BC-DC)F} \dots\dots\dots (1)$$

where :

**Subscript A** indicates the type of dynamic parameter being represented, for example; cycle time, setup time, enable time, etc.

**Subscript B** indicates the name of the signal or terminal for which a change of state or level (or establishment of a state or level) constitutes a signal event assumed to occur first, that is, at the beginning of the time interval. If this event actually occurs last, that is, at the end of the time interval, the value of the time interval is negative.

**Subscript C** indicates the direction of the transition and/or the final state or level of the signal represented by B. When two letters are used, the initial state or level is also indicated.

**Subscript D** indicates the name of the signal or terminal for which a change of state or level (or establishment of a state or level) constitutes a signal event assumed to occur last, that is, at the end of the time interval. If this event actually occurs first, that is, at the beginning of the time interval, the value of the time interval is negative.

**Subscript E** indicates the direction of the transition and/or the final state or level of the signal represented by D. When two letters are used, the initial state or level is also indicated.

**Subscript F** indicates additional information such as mode of operation, test conditions, etc.

Note 1. Subscripts A to F may each consists of one or more letters.

2. Subscripts D and E are not used for transition times.

3. The "-" in the symbol (1) above is used to indicate "to"; hence the symbol represents the time interval from signal event B occurring to signal event D occurring, and it is important to note that this convention is used for all dynamic parameters including hold times. Where no misunderstanding can occur the hyphen may be omitted.

### 2.2. Abbreviated Form

The general symbol given above may be abbreviated when no misunderstanding is likely to arise. For example to :

$$t_{A(B-D)}$$

or  $t_{A(B)}$

or  $t_{A(D)}$  — often used for hold times

or  $t_{AF}$  — no brackets are used in this case

or  $t_A$

or  $t_{BC-DE}$  — often used for unclassified time intervals

### 2.3. Allocation of Subscripts

In allocating letter symbols for the subscripts, the most commonly used subscripts are given single letters where practicable and those less commonly used are designated by up to three letters. As far as possible, some form of mnemonic representation is used. Longer letter symbols may be used for specialised signals or terminals if this aids understanding.

## 3. SUBSCRIPT A (For Type of Dynamic Parameter)

The subscript A represents the type of dynamic parameter to be designated by the symbol and, for memories, the parameters may be divided into two classes :

- a) those that are timing requirements for the memory and

# LETTER SYMBOLS FOR THE DYNAMIC PARAMETERS

b) those that are characteristics of the memory. The letter symbols so far proposed for memory circuits are listed in sub-clauses 3.1 and 3.2 below. All subscripts A should be in lower-case.

### 3.1. Timing Requirements

The letter symbols for the timing requirements of semiconductor memories are as follows :

Term	Subscript
Cycle time	c
Time interval between two signal events	d
Fall time	f
Hold time	h
Precharging time	pc
Rise time	r
Recovery time	rec
Refresh time interval	rf
Setup time	su
Transition time	t
Pulse duration (width)	w

### 3.2. Characteristics

The letter symbols for the dynamic characteristics of semiconductor memories are as follows :

Characteristic	Subscript
Access time	a
Disable time	dis
Enable time	en
Propagation time	p
Recovery time	rec
Transition time	t
Valid time	v

Note: Recovery time for use as a characteristic is limited to sense recovery time.

### 4. SUBSCRIPTS B AND D (For Signal Name or Terminal Name)

The letter symbols for the signal name or the name of the terminal are as given below. All subscripts B and D should be in upper-case.

Signal or terminal	Subscript
Address	A
Clock	C
Column address	CA
Column address strobe	CAS
Data input	D
Data input/output	DQ
Chip enable	E

Erase	ER
Output enable	G
Program	PR
Data output	Q
Read	R
Row address	RA
Row address strobe	RAS
Refresh	RF
Read/Write	RW
Chip select	S
Write (write enable)	W

- Note 1: In the letter symbols for time intervals, bars over the subscripts, for example CAS, should not be used.
- 2: It should be noted, when further letter symbols are chosen, that the subscript should not end with H, K, V, X, or Z. (See clause 5)
- 3: If the same terminal, or signal, can be used for two functions (for example Data input/output, Read/Write) the waveform should be labelled with the dual function, if appropriate, but the symbols for the dynamic parameters should include only that part of the subscript relevant to the parameter.

### 5. SUBSCRIPTS C AND E (For Transition of Signal)

The following symbols are used to represent the level or state of a signal :

Transition of signal	Subscript
High logic level	H
Low logic level	L
Valid steady-state level (either low or high)	V
Unknown, changing, or 'don't care' level	X
High-impedance state of three-state output	Z

The direction of transition is expressed by two letters, the direction being from the state represented by the first letter to that represented by the second letter, with the letters being as given above.

When no misunderstanding can occur, the first letter may be omitted to give an abbreviated symbol for subscripts C and E as indicated below.

All subscripts C and E should be in upper-case.

Examples	Subscript	
	Full	Abbreviated
Transition from high level to low level	HL	L
Transition from low level to high level	LH	H
Transition from unknown or changing state to valid state	XV	V
Transition from valid state to unknown or changing state	VX	X
Transition from high-impedance state to valid state	ZV	V

Note: Since subscripts C and E may be abbreviated, and since subscripts B and D may contain an indeterminate number of letters, it is necessary to put the restriction on the subscripts B and D that they should not end with H, L, V, X, or Z, so as to avoid possible confusion.

# LETTER SYMBOLS FOR THE DYNAMIC PARAMETERS

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## 6. SUBSCRIPT F (For Additional Information)

If necessary, subscript F is used to represent any additional qualification of the parameter such as mode of operation, test conditions, etc. The letter symbols for subscript F are given below.

Subscript F should be in upper-case.

Modes of operation	Subscript
Power-down	PD
Page-mode read	PGR
Page-mode write	PGW
Read	R
Refresh	RF
Read-modify-write	RMW
Read-write	RW
Write	W

**FOR DIGITAL INTEGRATED CIRCUITS**

New symbol	Former symbol	Parameter—definition
$C_i$		Input capacitance
$C_o$		Output capacitance
$C_{i/o}$		Input/output terminal capacitance
$C_i(\phi)$		Input capacitance of clock input
$f$		Frequency
$f(\phi)$		Clock frequency
$I$		Current—the current into an integrated circuit terminal is defined as a positive value and the current out of a terminal is defined as a negative value
$I_{BB}$		Supply current from $V_{BB}$
$I_{BB(AV)}$		Average supply current from $V_{BB}$
$I_{CC}$		Supply current from $V_{CC}$
$I_{CC(AV)}$		Average supply current from $V_{CC}$
$I_{CC(PD)}$		Power-down supply current from $V_{CC}$
$I_{DD}$		Supply current from $V_{DD}$
$I_{DD(AV)}$		Average supply current from $V_{DD}$
$I_{GG}$		Supply current from $V_{GG}$
$I_{GG(AV)}$		Average supply current from $V_{GG}$
$I_i$		Input current
$I_{iH}$		High-level input current—the value of the input current when $V_{OH}$ is applied to the input considered
$I_{iL}$		Low-level input current—the value of the input current when $V_{OL}$ is applied to the input considered
$I_{oH}$		High-level output current—the value of the output current when $V_{OH}$ is applied to the output considered
$I_{oL}$		Low-level output current—the value of the output current when $V_{OL}$ is applied to the output considered
$I_{OZ}$		Off-state (high-impedance state) output current—the current into an output having a three-state capability with input condition so applied that it will establish according to the product specification, the off (high-impedance) state at the output
$I_{OZH}$		Off-state (high-impedance state) output current, with high-level voltage applied to the output
$I_{OZL}$		Off-state (high-impedance state) output current, with low-level voltage applied to the output
$I_{OS}$		Short-circuit output current
$I_{SS}$		Supply current from $V_{SS}$
$P_d$		Power dissipation
$N_{EW}$		Number of erase/write cycles
$N_{RA}$		Number of read access unrefreshed
$R_i$		Input resistance
$R_L$		External load resistance
$R_{OFF}$		Off-state output resistance
$R_{ON}$		On-state output resistance
$t_a$		Access time—the time interval between the application of a specified input pulse during a read cycle and the availability of valid data signal at an output
$t_a(A)$	$t_a(AD)$	Address access time—the time interval between the application of an address input pulse and the availability of valid data signals at an output
$t_a(CAS)$		Column address strobe access time
$t_a(E)$	$t_a(CE)$	Chip enable access time
$t_a(G)$	$t_a(OE)$	Output enable access time
$t_a(PR)$		Data access time after program
$t_a(RAS)$		Row address strobe access time
$t_a(S)$	$t_a(CS)$	Chip select access time
$t_c$		Cycle time
$t_{CR}$	$t_c(RD)$	Read cycle time—the time interval between the start of a read cycle and the start of the next cycle
$t_{CRF}$	$t_c(REF)$	Refresh cycle time—the time interval between successive signals that are intended to restore the level in a dynamic memory cell to its original level
$t_{CPG}$	$t_c(PG)$	Page-mode cycle time
$t_{CRMW}$	$t_c(RMR)$	Read-modify-write cycle time—the time interval between the start of a cycle in which the memory is read and new data is entered, and the start of the next cycle
$t_{CW}$	$t_c(WR)$	Write cycle time—the time interval between the start of a write cycle and the start of the next cycle

New symbol	Former symbol	Parameter—definition
$t_d$		Delay time—the time between the specified reference points on two pulses
$t_d(\phi)$		Delay time between clock pulses—e.g., symbology, delay time, clock 1 to clock 2 or clock 2 to clock 1
$t_d(\text{CAS-RAS})$		Delay time, column address strobe to row address strobe
$t_d(\text{CAS-W})$	$t_d(\text{CAS-WR})$	Delay time, column address strobe to write
$t_d(\text{RAS-CAS})$		Delay time, row address strobe to column address strobe
$t_d(\text{RAS-W})$	$t_d(\text{RAS-WR})$	Delay time, row address strobe to write
$t_{dis}(\text{R-Q})$	$t_{dis}(\text{R-DA})$	Output disable time after read
$t_{dis}(\text{S})$	$t_{PXZ}(\text{CS})$	Output disable time after chip select
$t_{dis}(\text{W})$	$t_{PXZ}(\text{WR})$	Output disable time after write
$t_{DHL}$		High-level to low-level delay time
$t_{DLH}$		Low-level to high-level delay time
$t_{en}(\text{A-Q})$	$t_{PZV}(\text{A-DQ})$	Output enable time after address
$t_{en}(\text{R-Q})$	$t_{PZV}(\text{R-DQ})$	Output enable time after read
$t_{en}(\text{S-Q})$	$t_{PXZ}(\text{CS-DQ})$	Output enable time after chip select
$t_f$		Fall time
$t_h$		Hold time—the interval time during which a signal at a specified input terminal after an active transition occurs at another specified input terminal
$t_h(\text{A})$	$t_h(\text{AD})$	Address hold time
$t_h(\text{A-E})$	$t_h(\text{AD-CE})$	Chip enable hold time after address
$t_h(\text{A-PR})$	$t_h(\text{AD-PRO})$	Program hold time after address
$t_h(\text{CAS-CA})$		Column address hold time after column address strobe
$t_h(\text{CAS-D})$	$t_h(\text{CAS-DA})$	Data-in hold time after column address strobe
$t_h(\text{CAS-Q})$	$t_h(\text{CAS-OUT})$	Data-out hold time after column address strobe
$t_h(\text{CAS-RAS})$		Row address strobe hold time after column address strobe
$t_h(\text{CAS-W})$	$t_h(\text{CAS-WR})$	Write hold time after column address strobe
$t_h(\text{D})$	$t_h(\text{DA})$	Data-in hold time
$t_h(\text{D-PR})$	$t_h(\text{DA-PRO})$	Program hold time after data-in
$t_h(\text{E})$	$t_h(\text{CE})$	Chip enable hold time
$t_h(\text{E-D})$	$t_h(\text{CE-DA})$	Data-in hold time after chip enable
$t_h(\text{E-G})$	$t_h(\text{CE-OE})$	Output enable hold time after chip enable
$t_h(\text{R})$	$t_h(\text{RD})$	Read hold time
$t_h(\text{RAS-CA})$		Column address hold time after row address strobe
$t_h(\text{RAS-CAS})$		Column address strobe hold time after row address strobe
$t_h(\text{RAS-D})$	$t_h(\text{RAS-DA})$	Data-in hold time after row address strobe
$t_h(\text{RAS-W})$	$t_h(\text{RAS-WR})$	Write hold time after row address strobe
$t_h(\text{S})$	$t_h(\text{CS})$	Chip select hold time
$t_h(\text{W})$	$t_h(\text{WR})$	Write hold time
$t_h(\text{W-CAS})$	$t_h(\text{WR-CAS})$	Column address strobe hold time after write
$t_h(\text{W-D})$	$t_h(\text{WR-DA})$	Data-in hold time after write
$t_h(\text{W-RAS})$	$t_h(\text{WR-RAS})$	Row address hold time after write
$t_{PHL}$		High-level to low-level propagation time
$t_{PLH}$		Low-level to high-level propagation time
$t_r$		Rise time
$t_{rec}(\text{W})$	$t_{wr}$	Write recovery time—the time interval between the termination of a write pulse and the initiation of a new cycle
$t_{rec}(\text{PD})$	$t_{R}(\text{PD})$	Power-down recovery time
$t_{su}$		Setup time—the time interval between the application of a signal which is maintained at a specified input terminal and a consecutive active transition at another specified input terminal
$t_{su}(\text{A})$	$t_{su}(\text{AD})$	Address setup time
$t_{su}(\text{A-E})$	$t_{su}(\text{AD-CE})$	Chip enable setup time before address
$t_{su}(\text{A-W})$	$t_{su}(\text{AD-WR})$	Write setup time before address
$t_{su}(\text{CA-RAS})$		Row address strobe setup time before column address

New symbol	Former symbol	Parameter—definition
$t_{su}(D)$	$t_{su}(DA)$	Data-in setup time
$t_{su}(D-E)$	$t_{su}(DA-CE)$	Chip enable setup time before data-in
$t_{su}(D-W)$	$t_{su}(DA-WR)$	Write setup time before data-in
$t_{su}(E)$	$t_{su}(CE)$	Chip enable setup time
$t_{su}(E-P)$	$t_{su}(CE-P)$	Precharge setup time before chip enable
$t_{su}(G-E)$	$t_{su}(OE-CE)$	Chip enable setup time before output enable
$t_{su}(P-E)$	$t_{su}(P-CE)$	Chip enable setup time before precharge
$t_{su}(PD)$		Power-down setup time
$t_{su}(R)$	$t_{su}(RD)$	Read setup time
$t_{su}(R-CAS)$	$t_{su}(RA-CAS)$	Column address strobe setup time before read
$t_{su}(RA-CAS)$		Column address strobe setup time before row address
$t_{su}(S)$	$t_{su}(CS)$	Chip select setup time
$t_{su}(S-W)$	$t_{su}(CS-WR)$	Write setup time before chip select
$t_{su}(W)$	$t_{su}(WR)$	Write setup time
$t_{THL}$		High-level to low-level transition time
$t_{TLH}$		Low-level- to high-level transition time
		} the time interval between specified reference points on the edge of the output pulse when the output is going to the low (high) level and when a specified input signal is applied through a specified network and the output is loaded by another specified network
$t_v(A)$	$t_{dv}(AD)$	Data valid time after address
$t_v(E)$	$t_{dv}(CE)$	Data valid time after chip enable
$t_v(E)PR$	$t_v(CE)PR$	Data valid time after chip enable in program mode
$t_v(G)$	$t_v(OE)$	Data valid time after output enable
$t_v(PR)$		Data valid time after program
$t_v(S)$	$t_v(CS)$	Data valid time after chip select
$t_w$		Pulse width (pulse duration) the time interval between specified reference points on the leading and trailing edges of the waveforms
$t_w(E)$	$t_w(CE)$	Chip enable pulse width
$t_w(EH)$	$t_w(CEH)$	Chip enable high pulse width
$t_w(EL)$	$t_w(EL)$	Chip enable low pulse width
$t_w(PR)$		Program pulse width
$t_w(R)$	$t_w(RD)$	Read pulse width
$t_w(S)$	$t_w(CS)$	Chip select pulse width
$t_w(W)$	$t_w(WR)$	Write pulse width
$t_w(\phi)$		Clock pulse width
$T_a$		Ambient temperature
$T_{opr}$		Operating temperature
$T_{stg}$		Storage temperature
$V_{BB}$		$V_{BB}$ supply voltage
$V_{CC}$		$V_{CC}$ supply voltage
$V_{DD}$		$V_{DD}$ supply voltage
$V_{GG}$		$V_{GG}$ supply voltage
$V_I$		Input voltage
$V_{IH}$		High-level input voltage—the value of the permitted high-state voltage at the input
$V_{IL}$		Low-level input voltage—the value of the permitted low-state voltage at the input
$V_O$		Output voltage
$V_{OH}$		High-level output voltage—the value of the guaranteed high-state voltage range at the output
$V_{OL}$		Low-level output voltage—the value of the guaranteed low-state voltage range at the output
$V_{SS}$		$V_{SS}$ supply voltage

# QUALITY ASSURANCE AND RELIABILITY TESTING

1

## 1. PLANNING

In recent years, advances in integrated circuits have been rapid, with increasing density and speed accompanied by decreasing cost. Because of these advances, it is now practical and economically justifiable to use these devices in systems of greater complexity and in which they were previously considered too expensive. All of these advances add up to increased demand.

We at Mitsubishi foresaw this increased demand and organized our production facilities to meet it. We also realized that simply increasing production to meet the demand was not enough and that positive steps would have to be taken to assure the reliability of our products.

This realization resulted in development of our Quality Assurance System. The system has resulted in improved products, and Mitsubishi is able to supply its customers' needs with ICs of high reliability and stable quality. This system is the key to future planning for improved design, production and quality assurance.

## 2. QUALITY ASSURANCE SYSTEM

The Quality Assurance System imposes quality controls on Mitsubishi products from the initial conception of a new product to the final delivery of the product to the customer. A diagram of the total system is shown in Fig. 1. For ease of understanding, the system is divided into three stages.

### 2.1 Quality Assurance in the Design Stage

The characteristics of the breadboard devices are carefully checked to assure that all specifications are met. Standard integrated circuits and high-quality discrete components are used. During the design stage, extensive use is made of a sophisticated CAD program, which is updated to always include the latest state-of-the-art techniques.

### 2.2 Quality Assurance in the Limited-Manufacturing Stage

Rigid controls are maintained on the environment, incoming material and manufacturing equipment such as tools and test equipment. The products and materials used are subjected to stringent tests and inspections as they are manufactured. Wafer production is closely monitored.

Finally, a tough quality assurance test and inspection is made before the product is released for delivery to a customer. This final test includes a complete visual inspection and electrical characteristics tests. A sampling technique is used to conduct tests under severe operating conditions to assure that the products meet reliability specifications.

### 2.3 Quality Assurance in the Full Production Stage

Full production of a product is not started until it has been confirmed that it can be manufactured to meet quality and reliability specifications. The controls, tests and inspection

procedures developed in §2.2 are continued. The closest monitoring assures that they are complied with.

## 3. RELIABILITY CONTROL

### 3.1 Reliability Tests

The newly established Reliability Center for Electronic Components of Japan has established a qualification system for electronic components. Reliability test methods and procedures are developed to mainly meet MIL-STD-883 and JIS C 7022 specifications. Details of typical tests used on Mitsubishi ICs are shown in Table 1.

Table 1 Typical reliability test items and conditions

Group	Item	Test condition
1	High temperature operating life	Maximum operating ambient temperature 1000h
	High temperature storage life	Maximum storage temperature 1000h
	Humidity (steady state) life	65°C 95%RH 500h
2	Soldering heat	260°C 10s
	Thermal shock	0~100°C 15 cycles, 10min/cycle
	Temperature cycle	Minimum to maximum storage temperature, 10 cycles of 1h/cycle
3	Soldering	230°C, 5s, use rosin flux
	Lead integrity	Tension: 340g 30s Bonding stress: 225g, ±30°, 3 times
	Vibration	20G, X, Y, Z each direction, 4 times 100~2000Hz~4 min/cycle
	Shock	1500G, 0.5ms in X <sub>1</sub> , Y <sub>1</sub> and Z <sub>1</sub> direction, 5 times
	Constant acceleration	20000G, Y <sub>1</sub> direction, 1 min

### 3.2 Failure Analysis

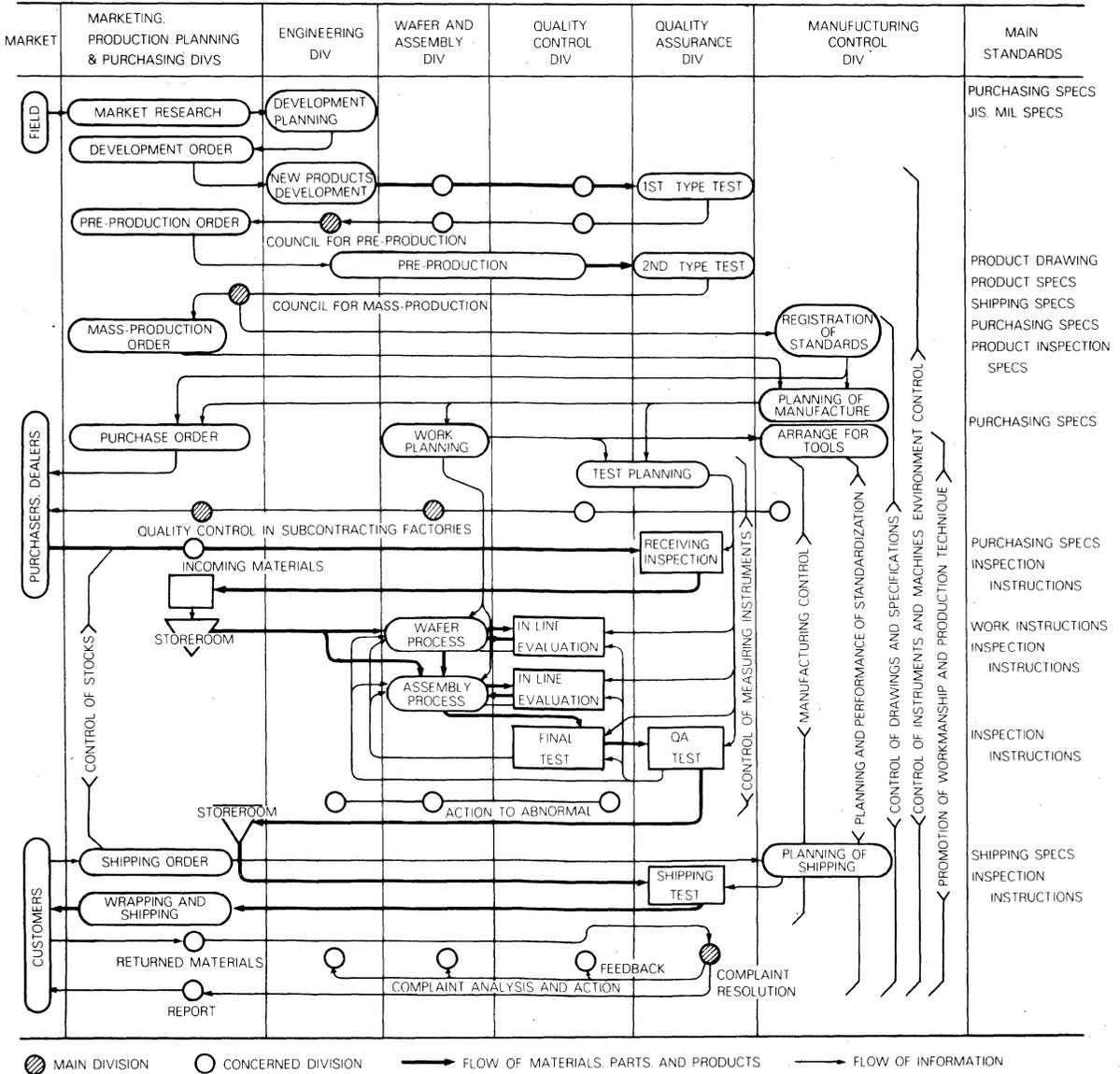
Devices that have failed during reliability or acceleration tests are analyzed to determine the cause of failure. This information is fed back to the process engineering section and manufacturing section so that improvements can be made to increase reliability. A summary of failure analysis procedures is shown in Table 2.

Table 2 Summary of failure analysis procedures

Step	Description
1. External examination	○ Inspection of leads, plating, soldering and welding
	○ Inspection of materials, sealing, package and marking
	○ Visual inspection of other items of the specifications
2. Electrical tests	○ Use of stereo microscopes, metallurgical microscopes, X-ray photographic equipment, line leakage and gross leakage testers in the examination
	○ Checking for open circuits, short circuits and parametric degradation by electrical parameter measurement
	○ Observation of characteristics by a synchroscope or a curve tracer and checking of important physical characteristics by electrical characteristics
	○ Stress tests such as environmental or life tests, if required
3. Internal examination	○ Removal of the cover of the device, the optical inspection of the internal structure of the device
	○ Checking of the silicon chip surface
	○ Measurement of electrical characteristics by probes, if applicable
	○ Use of SEM, XMA and infrared microscanner if required
4. Chip analysis	○ Use of metallurgical analysis techniques to supplement analysis of the internal examination
	○ Slicing for cross sectional inspection
	○ Analysis of oxide film defects
	○ Analysis of diffusion defects

# QUALITY ASSURANCE AND RELIABILITY TESTING

Fig. 1 Quality assurance system



**MITSUBISHI LSI's**

# **PRECAUTIONS IN HANDLING MOS ICs**

**1**

A MOS transistor has a very thin oxide insulator under the gate electrode on the silicon substrate. It is operated by altering the conductance ( $g_m$ ) between source and drain to control mobile charges in the channel formed by the applied gate voltage.

If a high voltage were applied to a gate terminal, the insulator-film under the gate electrode could be destroyed, and all Mitsubishi MOS IC/LSIs contain internal protection circuits at each input terminal to prevent this. It is inherently necessary to apply reverse bias to the P-N junctions of a MOS IC/LSI.

Under certain conditions, however, it may be impossible to completely avoid destruction of the thin insulator-film due to the application of unexpectedly high voltage or thermal destruction due to excessive current from a forward biased P-N junction. The following recommendations should be followed in handling MOS devices.

## **1. KEEPING VOLTAGE AND CURRENT TO EACH TERMINAL BELOW MAXIMUM RATINGS**

1. The recommended ranges of operating conditions provide adequate safety margins. Operating within these limits will assure maximum equipment performance and quality.
2. Forward bias should not be applied to any terminal since excessive current may cause thermal destruction.
3. Output terminals should not be connected directly to the power supply. Short-circuiting of a terminal to a power supply having low impedance may cause burn-out of the internal leads or thermal destruction due to excessive current.

## **2. KEEPING ALL TERMINALS AT THE SAME POTENTIAL DURING TRANSPORT AND STORAGE**

When MOS IC/LSIs are not in use, both input and output terminals can be in a very high impedance state so that they are easily subjected to electrostatic induction from AC fields of the surrounding space or from charged objects in their vicinity. For this reason, MOS IC/LSIs should be protected from electrostatic charges while being transported and stored by conductive rubber foam, aluminum foil, shielded boxes or other protective precautions.

## **3. KEEPING ELECTRICAL EQUIPMENT, WORK TABLES AND OPERATING PERSONNEL AT THE SAME POTENTIAL**

1. All electric equipment, work table surfaces and operat-

ing personnel should be grounded. Work tables should be covered with copper or aluminum plates of good conductivity, and grounded. One method of grounding personnel, after making sure that there is no potential difference with electrical equipment, is by the use of a wristwatch metallic ring, etc. attached around the wrist and grounded in series with a  $1M \Omega$  resistor. Be sure that the grounding meets national regulations on personnel safety.

2. Current leakage from electric equipment must be prevented not only for personnel safety, but also to avert the destruction of MOS IC/LSIs, as described above. Items such as testers, curve-tracers and synchroscopes must be checked for current leakage before being grounded.

## **4. PRECAUTIONS FOR MOUNTING OF MOS IC/LSIs**

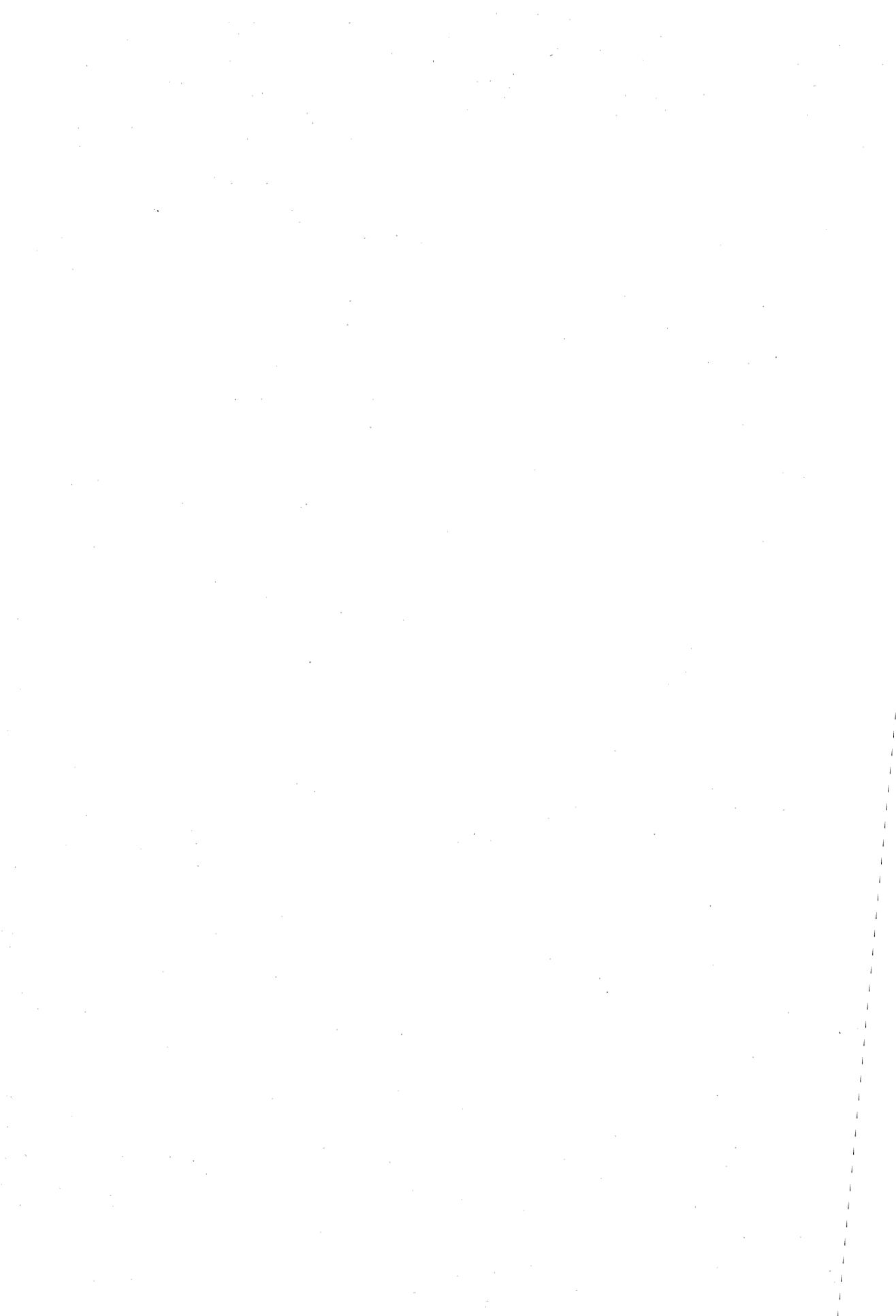
1. The printed wiring lines to input and output terminals of MOS IC/LSIs should not be close to or parallel to high-voltage or high-power signal lines. Turning power on while the device is short-circuited, either by a solder bridge made during assembly or by a probe during adjusting and testing, may cause maximum ratings to be exceeded, which may result in the destruction of the device.
2. When input/output, or input and/or output, terminals of MOS IC/LSIs (now open-circuits) are connected, we must consider the possibility of current leakage and take precautions similar to §2 above. To reduce such undesirable trouble, it is recommended that an interface circuit be inserted at the input or output terminal, or a resistor with a resistance that does not exceed the output driving capability of the MOS IC/LSI be inserted between the power supply and the ground.
3. A filter circuit should be inserted in the AC power supply line to absorb surges which can frequently be strong enough to destroy a MOS IC/LSI.
4. Terminal connections should be made as described in the catalog while being careful to meet specifications.
5. Ungrounded metal plates should not be placed near input or output terminals of any MOS IC/LSIs, since destruction of the insulation may result if they become electrostatically charged.
6. Equipment cases should provide shielding from electrostatic charges for more reliable operation. When a plastic case is used, it is desirable to coat the inside of the case with conductive paint and to ground it. This is considered necessary even for battery-operated equipment.



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# MELPS 85 MICROPROCESSORS

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# MITSUBISHI LSIs

## M5L8085AP

### 8-BIT PARALLEL MICROPROCESSOR

#### DESCRIPTION

This is a family of single-chip 8-bit parallel control processing units (CPUs) developed using the N-channel silicon-gate ED-MOS process. It requires a single 5V power supply and has a basic clock rate of 3MHz. With an instruction set that is completely compatible with that of the M5L8080AP,S, this device is designed to improve on the M5L8080AP,S with higher system speed.

#### FEATURES

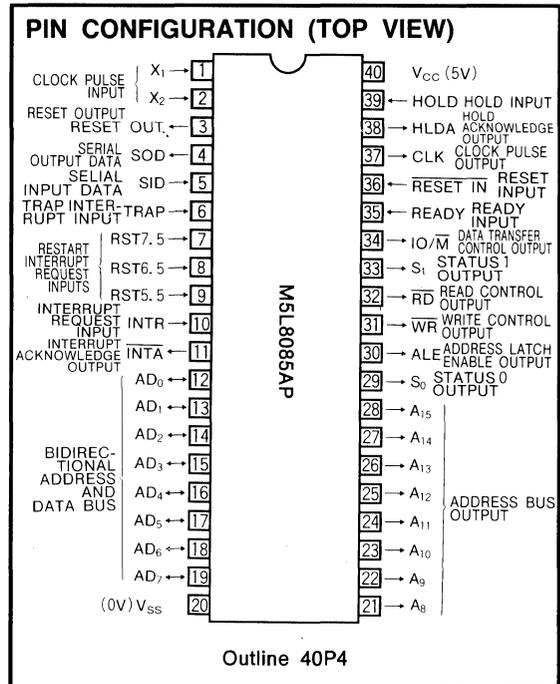
- Single 5V supply voltage
- TTL compatible
- Instruction cycle ..... 1.3  $\mu$ s (min.)
- Software compatibility with the M5L8080AP,S (with two additional instructions)
- Clock generator (with an external crystal or RC circuit)
- Built-in system controller
- Four vectored interrupts (one of which is non-maskable)
- Serial I/O port ..... 1 each
- Decimal, binary, and double precision arithmetic operations

#### APPLICATION

Central processing unit for a microcomputer

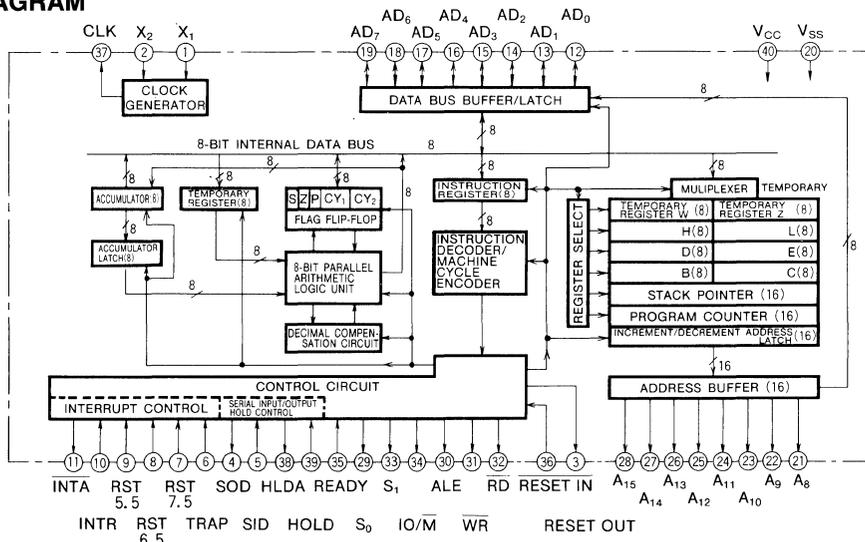
#### FUNCTION

Under the multiplexed data bus concept adopted, the high-order 8 bits of the address are used only as an address bus and the low-order 8 bit are used as an address/data bus. During the first clock cycle of an instruction cycle, the address is transferred. The low-order 8 bits of the address are stored in the external latch by the address latch enable (ALE) signal. During the second and third clock cycles, the address/data bus functions as the data bus, transferring the



data to memory or to the I/O. For bus control, the device provides  $\overline{RD}$ ,  $\overline{WR}$ , and  $\overline{IO/M}$  signals and an interrupt acknowledge signal (INTA.) The HOLD, READY and all interrupt signals are synchronized with the clock pulse. For simple serial data transfer it provides both a serial input data (SID) line and a serial output data (SOD) line. It also has three maskable restart interrupts and one non-maskable trap interrupt.

#### BLOCK DIAGRAM



8-BIT PARALLEL MICROPROCESSOR

PIN DESCRIPTIONS

Pin	Name	Input or output	Functions															
X <sub>1</sub> , X <sub>2</sub>	Clock input	In	These pins are used to connect an external crystal or CR circuit to the internal clock generator. An external clock pulse can also be input through X <sub>1</sub> .															
RESET OUT	Reset output	Out	This signal indicates that the CPU is in the reset mode. It can be used as a system RESET. The signal is synchronised to the processor clock.															
SOD	Serial output data	Out	This is an output data line for serial data. The output SOD may be set or reset by means of the SIM instruction. It return to high level after the RESET.															
SID	Serial input data	In	This is an input data line for serial data, and the data on this line is moved to the 7th bit of the accumulator whenever a RIM instruction is executed.															
TRAP	Trap interrupt	In	A non-maskable restart which is recognized at the same time as an INTR it is not affected by any mask or another interrupt. It has the highest interrupt priority.															
RST5.5 RST6.5 RST7.5	Restart interrupt request	In	Input timing is the same as for INTR for these three signals. They all cause an automatic insertion of an internal RESTART. RST 7.5 has the highest priority while RST 5.5 has the lowest. All three signals have a higher priority than INTR.															
INTR	Interrupt request signal	In	This signal is for a general purpose interrupt and is sampled only during the last clock cycle of the instruction. When an interrupt is acknowledged, the program counter (PC) is held and an INTA signal is generated. During this cycle, a RESTART or CALL can be inserted to jump to an interrupt service routine. The interrupt request may be enable and disable by means of software. But it is disable by the RESET and immediately after an accepted interrupt.															
$\overline{\text{INTA}}$	Interrupt acknowledge control signal	Out	This signal is used instead of $\overline{\text{RD}}$ during the instruction cycle after an INTR is accepted.															
AD <sub>0</sub> ~AD <sub>7</sub>	Bidirectional address and data bus	In/out	The low-order (I/O address) appears during the first clock cycle. During the second and third clock cycles, it becomes the data bus. It remains in the high-impedance state during the HOLD and HALT modes.															
A <sub>8</sub> ~A <sub>15</sub>	Address bus	Out	Output the high-order 8 bits of the memory address or the 8 bits of the I/O address. It remains in the high-impedance state during the HOLD and HALT modes.															
S <sub>0</sub> , S <sub>1</sub>	Status	Out	Indicates the status of the bus. <table style="margin-left: auto; margin-right: auto;"> <tr> <td></td> <td>S<sub>1</sub></td> <td>S<sub>0</sub></td> </tr> <tr> <td>HALT</td> <td>0</td> <td>0</td> </tr> <tr> <td>WRITE</td> <td>0</td> <td>1</td> </tr> <tr> <td>READ, DAD</td> <td>1</td> <td>0</td> </tr> <tr> <td>FETCH</td> <td>1</td> <td>1</td> </tr> </table> <p>The S<sub>1</sub> signal can be used as an advanced <math>\overline{\text{R/W}}</math> status.</p>		S <sub>1</sub>	S <sub>0</sub>	HALT	0	0	WRITE	0	1	READ, DAD	1	0	FETCH	1	1
	S <sub>1</sub>	S <sub>0</sub>																
HALT	0	0																
WRITE	0	1																
READ, DAD	1	0																
FETCH	1	1																
ALE	Address latch enable	Out	This signal is generated during the first clock cycle, to enable the address to be latched into the latches of peripherals. The falling edge of ALE is guaranteed to latch the address information. The ALE can also be used to strobe the status information, but it is kept in the low-level state during bus idle machine cycles.															
$\overline{\text{WR}}$	Write control	Out	Indicates that the data on the data bus is to be written into the selected memory at the falling edge of the signal $\overline{\text{WR}}$ . It remains the high-impedance state during the HOLD and HALT modes.															
$\overline{\text{RD}}$	Read control	Out	Indicates that the selected memory or I/O address is to be read and that the data bus is active for data transfer. It remains in the high-impedance state during the HOLD and HALT modes.															
IO/ $\overline{\text{M}}$	Data transfer control output	Out	This signal indicates whether the read/write is to memory or to I/O <sub>s</sub> . It remains in the high-impedance state during the HOLD and HALT modes.															
READY	Ready input	In	When it is at high-level during a read or write cycle, the READY indicates that the memory or peripheral is ready to send or receive data. When the signal is at low-level, the CPU will wait for the signal to turn high-level before completing the read or write cycle.															
$\overline{\text{RESET IN}}$	Reset input	In	This signal (at least three clock cycles are necessary) sets the program counter to zero and resets the interrupt enable and HLDA flip-flops. None of the other flags or registers (except the instruction register) are affected. The CPU is held in the reset mode as long as the signal is applied.															
CLK	Clock output	Out	Clock pulses are available from this pin when a crystal or CR circuit is used as an input to the CPU.															
HLDA	Hold acknowledge signal	Out	By this signal the processor acknowledges the HOLD request signal and indicates that it will relinquish the buses in the next clock cycle. The signal is returned to the low-level state after the HOLD request is completed. The processor resumes the use of the buses one half clock cycle after the signal HLDA goes low.															
HOLD	Hold request signal	In	When the CPU receives a HOLD request. It relinquishes the use of the buses as soon as the current machine cycle is completed. The CPU can regain the use of buses only after the HOLD state is removed. Upon acknowledging the HOLD signal, the address bus, the data bus, $\overline{\text{RD}}$ , $\overline{\text{WR}}$ and IO/ $\overline{\text{M}}$ lines are put in the high-impedance state.															

Note : HOLD, READY and all interrupt signals are synchronized with clock signal.

**STATUS INFORMATION**

Status information can be obtained directly from the M5L8085AP. ALE is used as a status strobe. As the status is partially encoded, it informs the user in advance what type of bus transfer is being performed. The  $\overline{IO/\overline{M}}$  cycle status signal is also obtained directly. Decoded  $S_0$  and  $S_1$  signals carry:

	$S_1$	$S_0$
HALT	0	0
WRITE	0	1
READ	1	0 (except for second and third machine cycles of DAD instruction.)
FETCH	1	1

$S_1$  can be used in determining the R/W status of all bus transfers.

In the M5L8085AP the low-order 8 bits of the address are multiplexed with data. When entering the low-order of the address into memory or peripheral latch circuits, the ALE is used as a strobe.

**INTERRUPT AND SERIAL I/O**

The M5L8085AP has five interrupt inputs—INTR, RST 5.5, RST 6.5, RST 7.5, and TRAP. INTR has the same function as INT of the M5L8080AP,S. The three RST inputs, 5.5, 6.5, 7.5, are provided with programmable masks. TRAP has the same function as the restart interrupt, except that it is non-maskable.

When an interrupt is enabled and the corresponding interrupt mask is not set, the three RST interrupts will cause the internal execution of the RST. When nonmaskable TRAP is applied, it causes the internal execution of an RST regardless of the state of the interrupt enable or masks. The restart addresses (hexadecimal) of the interrupts are:

Interrupt	Address
TRAP	24 <sub>16</sub>
RST 5.5	2C <sub>16</sub>
RST 6.5	34 <sub>16</sub>
RST 7.5	3C <sub>16</sub>

Two different types of signal are used for restart interrupts. Both RST 5.5 and RST 6.5 are sensitive to high-level as in INTR and INT of the M5L8080AP,S, and are acknowledged in the same timing as INTR. RST 7.5 is sensitive to rising-edge, and existence of a pulse sets the RST 7.5 inter-

rupt request. This condition will be maintained until the request is fulfilled or reset by a SIM or RESET instruction.

Each of the restart interrupts may be masked independently to avoid interrupting the CPU. An interrupt requested by an RST 7.5 will be stored even when its mask is set and the interrupt is disabled. Masks can be changed in a SIM instruction or the RESET. When two enabled interrupts are requested at the same time, the interrupt with the highest priority will be accepted. The TRAP has the highest priority followed in order by RST 7.5, RST 6.5, RST 5.5 and INTR. This priority system does not take into consideration the priority of an interrupt routine that is already started. In other words, when an RST 5.5 interrupt is reenabled before the termination of the RST 7.5 interrupt routine, it will interrupt the RST 7.5.

The TRAP interrupt is very useful in preventing disastrous errors and bus errors resulting from power failures. The TRAP input is recognized in the same manner as any other interrupt, but it has the highest priority, and is not affected by any flags or masks. The TRAP input can be sensed by both edge and level. TRAP should be maintained high-level until it is acknowledged. But, it will not be acknowledged again unless it turns low and high again. In this manner, faulty operation due to noise or logic glitches is prevented.

The serial I/O system is also considered to be an interrupt as it is controlled by instructions RIM and SIM. The SID is read by instruction RIM and the SOD data is set by instruction SIM.

**BASIC TIMING**

The M5L8085AP is provided with a multiplexed data bus. The ALE is utilized as a strobe with which the low-order 8 bits of the address on the data bus are sampled. Fig.1 shows the basic cycle in which an out instruction is fetched, and memory is read and written to the I/O port. The I/O port address is stored in both the address bus and the address/data bus during the I/O write and read cycle. To enable the M5L8085AP to be used with a slow memory, the READY line is used for extending the read and write pulse width in the same manner as in the M5L8080AP,S.

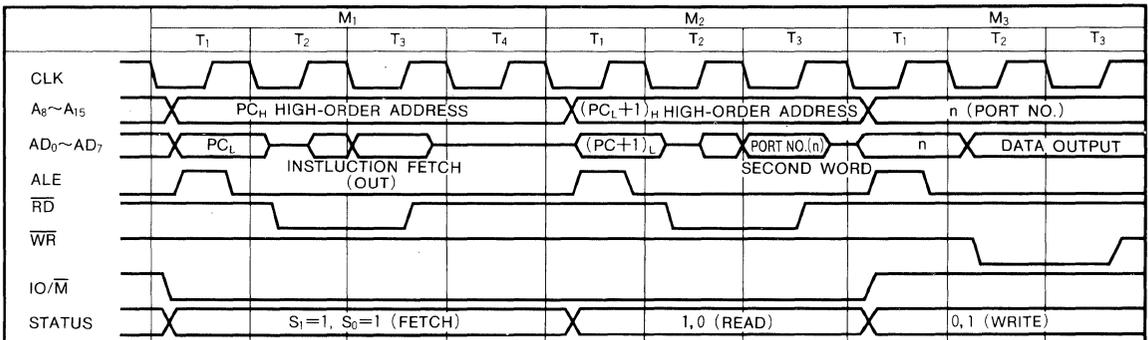


Fig. 1 Basic cycle

8-BIT PARALLEL MICROPROCESSOR

MACHINE INSTRUCTIONS

Item Instr. class	Mnemonic	Instruction code				16mal notatin	No. of states	No. of bytes	No. of cycles	Functions	Flags			Address bus		Data bus				
		D7D6	D5D4D3	D2D1D0							S	Z	P	Cy2	Cy1	Contents	Mach. cycle*	Contents	I/O	Mach. cycle**
Data transfer	MOV r1, r2	01	DDD	SSS		4	1	1	(r1) ← (r2)	X	X	X	X							
	MOV M, r	01	110	SSS		7	1	2	(M) ← (r)	X	X	X	X	M	M4	(r)	0	M4		
	MOV r, M	01	DDD	110		7	1	2	(r) ← (M)	X	X	X	X	M	M4	(M)	0	M4		
	MVI r, n	00	DDD	110		7	2	2	(r) ← n	X	X	X	X			<B2>	1	M4		
	MVI M, n	00	110	110		3	6	10	2	(M) ← n	X	X	X	X	M	M5	<B2>	1	M4	
	LXI B, m	00	000	001		0	1	10	3	(C) ← <B2> (B) ← <B3>	X	X	X	X			<B2> <B3>	1 1	M2 M3	
	LXI D, m	00	010	001		1	1	10	3	(E) ← <B2> (D) ← <B3>	X	X	X	X			<B2> <B3>	1 1	M2 M3	
	LXI H, m	00	100	001		2	1	10	3	(L) ← <B2> (H) ← <B3>	X	X	X	X			<B2> <B3>	1 1	M2 M3	
	LXI SP, m	00	110	001		3	1	10	3	(SP) ← m	X	X	X	X			<B2> <B3>	1 1	M2 M3	
	SPHL	11	111	001		F	9	6	1	(SP) ← (H) (L)	X	X	X	X						
	STAX B	00	000	010		0	2	7	1	2	((B) (C)) ← (A)	X	X	X	X	(B) (C)	M4	(A)	0	M4
	STAX D	00	010	010		1	2	7	1	2	((D) (E)) ← (A)	X	X	X	X	(D) (E)	M4	(A)	0	M4
	LDAX B	00	001	010		0	A	7	1	2	(A) ← ((B) (C))	X	X	X	X	(B) (C)	M4	((B) (C))	1	M4
	LDAX D	00	011	010		1	A	7	1	2	(A) ← ((D) (E))	X	X	X	X	(D) (E)	M4	((D) (E))	1	M4
	STA m	00	110	010		3	2	13	3	4	(m) ← (A)	X	X	X	X	m	M4	(A)	0	M4
LDA m	00	111	010		3	A	13	3	4	(A) ← (m)	X	X	X	X	m	M4	(m)	1	M4	
SHLD m	00	100	010		2	2	16	3	5	(m) ← (L) (m+1) ← (H)	X	X	X	X	m m+1	M4 M5	(L) (H)	0 0	M4 M5	
LHLD m	00	101	010		2	A	16	3	5	(L) ← (m) (H) ← (m+1)	X	X	X	X	m m+1	M4 M5	(m) (m+1)	1 1	M4 M5	
XCHG	11	101	011		E	B	4	1	1	(H) (L) ↔ (D) (E)	X	X	X	X						
XTHL	11	100	011		E	3	16	1	5	(H) (L) ↔ ((SP) + 1) ((SP))	X	X	X	X	(SP) (SP) + 1	M2 M3	((SP)) ((SP) + 1)	1 1	M2 M3	
Arithmetic, logical, compare	ADD r	10	000	SSS		4	1	1	(A) ← (A) + (r)	0	0	0	0							
	ADD M	10	000	110		8	7	1	2	(A) ← (A) + (M)	0	0	0	0	M	M4	(M)	1	M4	
	ADI n	11	000	110		C	6	7	2	2	(A) ← (A) + n	0	0	0	0			<B2>	1	M4
	ADC r	10	001	SSS		8	E	4	1	1	(A) ← (A) + (r) + (Cy2)	0	0	0	0					
	ADC M	10	001	110		8	E	7	1	2	(A) ← (A) + (M) + (Cy2)	0	0	0	0	M	M4	(M)	1	M4
	ACI n	11	001	110		C	E	7	2	2	(A) ← (A) + n + (Cy2)	0	0	0	0			<B2>	1	M4
	DAD B	00	011	001		0	9	10	1	3	(H) (L) ← (H) (L) + (B) (C)	X	X	X	X					
	DAD D	00	011	001		1	9	10	1	3	(H) (L) ← (H) (L) + (D) (E)	X	X	X	X					
	DAD H	00	101	001		2	9	10	1	3	(H) (L) ← (H) (L) + (H) (L)	X	X	X	X					
	DAD SP	00	111	001		3	9	10	1	3	(H) (L) ← (H) (L) + (SP)	X	X	X	X					
	SUB r	10	010	SSS		4	1	1	1	(A) ← (A) - (r)	0	0	0	0						
	SUB M	10	010	110		9	6	7	1	2	(A) ← (A) - (M)	0	0	0	0	M	M4	(M)	1	M4
	SUI n	11	010	110		D	6	7	2	2	(A) ← (A) - n	0	0	0	0			<B2>	1	M4
	SBB r	10	011	SSS		4	1	1	1	(A) ← (A) - (r) - (Cy2)	0	0	0	0						
	SBB M	10	011	110		9	E	7	1	2	(A) ← (A) - (M) - (Cy2)	0	0	0	0	M	M4	(M)	1	M4
SBI n	11	011	110		D	E	7	2	2	(A) ← (A) - n - (Cy2)	0	0	0	0			<B2>	1	M4	
ANA r	10	100	SSS		A	6	7	1	2	(A) ← (A) ∧ (r)	0	0	0	1						
ANA M	10	100	110		A	6	7	1	2	(A) ← (A) ∧ (M)	0	0	0	1	M	M4	(M)	1	M4	
ANI n	11	100	110		F	6	7	2	2	(A) ← (A) ∧ n	0	0	0	1			<B2>	1	M4	
XRA r	10	101	SSS		A	E	4	1	1	(A) ← (A) ∨ (r)	0	0	0	0						
XRA M	10	101	110		A	E	7	1	2	(A) ← (A) ∨ (M)	0	0	0	0	M	M4	(M)	1	M4	
XRI n	11	101	110		E	E	7	2	2	(A) ← (A) ∨ n	0	0	0	0			<B2>	1	M4	
ORA r	10	110	SSS		4	1	1	1	(A) ← (A) ∨ (r)	0	0	0	0							
ORA M	10	110	110		B	6	7	1	2	(A) ← (A) ∨ (M)	0	0	0	0	M	M4	(M)	1	M4	
ORI n	11	110	110		F	6	7	2	2	(A) ← (A) ∨ n	0	0	0	0			<B2>	1	M4	
CMP r	10	111	SSS		4	1	1	1	(A) - (r)	0	0	0	0							
CMP M	10	111	110		B	E	7	1	2	(A) - (M)	0	0	0	0	M	M4	(M)	1	M4	
CPI n	11	111	110		F	E	7	2	2	(A) - n	0	0	0	0			<B2>	1	M4	
Register increment/decrement	INR r	00	DDD	100		3	4	1	1	(r) ← (r) + 1	0	0	0	X						
	INR M	00	110	100		3	4	1	3	(M) ← (M) + 1	0	0	0	X	M	M4	(M)	1	M4	
	DCR r	00	DDD	101		4	1	1	1	(r) ← (r) - 1	0	0	0	X						
	DCR M	00	110	101		3	5	10	1	3	(M) ← (M) - 1	0	0	0	X	M	M4	(M)	1	M4
	INX B	00	000	011		0	3	6	1	1	(B) (C) ← (B) (C) + 1	X	X	X	X					
	INX D	00	010	011		1	3	6	1	1	(D) (E) ← (D) (E) + 1	X	X	X	X					
	INX H	00	100	011		2	3	6	1	1	(H) (L) ← (H) (L) + 1	X	X	X	X					
	INX SP	00	110	011		3	3	6	1	1	(SP) ← (SP) + 1	X	X	X	X					
	DCX B	00	000	011		0	B	6	1	1	(B) (C) ← (B) (C) - 1	X	X	X	X					
	DCX D	00	011	011		1	B	6	1	1	(D) (E) ← (D) (E) - 1	X	X	X	X					
DCX H	00	101	011		2	B	6	1	1	(H) (L) ← (H) (L) - 1	X	X	X	X						
DCX SP	00	111	011		3	B	6	1	1	(SP) ← (SP) - 1	X	X	X	X						
Rotate & shift accumulator	RLC	00	000	111		0	7	4	1	1	Left shift Cy2 → [A7 A6 ..... A1 A0] ←	X	X	X	X					
	RRC	00	001	111		0	F	4	1	1	Right shift [A7 A6 ..... A1 A0] ← Cy2	X	X	X	X					
	RAL	00	010	111		1	7	4	1	1	Left shift Cy2 → [A7 A6 ..... A1 A0] ←	X	X	X	X					
	RAR	00	011	111		1	F	4	1	1	Right shift [A7 A6 ..... A1 A0] ← Cy2	X	X	X	X					
Accumu compen	CMA	00	101	111		2	F	4	1	1	(A) ← (A)	X	X	X	X					
	DAA	00	100	111		2	7	4	1	1	Results of binary addition are adjusted to BCD	0	0	0	0					
	STC	00	110	111		3	7	4	1	1	(CY2) ← 1	X	X	X	X					
Carry set	CMC	00	111	111		3	F	4	1	1	(CY2) ← (CY2)	X	X	X	X					

\*: State is T1    \*\*: State is T2

8-BIT PARALLEL MICROPROCESSOR

Item Instr. class	Mnemonic	Instruction code				16mal notatin	No. of states	No. of bytes	No. of cycles	Functions	Flags			Address bus		Data bus	
		D7D6	D5D4D3	D2D1D0							S	Z	P	CY2CY1	Contents	Mach. cycle*	Contents
Jump	JMP m	1 1	0 0 0	0 1 1	C 3	10	3	3	(PC)+m	X	X	X	X			<B2> <B3>	I M2 M3
	PCHL	1 1	1 0 1	0 0 1	E 9	6	1	1	(PC)+ (H) (L)	X	X	X	X				
	JC m	1 1	0 1 1	0 1 0	D A	10/7	3	3/2	(CY2) = 1	X	X	X	X				
	JNC m	1 1	0 1 0	0 1 0	D 2	10/7	3	3/2	(CY2) = 0 If condition is true. (PC)--m	X	X	X	X				If condition is true.
	JZ m	1 1	0 0 1	0 1 0	C A	10/7	3	3/2	(Z) = 1	X	X	X	X			<B2> <B3>	I M2 M3
	JNZ m	1 1	0 0 0	0 1 0	C 2	10/7	3	3/2	(Z) = 0	X	X	X	X				
	JP m	1 1	1 1 0	0 1 0	F 2	10/7	3	3/2	(S) = 0 If condition is false. (PC)+ (PC) + 3	X	X	X	X				
	JM m	1 1	1 1 1	0 1 0	F A	10/7	3	3/2	(S) = 1	X	X	X	X				
	JPE m	1 1	1 0 1	0 1 0	E A	10/7	3	3/2	(P) = 1	X	X	X	X				
JPO m	1 1	1 0 0	0 1 0	E 2	10/7	3	3/2	(P) = 0	X	X	X	X					
Subroutine call	CALL m	1 1	0 0 1	1 0 1	C D	18	3	5	((SP) - 1)((SP) - 2) + (PC) + 3, (PC) + m (SP) + (SP) - 2	X	X	X	X			<B2> <B3>	I M2 M3
	RST n	1 1	A A A	1 1 1		12	1	3	((SP) - 1)((SP) - 2) + (PC) + 1, (PC) + n × 8, (SP) + (SP) - 2 Where 0 ≤ n ≤ 7	X	X	X	X	(SP) - 1 (SP) - 2 (SP) - 1 (SP) - 2	M4 M5 M4 M5	(PC) + 3 (PC) + 3 (PC) + 1 (PC) + 1	O M4 O M5
	CC m	1 1	0 1 1	1 0 0	D C	18/9	3	5/2	(CY2) = 1	X	X	X	X				
	CNC m	1 1	0 1 0	1 0 0	D 4	18/9	3	5/2	(CY2) = 0	X	X	X	X				
	CZ m	1 1	0 0 1	1 0 0	C C	18/9	3	5/2	(Z) = 1 If condition is true.	X	X	X	X				If condition is true
	CNZ m	1 1	0 0 0	1 0 0	C 4	18/9	3	5/2	(Z) = 0 ((SP) - 1)((SP) - 2) + (PC) + 3 (PC) + m	X	X	X	X			<B2> <B3>	I M2 M3
	CP m	1 1	1 1 0	1 0 0	F 4	18/9	3	5/2	(S) = 0 (SP) + (SP) - 2	X	X	X	X	(SP) - 1 (SP) - 2	M4 M5	(PC) + 3 (PC) + 3	O M5
	CM m	1 1	1 1 1	1 0 0	F C	18/9	3	5/2	(S) = 1 If condition is false	X	X	X	X				
	CPE m	1 1	1 0 1	1 0 0	E C	18/9	3	5/2	(P) = 1 (PC) + (PC) + 3	X	X	X	X				
CPO m	1 1	1 0 0	1 0 0	E 4	18/9	3	5/2	(P) = 0	X	X	X	X					
Return	RET	1 1	0 0 1	0 0 1	C 9	10	1	3	(PC) + ((SP) + 1)((SP), (SP) - (SP) + 2	X	X	X	X	(SP) (SP) + 1	M4 M5	((SP)) ((SP) + 1)	I M4 M5
	RC	1 1	0 1 1	0 0 0	D 8	12/6	1	3/1	(CY2) = 1	X	X	X	X				
	RNC	1 1	0 1 0	0 0 0	D 0	12/6	1	3/1	(CY2) = 0	X	X	X	X				
	RZ	1 1	0 0 1	0 0 0	C 8	12/6	1	3/1	(Z) = 1 If condition is true.	X	X	X	X				If condition is true
	RNZ	1 1	0 0 0	0 0 0	C 0	12/6	1	3/1	(Z) = 0 (PC) + ((SP) + 1)((SP)) (SP) - (SP) + 2	X	X	X	X	(SP) (SP) + 1	M4 M5	((SP)) ((SP) + 1)	I M4 M5
	RP	1 1	1 1 0	0 0 0	F 0	12/6	1	3/1	(S) = 0	X	X	X	X				
	RM	1 1	1 1 1	0 0 0	F 8	12/6	1	3/1	(S) = 1 If condition is false.	X	X	X	X				
RPE	1 1	1 0 1	0 0 0	E 8	12/6	1	3/1	(P) = 1 (PC) + (PC) + 1	X	X	X	X					
RPO	1 1	1 0 0	0 0 0	E 0	12/6	1	3/1	(P) = 0	X	X	X	X					
Input/output control	IN n	1 1	0 1 1	0 1 1	D B	10	2	3	(A) -- (Input buffer) -- (Input device of number n) (Input data)	X	X	X	X			<B2> <B3>	O M4 M5
	OUT n	1 1	0 1 0	0 1 1	D 3	10	2	3	(Output device of number n) -- (A)	X	X	X	X			<B2> <B3>	O M4 M5
Interrupt control	E I	1 1	1 1 1	0 1 1	F B	4	1	1	(INTE) = 1	X	X	X	X			<B2> <B3>	O M5
	D I	1 1	1 1 0	0 1 1	F 3	4	1	1	(INTE) = 0	X	X	X	X				
	PUSH PSW	1 1	1 1 0	1 0 1	F 5	12	1	3	((SP) - 1) - (A), ((SP) - 2) - (F) (SP) + (SP) - 2	X	X	X	X	(SP) - 1 (SP) - 2	M4 M5	(A) (F)	O M4 O M5
	PUSH B	1 1	0 0 0	1 0 1	C 5	12	1	3	((SP) - 1) + (B), ((SP) - 2) + (C) (SP) - (SP) - 2	X	X	X	X	(SP) - 1 (SP) - 2	M4 M5	(B) (C)	O M4 O M5
	PUSH D	1 1	0 1 0	1 0 1	D 5	12	1	3	((SP) - 1) - (D), ((SP) - 2) - (E) (SP) - (SP) - 2	X	X	X	X	(SP) - 1 (SP) - 2	M4 M5	(D) (E)	O M4 O M5
	PUSH H	1 1	1 0 0	1 0 1	E 5	12	1	3	((SP) - 1) + (H), ((SP) - 2) + (L) (SP) - (SP) - 2	X	X	X	X	(SP) - 1 (SP) - 2	M4 M5	(H) (L)	O M4 O M5
	POP PSW	1 1	1 1 0	0 0 1	F 1	10	1	3	((SP), (A) + ((SP) + 1) (SP) + (SP) + 2	O	O	O	O	(SP) (SP) + 1	M4 M5	((SP) + 1) ((SP) + 1)	I M4 M5
	POP B	1 1	0 0 0	0 0 1	C 1	10	1	3	((SP), (B) + ((SP) + 1) (SP) + (SP) + 2	X	X	X	X	(SP) (SP) + 1	M4 M5	((SP) + 1) ((SP) + 1)	I M4 M5
	POP D	1 1	0 1 0	0 0 1	D 1	10	1	3	((SP), (D) + ((SP) + 1) (SP) + (SP) + 2	X	X	X	X	(SP) (SP) + 1	M4 M5	((SP) + 1) ((SP) + 1)	I M4 M5
POP H	1 1	1 0 0	0 0 1	E 1	10	1	3	((SP), (H) + ((SP) + 1) (SP) + (SP) + 2	X	X	X	X	(SP) (SP) + 1	M4 M5	((SP) + 1) ((SP) + 1)	I M4 M5	
Others	HLT	0 1	1 1 0	1 1 0	7 6	5	1	1	(PC) + (PC) + 1	X	X	X	X				
	NOP	0 0	0 0 0	0 0 0	0 0	4	1	1	(PC) + (PC) + 1	X	X	X	X				
Mask set instructions	RIM	0 0	1 0 0	0 0 0	2 0	4	1	1	All RST interrupt masks, any pending RST interrupt requests, and the serial input data from the SID pin are read into the accumulator.	X	X	X	X				
	SIM	0 0	1 1 0	0 0 0	3	4	1	1	Mask is enabled (or disabled) to the RST interrupt corresponding to the contents (bit pattern) of the accumulator. The serial output is enabled and the serial output bit is loaded into the SOD latch.	X	X	X	X				

\*: State is T1. \*\*: State is T2.

Symbol	Meaning	Symbol	Meaning	Symbol	Meaning
r	Register	S S S or D D D	Bit pattern designating register or memory.  Where M = (H) (L)	←	Data is transferred in direction shown
m	Two-byte data			( )	Contents of register or memory location
n	One-byte data			v	Inclusive OR
<B2>	Second byte of instruction			∨	Exclusive OR
<B3>	Third byte of instruction			∧	Logical AND
AAA	Binary representation for RST instruction n			—	1's complement
F	8-bit data from the most to the least significant bit S, Z, X, CY1, 0, P, X, CY2 (X is indefinite.)			X	Content of flag is not changed after execution
PC	Program counter			O	Content of flag is set or reset after execution
SP	Stack pointer			I	Input mode
				O	Output mode

8-BIT PARALLEL MICROPROCESSOR

INSTRUCTION CODE LIST

D <sub>7</sub> ~D <sub>4</sub> D <sub>3</sub> ~D <sub>0</sub>	Hex- adecimal notation	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
		0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0000	0	NOP	(-)	RIM	SIM	MOV B, B	MOV D, B	MOV H, B	MOV M, B	ADD B	SUB B	ANA B	ORA B	RNZ	RNC	RPO	RP
0001	1	LXI B	LXI D	LXI H	LXI SP	MOV B, C	MOV D, C	MOV H, C	MOV M, C	ADD C	SUB C	ANA C	ORA C	POP B	POP D	POP H	POP PSW
0010	2	STAX B	STAX D	SHLD	STA	MOV B, D	MOV D, D	MOV H, D	MOV M, D	ADD D	SUB D	ANA D	ORA D	JNZ	JNC	JPO	JP
0011	3	INX B	INX D	INX H	INX SP	MOV B, E	MOV D, E	MOV H, E	MOV M, E	ADD E	SUB E	ANA E	ORA E	JMP	OUT	XTHL	DI
0100	4	INR B	INR D	INR H	INR M	MOV B, H	MOV D, H	MOV H, H	MOV M, H	ADD H	SUB H	ANA H	ORA H	CNZ	CNC	CPO	CP
0101	5	DCR B	DCR D	DCR H	DCR M	MOV B, L	MOV D, L	MOV H, L	MOV M, L	ADD L	SUB L	ANA L	ORA L	PUSH B	PUSH D	PUSH H	PUSH PSW
0110	6	MVI B	MVI D	MVI H	MVI M	MOV B, M	MOV D, M	MOV H, M	HLT	ADD M	SUB M	ANA M	ORA M	ADI	SUI	ANI	ORI
0111	7	RLC	RAL	DAA	STC	MOV B, A	MOV D, A	MOV H, A	MOV M, A	ADD A	SUB A	ANA A	ORA A	RST 0	RST 2	RST 4	RST 6
1000	8	(-)	(-)	(-)	(-)	MOV C, B	MOV E, B	MOV L, B	MOV A, B	ADC B	SBB B	XRA B	CMP B	RZ	RC	RPE	RM
1001	9	DAD B	DAD D	DAD H	DAD SP	MOV C, C	MOV E, C	MOV L, C	MOV A, C	ADC C	SBB C	XRA C	CMP C	RET	(-)	PCHL	SPHL
1010	A	LDAX B	LDAX D	LHLD	LDA	MOV C, D	MOV E, D	MOV L, D	MOV A, D	ADC D	SBB D	XRA D	CMP D	JZ	JC	JPE	JM
1011	B	DCX B	DCX D	DCX H	DCX SP	MOV C, E	MOV E, E	MOV L, E	MOV A, E	ADC E	SBB E	XRA E	CMP E	(-)	IN	XCHG	EI
1100	C	INR C	INR E	INR L	INR A	MOV C, H	MOV E, H	MOV L, H	MOV A, H	ADC H	SBB H	XRA H	CMP H	CZ	CC	CPE	CM
1101	D	DCR C	DCR E	DCR L	DCR A	MOV C, L	MOV E, L	MOV L, L	MOV A, L	ADC L	SBB L	XRA L	CMP L	CALL	(-)	(-)	(-)
1110	E	MVI C	MVI E	MVI L	MVI A	MOV C, M	MOV E, M	MOV L, M	MOV A, M	ADC M	SBB M	XRA M	CMP M	ACI	SBI	XRI	CPI
1111	F	RRC	RAR	CMA	CMC	MOV C, A	MOV E, A	MOV L, A	MOV A, A	ADC A	SBB A	XRA A	CMP A	RST 1	RST 3	RST 5	RST 7

This list shows the machine codes and corresponding machine instruction. D<sub>3</sub>~D<sub>0</sub> indicate the low-order 4 bits of the machine code and D<sub>7</sub>~D<sub>4</sub> indicate the high-order 4 bits. Hexadecimal numbers are also used to indicate this code.

The instruction may consists of one, two, or three bytes, but only the first byte is listed.

- indicates a three-byte instruction.
- indicates a two-byte instruction.

## 8-BIT PARALLEL MICROPROCESSOR

## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage	With respect to $V_{SS}$	-0.5~7	V
$V_I$	Input voltage		-0.5~7	V
$P_d$	Power dissipation	$T_a=25^\circ\text{C}$	1.5	W
$T_{opr}$	Operating free-air temperature range		-20~75	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		-65~150	$^\circ\text{C}$

RECOMMENDED OPERATING CONDITIONS ( $T_a=-20\sim75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.75	5	5.25	V
$V_{IH}$	High-level input voltage (Except for $X_1, X_2$ )	2.2		$V_{CC}+0.5$	V
$V_{IL}$	Low-level input voltage	-0.5		0.8	V
$V_{IH}(\text{RESIN})$	High-level reset input voltage	2.4		$V_{CC}+0.5$	V
$V_{IL}(\text{RESIN})$	Low-level reset input voltage	-0.5		0.8	V
$V_{IHx}$	$X_1, X_2$ High-level voltage	4.0		$V_{CC}+0.5$	V

ELECTRICAL CHARACTERISTICS ( $T_a=-20\sim75^\circ\text{C}$ ,  $V_{CC}=5V\pm5\%$ ,  $V_{SS}=0V$ , unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{OL}$	Low-level output voltage	$I_{OL}=2\text{mA}$			0.45	V
$V_{OH}$	High-level output voltage	$I_{OH}=-400\mu\text{A}$	2.4			V
$I_{CC}$	Supply current from $V_{CC}$				200	mA
$I_I$	Input leak current, except RESET IN (Note 1)	$V_I=V_{CC}$	-10		10	$\mu\text{A}$
$I_{OZL}$	Output floating leak current	$0.45V\leq V_O\leq V_{CC}$	-10		10	$\mu\text{A}$
$V_{IH}-V_{IL}$	Hysteresis RESET IN input		0.25			V

Note 1 : The input RESET IN is pulled up to  $V_{CC}$  with the resistor  $3k\Omega$  (typ) when  $V_I\geq V_{IH}(\text{RESIN})$

TIMING REQUIREMENTS ( $T_a=-20\sim75^\circ\text{C}$ ,  $V_{CC}=5V\pm5\%$ ,  $V_{SS}=0V$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Limits			Unit
			Min	Typ	Max	
$T_{C(\text{CLK})}$	Clock cycle time	$T_{CYC}$	320		2000	ns
$t_{SU(DA-AD)}$	DA input setup time	$-t_{AD}$	-575			ns
$t_{SU(DA-RD)}$	DA input setup time	$-t_{RD}$	-300			ns
$t_{H(DA-RD)}$	DA input hold time	$t_{RDH}$	0			ns
$t_{SU(RDY-AD)}$	READY input setup time	$-t_{ARY}$	-220			ns
$t_{SU(RDY-CLK)}$	READY input setup time	$-t_{RYS}$			-110	ns
$t_{H(RDY-CLK)}$	READY input hold time	$T_{RYH}$	0			ns
$t_{SU(DA-ALE)}$	DA input setup time	$-t_{LDR}$	-460			ns
$t_{SU(HLD-CLK)}$	HOLD input setup time	$t_{HDS}$	170			ns
$t_{H(HLD-CLK)}$	HLD input hold time	$t_{HDH}$	0			ns
$t_{SU(INT-CLK)}$	Interrupt setup time	$t_{INS}$	160			ns
$t_{H(INT-CLK)}$	Interrupt hold time	$t_{INH}$	0			ns
$t_{SU(RDY-ALE)}$	READY input setup time	$-t_{LRY}$	-110			ns

Note 2 : The input voltage level is  $V_{IL}=0.45V$  and  $V_{IH}=2.4V$

8-BIT PARALLEL MICROPROCESSOR

SWITCHING CHARACTERISTICS ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 5\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Limits			Unit
			Min	Typ	Max	
$t_{W(\overline{\text{CLK}})}$	CLK output low-level pulse width	$t_1$	80			ns
$t_{W(\text{CLK})}$	CLK output high-level pulse width	$t_2$	120			ns
$t_r(\text{CLK})$	CLK output rise time	$t_r$			30	ns
$t_f(\text{CLK})$	CLK output fall time	$t_f$			30	ns
$t_d(X_1 - \text{CLK})$	Delay time, $X_1$ to CLK	$t_{XKR}$	30		120	ns
$t_d(X_1 - \overline{\text{CLK}})$	Delay time, $X_1$ to $\overline{\text{CLK}}$	$t_{XKF}$	30		150	ns
$t_d(\text{AD} - \text{ALE})$	Delay time, address output to ALE signal	$AD_0 \sim AD_7$	90			ns
		$A_8 \sim A_{15}$	115			
$t_d(\text{ALE} - \text{AD})$	Delay time, ALE signal to address output	$t_{LA}$	100			ns
$t_W(\text{ALE})$	ALE pulse width	$t_{LL}$	140			ns
$t_d(\text{ALE} - \text{CLK})$	Delay time, ALE to CLK	$t_{LCK}$	100			ns
$t_d(\text{ALE} - \text{CONT})$	Delay time, ALE to control signal	$t_{LC}$	130			ns
$t_{DXZ}(\overline{\text{RD}} - \text{AD})$	Address disable time from read	$t_{AFR}$			0	ns
$t_{DZX}(\overline{\text{RD}} - \text{AD})$	Address enable time from read	$t_{RAE}$	150			ns
$t_d(\overline{\text{CONT}} - \text{AD})$	Address valid time after control signal	$t_{CA}$	120			ns
$t_d(\text{DA} - \overline{\text{WR}})$	Delay time, data output to $\overline{\text{WR}}$ signal	$t_{DW}$	420			ns
$t_d(\overline{\text{WR}} - \text{DA})$	Delay time, $\overline{\text{WR}}$ signal to data output	$t_{WD}$	100			ns
$t_W(\overline{\text{CONT}})$	Control signal pulse width	$t_{CC}$	400			ns
$t_d(\text{CONT} - \text{ALE})$	Delay time, CLK to ALE signal	$t_{CL}$	50			ns
$t_d(\text{CLK} - \text{HLDA})$	Delay time, CLK to HLDA signal	$t_{HACK}$	110			ns
$t_{DXZ}(\text{HLDA} - \text{BUS})$	Bus disable time from HLDA	$t_{HABF}$			210	ns
$t_{DZX}(\text{HLDA} - \text{BUS})$	Control signal disable time	$t_{HABE}$			210	ns
$t_d(\overline{\text{CONT}} - \overline{\text{CONT}})$	Control signal disable time	$t_{RV}$	400			ns
$t_d(\text{AD} - \overline{\text{CONT}})$	Delay time, address output to control signal	$AD_0 \sim AD_7$	240			ns
		$A_8 \sim A_{15}$	270			
$t_d(\text{ALE} - \text{DA})$	Delay time, ALE to data output	$t_{LDW}$			200	ns
$t_d(\overline{\text{WRHL}} - \text{DA})$	Delay time, $\overline{\text{WR}}$ signal to data output	$t_{WDL}$			40	ns

- Note 3 : at  $A_8 \sim A_{15}$ , and IO/M  $t_d(\text{AD} - \overline{\text{CONT}})$  after the release of the high-impedance state is 200ns  
 4 : Conditions of measurement M5L8085AP  $t_{C(\text{CLK})} \geq 320\text{ns}$ ,  $C_L = 150\text{pF}$   
 5 : Reference level for the input/output voltage is  $V_{OL} = 0.8V$ ,  $V_{OH} = 2V$   
 6 :  $t_{W(\overline{\text{CLK}})}$ ,  $t_{W(\text{CLK})}$  are 100ns(Min), 150ns(Min) respectively when 50pF+1TTL loaded

Parameters described in the timing requirements and with the relational expression shown in Table 1 when the frequency is varied.

Table 1 Relational expression with the frequency T ( $t_{C(\text{CLK})}$ ) in the M5L8085AP

TIMING REQUIREMENTS ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 5\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Test conditions	Relational expression (Note 6)	Limit
$t_{SU}(\text{DA} - \text{AD})$	DA input setup time	$-t_{AD}$		$225 - (5/2 + N)T$	Min
$t_{SU}(\text{DA} - \overline{\text{RD}})$	DA input setup time	$-t_{RD}$		$180 - (3/2 + N)T$	Min
$t_{SU}(\text{RDY} - \text{AD})$	READY input setup time	$-t_{ARY}$		$260 - (3/2)T$	Min
$t_{SU}(\text{DA} - \text{ALE})$	DA input setup time	$-t_{LDR}$		$180 - 2T$	Min

- Note 7 : N indicates the total number of wait cycles.  
 $T = t_{C(\text{CLK})}$

## 8-BIT PARALLEL MICROPROCESSOR

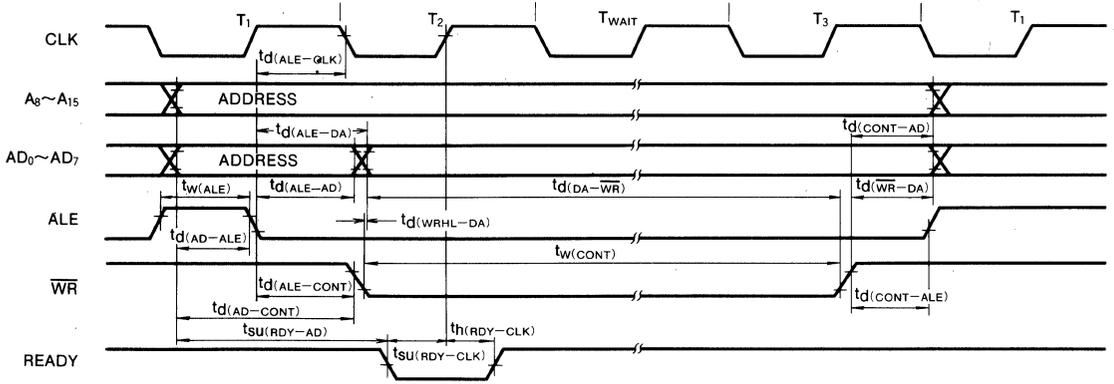
SWITCHING CHARACTERISTICS ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 5\%$ ,  $V_{SS} = 0V$ , unless otherwise notes)

Symbol	Parameter	Alternative symbol	Test conditions	Relational expression (Note 6)	Limit	
$t_{W(\overline{\text{CLK}})}$	CLK output low-level pulse width	$t_1$	$C_L = 150\text{pF}$	$(1/2)T - 80$	Min	
$t_{W(\text{CLK})}$	CLK output high-level pulse width	$t_2$		$(1/2)T - 40$	Min	
$t_{d(\text{AD-ALE})}$	Delay time, address output to ALE signal	$AD_0 \sim AD_7$		$t_{AL}$	$(1/2)T - 70$	Min
		$A_8 \sim A_{15}$			$(1/2)T - 45$	
$t_{d(\text{ALE-AD})}$	Delay time, ALE signal to address output	$t_{LA}$			$(1/2)T - 60$	Min
$t_{W(\text{ALE})}$	ALE pulse width	$t_{LL}$			$(1/2)T - 20$	Min
$t_{d(\text{ALE-CLK})}$	Delay time, ALE to CLK	$t_{LCK}$			$(1/2)T - 60$	Min
$t_{d(\text{ALE-CONT})}$	Delay time, ALE to control signal	$t_{LC}$			$(1/2)T - 30$	Min
$t_{DZX(\overline{\text{RD}}-\text{AD})}$	Address enable time from read	$t_{RAE}$			$(1/2)T - 10$	Min
$t_{d(\overline{\text{CONT}}-\text{AD})}$	Address valid time after control signal	$t_{CA}$			$(1/2)T - 40$	Min
$t_{d(\text{DA-}\overline{\text{WR}})}$	Delay time, data output to WR signal	$t_{DW}$			$(3/2+N)T - 60$	Min
$t_{d(\overline{\text{WR}}-\text{DA})}$	Delay time WR signal to data output	$t_{WD}$			$(1/2)T - 60$	Min
$t_{W(\overline{\text{CONT}})}$	Control signal pulse width	$t_{CC}$			$(3/2+N)T - 80$	Min
$t_{d(\overline{\text{CONT}}-\text{ALE})}$	Delay time, CONT to ALE signal	$t_{CL}$			$(1/2)T - 110$	Min
$t_{d(\text{CLK-HLDA})}$	Delay time, CLK to HLDA signal	$t_{HACK}$			$(1/2)T - 50$	Min
$t_{DXZ(\text{HLDA-BUS})}$	Bus disable time from HLDA	$t_{HABF}$			$(1/2)T + 50$	Max
$t_{DZX(\text{HLDA-BUS})}$	Bus enable time from HLDA	$t_{HABE}$			$(1/2)T + 50$	Max
$t_{d(\overline{\text{CONT}}-\overline{\text{CONT}})}$	Control signal disable time	$t_{RV}$			$(3/2)T - 80$	Min
$t_{d(\text{AD-}\overline{\text{CONT}})}$	Delay time, address output to control signal	$AD_0 \sim AD_7$		$t_{AC}$	$T - 80$	Min
		$A_8 \sim A_{15}$			$T - 50$	

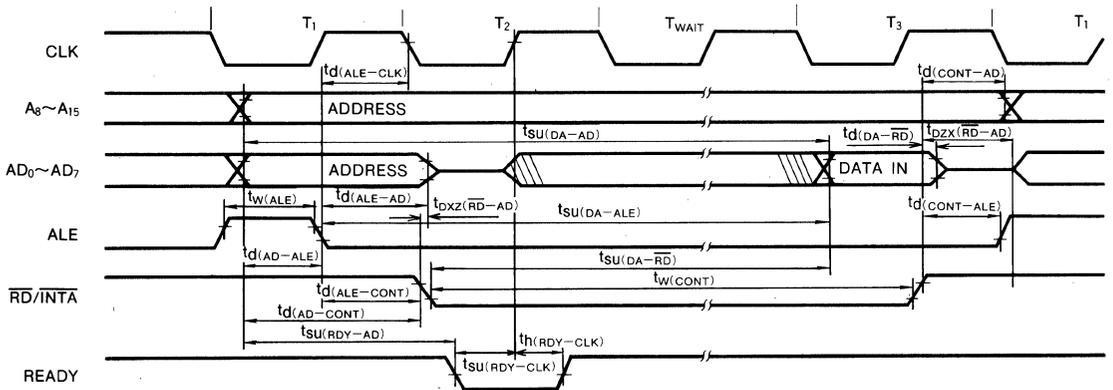
**8-BIT PARALLEL MICROPROCESSOR**

**TIMING DIAGRAM**

**Write Cycle**



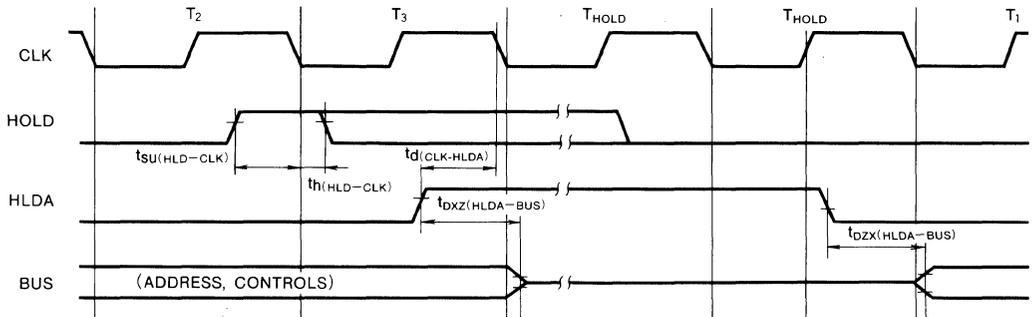
**Read Cycle**



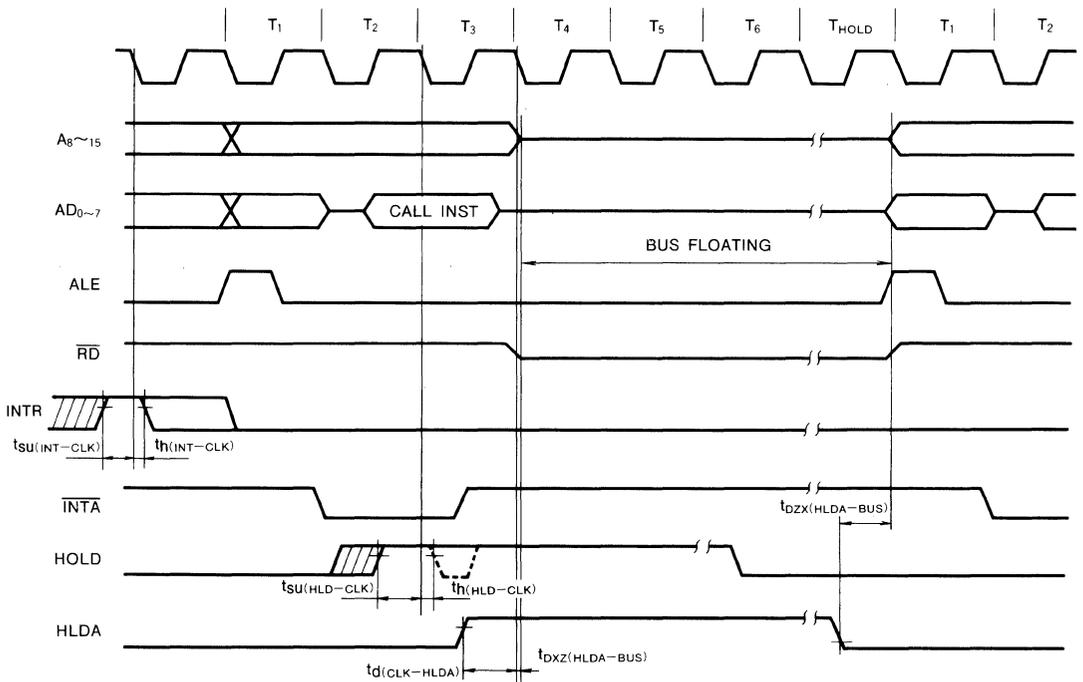
**8-BIT PARALLEL MICROPROCESSOR**

2

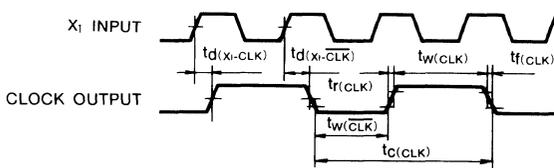
**Hold Cycle**



**Interrupt and Hold Cycle**



**Clock Output Timing Waveform**



**TRAP INTERRUPT AND RIM INSTRUCTIONS**

TRAP generates interrupts regardless of the interrupt enable flip-flop (INTE FF). The current state of the INTE FF is stored in flip flop A (AFF) of the CPU and then the INTE FF is reset. The first RIM instruction after the generation of a TRAP interrupt differs in function from the ordinary RIM instruction. That is, the bit 3 (INTE FF information) in the accumulator ((A)<sub>3</sub>) after the execution of the RIM instruction contains the contents of the A FF, regardless of the state of the INTE FF at the time the RIM instruction is executed. These details are shown in Fig.2, Tables 1 and 2.

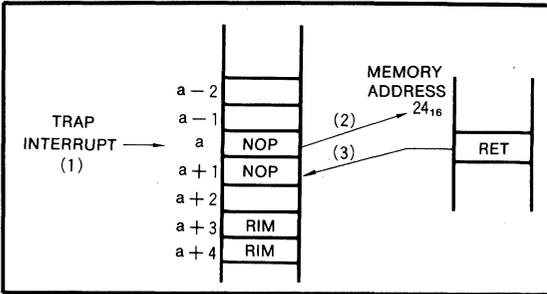


Fig. 2 TRAP interrupt processing

Below are the explanations of Fig. 2.

1. The TRAP interrupt request is issued while the instruction in address a is being executed.
2. The TRAP interrupt causes the same action as an RST instruction and then jumps to address 24<sub>16</sub>.
3. It returns to address a+1 after executing the RET instruction.

Table 1 shows the information in the INTE FF at address a+3 and a+4 when the instructions EI and/or DI are executed at addresses a-1 and a+2.

Fig. 3 is a flow chart of the TRAP interrupt processing routine.

Table 1 TRAP interrupt and RIM instructions

Condition	Number					
instruction in address a-1	EI	EI	EI	DI	DI	DI
instruction in address a+2	EI	NOP	DI	EI	NOP	DI
Contents of (A) <sub>3</sub> after the execution of the RIM instruction in address a+3	1	1	1	0	0	0
State of INTE FF after the execution of the RIM instruction in address a+3	1	0	0	1	0	0
Contents of (A) <sub>3</sub> after the execution of the RIM instruction in address a+4	1	0	0	1	0	0
State of INTE FF after the execution of the RIM instruction in address a+4	1	0	0	1	0	0

Note 3 : The contents of (A)<sub>3</sub> after the execution of the RIM instruction is an information of the INTE FF. The INTE FF assumes state "1" when it is in the EI state, and "0" when it is in the DI state.

Table 2 TRAP interrupt and INTE FF processing

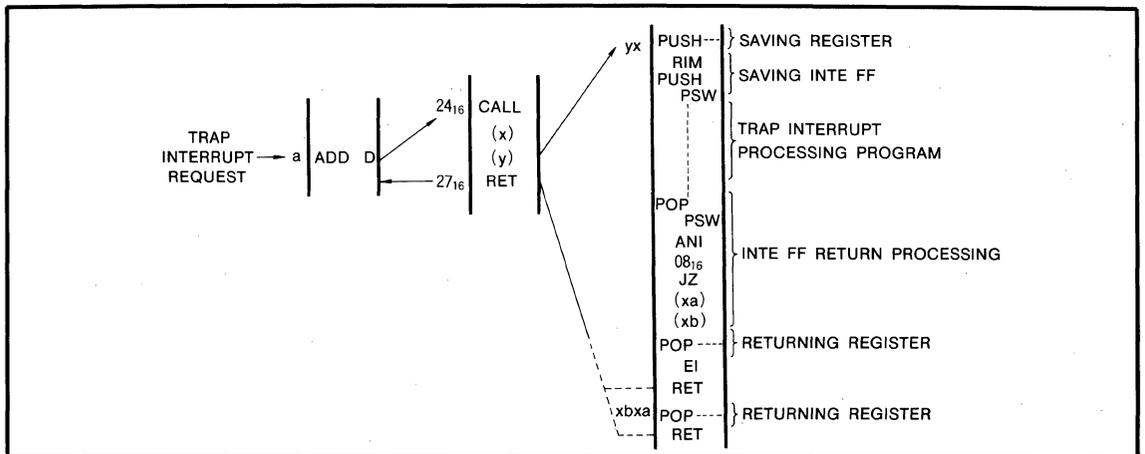
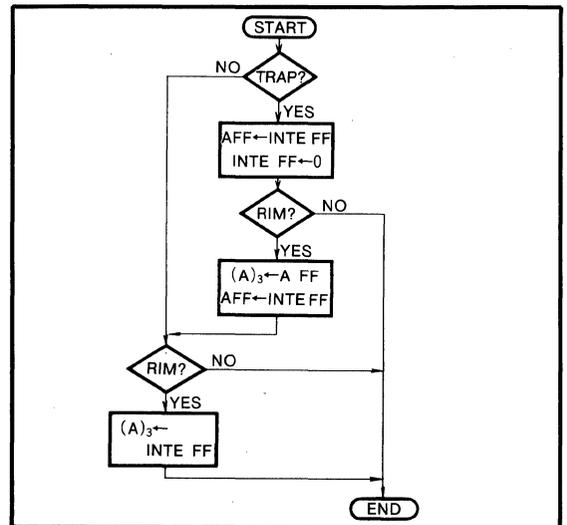


Fig. 3 TRAP interrupt processing routine

**PULL-UP OF THE RESET IN INPUT**

In order to increase the noise margin, the RESET IN input terminal is pulled up by about 3kΩ (typ) when the condition  $V_I \geq V_{IH(RESIN)}$  is satisfied. Fig. 4 is a connection diagram of the RESET IN input, and Fig. 5 shows the relation between input voltage and input current.

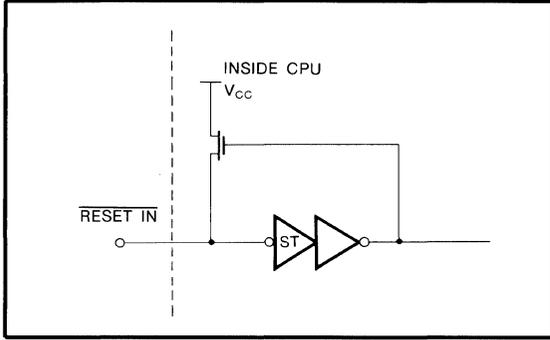


Fig. 4 Connections of RESET IN input

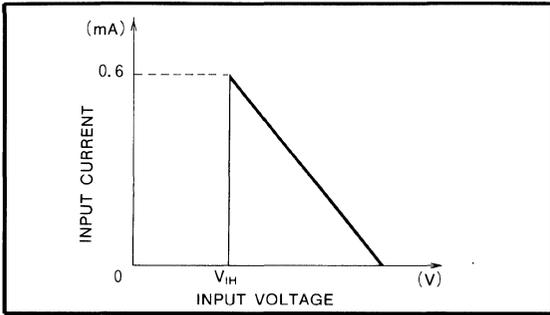


Fig. 5 RESET IN input current vs input voltage

**DRIVING CIRCUIT OF X<sub>1</sub> AND X<sub>2</sub> INPUTS**

Input terminals, X<sub>1</sub> and X<sub>2</sub> of the M5L8085AP can be driven by either a crystal, RC network, or external clock. Since the driver clock frequency is divided to 1/2 internally, the input frequency required is twice the actual execution frequency (6MHz for the M5L8085AP which is operated at 3MHz). Figs.

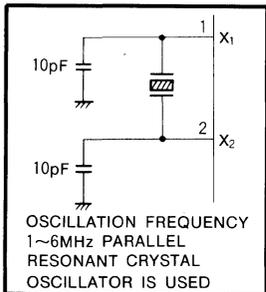


Fig. 6 Connections when crystal is used for X<sub>1</sub> and X<sub>2</sub> inputs

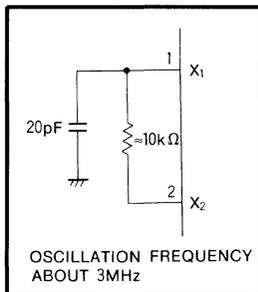


Fig. 7 Connections when RC network is used for X<sub>1</sub> and X<sub>2</sub> inputs

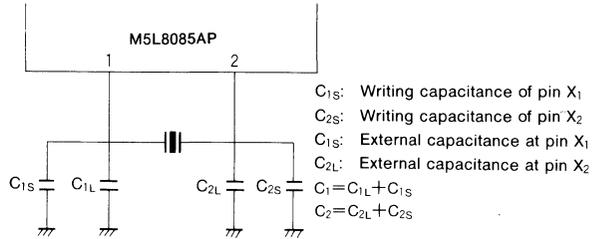
Figs. 6 and 7 are typical connection diagrams for a crystal and CR circuit respectively.

**Conditions for Using a Quartz Crystal Element**

1. Quartz Crystal Specifications

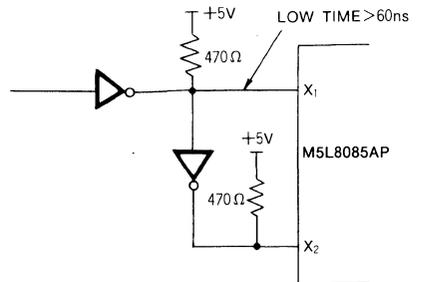
- Parallel resonance
- The frequency is 2 times the operation frequency (2 ~ 6.25MHz)
- Internal load capacitance: Approx. 16pF
- Parallel capacitance: Below 7pF
- Equivalent resistance: Below 75Ω (for operation above 4MHz)
- For operation in the range 2 ~ 4MHz, the resistance should be made as small as possible.
- Drive capability: Above 5mW (the power at which the crystal will be destroyed)

2. External Circuitry



- For operation above 4MHz:  
 C<sub>1</sub> = C<sub>2</sub> = 10pF
- For operation below 4MHz:  
 C<sub>1</sub> = C<sub>2</sub> = 15pF

**External Clock Driver Circuit**



Pullup resistors are required to assure that the high level voltage of the input is at least 4V.

**8-BIT PARALLEL MICROPROCESSOR**

**WAIT STATE GENERATOR**

Fig. 8 shows a typical 1-wait state generator for low speed RAM and ROM applications.

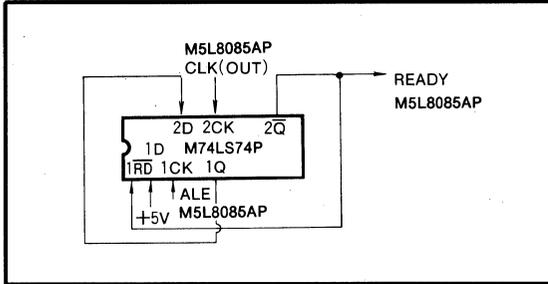
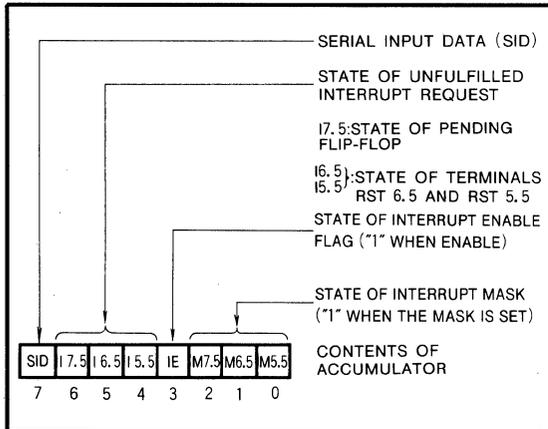


Fig. 8 1-wait state generator

**RELATION OF RIM AND SIM INSTRUCTIONS WITH THE ACCUMULATOR (SUPPLEMENTARY DESCRIPTION).**

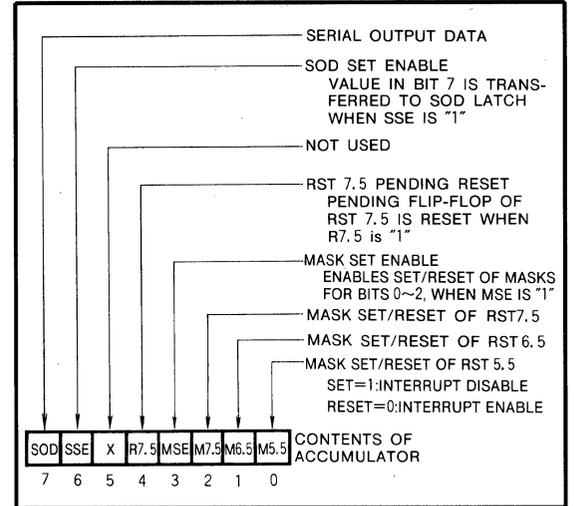
The contents of the accumulator after the execution of a RIM instruction is shown in Table 3.

Table 3 Relation of the instruction RIM with the accumulator



The contents of the accumulator after the execution of a SIM instruction is shown in Table 4.

Table 4 Relation of the SIM instruction with the accumulator



**8-BIT INPUT/OUTPUT PORT WITH 3-STATE OUTPUT**

**DESCRIPTION**

The M5L8212P is an input/output port consisting of an 8-bit latch with 3-state output buffers along with control and device selection logic. Also a service request flip-flop for the generation and control of interrupts to a microprocessor is included.

**FEATURES**

- Parallel 8-bit data register and buffer
- Service request flip-flop for interrupt generation
- Three-state outputs
- Low input load current:  $I_{IL} = \text{absolute} = 250\mu\text{A}(\text{max.})$
- High output sink current:  $I_{OL} = 16\text{mA}(\text{max.})$
- High-level output voltage for direct interface to a M5L8080AP, S CPU:  $V_{OH} = 3.65\text{V}(\text{min.})$

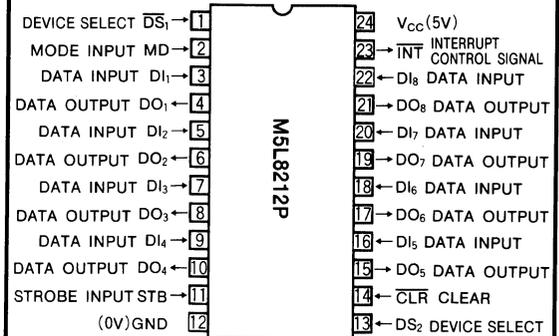
**APPLICATIONS**

- Input/output port for a M5L8080AP, S
- Latches, gate buffers or multiplexers
- Peripheral and input/output functions for microcomputer systems

**FUNCTION**

Device select 1 ( $\overline{DS}_1$ ) and device select 2 ( $DS_2$ ) are used for chip selection when the mode input MD is low. When  $\overline{DS}_1$  is low and  $DS_2$  is high, the data in the latches is transferred to the data outputs  $DO_1 \sim DO_8$ , and the service request flip-flop SR is set. Also, the strobed input STB is active, the data inputs  $DI_1 \sim DI_8$  are latched in the data latches, and the service request flip-flop SR is reset.

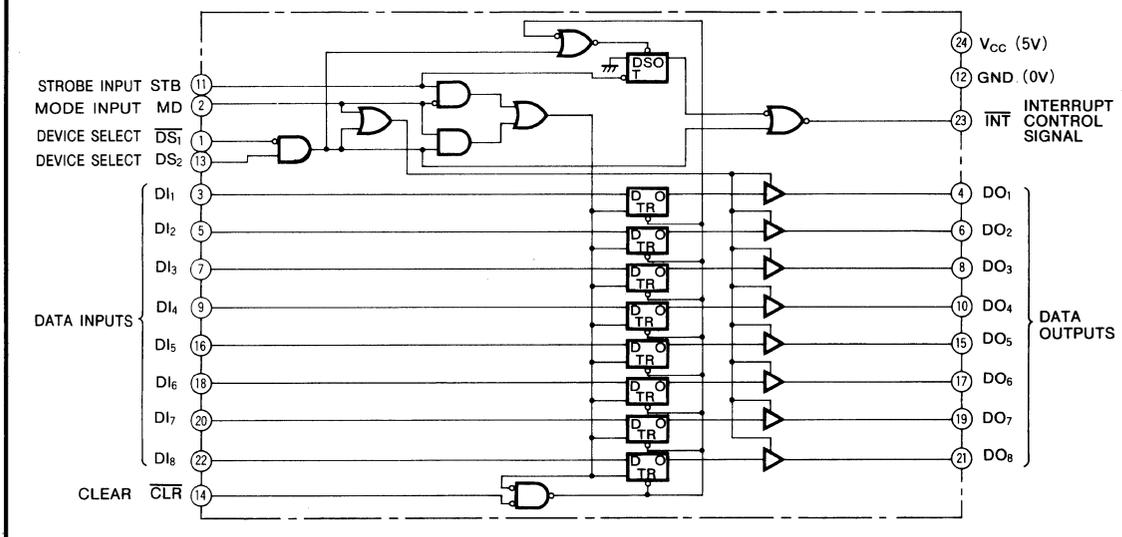
**PIN CONFIGURATION (TOP VIEW)**



Outline 24P4

When MD is high, the data in the data latches is transferred to the data outputs. When  $\overline{DS}_1$  is low and  $DS_2$  is high, the data inputs are latched in the data latches. The low-level clear input  $\overline{CLR}$  resets the data latches and sets the service request flip-flop SR, but the state of the output buffers is not changed.

**BLOCK DIAGRAM**



## 8-BIT INPUT/OUTPUT PORT WITH 3-STATE OUTPUT

ABSOLUTE MAXIMUM RATINGS ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage		7.0	V
$V_I$	Input voltage $\overline{DS1}$ , MD inputs		$V_{CC}$	V
$V_I$	Input voltage all other inputs except $\overline{DS1}$ , MD		5.5	V
$V_O$	Output voltage		$V_{CC}$	V
$P_d$	Power dissipation		800	mW
$T_{opr}$	Operating free-air temperature range		0~75	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		-55~125	$^\circ\text{C}$

RECOMMENDED OPERATING CONDITIONS ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.75	5.0	5.25	V
$I_{OH}$	High-level output current			-1	mA
$I_{OL}$	Low-level output current			16	mA

ELECTRICAL CHARACTERISTICS ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{IH}$	High-level input voltage		2			V
$V_{IL}$	Low-level input voltage				0.85	V
$V_{IC}$	Input clamp voltage	$V_{CC}=4.75\text{V}$ , $I_C=-5\text{mA}$			-1	V
$V_{OH}$	High-level output voltage	$V_{CC}=4.75\text{V}$ , $V_{IH}=2\text{V}$ $V_{IL}=0.85\text{V}$ , $I_{OH}=-1\text{mA}$	3.65			V
$V_{OL}$	Low-level output voltage	$V_{CC}=4.75\text{V}$ , $V_{IH}=2\text{V}$ , $V_{IL}=0.85\text{V}$ , $I_{OL}=15\text{mA}$			0.45	V
$I_{OZ}$	Three-state output current	$V_{CC}=5.25\text{V}$ , $V_{IH}=2\text{V}$ , $V_{IL}=0.85\text{V}$ , $V_O=5.25\text{V}$			20	$\mu\text{A}$
$I_{OZ}$	Three-state output current	$V_{CC}=5.25\text{V}$ , $V_{IH}=2\text{V}$ , $V_{IL}=0.85\text{V}$ , $V_O=0.45\text{V}$			-20	$\mu\text{A}$
$I_{IH}$	High-level input current. STB, $\overline{DS2}$ , $\overline{CLR}$ , $D_1\sim D_8$ inputs	$V_{CC}=5.25\text{V}$ , $V_I=5.25\text{V}$			10	$\mu\text{A}$
$I_{IH}$	High-level input current. MD input	$V_{CC}=5.25\text{V}$ , $V_I=5.25\text{V}$			30	$\mu\text{A}$
$I_{IH}$	High-level input current. $\overline{DS1}$ input	$V_{CC}=5.25\text{V}$ , $V_I=5.25\text{V}$			40	$\mu\text{A}$
$I_{IL}$	Low-level input current. STB, $\overline{DS2}$ , $\overline{CLR}$ , $D_1\sim D_8$ inputs	$V_{CC}=5.25\text{V}$ , $V_I=0.5\text{V}$			-0.25	mA
$I_{IL}$	Low-level input current. MD input	$V_{CC}=5.25\text{V}$ , $V_I=0.5\text{V}$			-0.75	mA
$I_{IL}$	Low-level input current. $\overline{DS1}$ input	$V_{CC}=5.25\text{V}$ , $V_I=0.5\text{V}$			-1	mA
$I_{OS}$	Short-circuit output current (Note 3)	$V_{CC}=5.0\text{V}$	-15		-75	mA
$I_{CC}$	Supply current from $V_{CC}$	$V_{CC}=5.25\text{V}$			130	mA

Note 1 : All voltage are with respect to GND terminal. Reference voltage (pin 12) is considered as 0V and all maximum and minimum values are defined in absolute values.

2 : Current flowing into an IC is positive, out is negative. The maximum and minimum values are defined in absolute values.

3 : All measurements should be done quickly, and two outputs should not be measured at the same time.

TIMING REQUIREMENTS ( $T_a=0\sim 75^\circ\text{C}$ ,  $V_{CC}=5\text{V}\pm 5\%$ , unless otherwise noted)

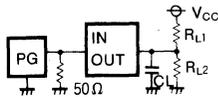
Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$t_{W(DS2)}$	Input pulse width, $\overline{DS1}$ , $\overline{DS2}$ and STB		30			ns
$t_{SU(DA)}$	Data setup time with respect to $\overline{DS1}$ , $\overline{DS2}$ and STB		15			ns
$t_{H(DA)}$	Data hold time with respect to $\overline{DS1}$ , $\overline{DS2}$ and STB		20			ns

## 8-BIT INPUT/OUTPUT PORT WITH 3-STATE OUTPUT

SWITCHING CHARACTERISTICS ( $T_a=0\sim 75^\circ\text{C}$ ,  $V_{CC}=5V\pm 5\%$ , unless otherwise noted)

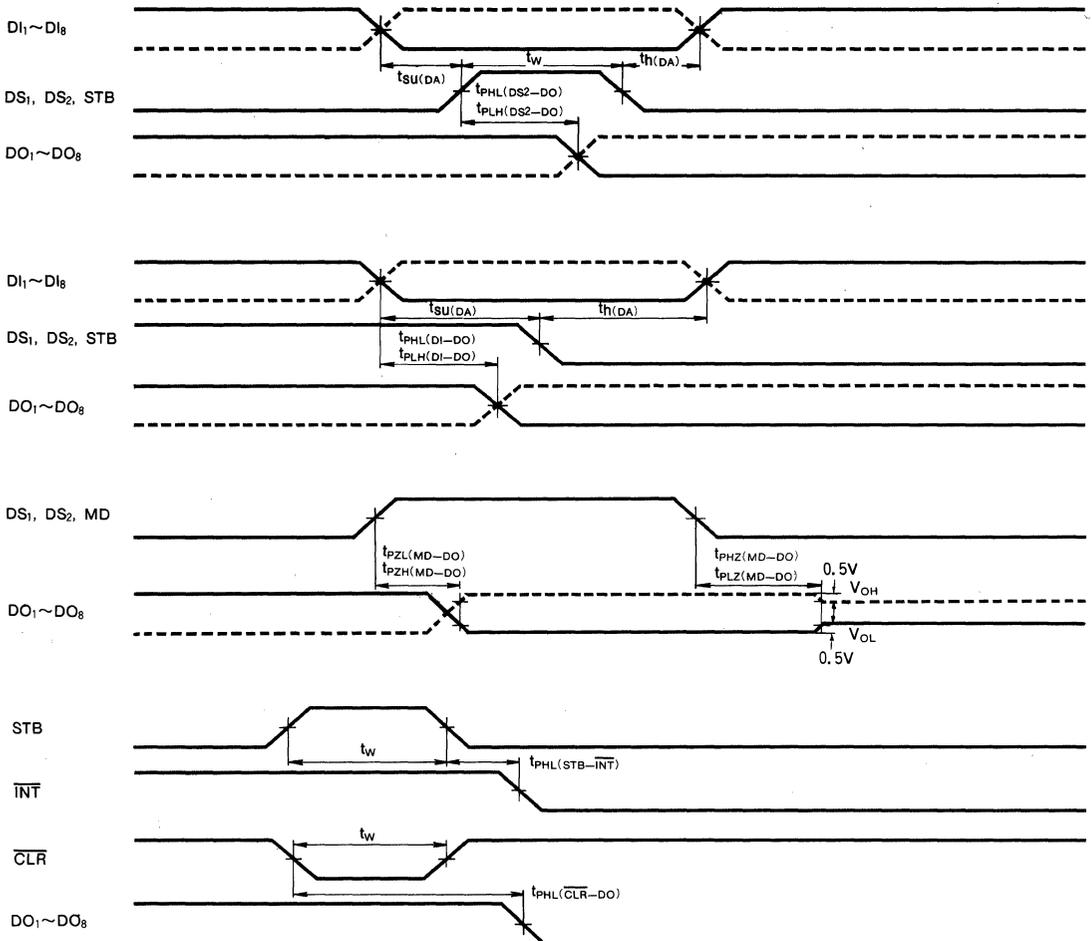
Symbol	Parameter	Test conditions (Note 4)	Limits			Unit
			Min	Typ	Max	
$t_{PHL}(DI-DO)$ $t_{PLH}(DI-DO)$	High-to-low-level and low-to-high-level output propagation time, from input DI to output DO	$C_L=30\text{pF}$ , $R_{L1}=300\Omega$ , $R_{L2}=600\Omega$			30	ns
$t_{PHL}(DS2-DO)$ $t_{PLH}(DS2-DO)$	High-to-low-level and low-to-high-level output propagation time, from input $\overline{DS1}$ , DS2 and STB to output DO				40	ns
$t_{PHL}(STB-\overline{INT})$	High-to-low-level output propagation time, from input STB to output $\overline{INT}$				40	ns
$t_{PZH}(MD-DO)$	Z-to-low-level and Z-to-high-level output propagation time, from inputs MD, $\overline{DS1}$ and DS2 to output DO	$C_L=30\text{pF}$ , $R_{L1}=300\Omega$ , $R_{L2}=2600\Omega$			45	ns
$t_{PHZ}(MD-DO)$ $t_{PLZ}(MD-DO)$	High-to-Z-level and low-to-Z-level output propagation time, from inputs MD, $\overline{DS1}$ and DS2 to output DO	$C_L=5\text{pF}$ , $R_{L1}=10\text{k}\Omega$ , $R_{L2}=1\text{k}\Omega$ $C_L=5\text{pF}$ , $R_{L1}=300\Omega$ , $R_{L2}=600\Omega$			45	ns
$t_{PHL}(\overline{CLR}-DO)$	High-to-low-level output propagation time, from input $\overline{CLR}$ to output DO	$C_L=30\text{pF}$ , $R_{L1}=300\Omega$ , $R_{L2}=600\Omega$			55	ns

Note 4 : Test circuit



8-BIT INPUT/OUTPUT PORT WITH 3-STATE OUTPUT

TIMING DIAGRAMS REFERENCE LEVEL=1.5V



# M5L8216P / M5L8226P

## 4-BIT PARALLEL BIDIRECTIONAL BUS DRIVERS

### DESCRIPTION

The M5L8216P and M5L8226P are 4-bit bidirectional bus drivers and suitable for the 8-bit parallel CPU M5L8080AP, S (8080A).

### FEATURES

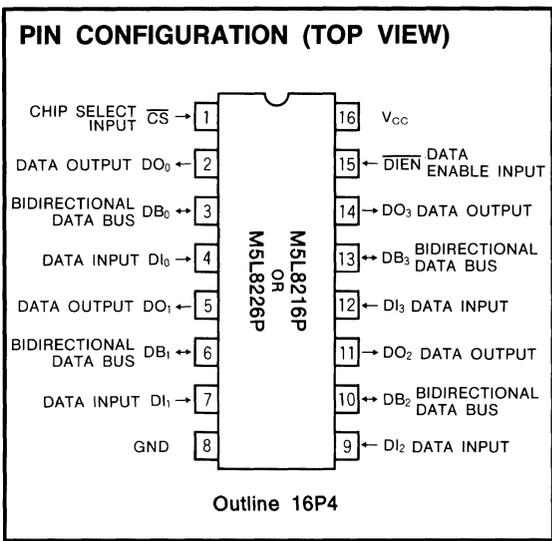
- Parallel 8-bit data bus buffer driver
- Low input current  $\overline{DIEN}$ ,  $\overline{CS}$ :  
 $I_{IL} = -500\mu A$  (max.)  
 $DI$ ,  $DB$ :  $I_{IL} = -250\mu A$  (max.)
- High output current  
**M5L8216P**  
 $DB$ :  $I_{OL} = 55mA$  (max.)  
 $I_{OH} = -10mA$  (max.)  
 $DO$ :  $I_{OH} = -1mA$  (max.)  
**M5L8226P**  
 $DB$ :  $I_{OL} = 50mA$  (max.)  
 $I_{OH} = -10mA$  (max.)  
 $DO$ :  $I_{OH} = -1mA$  (max.)
- Outputs can be connected with the CPU M5L8080AP, S:  $V_{OH} = 3.65V$  (min.)
- Three-state output

### APPLICATION

Bidirectional bus driver/receiver for various types of micro-computer systems.

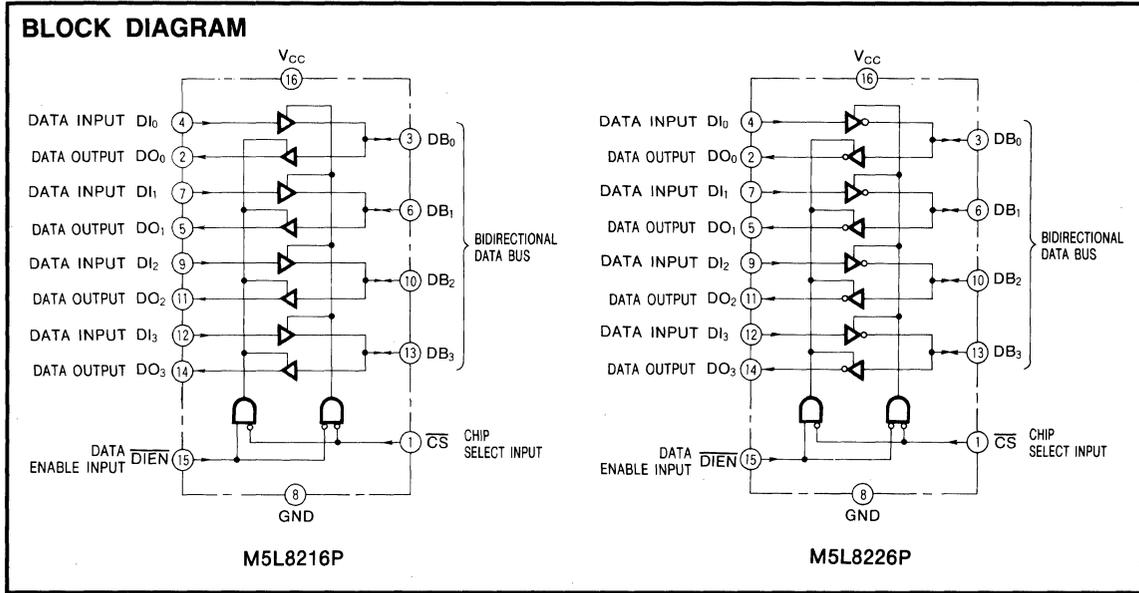
### FUNCTION

The M5L8216P is a non-inverting and the M5L8226P is an inverting 4-bit bidirectional bus driver.



When the terminal  $\overline{CS}$  is high-level, all outputs are in high-impedance state, and when low-level, the direction of the bidirectional bus can be controlled by the terminal  $\overline{DIEN}$ .

The terminal  $\overline{DIEN}$  controls the data flow. The data flow control is performed by placing one of a pair of buffers in high-impedance state and allowing the other to transfer the data.



## 4-BIT PARALLEL BIDIRECTIONAL BUS DRIVERS

ABSOLUTE MAXIMUM RATINGS ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage		7	V
$V_I$	Input voltage, CS, DIEN, DI inputs	With respect to GND	5.5	V
$V_I$	Input voltage, DB input		$V_{CC}$	V
$V_O$	High-level output voltage		$V_{CC}$	V
$P_d$	Power dissipation	$T_a=25^\circ\text{C}$	700	mW
$T_{opr}$	Operating free-air temperature range		0~75	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		-65~+150	$^\circ\text{C}$

RECOMMENDED OPERATING CONDITIONS ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.75	5	5.25	V
$I_{OH}$	High-level output current, DO output			-1	mA
$I_{OH}$	High-level output current, DB output			-10	mA
$I_{OL}$	Low-level output current, DO output			15	mA
$I_{OL}$	Low-level output current, DB output			25	mA

ELECTRICAL CHARACTERISTICS ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Limits			Unit	
			Min	Typ	Max		
$V_{IH}$	High-level input voltage		2			V	
$V_{IL}$	Low-level input voltage				0.95	V	
$V_{IC}$	Input clamp voltage	$V_{CC}=4.75\text{V}$ , $I_C=-5\text{mA}$			-1	V	
$V_{OH}$	High-level output voltage, DO output	$V_{CC}=4.75\text{V}$ $V_{IH}=2\text{V}$ $V_{IL}=0.95\text{V}$	$I_{OH}=-1\text{mA}$	3.65		V	
$V_{OH}$	High-level output voltage, DB output			$I_{OH}=-10\text{mA}$	2.4		V
$V_{OL1}$	Low-level output voltage, DO output		$I_{OL}=15\text{mA}$		0.45	V	
$V_{OL1}$	Low-level output voltage, DB output		$I_{OL}=25\text{mA}$		0.45	V	
$V_{OL2}$	Low-level output voltage, DB output		M5L8216P	$I_{OL}=55\text{mA}$		0.6	V
			M5L8226P	$I_{OL}=50\text{mA}$		0.6	V
$I_{OZH}$	Off-state output current, DO output	$V_{CC}=5.25\text{V}$	$V_O=5.25\text{V}$		20	$\mu\text{A}$	
$I_{OZH}$	Off-state output current, DB output				100	$\mu\text{A}$	
$I_{OZL}$	Off-state output current, DO output		$V_O=0.45\text{V}$		-20	$\mu\text{A}$	
$I_{OZL}$	Off-state output current, DB output				-100	$\mu\text{A}$	
$I_{IH}$	High-level input current, DIEN, CS inputs	$V_{CC}=5.25\text{V}$ , $V_{IH}=4.5\text{V}$			20	$\mu\text{A}$	
$I_{IH}$	High-level input current, DI, DB inputs	$V_{IL}=0\text{V}$ , $V_I=5.25\text{V}$			10	$\mu\text{A}$	
$I_{IL}$	Low-level input current, DIEN, CS inputs	$V_{CC}=5.25\text{V}$ , $V_{IH}=4.5\text{V}$			-500	$\mu\text{A}$	
$I_{IL}$	Low-level input current, DI, DB input	$V_{IL}=0\text{V}$ , $V_I=0.45\text{V}$			-250	$\mu\text{A}$	
$I_{OS}$	Short-circuit output DO output (Note 2)	$V_{CC}=5.25\text{V}$ , $V_O=0\text{V}$		-15	-65	mA	
$I_{OS}$	Short-circuit output DB output (Note 2)			-30	-120	mA	
$I_{CC}$	Supply current	M5L8216P	$V_{CC}=5.25\text{V}$		100	mA	
		M5L8226P			100	mA	
$I_{CCZ}$	Supply current z	M5L8216P			120	mA	
		M5L8226P			100	mA	

Note 1 : Current flowing into an IC is positive, out is negative.

2 : All measurements should be done quickly, and not more than one output should be shorted at a time.

# M5L8216P / M5L8226P

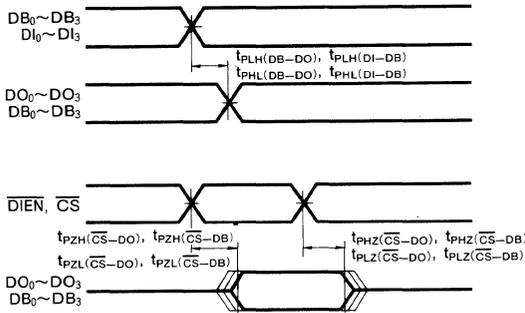
## 4-BIT PARALLEL BIDIRECTIONAL BUS DRIVERS

### SWITCHING CHARACTERISTICS (V<sub>CC</sub>=5V±5%, T<sub>a</sub>=25°C, unless otherwise noted)

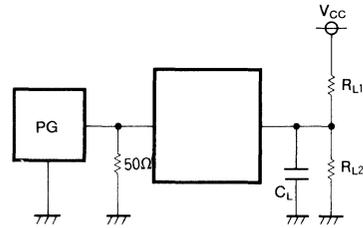
Symbol	Parameter	Conditions (Note 3)	Limits			Unit
			Min	Typ	Max	
t <sub>PHL</sub> (DB-DO) t <sub>PLH</sub> (DB-DO)	High-to-low and low-to-high output propagation time. from input DB to output DO	C <sub>L</sub> =30pF, R <sub>L1</sub> =300Ω, R <sub>L2</sub> =600Ω			25	ns
t <sub>PHL</sub> (DI-DB) t <sub>PLH</sub> (DI-DB)	High-to-low and low-to-high output propagation time. from input DI to output DB	C <sub>L</sub> =300pF, R <sub>L1</sub> =90Ω, R <sub>L2</sub> =180Ω			30	ns
t <sub>PHZ</sub> (CS-DO) t <sub>PLZ</sub> (CS-DO)	High-to-Z and low-to-Z output propagation time. from inputs DIEN, CS. to output DO	C <sub>L</sub> =5pF, R <sub>L1</sub> =10kΩ, R <sub>L2</sub> =1kΩ C <sub>L</sub> =5pF, R <sub>L1</sub> =300Ω, R <sub>L2</sub> =600Ω			35	ns
t <sub>PZH</sub> (CS-DO)	Output enable time. from inputs DIEN, CS to output DO	M5L8216P			65	ns
t <sub>PZL</sub> (CS-DO)		M5L8226P			54	ns
t <sub>PZH</sub> (CS-DB) t <sub>PZL</sub> (CS-DB)	Output enable time. from inputs DIEN, CS. to output DB	M5L8216P			65	ns
t <sub>PZH</sub> (CS-DB) t <sub>PZL</sub> (CS-DB)		M5L8226P			54	ns
t <sub>PZH</sub> (CS-DB) t <sub>PZL</sub> (CS-DB)	Output enable time. from inputs DIEN, CS. to output DB	M5L8216P			65	ns
t <sub>PZH</sub> (CS-DB) t <sub>PZL</sub> (CS-DB)		M5L8226P			54	ns

2

### TIMING DIAGRAM (Reference level=1.5V)



Note 3 : Test circuit



### APPLICATION EXAMPLES

Fig. 1 shows a pair of M5L8216Ps or M5L8226Ps which are directly connected with the M5L8080A CPU data bus, and their control signal. Fig. 2 shows an example circuit in which the M5L8216P or M5L8226P is used as an interface for memory and I/O to a bidirectional bus.

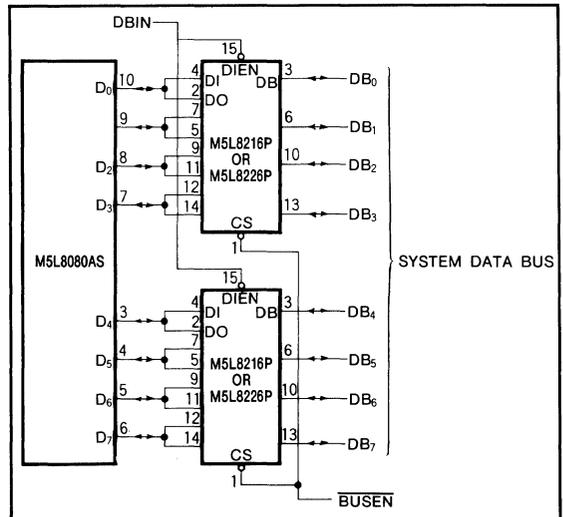


Fig. 1 Data bus buffer

# M5L8216P / M5L8226P

## 4-BIT PARALLEL BIDIRECTIONAL BUS DRIVERS

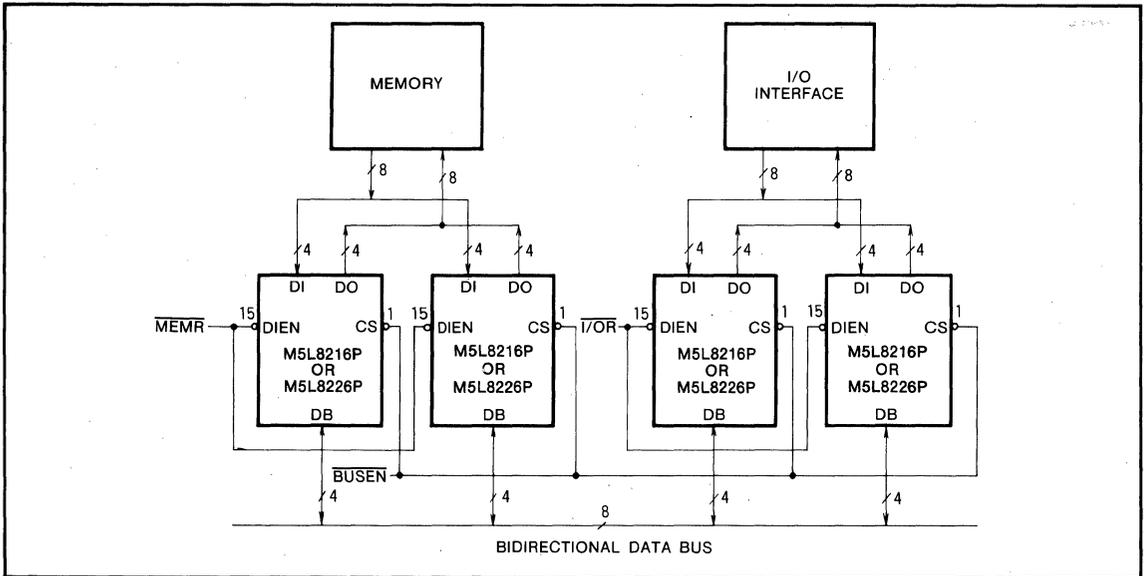


Fig. 2 Memory and I/O interface to bidirectional data bus

### PRECAUTIONS FOR USE

When the M5L8216P data input or two-way data bus is set to high to disable-output from the two-way bus or data output, care is required as a low glitch of approximate width 10ns will be generated.

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# MELPS 86 MICROPROCESSORS

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# MITSUBISHI LSIs

## M5L8282P/M5L8283P

OCTAL LATCH

### DESCRIPTION

The M5L8282P and M5L8283P are semiconductor integrated circuits consisting of sets of eight 3-state latches for use with various types of microprocessors.

### FEATURES

- 3-state, high-fanout output  
..... ( $I_{OL}=32\text{mA}$ ,  $I_{OH}=-5\text{mA}$ )
- Low power dissipation

### APPLICATION

Data latches for various microcomputer systems

### FUNCTION

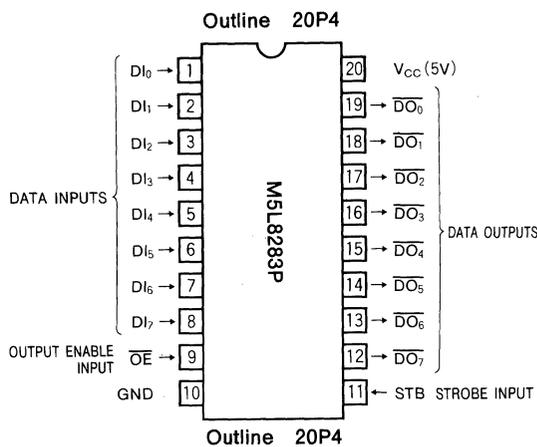
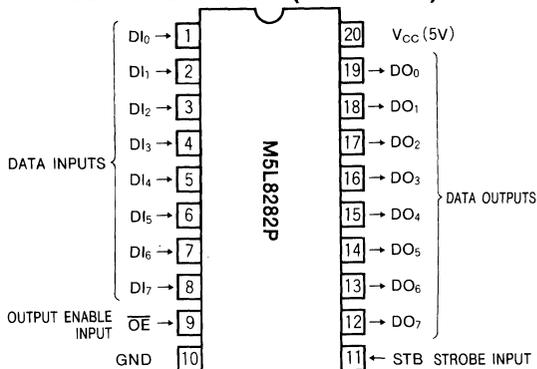
The M5L8282P and M5L8283P are latches with non-inverted and inverted outputs, respectively.

When the strobe input STB is high, the data inputs  $DI_0 \sim DI_7$  are passed through the data outputs  $DO_0 \sim DO_7$  (M5L8282P) or to the data outputs  $\overline{DO}_0 \sim \overline{DO}_7$  (M5L8283P), changes in the  $DI_0 \sim DI_7$  signals being reflected in the data outputs.

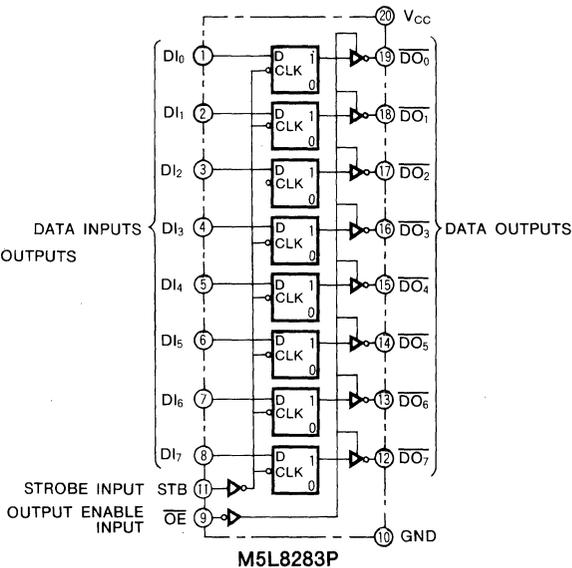
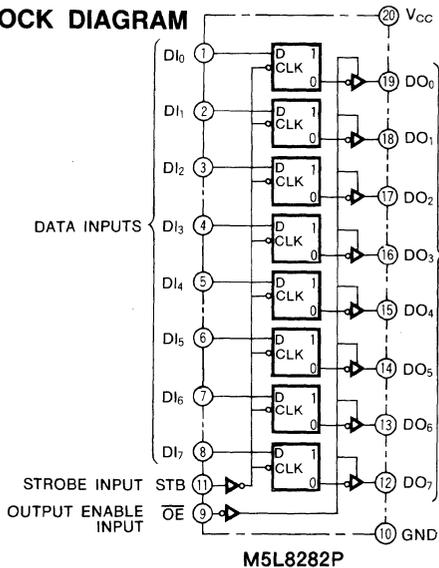
If the STB is changed from high to low, the data  $DI_0 \sim DI_7$  just before the change is latched. If the DI data is changed while STB is low, this change is not reflected in the data outputs.

When  $\overline{OE}$  is made high, all the data outputs go into the high-impedance state, the data latched prior to  $\overline{OE}$  going high being held.

### PIN CONFIGURATION (TOP VIEW)



### BLOCK DIAGRAM



**ABSOLUTE MAXIMUM RATINGS** ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage		$-0.5\sim +7$	V
$V_I$	Input voltage		$-0.5\sim +5.5$	V
$V_O$	Output voltage		$-0.5\sim V_{CC}$	V
$T_{opr}$	Operating free-air temperature range		$0\sim +75$	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		$-65\sim +150$	$^\circ\text{C}$

**RECOMMENDED OPERATING CONDITIONS** ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.5	5	5.5	V
$I_{OH}$	High-level output current $V_{OH}\geq 2.4\text{V}$	0		-5	mA
$I_{OL}$	Low-level output current $V_{OL}\leq 0.45\text{V}$	0		32	mA

**ELECTRICAL CHARACTERISTICS** ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{IH}$	High-level input voltage		2			V
$V_{IL}$	Low-level input voltage				0.8	V
$V_{IC}$	Input clamp voltage	$V_{CC}=4.5\text{V}, I_{IC}=-5\text{mA}$			-1	V
$V_{OH}$	High-level output voltage	$V_{CC}=4.5\text{V}, I_{OH}=-5\text{mA}$	2.4			V
$V_{OL}$	Low-level output voltage	$V_{CC}=4.5\text{V}, I_{OL}=32\text{mA}$			0.45	V
$I_{OZH}$	Off-state output current, high-level applied to the output	$V_{CC}=5.5\text{V}, V_I=2\text{V}, V_O=5.25\text{V}$			50	$\mu\text{A}$
$I_{OZL}$	Off-state output current, low-level applied to the output	$V_{CC}=5.5\text{V}, V_I=2\text{V}, V_O=0.4\text{V}$			-50	$\mu\text{A}$
$I_{IH}$	High-level input current	$V_{CC}=5.5\text{V}, V_I=5.25\text{V}$			50	$\mu\text{A}$
$I_{IL}$	Low-level input current	$V_{CC}=5.5\text{V}, V_I=0.45\text{V}$			-0.2	mA
$I_{CC}$	Supply current	$V_{CC}=5.5\text{V}$			80	mA
$C_{IN}$	Input capacitance	$F=1\text{MHz}, V_{BIAS}=2.5\text{V}$ $V_{CC}=5\text{V}, T_a=25^\circ\text{C}$			12	pF

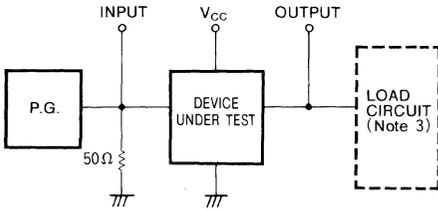
**SWITCHING CHARACTERISTICS** ( $V_{CC}=5\text{V}\pm 10\%$ ,  $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Alternate symbol	Test conditions	M5L8282P			M5L8283P			Unit
				Limits			Limits			
				Min	Typ	Max	Min	Typ	Max	
$t_{PLH}$ $t_{PHL}$	Propagation time from DI input to DO or $\overline{\text{DO}}$ for low-to-high or high-to-low change	$T_{I\text{VOV}}$	(Note 2)	5		30	5		22	ns
$t_{PLH}$ $t_{PHL}$	Propagation time from STB input to DO or $\overline{\text{DO}}$ for low-to-high and high-to-low change	$T_{SH\text{OV}}$		10		45	10		40	ns
$t_{PZH}$ $t_{PZL}$	Propagation time from $\overline{\text{OE}}$ input to DO or DO output when output is enabled	$T_{E\text{LOV}}$		10		30	10		30	ns
$t_{PHZ}$ $t_{PLZ}$	Propagation time from $\overline{\text{OE}}$ input to DO or DO output when the output is disabled	$T_{EH\text{OV}}$		5		18	5		18	ns
$t_r$	Output rise time	$T_{O\text{LOH}}$	From 0.8V to 2V			20			20	ns
$t_f$	Output fall time	$T_{O\text{HOL}}$	From 2V to 0.8V			12			12	ns

**TIMING REQUIREMENTS** ( $V_{CC}=5V\pm 10\%$ ,  $T_a=0\sim 75^\circ C$ , unless otherwise noted)

Symbol	Parameter	Alternate symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{W(STBH)}$	Strobe STB high pulse width	$T_{SHSL}$		15			ns
$t_{SU}$	Strobe STB setup time for $DI_0\sim DI_7$	$T_{IVSL}$		0			ns
$t_H$	STB hold time for $DI_0\sim DI_7$	$T_{SLIX}$		25			ns
$t_r$	Input rise time	$T_{ILIH}$	From 0.8V to 2V			20	ns
$t_f$	Input fall time	$T_{ILIH}$	From 2V to 0.8V			12	ns

Note 1 : Test Circuit

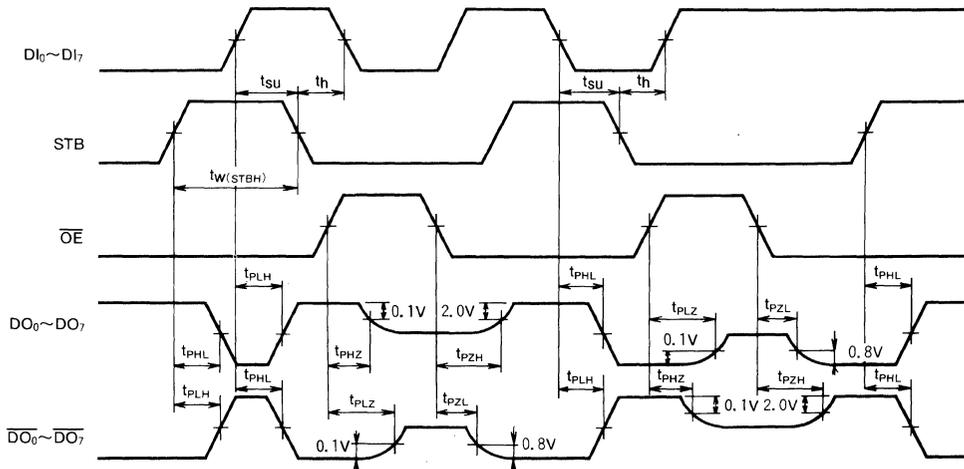


Note 2 :

TEST ITEM	$t_{PLH}, t_{PHL}$	$t_{PLZ}, t_{PZL}$	$t_{PHZ}, t_{PZH}$
LOAD CIRCUIT			

3

**TIMING DIAGRAM** (Reference voltage=1.5V)

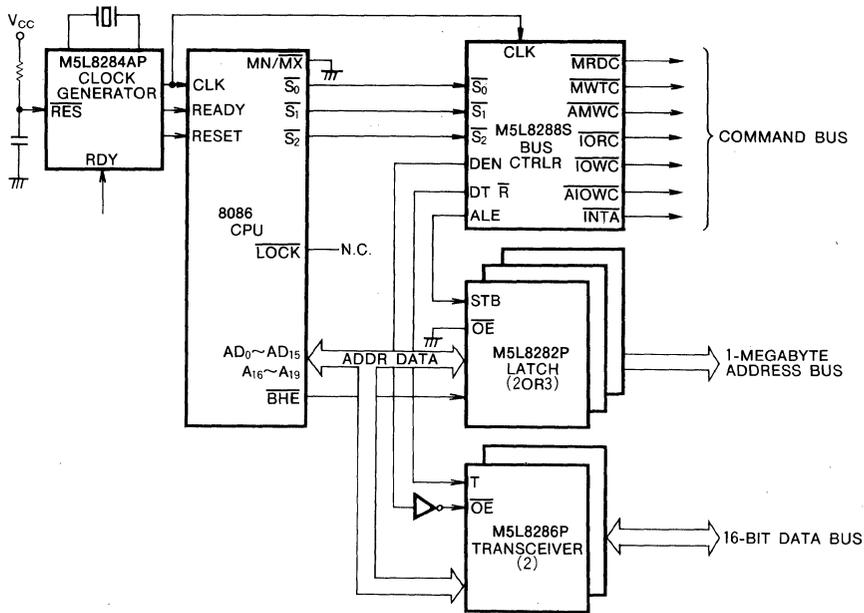


**PRECAUTIONS FOR USE**

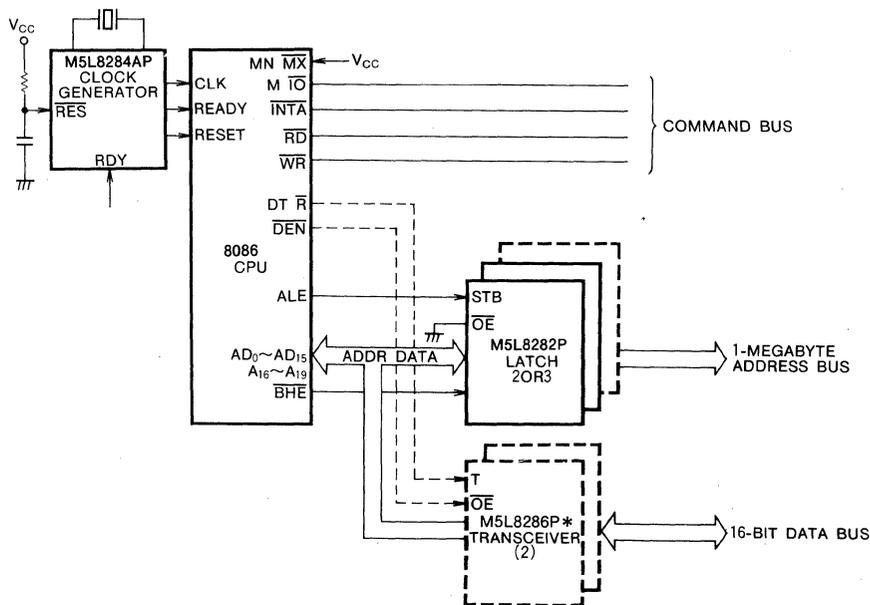
Care should be taken to accommodate the glitch that is generated when STB goes from low to high with the output low for the M5L8283P.

APPLICATION EXAMPLES

(1) Use in the maximum mode



(2) Use in the minimum mode



\* : Option  
Required when the number of devices  
driving the bus increases

MITSUBISHI LSIs  
**M5L8284AP**

**CLOCK GENERATOR AND DRIVER FOR 8086/8088/8089 PROCESSORS**

**DESCRIPTION**

The M5L8284AP is a clock generator and driver for use with the 8086, 8088 and 8089 processors.

It has a synchronous delay circuit and synchronous control circuit capable of controlling two Multibus (Intel trademark) circuits.

**FEATURES**

- Crystal controlled stable output frequency
- Capable of synchronous operation with other M5L8284APs
- External frequency input
- A power-on reset by means of an external capacitor and resistor

**APPLICATION**

Clock driver and generators and driver for 8086, 8088, and 8089.

**FUNCTION**

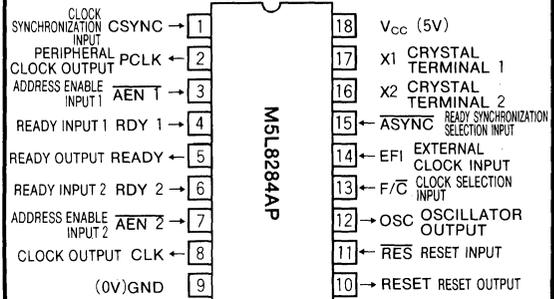
The M5L8284AP is a clock generator/driver for the 8086, 8088 and 8089 microprocessors.

The chip contains a crystal controlled oscillator, a divided-by-3 counter, a peripheral clock output provided divided-by-2 counter, a reset circuit and ready circuit to ensure synchronization to the CLK signal.

The reset input RES is used to generate the reset output RESET as the CPU reset synched to the CLK signal. A Schmitt trigger is used at the input side.

Thus, a reset signal can be output at power on by connecting a capacitor and resistor to the RES input.

**PIN CONFIGURATION (TOP VIEW)**



Outline 18P4

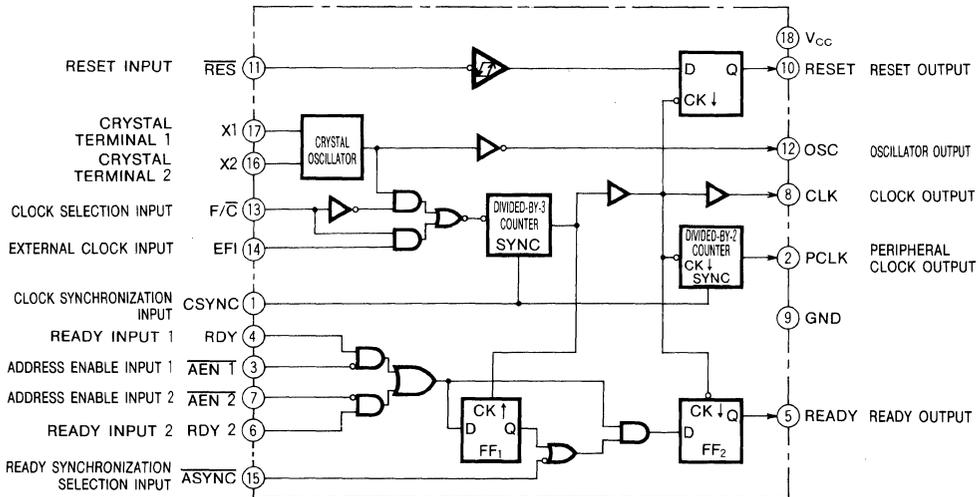
**3**

The frequency/crystal selection input F/C can be used to select the crystal oscillator circuit output or an external clock input as the input for the divide-by-three counter.

By using these pins, the M5L8284AP output can be used to drive multiple M5L8284AP devices.

The clock synchronization input CSYNC is used to operate multiple M5L8284APs in sync.

**BLOCK DIAGRAM**



CLOCK GENERATOR AND DRIVER FOR 8086/8088/8089 PROCESSORS

PIN DESCRIPTIONS

Pin	Name	Input or output	Function
$\overline{\text{AEN1}}$ , $\overline{\text{AEN2}}$	Address enable input	Input	When $\overline{\text{AEN1}}$ and $\overline{\text{AEN2}}$ are set low, RDY1 and RDY2 are enabled, respectively. By using these two inputs separately, the CPU can be used to access two Multibusses. When not used as a multimaster, AEN should be set to low. These inputs are active low.
RDY1, RDY2	Bus ready input	Input	These inputs are connected to the output signal indicating the completion of data reception from a system bus device or, indicating that data is valid. RDY1 and RDY2 are enabled when $\overline{\text{AEN1}}$ and $\overline{\text{AEN2}}$ are low, respectively. These inputs are active high.
$\overline{\text{ASYNC}}$	Active low input	Input	This signal is used to select the synchronization mode of the READY signal generation circuit. When the $\overline{\text{ASYNC}}$ signal is set low, the READY signal is generated in two synchronization steps. When the $\overline{\text{ASYNC}}$ signal is set high, the READY signal is generated in one step.
READY	Ready output	Output	The state of RDY appears at this output in synchronization with the CLK output. This is done to synchronize the READY output to the M5L8284AP internal clock because the RDY input generation is unrelated to the CLK signal. This pin is normally connected to the CPU ready input and cleared after the required hold CPU time has elapsed.
X <sub>1</sub> , X <sub>2</sub>	Crystal element terminals	Input	These pins are used to connect the crystal. The crystal frequency is 3 times of CPU clock frequency. The crystal should be in the 12-25MHz range with the series resistance as possible as small. Care should be taken that these pins are not shorted to ground.
$\overline{\text{F/C}}$	Clock selection input	Input	When $\overline{\text{F/C}}$ is set low, CLK and PCLK outputs are driven from the crystal oscillator circuit. When it is set high, they are driven from the EFI input.
EFI	External clock input	Input	When $\overline{\text{F/C}}$ is set high, CLK and PCLK output signals are driven from this pin. A TTL level rectangular signal and three times of the CPU frequency should be used.
CLK	Clock output	Output	This output is connected to the clock inputs of the CPU and the peripheral devices on the local bus. The output waveform is 1/3 the frequency of the crystal oscillator connected at X <sub>1</sub> and X <sub>2</sub> or the signal applied to the EFI input, and has a duty cycle of 1/3. Since for V <sub>CC</sub> =5V, V <sub>OH</sub> =4.5V, this output can be directly drive the CPU clock input.
PCLK	Peripheral clock output	Output	This output provides a clock signal for use with peripheral devices. The output waveform is 50% duty cycle TTL level rectangular waveform with a frequency 1/2 that of the clock output.
OSC	Oscillator output	Output	This output is a TTL level crystal oscillator output. The frequency is the same as that of the crystal connected at X <sub>1</sub> and X <sub>2</sub> , but care should be taken as the frequency will be unstable if these pins are left open.
$\overline{\text{RES}}$	Reset input	Input	This active low input is used to generate the reset output signal for the CPU. The input is a schmitt trigger input so that by connecting a capacitor and a resistor, the CPU reset signal can be generated at power on.
RESET	Reset output	Output	This pin is connected to the CPU reset input. The signal at this pin is synchronized the $\overline{\text{RES}}$ input with the CLK signal. This output is active high.
CSYNC	Clock synchronization input	Input	When using multiple M5L8284AP devices, this input is used as a clock synchronization input. When CSYNC is high, the internal counter of the M5L8284AP is reset and when CSYNL is low, it begins operation. CSYNC must be synchronized with EFI. See application notes.

CLOCK GENERATOR AND DRIVER FOR 8086 / 8088 / 8089 PROCESSORS

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
V <sub>CC</sub>	Supply voltage		-0.5~7	V
V <sub>I</sub>	Input voltage		-0.5~5.5	V
V <sub>O</sub>	Output voltage		-0.5~V <sub>CC</sub>	V
T <sub>opr</sub>	Operating free-air temperature range		0~75	°C
T <sub>stg</sub>	Storage temperature range		-65~150	°C

RECOMMENDED OPERATING CONDITIONS (T<sub>a</sub>=0~75°C, unless otherwise noted)

Symbol	Parameter		Limits			Unit
			Min	Nom	Max	
V <sub>CC</sub>	Supply voltage		4.5	5	5.5	V
I <sub>OH</sub>	High-level output current	CLK V <sub>OH</sub> =4V	0		-1	mA
		Other outputs V <sub>OH</sub> =2.4V				
I <sub>OL</sub>	Low-level output current	V <sub>OL</sub> ≤0.45V	0		5	mA

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ELECTRIC CHARACTERISTICS (T<sub>a</sub>=0~75°C, unless otherwise noted)

Symbol	Parameter		Test conditions	Limits			Unit
				Min	Typ	Max	
V <sub>IH</sub>	High-level input voltage	RES		2.6			V
		Other inputs RES		2			V
V <sub>IL</sub>	Low-level input voltage					0.8	V
V <sub>T+</sub> -V <sub>T-</sub>	Hysteresis width	RES	V <sub>CC</sub> =5V	0.25			V
V <sub>IC</sub>	Input clamp voltage		V <sub>CC</sub> =4.5V, I <sub>C</sub> =-5mA			-1	V
V <sub>OH</sub>	High-level output voltage	CLK	V <sub>CC</sub> =4.5V, I <sub>OH</sub> =-1mA	4			V
		Other outputs CLK		2.4			V
V <sub>OL</sub>	Low-level output voltage		V <sub>CC</sub> =4.5V, I <sub>OL</sub> =5mA			0.45	V
I <sub>IH</sub>	High-level input current		V <sub>CC</sub> =5.5V, V <sub>I</sub> =5.25V			50	μA
I <sub>IL</sub>	Low-level input current	ASYNC	V <sub>CC</sub> =5.5V, V <sub>I</sub> =0.45V			-1.3	mA
		Other inputs ASYNC				-0.5	mA
I <sub>CC</sub>	Supply current		V <sub>CC</sub> =5.5V			162	mA

CLOCK GENERATOR AND DRIVER FOR 8086 / 8088 / 8089 PROCESSORS

SWITCHING CHARACTERISTICS (V<sub>CC</sub>=5V±10%, T<sub>a</sub>=0~75°C, unless otherwise noted)

Symbol	Parameter	Alternate symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
T <sub>C</sub>	CLK repetition period	t <sub>CLCL</sub>		100			ns
T <sub>W</sub> (CLKH)	CLK high pulse width	t <sub>CHCL</sub>	(Note 5 a, b) CLKF <sub>reg</sub> ≤8MHz	(1/3)t <sub>CLCL</sub> +2			ns
			CLKF <sub>reg</sub> =10MHz	39			ns
T <sub>W</sub> (CLKL)	CLK low pulse width	t <sub>CLCH</sub>	(Note 5 a, b) CLKF <sub>reg</sub> ≤8MHz	(2/3)t <sub>CLCL</sub> -15			ns
			CLKF <sub>reg</sub> =10MHz	53			ns
t <sub>TLH</sub>	CLK low-high transition time	t <sub>CH1CH2</sub>	1~3.5V			10	ns
t <sub>THL</sub>	CLK high-low transition time	t <sub>CL2CL1</sub>	3.5~1V			10	ns
T <sub>W</sub> (PCLKH)	PCLK high pulse width	t <sub>PHPL</sub>		t <sub>CLCL</sub> -20			ns
T <sub>W</sub> (PCLKL)	PCLK low pulse width	t <sub>PLPH</sub>		t <sub>CLCL</sub> -20			ns
t <sub>dIV</sub>	READY inhibit time with respect to CLK (Note 1)	t <sub>RYLCL</sub>	(Note 5 c, d)	-8			ns
t <sub>dV</sub>	READY enable time with respect to CLK (Note 2)	t <sub>RYHCH</sub>	(Note 5 c, d) CLKF <sub>reg</sub> ≤8MHz	53			ns
			CLKF <sub>reg</sub> =10MHz				
T <sub>DHL</sub> (CLK-RESET)	High-low delay time from CLK to RESET	t <sub>CLIL</sub>				40	ns
T <sub>DLH</sub> (CLK-PCLK)	Low-high delay time from CLK to PCLK	t <sub>CLPH</sub>				22	ns
T <sub>DHL</sub> (CLK-PCLK)	High-low delay time from CLK to PCLK	t <sub>CLPL</sub>				22	ns
T <sub>DLH</sub> (OSC-CLK)	Low-high delay time from OSC to CLK	t <sub>OLCH</sub>		-5		22	ns
T <sub>DHL</sub> (OSC-CLK)	High-low delay time from OSC to CLK	t <sub>OLCL</sub>		2		35	ns
T <sub>r</sub>	Output rise time	t <sub>OLOH</sub>	0.8~2V (except CLK)			20	ns
t <sub>f</sub>	Output fall time	t <sub>OHOL</sub>	2~0.8V (except CLK)			12	ns

Note 1 : Applies to T2 state time  
 Note 2 : Applies to T3 and TW state times

CLOCK GENERATOR AND DRIVER FOR 8086 / 8088 / 8089 PROCESSORS

**TIMING REQUIREMENTS** ( $V_{CC}=5V \pm 10\%$ ,  $T_a=0\sim 75^\circ C$ , unless otherwise noted)

Symbol	Parameter	Alternate symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$f_{(xtal)max}$	Crystal frequency			12		25	MHz
$t_{W(EFIH)}$	EFI high pulse width	$t_{EHEL}$	$90\% - 90\%V_{IN}$	13			ns
$t_{W(EFIL)}$	EFI low pulse width	$t_{ELEH}$	$10\% - 10\%V_{IN}$	13			ns
$T_{C(FEI)}$	EFI repetition period (Note 3)	$t_{EEL}$		$t_{EHEL} + t_{ELEH} + \delta$			ns
$t_{SU(RDY)}$	RDY1 and RDY2 active setup time with respect to CLK	$t_{RIVCL}$	ASYNC=HIGH	35			ns
$t_{SU(RDY)}$	RDY1 and RDY2 active hold time with respect to CLK	$t_{RIVCH}$	ASYNC=LOW	35			ns
$t_{SU(RDY)}$	RDY1 and RDY2 inactive setup time with respect to CLK	$t_{RIVCL}$		35			ns
$t_{H(RDY)}$	RDY1 and RDY2 hold time with respect to CLK	$t_{CLRIX}$		0			ns
$t_{SU(ASYNC)}$	ASYNC setup time with respect to CLK	$t_{AYVCL}$		50			ns
$t_{H(ASYNC)}$	ASYNC hold time with respect to CLK	$t_{CLAYX}$		0			ns
$t_{SU(AEN)}$	AEN1 and AEN2 setup time with respect to RDY1 and RDY2	$t_{AIVRIV}$		15			ns
$t_{H(AEN)}$	AEN1 and AEN2 hold time with respect to CLK	$t_{CLAIX}$		0			ns
$t_{SU(CSYNC)}$	CSYNC setup time with respect to EFI	$t_{YHEH}$		20			ns
$t_{H(CSYNC)}$	CSYNC hold time with respect to EFI	$t_{EHYL}$		20			ns
$t_{W(CSYNC)}$	CSYNC pulse width	$t_{YHYL}$		$2t_{EEL}$			ns
$t_{SU(RES)}$	RES setup time with respect to CLK (Note 4)	$t_{IHCL}$		65			ns
$t_{H(RES)}$	RES hold time with respect to CLK (Note 4)	$t_{CLITH}$		20			ns
$t_r$	Input rise time	$t_{LIH}$	0.8~2V			20	ns
$t_f$	Input fall time	$t_{HIL}$	2~0.8V			12	ns

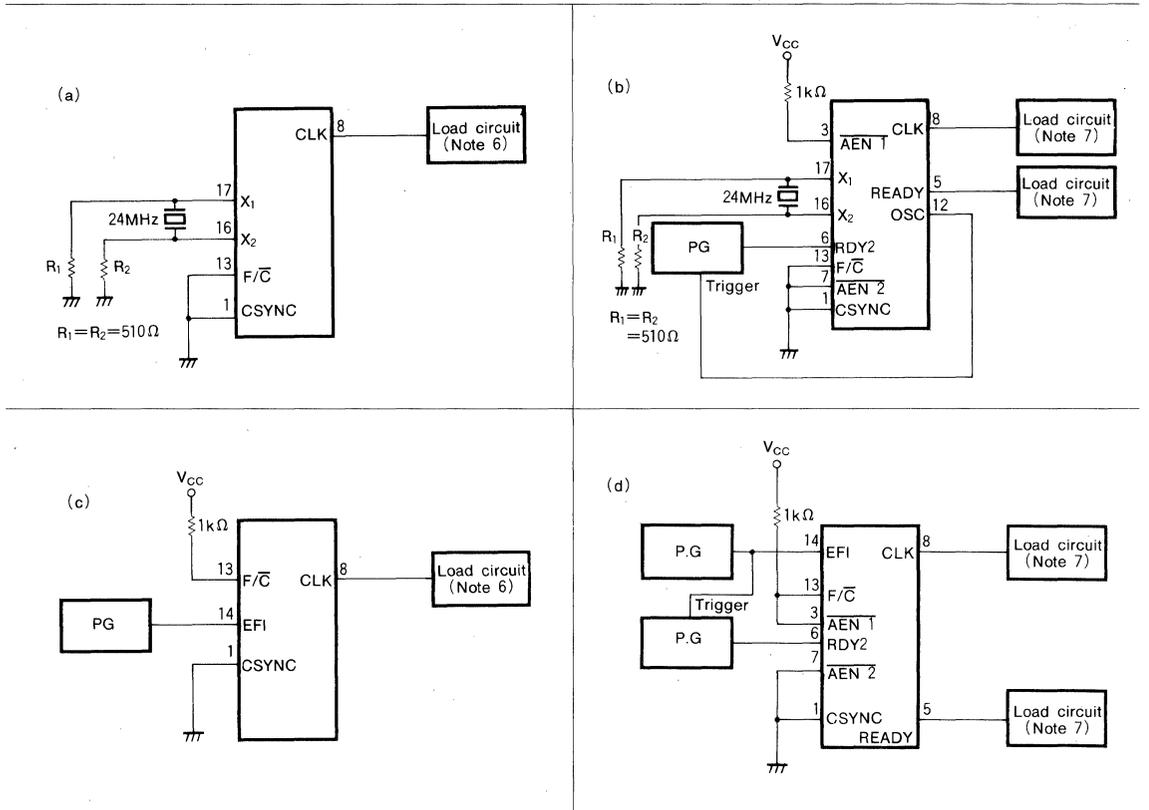
Note 3 :  $\delta = t_r(5ns \text{ max}) + EFI + t_f(5ns \text{ max}) + EFI$

4 :  $t_{SU(RES)}$  and  $t_{H(RES)}$  are theoretically only to guarantee logic in the next clock period

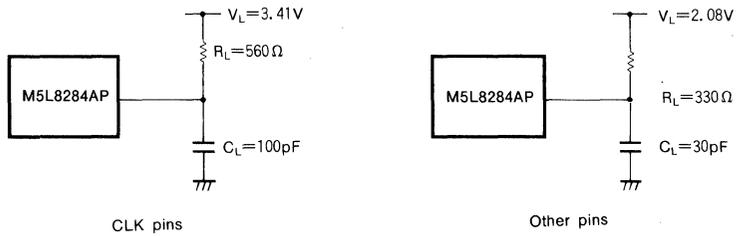
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CLOCK GENERATOR AND DRIVER FOR 8086/8088/8089 PROCESSORS

Note 5 : Test circuits



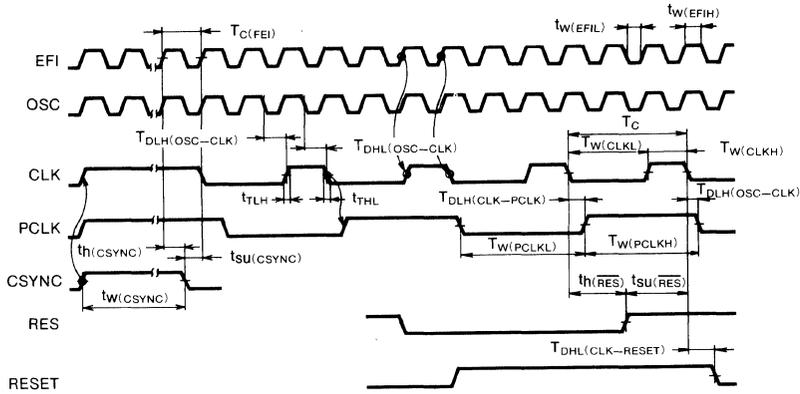
Note 6 : Load circuit



CLOCK GENERATOR AND DRIVER FOR 8086/8088/8089 PROCESSORS

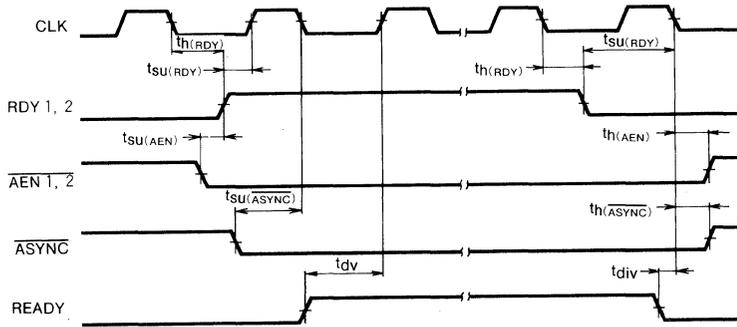
TIMING DIAGRAM (Reference level=1.5V)

CLK, RESET Signals

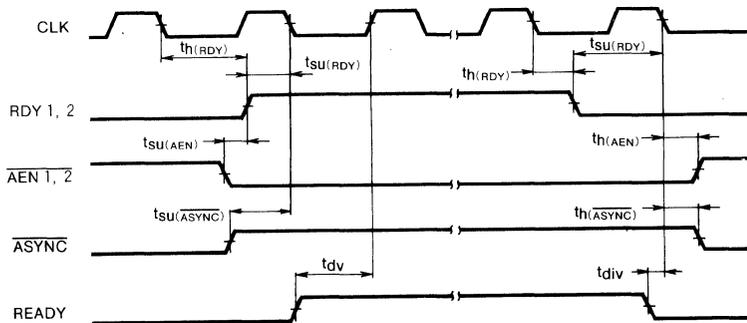


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READY Signal (with asynchronous device)



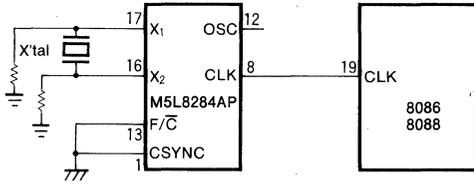
READY Signal (with synchronous device)



CLOCK GENERATOR AND DRIVER FOR 8086/8088/8089 PROCESSORS

APPLICATION NOTES

(1) Connecting the crystal



The crystal frequency should be three times the cycle time of the 8086, 8088 or 8089, and the crystal should be located as close to the M5L8284AP as possible.

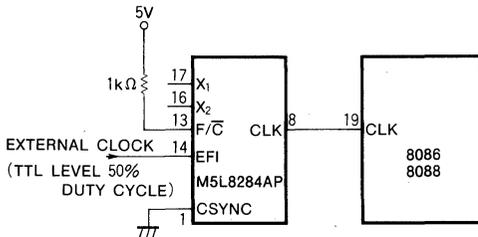
PRECAUTIONS FOR USE

(1) The oscillator circuit of the M5L8284AP is designed for use with the fundamental mode crystal.

If noise is allowed to enter the XTAL1, XTAL2 or V<sub>CC</sub> pins, the oscillator frequency will be pulled of the parallel resident frequency and the stray capacitance between XTAL1 and XTAL2 may cause the circuit to go into relaxation oscillation. To prevent this, care should be given to the following points.

- (1) There should be one with a small parallel capacitance.
- (2) A 0.01 – 0.1 μF capacitor should be connected between V<sub>CC</sub> and ground. This capacitor should be located as close as possible to the IC.

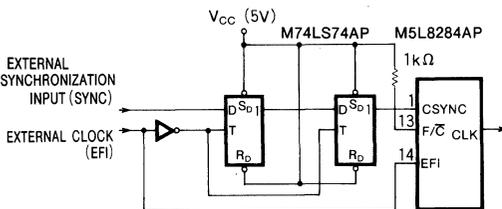
(2) External clock connections



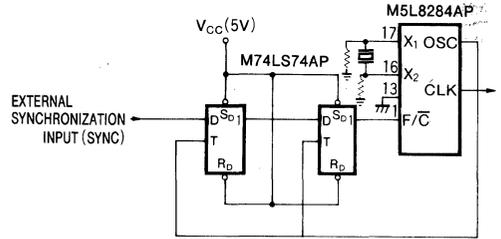
The frequency should be three times the CPU cycle frequency

(3) Synchronizing using the CSYNC input

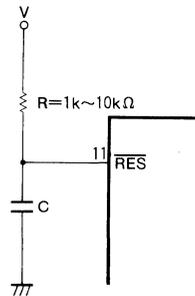
● When the EFI input is used



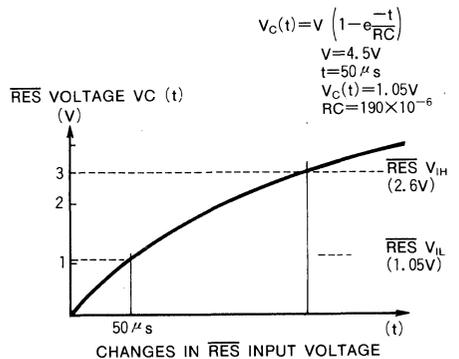
● When the EFI input is not used



(4) Power-on reset circuit



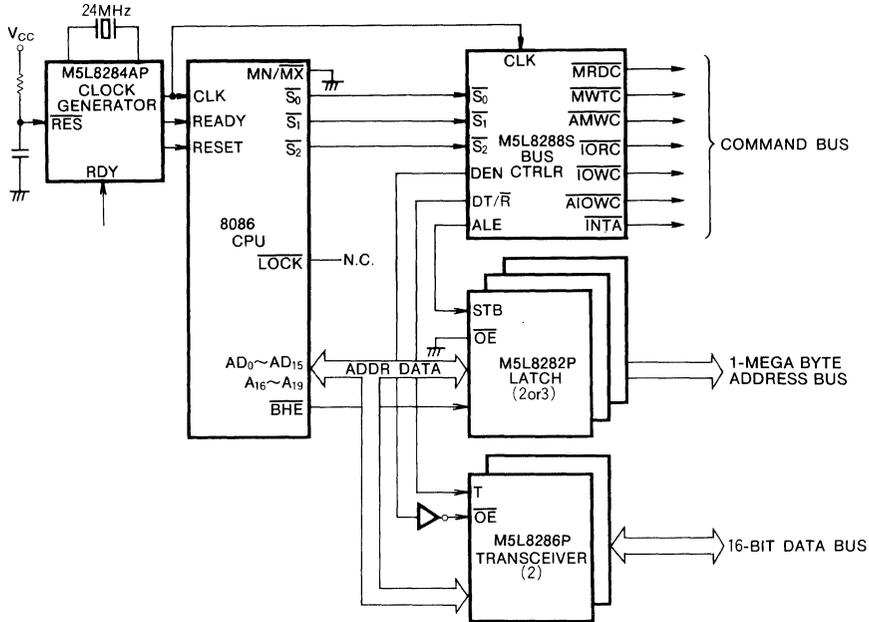
Since the 8086, 8088 and 8089 require a reset pulse over 50 μs after V<sub>CC</sub> reaches 4.5V upon power on, the capacitor value should be determined by the graph shown below. Note that the time for V<sub>CC</sub> to reach 4.5V has not been considered, so that it is necessary to choose the characteristics value of capacitance under consideration of the power supply.



**CLOCK GENERATOR AND DRIVER FOR 8086/8088/8089 PROCESSORS**

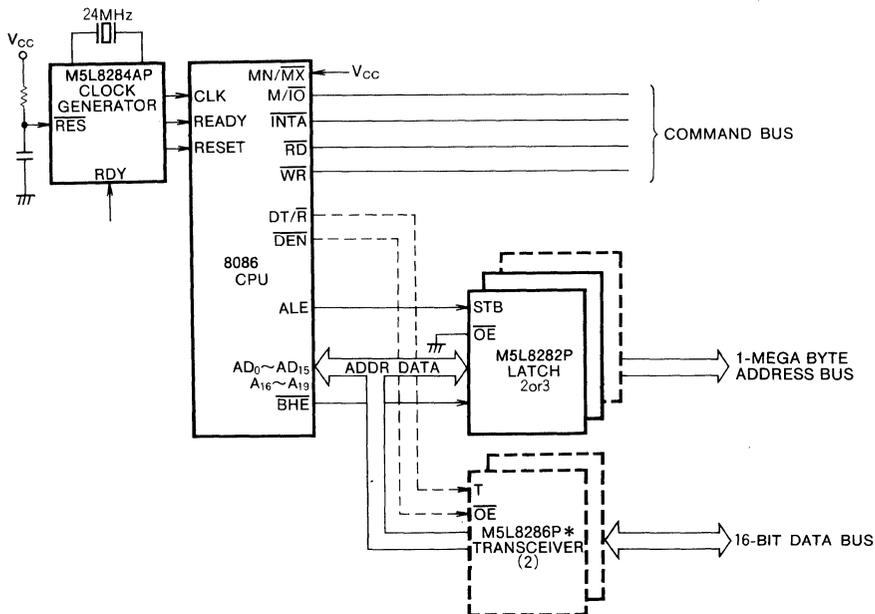
**APPLICATION EXAMPLES**

(1) Use in the maximum mode



**3**

(2) Use in the minimum mode



\* : Option  
Required when the number of devices driving the bus increases

# M5L8286P / M5L8287P

## OCTAL BUS TRANSCEIVER

### DESCRIPTION

The M5L8286P and M5L8287P are semiconductor integrated circuits consisting of a set of eight 3-state output bus transceivers for use with a variety of microprocessor systems.

### FEATURES

- 3-state, high-fanout outputs ( $I_{OL} = 16\text{mA}$ ,  $I_{OH} = -1\text{mA}$  for the A outputs and  $I_{OL} = 32\text{mA}$ ,  $I_{OH} = -5\text{mA}$  for the B outputs)
- Low power dissipation

### APPLICATION

Two-way bus transceivers for microcomputer systems

### FUNCTION

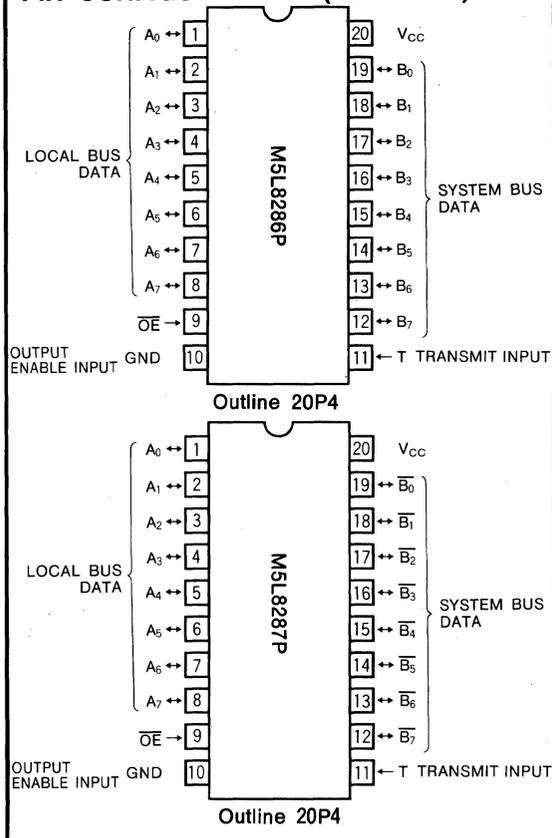
The M5L8286P and M5L8287P are two-way bus transceivers with non-inverted and inverted outputs respectively.

When the output enable input  $\overline{OE}$  is high, the local bus data pins  $A_0 \sim A_7$  and system data pins  $B_0 \sim B_7$  are both placed in the high-impedance state.

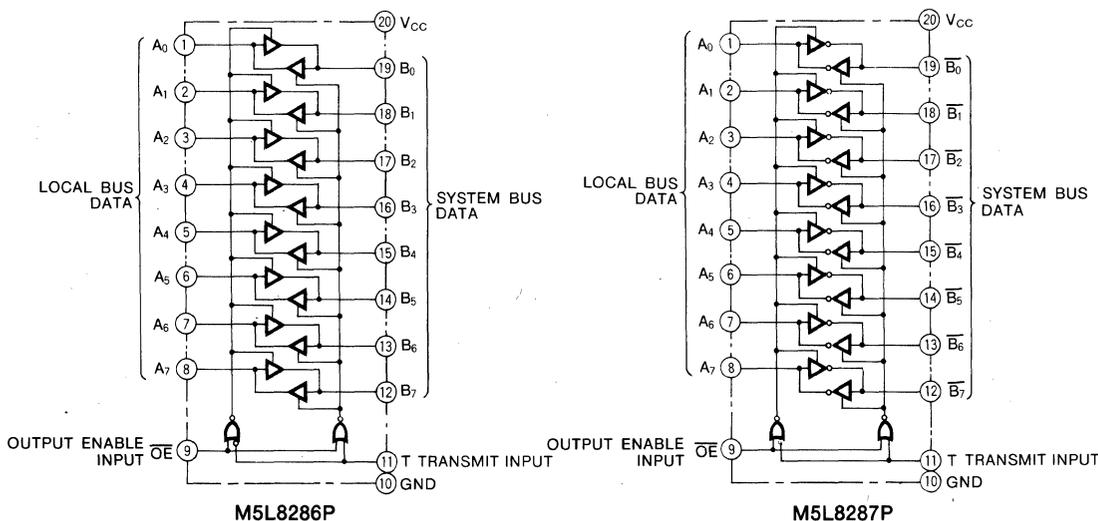
When the output enable input  $\overline{OE}$  is low, the input and output states are controlled by the transmit input T.

When T is high,  $A_0 \sim A_7$  are input pins and  $B_0 \sim B_7$  are output pins. When T is low,  $B_0 \sim B_7$  are input pins and  $A_0 \sim A_7$  are output pins.

### PIN CONFIGURATIONS (TOP VIEW)



### BLOCK DIAGRAM



**M5L8286P/M5L8287P**

**OCTAL BUS TRANSCEIVER**

**FUNCTION TABLES** (Note 1)

**M5L8286P**

**M5L8287P**

$\overline{OE}$	T	A	B
L	L	O	I
L	H	I	O
H	X	Z	Z

$\overline{OE}$	T	A	B
L	L	$\overline{O}$	I
L	H	I	$\overline{O}$
H	X	Z	Z

Note 1 : I : Input pin

O,  $\overline{O}$  : Output pin (non-inverted for the M5L8286P and inverted for the M5L8283P)

Z : Indicated the high-impedance state (A and B are separated)

X : Either high or low

**ABSOLUTE MAXIMUM RATINGS** ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage		-0.5~+7	V
$V_i$	Input voltage		-0.5~+5.5	V
$V_o$	Output voltage		-0.5~ $V_{CC}$	V
$T_{opr}$	Operating free-air temperature range		0~+75	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		-65~+150	$^\circ\text{C}$

**RECOMMENDED OPERATING CONDITIONS** ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter		Limits			Unit
			Min	Nom	Max	
$V_{CC}$	Supply voltage		4.5	5	5.5	V
$I_{OH}$	High-level output current	$V_{OH}\geq 2.4\text{V}$	A output	0	-1	mA
			B output	0	-5	mA
$I_{OL}$	Low-level output current	$V_{OL}\leq 0.45\text{V}$	A output	0	16	mA
			B output	0	32	mA

**ELECTRICAL CHARACTERISTICS** ( $T_a=0\sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter		Test conditions	Limits			Unit	
				Min	Typ	Max		
$V_{IH}$	High-level input voltage			2			V	
$V_{IL}$	Low-level input voltage		A input			0.8	V	
			B input			0.9	V	
$V_{IC}$	Input clamp voltage		$V_{CC}=4.5\text{V}, I_{IC}=-5\text{mA}$			-1	V	
$V_{CH}$	High-level output voltage		A output	$V_{CC}=4.5\text{V}, I_{OH}=-1\text{mA}$	2.4		V	
			B output	$V_{CC}=4.5\text{V}, I_{OH}=-5\text{mA}$	2.4		V	
$V_{OL}$	Low-level output voltage		A output	$V_{CC}=4.5\text{V}, I_{OL}=16\text{mA}$		0.45	V	
			B output	$V_{CC}=4.5\text{V}, I_{OL}=32\text{mA}$		0.45	V	
$I_{OZH}$	Off-state output current with high-level applied at the output		A output	$V_{CC}=5.5\text{V}, V_i=2\text{V}$		$V_i=0.8\text{V}$	50	$\mu\text{A}$
			B output	$V_o=5.25\text{V}$		$V_i=0.9\text{V}$		
$I_{OZL}$	Off-state output current with low-level applied the output		A output	$V_{CC}=5.5\text{V}, V_i=2\text{V}$		$V_i=0.8\text{V}$	-0.2	mA
			B output	$V_o=0.45\text{V}$		$V_i=0.9\text{V}$		
$I_{IH}$	High-level input current		$V_{CC}=5.5\text{V}, V_i=5.25\text{V}$			50	$\mu\text{A}$	
$I_{IL}$	Low-level input current		$V_{CC}=5.5\text{V}, V_i=0.45\text{V}$			-0.2	mA	
$I_{CC}$	Supply current		M5L8286P	$V_{IC}=5.5\text{V}$		110	mA	
			M5L8287P			110	mA	
$C_{IN}$	Input capacitance		$F=1\text{MHz}, V_{BIAS}=2.5\text{V}$ $V_{CC}=5\text{V}, T_a=25^\circ\text{C}$			12	pF	

3

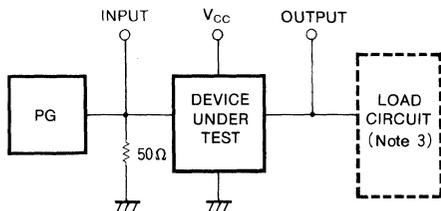
**SWITCHING CHARACTERISTICS** ( $V_{CC}=5V\pm 10\%$ ,  $T_a=0\sim 75^\circ C$ , unless otherwise noted)

Symbol	Parameter	Alternate symbol	Test conditions	M5L8286P			M5L8287P			Unit
				Limits			Limits			
				Min	Typ	Max	Min	Typ	Max	
$t_{PLH}$ $t_{PHL}$	Low-level to high-level and high-level and low-level transition time from input A, B to outputs B, A	TIVOV	(Note 2)	5		30	5		22	ns
$t_{PZH}$ $t_{PZL}$	Output enable time from $\overline{OE}$ input to A or B output	TELOV		10		30	10		30	ns
$t_{PHZ}$ $t_{PLZ}$	Output disable time from $\overline{OE}$ input to A or B output	TEHOZ		5		18	5		18	ns
$t_r$	Output risetime	TOLOH	From 0.8V to 2V			20			20	ns
$t_f$	Output falltime	TOHOL	From 2V to 0.8V			12			12	ns

**TIMING REQUIREMENTS** ( $V_{CC}=5V\pm 10\%$ ,  $T_a=0\sim 75^\circ C$ , unless otherwise noted)

Symbol	Parameter	Alternate Symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{su}$	T setup time with respect to $\overline{OE}$	$T_{TVFL}$		10			ns
$t_h$	T hold time with respect to $\overline{OE}$	$T_{EHTV}$		5			ns
$t_r$	Input risetime	$T_{ILIH}$	From 0.8V to 2V			20	ns
$t_f$	Input falltime	$T_{ILIL}$	From 2V to 0.8V			12	ns

Note 2 : Test Circuit



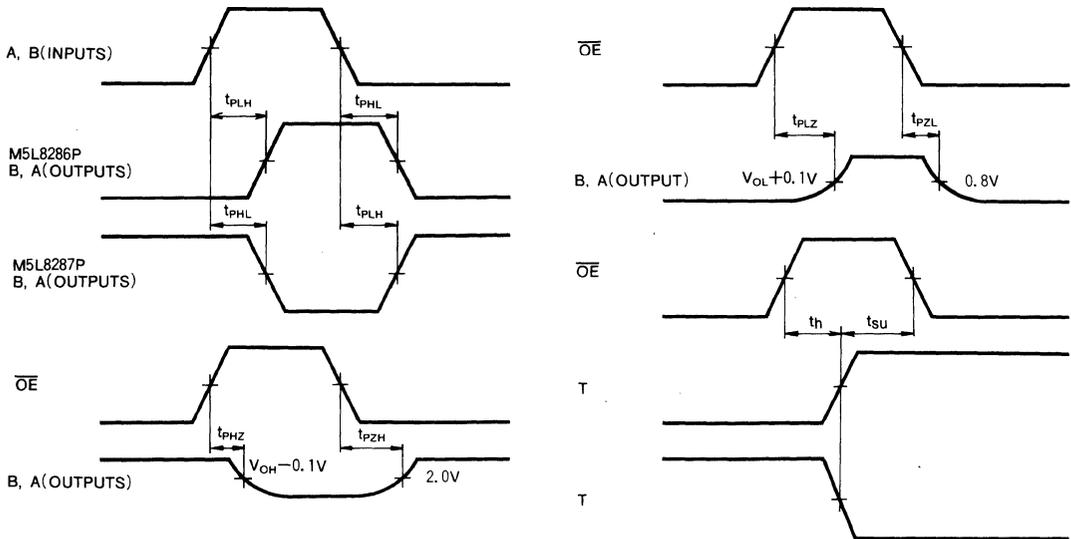
Note 3

Test Item	$t_{PLH}$ , $t_{PHL}$	$t_{PLZ}$ , $t_{PZL}$	$t_{PHZ}$ , $t_{PZH}$
A OUTPUT LOAD CIRCUIT			
8 OUTPUT LOAD CIRCUIT			

# M5L8286P/M5L8287P

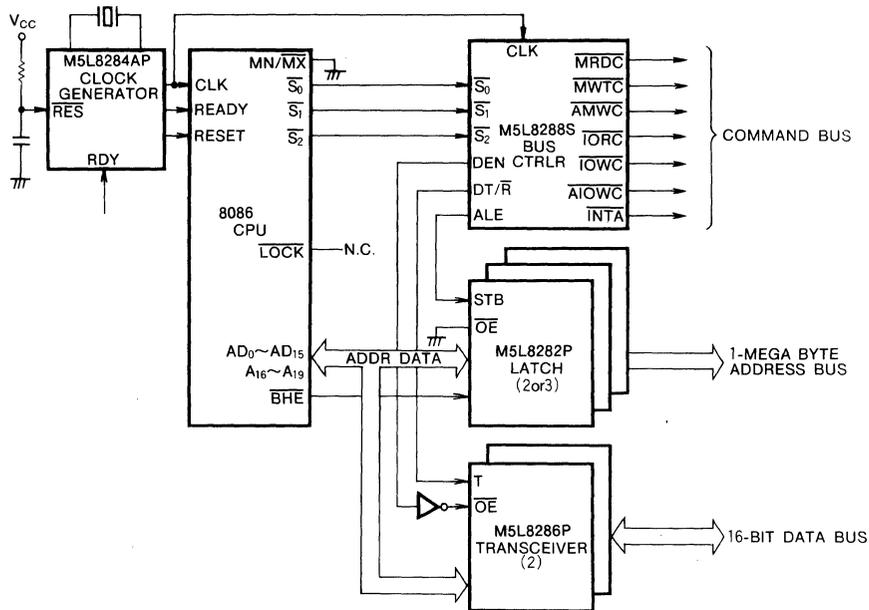
## OCTAL BUS TRANSCEIVER

### TIMING DIAGRAM (Reference voltage=1.5V)



3

### APPLICATION EXAMPLE



**BUS CONTROLLER FOR 8086/8088/8089 PROCESSORS**

**DESCRIPTION**

The M5L8288S is a semiconductor integrated circuit consisting of a bus controller and bus driver for the 8086 and 8088, 16-bit microprocessors. By using the status signals from the CPU a Multibus (Intel trademark) control signal is generated.

**FEATURES**

- High-fanout outputs  
 Command output  $I_{OL}=32\text{mA}$ ,  $I_{OH}=-5\text{mA}$   
 Control output  $I_{OL}=16\text{mA}$ ,  $I_{OH}=-1\text{mA}$
- Advanced command outputs ( $\overline{\text{AIOWC}}$  and  $\overline{\text{AMWC}}$  outputs)
- Low power dissipation

**APPLICATION**

Bus controller and bus driver for maximum mode operation of the 8086 and 8088

**FUNCTION**

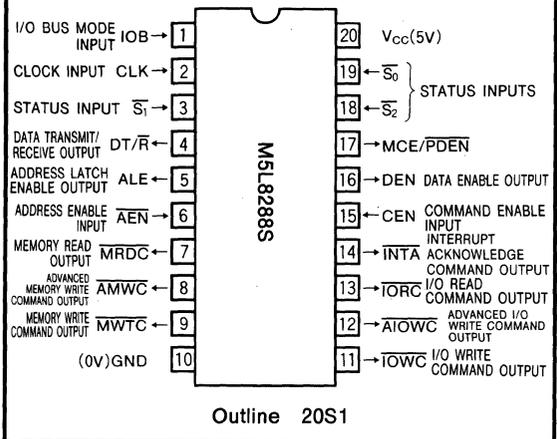
The M5L8288S is a bus controller and driver for maximum mode operation of the 8086 and 8088 processors.

The command signals and control signals are decoded by means of the  $S_0 \sim S_2$  outputs from the CPU and the control signals for I/O devices and memory are output.

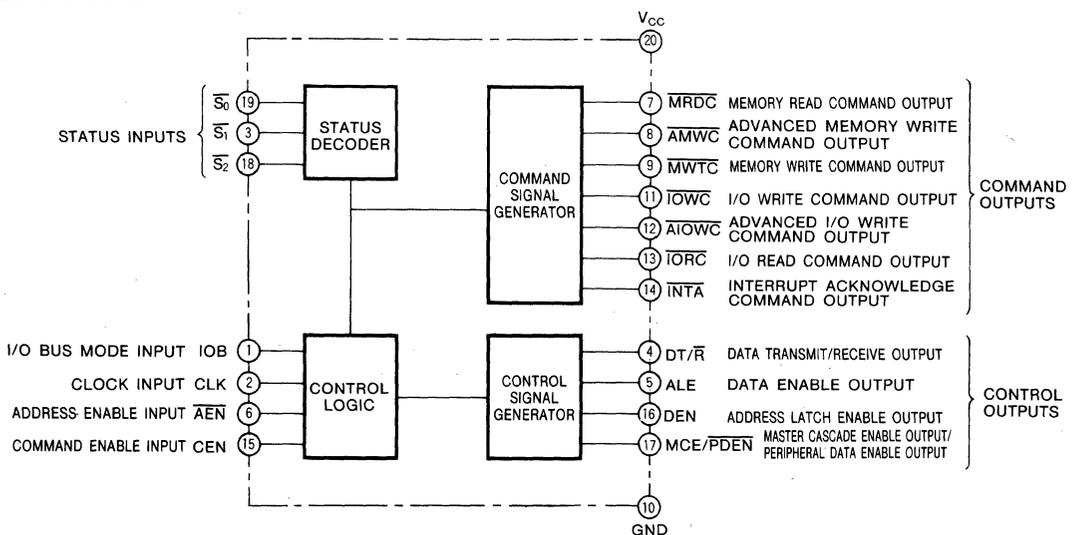
The device can be used in the Multimaster mode in which several CPUs acting as masters are connected to one data bus. An input pin for the control signal  $\overline{\text{AEN}}$  from an 8289 bus arbiter is provided.

By using the M5L8288S as a bus controller, a higher-performance 16-bit microcomputer system can be configured.

**PIN CONFIGURATION (TOP VIEW)**



**BLOCK DIAGRAM**



## BUS CONTROLLER FOR 8086/8088/8089 PROCESSORS

## PIN DESCRIPTIONS

Pin	Name	Input of output	Functions
$\overline{S_0}, \overline{S_1}, \overline{S_2}$	Status input	Input	These are connected to the CPU status output $\overline{S_0} \sim \overline{S_2}$ . The M5L8288S uses these signals to generate the proper timing command signals and control signals. All pins are provided with internal pull-up resistors.
CLK	Clock input	Input	Used to connect the clock generator M5L8284AP clock output CLK. All outputs of the M5L8288S change in synchronization with the clock input.
ALE	Address latch enable output	Output	Provides the strobe signal output for the address latches. This pin is connected to the STB pin of the M5L8282P or M5L8283P and used to latch the address from the CPU. When using any other address latch, the following conditions must be satisfied. 1. The enable input must be active high. 2. Data reading is always performed while the enable input is high. 3. The latching operation is performed as the enable input goes from high to low.
DEN	Data enable	Output	Provides the data enable signal for the local bus or a data transceiver on the system bus. Operates in active high mode.
DT/ $\overline{R}$	Data transmit/receive control output	Output	Controls the flow of data between CPU and memory or peripheral I/O devices. When this pin is high, the CPU can write data to the peripheral devices. When it is low, it can read data from the peripheral devices. It is connected to the transmit input T of the M5L8286P or M5L8287P bus transceivers.
$\overline{AEN}$	Address enable input	Input	When the IOB input is low and the AEN input is set to high, all command outputs are put in the high-impedance state. When the IOB input is high, there is no effect on the $\overline{IORC}$ , $\overline{IOWC}$ , $\overline{AIOWC}$ , and INTA outputs, the command output other than these four going into the high-impedance state. None of the command outputs will go low until at least 115ns after $\overline{AEN}$ transits from high to low.
CEN	Command enable input	Input	When this pin is set to low, all command outputs and DEN are prohibited by the PDEN control output (not high-impedance state). When set to high, the above outputs are enabled.
IOB	Input/output bus mode input	Input	When this pin is set to high, the M5L8288S functions in the I/O bus mode, and when set to low it functions in the system bus mode. (The I/O bus mode and system bus mode are described in the functional description)
$\overline{AIOWC}$	Advanced I/O write command output	Output	The $\overline{AIOWC}$ issues an I/O Write Command earlier in the machine cycle to give I/O devices an early indication of a write instruction its timing is the same as a read command signal. Active low.
$\overline{IOWC}$	I/O write command output	Output	Instructs an I/O device to read the data on the data bus. Active low.
$\overline{IORC}$	I/O read command output	Output	Instructs an I/O device to drive its data onto the data bus. Active low.
$\overline{AMWC}$	Advanced write command output	Output	The $\overline{AMWC}$ issues a memory write command earlier in the machine cycle to give memory devices an early indication of a write instruction. Its timing is the same as a read command signal. Active low.
$\overline{MWTC}$	Memory write command output	Output	Provides a write instruction to memory for the current data on the bus. Active low.
$\overline{MRDC}$	Memory read command output	Output	Provides an output instruction to memory for the present data on the bus. Active low.
$\overline{INTA}$	Interrupt acknowledge command output	Output	This output informs an interrupting device that it has accepted the interrupt, outputting a vector address output instruction to the data bus. $\overline{IORC}$ operates in the same manner for interrupt cycles. Active low.
MCE/ PDEN	Master cascade Enable output/ Peripheral data Enable output	Output	This output pin has two functions. 1. When the IOB input is set to low: The MCE function is enabled. The signal acts as the enable signal which allows a slave PIC (M5L8259AP) to read the cascade address output to the bus by the master PIC during an interrupt sequence. Active high. 2. When the IOB input is set to high: The PDEN function is enabled. This output provides the enable signal to the data bus transceiver connected to the I/O interface bus when an instruction occurs ( $\overline{IORC}$ , $\overline{IOWC}$ , $\overline{AIOWC}$ , $\overline{INTA}$ ). Operates the same way as DEN with respect to the system bus.

## BUS CONTROLLER FOR 8086/8088/8089 PROCESSORS

## FUNCTIONAL DESCRIPTION

The state of the command outputs and control outputs are determined by the CPU status outputs  $\overline{S_0} \sim \overline{S_2}$ . The table summarizes the states of the outputs  $\overline{S_0} \sim \overline{S_2}$  and their cor-

responding valid command output names.

Depending upon whether the M5L8288S is in the I/O bus mode or system bus mode, the command output sequence will vary.

## STATUS INPUTS AND COMMAND OUTPUTS RELATIONSHIPS

$\overline{S_2}$	$\overline{S_1}$	$\overline{S_0}$	8086, 8088 status	Valid command output name
L	L	L	Interrupt acknowledge	$\overline{INTA}$
L	L	H	Data read from an I/O port	$\overline{IORC}$
L	H	L	Data write to an I/O port	$\overline{IOWC}$ , $\overline{AIOWC}$
L	H	H	Halt	—
H	L	L	Instruction fetch	$\overline{MRDC}$
H	L	H	Read data from memory	$\overline{MRDC}$
H	H	L	Write data to memory	$\overline{MWTC}$ , $\overline{AMWC}$
H	H	H	Passive state	—

## 1. I/O bus mode operation

When IOB is high, the M5L8288S function in the I/O bus mode.

In the I/O Bus mode all I/O command lines ( $\overline{IORC}$ ,  $\overline{IOWC}$ ,  $\overline{AIOWC}$ ,  $\overline{INTA}$ ) are always enabled (i.e., not dependent on  $\overline{AEN}$ ). When an I/O command is initiated by the processor, the 8288 immediately activates the command lines using  $\overline{PDEN}$  and  $\overline{DT/R}$  to control the I/O bus transceiver. The I/O command lines should not be used to control the system bus in this configuration because no arbitration is present. This mode allows one 8288 Bus Controller to handle two external busses. No waiting is involved when the CPU wants to gain access to the I/O bus. Normal memory access requires a "Bus Ready" signal ( $\overline{AEN}$  LOW) before it will proceed. It is advantageous to use the IOB mode if I/O or peripherals dedicated to one processor exist in a multi-processor system.

## 2. System bus mode operation

When IOB is set to low, the M5L8288S enters the system bus mode. In this mode no command is issued until 115 ns after

the  $\overline{AEN}$  Line is activated (LOW). This mode assumes bus arbitration logic will inform the bus controller (on the  $\overline{AEN}$  line) when the bus is free for use. Both memory and I/O commands wait for bus arbitration. This mode is used when only one bus exists. Here, both I/O and memory are shared by more than one processor.

3.  $\overline{AMWC}$  and  $\overline{AIOWC}$  outputs

With respect to the normal write control signals  $\overline{MWTC}$  and  $\overline{IOWC}$ , the advanced-write command signals  $\overline{AMWC}$  and  $\overline{AIOWC}$  transit low one clock cycle earlier and remain low for two clock cycles.

These signals are used with peripheral devices or static RAM devices which require a long write pulse, so that the CPU does not go into an unnecessarily wait cycle.

**BUS CONTROLLER FOR 8086/8088/8089 PROCESSORS**

**ABSOLUTE MAXIMUM RATINGS** ( $T_a=0\sim75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage		$-0.5\sim+7$	V
$V_I$	Input voltage		$-0.5\sim+5.5$	V
$V_O$	Output voltage		$-0.5\sim V_{CC}$	V
$P_d$	Power dissipation		1.5	W
$T_{opr}$	Operating free-air temperature range		$0\sim75$	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		$-65\sim+150$	$^\circ\text{C}$

**RECOMMENDED OPERATING CONDITIONS** ( $T_a=0\sim75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter		Limits			Unit
			Min	Nom	Max	
$V_{CC}$	Supply voltage		4.5	5	5.5	V
$I_{OH}$	High-level output current	Command outputs			-5	mA
		Control outputs			-1	
$I_{OL}$	Low-level output current	Command outputs			32	mA
		Control outputs			16	

**ELECTRICAL CHARACTERISTICS** ( $T_a=0\sim75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter		Test conditions		Limits			Unit
					Min	Typ	Max	
$V_{IH}$	High-level input voltage				2			V
$V_{IL}$	Low-level input voltage						0.8	V
$V_{IC}$	Input clamp voltage						-1	V
$V_{OH}$	High-level output voltage	Command outputs	$V_{CC}=4.5\text{V}, V_I=2\text{V}$	$I_{OH}=-5\text{mA}$	2.4			V
		Control outputs	$V_I=0.8\text{V}$	$I_{OH}=-1\text{mA}$	2.4			
$V_{OL}$	Low-level output voltage	Command outputs	$V_{CC}=4.5\text{V}, V_I=2\text{V}$	$I_{OL}=32\text{mA}$			0.5	V
		Control outputs	$V_I=0.8\text{V}$	$I_{OL}=16\text{mA}$			0.5	
$I_{IH}$	High-level input voltage		$V_{CC}=5.5\text{V}, V_I=5.5\text{V}$				50	$\mu\text{A}$
$I_{IL}$	Low-level input voltage		$V_{CC}=5.5\text{V}, V_I=0.45\text{V}$				-0.7	mA
$I_{OZH}$	Off-state output current with high-level applied to output		$V_{CC}=5.5\text{V}, V_O=5.25\text{V}$				100	$\mu\text{A}$
$I_{OZL}$	Off-state output current with low-level applied to output		$V_{CC}=5.5\text{V}, V_O=0.4\text{V}$				-100	$\mu\text{A}$
$I_{CC}$	Supply current		$V_{CC}=5.5\text{V}$				160	mA

**3**

BUS CONTROLLER FOR 8086/8088/8089 PROCESSORS

SWITCHING CHARACTERISTICS ( $V_{CC}=5V\pm 10\%$ ,  $T_a=0\sim 75^\circ C$ , unless otherwise noted)

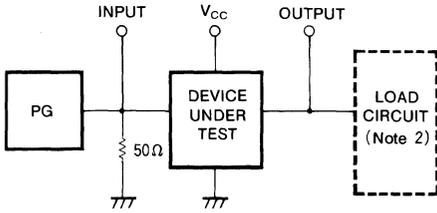
Symbol	Parameter	Alternate symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{PLH}$	Output low-level to high-level propagation time From CLK input to DEN output	TCVNV		5		45	ns
$t_{PHL}$	Output high-level to low-level propagation time From CLK input to PDEN output						
$t_{PLH}$	Output low-level to high-level propagation time From CLK input to DEN output.	TCVNX		10		45	ns
$t_{PHL}$	Output high-level to low-level propagation time From CLK input to PDEN output						
$t_{PLH}$	Output low-level to high-level propagation time From CLK input to ALE output	TCLLH				20	ns
$t_{PLH}$	Output low-level to high-level propagation time From CLK input to MCE output	TCLMCH				20	ns
$t_{PLH}$	Output low-level to high-level propagation time From $\overline{S_0}\sim\overline{S_1}$ inputs to ALE output	TSVLH				20	ns
$t_{PLH}$	Output low-level to high-level propagation time From $\overline{S_0}\sim\overline{S_1}$ inputs to MCE output	TSMVCH				20	ns
$t_{PHL}$	Output high-level to low-level propagation time From CLK input to ALE output	TCHLL		4		15	ns
$t_{PHL}$	Output high-level to low-level propagation time From CLK input to MRDC, IORC, INTA, AMWC, MWTC, AIOWC, and IOWC outputs	TCLML		10		35	ns
$t_{PLH}$	Output low-level to high-level propagation time From CLK input to MRDC, IORC, INTA, AMWC, MWTC, AIOWC, and IOWC outputs	TCLMH		10		35	ns
$t_{PHL}$	Output high-level to low-level propagation time From CLK input to DT/ $\overline{R}$ output	TCHDTL	(Note 1)			50	ns
$t_{PLH}$	Output low-level to high-level propagation time From CLK input to DT/ $\overline{R}$ output	TCHDTH				30	ns
$t_{PZH}$	High-level output enable time From AEN input to MRDC, IORC, INTA, AMWC, MWTC, AIOWC, and IOWC outputs	TAE LCH				40	ns
$t_{PHZ}$	High-level output disable time From AEN input to MRDC, IORC, INTA, AMWC, MWTC, AIOWC, and IOWC outputs	TAEHCZ				40	ns
$t_{PHL}$	Output high-level to low-level propagation time From AEN input to MRDC, IORC, INTA, AMWC, MWTC, AIOWC, and IOWC outputs	TAE LCV		115		200	ns
$t_{PLH}$ $t_{PHL}$	Output low-level to high-level and high-level to low-level propagation time From AEN input to DEN output	TAEVNV				20	ns
$t_{PLH}$ $t_{PHL}$	Output low-level to high-level and high-level to low-level propagation time From CEN input to DEN and PDEN outputs	TCEVNV				25	ns
$t_{PLH}$ $t_{PHL}$	Output low-level to high-level and high-level to low-level propagation time. From CEN input to MRDC, IORC, INTA, AMWC, MWTC, AIOWC and IOWC outputs	TCELRH				35	ns

TIMING REQUIREMENTS ( $V_{CC}=5V\pm 10\%$ ,  $T_a=0\sim 75^\circ C$ , unless otherwise noted)

Symbol	Parameter	Alternate symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_C$	Clock CLK cycle time	TCLCL		100			ns
$t_{w(CLKL)}$	Clock CLK low pulse width	TCLCH		50			ns
$t_{w(CLKH)}$	Clock CLK high pulse width	TCHCL		30			ns
$t_{su}(\overline{S_0}\sim\overline{S_2})$	$\overline{S_0}\sim\overline{S_2}$ setup time with respect to T for the $T_1$ state	TSVCH		35			ns
$t_h(\overline{S_0}\sim\overline{S_2})$	$\overline{S_0}\sim\overline{S_2}$ hold time with respect to T for the $T_4$ state	TCHSV		10			ns
$t_{su}(\overline{S_0}\sim\overline{S_2})$	$\overline{S_0}\sim\overline{S_2}$ setup time with respect to T for the $T_3$ state	TSHCL		35			ns
$t_h(\overline{S_0}\sim\overline{S_2})$	$\overline{S_0}\sim\overline{S_2}$ hold time with respect to T for the $T_3$ state	TCLSH		10			ns
$t_r$	Input rise time	TILIH				20	ns
$t_f$	Input fall time	TIHIL				12	ns

BUS CONTROLLER FOR 8086/8088/8089 PROCESSORS

Note 1 : Test Circuit

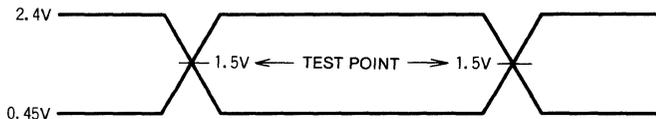


3

Note 2

Load circuit	$t_{PLH}, t_{PHL}$	$t_{PLZ}, t_{PZL}$	$t_{PHZ}, t_{PZH}$
Command output load circuit			
Control output load circuit		---	---

Note 3 : AC TEST WAVE FORM

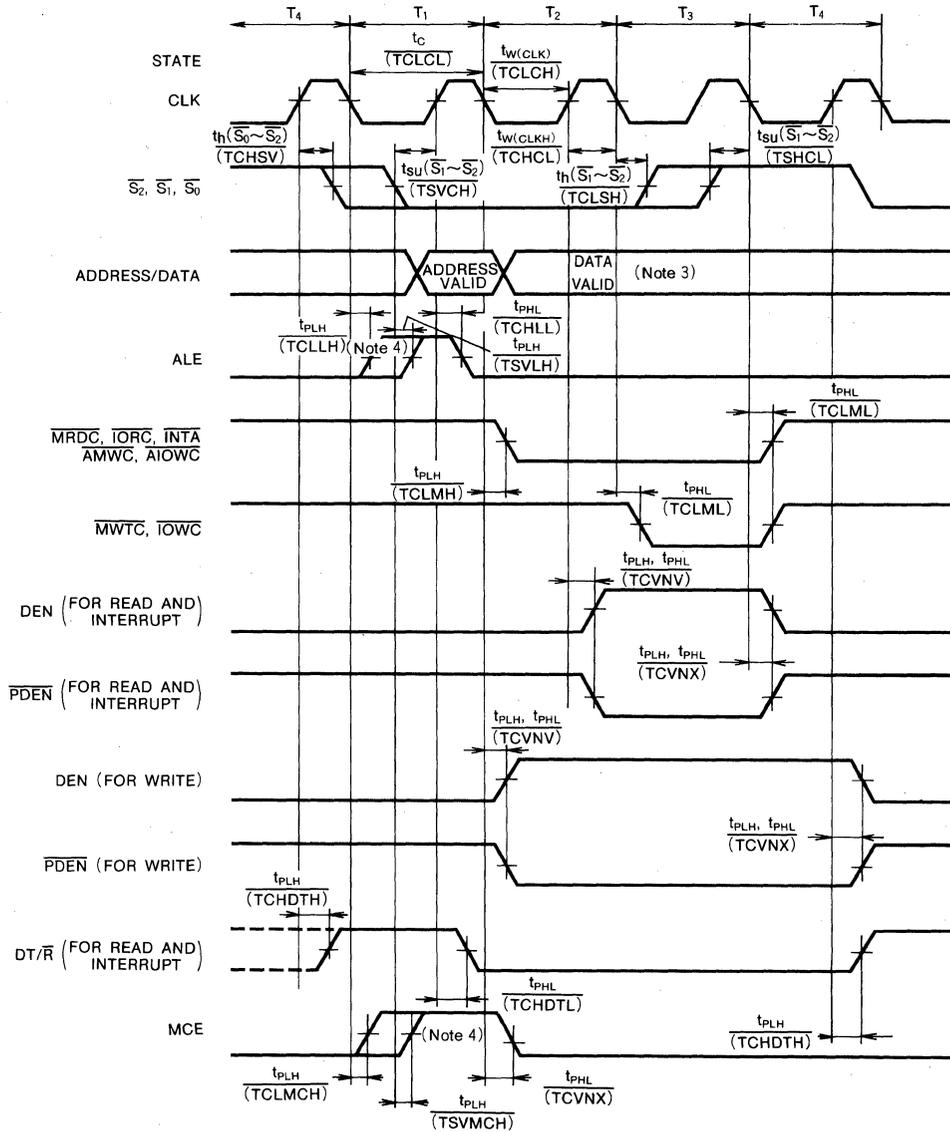


INPUT PULSE LEVEL : 0.45~2.4V

TIMING MEASUREMENT POINT : 1.5V

**TIMING DIAGRAM**

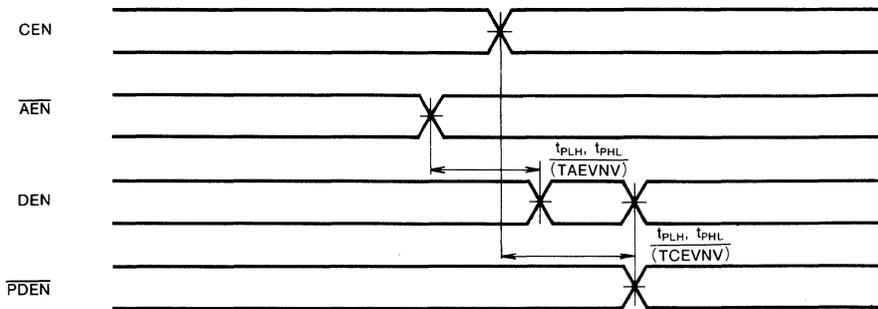
**1. Command output timing**



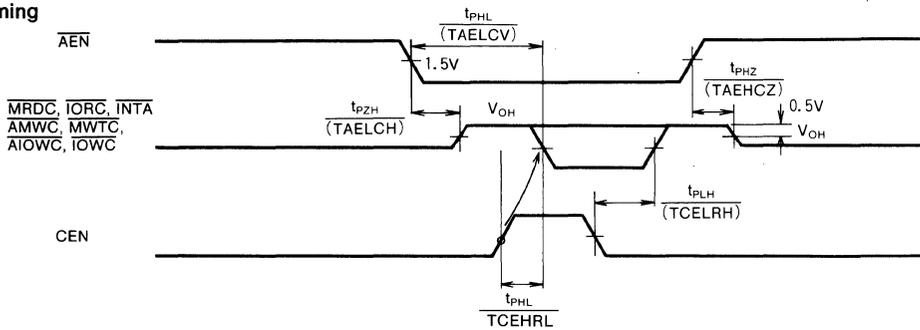
Note 3 : The address/data bus signals are shown only for reference.  
 4 : The ALE and MCE leading edge occurs in synchronization with the falling edge of CLK or  $\overline{S_0} \sim \overline{S_2}$ , whichever is later.  
 5 : Unless otherwise noted, the timing of all signals is respect to 1.5V

BUS CONTROLLER FOR 8086/8088/8089 PROCESSORS

2. DEN and PDEN timing

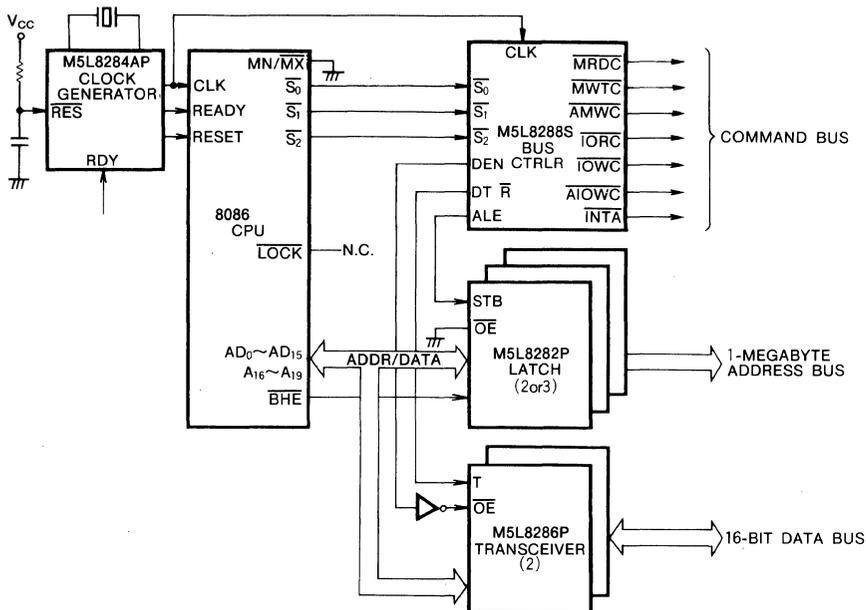


3. AEN timing



Note 6 : CEN must be low or valid prior to T<sub>2</sub> to prevent the command from being generated.

APPLICATION EXAMPLE



**BUS ARBITER FOR 8086/8088/8089 PROCESSORS**

**DESCRIPTION**

The M5L8289P is a system bus (®MULTIBUS) arbiter for the 8086, 8088, and 8089 16-bit microprocessors. When a request for access to the system bus is made by any of these microprocessors, the M5L8289P prevents simultaneous access by two or more processors by allowing only the first processor which requests access to access the system, preventing all others from accessing the system bus. It generates the required signals for bus access. (®MULTIBUS is a registered trademark of Intel Corporation.)

**FEATURES**

- ®MULTIBUS compatible
- Usable in multiprocessing systems using the 8086, 8088, and 8089 microprocessors
- Four modes of request and bus surrender are possible
- Low power dissipation

**APPLICATION**

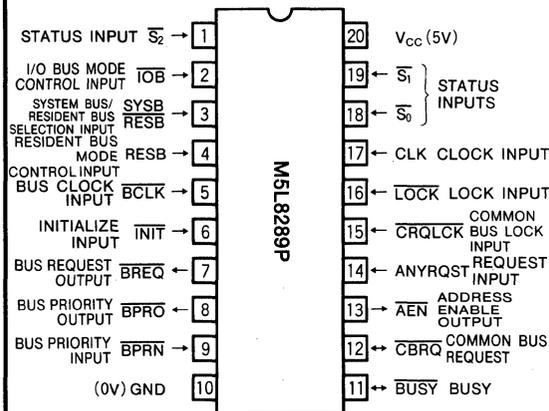
Bus arbitration for MULTIBUS boards using the 8088, 8086, or 8089

**FUNCTION**

The M5L8289P is a bus arbiter for ®MULTIBUS boards using the 8086, 8088, or 8089 microprocessors. When several processors are connected to the system bus (®MULTIBUS), it is necessary to prevent two or more processors from attempting to access the system bus simultaneously.

This function is performed by the M5L8289P, which decodes the processor status, and if access to the system bus

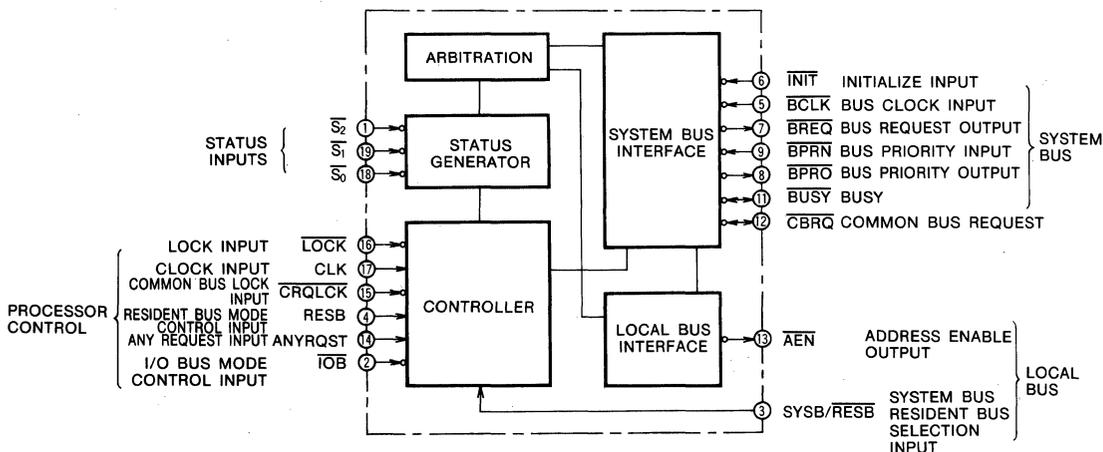
**PIN CONFIGURATION (TOP VIEW)**



Outline 20P4

is required, prevents other processors from attempting system bus access by generating the required control signals.

**BLOCK DIAGRAM**



**FUNCTIONAL DESCRIPTION**

The M5L8289P decodes the status signals  $\overline{S_0} \sim \overline{S_2}$  from the processor, and requests system bus privileges or surrenders them. The conditions for such operation are shown in Table 1. As shown in the Table 1, the following four modes are possible for use with boards of various types.

**(1) Single Bus Mode**

In this mode there is neither memory nor I/O ports on the board, and the processor accesses only the system bus.

**(2) I/O Bus Mode**

In this mode I/O ports exist on the board, and the processor accesses only these. For this mode the M5L8289P outputs a system bus request signal only for memory access.

**(3) Resident Bus Mode**

In this mode both memory and/or I/O port(s) exist on the board and the processor can access both on the system bus. In this mode the chip select signal (active low) for I/O ports and memory on the system bus is input to SYSB/RESB. By doing this, when the I/O port(s) and memory on the board are accessed, the M5L8289P does not output a request signal to the system bus.

**(4) I/O Bus Mode Resident Bus Mode**

In this mode both I/O ports and memory are existent on the board, and only the I/O port on the board is accessed.

In this mode the chip select signal (active low) for memory on the board is input to SYSB/RESB. By doing this, the M5L8289P outputs a request signal to the system bus when system memory is accessed.

In addition, the M5L8289P has the following control inputs.

● **LOCK**

This signal locks the bus arbitrate function when it is low, the M5L8289P continues to output a request signal to the system bus, and once acquired, setting  $\overline{LOCK}$  to a high level retains bus privileges until the conditions listed in Table 1 are satisfied. Normally, this input is connected to the  $\overline{LOCK}$  output of the processor.

● **CRQLCK**

This signal locks the arbitrate function by CBRQ. When set to low, the bus privilege surrender conditions listed in Table 1 in which CBRQ are input, are ignored. This input is set to low level when it is desired to prevent low-priority arbiters from acquiring bus privileges:

● **ANYRQST**

Even after one bus access has been completed, the M5L8289P does not surrender bus privileges until the surrender conditions listed in Table 1 are satisfied. However, by setting the ANYRQST input to high, the bus can be freed after each single access, thereby facilitating the acquisition of bus privileges by low-priority arbiters.

BUS ARBITER FOR 8086/8088/8089 PROCESSORS

Table 1 M5M8289P Modes and Bus Request and surrender Conditions

Status		I/O Bus mode only	Resident bus mode only		I/O Bus mode resident bus mode		Single bus mode
Command	S <sub>2</sub> S <sub>1</sub> S <sub>0</sub>	IOB=L RESB=L	IOB=H RESB=H		IOB=L RESB=H		IOB=H RESB=L
			SYSB/ $\overline{\text{RESB}}=H$	SYSB/ $\overline{\text{RESB}}=H$	SYSB/ $\overline{\text{RESB}}=H$	SYSB/ $\overline{\text{RESB}}=L$	
Interrupt acknowledge	0 0 0	×	○	×	×	×	○
I/O Port read	0 0 1	×	○	×	×	×	○
I/O Write	0 1 0	×	○	×	×	×	○
Halt	0 1 1	×	×	×	×	×	×
Instruction fetch	1 0 0	○	○	×	○	×	○
Memory read	1 0 1	○	○	×	○	×	○
Memory write	1 1 0	○	○	×	○	×	○
Passive cycle	1 1 1	×	×	×	×	×	×

○ ..... A request signal is output by the system bus.  
 X ..... The system bus privileges are surrendered.

Mode	Input		Bus request condition (excluding halt and passive cycles)	Bus surrender condition (Note 1)
	IOB	RESB		
Single bus mode	H	L	All bus access states	HLT+(TI-CBRQ)+HPBRQ
Resident bus mode only	H	H	(SYSB/ $\overline{\text{RESB}}=high$ )·(Bus access state)	((SYSB/ $\overline{\text{RESB}}=L+T1$ )·CBRQ)+HLT+HPBRQ
I/O Bus mode only	L	L	All memory access states	(I/O Access state+T1)·CBRQ)+HLT+HPRQ
I/O Bus mode resident bus mode	L	H	(SYSB/ $\overline{\text{RESB}}=high$ )·(Memory access states)	((I/O Access state+(SYSB/ $\overline{\text{RESB}}=low$ ))·CBRQ + HPBRQ HLT +HPBRQ

Note 1 : When  $\overline{\text{LOCK}}=low$ , the bus is not released under any circumstances.  
 When  $\overline{\text{CRQLCK}}=low$ , the bus is not released even when low-priority arbiters request it.  
 2 : HLT.....Halt state  
 TI.....Idle (passive) state  
 CBRQ.....CBRQ=low  
 HPBRQ .....Indicates that a high-priority arbiter is requesting the bus ( $\overline{\text{BPRN}}=high$ )

## BUS ARBITER FOR 8086/8088/8089 PROCESSORS

## PIN DESCRIPTION

Pin	Name	Input or output	Function
$\overline{S_0}, \overline{S_1}, \overline{S_2}$	Status input	In	Status input from the processor. The M5L8289P decodes this signal and based on it, requests or surrenders bus privileges.
CLK	Clock input	In	This is the same clock input as used on the processor, and used for decoding of the status. It receives the clock from the M5L8284P.
$\overline{LOCK}$	Lock input	In	This is the lock input signal from the processor. When $\overline{LOCK}$ =low, the M5L8289P will, in no circumstances, surrender bus privileges.
$\overline{CRQLCK}$	Common bus request lock input	In	This is the lock signal for arbitration from a common bus request. When $\overline{CRQLCK}$ =low, the M5L8289P ignores bus surrendering conditions by signal CBRQ.
RESB	Resident bus mode control input	In	This is the M5L8289P mode setting input. When RESB=high, the M5L8289P is in the resident bus mode.
$\overline{IOB}$	I/O Bus mode control input	In	This is an M5L8289P mode setting input. When $\overline{IOB}$ =low, the M5L8289P is in the I/O bus mode.
ANYRQST	Any request input	In	This controls the bus surrendering conditions for the M5L8289P. When ANYRQST=low, the M5L8289P releases the bus under the conditions listed in Table 1. When ANYRQST=high, as soon as $\overline{CBRQ}$ goes low, the bus is released. Therefore, by setting ANYRQST to high and $\overline{CBRQ}$ to low, the M5L8289P can be made to release the bus after a single access.
SYSB/ RESB	System bus/resident bus selection input	In	This input is valid when the M5L8289P is in the resident bus mode. When SYSB/ $\overline{RESB}$ =low, this means that the processor is accessing the bus on the board, and the M5L8289P does not output a request to the system bus. When SYSB/ $\overline{RESB}$ =high, this indicates that the processor is accessing the system bus, and the M5L8289P outputs the request signal to the system bus.
$\overline{BCLK}$	Bus lock input	In	This is the clock for arbitration of other boards. The M5L8289P performs arbitration in synchronous with this clock. It is fed from the system bus $\overline{BCLK}$ signal.
$\overline{INIT}$	Initialize input	In	This line resets the arbitration circuit. Immediately after resetting, none of the arbiters have system bus privileges. This input is fed from the system bus $\overline{INIT}$ signal.
$\overline{BREQ}$	Bus request output	Out	This signal requests system bus privileges. It is used as the system bus $\overline{BREQ}$ signal.
$\overline{BPRN}$	Bus priority input	In	This signal indicates whether a high-priority arbiter has requested privileges or not. When $\overline{BPRN}$ =low, a high-priority arbiter has not requested privileges and when $\overline{BPRN}$ =high, this indicates that a high-priority arbiter has requested privileges. This input is fed from the system bus $\overline{BPRN}$ signal.
$\overline{BPRO}$	Bus priority output	Out	This signal indicates whether the M5L8289P or high-order arbiter has requested the bus. When $\overline{BPRO}$ =low, there was a bus request and when $\overline{BPRO}$ =high, there was no bus request. This signal is used as the system bus $\overline{BPRO}$ signal.
$\overline{BUSY}$	Busy	In/Out	This signal indicates that the system bus has been acquired. When $\overline{BUSY}$ =low, the bus is busy and when $\overline{BUSY}$ =high, it indicates that no arbiter has acquired the bus privileges. When the M5L8289P has acquired bus privileges, a low-level output (open collector) is made. This signal is used as the system bus $\overline{BUSY}$ signal.
$\overline{CBRQ}$	Common bus request	In/Out	This signal indicates when any arbiter has requested the system bus. When $\overline{CBRQ}$ =low, the M5L8289P releases the bus according to the conditions listed in Table 1. When making a request of the system bus, $\overline{CBRQ}$ is output as low (open collector). This signal is used as the system bus $\overline{CBRQ}$ signal.
$\overline{AEN}$	Address enable input	Out	This signal informs the bus buffer on the board that the system bus has been acquired. It is connected to the address and data buffer outputs, and the output enable line on the board as well as the M5L8288P $\overline{AEN}$ line.

**BUS ARBITER FOR 8086/8088/8089 PROCESSORS**

**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Conditions	Limits	Unit
V <sub>CC</sub>	Supply voltage		-0.5~7	V
V <sub>I</sub>	Input voltage		-1~5.5	V
V <sub>O</sub>	Output voltage		-0.5~7	V
T <sub>opr</sub>	Operating temperature		0~75	°C
T <sub>stg</sub>	Storage temperature		-65~150	°C

**RECOMMENDED OPERATING CONDITIONS** (T<sub>a</sub>=0~75°C, unless otherwise noted)

Symbol	Parameter		Limits			Unit
			Min	Nom	Max	
V <sub>CC</sub>	Supply voltage		4.5	5	5.5	V
I <sub>OH</sub>	High-level output current	BUSY, CBRQ, V <sub>OH</sub> ≥2.4V	Open collector			
		Other output, V <sub>OH</sub> ≥2.4V	0		400	μA
I <sub>OL</sub>	Low-level output current	BUSY, CBRQ, V <sub>OL</sub> ≤0.45V	0		20	mA
		AEN, V <sub>OL</sub> ≤0.45V	0		16	mA
		BPRO, BREQ, V <sub>OL</sub> ≤0.45V	0		10	mA

**ELECTRICAL CHARACTERISTICS** (T<sub>a</sub>=0~75°C, V<sub>CC</sub>=5V±10%, unless otherwise noted)

Symbol	Parameter		Test conditions	Limits			Unit
				Min	Typ	Max	
V <sub>IL</sub>	Low-level input voltage					0.8	V
V <sub>IH</sub>	High-level input voltage			2.0			V
V <sub>OL</sub>	Low-level output voltage	BUSY, CBRQ	I <sub>OL</sub> =20mA			0.45	V
		AEN	I <sub>OL</sub> =16mA			0.45	V
		BPRO, BREQ	I <sub>OL</sub> =10mA			0.45	V
V <sub>OH</sub>	High-level output voltage	BUSY, CBRQ		Open collector			V
		AEN, BPRO, BREQ	I <sub>OH</sub> =400μA	2.4			V
V <sub>IC</sub>	Input clamp voltage		V <sub>CC</sub> =4.50V, I <sub>C</sub> =-5mA			-1	V
I <sub>IL</sub>	Low-level input current		V <sub>CC</sub> =5.50V, V <sub>F</sub> =0.45V			-0.5	mA
I <sub>IH</sub>	High-level input current		V <sub>CC</sub> =5.50V, V <sub>R</sub> =5.50V			60	μA
I <sub>CC</sub>	Supply current					120	mA

## BUS ARBITER FOR 8086/8088/8089 PROCESSORS

TIMING REQUIREMENT ( $T_a=0\sim 75^\circ\text{C}$ ,  $V_{CC}=5V\pm 10\%$ , unless otherwise noted)

Symbol	Parameter	Alternate symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{C(CLK)}$	CLK cycle period	$t_{CLCL}$		125			ns
$t_{W(CLKL)}$	CLK"L" pulse width	$t_{CLCH}$		65			ns
$t_{W(CLKH)}$	CLK"H" pulse width	$t_{CHCL}$		35			ns
$t_{SU}(\overline{S0}\sim\overline{S2})$	Status active setup time	$t_{SVCH}$		65		$t_{CLCL}\cdot 10$	ns
$t_{H}(\overline{S0}\sim\overline{S2})$	Status active hold time	$t_{CHSV}$		10		$t_{CLCL}\cdot 10$	ns
$t_{SU}(\overline{S0}\sim\overline{S2})$	Status inactive setup time	$t_{SHCL}$		50			ns
$t_{H}(\overline{S0}\sim\overline{S2})$	Status inactive hold time	$t_{CLSH}$		10			ns
$t_{H}(LOCK)$	LOCK inactive hold time	$t_{CLLL1}$		10			ns
$t_{SU}(LOCK)$	LOCK active setup time	$t_{CLLL2}$		40			ns
$t_{SU}(SYSB/\overline{RESB})$	SYSB/ $\overline{RESB}$ setup time	$t_{CLSR1}$		0			ns
$t_{H}(SYSB/\overline{RESB})$	SYSB/ $\overline{RESB}$ hold time	$t_{CLSR2}$		20			ns
$t_{C}(\overline{BCLK})$	$\overline{BCLK}$ cycle time	$t_{BLBL}$		100			ns
$t_{W}(\overline{BCLKH})$	$\overline{BCLK}$ "H" pulse width	$t_{BHBL}$		30			ns
$t_{SU}(\overline{BPRU})$	$\overline{BPRN} \uparrow \downarrow$ to $\overline{BCLK} \downarrow$ setup time	$t_{PNSBL}$		15			ns
$t_{SU}(\overline{BUSY})$	$\overline{BUSY} \uparrow \downarrow$ to $\overline{BCLK} \downarrow$ setup time	$t_{BYSBL}$		20			ns
$t_{SU}(\overline{CBRQ})$	$\overline{CBRQ} \uparrow \downarrow$ to $\overline{BCLK} \downarrow$ setup time	$t_{CBSBL}$		20			ns
$t_{W}(INIT)$	INIT pulse width	$t_{IVIH}$		$3t_{BLBL}+3t_{CLCL}$			ns
$t_r$	Input rise time	$t_{ILIH}$	0.8~2V			20	ns
$t_f$	Input fall time	$t_{IHIL}$	2~0.8V			12	ns

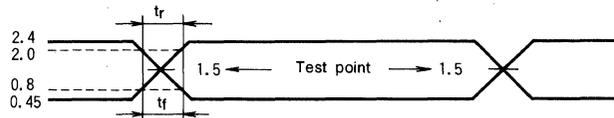
BUS ARBITER FOR 8086/8088/8089 PROCESSORS

SWITCHING CHARACTERISTICS ( $T_a=0\sim75^\circ\text{C}$ ,  $V_{CC}\pm 5V\pm 5\%$ , unless otherwise noted)

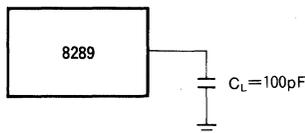
Symbol	Parameter	Alternate symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{PHL}(\overline{BREQ})$	$\overline{BCLK}\rightarrow\overline{BREQ}$ $\uparrow, \downarrow$ Delay time	$t_{BLBRL}$				35	ns
$t_{PLH}(\overline{BPRO})$	$\overline{BCLK}\rightarrow\overline{BPRO}$ $\uparrow, \downarrow$ Delay time (See note 2)	$t_{BLPOH}$				40	ns
$t_{PHL}(\overline{BPRO})$	$\overline{BPRN}$ $\uparrow, \downarrow\rightarrow\overline{BPRO}$ $\uparrow, \downarrow$ Delay time (See note 2)	$t_{PNPO}$				25	ns
$t_{PHL}(\overline{BUSY})$	$\overline{BCLK}\rightarrow\overline{BUSY}$ $\downarrow$ Delay time	$t_{BLBYL}$				60	ns
$t_{PLZ}(\overline{BUSY})$	$\overline{BCLK}\rightarrow\overline{BUSY}$ Float time (See note 3)	$t_{BLBYH}$				35	ns
$t_{PLH}(\overline{AEN})$	$\overline{CLK}\rightarrow\overline{AEN}$ $\uparrow$ Delay time	$t_{CLAEH}$				65	ns
$t_{PHL}(\overline{AEN})$	$\overline{BCLK}\rightarrow\overline{AEN}$ $\downarrow$ Delay time	$t_{BLAEL}$				40	ns
$t_{PHL}(\overline{CBRQ})$	$\overline{BCLK}\rightarrow\overline{CBRQ}$ $\downarrow$ Delay time	$t_{BLCBL}$				60	ns
$t_{PLZ}(\overline{CBRQ})$	$\overline{BCLK}\rightarrow\overline{CBRQ}$ Delay time (See note 3)	$t_{BLCBH}$				35	ns
$t_r$	Output rise time	$t_{OLOH}$	0.8V~2.0V			20	ns
$t_f$	Output fall time (See note 4, 5)	$t_{OHOL}$	2.0V~0.8V			12	ns

- Note 1 : Symbol  $\uparrow, \downarrow$  means rise signal and fall signal.
- Note 2 :  $\overline{BCLK}$  generate the first  $\overline{BPRO}$  and then  $\overline{BPRO}$  changes lower in the chain are generated through  $\overline{BPRN}$ .
- Note 3 : Measured at 0.5V above GND

Note 4 : A.C. test wave form.

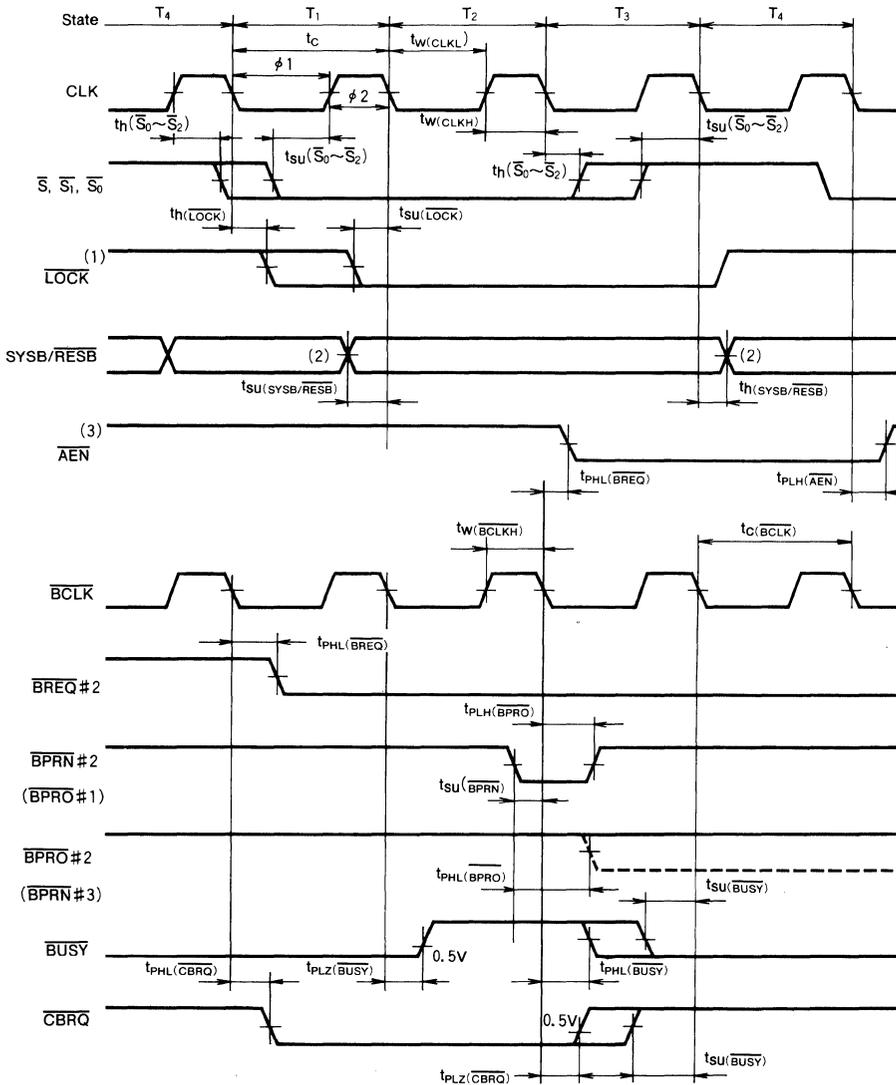


Note 5 : Load circuit



BUS ARBITER FOR 8086/8088/8089 PROCESSORS

TIMING DIAGRAM



- Note 1 : LOCK can be active during any state as long as the relationships shown above with the respect to CLK are maintained.  
 LOCK can be inactive asynchronously.  
 CRQLCK is an asynchronous input signal.
- 2 : Noise is permitted during this time. After φ<sub>2</sub> of T<sub>1</sub> and before φ<sub>1</sub> of T<sub>4</sub> should be stable.
- 3 : AEN negative-edge is related to CLK, positive-edge to CLK.  
 AEN positive-edge is generated after asricity is lost.

3



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# NMOS PERIPHERAL CIRCUITS

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**2048-BIT STATIC RAM WITH I/O PORTS AND TIMER**

**DESCRIPTION**

The M5L8155P is a 2K-bit RAM (256-word by 8-bit) fabricated with the Nchannel silicon-gate ED-MOS technology. This IC has 3 I/O ports and a 14-bit counter/timer which make it a good choice to extend the functions of an 8-bit microcomputer. It is incased in a 40-pin plastic DIL package and operates with a single 5V power supply.

**FEATURES**

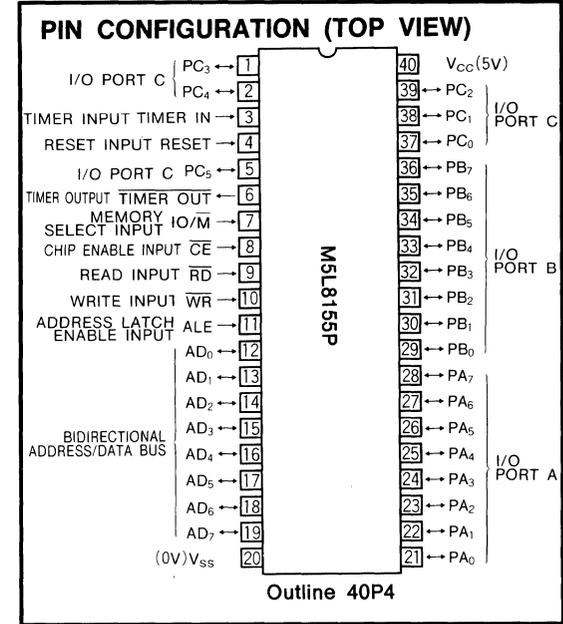
- Single 5V supply voltage
- TTL compatible
- Compatible with MELPS 85 devices
- Static RAM: 256 words by 8 bits
- Programmable 8-bit I/O port: 2
- Programmable 6-bit I/O port: 1
- Programmable counter/timer: 14 bits
- Multiplexed address/data bus

**APPLICATION**

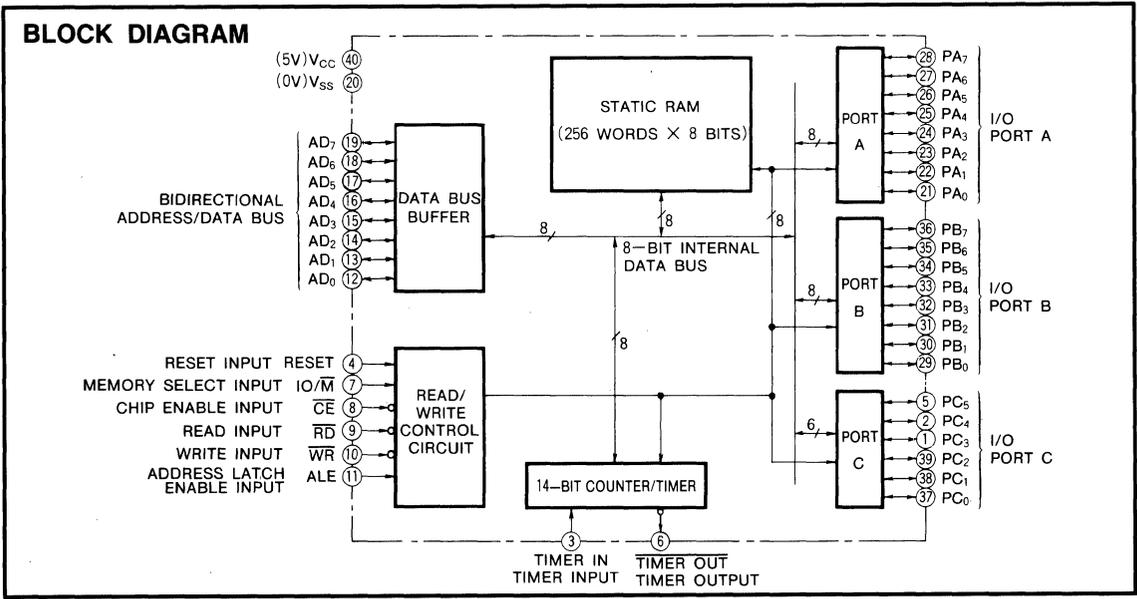
Extension of I/O ports and timer function for MELPS 85 and MELPS 8-48 devices

**FUNCTION**

The M5L8155P is composed of RAM, I/O ports and counter/timer. The RAM is a 2K-bit static RAM organized as 256 words by 8 bits. The I/O ports consist of 2 programmable 8-bit ports and 1 programmable 6-bit port. The terminals of the 6-bit port can be programmed to function as control terminals for the 8-bit ports, so that the 8-bit ports can be operated



in a handshake mode. The counter/timer is composed of 14 bits that can be used to count down (events or time) and it can generate square wave pulses that can be used for counting and timing.



2048-BIT STATIC RAM WITH I/O PORTS AND TIMER

**OPERATION**

**Data Bus Buffer**

This 3-state bidirectional 8-bit buffer is used to transfer the data while input or output instructions are being executed by the CPU. Command and address information is also transferred through the data bus buffer.

**Read/Write Control Logic**

The read/write control logic controls the transfer of data by interpreting I/O control bus output signals ( $\overline{RD}$ ,  $\overline{WR}$ ,  $IO/\overline{M}$  and ALE) along with CPU signal ( $\overline{CE}$ ). RESET signal is also used to control the transfer of data and commands.

**Bidirectional Address/Data Bus ( $AD_0 \sim AD_7$ )**

The bidirectional address/data bus is a 3-state 8-bit bus. The 8-bit address is latched in the internal latch by the falling edge of ALE. Then if  $IO/\overline{M}$  input signal is at high-level, the address of I/O port, counter/timer, or command register is selected. If it is at low-level, memory address is selected.

The 8-bit address data is transferred by read input ( $\overline{RD}$ ) or write input ( $\overline{WR}$ ).

**Chip Enable Input ( $\overline{CE}$ )**

When  $\overline{CE}$  is at low-level, the address information on address/data bus is stored in the M5L8155P

**Read Input ( $\overline{RD}$ )**

When  $\overline{RD}$  is at low-level the data bus buffer is active. If  $IO/\overline{M}$  input signal is at low-level, the contents of RAM are read through the address/data bus. If  $IO/\overline{M}$  input is at high-level, the selected contents of I/O port or counter/timer are read through the address/data bus.

**Write Input ( $\overline{WR}$ )**

When  $\overline{WR}$  is at low-level, the data on the address/data bus are written into RAM if  $IO/\overline{M}$  is at low-level, or if  $IO/\overline{M}$  is at high-level they are written into I/O port, counter/timer or command register.

**Address Latch Enable Input (ALE)**

An address on the address/data bus along with the levels of  $\overline{CE}$  and  $IO/\overline{M}$  are latched in the M5L8155P on the falling edge of ALE.

**IO/Memory Input ( $IO/\overline{M}$ )**

When  $IO/\overline{M}$  is at low-level, the RAM is selected, while at high-level the I/O port, counter/timer or command register are selected.

**I/O Port A ( $PA_0 \sim PA_7$ )**

Port A is an 8-bit general-purpose I/O port. Input/output setting is controlled by the system software.

**I/O Port B ( $PB_0 \sim PB_7$ )**

Port B is an 8-bit general-purpose I/O port. Input/output setting is controlled by the system software.

**I/O Port C ( $PC_0 \sim PC_5$ )**

Port C is a 6-bit I/O port that can also be used to output control signals of port A (PA) or port B (PB). The functions of port C are controlled by the system software. When port C is used to output control signals of ports A or B the assignment of the signals to the pins is as shown in Table 1.

Table 1 Pin assignment of control signals of port C

Pin	Function
PC <sub>5</sub>	B STB (port B strobe)
PC <sub>4</sub>	B BF (port B buffer full)
PC <sub>3</sub>	B INTR (port B interrupt)
PC <sub>2</sub>	A STB (port A strobe)
PC <sub>1</sub>	A BF (port A buffer full)
PC <sub>0</sub>	A INTR (port A interrupt)

**Timer Input (TIMER IN)**

The signal at this input terminal is used by the counter/timer for counting events or time. (3MHz max.)

**Timer Output (TIMER OUT)**

A square wave signal or pulse from the counter/timer is output through this pin when in the operation mode.

**Command Register (8 bits)**

The command register is an 8-bit latched register. The lower 4 bits (bits 0~3) are used for controlling and determination of mode of the ports. Bits 4 and 5 are used as interrupt enable flags for ports A and B when port C is used as a control port. Bits 6 and 7 are used for controlling the counter/timer. The contents of the command register are rewritten by output instructions (address I/O XXXXX000).

Details of the functions of the individual bits of the command register are shown in Table 2.

Table 2 Bit functions of the command register

Bit	Symbol	Function
0	PA	PORT A I/O FLAG 1: OUTPUT PORT A 0: INPUT PORT A
1	PB	PORT B I/O FLAG 1: OUTPUT PORT B 0: INPUT PORT B
2	PC <sub>1</sub>	PORT C FLAG 00: ALT1 11: ALT2 01: ALT3 10: ALT4
3	PC <sub>2</sub>	
4	IEA	PORT A INTERRUPT ENABLE FLAG 1: ENABLE INTERRUPT 0: DISABLE INTERRUPT
5	IEB	PORT B INTERRUPT ENABLE FLAG 1: ENABLE INTERRUPT 0: DISABLE INTERRUPT
6	TM1	COUNTER/TIMER CONTROL 00: NO INFLUENCE ON COUNTER/TIMER OPERATION 01: COUNTER/TIMER OPERATION DISCONTINUED (IF NOT ALREADY STOPPED) 10: COUNTER/TIMER OPERATION DISCONTINUED AFTER THE CURRENT COUNTER/TIMER OPERATION IS COMPLETED 11: COUNTER/TIMER OPERATION STARTED
7	TM2	

**2048-BIT STATIC RAM WITH I/O PORTS AND TIMER**

**Status Register (7 bits)**

The status register is a 7-bit latched register. The lower order 5 bits (bits 0~4) are used as status flags for the I/O ports. Bit 6 is as a status flag for the counter/timer. The contents of

the status register are transferred into the CPU by reading (INPUT instruction, address I/O XXXXX000). Details of the functions of the individual bits of the status register are shown in Table 3.

**Table 3 Bit functions of the status register**

Bit	Symbol	Function
0	INTR A	PORT A INTERRUPT REQUEST
1	A BF	PORT A BUFFER FULL FLAG
2	INTE A	PORT A INTERRUPT ENABLE
3	INTR B	PORT B INTERRUPT REQUEST
4	B BF	PORT B BUFFER FULL FLAG
5	INTE B	PORT B INTERRUPT ENABLE
6	TIMER	COUNTER/TIMER INTERRUPT (SET TO 1 WHEN THE FINAL LIMIT OF THE COUNTER/TIMER IS REACHED AND IS RESET TO 0 WHEN THE STATUS IS READ)
7	—	THIS BIT IS NOT USED

**I/O Ports**

**Command/status registers (8 bits/7 bits)**

These registers are assigned address XXXXX000. When executing an OUTPUT instruction, the contents of the command register are rewritten. When executing an INPUT instruction the contents of the status register are read.

**Port A Register (8 bits)**

Port A Register is assigned address XXXXX001. This register can be programmed as an input or output by setting the appropriate bits of the command register as shown in Table 2.

Port A can be operated in basic or strobe mode and is assigned I/O terminal PA<sub>0</sub>~PA<sub>7</sub>.

**Port B Register (8 bits)**

Port B register is assigned address XXXXX010. As with Port A register, this register can be programmed as an input or output by setting the appropriate bits of the command register as shown in Table 2. Port B can be operated in basic or strobe mode and is assigned I/O terminals PB<sub>0</sub>~PB<sub>7</sub>.

**Port C Register (6 bits)**

Port C register is assigned address XXXXX011. This port is used for controlling input/output operations of ports A and B by selectively setting bits 2 and 3 of the command register as shown in Table 2. Details of the functions of the various setting of bits 2 and 3 are shown in Table 4. Port C is assigned I/O terminals PC<sub>0</sub>~PC<sub>5</sub> and when used as port control signals, the 3 low-order bits are assigned for port A while the 3 high-order bits are assigned for port B.

**Table 4 Functions of port C**

State Terminal	ALT 1	ALT 2	ALT 3	ALT 4
PC <sub>5</sub>	Input	Output	Output	B STB (port B strobe)
PC <sub>4</sub>	Input	Output	Output	B BF (port buffer full)
PC <sub>3</sub>	Input	Output	Output	B INTR (port B interrupt)
PC <sub>2</sub>	Input	Output	A STB (port A strobe)	A STB (port A strobe)
PC <sub>1</sub>	Input	Output	A BF (port A buffer full)	A BF (port A buffer full)
PC <sub>0</sub>	Input	Output	A INTR (port A interrupt)	A INTR (port A interrupt)

2048-BIT STATIC RAM WITH I/O PORTS AND TIMER

**Configuration of ports**

A block diagram of 1 bit of ports A and B is shown in Fig. 1. While port A or B is programmed as an output port, if the port is addressed by an input instruction, the contents of the selected port can be read. When a port is put in input mode, the output latch is cleared and writing into the output latch is

disabled. Therefore when a port is changed to output mode from input mode, low-level signals are output through the port. When a reset signal is applied, all 3 ports (PA, PB, and PC) will be input ports and their output latches are cleared. Port C has the same configuration as ports A and B in modes ALT1 and ALT2.

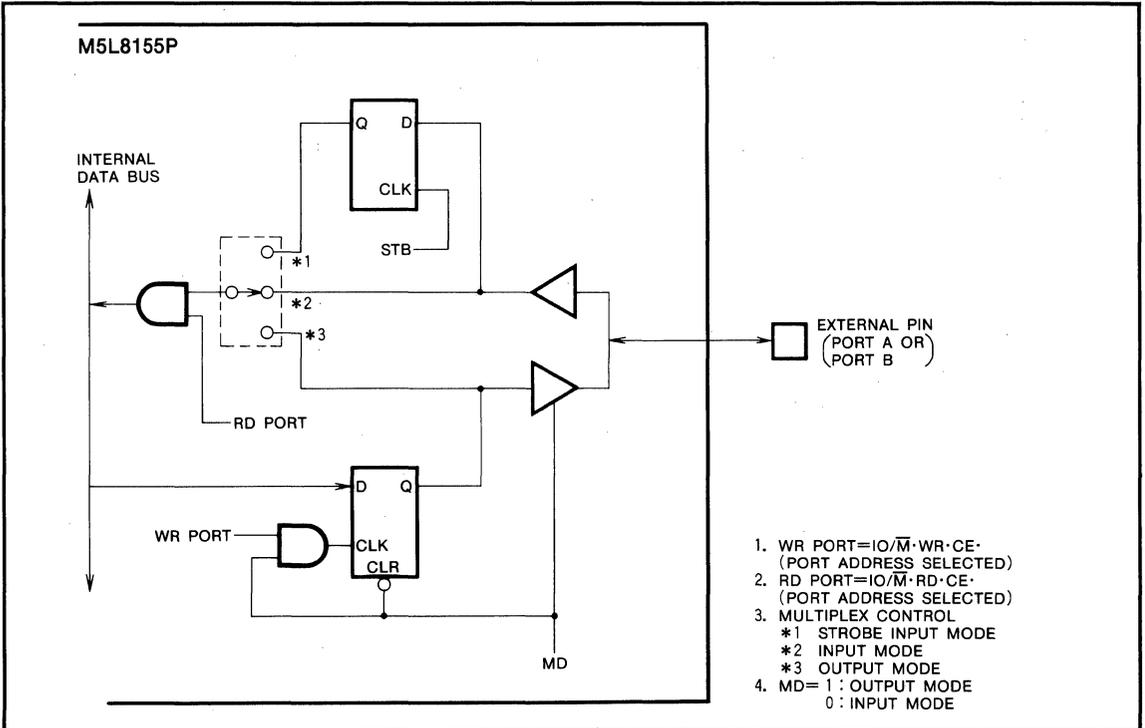


Fig. 1 Configuration for 1 bit of port A or B

Table 5 Basic functions of I/O ports

Address	$\overline{\text{RD}}$	$\overline{\text{WR}}$	Function
XXXXX000	0	1	AD bus ← status register
	1	0	Command register ← AD bus
XXXXX001	0	1	AD bus ← port A
	1	0	Port A ← AD bus
XXXXX010	0	1	AD bus ← port B
	1	0	Port B ← AD bus
XXXXX011	0	1	AD bus ← port C
	1	0	Port C ← AD bus

Table 6 Port control signal levels at ALT3 and ALT4

Control Signal	Output mode	Input mode
STB	Input	Input
BF	"L"	"L"
INTR	"H"	"L"

The basic functions of the I/O ports are shown in Table 5. The control signal levels to ports A and B, when port C is programmed as a control port, are shown in Table 6.

**Counter/Timer**

The counter/timer is a 14-bit counting register plus 2 mode flags. The register has two sections; address I/O XXXXX100 is assigned to the low-order 8 bits and address I/O XXXXX101 is assigned to the high-order 8 bits. The low-order bits 0~13 are used for counting or timing. The counter is initialized by the program and then counted down to zero. The initial setting can range from  $2_{16}$  to  $3FFF_{16}$ . Bits 14 and 15 are used as mode flags.

The mode flags select 1 of 4 modes with functions as follow:

- Mode 0: Outputs high-level signal during the former half of the counter operation  
Outputs low-level signal during the latter half of the counter operation

**2048-BIT STATIC RAM WITH I/O PORTS AND TIMER**

**Table 7 Format of counter/timer**

Address	Bit Number								Function
	7	6	5	4	3	2	1	0	
XXXXX100	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	T <sub>2</sub>	T <sub>1</sub>	T <sub>0</sub>	THE LOW-ORDER 8 BITS OF THE COUNTER REGISTER
XXXXX101	M <sub>2</sub>	M <sub>1</sub>	T <sub>13</sub>	T <sub>12</sub>	T <sub>11</sub>	T <sub>10</sub>	T <sub>9</sub>	T <sub>8</sub>	M1,M2: TIMER MODE T <sub>8</sub> ~T <sub>13</sub> : THE HIGH-ORDER 6 BITS OF THE COUNTER REGISTER

**Table 8 Timer mode**

M <sub>2</sub>	M <sub>1</sub>	Timer operation
0	0	Outputs high-level signal during the former half of the counter operation Outputs low-level signal during the latter half of the counter operation (mode 0)
0	1	Outputs square wave signals in mode 0 (mode 1)
1	0	Outputs a low-level pulse during the final count down (mode 2)
1	1	Outputs a low-level pulse during each final count down (mode 3)

Mode 1: Outputs square wave signals as in mode 0

Mode 2: Outputs a low-level pulse during the final count down

Mode 3: Outputs a low-level pulse during each final count down

Starting and stopping the counter/timer is controlled by bits 6 and 7 of the command register (see Table 2 for details). The format and timer modes of the counter/timer register are shown in Table 7 and Table 8.

The counter/timer is not influenced by a reset, but counting is discontinued. To resume counting, a start command must be written into the command register as shown in Table 2.

While operating 2n+1 count down in mode 0, a high-level signal is output during the n+1 counting and a low-level signal is output during the n counting.

**4**

**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Conditions	Limits	Unit
V <sub>CC</sub>	Supply voltage	With respect to V <sub>SS</sub>	-0.5~7	V
V <sub>I</sub>	Input voltage		-0.5~7	V
V <sub>O</sub>	Output voltage		-0.5~7	V
P <sub>d</sub>	Maximum power dissipation	T <sub>a</sub> =25°C	1.5	W
T <sub>opr</sub>	Operating free-air temperature range		-20~75	°C
T <sub>stg</sub>	Storage temperature range		-65~150	°C

**RECOMMENDED OPERATING CONDITIONS** (T<sub>a</sub>=-20~75°C, unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
V <sub>CC</sub>	Supply voltage	4.75	5	5.25	V
V <sub>SS</sub>	Power-supply voltage		0		V
V <sub>IL</sub>	Low-level input voltage	-0.5		0.8	V
V <sub>IH</sub>	High-level input voltage	2		V <sub>CC</sub> +0.5	V

**ELECTRICAL CHARACTERISTICS** (T<sub>a</sub>=-20~75°C, V<sub>CC</sub>=5V±5%, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
V <sub>OH</sub>	High-level output voltage	V <sub>SS</sub> =0V, I <sub>OH</sub> =-400μA	2.4			V
V <sub>OL</sub>	Low-level output voltage	V <sub>SS</sub> =0V, I <sub>OL</sub> =2mA			0.45	V
I <sub>I</sub>	Input leak current	V <sub>SS</sub> =0V, V <sub>I</sub> =0~V <sub>CC</sub>	-10		10	μA
I <sub>I(CE)</sub>	Input leak current, CE pin	V <sub>SS</sub> =0V, V <sub>I</sub> =0~V <sub>CC</sub>	-100		100	μA
I <sub>OZ</sub>	Output floating leak current	V <sub>SS</sub> =0V, V <sub>I</sub> =0.45~V <sub>CC</sub>	-10		10	μA
C <sub>i</sub>	Input capacitance	V <sub>IL</sub> =0V, f=1MHz, 25mVrms, T <sub>a</sub> =25°C			10	pF
C <sub>i/O</sub>	Input/output terminal capacitance	V <sub>I/OL</sub> =0V, f=1MHz, 25mVrms, T <sub>a</sub> =25°C			20	pF
I <sub>CC</sub>	Supply current from V <sub>CC</sub>	V <sub>SS</sub> =0V			180	mA

Note 1 : Current flowing into an IC is positive, out is negative.

2048-BIT STATIC RAM WITH I/O PORTS AND TIMER

**TIMING REQUIREMENTS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5\text{V} \pm 5\%$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{SU(A-L)}$	Address setup time before latch	$t_{AL}$		50			ns
$t_H(L-A)$	Address hold time after latch	$t_{LA}$		80			ns
$t_H(L-RWH)$	Read/write hold time after latch	$t_{LC}$		100			ns
$t_W(L)$	Latch pulse width	$t_{LL}$		100			ns
$t_H(RW-L)$	Latch hold time after read/write	$t_{CL}$		20			ns
$t_W(RWL)$	Read/write low-level pulse width	$t_{CC}$		250			ns
$t_{SU(D-W)}$	Data setup time before write	$t_{DW}$		150			ns
$t_H(W-D)$	Data hold time after write	$t_{WD}$		0			ns
$t_W(RWH)$	Read/write high-level pulse width	$t_{RV}$		300			ns
$t_{SU(P-R)}$	Port setup time before read	$t_{PR}$		70			ns
$t_H(R-P)$	Port hold time after read	$t_{RP}$		50			ns
$t_W(STB)$	Strobe pulse width	$t_{SS}$		200			ns
$t_{SU(P-STB)}$	Port setup time before strobe	$t_{PSS}$		50			ns
$t_H(STB-P)$	Port hold time after strobe	$t_{PHS}$		120			ns
$t_W(\neq H)$	Timer input high-level pulse width	$t_2$		120			ns
$t_W(\neq L)$	Timer input low-level pulse width	$t_1$		80			ns
$t_C(\neq)$	Timer input cycle time	$t_{CYC}$		320			ns
$t_r(\neq)$	Timer input rise time	$t_r$				30	ns
$t_f(\neq)$	Timer input fall time	$t_f$				30	ns

**SWITCHING CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5\text{V} \pm 5\%$ , unless otherwise noted.)

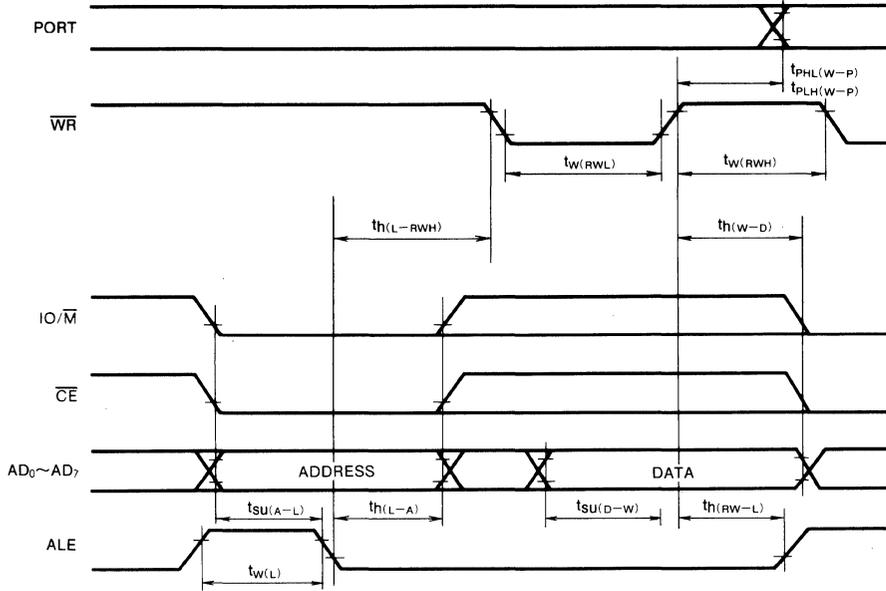
Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{PXV(R-DQ)}$	Propagation time from read to data output	$t_{RD}$				170	ns
$t_{PZX(A-DQ)}$	Propagation time from address to data output	$t_{AD}$				400	ns
$t_{PVZ(R-DQ)}$	Propagation time from read to data floating (Note 2)	$t_{RDF}$		0		100	ns
$t_{PHL(W-P)}$	Propagation time from write to data output	$t_{WDP}$				400	ns
$t_{PLH(W-P)}$		$t_{WLP}$					
$t_{PLH(STB-BF)}$	Propagation time from strobe to BF flag	$t_{SBF}$				400	ns
$t_{PHL(R-BF)}$	Propagation time from read to BF flag	$t_{RBE}$				400	ns
$t_{PLH(STB-INTR)}$	Propagation time from strobe to interrupt	$t_{SI}$				400	ns
$t_{PHL(R-INTR)}$	Propagation time from read to interrupt	$t_{RDI}$				400	ns
$t_{PHL(STB-BF)}$	Propagation time from strobe to BF flag	$t_{SBE}$				400	ns
$t_{PLH(W-BF)}$	Propagation time from write to BF flag	$t_{WBF}$				400	ns
$t_{PHL(W-INTR)}$	Propagation time from write to interrupt	$t_{WI}$				400	ns
$t_{PHL(\neq-OUT)}$	Propagation time from timer input to timer output	$t_{TL}$				400	ns
$t_{PLH(\neq-OUT)}$		$t_{TH}$					
$t_{PZX(R-DQ)}$	propagation time from read to data enable	$t_{RDE}$		10			ns

Note 1 : Measurement conditions C=150pF  
 2 : Measurement conditions of note 1 are not applied.

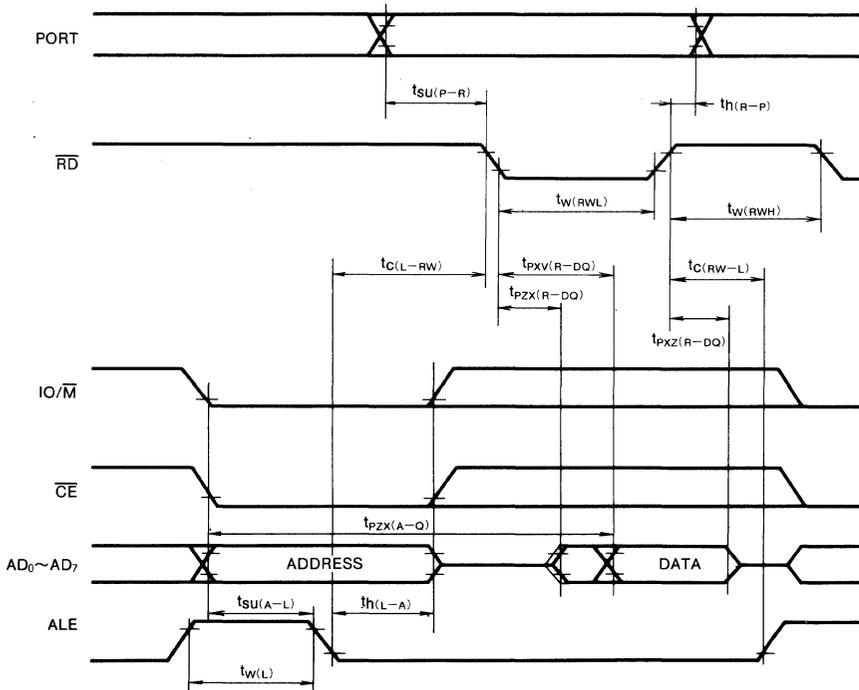
2048-BIT STATIC RAM WITH I/O PORTS AND TIMER

**TIMING DIAGRAM** (reference level, high-level=2V, low-level=0.8V)

**Basic output**



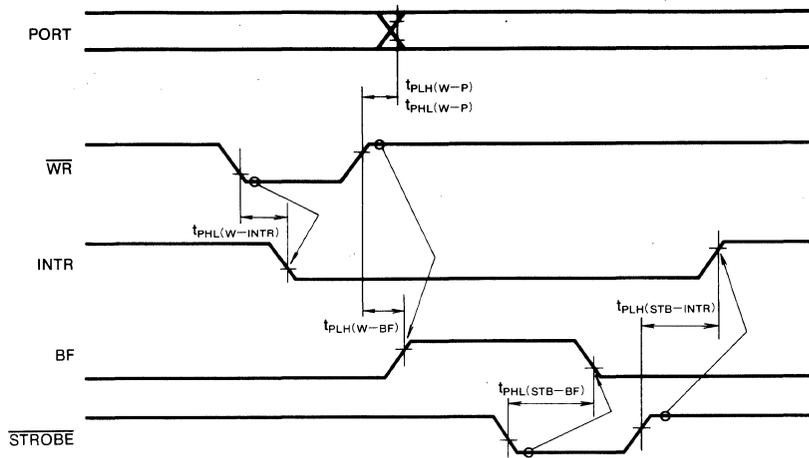
**Basic input**



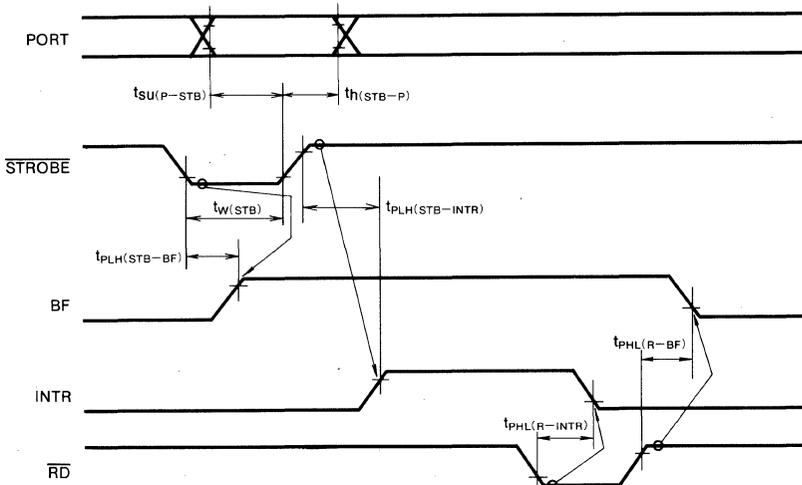
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2048-BIT STATIC RAM WITH I/O PORTS AND TIMER

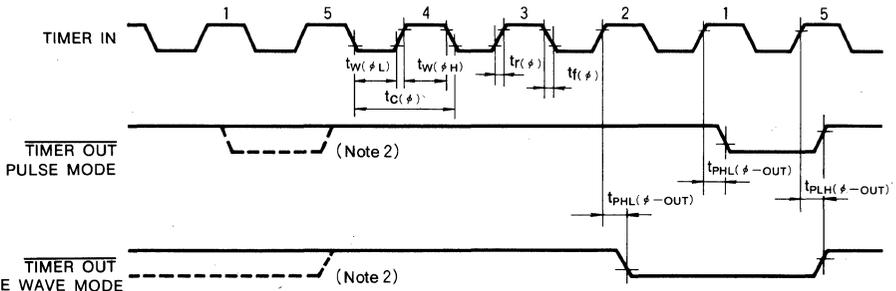
Strobed output



Strobed input



Timer (Note 1)



- Note 1 : The wave form is shown counting down from 5 to 1.
- 2 : As long as the M1 mode flag of the timer register is at high-level, pulses are continuously output.

**MITSUBISHI LSIs**  
**M5L8156P**

**2048-BIT STATIC RAM WITH I/O PORTS AND TIMER**

**DESCRIPTION**

The M5L8156P is a 2K-bit RAM (256-word by 8-bit) fabricated with the N-channel silicon-gate ED-MOS technology. This IC has 3 I/O ports and a 14-bit counter/timer which make it a good choice to extend the functions of an 8-bit microcomputer. It is incased in a 40-pin plastic DIL package and operates with a single 5V power supply.

**FEATURES**

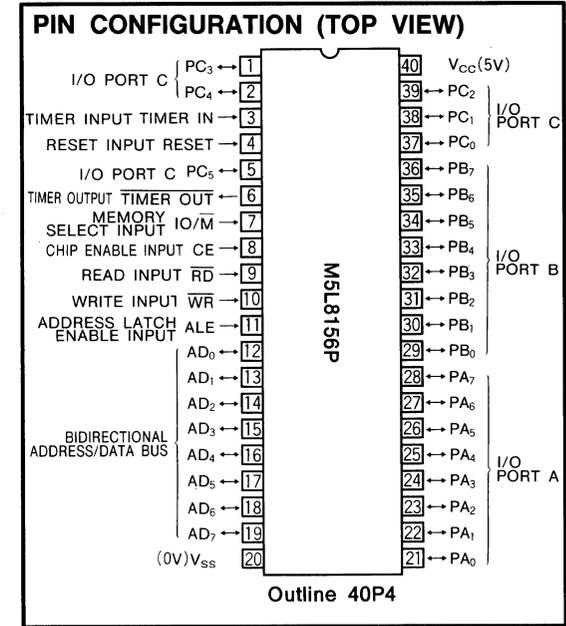
- Single 5V supply voltage
- TTL compatible
- Compatible with MELPS 85 devices
- Static RAM: 256 words by 8 bits
- Programmable 8-bit I/O port: 2
- Programmable 6-bit I/O port: 1
- Programmable counter/timer: 14 bits
- Multiplexed address/data bus

**APPLICATION**

Extension of I/O ports and timer function for MELPS 85 and MELPS 8-48 devices

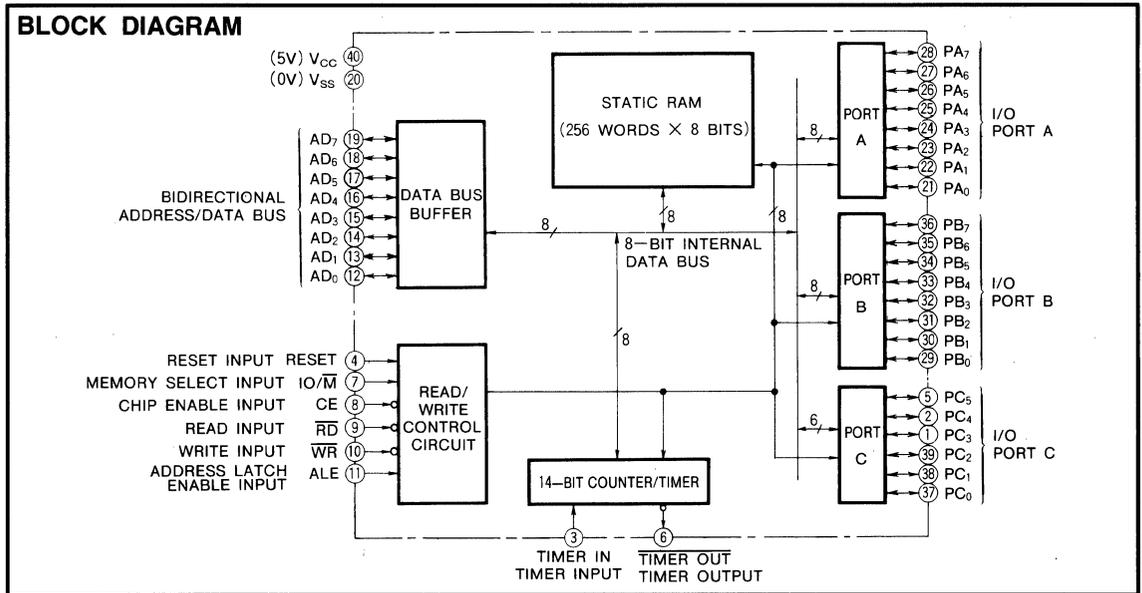
**FUNCTION**

The M5L8156P is composed of RAM, I/O ports and counter/timer. The RAM is a 2K-bit static RAM organized as 256 words by 8 bits. The I/O ports consist of 2 programmable 8-bit ports and 1 programmable 6-bit port. The terminals of the 6-bit port can be programmed to function as control terminals for the 8-bit ports, so that the 8-bit ports can be operated



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in a handshake mode. The counter/timer is composed of 14 bits that can be used to count down (events or time) and it can generate square wave pulses that can be used for counting and timing.



## 2048-BIT STATIC RAM WITH I/O PORTS AND TIMER

## OPERATION

## Data Bus Buffer

This 3-state bidirectional 8-bit buffer is used to transfer the data while input or output instructions are being executed by the CPU. Command and address information is also transferred through the data bus buffer.

## Read/Write Control Logic

The read/write control logic controls the transfer of data by interpreting I/O control bus output signals ( $\overline{RD}$ ,  $\overline{WR}$ ,  $\overline{IO/M}$  and  $\overline{ALE}$ ) along with CPU signal ( $\overline{CE}$ ). RESET signal is also used to control the transfer of data and commands.

Bidirectional Address/Data Bus ( $\overline{AD}_0\sim\overline{AD}_7$ )

The bidirectional address/data bus is a 3-state 8-bit bus. The 8-bit address is latched in the internal latch by the falling edge of  $\overline{ALE}$ . Then if  $\overline{IO/M}$  input signal is at high-level, the address of I/O port, counter/timer, or command register is selected. If it is at low-level, memory address is selected.

The 8-bit address data is transferred by read input ( $\overline{RD}$ ) or write input ( $\overline{WR}$ ).

## Chip Enable Input (CE)

When CE is at high-level, the address information on address/data bus is stored in the M5L8156P

Read Input ( $\overline{RD}$ )

When  $\overline{RD}$  is at low-level the data bus buffer is active. If  $\overline{IO/M}$  input signal is at low-level, the contents of RAM are read through the address/data bus. If  $\overline{IO/M}$  input is at high-level, the selected contents of I/O port or counter/timer are read through the address/data bus.

Write Input ( $\overline{WR}$ )

When  $\overline{XR}$  is at low-level, the data on the address/data bus are written into RAM if  $\overline{IO/M}$  is at low-level, or if  $\overline{IO/M}$  is at high-level they are written into I/O port, counter/timer or command register.

## Address Latch Enable Input (ALE)

An address on the address/data bus along with the levels of CE and  $\overline{IO/M}$  are latched in the M5L8156P on the falling edge of ALE.

IO/Memory Input ( $\overline{IO/M}$ )

When  $\overline{IO/M}$  is at low-level, the RAM is selected, while at high-level the I/O port, counter/timer or command register are selected.

I/O Port A ( $\overline{PA}_0\sim\overline{PA}_1$ )

Port A is an 8-bit general-purpose I/O port. Input/output setting is controlled by the system software.

I/O Port B ( $\overline{PB}_0\sim\overline{PB}_2$ )

Port B is an 8-bit general-purpose I/O port. Input/output setting is controlled by the system software.

I/O Port C ( $\overline{PC}_0\sim\overline{PC}_5$ )

Port C is a 6-bit I/O port that can also be used to output control signals of port A (PA) or port B (PB). The functions of port C are controlled by the system software. When port C is used to output control signals of ports A or B the assignment of the signals to the pins is as shown in Table 1.

Table 1 Pin assignment of control signals of port C

Pin	Function
$\overline{PC}_5$	B STB (port B strobe)
$\overline{PC}_4$	B BF (port B buffer full)
$\overline{PC}_3$	B INTR (port B interrupt)
$\overline{PC}_2$	A STB (port A strobe)
$\overline{PC}_1$	A BF (port A buffer full)
$\overline{PC}_0$	A INTR (port A interrupt)

## Timer Input (TIMER IN)

The signal at this input terminal is used by the counter/timer for counting events or time. (3MHz max.)

## Timer Output (TIMER OUT)

A square wave signal or pulse from the counter/timer is output through this pin when in the operation mode.

## Command Register (8 bits)

The command register is an 8-bit latched register. The lower order 4 bits (bits 0~3) are used for controlling and determination of the mode of the ports. Bits 4 and 5 are used as interrupt enable flags for ports A and B when port C is used as a control port. Bits 6 and 7 are used for controlling the counter/timer. The contents of the command register are rewritten by output instructions (address I/O XXXXX000).

Details of the functions of the individual bits of the command register are shown in Table 2.

Table 2 Bit functions of the command register

Bit	Symbol	Function
0	PA	PORT A I/O FLAG 1: OUTPUT PORT A 0: INPUT PORT A
1	PB	PORT B I/O FLAG 1: OUTPUT PORT B 0: INPUT PORT B
2	$\overline{PC}_1$	PORT C FLAG 00: ALT1 11: ALT2 01: ALT3 10: ALT4
3	$\overline{PC}_2$	
4	IEA	PORT A INTERRUPT ENABLE FLAG 1: ENABLE INTERRUPT 0: DISABLE INTERRUPT
5	IEB	PORT B INTERRUPT ENABLE FLAG 1: ENABLE INTERRUPT 0: DISABLE INTERRUPT
6	TM1	COUNTER/TIMER CONTROL 00: NO INFLUENCE ON COUNTER/TIMER OPERATION 01: COUNTER/TIMER OPERATION DISCONTINUED (IF NOT ALREADY STOPPED) 10: COUNTER/TIMER OPERATION DISCONTINUED AFTER THE CURRENT COUNTER/TIMER OPERATION IS COMPLETED 11: COUNTER/TIMER OPERATION STARTED
7	TM2	

2048-BIT STATIC RAM WITH I/O PORTS AND TIMER

**Status Register (7 bits)**

The status register is a 7-bit latched register. The lower order 5 bits (bits 0~4) are used as status flags for the I/O ports. Bit 6 is as a status flag for the counter/timer. The contents of

the status register are transferred into the CPU by reading (INPUT instruction, address I/O XXXXX000). Details of the functions of the individual bits of the status register are shown in Table 3.

Table 3 Bit functions of the status register

Bit	Symbol	Function
0	INTR A	PORT A INTERRUPT REQUEST
1	A BF	PORT A BUFFER FULL FLAG
2	INTE A	PORT A INTERRUPT ENABLE
3	INTR B	PORT B INTERRUPT REQUEST
4	B BF	PORT B BUFFER FULL FLAG
5	INTE B	PORT B INTERRUPT ENABLE
6	TIMER	COUNTER/TIMER INTERRUPT (SET TO 1 WHEN THE FINAL LIMIT OF THE COUNTER/TIMER IS REACHED AND IS RESET TO 0 WHEN THE STATUS IS READ)
7	—	THIS BIT IS NOT USED

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**I/O Ports**

**Command/status registers (8 bits/7 bits)**

These registers are assigned address XXXXX000. When executing an OUTPUT instruction, the contents of the command register are rewritten. When executing an INPUT instruction the contents of the status register are read.

**Port A Register (8 bits)**

Port A Register is assigned address XXXXX001. This register can be programmed as an input or output by setting the appropriate bits of the command register as shown in Table 2.

Port A can be operated in basic or strobe mode and is assigned I/O terminal PA<sub>0</sub>~PA<sub>7</sub>.

**Port B Register (8 bits)**

Port B register is assigned address XXXXX010. As with Port A register, this register can be programmed as an input or output by setting the appropriate bits of the command register as shown in Table 2. Port B can be operated in basic or strobe mode and is assigned I/O terminals PB<sub>0</sub>~PB<sub>7</sub>.

**Port C Register (6 bits)**

Port C register is assigned address XXXXX011. This port is used for controlling input/output operations of ports A and B by selectively setting bits 2 and 3 of the command register as shown in Table 2. Details of the functions of the various setting of bits 2 and 3 are shown in Table 4. Port C is assigned I/O terminals PC<sub>0</sub>~PC<sub>5</sub> and when used as port control signals, the 3 low-order bits are assigned for port A while the 3 high-order bits are assigned for port B.

Table 4 Functions of port C

State Terminal	ALT 1	ALT 2	ALT 3	ALT 4
PC <sub>5</sub>	Input	Output	Output	B STB (port B strobe)
PC <sub>4</sub>	Input	Output	Output	B BF (port buffer full)
PC <sub>3</sub>	Input	Output	Output	B INTR (port B interrupt)
PC <sub>2</sub>	Input	Output	A STB (port A strobe)	A STB (port A strobe)
PC <sub>1</sub>	Input	Output	A BF (port A buffer full)	A BF (port A buffer full)
PC <sub>0</sub>	Input	Output	A INTR (port A interrupt)	A INTR (port A interrupt)



2048-BIT STATIC RAM WITH I/O PORTS AND TIMER

Table 7 Format of counter/timer

Address	Bit Number								Function
	7	6	5	4	3	2	1	0	
XXXXX100	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	T <sub>2</sub>	T <sub>1</sub>	T <sub>0</sub>	THE LOW-ORDER 8 BITS OF THE COUNTER REGISTER
XXXXX101	M <sub>2</sub>	M <sub>1</sub>	T <sub>13</sub>	T <sub>12</sub>	T <sub>11</sub>	T <sub>10</sub>	T <sub>9</sub>	T <sub>8</sub>	M1,M2: TIMER MODE T <sub>8</sub> ~T <sub>13</sub> : THE HIGH-ORDER 6 BITS OF THE COUNTER REGISTER

Table 8 Timer mode

M <sub>2</sub>	M <sub>1</sub>	Timer operation
0	0	Outputs high-level signal during the former half of the counter operation Outputs low-level signal during the latter half of the counter operation (mode 0)
0	1	Outputs square wave signals as in mode 0 (mode 1)
1	0	Outputs a low-level pulse during the final count down (mode 2)
1	1	Outputs a low-level pulse during each final count down (mode 3)

Mode 1: Outputs square wave signals as in mode 0

Mode 2: Outputs a low-level pulse during the final count down

Mode 3: Outputs a low-level pulse during each final count down

Starting and stopping the counter/timer is controlled by bits 6 and 7 of the command register (see Table 2 for details). The format and timer modes of the counter/timer register are shown in Table 7 and Table 8.

The counter/timer is not influenced by a reset, but counting is discontinued. To resume counting, a start command must be written into the command register as shown in Table 2. While operating 2n+1 count down in mode 0, a high-level signal is output during the n+1 counting and a low-level signal is output during the n counting.

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ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
V <sub>CC</sub>	Supply voltage	With respect to V <sub>SS</sub>	-0.5~7	V
V <sub>I</sub>	Input voltage		-0.5~7	V
V <sub>O</sub>	Output voltage		-0.5~7	V
P <sub>d</sub>	Maximum power dissipation	T <sub>a</sub> =25°C	1.5	W
T <sub>opr</sub>	Operating free-air temperature range		-20~75	°C
T <sub>stg</sub>	Storage temperature range		-65~150	°C

RECOMMENDED OPERATING CONDITIONS (T<sub>a</sub>=-20~75°C, unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
V <sub>CC</sub>	Supply voltage	4.75	5	5.25	V
V <sub>SS</sub>	Power-supply voltage		0		V
V <sub>IL</sub>	Low-level input voltage	-0.5		0.8	V
V <sub>IH</sub>	High-level input voltage	2		V <sub>CC</sub> +0.5	V

ELECTRICAL CHARACTERISTICS (T<sub>a</sub>=-20~75°C, V<sub>CC</sub>=5V±5%, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
V <sub>OH</sub>	High-level output voltage	V <sub>SS</sub> =0V, I <sub>OH</sub> =-400μA	2.4			V
V <sub>OL</sub>	Low-level output voltage	V <sub>SS</sub> =0V, I <sub>OL</sub> =2mA			0.45	V
I <sub>I</sub>	Input leak current	V <sub>SS</sub> =0V, V <sub>I</sub> =0~V <sub>CC</sub>	-10		10	μA
I <sub>I(CE)</sub>	Input leak current, CE pin	V <sub>SS</sub> =0V, V <sub>I</sub> =0~V <sub>CC</sub>	-100		100	μA
I <sub>OZ</sub>	Output floating leak current	V <sub>SS</sub> =0V, V <sub>I</sub> =0.45~V <sub>CC</sub>	-10		10	μA
C <sub>i</sub>	Input capacitance	V <sub>IL</sub> =0V, f=1MHz, 25mVrms, T <sub>a</sub> =25°C			10	pF
C <sub>i/o</sub>	Input/output terminal capacitance	V <sub>I/OL</sub> =0V, f=1MHz, 25mVrms, T <sub>a</sub> =25°C			20	pF
I <sub>CC</sub>	Supply current from V <sub>CC</sub>	V <sub>SS</sub> =0V			180	mA

Note 1 : Current flowing into an IC is positive, out is negative.

2048-BIT STATIC RAM WITH I/O PORTS AND TIMER

**TIMING REQUIREMENTS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{cc} = 5\text{V} \pm 5\%$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{SU(A-L)}$	Address setup time before latch	$t_{AL}$		50			ns
$t_{H(L-A)}$	Address hold time after latch	$t_{LA}$		80			ns
$t_{H(L-RWH)}$	Read/write hold time after latch	$t_{LG}$		100			ns
$t_{W(L)}$	Latch pulse width	$t_{LL}$		100			ns
$t_{H(RW-L)}$	Latch hold time after read/write	$t_{CL}$		20			ns
$t_{W(RWL)}$	Read/write low-level pulse width	$t_{CC}$		250			ns
$t_{SU(D-W)}$	Data setup time before write	$t_{DW}$		150			ns
$t_{H(W-D)}$	Data hold time after write	$t_{WD}$		0			ns
$t_{W(RWH)}$	Read/write high-level pulse width	$t_{RV}$		300			ns
$t_{SU(P-R)}$	Port setup time before read	$t_{PR}$		70			ns
$t_{H(R-P)}$	Port hold time after read	$t_{RP}$		50			ns
$t_{W(STB)}$	Strobe pulse width	$t_{SS}$		200			ns
$t_{SU(P-STB)}$	Port setup time before strobe	$t_{PSS}$		50			ns
$t_{H(STB-P)}$	Port hold time after strobe	$t_{PHS}$		120			ns
$t_{W(\neq H)}$	Timer input high-level pulse width	$t_2$		120			ns
$t_{W(\neq L)}$	Timer input low-level pulse width	$t_1$		80			ns
$t_{C(\neq)}$	Timer input cycle time	$t_{CYC}$		320			ns
$t_{r(\neq)}$	Timer input rise time	$t_r$				30	ns
$t_{f(\neq)}$	Timer input fall time	$t_f$				30	ns

**SWITCHING CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{cc} = 5\text{V} \pm 5\%$ , unless otherwise noted.)

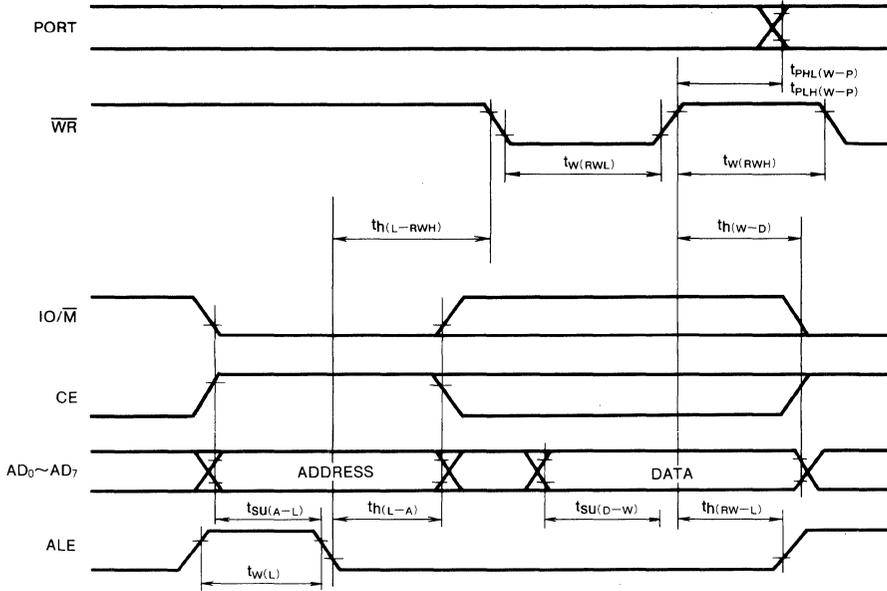
Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{PXV(R-DQ)}$	Propagation time from read to data output	$t_{RD}$				170	ns
$t_{PZX(A-DQ)}$	Propagation time from address to data output	$t_{AD}$				400	ns
$t_{PVZ(R-DQ)}$	Propagation time from read to data floating (Note 7)	$t_{RDF}$		0		100	ns
$t_{PHL(W-P)}$	Propagation time from write to data output	$t_{WP}$				400	ns
$t_{PLH(W-P)}$		$t_{WP}$					
$t_{PLH(STB-BF)}$	Propagation time from strobe to BF flag	$t_{SBF}$				400	ns
$t_{PHL(R-BF)}$	Propagation time from read to BF flag	$t_{RBE}$				400	ns
$t_{PLH(STB-INTR)}$	Propagation time from strobe to interrupt	$t_{SI}$				400	ns
$t_{PHL(R-INTR)}$	Propagation time from read to interrupt	$t_{RDI}$				400	ns
$t_{PHL(STB-BF)}$	Propagation time from strobe to BF flag	$t_{SBE}$				400	ns
$t_{PLH(W-BF)}$	Propagation time from write to BF flag	$t_{WBF}$				400	ns
$t_{PHL(W-INTR)}$	Propagation time from write to interrupt	$t_{WI}$				400	ns
$t_{PHL(\neq-OUT)}$	Propagation time from timer input to timer output	$t_{TL}$				400	ns
$t_{PLH(\neq-OUT)}$		$t_{TH}$					
$t_{PZX(R-DQ)}$	propagation time from read to data enable	$t_{RDE}$		10			ns

Note 1 : Measurement conditions C=150pF  
 2 : Measurement conditions of note 6 are not applied.

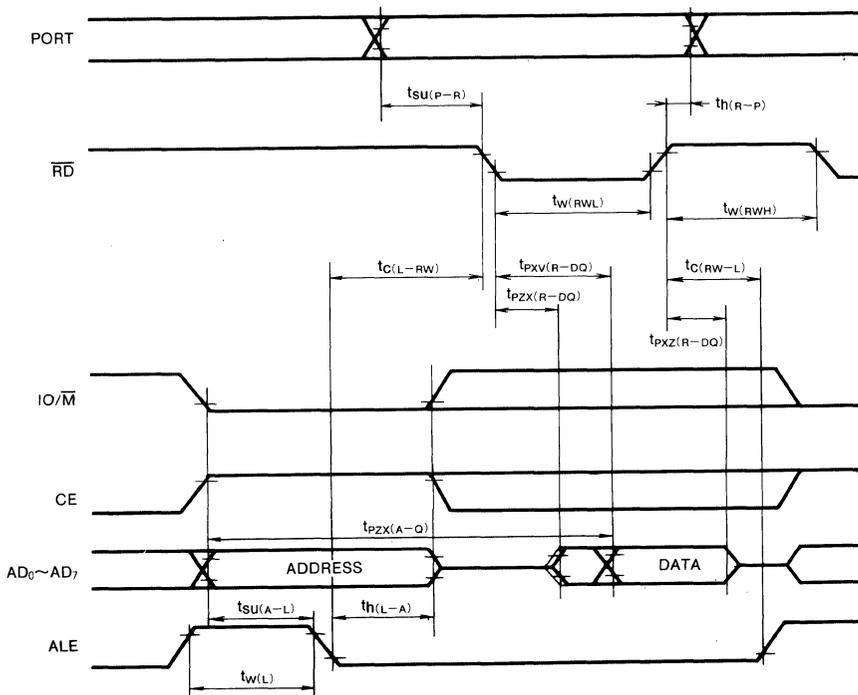
2048-BIT STATIC RAM WITH I/O PORTS AND TIMER

**TIMING DIAGRAM** (reference level, high-level=2V, low-level=0.8V)

**Basic output**

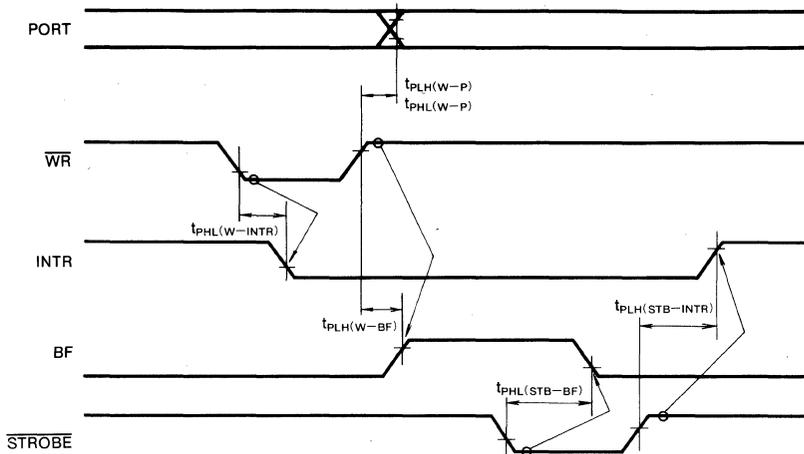


**Basic input**

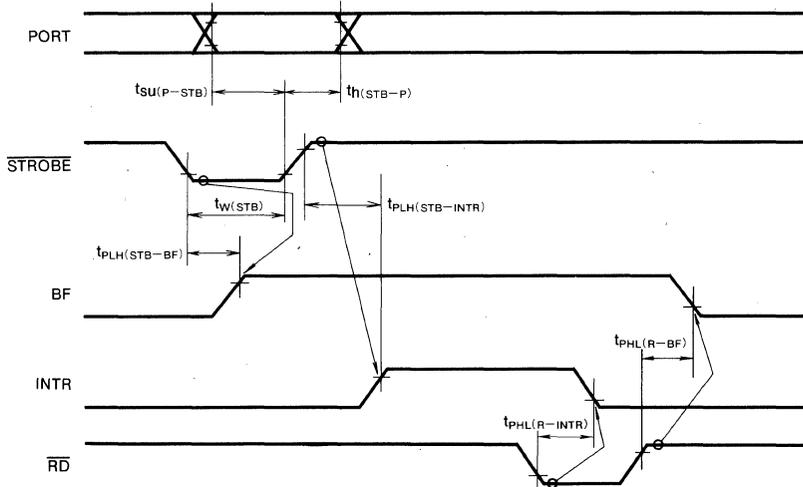


2048-BIT STATIC RAM WITH I/O PORTS AND TIMER

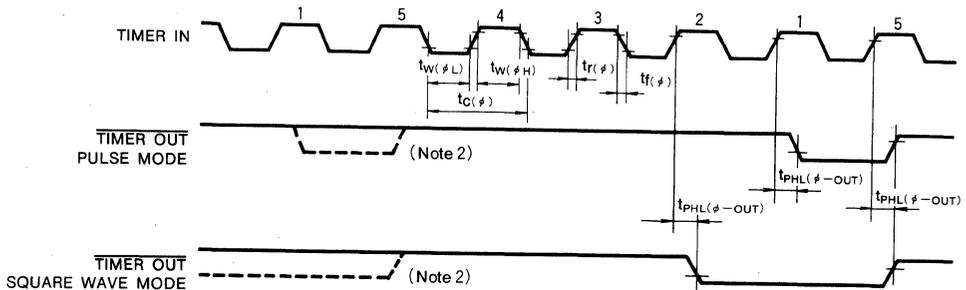
Strobed output



Strobed input



Timer (Note 1)



- Note 1 : The wave form is shown counting down from 5 to 1.
- Note 2 : As long as the M1 mode flag of the timer register is at high-level, pulses are continuously output.

# MITSUBISHI LSIs

## M5L8251AP-5

### PROGRAMMABLE COMMUNICATION INTERFACE

#### DESCRIPTION

The M5L8251AP-5 is a universal synchronous/asynchronous receiver/transmitter (USART) IC chip designed for data communications use. It is produced using the N-channel silicon-gate ED-MOS process and is mainly used in combination with 8-bit microprocessors.

#### FEATURES

- Single 5V supply voltage
- Synchronous and asynchronous operation
  - Synchronous:
    - 5~8-bit characters
    - Internal or external synchronization
    - Automatic SYNC character insertion
  - Asynchronous system:
    - 5~8-bit characters
    - Clock rate—1, 16 or 64 times the baud rate
    - 1, 1½, or 2 stop bits
    - False-start-bit detection
    - Automatic break-state detection

- Baud rate: DC~64k-baud
- Full duplex, double-buffered transmitter/receiver
- Error detection: parity, overrun, and framing

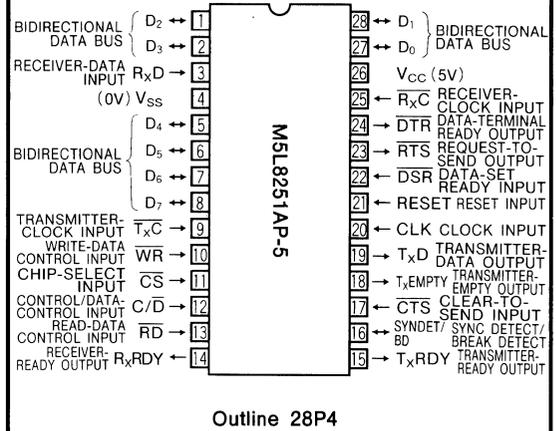
#### APPLICATIONS

- Modem control of data communications using micro-computers
- Control of CRT, TTY and other terminal equipment

#### FUNCTION

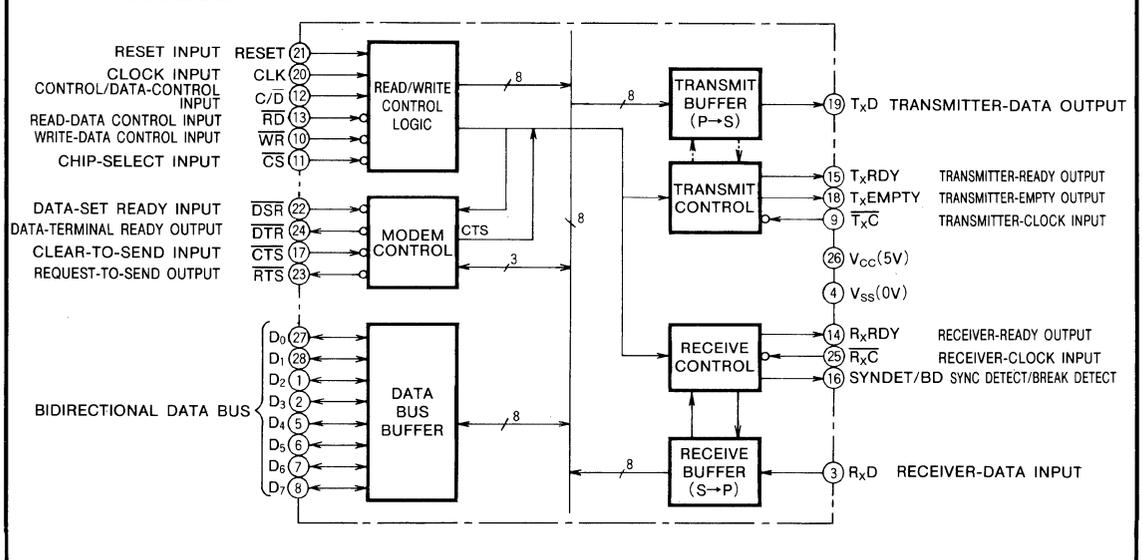
The M5L8251AP-5 is used in the peripheral circuits of a CPU. It permits assignments, by means of software, of operations in all the currently used serial-data transfer systems

#### PIN CONFIGURATION (TOP VIEW)



including IBM's 'bi-sync'. The M5L8251AP-5 receives parallel-format data from the CPU, converts it into a serial format, and then transmits via the T<sub>x</sub>D pin. It also receives data sent in via the R<sub>x</sub>D pin from the external circuit, and converts it into a parallel-format for sending to the CPU. On receipt of parallel-format data for transmission from the CPU or serial data for the CPU from external devices, the M5L8251AP-5 informs the CPU using the T<sub>x</sub>RDY or R<sub>x</sub>RDY pin. In addition, the CPU can read the M5L8251AP-5 status at any time. The M5L8251AP-5 can detect the data received for errors and inform the CPU of the presence of errors as status information. Errors include parity, overrun and frame errors.

#### BLOCK DIAGRAM



PROGRAMMABLE COMMUNICATION INTERFACE

**OPERATION**

The M5L8251AP-5 interfaces with the system bus as shown in Fig.1, positioned between the CPU and the modem or terminal equipment, and offers all the functions required for data communication.

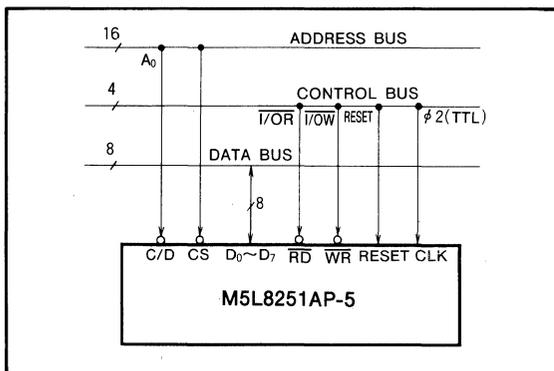


Fig. 1 M5L8251AP-5 interface to 8080A standard system bus

When using the M5L8251AP-5, it is necessary to program, as the initial setting, assignments for synchronous/asynchronous mode selection, baud rate, character length, parity check, and even/odd parity selection in accordance with the communication system used. Once programming is completed, functions appropriate to the communication system can be carried out continuously.

When initial setting of the USART is completed, data communication becomes possible. Though the receiver is always in the enable state, the transmitter is placed in the transmitter-enable state (TxEN) by a command instruction, and the application of a low-level signal to the CTS pin prompts data-transfer start-up. Until this condition is satisfied, transmission is not executed. On receiving data, the receiver informs the CPU that reading for the receiver data in the USART by the CPU has become possible (the RxRDY terminal has turned to '1'). Since data reception and the entry of the CPU into the data-readable state are output as status information, the CPU can assess USART status without accessing the RxRDY terminal.

During receiving operation, the USART checks errors and gives out status information. There are three types of errors: parity, overrun, and frame. Even though an error occurs, the USART continues its operations, and the error state is retained until error reset (ER) is effected by a command instruction. The M5L8251AP-5 access methods are listed in Table 1.

Table 1 M5L8251AP-5 Access Methods

C/D	RD	WR	CS	Function
L	L	H	L	Data bus ← Data in USART
L	H	L	L	USART ← Data bus
H	L	H	L	Data bus ← Status
H	H	L	L	Control ← Data bus
X	H	H	L	3-State ← Data bus
X	X	X	H	3-State ← Data bus

**Read/Write Control Logic**

This logic consists of a control word register and command word register. It receives signals from the CPU control bus and generates internal-control signals for the elements.

**Modem Control Circuit**

This is a general-purpose control-signal circuit designed to simplify the interface to the modem. Four types of control signal are available: output signals DTR and RTS are controlled by command instructions, input signal DSR is given to the CPU as status information and input signal CTS controls direct transmission.

**Data-Bus Buffer**

This is an 8-bit 3-state bidirectional bus through which control words, command words, status information, and transfer data are transferred. Fig. 2 shows the structure of the data-bus buffer.

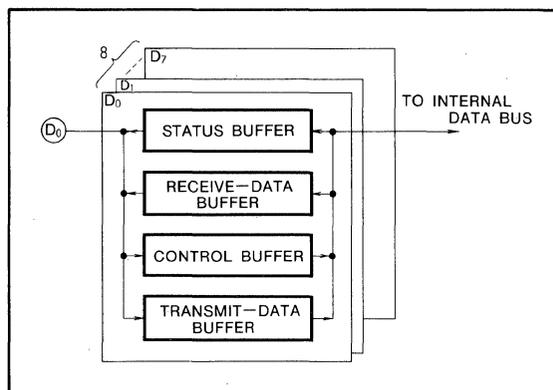


Fig. 2 Data-bus-buffer structure

**Transmit Buffer**

This buffer converts parallel-format data given to the data-bus buffer in to serial data with addition of a start bit, stop bits and a parity bit, and sends out the converted data through the TxD pin based on the control signal.

**Transmit-Control Circuit**

This circuit carries out all the controls required for serial data transmission. It controls transmitter data and outputs the signals required by external devices in accordance with the instructions of the read/write control logic.

## PROGRAMMABLE COMMUNICATION INTERFACE

**Receive Control Circuit**

This circuit offers all the controls required for normal reception of the input serial data. It controls receiver data and outputs signals for the external devices in accordance with the instructions of the read/write control logic.

**Receive Buffer**

This buffer converts serial data given via the  $R_xD$  pin into a parallel format, checks the bits and characters in accordance with the communication format designated by mode setting, and transfers the assembled characters to the CPU via the data-bus buffer.

**Receiver-Data Input ( $R_xD$ )**

Serial characters sent from another device are input to this pin and converted to a parallel-character format to serve as data for the CPU. Unless the '1' state is detected after a chip-master reset procedure (this resetting is carried out to prevent spurious operation such as that due to faulty connection of the  $R_xD$  to the line in a break state), the serial characters are not received. This applies to only the asynchronous mode. When the  $R_xD$  line enters the low state instantaneously because of noise, etc, the mis-start prevention function starts working. That is, the start bit is detected by its falling edge but in order to make sure that it is the correct start bit, the  $R_xD$  line is strobed at the middle of the start bit to reconfirm the low state. If it is found to be high a faulty-start judgment is made.

**Transmitter-Clock Input ( $T_xC$ )**

This clock controls the baud rate for character transmission from the  $T_xD$  pin. Serial data is shifted by the falling edge of the  $T_xC$  signal. In the synchronous mode, the  $T_xC$  frequency is equal to the actual baud rate. In the asynchronous mode, the frequency is specified as 1, 16, or 64 times the baud rate by the mode setting.

Example When the baud rate is 110 bauds:

$$\overline{T_xC} = 110\text{Hz}(1X)$$

$$\overline{T_xC} = 1.76\text{kHz}(16X)$$

$$\overline{T_xC} = 7.04\text{kHz}(64X)$$

**Write-Data Control Input ( $\overline{WR}$ )**

Data and control words output from the CPU by the lowlevel input are written in the M5L8251AP-5. This terminal is usually used in a form connected with the control bus  $\overline{I/O}$  of the CPU.

**Chip-Select Input ( $\overline{CS}$ )**

This is a device-select signal that enables the USART by a low-level input. Usually, it is connected to the address bus directly or via the decoder. When this signal is in the high state, the M5L8251AP-5 is disabled.

**Control/Data Control Input ( $C/D$ )**

This signal shows whether the information on the USART data bus is in the form of data characters or control words, or in the form of status information, in accordance with the  $\overline{RD}$  and  $\overline{WR}$  inputs while the CPU is accessing the M5L8251AP-5. The high level identifies control words or status information, and the low level, data characters.

**Read-Data Control Input ( $\overline{RD}$ )**

Receiver data and status information are output from the CPU by a low-level input for the CPU data bus.

**Receiver-Ready Output ( $R_xRDY$ )**

This signal indicates that the received characters have entered the receiver buffer, and further, the receiver-data buffer in the data-bus buffer shown in Fig.2. It is possible to confirm the  $R_xRDY$  status by using this signal as an interruption signal for the CPU or by allowing the CPU to read the  $D_1$  bit of the status information by polling. The  $R_xRDY$  is automatically reset when a character is read by the CPU. Even in the break state in which the  $R_xD$  line is held at low, the  $R_xRDY$  remains active. It can be masked by making the  $R_xE(D_2)$  of the command instruction 0.

**Transmitter-Ready ( $T_xRDY$ )**

This signal shows that the data is ready for transmission. It is possible to confirm the status of serial-data transmission by using it as an interruption signal for the CPU or by allowing the CPU to read the  $D_0$  bit of the status information by polling. Since the  $T_xRDY$  signal shows that the data buffer is empty, it is automatically reset when a transmission character is loaded by the CPU. The  $T_xRDY$  bit of the status information means that the transmit-data buffer shown in Fig.2 has become empty, while the  $T_xRDY$  pin enters the high-level state only when the transmit-data buffer is empty,  $T_xEN$  equals '1', and a lowlevel input has been applied to the  $\overline{CTS}$  pin.

Status ( $D_0$ ): When transmit-data buffer (TDB) is empty, it becomes '1'.

$T_xRDY$  terminal: When (TDB is empty) · ( $T_xEN=1$ ) · ( $\overline{CTS}=0$ ) = 1 or resetting, it becomes active.

**Sync Detect/Break Detect Output-Input ( $\overline{SYNDET/BD}$ )**

In the synchronous mode this pin is used for input and output operations. When it is specified for the internal synchronous mode by mode setting, this pin works as an output terminal. It enters the high state when a SYNC character is received through the  $R_xD$  pin. If the M5L8251AP-5 has been programmed for double SYNC characters (bi-sync), a high is entered in the middle of the last bit of the second SYNC character. This signal is automatically reset by reading the status information.

On designation of the M5L8251AP-5 to the external synchronous mode, this pin begins to serve for input operations. Applying a high signal to this pin prompts the M5L8251AP-5 to begin assembling data characters at the next rising edge of the  $\overline{R_xC}$ . For the width of a high-level signal to be input, a minimum  $\overline{R_xC}$  period is required.

Designation of the asynchronous mode causes this pin to function as a BD (output) pin. When the start, data, and parity bits and stop bits are all in the low state for two characters period, a high is entered. The BD (break detect) signal can also be read as the  $D_6$  bit of the status information. This signal is reset by resetting the chip master or by the  $R_xD$  line's recovering the high state.

**PROGRAMMABLE COMMUNICATION INTERFACE**

**Clear-To-Send Input ( $\overline{\text{CTS}}$ )**

When the  $\text{T}_\text{XEN}$  bit ( $\text{D}_0$ ) of the command instruction has been set to '1' and the  $\overline{\text{CTS}}$  input is low serial data is sent out from the  $\text{T}_\text{XD}$  pin. Usually this is used as a clear-to-send signal for the modem.

Note: CTS indicates the modem status as follows:

- ON means data transmission is possible;
- OFF means data transmission is impossible.

**Transmitter-Empty Output ( $\text{T}_\text{XEMPTY}$ )**

When no transmission characters are left in the transmit buffer, this pin enters the high state. In the asynchronous mode, the following transmission character is shifted to the transmit buffer when it is loaded from the CPU. Thus, it is automatically reset. In the synchronous mode, a SYNC character is loaded automatically on the transmit buffer when no transfer-data characters are left. In this case, however, the  $\text{T}_\text{XEMPTY}$  does not enter the low state when a SYNC character has been sent out, since  $\text{T}_\text{XEMPTY} = \text{H}$  denotes the state in which there is no transfer character and one or two SYNC characters are being transferred or the state in which a SYNC character is being transferred as a filler.  $\text{T}_\text{XEMPTY}$  is unrelated to the  $\text{T}_\text{XEN}$  bit of the command instruction.

**Transmission-Data Output ( $\text{T}_\text{XD}$ )**

Parallel-format transmission characters loaded on the M5L8251AP-5 by the CPU are assembled into the format designated by the mode instruction and sent in serial-data form via the  $\text{T}_\text{XD}$  pin. Data is output, however, only in cases where the  $\text{D}_0$  bit ( $\text{T}_\text{XEN}$ ) of the command instruction is '1' and the  $\overline{\text{CTS}}$  terminal is in the low state. Once reset, this pin is kept at the mark status (high level) until the first character is sent.

**Clock Input (CLK)**

This system-clock input is required for internal-timing generation and is usually connected to the clock-output (CLK) pin of the M5L8085AP. Although there is no direct relation with the data-transfer baud rate, the clock-input (CLK) frequency is more than 30 times the  $\overline{\text{T}_\text{XC}}$  or  $\overline{\text{R}_\text{XC}}$  input frequency in the case of the synchronous system and more than 4.5 times in the case of the asynchronous system.

**Reset Input (RESET)**

Once the USART is shifted to the idle mode by a high-level input, this state continues until a new control word is set. Since this is a master reset, it is always necessary to load a control word following the reset process. The reset input requires a minimum 6-clock pulse width.

**Data-Set Ready Input ( $\overline{\text{DSR}}$ )**

This is a general-purpose input signal, but is usually used as a data-set ready signal to test modem status. Its status can be known from the status reading process. The  $\text{D}_7$  bit of the status information equals '1' when the  $\overline{\text{DSR}}$  pin is in the low state, and '0' when in the high state.

$\overline{\text{DSR}} = \text{L} \rightarrow \text{D}_7$  bit of status information = 1

$\overline{\text{DSR}} = \text{H} \rightarrow \text{D}_7$  bit of status information = 0

Note: DSR indicates modem status as follows:

- ON means the modem can transmit and receive;
- OFF means it cannot.

**Request-To-Send Output ( $\overline{\text{RTS}}$ )**

This is a general-purpose output signal but is used as a request-to-send signal for the modem. The  $\overline{\text{RTS}}$  terminal is controlled by the  $\text{D}_5$  bit of the command instruction. When  $\text{D}_5$  is equal to '1',  $\overline{\text{RTS}} = \text{L}$ , and when  $\text{D}_5$  is 0,  $\overline{\text{RTS}} = \text{H}$ .

Command register  $\text{D}_5 = 1 \rightarrow \overline{\text{RTS}} = \text{L}$

Command register  $\text{D}_5 = 0 \rightarrow \overline{\text{RTS}} = \text{H}$

Note: RTS controls the modem transmission carrier as follows:

- ON means carrier dispatch;
- OFF means carrier stop.

**Data-Terminal Ready Output ( $\overline{\text{DTR}}$ )**

This is a general-purpose output signal, but is usually used as a data-terminal ready or rate-select signal to the modem. The  $\overline{\text{DTR}}$  pin is controlled by the  $\text{D}_1$  bit of the command instruction; if  $\text{D}_1 = 1$ ,  $\overline{\text{DTR}} = \text{L}$ , and if  $\text{D}_1 = 0$ ,  $\overline{\text{DTR}} = \text{H}$ .

$\text{D}_1$  of the command register = 1  $\rightarrow \overline{\text{DTR}} = \text{L}$

$\text{D}_1$  of the command register = 0  $\rightarrow \overline{\text{DTR}} = \text{H}$

**Receiver-Clock Input ( $\overline{\text{R}_\text{XC}}$ )**

This clock signal controls the baud rate for the sending in of characters via the  $\overline{\text{R}_\text{XD}}$  pin. The data is shifted in by the rising edge of the  $\overline{\text{R}_\text{XC}}$  signal. In the synchronous mode, the  $\overline{\text{R}_\text{XC}}$  frequency is equal to the actual baud rate. In the asynchronous mode, the frequency is specified as 1, 16, or 64 times the baud rate by mode setting. This relationship is parallel to that of  $\overline{\text{T}_\text{XC}}$ , and in usual communication-line systems the transmission and reception baud rates are equal. The  $\overline{\text{T}_\text{XC}}$  and  $\overline{\text{R}_\text{XC}}$  terminals are, therefore, used connected to the same baud-rate generator.

**PROGRAMMING**

It is necessary for the M5L8251AP-5 to have the control word loaded by the CPU prior to data transfer. This must always be done following any resetting operation (by external RESET pin or command instruction IR). There are two types of control words: mode instructions specifying general operations required for communications and command instructions to control the M5L8251AP-5 actual operations.

Following the resetting operation, a mode instruction must be set first. This instruction sets the synchronous or asynchronous system to be used. In the synchronous system, a SYNC character is loaded from the CPU. In the case of the bi-sync system, however, a second SYNC character must be loaded in succession.

Loading a command instruction makes data transfer possible. This operation after resetting must be carried out for initializing the M5L8251AP-5. The USART command instruction contains an internal-reset IR instruction ( $\text{D}_6$  bit) that makes it possible to return the M5L8251AP-5 to its reset state. The initialization flowchart is shown in Fig. 3 and the mode-instruction and command-instruction formats are shown in Figs. 4 and 5.

**PROGRAMMABLE COMMUNICATION INTERFACE**

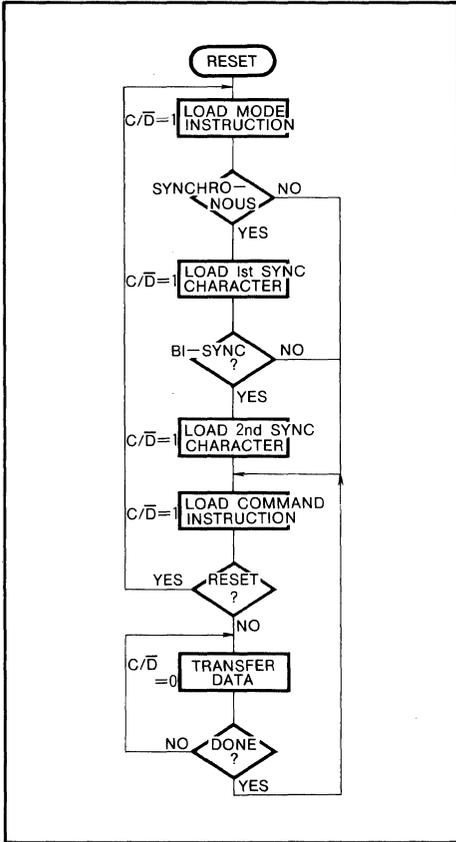


Fig. 3 Initialization flow chart

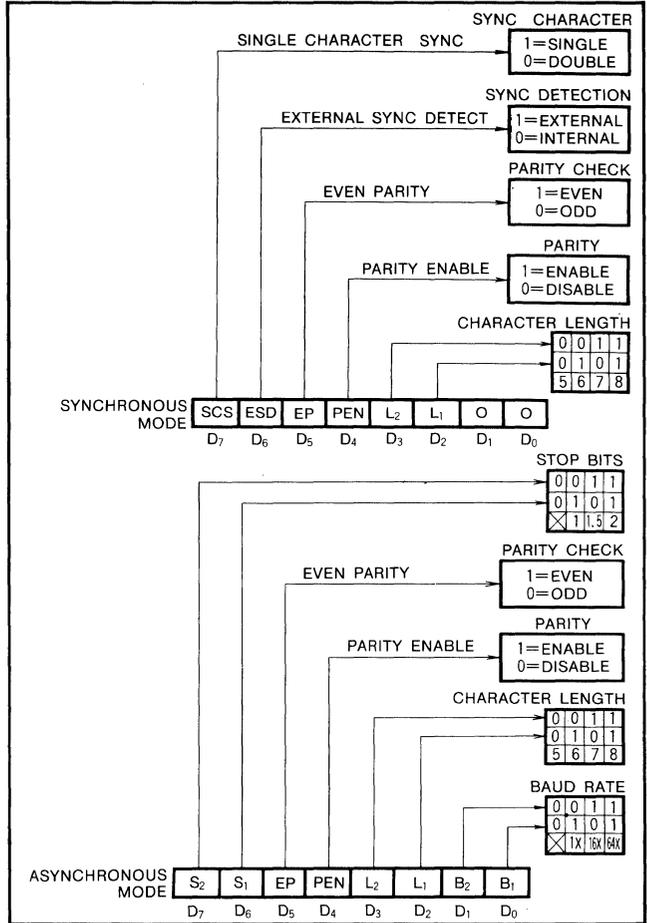


Fig. 4 Mode-instruction format (C/D=1, WR=0)

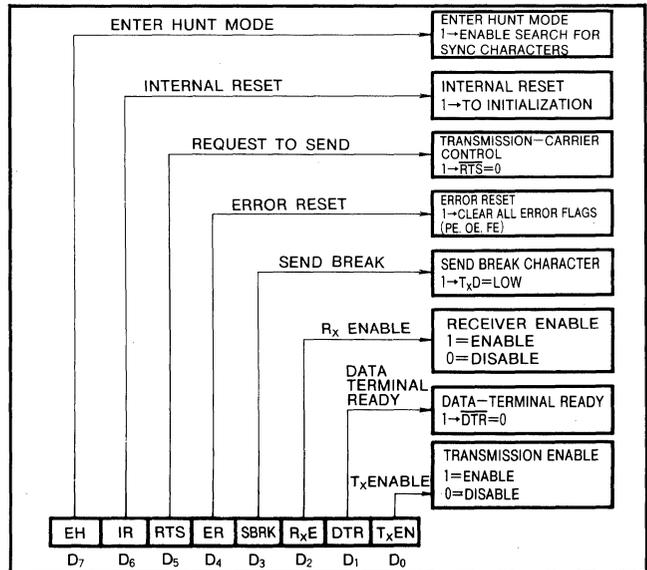


Fig. 5 Command-instruction format (C/D=1, WR=0)

4

**PROGRAMMABLE COMMUNICATION INTERFACE**

**Asynchronous Transmission Mode**

When data characters are loaded on the M5L8251AP-5 after initial setting, the USART automatically adds a start bit (low), an odd or even parity bit specified by the mode instruction during initialization, and a specified number of stop bits (high). After that, the assembled data characters are transferred as serial data via the T<sub>X</sub>D pin if, transfer is enabled (T<sub>X</sub>EN=1·CTS=L). In this case, the transfer data (baud rate) is shifted by the mode instruction at a rate of 1X, 1/16X, or 1/64X the T<sub>X</sub>C period.

If the data characters are not loaded on the M5L8251AP-5, the T<sub>X</sub>D pin enters a mark state (high). When SBRK is programmed by the command instruction, break characters (low) are output continuously through the T<sub>X</sub>D pin.

**Asynchronous Reception Mode**

The R<sub>X</sub>D line usually starts operations in a mark state (high), triggered by the falling edge of a low-level pulse when it comes to this line. This signal is again strobed at the middle of the bit to confirm that it is a perfect start bit. The detection of a second low indicates the validity of the start bit (restrobing is carried out only in the case of 16X and 64X). After that, the bit counter inside the M5L8251AP-5 starts operating; each bit of the serial information on the R<sub>X</sub>D line is shifted in by the rising edge of R<sub>X</sub>C, and the data bit, parity bit (when necessary), and stop bit are sampled at the middle position.

The occurrence of a parity error causes the setting of a parity-error flag. If the stop bit is in the low state, a frame error flag is set. Attention should be paid to the fact that the receiver requires only one stop bit even though the program has designated 1½ or 2 stop bits.

Reception up to the stop bit means reception of a complete character. This character is then transferred to the receiver-data buffer shown in Fig.2, and the R<sub>X</sub>RDY becomes active. In cases where this character is not read by the CPU

and where the next character is transferred to the receiver-data buffer, the preceding character is destroyed and an overrun-error flag is set.

These error flags can be read as the M5L8251AP-5 status information. The occurrence of an error does not stop USART operations. The error flags are cleared by the ER(D<sub>4</sub> bit) of the command instruction.

The asynchronous-system transfer formats are shown in Figs. 6 and 7.

**Synchronous Transmission Mode**

In this mode the T<sub>X</sub>D pin remains in the high state until initial setting by the CPU is completed. After initialization, the state of CTS=L and T<sub>X</sub>EN =1 enables serial transmission of characters through the T<sub>X</sub>D pin. Then, data characters are sent out and shifted by the falling edge of the T<sub>X</sub>C signal. The transmission rate equals the T<sub>X</sub>C rate.

Thus, once data-character transfer starts, it must continue through the T<sub>X</sub>D pin at the same rate as that of T<sub>X</sub>C. Unless data characters are provided from the CPU before the transmitter buffer becomes empty, one or two SYNC characters are automatically output from the T<sub>X</sub>D pin. In this case, it should be noted that the T<sub>X</sub>EMPTY pin enters the high state when there are no data characters left in the M5L8251AP-5 to be transferred, and that the low state is not entered until the USART is provided with the next data character from the CPU. Care should also be taken over the fact that merely setting a command instruction does not effect SYNC-character insertion, because the SYNC character insertion is enabled after sending out the first data character.

In this mode, too, break characters are sent out in succession from the T<sub>X</sub>D pin when SBRK is designated (D<sub>3</sub>=1) by a command instruction.

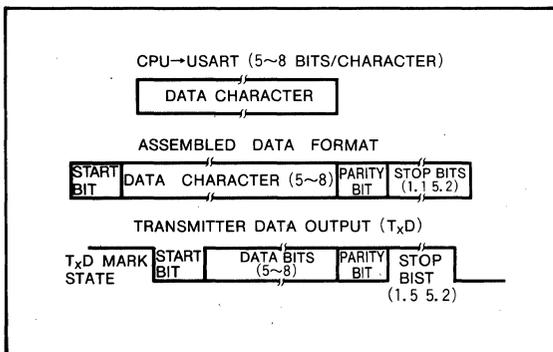


Fig. 6 Asynchronous transmission format I (transmission)

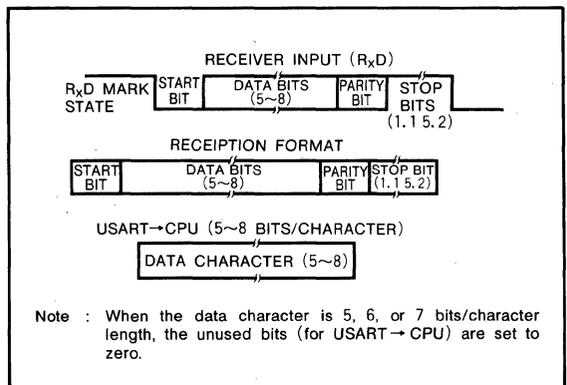


Fig. 7 Asynchronous transmission format II (reception)

**PROGRAMMABLE COMMUNICATION INTERFACE**

**Synchronous Reception Mode**

Character synchronization in this mode is carried out internally or externally by initial-setting designation.

Programming in the internal synchronous mode requires that an EH instruction ( $D_7=1$ , enter hunt mode) is included in the first command instruction. Data on the  $R_xD$  pin is sampled by the rising  $R_xC$  signal, and the receiver-buffer contents are compared with the SYNC character each time a bit is input. Comparison continues until an agreement is reached. When the M5L8251AP-5 has been programmed in the bi-sync mode, data received in further succession is compared. The detection of two SYNC characters in succession makes the USART end the hunt mode, setting the SYNDET pin to the high state. This reset operation is prompted by the reading of the status information. When the parity has been programmed, SYNDET is not set in the middle of the last data bit but in the middle of the parity bit.

In the external synchronous mode, the M5L8251AP-5 gets out of the hunt mode when a high synchronization signal is given to the SYNDET pin. The high signal requires a minimum duration of one  $R_xC$  cycle. In the asynchronous mode, however, the EH signal does not affect the operation at all.

Parity and overrun errors are checked in the same way as in the asynchronous system. During hunt-mode operations the parity bit is not checked, but parity checking is carried out even when the receiver is disabled.

The CPU can command the receiver to enter the hunt mode, if synchronization is lost. This prevents the SYNC character from erroneously becoming equal to the received data when all the data in the receiver buffer is set to '1'. Attention should be paid to the fact that the SYNDET F/F is reset each time status information is read irrespective of the synchronous mode's being internal or external. This, howev-

er, does not return the M5L8251AP-5 to the hunt mode. Synchronism detection is carried out even though it is not the hunt mode. The synchronous transfer formats are shown in Figs. 8 and 9.

**Command Instruction**

This instruction defines actual operations in the communication mode designated by mode setting. Command instructions include transmitter/receiver enable error-reset, internal-reset, modem-control, enter-hunt and break transmission instructions.

The mode is set following the reset operation. A SYNC character is set as required, and the writing of high-level signals on the control/data pin (C/D) that follows it is regarded as a command instruction. When the mode is set all over again from the beginning, the M5L8251AP-5 can be reset by using inputting via the reset terminal or by internal resetting based on the command instruction.

- Note 1: The command error reset (ER), internal reset (IR) and enter-hunt-mode (EH) operations are only effective when the command instruction is loaded, so that these bits need not be returned to '0'.
- 2: When a break character is sent out by a command, the  $T_xD$  enters the low state immediately irrespective of whether or not the USART has sent out data.
- 3: Operations of the USART's receiver section which is always in the enable state cannot be inhibited. The command instruction  $R_xE=0$  does not mean that data reception via the  $R_xD$  pin is inhibited; it means that the  $R_xRDY$  is masked and error flags are inhibited.

**4**

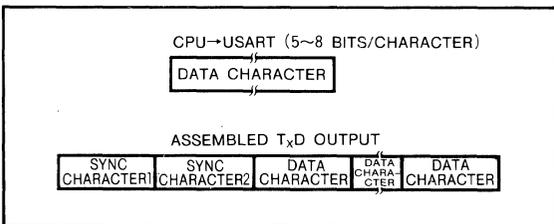


Fig. 8 Synchronous transmission format I (transmission)

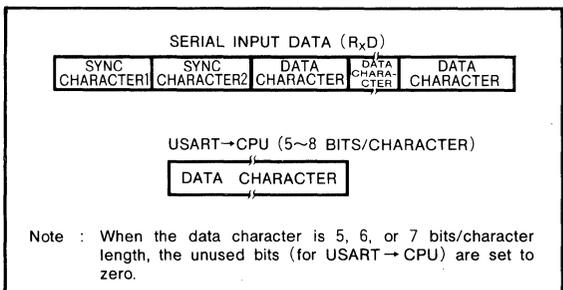


Fig. 9 Synchronous transmission format II (reception)

**PROGRAMMABLE COMMUNICATION INTERFACE**

**Status Information**

The CPU can always read USART status by setting the  $C/\bar{D}$  to '1' and  $\bar{RD}$  to '0'.

The status information format is shown in Fig. 10. In this format  $R_xRDY$ ,  $T_xEMPTY$  and  $SYNDET$  have the same definitions as those of the pins. This means that these three pieces of status information become '1' when each pin is in the high state. The other status information is defined as follows:

**DSR:** When the  $\bar{DSR}$  pin is in the low state, status information DSR becomes '1'.

**FE:** The occurrence of a frame error in the receiver section makes the status information FE '1'.

**OE:** The occurrence of an overrun error in the receiver section makes the status information OE '1'.

**PE:** The occurrence of a parity error in the receiver section makes this status information PE '1'.

**$T_xRDY$ :** This information becomes '1' when the transmit data buffer is empty. Be careful because this has a different meaning from the  $T_xRDY$  pin that enters the high state only when the transmitter buffer is empty, when the CTS pin is in the low state, and when  $T_xEN$  is '1'.

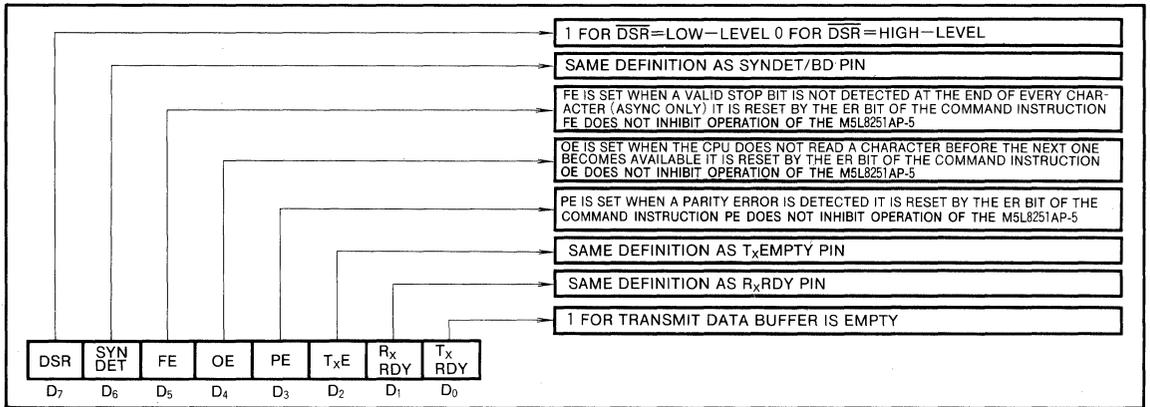


Fig. 10 Status information ( $C/\bar{D}=1, \bar{RD}=0$ )

**APPLICATION EXAMPLES**

Fig. 11 shows an application example for the M5L8251AP-5 in the asynchronous mode. When the port addresses of the M5L8251AP-5 are assumed to be 00# and 01# in this figure, initial setting in the asynchronous mode is carried out in the following manner:

```

MVI   A, B6#    Mode setting
OUT   01#
MVI   A, 27#    Command instruction
OUT   01#
    
```

In this case, the following are set by mode setting:

- Asynchronous mode
- 6 bits/character
- Parity enable (even)
- 1½stop bits
- Baud rate: 16X

Command instructions set the following

```

RTS=1 → RTS pin=L
RxE=1
DTR=1 →  $\bar{DTR}$  pin=L
TxEN=1
    
```

When the initial setting is complete, transfer operations are allowed. The RTS pin is initially set to the low-level by setting RTS to '1', and this serves as a CTS input with  $T_xEN$

being equal to '1'. For this reason the same definition applies to the status and pin of  $T_xRDY$ , and '1' is assigned when the transmit-data buffer is empty. Actual transfer of data is carried out in the following way:

```

IN     01#    Status read
    
```

The IN instruction prompts the CPU to read the USART's status. The result is; if the  $T_xRDY$  equals '1' transmitter data is sent from the CPU and written on the M5L8251AP-5. Transmitter data is written in the M5L8251AP-5 in the following manner:

```

MVI   A, 2D#    2D16 is an example of transmitter data.
OUT   00#    USART←(A)
    
```

Receiver data is read in the following manner:

```

IN     00#    (A)←USART
    
```

In the above example, the status information is read and as a result, the transmitter data is written and read. Interruption processing by using the  $T_xRDY$  and  $R_xRDY$  pins is also possible.

Fig. 12 shows the status of the  $T_xD$  pin when data written in the USART is transferred from the CPU. When the data shown in Fig.12 enters the  $R_xD$  pin, data sent from the M5L8251AP-5 to the CPU becomes 2D16 and bits D6 and D7 are treated as '0'.



**PROGRAMMABLE COMMUNICATION INTERFACE**

**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Power-supply voltage	With respect to $V_{SS}$	-0.5~7	V
$V_I$	Input voltage		-0.5~7	V
$V_O$	Output voltage		-0.5~7	V
$P_d$	Power dissipation		1000	mW
$T_{opr}$	Operating free-air temperature range		-20~75	°C
$T_{stg}$	Storage temperature range		-65~150	°C

**RECOMMENDED OPERATING CONDITIONS** ( $T_a = -20 \sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.75	5	5.25	V
$V_{SS}$	Power-supply voltage		0		V
$V_{IH}$	High-level input voltage	2.0		$V_{CC}$	V
$V_{IL}$	Low-level input voltage	-0.5		0.8	V

**ELECTRICAL CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 5\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{OH}$	High-level output voltage	$I_{OH} = -400\mu\text{A}$	2.4			V
$V_{OL}$	Low-level output voltage	$I_{OL} = 2.2\text{mA}$			0.45	V
$I_{CC}$	Supply current from $V_{CC}$	All outputs are high			100	mA
$I_{IH}$	High-level input current	$V_I = V_{CC}$	-10		10	$\mu\text{A}$
$I_{IL}$	Low-level input current	$V_I = 0.45\text{V}$	-10		10	$\mu\text{A}$
$I_{OZ}$	Off-state input current	$V_{SS} = 0V$ , $V_I = 0.45 \sim 5.25\text{V}$	-10		10	$\mu\text{A}$
$C_I$	Input capacitance	$V_{CC} = V_{SS}$ , $f = 1\text{MHz}$ , $25\text{mV}_{rms}$ , $T_a = 25^\circ\text{C}$			10	pF
$C_{I/O}$	Input/output capacitance	$V_{CC} = V_{SS}$ , $f = 1\text{MHz}$ , $25\text{mV}_{rms}$ , $T_a = 25^\circ\text{C}$			20	pF

## PROGRAMMABLE COMMUNICATION INTERFACE

TIMING REQUIREMENTS ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 5\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

Symbol	Parameter		Alternative Symbol	Test conditions	Limits			Unit
					Min	Typ	Max	
$t_{C(\phi)}$	Clock cycle time (Notes1, 2)		$t_{CY}$		320		1350	ns
$t_{W(\phi)}$	Clock high pulse width		$t_{\phi}$		120		$t_{C(\phi)} - 90$	ns
$t_{\bar{W}(\phi)}$	Clock low pulse width		$t_{\bar{\phi}}$		90			ns
$t_r$	Clock rise time		$t_r$				20	ns
$t_f$	Clock fall time		$t_f$				20	ns
$f_{TX}$	Transmitter input clock frequency	1X baud rate	$f_{TX}$		DC		64	kHz
		16X baud rate	$f_{TX}$		DC		310	kHz
		64X baud rate	$f_{TX}$		DC		615	kHz
$t_{W(TPWL)}$	Transmitter input clock low pulse width	1X baud rate	$t_{TPW}$		12		$t_{C(\phi)}$	
		16X, 64X baud rate	$t_{TPW}$		1		$t_{C(\phi)}$	
$t_{W(TPWH)}$	Transmitter input clock high pulse width	1X baud rate	$t_{TPD}$		15		$t_{C(\phi)}$	
		15X, 64X baud rate	$t_{TPD}$		3		$t_{C(\phi)}$	
$f_{RX}$	Receiver input clock frequency	1X baud rate	$f_{RX}$		DC		64	kHz
		16X baud rate	$f_{RX}$		DC		310	kHz
		64X baud rate	$f_{RX}$		DC		615	kHz
$t_{W(RPWL)}$	Receiver input clock low pulse width	1X baud rate	$t_{RPW}$		12		$t_{C(\phi)}$	
		15X, 64X baud rate	$t_{RPW}$		1		$t_{C(\phi)}$	
$t_{W(RPWH)}$	Receiver input clock high pulse width	1X baud rate	$t_{RPD}$		15		$t_{C(\phi)}$	
		16X, 64X baud rate	$t_{RPD}$		3		$t_{C(\phi)}$	
$t_{SU(A-R)}$	Address setup time before read ( $\overline{CS}$ , $C/D$ ) (Note3)		$t_{AR}$		0			ns
$t_{H(R-A)}$	Address hold time after read ( $\overline{CS}$ , $C/D$ ) (Note3)		$t_{RA}$		0			ns
$t_{W(R)}$	Read pulse width		$t_{RR}$		250			ns
$t_{SU(A-W)}$	Address setup time before write		$t_{AW}$		0			ns
$t_{H(W-A)}$	Address hold time after write		$t_{WA}$		0			ns
$t_{W(W)}$	Write pulse width		$t_{WW}$		250			ns
$t_{SU(DO-W)}$	Data setup time before write		$t_{DW}$		150			ns
$t_{H(W-DO)}$	Data hold time after write		$t_{WD}$		20			ns
$t_{SU(ESO-RxC)}$	ESYNDET setup time before $R_xC$		$t_{ES}$		18			$t_{C(\phi)}$
$t_{SU(C-R)}$	Control setup time before read		$t_{CR}$		20			$t_{C(\phi)}$
$t_{RV}$	Write recovery time between writes (Note4)		$t_{RV}$		6			$t_{C(\phi)}$
$t_{SU(RxD-tS)}$	$R_xD$ setup time before internal sampling pulse		$t_{SRx}$		2			$\mu\text{s}$
$t_{H(tS-RxD)}$	$R_xD$ hold time after internal sampling pulse		$t_{HRx}$		2			$\mu\text{s}$

Note 1 : The  $T_xC$  and  $R_xC$  frequencies have the following limitations with respect to CLK.

For 1X baud rate  $f_{TX}$ ,  $f_{RX} \leq 1/(30t_{C(\phi)})$ . For 16X 64X baud rate  $f_{TX}$ ,  $f_{RX} \leq 1/(4.5t_{C(\phi)})$

2 : Reset pulse width =  $6t_{C(\phi)}$  minimum. System clock must be running during reset.

3 :  $\overline{CS}$ ,  $C/D$  are considered as address.

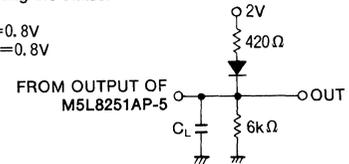
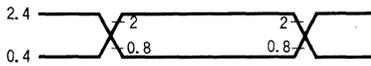
4 : This recovery time is for mode initialization only. Write data is allowed only when  $T_xRDY=1$ . Recovery time between writes for asynchronous mode is  $8t_{C(\phi)}$ , and that for synchronous mode is  $16t_{C(\phi)}$ .

**PROGRAMMABLE COMMUNICATION INTERFACE**

**SWITCHING CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 5\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Test conditions (Note7)	Limits			Unit
				Min	Typ	Max	
$t_{pZV(R-DO)}$	Output data enable time after read (Note5)	$t_{RD}$	$C_L = 150\text{pF}$			200	ns
$t_{pVZ(R-DO)}$	Output data disast. time after read	$t_{DF}$		10		100	ns
$t_{pZV(Tx-C-TxD)}$	TxD enable time after falling edge of $\overline{T_xC}$	$t_{DTx}$				1	$\mu\text{s}$
$t_{PLH(CLB-TxR)}$	Propagation time from center of last bit to $T_xRDY$ clear (Note6)	$t_{TxRDY}$				8	$t_C(\neq)$
$t_{PHL(W-TxR)}$	Propagation time from write data to $T_xRCY$ (Note5)	$t_{TxRDY \text{ CLEAR}}$				400	ns
$t_{PLH(CLB-RxR)}$	Propagation time from center of last bit to $R_xRDY$ (Note6)	$t_{RxRDY}$				26	$t_C(\neq)$
$t_{PHL(R-RxR)}$	Propagation time from read data to $R_xRDY$ clear (Note6)	$t_{RxRDY \text{ CLEAR}}$				400	ns
$t_{PLH(RxD-SyD)}$	Propagation time from rising edge of $R_xC$ to internal SYNDY (Note6)	$t_{IS}$				26	$t_C(\neq)$
$t_{PLH(CLB-TxE)}$	Propagation time from center of last bit to $T_xEMPTY$ (Note5)	$t_{TxEMPTY}$		20			$t_C(\neq)$
$t_{PHL(W-C)}$	Propagation time from rising edge of $\overline{WR}$ to control (Note5)	$t_{WC}$		8			$t_C(\neq)$

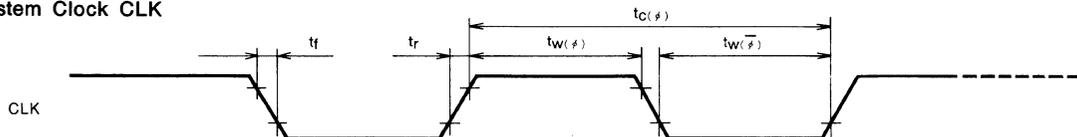
- Note 5 : Assumes that address is valid before falling edge of RD  
 Note 6 : Status-up date can have a maximum delay of 28 clock periods from the event affecting the status.  
 Note 7 : Input pulse level                    0.45–2.4V    Reference level    Input  
           Input pulse rise time            20ns                    Output  $V_{IH} = 2V$ ,  $V_{IL} = 0.8V$   
           Input pulse fall time            20ns                    Load  $V_{OH} = 2V$ ,  $V_{OL} = 0.8V$



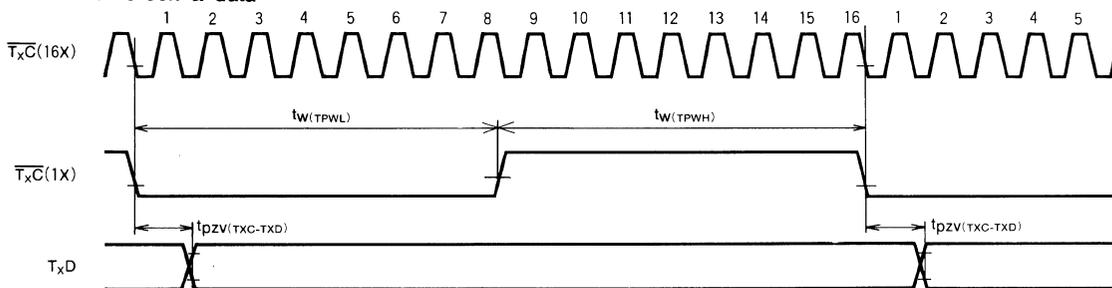
**PROGRAMMABLE COMMUNICATION INTERFACE**

**TIMING DIAGRAMS**

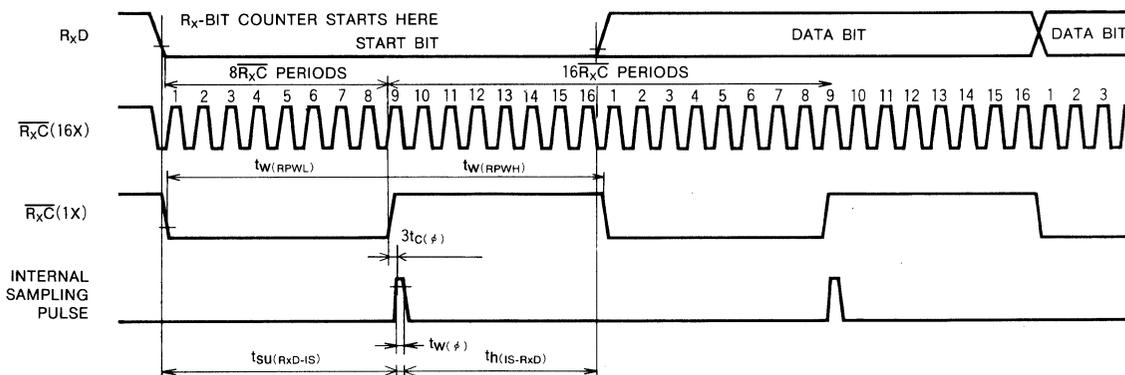
System Clock CLK



Transmitter Clock & data



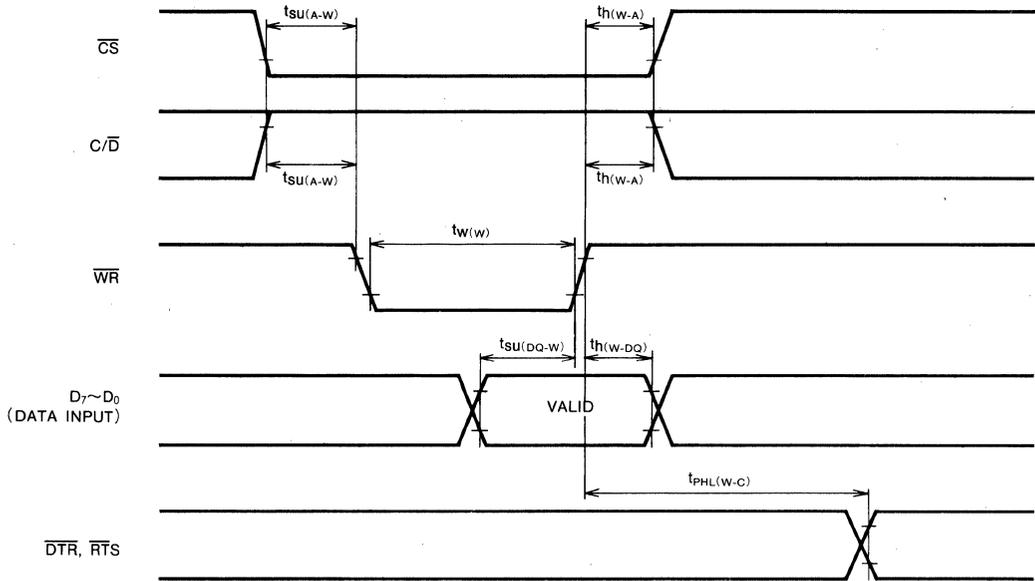
Receiver Clock & data



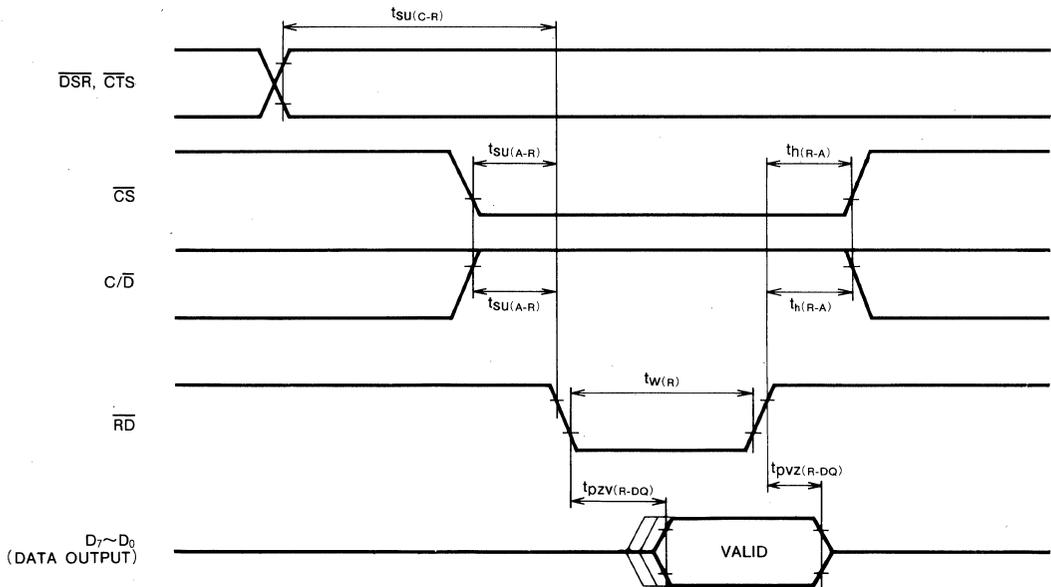
4

**PROGRAMMABLE COMMUNICATION INTERFACE**

**Write Control Cycle (CPU→USART)**

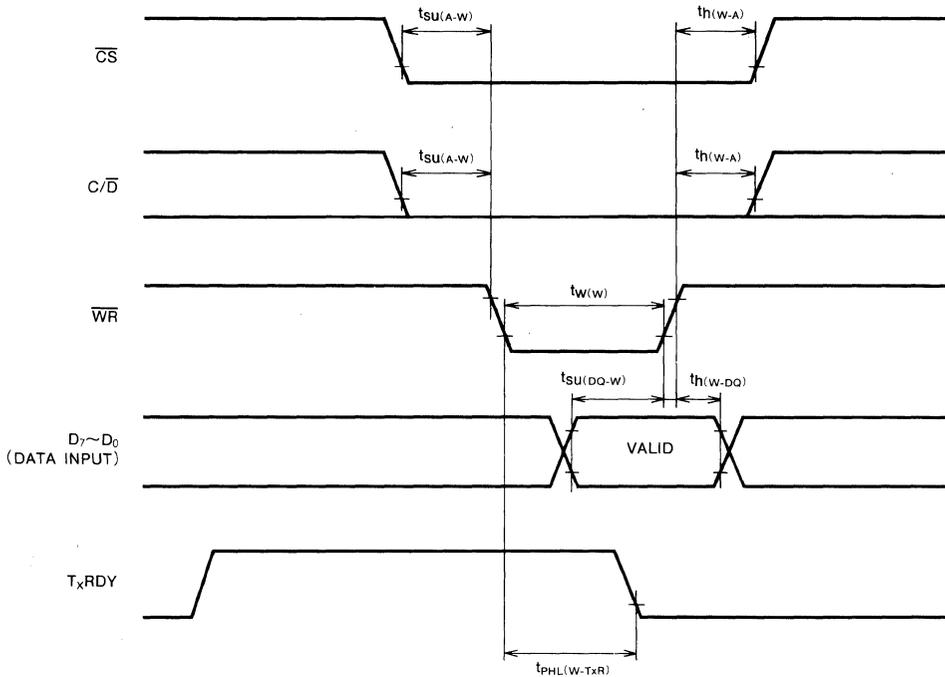


**Read Control Cycle (USART→CPU)**

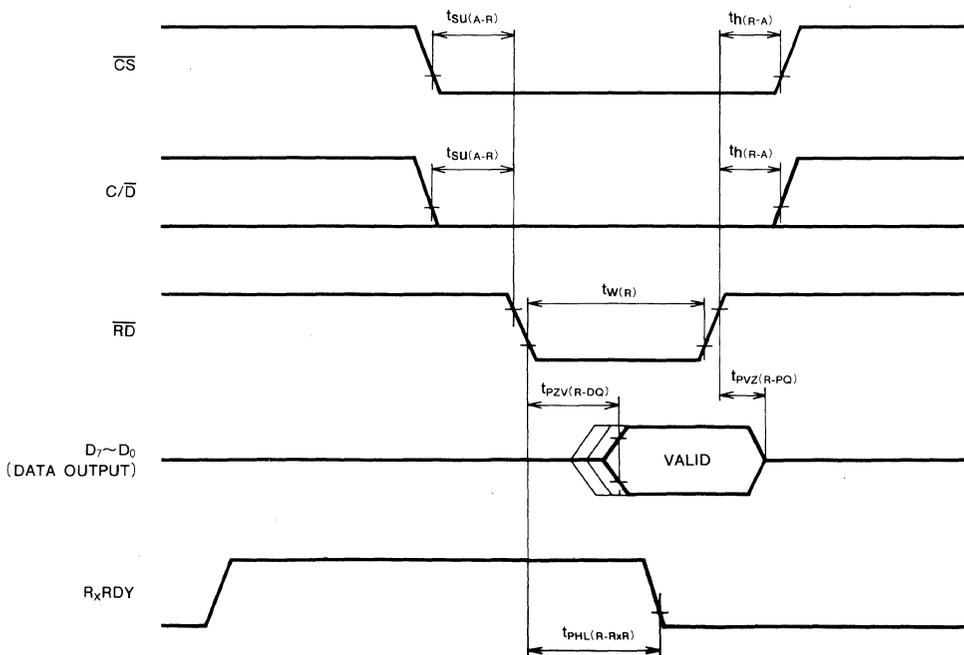


PROGRAMMABLE COMMUNICATION INTERFACE

Write Data Cycle (CPU→USART)



Read Data Cycle (USART→CPU)

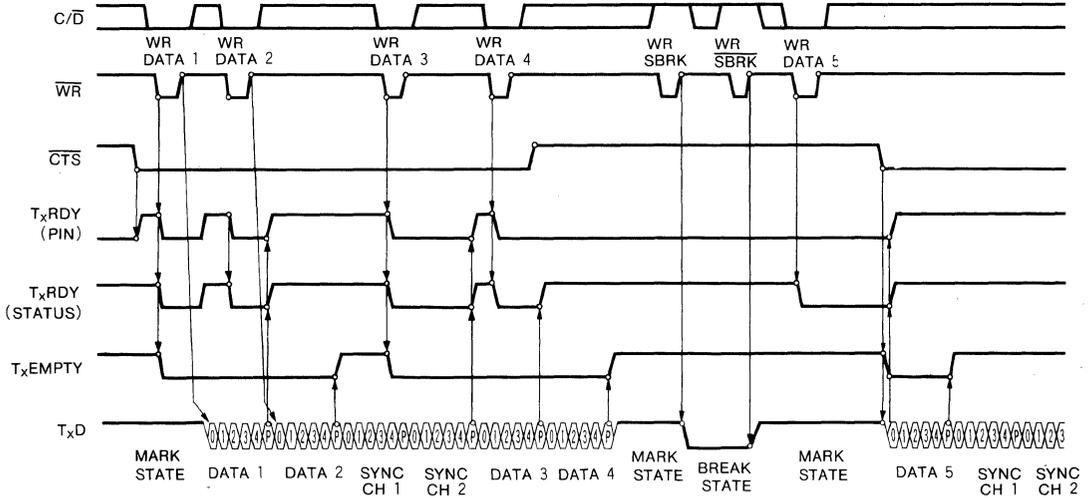


4



**PROGRAMMABLE COMMUNICATION INTERFACE**

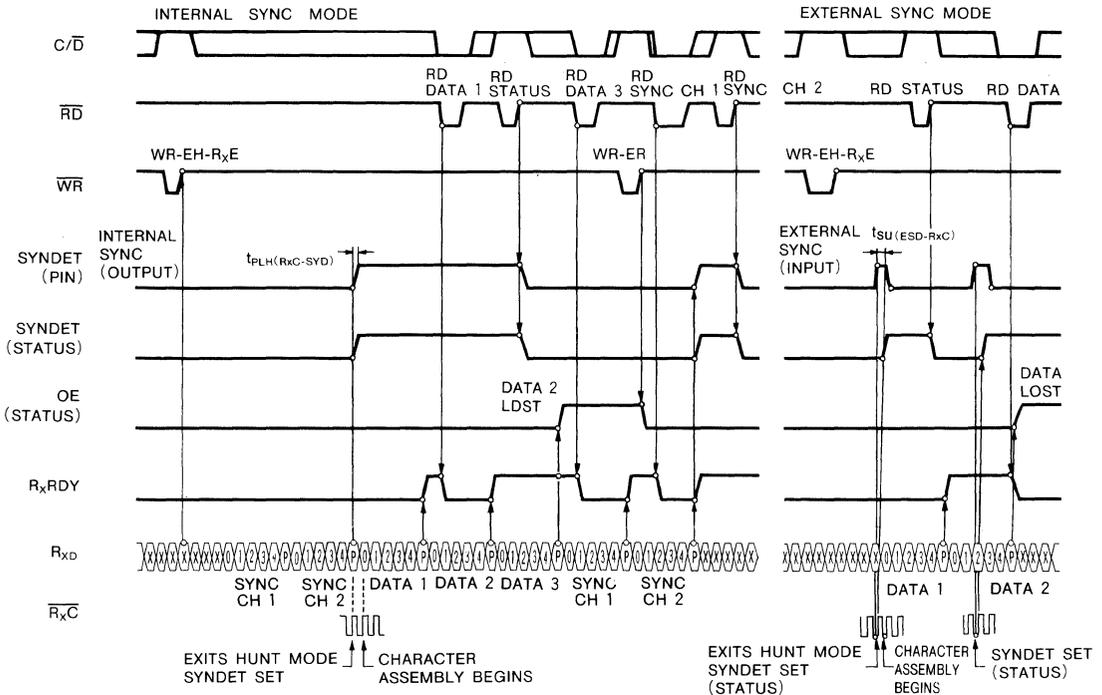
**Transmitter Control & Flag Timing (Sync Mode)**



Note 12 : Example format = 5 bits/character with parity, bi-sync characters.

4

**Receiver Control & Flag Timing (Sync Mode)**



Note 13 : Example format = 5 bits/character with parity, bi-sync characters.

MITSUBISHI LSIs  
**M5L8253P-5**

**PROGRAMMABLE INTERVAL TIMER**

**DESCRIPTION**

The M5L8253P-5 is a programmable general-purpose timer device developed by using the N-channel silicon-gate ED-MOS process. It offers counter and timer functions in systems using an 8-bit parallel-processing CPU.

The use of the M5L8253P-5 frees the CPU from the execution of looped programs, count-operation programs and other simple processing involving many repetitive operations, thus contributing to improved system throughputs.

The M5L8253P-5 works on a single power supply, and both its input and output can be connected to a TTL circuit.

**FEATURES**

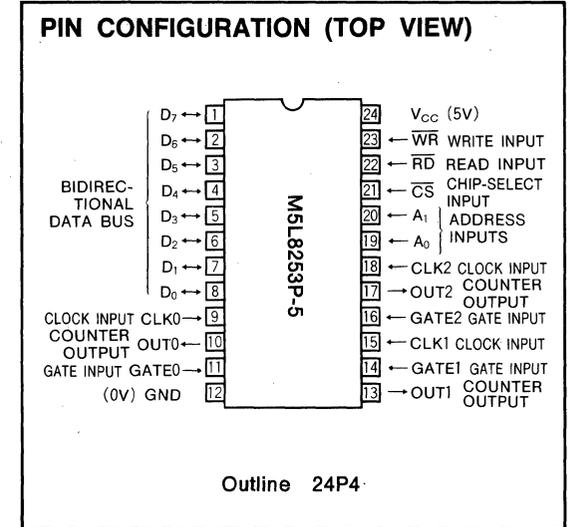
- Single 5V supply voltage
- TTL compatible
- Clock period: DC~2MHz
- 3 independent built-in 16-bit down counters
- 6 counter modes freely assignable for each counter
- Binary or decimal counts

**APPLICATION**

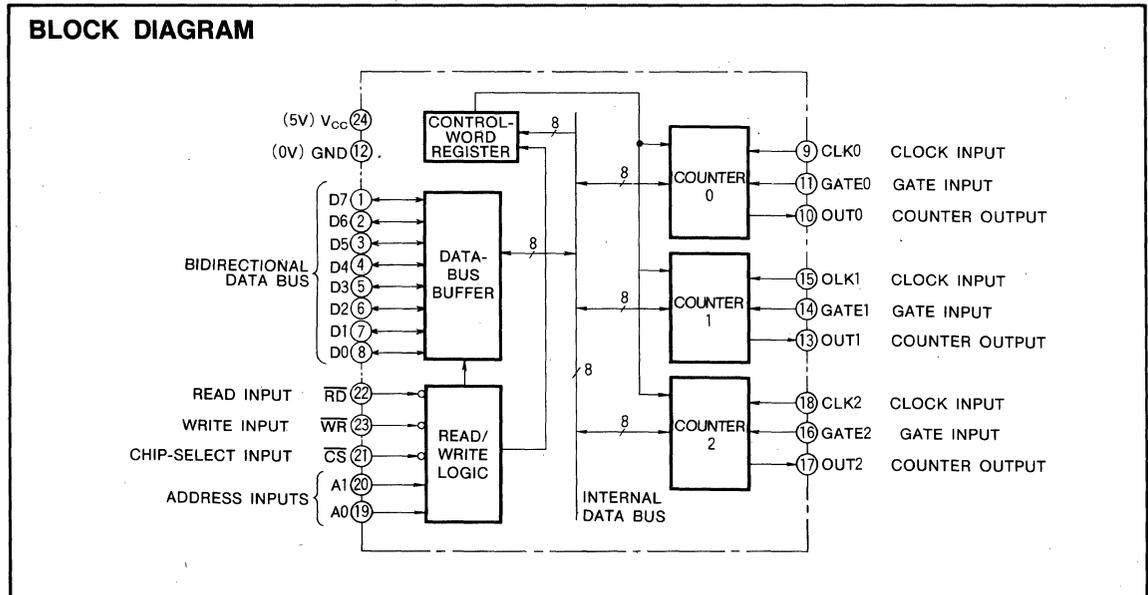
Delayed-time setting, pulse counting and rate generation in microcomputers.

**FUNCTION**

Three independent 16-bit counters allow free programming based on mode-control instructions from the CPU. When roughly classified, there are 6 modes (0~5). Mode 0 is mainly used as an interruption timer and event counter, mode 1 as a digital one-shot, modes 2 and 3 as rate generators, mode 4 for a software triggered strobe, and mode 5 for a



hardware triggered strobe. The count can be monitored and set at any time. The counter operates with either the binary or BCD system.



## PROGRAMMABLE INTERVAL TIMER

## DESCRIPTION OF FUNCTIONS

## Data-Bus Buffer

This 3-state, bidirectional, 8-bit buffer is used to interface the M5L8253P-5 to the system-side data bus. Transmission and reception of all the data including control words for mode designation and values written in, and read from, the counters are carried out through this buffer.

## Read/Write Logic

The read/write logic accepts control signals ( $\overline{RD}$ ,  $\overline{WR}$ ) from the system and generates control signals for each counter. It is enabled or disabled by the chip-select signal ( $\overline{CS}$ ); if  $\overline{CS}$  is at the high-level the data-bus buffer enters a floating (high-impedance) state.

Read Input ( $\overline{RD}$ )

The count of the counter designated by address inputs  $A_0$  and  $A_1$  on the low-level is output to the data bus.

Write Input ( $\overline{WR}$ )

Data on the data bus is written in the counter or controlword register designated by address inputs  $A_0$  and  $A_1$  on the low-level.

Address Inputs ( $A_0$ ,  $A_1$ )

These are used for selecting one of the 3 internal counters and either of the control-word registers.

Chip-Select Input ( $\overline{CS}$ )

A low-level on this input enables the M5L8253P-5. Changes in the level of the  $\overline{CS}$  input have no effect on the operation of the counters.

## Control-Word Register

This register stores information required to give instructions about operational modes and to select binary or BCD counting. Unlike the counters, it allows no reading, only writing.

## Counters 0,1 and 2

These counters are identical in operation and independent of each other. Each is a 16-bit, presetable, down counter, and has clock-input, gate-input and output pins. The counter can operate in either binary or BCD using the falling edge of each clock. The mode of counter operation and the initial value from which to start counting can be designated by software. The count can be read by input instruction at any time, and there is a "read-on-the-fly" function which enables stable reading by latching each instantaneous count to the registers by a special counter-latch instruction.

## CONTROL WORD AND INITIAL-VALUE LOADING

The function of the M5L8253P-5 depends on the system software. The operational mode of the counters can be specified by writing control words ( $A_0$ ,  $A_1 = 1, 1$ ) into the control-word registers.

The programmer must write out to the M5L8253P-5 the programmed number of count register bytes (1 or 2) prior to actually using the selected counter.

Table 2 shows control-word format, which consists of 4 fields. Only the counter selected by the  $D_7$  and  $D_6$  bits of the control word is set for operation. Bits  $D_5$  and  $D_4$  are used for specifying operations to read values in the counter and to initialize. Bits  $D_3 \sim D_1$  are used for mode designation, and  $D_0$  for specifying binary or BCD counting. When  $D_0 = 0$ , binary counting is employed, and any number from  $0000_{16}$  to  $FFFF_{16}$  can be loaded into the count register. The counter is counted down for each clock. The counting of  $0000_{16}$  causes the transmission of a time-out signal from the count-output pin.

The maximum number of counts is obtained when  $0000_{16}$  is set as the initial value. When  $D_0 = 1$ , BCD counting is employed, and any number from  $0000_{10}$  to  $9999_{10}$  can be loaded on the counter.

Neither system resetting nor connecting to the power supply sets the control word to any specific value. Thus to bring the counters into operation, the above-mentioned control words for mode designation must be given to each counter, and then 1~2 byte initial counter values must be set. The following is an example of this programming step.

To designate mode 0 for counter 1, with initial value  $8253_{16}$  set by binary count, the following program is used:

```

MVI   A, 7016   Control word 7016
OUT   n1       n1 is control-word-register address
MVI   A, 5316   Low-order 8 bits
OUT   n2       n2 is counter 1 address
MVI   A, 8216   High-order 8 bits
OUT   n2       n2 is counter 1 address

```

Thus, the program generally has the following sequence:

- (1) Control-word output to counter  $i$  ( $i=0, 1, 2$ ).
- (2) Initialization of low-order 8 counter bits
- (3) Initialization of high-order 8 counter bits

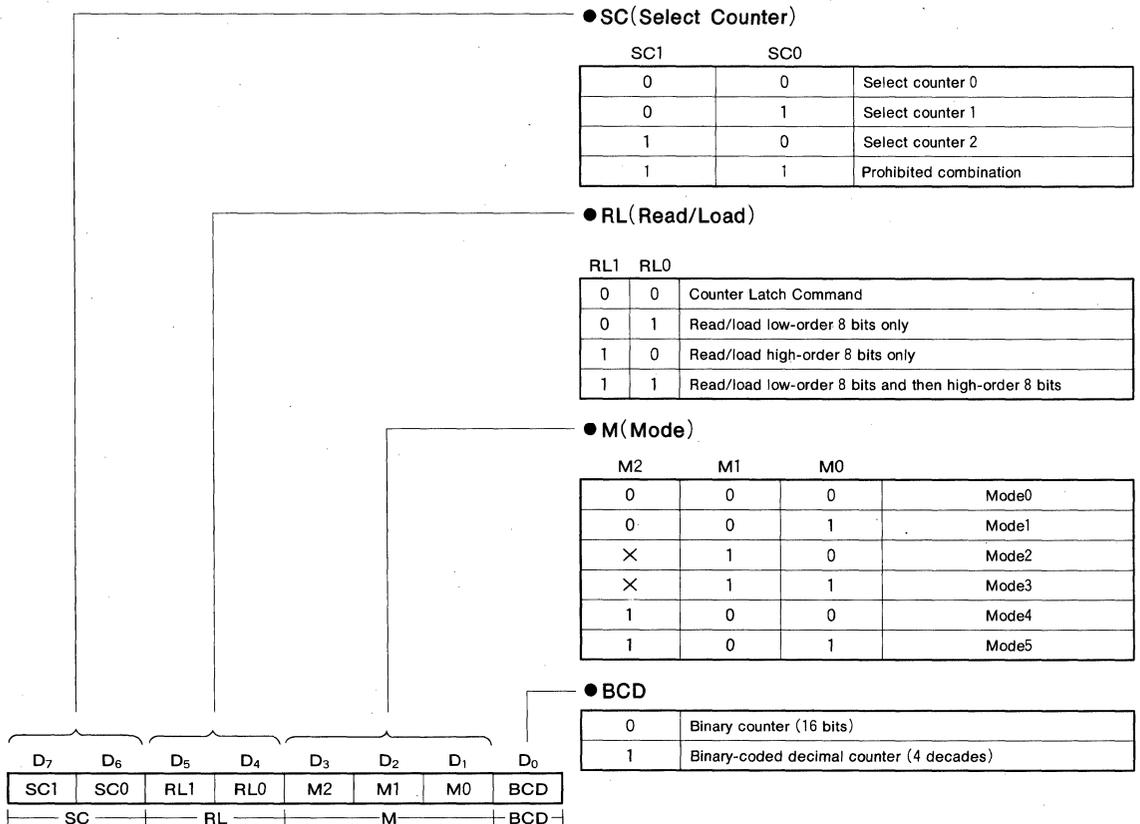
The three counters can be executed in any sequence. It is possible, for instance, to designate the mode of each counter and then load initial values in a different order. Initialization of the counters designated by RL 1 and RL 0 must be executed in the order of the low-order 8 bits and then the high-order 8 bits for the counter in question.

**PROGRAMMABLE INTERVAL TIMER**

**Table 1 Basic Functions**

$\overline{CS}$	$\overline{RD}$	$\overline{WR}$	A <sub>1</sub>	A <sub>0</sub>	Function
0	1	0	0	0	Data bus→Counter 0
0	1	0	0	1	Data bus→Counter 1
0	1	0	1	0	Data bus→Counter 2
0	1	0	1	1	Data bus→Control-word register
0	0	1	0	0	Data bus←Counter 0
0	0	1	0	1	Data bus←Counter 1
0	0	1	1	0	Data bus←Counter 2
0	0	1	1	1	3-state
1	X	X	X	X	3-state
0	1	1	X	X	3-state

**Table 2 Control-Word Format**



**PROGRAMMABLE INTERVAL TIMER**

**MODE DEFINITION**

**Mode 0 (Interrupt on Terminal Count)**

Mode set and initialization cause the counter output to go low-level (see Fig. 1). When the counter is loaded with an initial value, it will start counting the clock input. When the terminal count is reached, the output will go high and remain high until the selected count register is reloaded with the mode. This mode can be used when the CPU is to be interrupted after a certain period or at the time of counting up.

Fig. 1 shows a setting of 4 as the initial value. If gate input goes low, counting is inhibited for the duration of the low-level period.

Reloading of the initial value during count operation will stop counting by the loading of the first byte and start the new count by the loading of the second byte.

**Mode 1 (Programmable One-Shot)**

The gate input functions as a trigger input. A gate-input rising edge causes the generation of low-level one-shot output with a predetermined clock length starting from the next clock. Fig. 2 shows an initial setting of 4. While the counter output is at the low-level (during one-shot), loading of a new value does not change the one-shot pulse width, which has already been output. The current count can be read at any time without affecting the width of the one-shot pulse being output. This mode permits retriggering.

**Mode 2 (Rate Generator)**

Low-level pulses during one clock operation are generated from the counter output at a rate of one per  $n$  clock inputs (where  $n$  is the value initially set for the counter). When a new value is loaded during the counter operation, it is reflected on the output after the pulses by the current count have been output. In the example shown in Fig. 3,  $n$  is given as 4 at the outset and is then changed to 3.

In this mode, the gate input provides a reset function. While it is on the low-level, the output is maintained high; the counter restarts from the initial value, triggered by a rising gate-input edge. This gate input, therefore, makes possible external synchronization of the counter by hardware.

After the mode is set, the counter does not start counting until the rate  $n$  is loaded into the count register, with the counter output remaining at the high-level.

**Mode 3 (Square Rate Generator)**

This is similar to Mode 2 except that it outputs a square wave with the half count of the set rate. When the set value  $n$  is odd, the square-wave output will be high for  $(n+1)/2$  clock-input counts and low for  $(n-1)/2$  counts. When a new rate is reloaded into the count register during its operation, it is immediately reflected on the count directly following the output transition (high-to-low or low-to-high) of the current count. Gate-input operations are exactly the same as in Mode 2. Fig. 4 shows an example of Mode 3 operation.

**Mode 4 (Software Triggered Strobe)**

After the mode is set, the output will be high. By loading a

number on the counter, however, clock-input counts can be started and on the terminal count, the output will go low for one input-clock period and then will go high again. Mode 4 differs from Mode 2 in that pulses are not output repeatedly with the same set count. The pulse output is delayed one clock period in Mode 2, as shown in Fig. 5. When a new value is loaded into the count register during its count operation, it is reflected on the next pulse output without affecting the current count. The count will be inhibited while the gate input is low-level.

**Mode 5 (Hardware Triggered Strobe)**

This is a variation of Mode 1. The gate input provides a trigger function, and the count is started by its rising edge. On the terminal count, the counter output goes low for one clock period and then goes high. As in Mode 1, retriggering by the gate input is possible. An example of timing in Mode 5 is shown in Fig. 6.

As mentioned above, the gate input plays different roles according to the mode. The functions are summarized in Table 3.

**Table 3 Gate Operations**

Gate Mode	Low or going low	Rising	High
0	Disables counting		Enables counting
1		(1) Initiates counting (2) Resets output after next clock	
2	(1) Disables counting (2) Sets output high immediately	(1) Reloads counter (2) Initiates counting	Enables counting
3	(1) Disables counting (2) Sets output high immediately	(1) Reloads counter (2) Initiates counting	Enables counting
4	Disables counting		Enables counting
5		Initiates counting	

PROGRAMMABLE INTERVAL TIMER

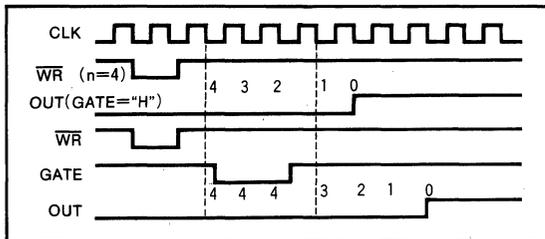


Fig. 1 Mode 0

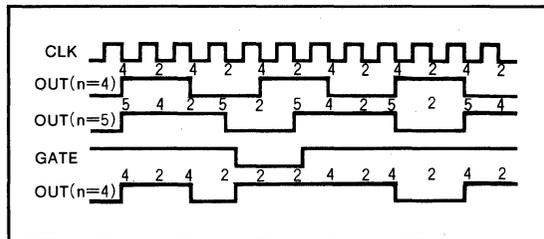


Fig. 4 Mode 3

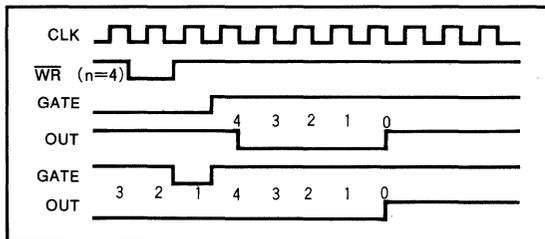


Fig. 2 Mode 1

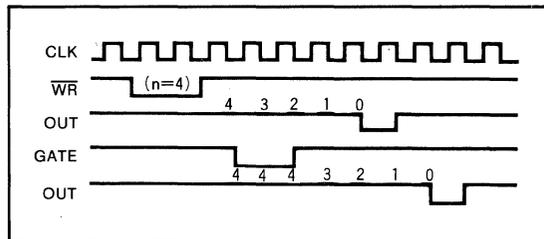


Fig. 5 Mode 4

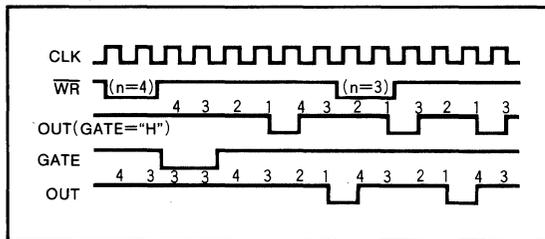


Fig. 3 Mode 2

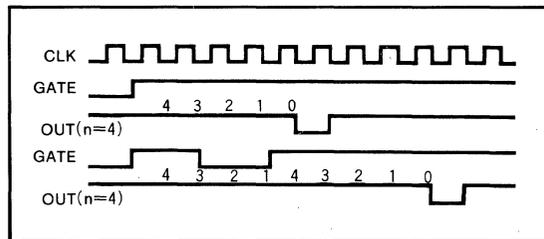


Fig. 6 Mode 5

COUNTER MONITORING

Sometimes the counter must be monitored by reading its count or using it as an event counter. The M5L8253P-5 offers the following two methods for count reading:

Read Operation

The count can be read by designating the address of the counter to be monitored and executing a simple I/O read operation. In order to ensure correct reading of the count, it is necessary to cause the clock input to pause by external logic or prevent a change in the count by gate input. An example of a program to read the counter 1 count is shown below. If RL1, RL0=1, 1 has been specified in the control word, the first IN instruction enables the low-order 8 bits to be read and the second IN instruction enables the higher 8 bits.

```
IN    n2 ... n2 is the counter 1 address
MOV  D, A
IN    n2
MOV  E, A
```

The IN instruction should be executed once or twice by the RL1 and RL0 designations in the control-word register.

Read-on-the-Fly Operation

This method makes it possible to read the current count without affecting the count operation at all. A special counter-latch command is first written in the control-word register. This causes latching of all the instantaneous counts to the register, allowing retention of stable counts. An example of a program to execute this operation for counter 2 is given below.

```
MVI  A, 1000XXXX ... D5=D4=0 designates counter
                           latching
OUT  n1 ... n1 is the control-word-register address
IN   n3 ... n3 is the counter 2 address
MOV  D, A
IN   n3
MOV  E, A
```

In this example, the IN instruction is executed twice. Due to the internal logic of the M5L8253P-5 it is absolutely essential to complete the entire reading procedure. If two bytes are programmed to be read, then two bytes must be read before any OUT instruction can be executed to the same counter.

**PROGRAMMABLE INTERVAL TIMER**

**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Power supply voltage	With respect to GND	-0.5~7	V
$V_I$	Input voltage		-0.5~7	V
$V_O$	Output voltage		-0.5~7	V
$P_d$	Maximum power dissipation	$T_a=25^\circ\text{C}$	1000	mW
$T_{opr}$	Operating free-air temperature range		-20~75	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		-65~150	$^\circ\text{C}$

**RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Power supply voltage	4.5	5	5.5	V
$V_{SS}$	Supply voltage (GND)		0		V
$V_{IH}$	High-level input voltage	2.2		$V_{CC}+0.5$	V
$V_{IL}$	Low-level input voltage	-0.5		0.8	V

**4**

**ELECTRICAL CHARACTERISTICS** ( $T_a=-20\sim75^\circ\text{C}$ ,  $V_{CC}=5\text{V}\pm 10\%$ , unless otherwise noted.)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{OH}$	High-level output voltage	$V_{SS}=0\text{V}$ , $I_{OH}=-400\mu\text{A}$	2.4			V
$V_{OL}$	Low-level output voltage	$V_{SS}=0\text{V}$ , $I_{OL}=2.2\text{mA}$			0.45	V
$I_{IH}$	High-level input current	$V_{SS}=0\text{V}$ , $V_I=5.5\text{V}$			$\pm 10$	$\mu\text{A}$
$I_{IL}$	Low-level input current	$V_{SS}=0\text{V}$ , $V_I=0\text{V}$			$\pm 10$	$\mu\text{A}$
$I_{OZ}$	Off-state output current	$V_{SS}=0\text{V}$ , $V_I=0\sim V_{CC}$			$\pm 10$	$\mu\text{A}$
$I_{CC}$	Power supply current	$V_{SS}=0\text{V}$			140	mA
$C_i$	Input capacitance	$V_{IL}=V_{SS}$ , $f=1\text{MHz}$ , $25\text{mVrms}$ , $T_a=25^\circ\text{C}$			10	pF
$C_{i/O}$	Input/output capacitance	$V_{i/O}=V_{SS}$ , $f=1\text{MHz}$ , $25\text{mVrms}$ , $T_a=25^\circ\text{C}$			20	pF

PROGRAMMABLE INTERVAL TIMER

**TIMING REQUIREMENTS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5\text{V} \pm 10\%$ ,  $V_{SS} = 0\text{V}$ )

Read cycle

Symbol	Parameter	Alternative symbol	Test condition	Limits			Unit
				Min	Typ	Max	
$t_{W(R)}$	Read pulse width	$t_{RR}$	$C_L = 150\text{pF}$	300			ns
$t_{SU(A-R)}$	Address setup time before read	$t_{AR}$		30			ns
$t_{H(R-A)}$	Address hold time after read	$t_{RA}$		5			ns
$t_{rec(R)}$	Read recovery time	$t_{RV}$		1000			ns

Write cycle

Symbol	Parameter	Alternative symbol	Test condition	Limits			Unit
				Min	Typ	Max	
$t_{W(W)}$	Write pulse width	$t_{WW}$	$C_L = 150\text{pF}$	300			ns
$t_{SU(A-W)}$	Address setup time before write	$t_{AW}$		30			ns
$t_{H(W-A)}$	Address hold time after write	$t_{WA}$		30			ns
$t_{SU(D-W)}$	Data setup time before write	$t_{DW}$		250			ns
$t_{H(W-D)}$	Data hold time after write	$t_{WD}$		30			ns
$t_{rec(W)}$	Write recovery time	$t_{RV}$		1000			ns

Clock and gate timing

Symbol	Parameter	Alternative symbol	Test condition	Limits			Unit
				Min	Typ	Max	
$t_{W(\neq H)}$	Clock high pulse width	$t_{PWH}$	$C_L = 150\text{PF}$	230			ns
$t_{W(\neq L)}$	Clock low pulse width	$t_{PWL}$		150			ns
$t_{C(\neq)}$	Clock cycle time	$t_{CLK}$		380		DC	ns
$t_{W(GH)}$	Gate high pulse width	$t_{GW}$		150			sn
$t_{W(GL)}$	Gate low pulse width	$t_{GL}$		100			ns
$t_{SU(G-\neq)}$	Gate setup time before clock	$t_{GS}$		100			ns
$t_{H(\neq G)}$	Gate hold time after clock	$t_{GH}$		50			ns

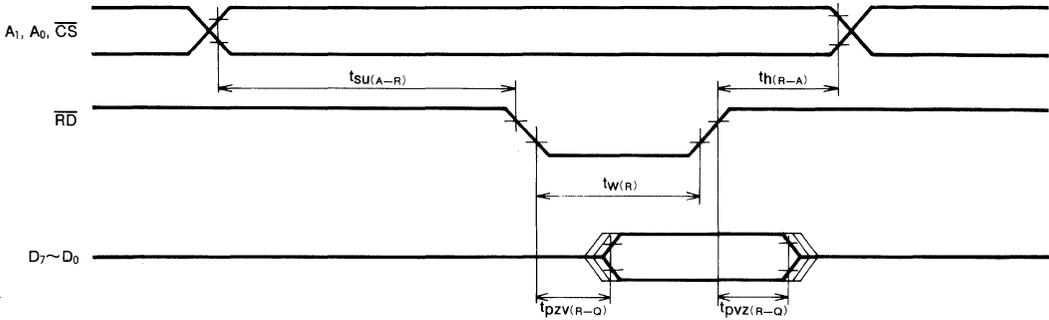
**SWITCHING CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5\text{V} \pm 10\%$ ,  $V_{SS} = 0\text{V}$ )

Symbol	Parameter	Alternative symbol	Test condition	Limits			Unit
				Min	Typ	Max	
$t_{PZV(R-Q)}$	Propagation time from read to output	$t_{RD}$	$C_L = 150\text{pF}$			200	ns
$t_{PVZ(R-Q)}$	Propagation time from read to output floating	$t_{DF}$		25		100	ns
$t_{PXV(G-Q)}$	Propagation time from gate to output	$t_{ODG}$				300	ns
$t_{PXV(\neq Q)}$	Propagation time from clock to output	$t_{OD}$				400	ns

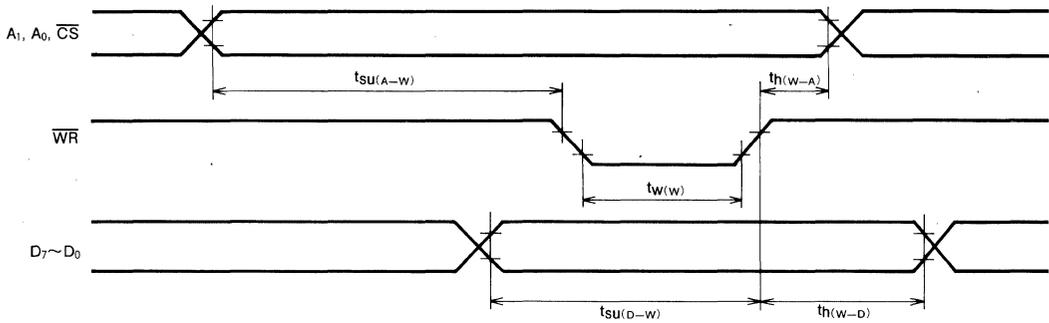
**PROGRAMMABLE INTERVAL TIMER**

**TIMING DIAGRAMS** (Reference Voltage: High=2.2V, Low=0.8V)

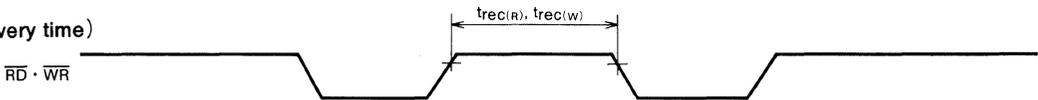
**Read Cycle**



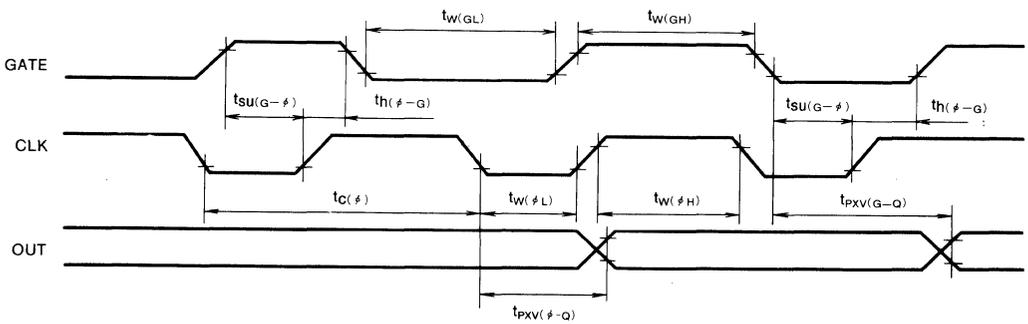
**Write Cycle**



**(recovery time)**



**Clock and Gate Cycle**



4

# M5L8255AP-5

## PROGRAMMABLE PERIPHERAL INTERFACE

### DESCRIPTION

This is a family of general-purpose programmable input/output devices designed for use with an 8-bit/16-bit parallel CPU as input/output ports. Device is fabricated using N-channel silicon-gate ED-MOS technology for a single supply voltage. They are simple input and output interfaces for TTL circuits, having 24 input/output pins which correspond to three 8-bit input/output ports.

### FEATURES

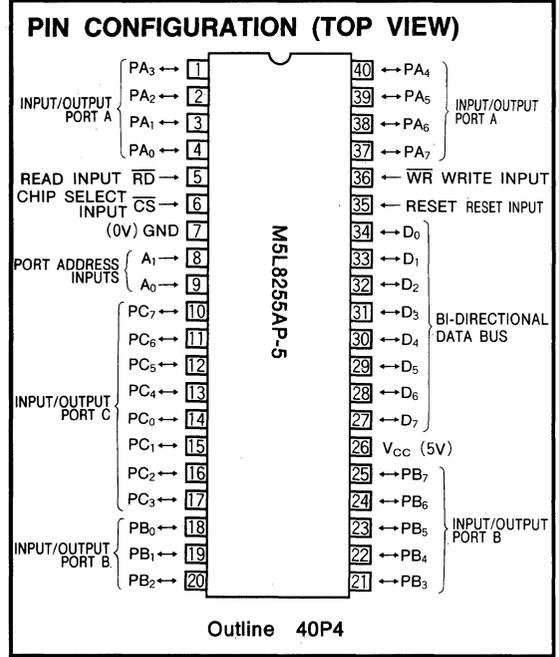
- Single 5V supply voltage
- TTL-compatible
- Darlington drive capability
- 24 programmable I/O pins
- Direct bit set/reset capability

### APPLICATION

Input/output ports for MELPS85 microprocessor

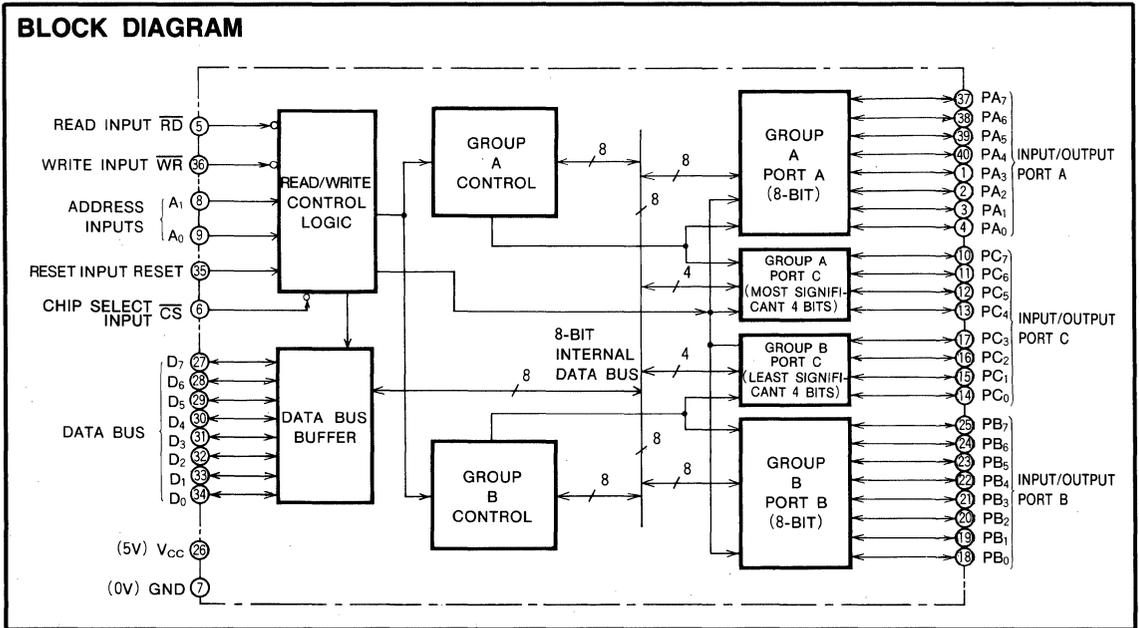
### FUNCTION

These PPIs have 24 input/output pins which may be individually programmed in two 12-bit groups A and B with mode control commands from a CPU. They are used in three major modes of operation, mode 0, mode 1 and mode 2. Operating in mode 0, each group of 12 pins may be programmed in sets of 4 to be inputs or outputs. In mode 1, the 24 I/O terminals may be programmed in two 12-bit groups, group A and group B. Each group contains one 8-bit data port, which may be programmed to serve as input or output, and one 4-bit control port used for handshaking and interrupt control signals. Mode 2 is used with group A only, as one 8-bit bidirectional bus port and one 5-bit control port. Bit set/reset is controlled by CPU. A high-level reset input (RESET) clears the control register, and all ports are set to the input mode (high-impedance state).



bit bidirectional bus port and one 5-bit control port. Bit set/reset is controlled by CPU. A high-level reset input (RESET) clears the control register, and all ports are set to the input mode (high-impedance state).

### BLOCK DIAGRAM



PROGRAMMABLE PERIPHERAL INTERFACE

FUNCTIONAL DESCRIPTION

RD (Read) Input

At low-level, the status or the data at the port is transferred to the CPU from the PPI. In essence, it allows the CPU to read data from the PPI.

WR (Write) Input

At low-level, the data or control words are transferred from the CPU and written in the PPI.

A<sub>0</sub>, A<sub>1</sub> (Port address) Input

These input signals are used to select one of the three ports: port A, port B, and port C, or the control register. They are normally connected to the least significant two bits of the address bus.

RESET (Reset) Input

At high-level, the control register is cleared. Then all ports are set to the input mode (high-impedance state).

CS (Chip-Select) Input

At low-level, the communication between the PPI and the CPU is enabled. While at high-level, the data bus is kept in the high-impedance state, so that commands from the CPU are ignored. Then the previous data is kept at the output port.

Read/Write Control Logic

The function of this block is to control transfers of both data and control words. It accepts the address signals (A<sub>0</sub>, A<sub>1</sub>, CS), I/O control signals (RD, WR) and RESET signal, and then issues commands to both of the control groups in the PPI.

Data Bus Buffer

This three-state, bidirectional, eight-bit buffer is used to transfer the data when an input or output instruction is executed by the CPU. Control words and status information are also transferred through the data bus buffer.

Group A and Group B Control

Accepting commands from the read/write control logic, the control blocks (Group A, Group B) receive 8-bit control words from the internal data bus and issue the proper commands for the associated ports. Control group A is associated with port A and the four high-order bits of port C. Control group B is associated with port B and the four low-order bits of port C. The control register, which stores control words, can only be written into.

Port A, Port B and Port C

The PPI contains three 8-bit ports whose modes and input/output settings are programmed by the system software.

Port A has an output latch/buffer and an input latch. Port B has an I/O latch/buffer and an input buffer. Port C has an output latch/buffer and an input buffer. Port C can be divided into two 4-bit ports which can be used as ports for control signals for port A and port B.

The basic operations are shown in Table 1.

Table 1 Basic Operations

A <sub>1</sub>	A <sub>0</sub>	CS	RD	WR	Operation
0	0	0	0	1	Data bus ← Port A
0	1	0	0	1	Data bus ← Port B
1	0	0	0	1	Data bus ← Port C
0	0	0	1	0	Port A ← Data bus
0	1	0	1	0	Port B ← Data bus
1	0	0	1	0	Port C ← Data bus
1	1	0	1	0	Control register ← Data bus
X	X	1	X	X	Data bus is in high-impedance state
1	1	0	0	1	illegal condition

Where, "0" indicates low level

"1" indicates high-level

Bit Set/Reset

When port C is used as an output port, any one bit of the eight bits can be set (high) or reset (low) by a control word from the CPU. This bit set/reset can be operated in the same way as the mode set, but the control word format is different. This operation is also used for INTE set/reset in mode 1 and mode 2.

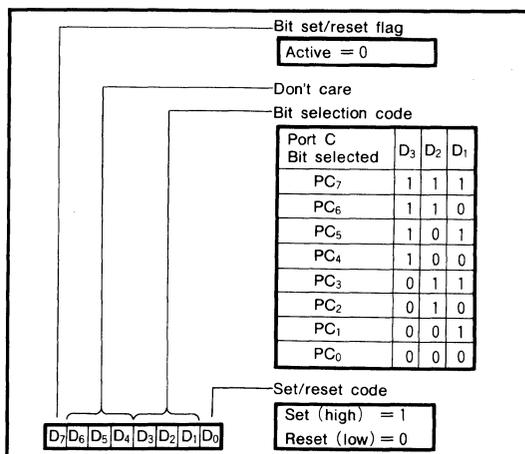


Fig. 1 Control word format for port C set/reset

**PROGRAMMABLE PERIPHERAL INTERFACE**

**BASIC OPERATING MODES**

The PPI can operate in any one of three selected basic modes.

Mode 0: Basic input/output (group A, group B)

Mode 1: Strobed input/output (group A, group B)

Mode 2: Bidirectional bus (group A only)

The mode of both group A and group B can be selected independently. The control word format for mode set is shown in Fig. 2.

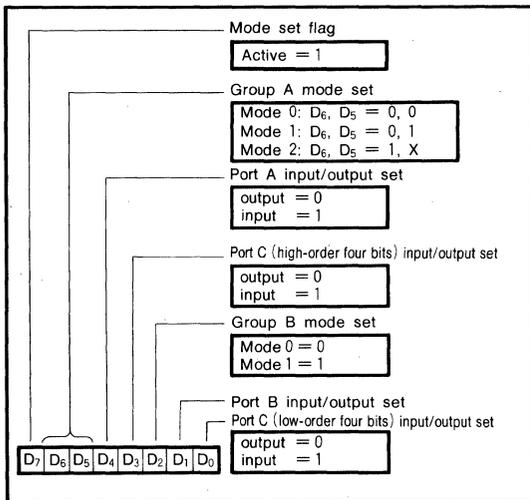
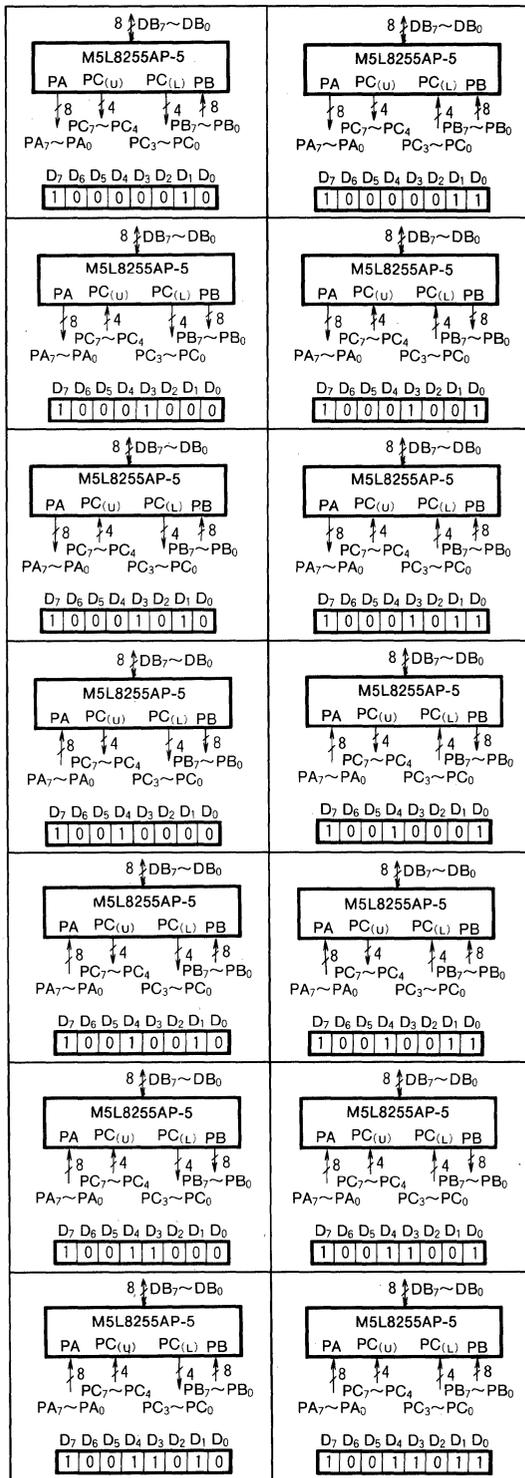
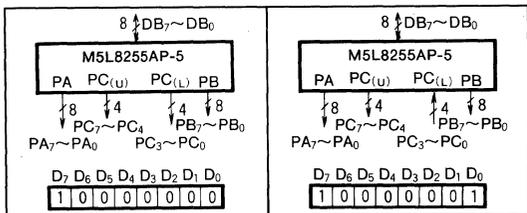


Fig. 2 Control word format for mode set.

**1. Mode 0 (Basic Input/Output)**

This functional configuration provides simple input and output operations for each of the three ports. No "handshaking" is required; data is simply written in, or read from, the specified port. Output data from the CPU to the port can be held, but input data from the port to the CPU cannot be held. Any one of the 8-bit ports and 4-bit ports can be used as an input port or an output port. The diagrams following show the basic input/output operating modes.



**PROGRAMMABLE PERIPHERAL INTERFACE**

**2. Mode 1 (Strobed Input/Output)**

This function can be set in both group A and B. Both groups are composed of one 8-bit data port and one 4-bit control data port. The 8-bit port can be used as an input port or an output port. The 4-bit port is used for control and status signals affecting the 8-bit data port. The following shows operations in mode 1 for using input ports.

**STB (Strobe Input)**

A low-level on this input latches the output data from the terminal units into the input register of the port. In short, this is a clock for data latching. The data from the terminal units can be latched by the PPI independent of the control signal from the CPU. This data is not sent to the data bus until the instruction IN is executed.

**IBF (Input Buffer Full Flag Output)**

A high-level on this output indicates that the data from the terminal units has been latched into the input register. IBF is set to high-level by the falling edge of the STB input, and is reset to low-level by the rising edge of the RD input.

**INTR (Interrupt Request Output)**

This can be used to interrupt the CPU when an input device is requesting service. When INTE (interrupt enable flag) of the PPI is high-level, INTR is set to high-level by the rising edge of the STB input and is reset to low-level by the falling edge of RD input.

INTE<sub>A</sub> of group A is controlled by bit setting of PC<sub>4</sub>. INTE<sub>B</sub> of group B is controlled by bit setting of PC<sub>2</sub>.

Mode 1 input state is shown in Fig. 3, and the timing chart is shown in Fig. 4.

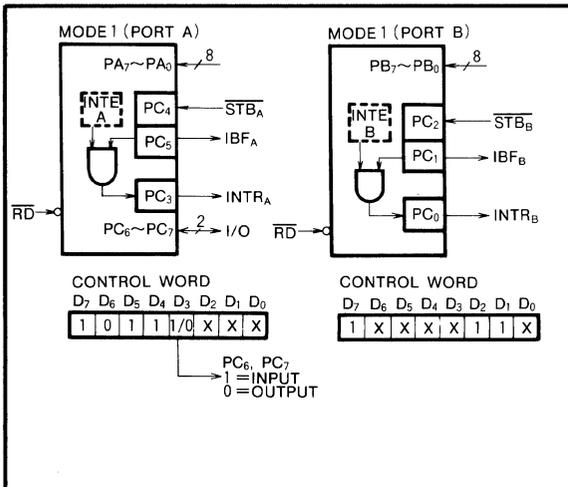


Fig. 3 An example of mode 1 input state

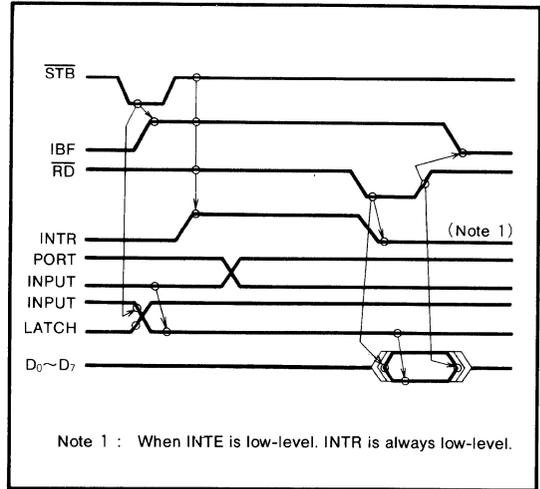


Fig. 4 Timing chart

The following shows operations using mode 1 for output ports.

**OBF (Output Buffer Full Flag Output)**

This is reset to low-level by the rising edge of the WR signal and is set to high-level by the falling edge of the ACK (acknowledge input). In essence, the PPI indicates to the terminal units by the OBF signal that the CPU has sent data to the port.

**ACK (Acknowledge Input)**

Receiving this signal from a terminal unit can indicate to the PPI that the terminal unit has accepted data from a port.

**INTR (Interrupt Request)**

When a peripheral unit is accepting data from the CPU, setting INTR to high-level can be used to interrupt the CPU. When INTE (interrupt enable flag) is high and OBF is set to high-level by the rising edge of an ACK signal, then INTR will also be set to high-level by the rising edge of the ACK signal. Also, INTR is reset to low-level by the falling edge of the WR signal when the PPI has been receiving data from the CPU.

INTE<sub>A</sub> of group A is controlled by bit setting of PC<sub>6</sub>.

INTE<sub>B</sub> of group B is controlled by bit setting of PC<sub>2</sub>.

Mode 1 output state is shown in Fig. 5, and the timing chart is shown in Fig. 6.

Combinations for using port A and port B as input or output in mode 1 are shown in Fig. 7 and Fig. 8.

**PROGRAMMABLE PERIPHERAL INTERFACE**

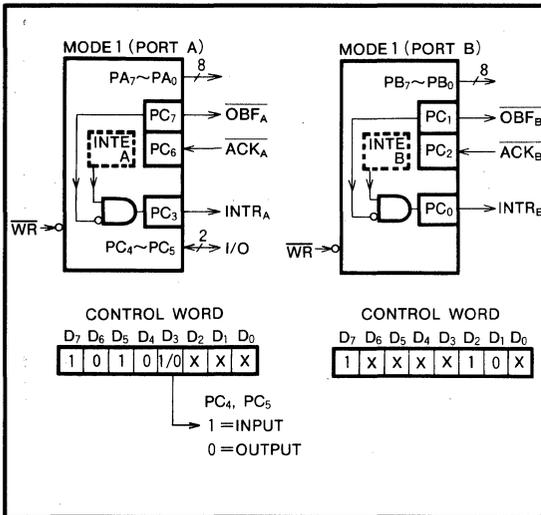


Fig. 5 Mode 1 output example

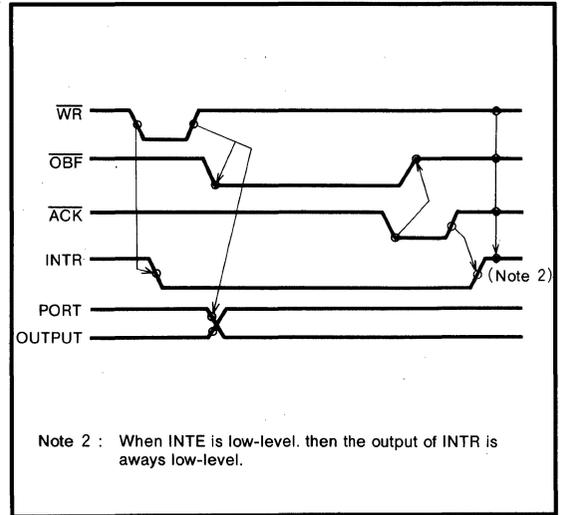


Fig. 6 Timing diagram

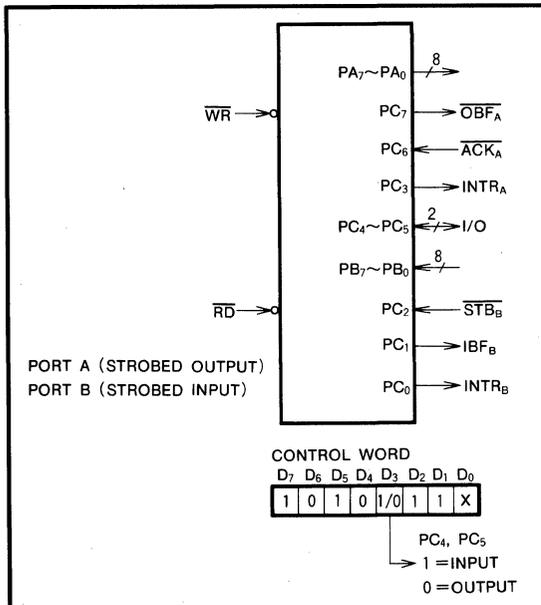


Fig. 7 Mode 1 port A and port B I/O example

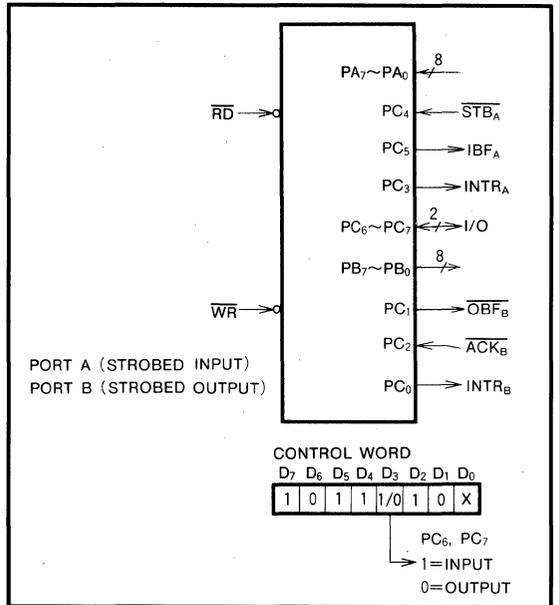


Fig. 8 Mode 1 port A and port B I/O example

PROGRAMMABLE PERIPHERAL INTERFACE

3. Mode 2 (Strobed Bidirectional Bus Input/Output)

Mode 2 can provide bidirectional operations, using one 8-bit bus for communicating with terminal units. Mode 2 is only valid with group A and uses one 8-bit bidirectional bus port (port A) and a 5-bit control port (high-order five bits of port C). The bus port (port A) has two internal registers, one for input and the other for output. On the other hand, the control port (port C) is used for communicating control signals and bus-status signals. These control signals are similar to mode 1 and can also be used to control interruption of the CPU. When group A is programmed as mode 2, group B can be programmed independently as mode 0 or mode 1. When group A is in mode 2, the following five control signals can be used.

**OBF (Output Buffer Full Flag Output)**

The OBF output will go low-level to indicate that the CPU has sent data to the internal register of port A. This signal lets the terminal units know that the data is ready for transfer from the CPU. When this occurs, port A remains in the floating (high-impedance) state.

**ACK (Acknowledge Input)**

A low-level ACK input will cause the data of the internal register to be transferred to port A. For a high-level ACK input, the output buffer will be in the floating (high-impedance) state.

**STB (Strobe Input)**

When the STB input is low-level, the data from terminal units will be held in the internal register, and the data will be sent to the system data bus with an RD signal to the PPI.

**IBF (Input Buffer Full Flag Output)**

When data from terminal units is held on the internal register, IBF will be high level.

**INTR (Interrupt Request Output)**

This output is used to interrupt the CPU and its operations the same as in mode 1. There are two interrupt enable flags that correspond to INTE<sub>A</sub> for mode 1 output and mode 1 input.

INTE<sub>1</sub> is used in generating INTR signals in combination with OBF and ACK. INTE<sub>1</sub> is controlled by bit setting of PC<sub>6</sub>.

INTE<sub>2</sub> is used in generating INTR signals in combination with IBF and STB. INTE<sub>2</sub> is controlled by bit setting of PC<sub>4</sub>.

Fig. 9 shows the timing diagram of mode 2, and Fig. 10 is an example of mode 2 operation.

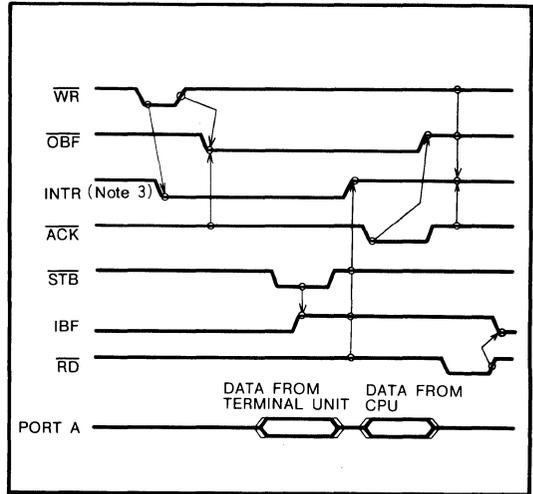


Fig. 9 Mode 2 timing diagram

Note 3 :  $INTR = IBF \cdot \overline{MASK} \cdot \overline{STB} \cdot \overline{RD} + OBF \cdot \overline{MASK} \cdot \overline{ACK} \cdot \overline{WR}$

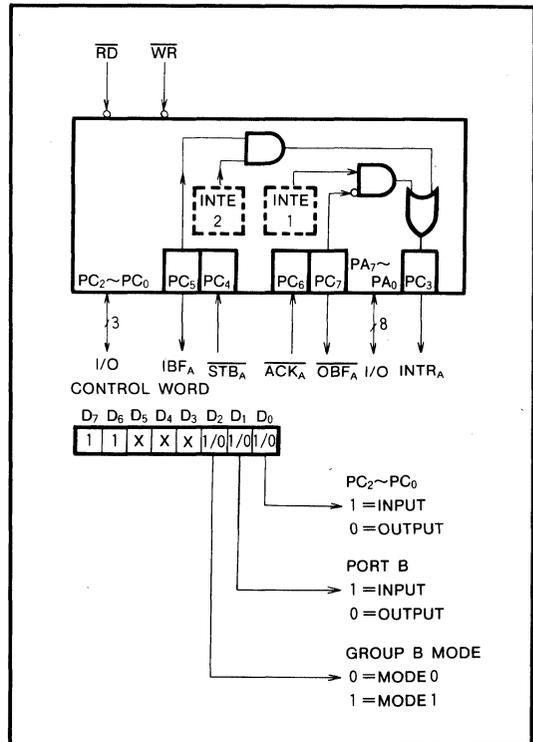


Fig. 10 An example of mode 2 operation

PROGRAMMABLE PERIPHERAL INTERFACE

4. Control Signal Read

In mode 1 or mode 2 when using port C as a control port, by CPU execution of an IN instruction, each control signal and bus status from port C can be read.

5. Control Word Tables

Control word formats and operation details for mode 0, mode 1, mode 2 and set/reset control of port C are given in Tables 3, 4, 5 and 6, respectively.

Table 2 Read-out control signals

Data Mode	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
Mode 1, input	I/O	I/O	IBF <sub>A</sub>	INTE <sub>A</sub>	INTR <sub>A</sub>	INTE <sub>B</sub>	IBF <sub>B</sub>	INTR <sub>B</sub>
Mode 1, output	$\overline{\text{OBF}}_A$	INTE <sub>A</sub>	I/O	I/O	INTR <sub>A</sub>	INTE <sub>B</sub>	$\overline{\text{OBF}}_B$	INTR <sub>B</sub>
Mode 2	$\overline{\text{OBF}}_A$	INTE <sub>1</sub>	IBF <sub>A</sub>	INTE <sub>2</sub>	INTR <sub>A</sub>	By group B mode		

Table 3 Mode 0 control words

Control words								Hexadecimal	Group A		Group B	
D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>		Port A	Port C (high order 4 bits)	Port C (low order 4 bits)	Port B
1	0	0	0	0	0	0	0	80	OUT	OUT	OUT	OUT
1	0	0	0	0	0	0	1	81	OUT	OUT	IN	OUT
1	0	0	0	0	0	1	0	82	OUT	OUT	OUT	IN
1	0	0	0	0	0	1	1	83	OUT	OUT	IN	IN
1	0	0	0	1	0	0	0	88	OUT	IN	OUT	OUT
1	0	0	0	1	0	0	1	89	OUT	IN	IN	OUT
1	0	0	0	1	0	1	0	8A	OUT	IN	OUT	IN
1	0	0	0	1	0	1	1	8B	OUT	IN	IN	IN
1	0	0	1	0	0	0	0	90	IN	OUT	OUT	OUT
1	0	0	1	0	0	0	1	91	IN	OUT	IN	OUT
1	0	0	1	0	0	1	0	92	IN	OUT	OUT	IN
1	0	0	1	0	0	1	1	93	IN	OUT	IN	IN
1	0	0	1	1	0	0	0	98	IN	IN	OUT	OUT
1	0	0	1	1	0	0	1	99	IN	IN	IN	OUT
1	0	0	1	1	0	1	0	9A	IN	IN	OUT	IN
1	0	0	1	1	0	1	1	9B	IN	IN	IN	IN

Note 4 : OUT indicates output port, and IN indicates input port.

Table 4 Mode 1 control words

Control words								Hexadecimal	Group A					Group B			
D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>		Port A	Port C					Port B		
										PC <sub>7</sub>	PC <sub>6</sub>	PC <sub>5</sub>	PC <sub>4</sub>	PC <sub>3</sub>		PC <sub>2</sub>	PC <sub>1</sub>
1	0	1	0	0	1	0	X	A4 A5	OUT	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	OUT	INTR <sub>A</sub>	$\overline{\text{ACK}}_B$	$\overline{\text{OBF}}_B$	INTR <sub>B</sub>	OUT
1	0	1	0	0	1	1	X	A6 A7	OUT	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	OUT	INTR <sub>A</sub>	$\overline{\text{STB}}_B$	IBF <sub>B</sub>	INTR <sub>B</sub>	IN
1	0	1	0	1	1	0	X	AC AD	OUT	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	IN	INTR <sub>A</sub>	$\overline{\text{ACK}}_B$	$\overline{\text{OBF}}_B$	INTR <sub>B</sub>	OUT
1	0	1	0	1	1	1	X	AE AF	OUT	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	IN	INTR <sub>A</sub>	$\overline{\text{STB}}_B$	IBF <sub>B</sub>	INTR <sub>B</sub>	IN
1	0	1	1	0	1	0	X	B4 B5	IN	OUT	IBF <sub>A</sub>	$\overline{\text{STB}}_A$	INTR <sub>A</sub>	$\overline{\text{ACK}}_B$	$\overline{\text{OBF}}_B$	INTR <sub>B</sub>	OUT
1	0	1	1	0	1	1	X	B6 B7	IN	OUT	IBF <sub>A</sub>	$\overline{\text{STB}}_A$	INTR <sub>A</sub>	$\overline{\text{STB}}_B$	IBF <sub>B</sub>	INTR <sub>B</sub>	IN
1	0	1	1	1	1	0	X	BC BD	IN	IN	IBF <sub>A</sub>	$\overline{\text{STB}}_A$	INTR <sub>A</sub>	$\overline{\text{ACK}}_B$	$\overline{\text{OBF}}_B$	INTR <sub>B</sub>	OUT
1	0	1	1	1	1	1	X	BE BF	IN	IN	IBF <sub>A</sub>	$\overline{\text{STB}}_A$	INTR <sub>A</sub>	$\overline{\text{STB}}_B$	IBF <sub>B</sub>	INTR <sub>B</sub>	IN

Note 5 : Mode of group A and group B can be programmed independently.  
 Note 6 : It is not necessary for both group A and group B to be in mode 1.

**PROGRAMMABLE PERIPHERAL INTERFACE**

**Table 5 Mode 2 control words**

Control words									Group A					Group B					
D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>	Hexa-decimal (Ex)	Port A	Port C					PortC			Port B	
									PC <sub>7</sub>	PC <sub>6</sub>	PC <sub>5</sub>	PC <sub>4</sub>	PC <sub>3</sub>	PC <sub>2</sub>	PC <sub>1</sub>	PC <sub>0</sub>			
1	1	X	X	X	0	0	0	C0	Bidirectional bus	$\overline{\text{OBF}}_A$	$\text{ACK}_A$	$\text{IBF}_A$	$\text{STB}_A$	$\text{INTR}_A$	OUT			OUT	
1	1	X	X	X	0	0	1	C1	Bidirectional bus	$\overline{\text{OBF}}_A$	$\text{ACK}_A$	$\text{IBF}_A$	$\text{STB}_A$	$\text{INTR}_A$	IN			OUT	
1	1	X	X	X	0	1	0	C2	Bidirectional bus	$\overline{\text{OBF}}_A$	$\text{ACK}_A$	$\text{IBF}_A$	$\text{STB}_A$	$\text{INTR}_A$	OUT			IN	
1	1	X	X	X	0	1	1	C3	Bidirectional bus	$\overline{\text{OBF}}_A$	$\text{ACK}_A$	$\text{IBF}_A$	$\text{STB}_A$	$\text{INTR}_A$	IN			IN	
1	1	X	X	X	1	0	X	C4	Bidirectional bus	$\overline{\text{OBF}}_A$	$\text{ACK}_A$	$\text{IBF}_A$	$\text{STB}_A$	$\text{INTR}_A$	$\text{ACK}_B$	$\text{OBF}_B$	$\text{INTR}_B$	OUT	
1	1	X	X	X	1	1	X	C6	Bidirectional bus	$\overline{\text{OBF}}_A$	$\text{ACK}_A$	$\text{IBF}_A$	$\text{STB}_A$	$\text{INTR}_A$	$\text{STB}_B$	$\text{IBF}_B$	$\text{INTR}_B$	IN	

**Table 6 Port C set/reset control words**

Control words									Port C								Remarks
D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>	Hexa-decimal	PC <sub>7</sub>	PC <sub>6</sub>	PC <sub>5</sub>	PC <sub>4</sub>	PC <sub>3</sub>	PC <sub>2</sub>	PC <sub>1</sub>	PC <sub>0</sub>	
0	X	X	X	0	0	0	0	00								0	
0	X	X	X	0	0	0	1	01								1	
0	X	X	X	0	0	1	0	02							0		
0	X	X	X	0	0	1	1	03							1		
0	X	X	X	0	1	0	0	04						0		INTE <sub>B</sub> set/reset for mode 1 input	
0	X	X	X	0	1	0	1	05						1		INTE <sub>B</sub> set/reset for mode 1 output	
0	X	X	X	0	1	1	0	06					0				
0	X	X	X	0	1	1	1	07					1				
0	X	X	X	1	0	0	0	08				0					INTE <sub>A</sub> set/reset for mode 1 input
0	X	X	X	1	0	0	1	09				1					INTE <sub>2</sub> set/reset for mode 2
0	X	X	X	1	0	1	0	0A			0						
0	X	X	X	1	0	1	1	0B			1						
0	X	X	X	1	1	0	0	0C		0							INTE <sub>A</sub> set/reset for mode 1 output
0	X	X	X	1	1	0	1	0D		1							INTE <sub>1</sub> set/reset for mode 2
0	X	X	X	1	1	1	0	0E	0								
0	X	X	X	1	1	1	1	0F	1								

Note 7 : The terminals of port C should be programmed for the output mode, before the bit set/reset operation is executed.  
 8 : Also used for controlling the interrupt enable flag(INTE)

**4**

## PROGRAMMABLE PERIPHERAL INTERFACE

## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage	With respect to GND	-0.5~7	V
$V_I$	Input voltage		-0.5~7	V
$V_O$	Output voltage		-0.5~7	V
$P_d$	Power dissipation	$T_a=25^\circ\text{C}$	1000	mW
$T_{opr}$	Operating free-air temperature range		-20~75	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		-65~150	$^\circ\text{C}$

RECOMMENDED OPERATING CONDITIONS ( $T_a=-20\sim75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.75	5	5.25	V
GND	Supply voltage		0		V
$V_{IH}$	High-level input voltage	2		$V_{CC}$	V
$V_{IL}$	Low-level input voltage	-0.5		0.8	V

ELECTRICAL CHARACTERISTICS ( $T_a=-20\sim75^\circ\text{C}$ ,  $V_{CC}=5\text{V}\pm 5\%$ , GND=0V, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{OH}$	High-level output voltage	Data bus	GND=0V	2.4		V
		Port				
$V_{OL}$	Low-level output voltage	Data bus	GND=0V		0.45	V
		Port				
$I_{OH}$	High-level output current (Note10)	GND=0V, $V_{OH}=1.5\text{V}$ , $R_{EXT}=750\Omega$	-1		-4	mA
$I_{CC}$	Supply current from $V_{CC}$	GND=0V			120	mA
$I_{IH}$	High-level input current	GND=0V, $V_I=5.25\text{V}$			$\pm 10$	$\mu\text{A}$
$I_{IL}$	Low-level input current	GND=0V, $V_I=0\text{V}$			$\pm 10$	$\mu\text{A}$
$I_{OZ}$	Off-state output current	GND=0V, $V_I=0\sim 5.25\text{V}$			$\pm 10$	$\mu\text{A}$
$C_i$	Input capacitance	$V_{IL}=\text{GND}$ , $f=1\text{MHz}$ , $25\text{mVrms}$ , $T_a=25^\circ\text{C}$			10	pF
$C_{i/O}$	Input/output terminal capacitance	$V_{i/O}=\text{GND}$ , $f=1\text{MHz}$ , $25\text{mVrms}$ , $T_a=25^\circ\text{C}$			20	pF

Note 9 : Current flowing into an IC is positive; out is negative.

10 : It is valid only for any 8 input/output pins of PB and PC.

TIMING REQUIREMENTS ( $T_a=-20\sim75^\circ\text{C}$ ,  $V_{CC}=5\text{V}\pm 5\%$ , GND=0V, unless otherwise noted)

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{W(R)}$	Read pulse width	$t_{RR}$		300			ns
$t_{SU(PE-R)}$	Peripheral setup time before read	$t_{IR}$		0			ns
$t_{H(R-PE)}$	Peripheral hold time after read	$t_{HR}$		0			ns
$t_{SU(A-R)}$	Address setup time before read	$t_{AR}$		0			ns
$t_{H(R-A)}$	Address hold time after read	$t_{RA}$		0			ns
$t_{W(W)}$	Write pulse width	$t_{WW}$		300			ns
$t_{SU(DQ-W)}$	Data setup time before write	$t_{DW}$		100			ns
$t_{H(W-DQ)}$	Data hold time after write	$t_{WD}$		30			ns
$t_{SU(A-W)}$	Address setup time before write	$t_{AW}$		0			ns
$t_{H(W-A)}$	Address hold time after write	$t_{WA}$		20			ns
$t_{W(ACK)}$	Acknowledge pulse width	$t_{AK}$		300			ns
$t_{W(STB)}$	Strobe pulse width	$t_{ST}$		500			ns
$t_{SU(PE-STB)}$	Peripheral setup time before strobe	$t_{PS}$		0			ns
$t_{H(STB-PE)}$	Peripheral hold time after strobe	$t_{PH}$		180			ns
$t_{C(RW)}$	Read/write cycle time	$t_{RV}$		850			ns

**PROGRAMMABLE PERIPHERAL INTERFACE**

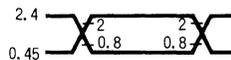
**SWITCHING CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5\text{V} \pm 5\%$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{PZV(R-DQ)}$	Propagation time from read to data output	$t_{RD}$	$C_L = 150\text{pF}$			200	ns
$t_{PVZ(R-DQ)}$	Propagation time from read to data floating (Note11)	$t_{DF}$		10		100	ns
$t_{PHL(W-PE)}$	Propagation time from write to output	$t_{WB}$				350	ns
$t_{PLH(W-PE)}$							
$t_{PLH(STB-IBF)}$	Propagation time from strobe to IBF flag	$t_{SIB}$				300	ns
$t_{PLH(STB-INTR)}$	Propagation time from strobe to interrupt	$t_{SIT}$				300	ns
$t_{PHL(R-INTR)}$	Propagation time from read to interrupt	$t_{RIT}$				400	ns
$t_{PHL(R-IBF)}$	Propagation time from read to IBF flag	$t_{RIB}$				300	ns
$t_{PHL(W-INTR)}$	Propagation time from write to interrupt	$t_{WIT}$				850	ns
$t_{PHL(W-OBF)}$	Propagation time from write to $\overline{\text{OBF}}$ flag	$t_{WOB}$				650	ns
$t_{PLH(ACK-OBF)}$	Propagation time from acknowledge to $\overline{\text{OBF}}$ flag	$t_{AOB}$				350	ns
$t_{PLH(ACK-INTR)}$	Propagation time from acknowledge to interrupt	$t_{AIT}$				350	ns
$t_{PZV(ACK-PE)}$	Propagation time from acknowledge to data output	$t_{AD}$				300	ns
$t_{PVZ(ACK-PE)}$	Propagation time from acknowledge to data floating (Note11)	$t_{KD}$		20		250	ns

Note 11 : Test conditions are not applied

12 : A.C Testing waveform

Input pulse level            0.45~2.4V  
 Input pulse rise time        20ns  
 Input pulse fall time        20ns  
 Reference level input         $V_{IH}=2\text{V}$ ,  $V_{IL}=0.8\text{V}$   
    output         $V_{OH}=2\text{V}$ ,  $V_{OL}=0.8\text{V}$

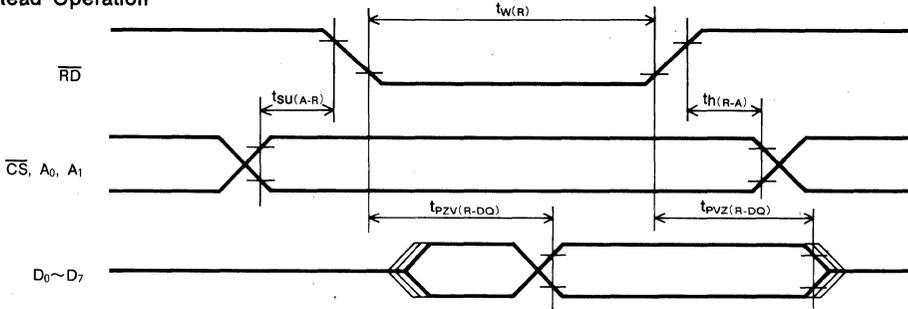


**4**

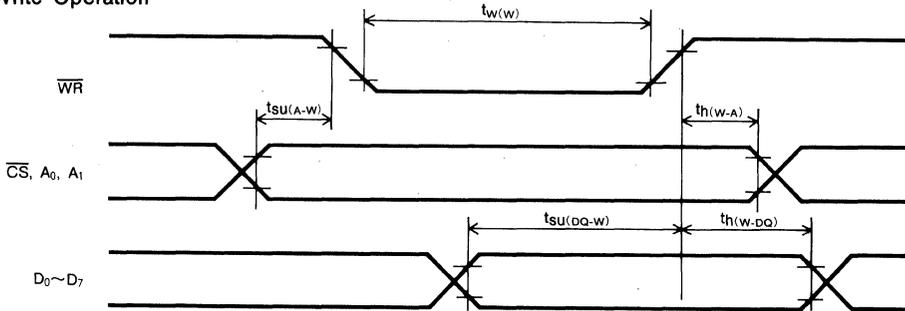
**PROGRAMMABLE PERIPHERAL INTERFACE**

**TIMING DIAGRAM**

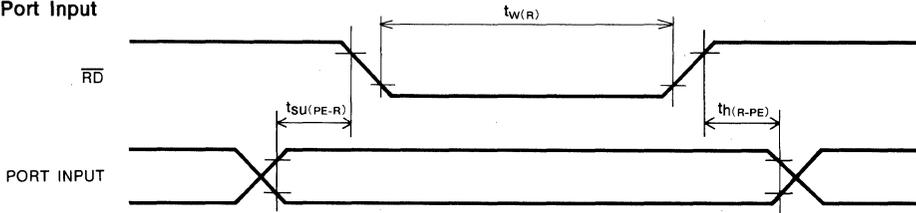
**Data Bus Read Operation**



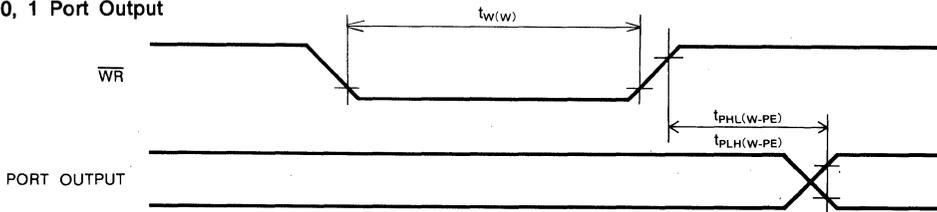
**Data Bus Write Operation**



**Mode0 Port Input**

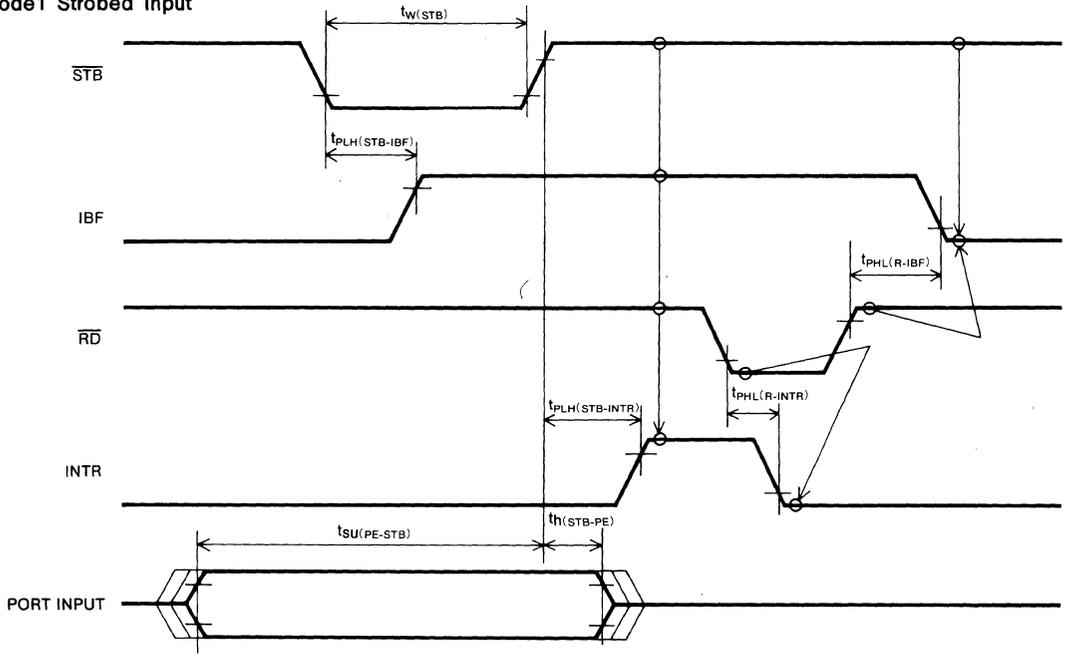


**Mode0, 1 Port Output**



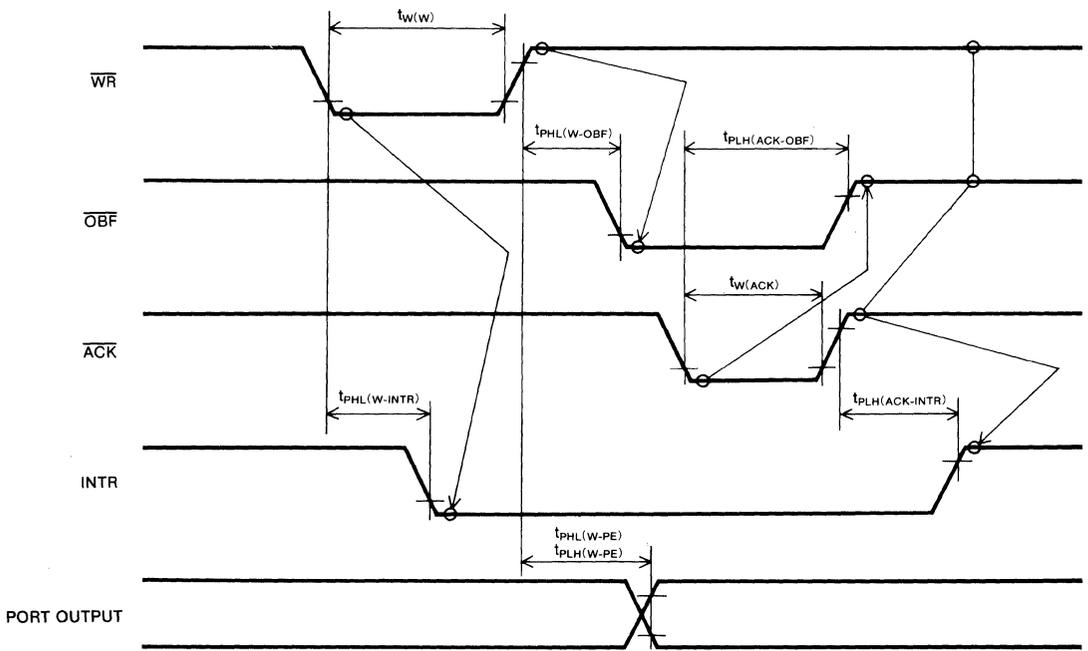
PROGRAMMABLE PERIPHERAL INTERFACE

Mode1 Strobed Input



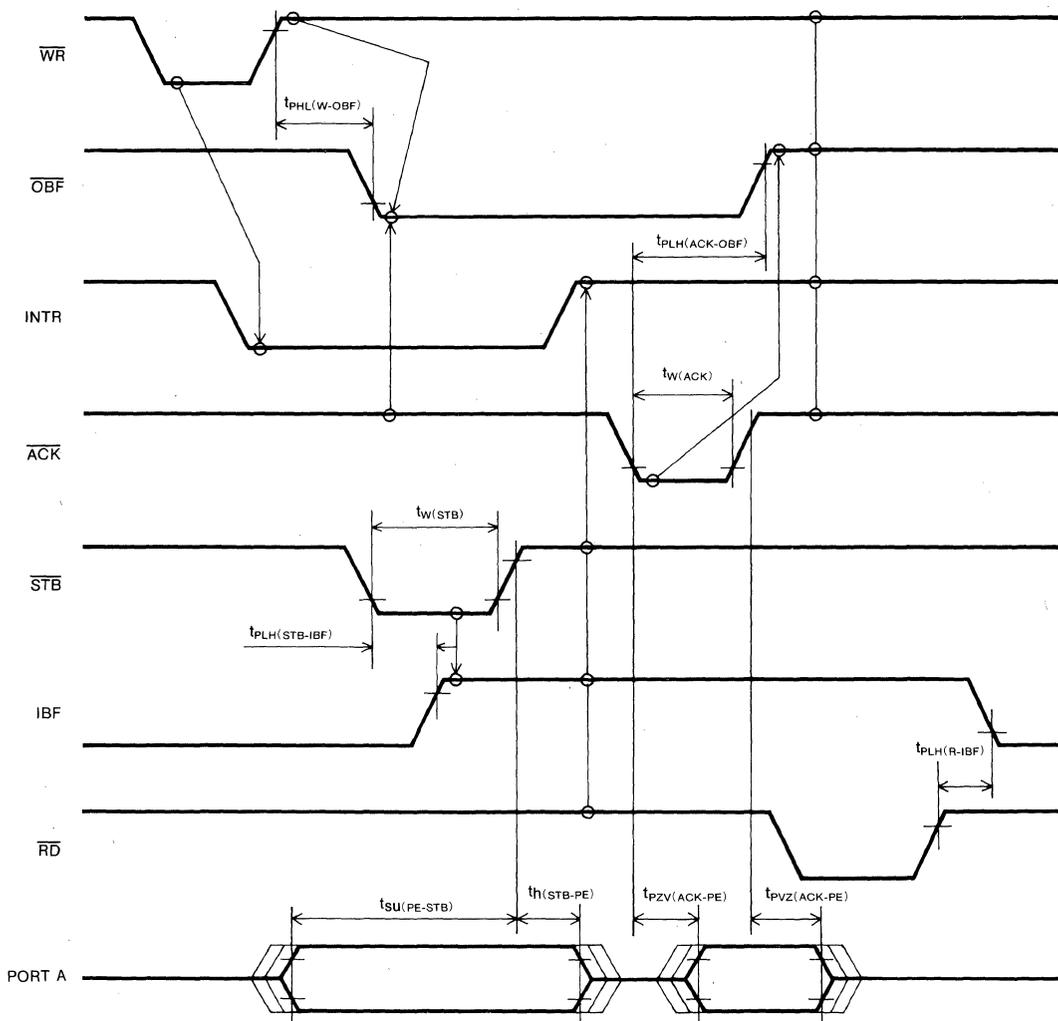
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Mode1 Strobed Output



**PROGRAMMABLE PERIPHERAL INTERFACE**

Mode2 Bidirectional



Note 13 :  $INTR = IBF \cdot \overline{MASK} \cdot \overline{STB} \cdot \overline{RD} + OBF \cdot \overline{MASK} \cdot \overline{ACK} \cdot \overline{WR}$

**PROGRAMMABLE PERIPHERAL INTERFACE**

**Circuit Examples for Applications**

**1. Mode 0**

An example of a circuit for an application using mode 0 is shown in Fig. 11.

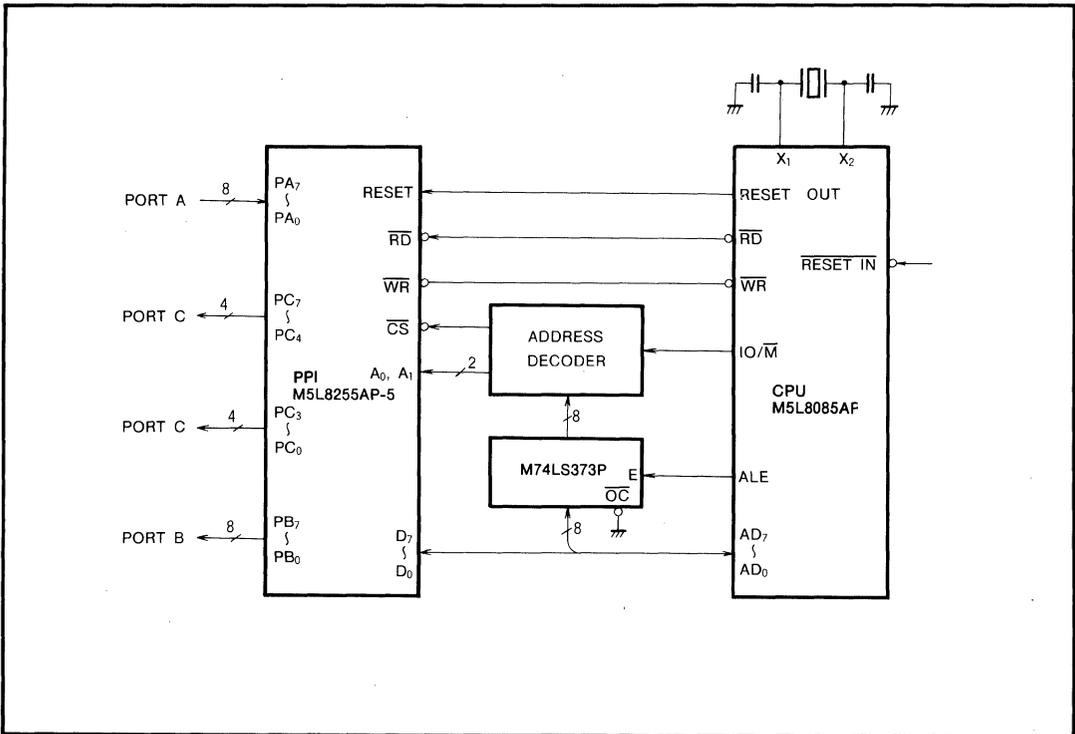


Fig. 11 Circuit example for an application using mode 0.

In this example, the PPI is in mode 0, and the control word should be 10010000 (90<sub>16</sub>).

```
MVI A, 90#
OUT 03#
```

The PPI Will be initialized by executing the above two instructions.

Then, for example, to read data from port A and to output data to port B and C, the following three instructions can be used.

```
IN 00# CPU A register ← Port A
OUT 01# Port B ← A register
OUT 02# Port C ← A register
```

After setting the mode, each port operates as a normal port.

After setting the mode, as shown in Fig. 11, to read data from port A, to output to port B, and to set the first bit of port C "1", the following four instructions can be used.

```
IN 00# CPU A register ← Port A
OUT 01# Port B ← A register
MVI A, 01# Bit-setting control word for PC0
OUT 03# Outputting to control address
(CS = "0", A1 = A0 = "1")
```

The other bits of port C, in this case, are not affected.

# M5L8255AP-5

## PROGRAMMABLE PERIPHERAL INTERFACE

### 2. Mode 1

An example of a circuit for an application using mode 1 is shown in Fig. 12.

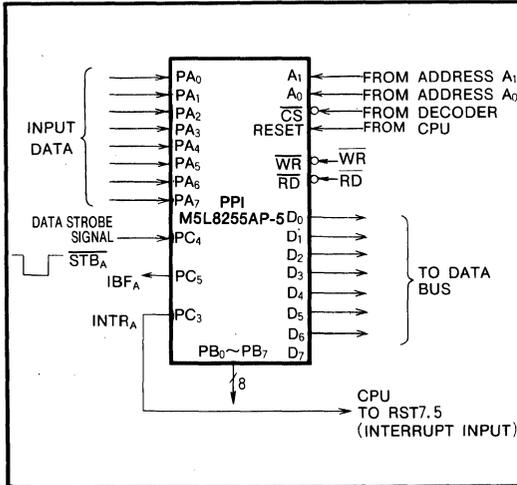


Fig. 12 A circuit for an application using mode 1

Transferring data from a terminal unit to port A and sending a strobe signal to PC<sub>4</sub> will hold the data in the internal latch of the PPI, and PC<sub>5</sub> (IBF input buffer full flag) is set to "1". If a bit-set of PC<sub>4</sub> has been executed in advance, the CPU can be interrupted by the INTR signal of PC<sub>3</sub> when the input data is latched in the PPI. In this way, port A becomes an interrupting port; and at the same time, port B can select its mode independently.

The actual program for the circuit of Fig. 12 is as follows:

```

MVI  A, B0#  Control word is 10110000, port A is
              the mode 1 input and the others are
              output
OUT   03#    Outputting to the control address
MVI  A, 09#  PC4 bit-set 00001001
OUT   03#    Outputting to the control address
EI                    Interrupt enable
HLT                    Halt
    
```

If the data has been set in a terminal unit, and the strobe signal has been input, then the data will be latched in port A and the CPU RST7.5 goes high-level. In the case of Fig. 11, a jump to 003C<sub>16</sub> is executed to continue the program as follows:

```

003C16 IN  00#  CPU register A ← Port A
              PC3 interrupt signal becomes low-level
EI
RET
    
```

PROGRAMMABLE PERIPHERAL INTERFACE

3. Mode 2

An example of a circuit for an application using mode 2 is shown in Fig. 13.

In Fig. 13, the data bus of the slave system is connected with the corresponding PPI A bit of the master station. The input port consists of a three-state buffer and gate B which allow the slave CPU to read flag outputs (IBF, OBF) of the PPI as data.

When the following instruction is executed in this example, the action is as described:

IN 01# (reading in from 01<sub>16</sub> input port)

The data which is made up of the least significant bit (D<sub>0</sub>), the OBF (output buffer full flag output) and the next least significant bit (D<sub>1</sub>), the IBF (input buffer full flag output) will be read into the slave CPU.

When the following instruction is executed, the action is as described:

IN 00# (reading in from 00<sub>16</sub> input port)

ACK (PC<sub>6</sub>) of the PPI becomes low-level by gate C, and the contents of the port A output latch will be read into the slave CPU.

When the following instruction is executed, the action is as described:

OUT 00# (writing out to 00<sub>16</sub> output port)

STB (PC<sub>4</sub>) of the PPI becomes low-level by gate D, then the contents of the slave CPU register A will be written into the port A input latch of the PPI.

Actual operations are as follows:

1. PPI is set in mode 2 by the master CPU (03 address).
2. The master CPU writes the data, which is transferred to the slave CPU, into port A of the PPI (in turn, OBF becomes low-level).
3. The slave CPU continues to read the state of flags (OBF and IBF) as data while OBF is high-level (i.e. no data from the master CPU).

4. When the slave CPU senses that OBF has become low-level, the slave CPU starts to read the data from 00<sub>16</sub> (Which is the input address for the preceding data) which is in the output latch of port A (in turn, OBF returns to high-level).
5. During this period, the master CPU reads the status flags (reading in from 02 of port C) and checks the states of both the bit 7 (OBF) and bit 5 (IBF). If OBF is low-level, it indicates that the slave CPU has not yet received the data; so the maser does not write new data. If OBF is high-level, the master CPU writes the next data.
6. When data is to be transferred to the master CPU, the contents of the slave CPU A register will be transmitted to the port input latch of the PPI. The slave CPU transfers the data to address 00<sub>16</sub> (in turn, the IBF becomes high-level).
7. The master CPU transfers data to port C and then checks the status flag. If the input latch contains data from the slave CPU, which is indicated by IBF having a high-level output, the data is read from port (00<sub>16</sub>) (in turn, the IBF returns to low-level).
8. The slave CPU reads the status flag from 01<sub>16</sub> to determine if IBF has returned to low-level. If it has not, new data will not be written as long as IBF is high-level.
9. In this way, data can be exchanged. Since there are two sets of independent registers, input latch and output latch, used by port A of the PPI, it is not necessary to alternate input/output transfers.

A program which has operating functions as described above, is explained as follows.

The operation, in mode 2, for group A of the PPI is considered here.

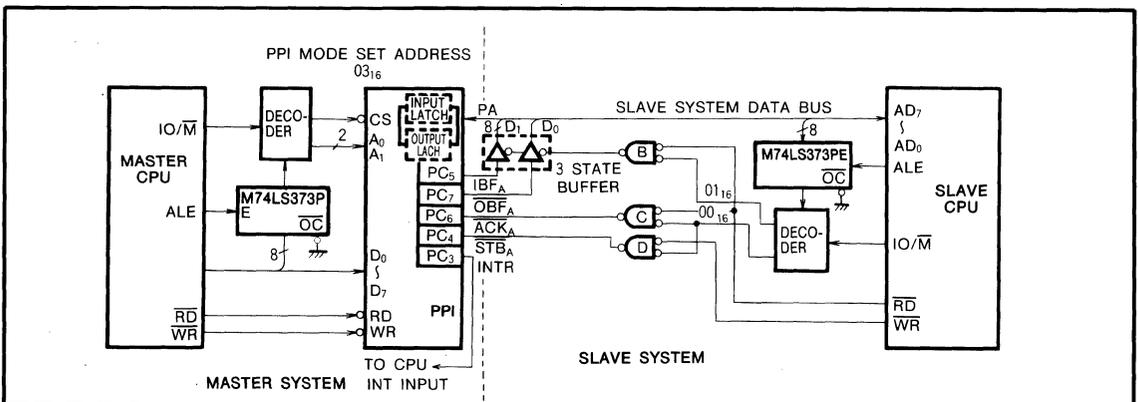
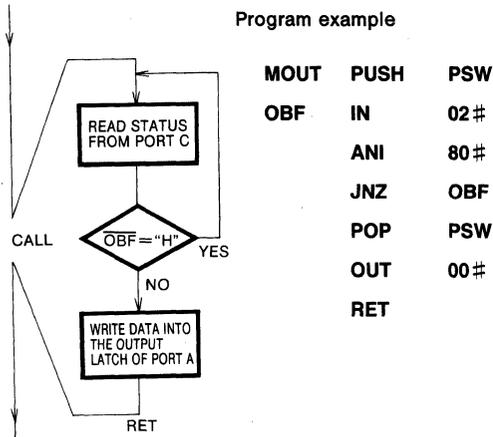


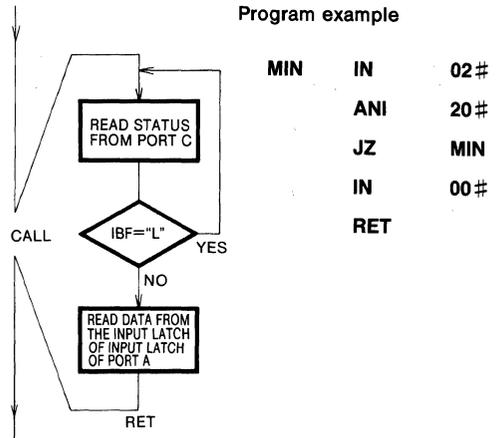
Fig. 13 A circuit for an application using mode 2

**PROGRAMMABLE PERIPHERAL INTERFACE**

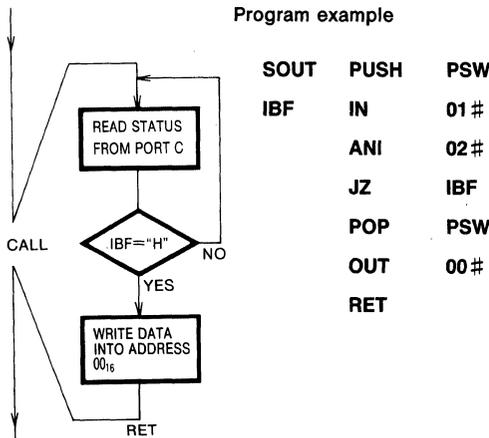
1. Master CPU subroutine for transmitting data to the slave CPU.



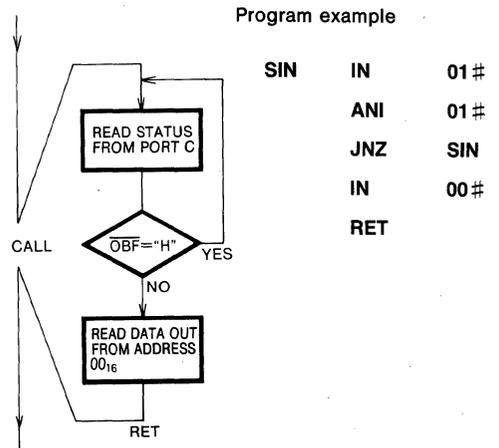
2. Subroutine for receiving data from the slave CPU.



3. Slave CPU subroutine for transmitting data to the master CPU.



4. Subroutine for receiving data from the master CPU.



**PROGRAMMABLE PERIPHERAL INTERFACE**

**4. Address Decoding**

Address decoding with multiple PPI units is shown in Figs. 14 and 15. These are functionally equal.

The same address data is output to both the upper and lower 8-bit address bus with the execution of IN or OUT instruction by the CPU.

**5. PPI Initialization**

It is advisable to reset the PPI with a system initial reset and to select the mode at the beginning of a system program. The initial state of the PPI used as an output port is shown in Fig. 16.

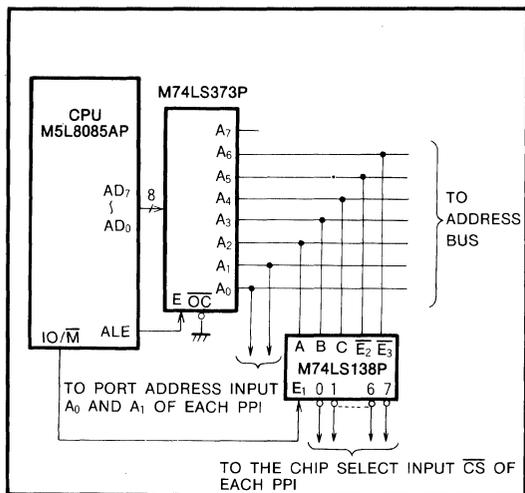


Fig. 14 PPI address decoding (case 1)

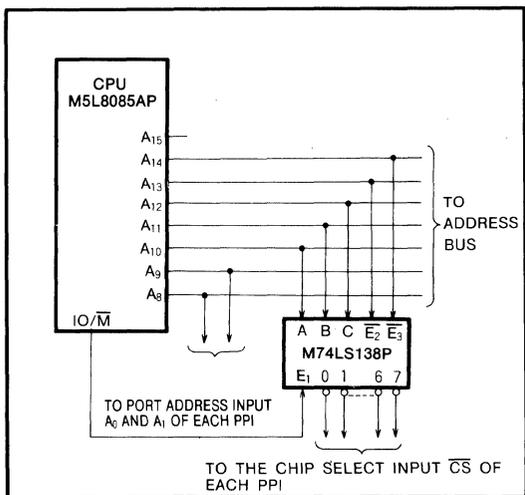


Fig. 15 PPI address decoding (case 2)

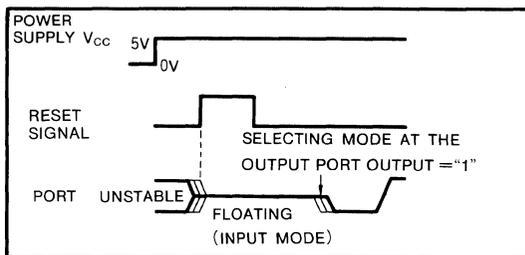


Fig. 16 PPI initialization

Note 14 : Period of reset pulse must be at least 50μs during or after power on. Subsequent reset pulse can be 500ns minimum.

# MITSUBISHI LSIs

## M5L8257P-5

### PROGRAMMABLE DMA CONTROLLER

#### DESCRIPTION

The M5L8257P-5 is a programmable, 4-channel direct memory access (DMA) controller. It is produced using the N-channel silicon-gate ED-MOS process and is specifically designed to simplify data transfer at high speeds for micro-computer systems.

The LSI operates on a single 5V power supply.

#### FEATURES

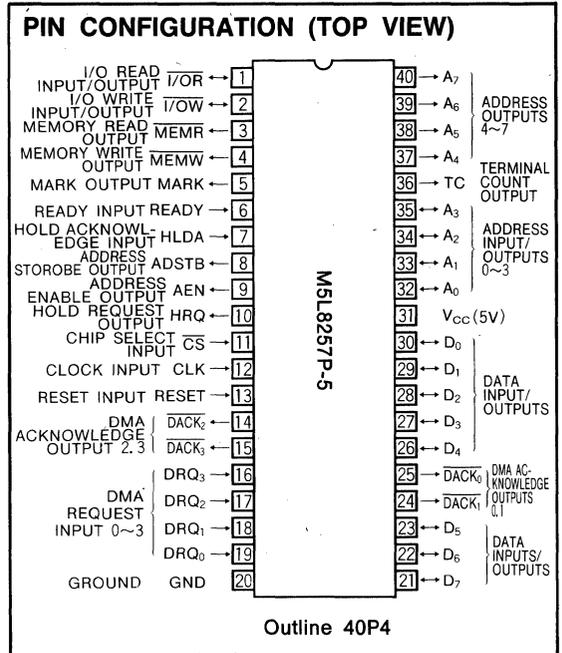
- Single 5V supply voltage
- Single TTL compatible
- Priority DMA request logic
- Channel-masking function
- Terminal count and Modulo 128 outputs
- 4-channel DMA controller
- Compatible with MELPS85 devices

#### APPLICATION

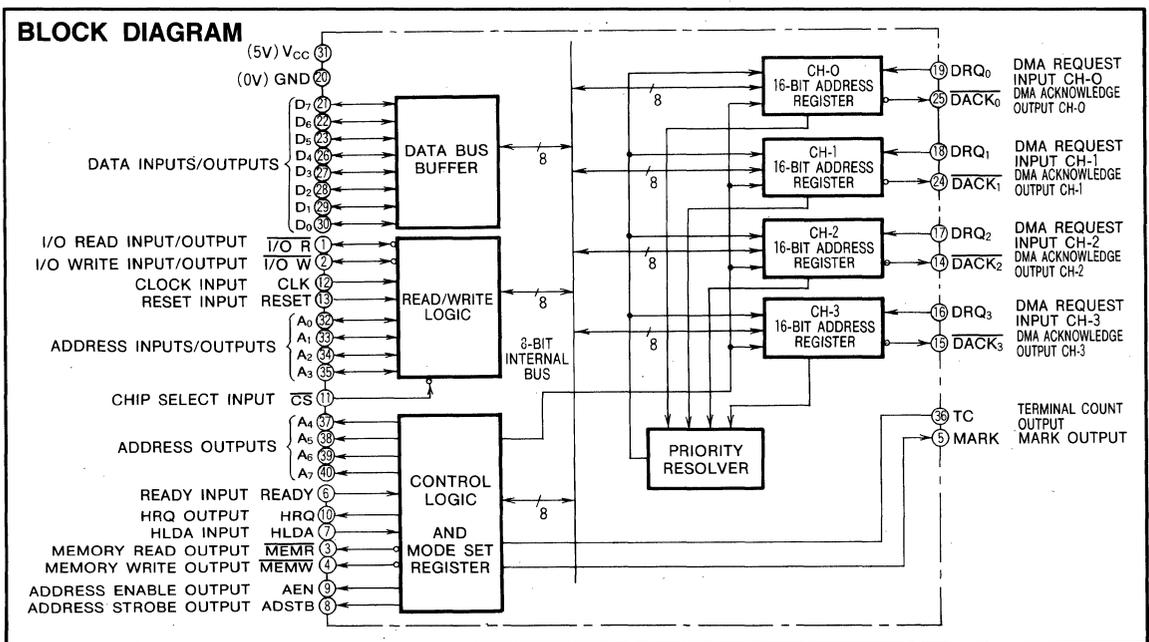
DMA control of peripheral equipment such as floppy disks and CRT terminals that require high-speed data transfer.

#### FUNCTION

The M5L8257P-5 controller is used in combination with the M5L8212P 8-bit input/output port in 8-bit microcomputer systems. It consists of a channel section to acknowledge DMA requests, control logic to exchange commands and data with the CPU, read/write logic, and registers to hold transfer addresses and count the number of bytes to be transferred. When a DMA request is made to an unmasked channel from the peripherals after setting of the transfer mode, transfer-start address and the number of transferred bytes for the registers, the M5L8257P-5 issues a priority request for the use of the bus to the CPU. On receiving an HLDA signal



from the CPU, it sends a DMA acknowledge signal to the channel with the highest priority, starting DMA operation. During DMA operation, the contents of the high-order 8 bits of the transfer memory address are transmitted to the M5L8212P address-latch device through pins  $D_0 \sim D_7$ . The contents of the low-order 8 bits are transmitted through pins  $A_0 \sim A_7$ . After address transmission, DMA transfer can be started by dispatching read and write signals to the memories and peripherals.



## OPERATION

### I/O Read Input/Output ( $\overline{I/OR}$ )

When the M5L8257P-5 is in slave-mode operation, this three-state, bidirectional pin serves for inputting and reads the upper/lower bytes of the 8-bit status register or 16-bit DMA address register and the high/low order bytes of the terminal counter.

In the master mode, the pin gives control output and is used to obtain data from a peripheral equipment during the DMA write cycle.

### I/O Write Input/Output ( $\overline{I/OW}$ )

This pin is also of the three-state bidirectional type. When the M5L8257P-5 is in slave-mode operation, it serves for inputting and loads the contents of the data bus on the upper/lower bytes of the 8-bit status register or 16-bit DMA address register and the upper/lower bytes of the terminal counter.

### Memory Read Output ( $\overline{MEMR}$ )

This active-low three-state output is used to read data from the addressed memory location during DMA read cycles.

### Memory Write Output ( $\overline{MEMW}$ )

This active-low three-state output is used to write data into the addressed memory location during DMA write cycles.

### Mark Output (MARK)

This signal notifies that the DMA transfer cycle for each channel is the 128th cycle since the previous MARK output.

### Ready Input (READY)

This asynchronous input is used to extend the memory read and write cycles in the M5L8257P-5 with wait states if the selected memory requires longer cycles.

### Hold Acknowledge Input (HLDA)

This input from the CPU indicates that the system bus is controlled by the M5L8257P-5.

### Address Strobe Output (ADSTB)

This output strobes the most significant byte of the memory address into the M5L8212P 8-bit input/output port through the data bus.

### Address Enable Output (AEN)

This signal is used to disable the system data bus and system control bus by means of the bus enable pin on the M5L8228P system controller. It may also be used to inhibit non-DMA devices from responding during DMA cycles.

### Hold Request Output (HRQ)

This output requests control of the system bus. HRQ will normally be applied to the HOLD input on the CPU.

### Chip-Select Input ( $\overline{CS}$ )

This pin is active on a low-level. It enable the IORD and LOWR signals output from the CPU, when the M5L8257P-5 is in slave-mode operation.

In the master mode, it is disabled to prevent the chip from selecting itself while performing the DMA function.

### Clock Input (CLK)

This pin generates internal timing for the M5L8257P-5 and is connected to the  $\phi_2$  (TTL) output of the M5L8224P-5 clock generator.

### Reset Input (RESET)

This asynchronous input clears all registers and control lines inside the M5L8257P-5.

### DMA Acknowledge Outputs ( $\overline{DACK0} \sim \overline{DACK3}$ )

These active-low outputs indicate that the peripheral equipment connected to the channel in question can execute the DMA cycle.

### DMA Request Inputs (DRQ0~DRQ3)

These independent, asynchronous channel-request inputs are used to secure use of the DMA cycle for the peripherals.

### Data-Bus Buffer

This three-state, bidirectional, 8-bit buffer interfaces the M5L8257P-5 to the CPU for data transfer. During a DMA cycle the upper 8 bits of the DMA address are output to the M5L8212P latch device through this buffer.

### Address Inputs/Outputs ( $A_0 \sim A_3$ )

The four bits of these input/output pins are bidirectional. When the M5L8257P-5 is in slave-mode operation, serve to input and address the internal registers. In the case of master operation, they output the low-order 4 bits of the 16-bit memory address.

### Terminal Count Output (TC)

This output signal notifies that the present DMA cycle is the last cycle for this data block.

### Address Inputs/Outputs ( $A_4 \sim A_7$ )

These four address lines are three-state outputs which constitute bits 4 through 7 of the memory address generated by the M5L8257P-5 during all DMA cycles.

**PROGRAMMABLE DMA CONTROLLER**

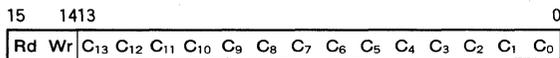
**Register Initialization**

Two 16-bit registers are provided for each of the 4 channels.

**DMA Address register**



**Terminal count register**



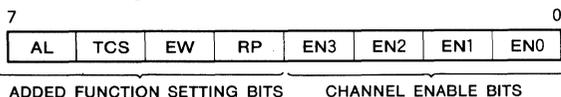
DMA MODE                  NUMBER OF TRANSFERRED BYTES-1

The DMA transfer starting address, number of transferred bytes, and DMA mode are written for each channel in 2 steps using the 8-bit data bus. The lower-order and upper-order bytes are automatically indicated by the firstlast flip-flop for the writing and reading in 2 continuous steps.

The DMA mode (read, write, or verify) is indicated by the upper 2 bits of the terminal count register. The read mode refers to the operation of peripheral devices reading data out of memory. The write mode refers to data from peripheral devices being written into memory. The verify mode sends neither the read nor the write signals and performs a data check at the peripheral device.

In addition to the above-mentioned registers, there is a mode set register and a status register.

**Mode set register (write only)**



**Status Register (read only)**



The upper-order 4-bits of the mode set register are used to select the added function, as described in Table 1. The lower-order 4-bits are mask kits for each channel. When set to 1, DMA requests are allowed. When the reset signal is input, all bits of the mode set and status registers are reset and DMA is inhibited for all channels. Therefore, to execute DMA operations, registers must first be initialized. An example of such an initialization is shown below.

**MODESET:**

- MVI A, ADDL**
- OUT 00#:** Channel 0 lower-order address
- MVI A, ADDH**
- OUT 00#:** Channel 0 upper-order address
- MVI A, TCL**
- OUT 01#:** Channel 0 terminal count lower-order
- OUT 01#:** Channel 0 terminal count upper-order
- MVI A, XX**
- OUT 08#:** Mode set register

As can be seen from the above example, until the contents of the address register and terminal count register become valid, the enable bit of the mode set register must not be set. This prevents memory contents from being destroyed by improper DRQ signals from peripheral devices.

**DMA Operation Description**

When a DMA request signal is received at the DRQ pin from a peripheral device after register initialization for a channel that is not masked, the M5L8257P-5 outputs a hold request signal to the CPU to begin DMA operation (S<sub>1</sub>).

The CPU, upon receipt of the HRQ signal, outputs the HLDA signal which reserves capture of the bus after it has executed the present instruction to place this system in the hold state.

When the M5L8257P receives the HLDA signal, an internal priority determining circuit selects the channel with the highest priority for the beginning of data transfer (S<sub>0</sub>).

Upon the next S<sub>1</sub> state, the address signal is sent. The lower-order 8-bits and upper-order 8-bits are sent by means of the A<sub>0</sub>~A<sub>7</sub> and D<sub>0</sub>~D<sub>7</sub> pins respectively, latched into the M5L8212P and output at pins A<sub>6</sub>~A<sub>15</sub>. Simultaneous with this, the AEN signal is output to prohibit the selection of a device not capable of DMA.

In the S<sub>2</sub> state, the read, extended write, and DACK signals are output and data transferred from memory or a peripheral device appears on the data bus.

In the S<sub>3</sub> state, the write signal required to write data from the bus is output. At this time if the remaining number of bytes to be transferred from the presently selected channel has reached 0, the terminal count (TC) signal is output. Simultaneously with this, after each 128-byte data transfer a mark signal is output as required. In addition, in this state the READY pin is sampled and, if low, the wait state (S<sub>w</sub>) is entered. This is used to perform DMA with slow access memory devices. In the verify mode, READY input is ignored.

**PROGRAMMABLE DMA CONTROLLER**

In the  $S_4$  state, the DRQ and HLDA pins are sampled at the end of a transferred byte as the address signal, control signals, and  $\overline{DACK}$  signal are held to determine if transfer will continue.

As described above, transfer of 1 byte requires a minimum of 4 states for execution. For example, if a 2MHz clock input is used, the maximum transfer rate is 500k byte/s.

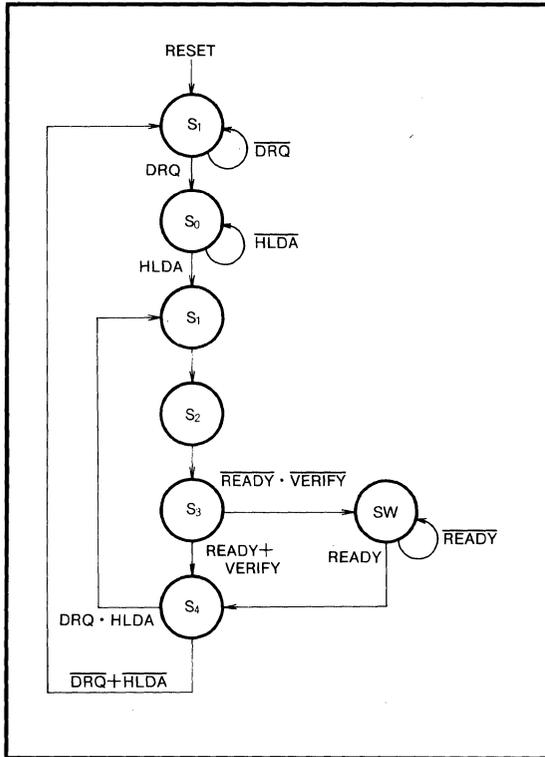


Fig. 1 DMA Operation state transition diagram

**Memory Mapped I/O**

When using memory mapped I/O, it is necessary to change the connections for the control signals.

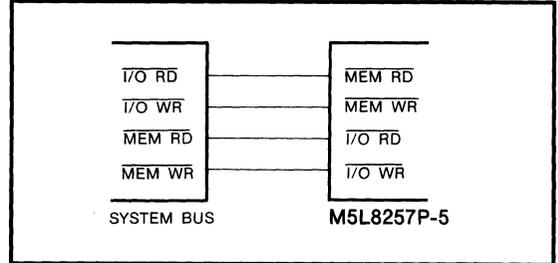
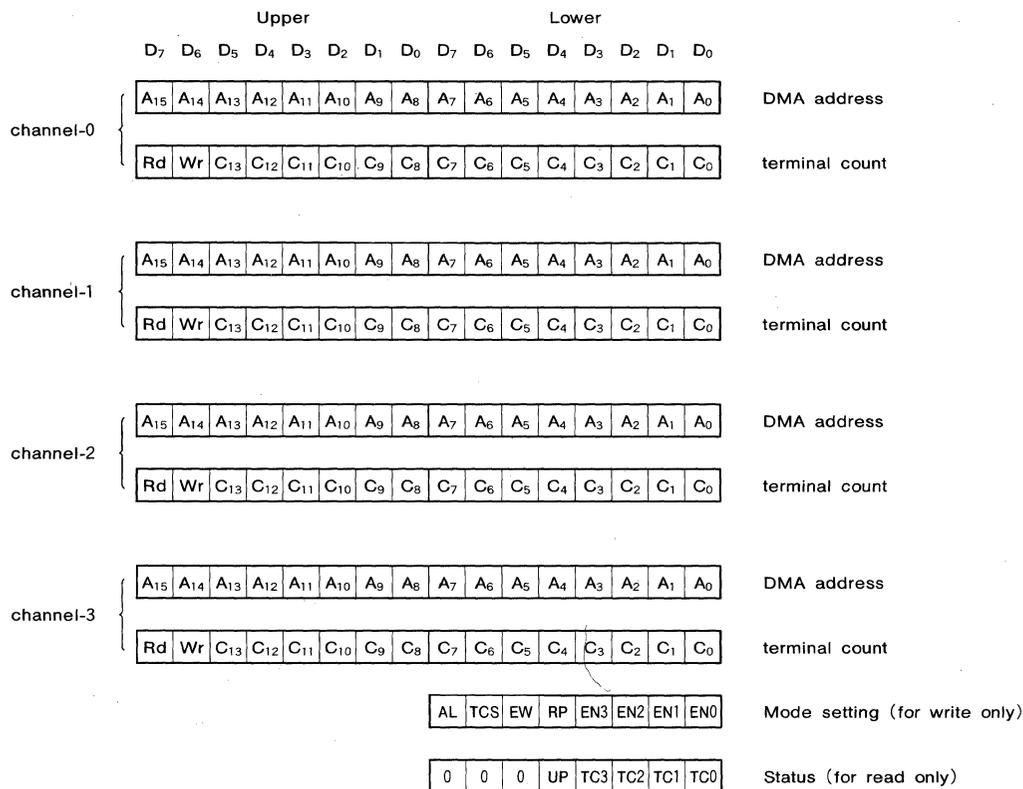


Fig. 2 Memory mapped I/O

Also, the read mode and write mode specifications for setting the mode of the terminal count are reversed.

**4**

INTERNAL REGISTERS OF THE M5L8257P-5



- A<sub>0</sub>~A<sub>15</sub> : Address of the memories for which DMA will be carried out from now on. In initialization, DMA start addresses must be written.
- C<sub>0</sub>~C<sub>13</sub> : Terminal counts-in this IC (the number of remaining transfer bytes minus 1)
- Rd, Wr : Used for DMA-mode-setting by the following convention:

Rd	Wr	Mode to be set
0	0	DMA verify
0	1	DMA write
1	0	DMA read
1	1	Prohibition

- AL : Automatic load mode. When this bit has been set, contents of the channel 3 register are written, as are on the channel 2 register when channel 2 DMA transfer comes to an end. This mode allows quick, automatic chaining operations without intervention of the software.
- EW : Extended write signal mode. When this bit has been set, write signals can be transmitted in advance to memories and peripheral equipment requiring long access time.
- TCS : Terminal count stop. When a DMA transfer process is complete, with terminal-count output, the channel-enable mask of that channel is reset, prohibiting subsequent DMA cycles.
- RP : Rotating priority mode. The setting of this mode allows the priority order to be rotated by each byte transfer.

Channel used for the present data transfer	CH-0	CH-1	CH-2	CH-3
Priority list for the next cycle	1	CH-1	CH-2	CH-3
	2	CH-2	CH-3	CH-0
	3	CH-3	CH-0	CH-1
	4	CH-0	CH-1	CH-2

- EN<sub>0</sub>~EN<sub>3</sub> : Channel-enable mask. This mask prohibits or allows the DMA request.
- UP : Update flag. This is set when register contents are transferred in an automatic load mode from channel 3 to channel 2.
- TC<sub>0</sub>~TC<sub>3</sub> : Terminal-count status flags. At the time of terminal-count output, the flag corresponding to the channel is set.

REGISTER ADDRESS

Address input				F/L	Register
A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>		
0	0	0	0	0	channel 0 DMA address Low-order
0	0	0	0	1	channel 0 DMA address High-order
0	0	0	1	0	channel 0 terminal count Low-order
0	0	0	1	1	channel 0 terminal count High-order
0	0	1	0	0	channel 1 DMA address Low-order
0	0	1	0	1	channel 1 DMA address High-order
0	0	1	1	0	channel 1 terminal count Low-order
0	0	1	1	1	channel 1 terminal count High-order
0	1	0	0	0	channel 2 DMA address Low-order
0	1	0	0	1	channel 2 DMA address High-order
0	1	0	1	0	channel 2 terminal count Low-order
0	1	0	1	1	channel 2 terminal count High-order
0	1	1	0	0	channel 3 DMA address Low-order
0	1	1	0	1	channel 3 DMA address High-order
0	1	1	1	0	channel 3 terminal count Low-order
0	1	1	1	1	channel 3 terminal count High-order
1	0	0	0	0	Mode Setting (for Write Only)
1	0	0	0	0	Status (for Read Only)

F/L : First/last flip-flop. This is toggled when program and register-read operations for each channel are finished, and specifies whether the next program or read operation is to be for the upper bytes or the lower bytes. This means that write and read operations for each register must be carried out for a set of lower and higher bytes.

4

PROGRAMMABLE DMA CONTROLLER

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Power-supply voltage		-0.5~7	V
$V_I$	Input voltage	With respect to GND	-0.5~7	V
$V_O$	Output voltage		-0.5~7	V
$P_d$	Power dissipation (max.)	$T_a=25^\circ\text{C}$	1000	mW
$T_{opr}$	Operating free-air temperature range		-20~75	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		-65~150	$^\circ\text{C}$

RECOMMENDED OPERATING CONDITIONS ( $T_a=-20\sim75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Power-supply voltage	4.75	5	5.25	V
$V_{SS}$	Power-supply voltage (GND)		0		V
$V_{IH}$	High-level input voltage	2		$V_{CC}+0.5$	V
$V_{IL}$	Low-level input voltage	-0.5		0.8	V

ELECTRICAL CHARACTERISTICS ( $T_a=-20\sim75^\circ\text{C}$ ,  $V_{CC}=5\text{V}\pm 5\%$ , unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{OL}$	Low-level output voltage	$I_{OL}=1.6\text{mA}$			0.45	V
$V_{OH1}$	High-level output voltage for AB, DB and AEN	$I_{OH}=-150\mu\text{A}$	2.4		$V_{CC}$	V
$V_{OH2}$	High-level output voltage for HRQ		3.3		$V_{CC}$	V
$V_{OH3}$	High-level output voltage for others	$I_{OH}=-80\mu\text{A}$	2.4		$V_{CC}$	V
$I_{CC}$	Power-supply current from $V_{CC}$				120	mA
$I_I$	Input current	$V_I=V_{CC}\sim 0\text{V}$	-10		10	$\mu\text{A}$
$I_{OZ}$	Off-state output current	$V_I=V_{CC}\sim 0\text{V}$	-10		10	$\mu\text{A}$
$C_I$	Input capacitance	$T_a=25^\circ\text{C}$ , $V_{CC}=V_{SS}=0\text{V}$ Pins other than that under measurement are set to 0V, $f_c=1\text{MHz}$			10	pF
$C_{I/O}$	Input/output terminal capacitance				20	pF

TIMING REQUIREMENTS ( $T_a=-20\sim75^\circ\text{C}$ ,  $V_{CC}=5\text{V}\pm 5\%$ ,  $V_{SS}=0\text{V}$ ,  $V_{IH}=V_{OH}=2\text{V}$ ,  $V_{IL}=V_{OL}=0.8\text{V}$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{w(R)}$	Read pulse width	$T_{RR}$	$C_L=150\text{pF}$	250			ns
$t_{SU(A-R)}$	Address or $\overline{\text{CS}}$ setup time before read	$T_{AR}$		0			ns
$t_{H(R-A)}$	Address or $\overline{\text{CS}}$ hold time after read	$T_{RA}$		0			ns
$t_{SU(R-DQ)}$	Data setup time before read	$T_{RD}$		0		200	ns
$t_{H(R-DQ)}$	Data hold time after read	$T_{DF}$		20		100	ns
$t_{W(W)}$	White pulse width	$T_{WW}$		200			ns
$t_{SU(A-W)}$	Address setup time before write	$T_{AW}$		20			ns
$t_{H(W-A)}$	Address hold time after write	$T_{WA}$		0			ns
$t_{SU(DQ-W)}$	Data setup time before write	$T_{DW}$		200			ns
$t_{H(W-DQ)}$	Data hold time after write	$T_{WD}$		0			ns
$t_{W(RST)}$	Reset pulse width	$T_{RSTW}$		300			ns
$t_{SU(V_{CC}-RST)}$	Supply voltage setup time before reset	$T_{RSTD}$		500			$\mu\text{s}$
$t_r$	Input signal rise time	$T_r$				20	ns
$t_f$	Input signal fall time	$T_f$				20	ns
$t_{SU(RST-W)}$	Reset setup time before write	$T_{RSTS}$		2			$t_{C(\neq)}$
$t_{C(\neq)}$	Clock cycle time	$T_{CY}$		0.32		4	$\mu\text{s}$
$t_{W(\neq)}$	Clock pulse width	$T_e$		80		$0.8t_{C(\neq)}$	ns
$t_{SU(DRQ-\neq)}$	DRQ setup time before clock	$T_{QS}$		70			ns
$t_{H(HLDA-DRQ)}$	DRQ hold time after HLDA	$T_{QH}$		0			ns
$t_{SU(HLDA-\neq)}$	HLDA setup time before clock	$T_{HS}$		100			ns
$t_{SU(RDY-\neq)}$	Ready setup time before clock	$T_{RS}$	30			ns	
$t_{H(\neq-RDY)}$	Ready hold time after clock	$T_{RH}$	20			ns	

Note 1 : Measurement conditions: M5L8257P  $C_L=100\text{pF}$ , M5L8257P-5  $C_L=150\text{pF}$

PROGRAMMABLE DMA CONTROLLER

SWITCHING CHARACTERISTICS ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 5\%$ ,  $V_{SS} = 0V$ ,  $V_{OH} = 2V$ ,  $V_{OL} = 0.8V$ , unless otherwise noted) (Note2)

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{PLH}(\phi-HRQ)$ $t_{PHL}(\phi-HRQ)$	Propagation time from clock to HRQ (Note3)	$T_{DQ}$			160	ns	
$t_{PLH}(\phi-HRQ)$ $t_{PHL}(\phi-HRQ)$	Propagation time from clock to HRQ (Note5)	$T_{DQI}$			250	ns	
$t_{PLH}(\phi-AEN)$	Propagation time from clock to AEN (Note3)	$T_{AEL}$			300	ns	
$t_{PHL}(\phi-AEN)$	Propagation time from clock to AEN (Note3)	$T_{AET}$			200	ns	
$t_{PZV}(AEN-A)$	Propagation time from AEN to address active (Note6)	$T_{AEA}$		20		ns	
$t_{PZV}(\phi-A)$	Propagation time from clock to address active (Note4)	$T_{FAAB}$			250	ns	
$t_{PVZ}(\phi-A)$	Propagation time from clock to address floating (Note4)	$T_{FAFB}$			150	ns	
$t_{PLH}(\phi-A)$	Address setup time after clock (Note4)	$T_{ASM}$			250	ns	
$t_h(\phi-A)$	Address hold time after clock (Note4)	$T_{AH}$		$t_{PLH}(\phi-A) - 50$		ns	
$t_h(R-A)$	Address hold time after read (Note6)	$T_{AHR}$		60		ns	
$t_h(W-A)$	Address hold time after write (Note6)	$T_{AHW}$		300		ns	
$t_{PZV}(\phi-DQ)$	Propagation time from clock to data active	$T_{FADB}$			300	ns	
$t_{PVZ}(\phi-DQ)$	Propagation time from clock to data floating (Note4)	$T_{AFDB}$			170	ns	
$t_{PHL}(A-ASTB)$	Propagation time from address to address strobe (Note4)	$T_{ASS}$		100		ns	
$t_h(ASTB-A)$	Propagation time from address strobe to address hold (Note6)	$T_{AHS}$		50		ns	
$t_{PLH}(\phi-ASTB)$	Propagation time from clock to address strobe (Note3)	$T_{STL}$			200	ns	
$t_{PHL}(\phi-ASTB)$	Propagation time from clock to address strobe (Note3)	$T_{STT}$			140	ns	
$t_w(ASTB)$	Address strobe pulse width (Note6)	$T_{SW}$		$t_C(\phi) - 100$		ns	
$t_{PHL}(AS-R)$ $t_{PHL}(AS-WE)$	Propagation time from address strobe to read or extended write (Note6)	$T_{ASC}$		70		ns	
$t_h(DQ-R)$ $t_h(DQ-WE)$	Read or extended write hold time after data (Note6)	$T_{DBC}$		20		ns	
$t_{PLH}(\phi-DACK)$ $t_{PHL}(\phi-TC/MARK)$ $t_{PLH}(\phi-TC/MARK)$	Propagation time from clock to DACK or TC/MARK (Note3, 7)	$T_{AK}$			250	ns	
$t_{PHL}(\phi-R)$ $t_{PHL}(\phi-W)$ $t_{PHL}(\phi-WE)$	Propagation time from clock to read, write or extended write (Note4, 8)	$T_{DCL}$			200	ns	
$t_{PLH}(\phi-R)$ $t_{PLH}(\phi-W)$	Propagation time from clock to read or write (Notes4, 9)	$T_{DCT}$			200	ns	
$t_{PZV}(\phi-R)$ $t_{PZV}(\phi-W)$	Propagation time from clock to read active or write active (Note4)	$T_{FAC}$			300	ns	
$t_{PVZ}(\phi-R)$ $t_{PVZ}(\phi-W)$	Propagation time from clock to read floating or write floating (Note4)	$T_{AFC}$			150	ns	
$t_w(R)$	Read pulse width (Note6)	$T_{RAM}$		$2t_C(\phi) + t_w(\phi) - 50$		ns ns	
$t_w(W)$	Write pulse width (Note6)	$T_{WWM}$		$t_C(\phi) - 50$		ns	
$t_w(WE)$	Extended write pulse width	$T_{WVME}$		$2t_C(\phi) - 50$		ns	

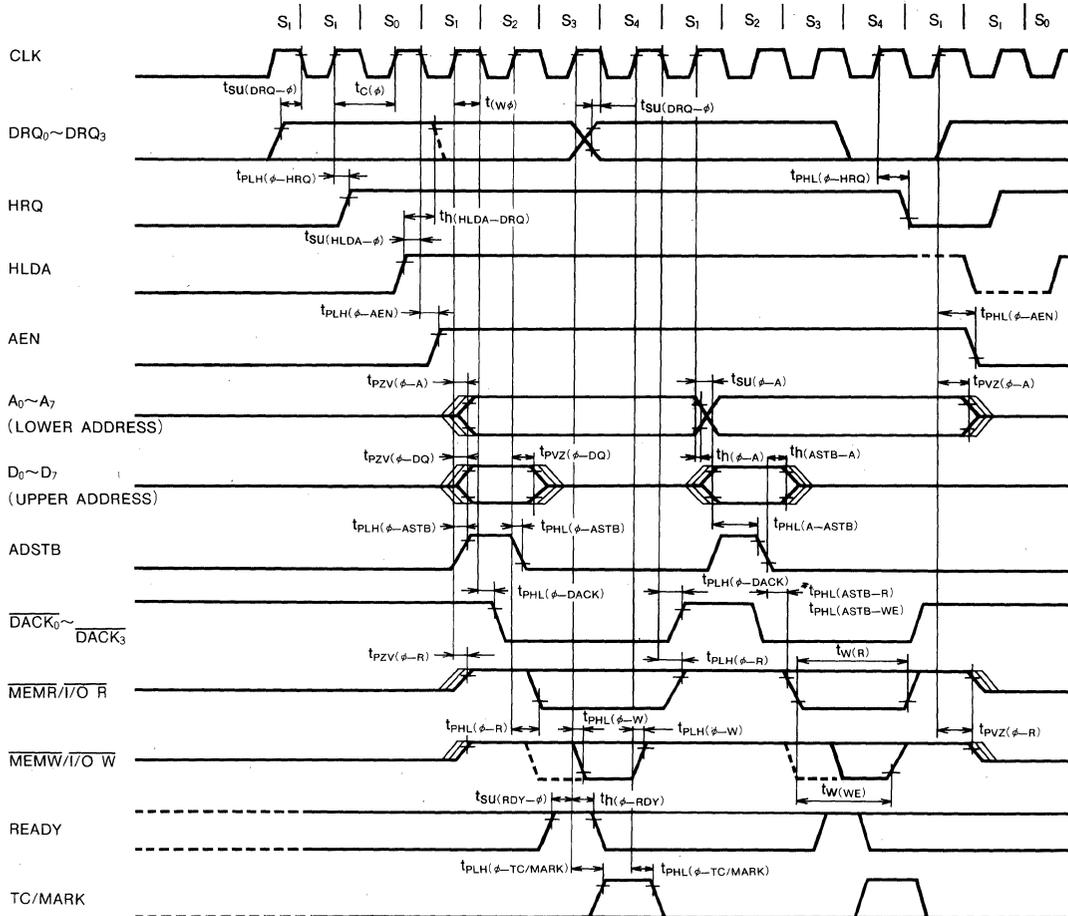
Note 2 : Reference level is  $V_{OH} = 3.3V$   
 3 : Load = 1TTL  
 4 : Load = 1TTL + 50pF  
 5 : Load = 1TTL + ( $R_L = 3.3k\Omega$ ),  $V_{OH} = 3.3V$

Note 6 : Tracking specification  
 7 :  $\Delta t_{PLH}(\phi-DACK) < 50ns$ ,  $\Delta t_{PHL}(\phi-TC/MARK) < 50ns$ ,  $\Delta t_{PLH}(\phi-TC/MARK) < 50ns$   
 8 :  $\Delta t_{PLH}(\phi-R) < 50ns$ ,  $\Delta t_{PHL}(\phi-W) < 50ns$ ,  $\Delta t_{PHL}(\phi-WE) < 50ns$   
 9 :  $\Delta t_{PLH}(\phi-R) < 50ns$ ,  $\Delta t_{PLH}(\phi-W) < 50ns$

4

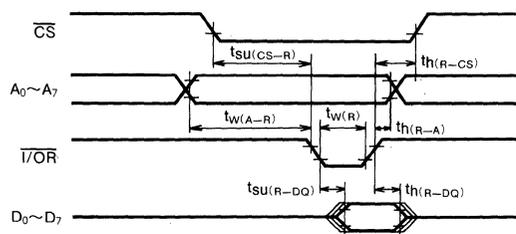
**TIMING DIAGRAMS**

**DMA Mode**

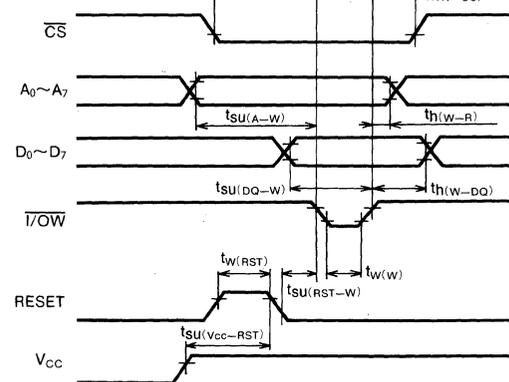


**Slave Mode** (Reference voltage: "H"=2V "L"=0.8V)

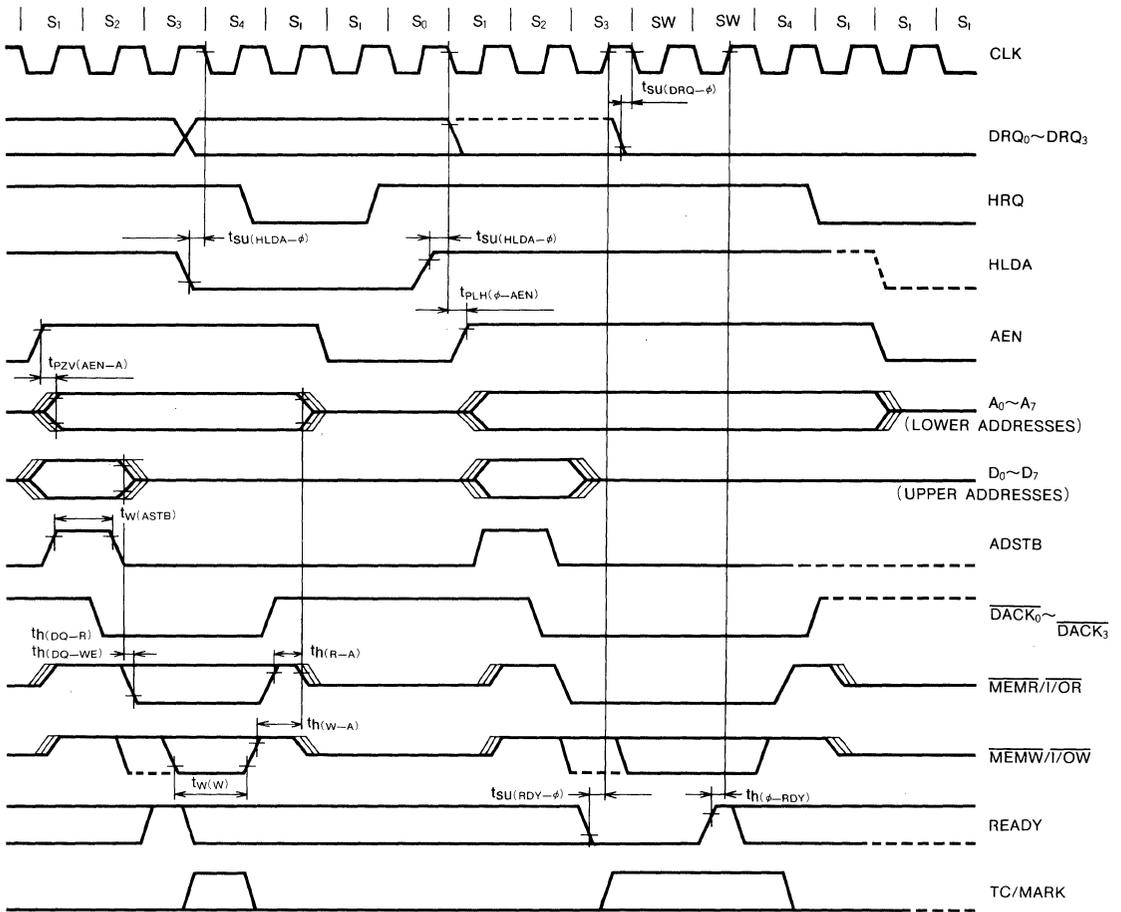
**Read**



**Write**

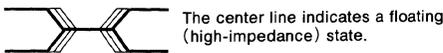


PROGRAMMABLE DMA CONTROLLER



4

Note 1 :



**MITSUBISHI LSIs**  
**M5L8259AP**

**PROGRAMMABLE INTERRUPT CONTROLLER**

**DESCRIPTION**

The M5L8259AP is a programmable LSI for interrupt control. It is fabricated using N-channel silicon-gate ED-MOS technology and is designed to be used easily in connection with an 8085A, 8086 or 8088.

**FEATURES**

- Single 5V supply voltage
- TTL compatible
- CALL instruction to the CPU is generated automatically
- Priority, interrupt mask and vectored address for each interrupt request input are programmable
- Up to 64 levels of interrupt requests can be controlled by cascading with M5L8259AP
- Polling functions

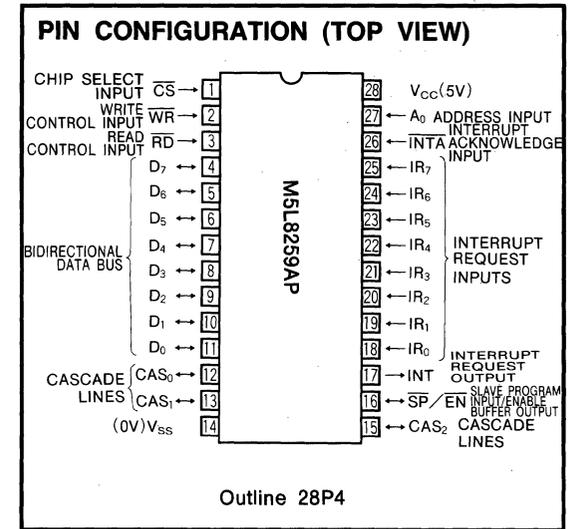
**APPLICATION**

The M5L8259AP can be used as an interrupt controller for CPUs 8085A, 8086 and 8088

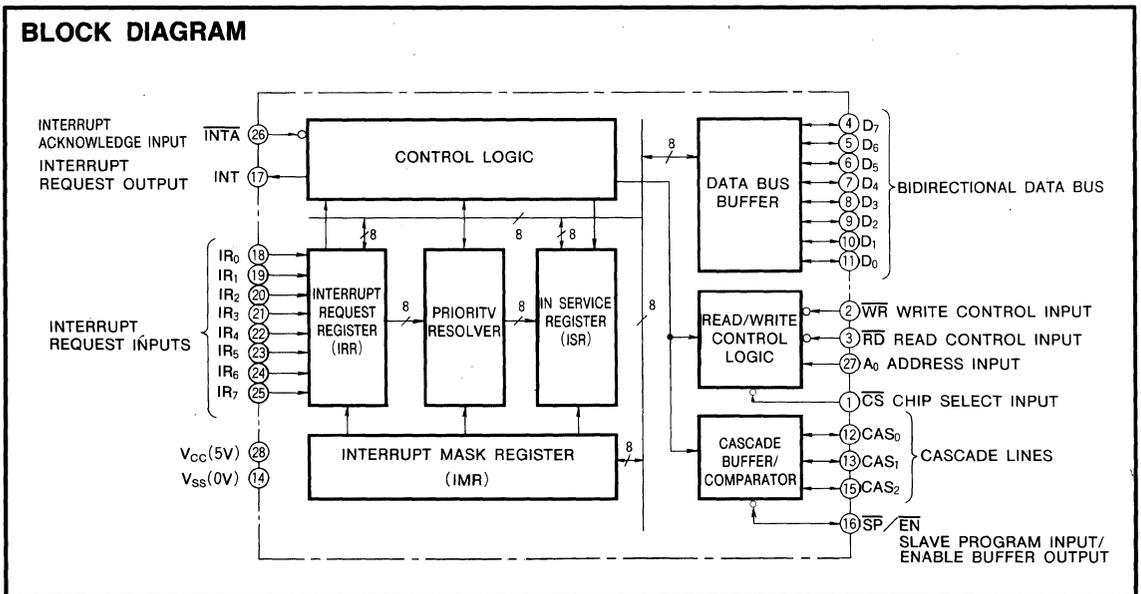
**FUNCTION**

The M5L8259AP is a device specifically designed for use in real time, interrupt driven microcomputer systems. It manages eight level requests and has built-in features for expandability to other M5L8259APs. The priority and interrupt mask can be changed or reconfigured at any time by the main program.

When an interrupt is generated because of an interrupt request at 1 of the pins, the M5L8259AP based on the mask



and priority will output an INT to the CPU. After that, when an INTA signal is received from the CPU or the system controller, a CALL instruction and a programmed vector address is released onto the data bus.



**PROGRAMMABLE INTERRUPT CONTROLLER**

**PIN DESCRIPTION**

Symbol	Pin name	Input or output	Functional significance
$\overline{CS}$	Chip select input	Input	This input is active at low-level, but may be at high-level during interrupt request input and interrupt processing.
$\overline{WR}$	Write control input	Input	Command write control input from the CPU
$\overline{RD}$	Read control input	Input	Data read control input for the CPU
$D_7 \sim D_0$	Bidirectional data bus	Input/ output	Data and commands are transmitted through this bidirectional data bus to and from the CPU.
$CAS_2 \sim CAS_0$	Cascade lines	Input/ output	These pins are outputs for a master and inputs for a slave. And these pins of the master will be able to address each individual slave. The master will enable the corresponding slave to release the device routine address during bytes 2 and 3 of $\overline{INTA}$ .
$\overline{SP/EN}$	Slave program input/ Enable buffer output	Input/ output	SP: In normal mode, a master is designated when $\overline{SP/EN}=1$ and a slave is designated when $\overline{SP/EN}=0$ . EN: In the buffered mode, whenever the M5L8259AP's data bus output is enabled, its $\overline{SP/EN}$ pin will go low.
$\overline{INT}$	Interrupt request output	Output	This pin goes high whenever a valid interrupt is asserted.
$IR_7 \sim IR_0$	Interrupt request input	Input	The asynchronous interrupt inputs are active at high-level. The interrupt mask and priority of each interrupt input can be changed at any time. When using edge triggered mode, the rising edge (low to high) of the interrupt request and the high-level must be held until the first $\overline{INTA}$ . For level triggered mode, the high-level must be held until the first $\overline{INTA}$ .
$\overline{INTA}$	Interrupt acknowledge input	Input	When an interrupt acknowledge ( $\overline{INTA}$ ) from the CPU is received, the M5L8259AP releases a CALL instruction or vectored address onto the data bus.
$A_0$	$A_0$ address input	Input	This pin is normally connected to one of the address lines and acts in conjunction with the $\overline{CS}$ , $\overline{WR}$ and $\overline{RD}$ when writing commands or reading status registers.

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**OPERATION**

The M5L8259AP is interfaced with a standard system bus as shown in Fig. 1 and operates as an interrupt controller.

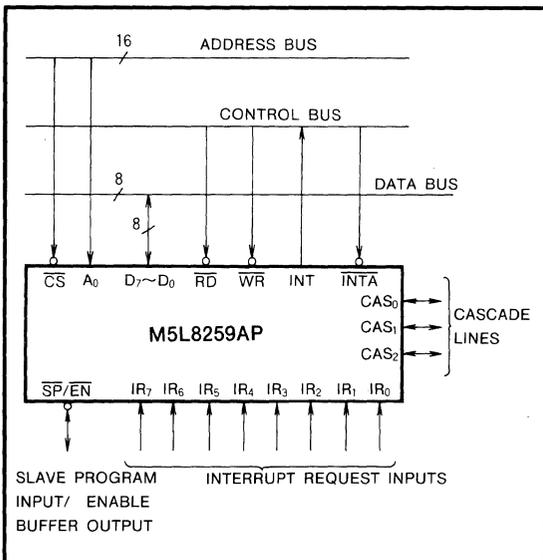


Fig. 1 The M5L8259AP interfaces to standard system bus.

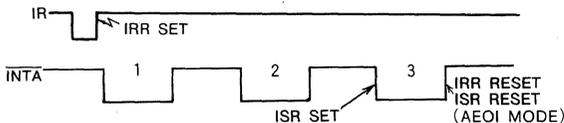
Table 1 M5L8259AP basic operation

$A_0$	$D_4$	$D_3$	$\overline{RD}$	$\overline{WR}$	$\overline{CS}$	Input operation (read)
0			0	1	0	IRR, ISR or interrupting level→data bus
1			0	1	0	IMR→Data bus
						Output operation (write)
0	0	0	1	0	0	Data bus→OCW2
0	0	1	1	0	0	Data bus→OCW3
0	1	X	1	0	0	Data bus→ICW1
1	X	X	1	0	0	Data bus→OCW1, ICW2, ICW3, ICW4
						Disable function
X	X	X	1	1	0	Data bus→High-impedance
X	X	X	X	X	1	Data bus→High-impedance

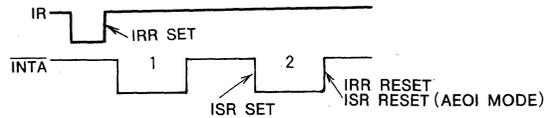
PROGRAMMABLE INTERRUPT CONTROLLER

Interrupt Sequence

1. When the CPU is an 8085A:
  - (1) When one or more of the interrupt request inputs are raised high, the corresponding IRR bit(s) for the high-level inputs will be set.
  - (2) Mask state and priority levels are considered and, if appropriate, the M5L8259AP sends an INT signal to the CPU.
  - (3) The acknowledgement of the CPU to the INT signal, the CPU issues an  $\overline{INTA}$  pulse to the M5L8259AP.
  - (4) Upon receiving the first  $\overline{INTA}$  pulse from the CPU, a CALL instruction is released onto the data bus.
  - (5) A CALL is a 3-byte instruction, so additional two  $\overline{INTA}$  pulses are issued to the M5L8259AP from the CPU.
  - (6) These two  $\overline{INTA}$  pulses allow the M5L8259AP to release the program address onto the data bus. The low-order 8-bit vectored address is released at the second  $\overline{INTA}$  pulse and the high-order 8-bit vectored address is released at the third  $\overline{INTA}$  pulse. The ISR bit corresponding to the interrupt request input is set upon receiving the third  $\overline{INTA}$  pulse from the CPU, and the corresponding IRR bit is reset.
  - (7) This completes the 3-byte CALL instruction and the interrupt routine will be serviced. The ISR bit is reset at the trailing edge of the third  $\overline{INTA}$  pulse in the AEOI mode. In the other modes the ISR bit is not reset until an EOI command is issued.



2. When the CPU is an 8086 or 8088:
  - (1) When one or more of the interrupt request inputs are raised high, the corresponding IRR bit(s) for the high-level inputs will be set.
  - (2) Mask state and priority levels are considered and if appropriated, the M5L8259AP sends an INT signal to the CPU.
  - (3) As an acknowledgement to the INT signal, the CPU issues an  $\overline{INTA}$  pulse to the M5L8259AP.
  - (4) Upon receiving the first  $\overline{INTA}$  pulse from the CPU, the M5L8259AP does not drive the data bus, and the data bus keeps high-impedance state.
  - (5) When the second  $\overline{INTA}$  pulse is issued from the CPU, an 8-bit pointer is released onto the data bus.
  - (6) This completes the interrupt cycle and the interrupt routine will be serviced. The ISR bit is reset at the trailing edge of the second  $\overline{INTA}$  pulse in the AEOI mode. In the other modes the ISR bit is not reset until an EOI command is issued from the CPU.



The interrupt request input must be held at high-level until the first  $\overline{INTA}$  pulse is issued. If it is allowed to return to low-level before the first  $\overline{INTA}$  pulse is issued, an interrupt request in  $IR_7$  is executed. However, in this case the ISR bit is not set.

This is a function for a noise countermeasure of interrupt request inputs. In the interrupt routine of  $IR_7$ , if ISR is checked by software either the interrupt by noise or real interrupt can be acknowledged. In the state of edge trigger mode normally the interrupt request inputs hold high-level and its input low-level pulse in the case of interrupt.

Interrupt sequence outputs

1. When the CPU is an 8085A:
 

A CALL instruction is released onto the data bus when the first  $\overline{INTA}$  pulse is issued. The low-order 8 bits of the vectored address are released when the second  $\overline{INTA}$  pulse is issued, and the high-order 8 bits are released when the third  $\overline{INTA}$  pulse is issued. The format of these three outputs is shown in Table 2.

Table 2 Formats of interrupt CALL instruction and vectored address

First  $\overline{INTA}$  pulse (CALL instruction)

D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
1	1	0	0	1	1	0	1

Second  $\overline{INTA}$  pulse (low-order 8-bit of vectored address)

IR	Interval = 4							
	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
$IR_0$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	0	0	0	0	0
$IR_1$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	0	0	1	0	0
$IR_2$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	0	1	0	0	0
$IR_3$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	0	1	1	0	0
$IR_4$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	0	0	0
$IR_5$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	1	0	0
$IR_6$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	0	0	0
$IR_7$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	1	0	0

PROGRAMMABLE INTERRUPT CONTROLLER

IR	Interval=8							
	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
IR <sub>0</sub>	A <sub>7</sub>	A <sub>6</sub>	0	0	0	0	0	0
IR <sub>1</sub>	A <sub>7</sub>	A <sub>6</sub>	0	0	1	0	0	0
IR <sub>2</sub>	A <sub>7</sub>	A <sub>6</sub>	0	1	0	0	0	0
IR <sub>3</sub>	A <sub>7</sub>	A <sub>6</sub>	0	1	1	0	0	0
IR <sub>4</sub>	A <sub>7</sub>	A <sub>6</sub>	1	0	0	0	0	0
IR <sub>5</sub>	A <sub>7</sub>	A <sub>6</sub>	1	0	1	0	0	0
IR <sub>6</sub>	A <sub>7</sub>	A <sub>6</sub>	1	1	0	0	0	0
IR <sub>7</sub>	A <sub>7</sub>	A <sub>6</sub>	1	1	1	0	0	0

Third INTA pulse (high-order 8 bits of vectored address)

D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
A <sub>15</sub>	A <sub>14</sub>	A <sub>13</sub>	A <sub>12</sub>	A <sub>11</sub>	A <sub>10</sub>	A <sub>9</sub>	A <sub>8</sub>

2. When the CPU is a 8086 or 8088:

The data bus keeps a high-impedance state when the first INTA pulse is issued. Then the pointer T<sub>7</sub>~T<sub>0</sub> is released when the next INTA pulse is issued. The content of the pointer T<sub>7</sub>~T<sub>0</sub> is shown in Table 3. The T<sub>2</sub>~T<sub>0</sub> are a binary code corresponding to the interrupt request level, A<sub>10</sub> ~ A<sub>5</sub> are unused and ADI mode control is ignored.

Table 3 Contents of interrupt pointer  
Second INTA pulse (8-bit pointer)

	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
IR <sub>0</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	0	0	0
IR <sub>1</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	0	0	1
IR <sub>2</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	0	1	0
IR <sub>3</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	0	1	1
IR <sub>4</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	1	0	0
IR <sub>5</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	1	0	1
IR <sub>6</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	1	1	0
IR <sub>7</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	1	1	1

**Interrupt Request Register (IRR), In-service Register (ISR)**

As interrupt requests are received at inputs IR<sub>7</sub>~IR<sub>0</sub>, the corresponding bits of IRR are set and as an interrupt request is serviced the corresponding bit of ISR is set. The IRR is used to store all the interrupt levels which are requesting service, and the ISR is used to store all the interrupt levels which are being serviced. The status of these two registers can be read. These two registers are connected through the priority resolver.

An interrupt request received by IR<sub>n</sub> is acknowledged on the leading edge when in the edge triggered mode or it is acknowledged on the level when in the level triggered

mode. After that an INT signal is released and the interrupt request signal is latched in the corresponding IRR bit if the high-level is held until the first INTA pulse is issued. It is important to remember that the interrupt request signal must be held at high-level until the first INTA pulse is issued.

The interrupt request latching in the IRR causes a signal to be sent to the priority resolver unless it is masked out. When the priority resolver receives the signals it selects the highest priority interrupt request latched in IRR. The ISR is set when the last INTA pulse is issued while the corresponding bit of IRR is reset and the other bits of IRR are unaffected.

The bit of ISR that was set is not reset during the interrupt routine, but is reset at the end of the routine by the EOI command (end of interrupt) or by the trailing edge of the last INTA pulse in AEIOI mode.

**Priority Resolver**

The priority resolver examines all of the interrupt requests set in IRR to determine and selects the highest priority. The ISR bit corresponding to the selected (highest priority) request is set by the last INTA pulse.

**Interrupt Mask Register (IMR)**

The contents of the interrupt mask register are used to mask out (disable) interrupt requests of selected interrupt request pins. Each terminal is independently masked so that masking a high priority interrupt does not influence the lower or higher priority interrupts. Therefore the contents of IMR selectively enable reading.

**Interrupt Request Output (INT)**

The interrupt request output connects directly to the interrupt input of the CPU. The output level is compatible with the input level required for the CPUs.

**Interrupt Acknowledge Input (INTA)**

The CALL instruction and vectored address are released onto the data bus by the INTA pulse.

**Data Bus Buffer**

The data bus buffer is a 3-state bidirectional data bus buffer that is used to interface with the system bus. Write commands to the M5L8259AP, CALL instructions, vectored addresses, status information, etc. are transferred through the data bus buffer.

**Read/Write Control Logic**

The read/write control logic is used to control functions such as receiving commands from the CPU and supplying status information to the data bus.

**Chip Select (CS)**

The M5L8259AP is selected (enabled) when CS is at low-level, but during interrupt request input or interrupt processing it may be high-level.

**Write Control Input (WR)**

When WR goes to low-level the M5L8259AP can be written.

**Read Control Input (RD)**

When RD goes low status information in the internal register of the M5L8259AP can be read through the data bus.

PROGRAMMABLE INTERRUPT CONTROLLER

**Address Input (A<sub>0</sub>)**

The address input is normally connected with one of the address lines and is used along with  $\overline{WR}$  and  $\overline{RD}$  to control write commands and reading status information.

**Cascade Buffer/Comparator**

The cascade buffer/comparator stores or compares identification codes. The three cascade lines are output when the M5L8259AP is a master or input when it is a slave. The identification code on the cascade lines select it as master or slave.

**PROGRAMMING THE M5L8259AP**

The M5L8259AP is programmed through the Initialization Command Word (ICW) and the operation command word (OCW). The following explains the functions of these two commands.

**Initialization Command Words (ICW<sub>s</sub>)**

The initialization command word is used for the initial setting of the M5L8259AP. There are four commands in this group and the following explains the details of these four commands.

**ICW1**

The meaning of the bits of ICW1 is explained in Fig. 3 along with the functions. ICW1 contains vectored address bits A<sub>7</sub>~A<sub>5</sub>, a flag indicating whether interrupt input is edge triggered or level triggered, CALL address interval, whether a single M5L8259AP or the cascade mode is used, and whether ICW4 is required or not.

Whenever a command is issued with A<sub>0</sub>=0 and D<sub>4</sub>=1,

this is interpreted as ICW1 and the following will automatically occur.

- (a) The interrupt mask register (IMR) is cleared.
- (b) The interrupt request input IR<sub>7</sub> is assigned the lowest priority.
- (c) The special mask mode is cleared and the status read is set to the interrupt request register (IRR).
- (d) When IC4=0 all bits in ICW4 are set to zero.

**ICW2**

ICW2 contains vectored address bits A<sub>15</sub>~A<sub>8</sub> or interrupt type T<sub>7</sub>~T<sub>3</sub>, and the format is shown in Fig. 3.

**ICW3**

When SNGL=1 it indicates that only a single M5L8259AP is used in the system, in which case ICW3 is not valid. When SNGL=0, ICW3 is valid and indicates cascade connections with other M5L8259AP devices. In the master mode, a "1" is set for each slave.

When the CPU is an 8085A the CALL instruction is released from the master at the first  $\overline{INTA}$  pulse and the vectored address is released onto the data bus from the slave at the second and third  $\overline{INTA}$  pulses.

When the CPU is a 8086 the master and slave are in high-impedance at the first  $\overline{INTA}$  pulse and the pointer is released onto the data bus from the slave at the second  $\overline{INTA}$  pulse.

The master mode is specified when  $\overline{SP/EM}$  pin is high-level or BUF=1 and M/S=1 in ICW4, and slave mode is specified when  $\overline{SP/EM}$  pin is low-level or BUF=1 and M/S

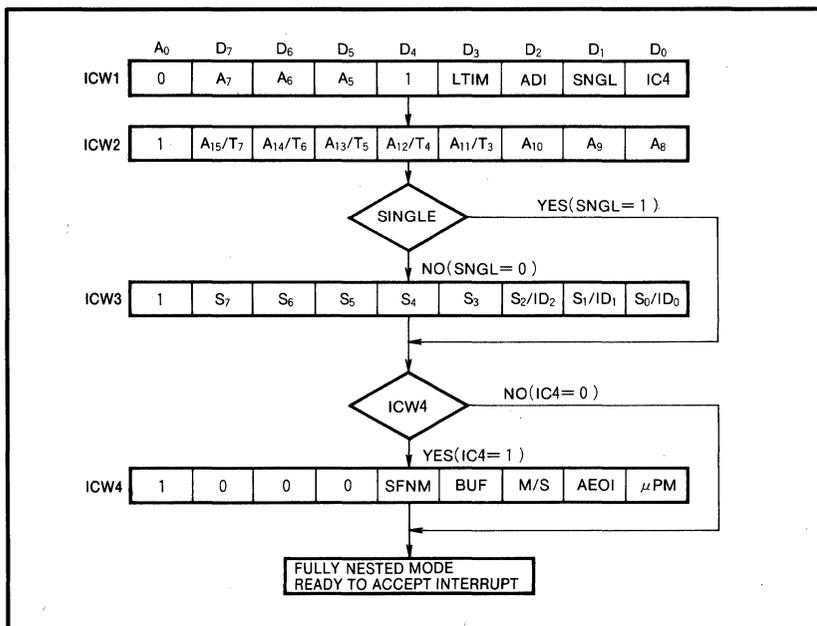


Fig. 2 Initialization sequence

PROGRAMMABLE INTERRUPT CONTROLLER

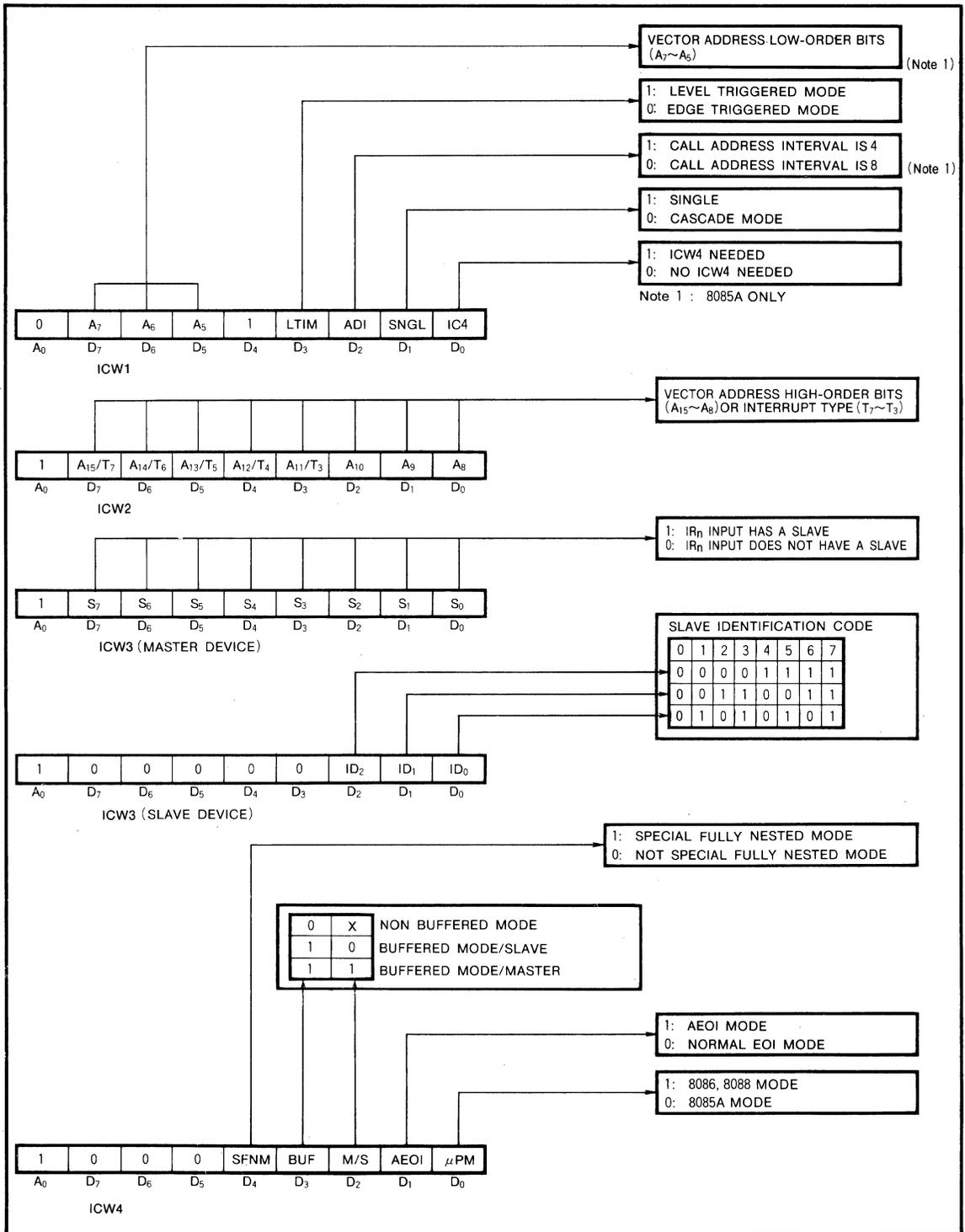


Fig. 3 Initialization command word format

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PROGRAMMABLE INTERRUPT CONTROLLER

=0 in ICW4. In the slave mode, three bits ID<sub>2</sub>~ID<sub>0</sub> identify the slave. And then when the slave code released on the cascade lines from the master, matches the assigned ID code, the vectored address is released by it onto the data bus at the next INTA pulse.

**ICW4**

Only when IC4=1 in ICW1 is ICW4 valid. Otherwise all bits are set to zero. When ICW4 is valid it specifies special fully nested mode, buffer mode master/slave, automatic EOI and microprocessor mode. The format of ICW4 is shown in Fig. 3.

**Operation Command Words (OCW<sub>s</sub>)**

The operation command words are used to change the contents of IMR, the priority of interrupt request inputs and the special mask. After the ICW are programmed into the

M5L8259AP, the device is ready to accept interrupt requests. There are three types of OCW<sub>s</sub>, explanation of each follows, and the format of OCW<sub>s</sub> is shown in Fig. 4.

**OCW1**

The meaning of the bits of OCW1 are explained in Fig. 4 along with their functions. Each bit of IMR can be independently changed (set or reset) by OCW1.

**OCW2**

The OCW2 is used for issuing EOI commands to the M5L8259AP and for changing the priority of the interrupt request inputs.

**OCW3**

The OCW3 is used for specifying special mask mode, poll mode and status register read.

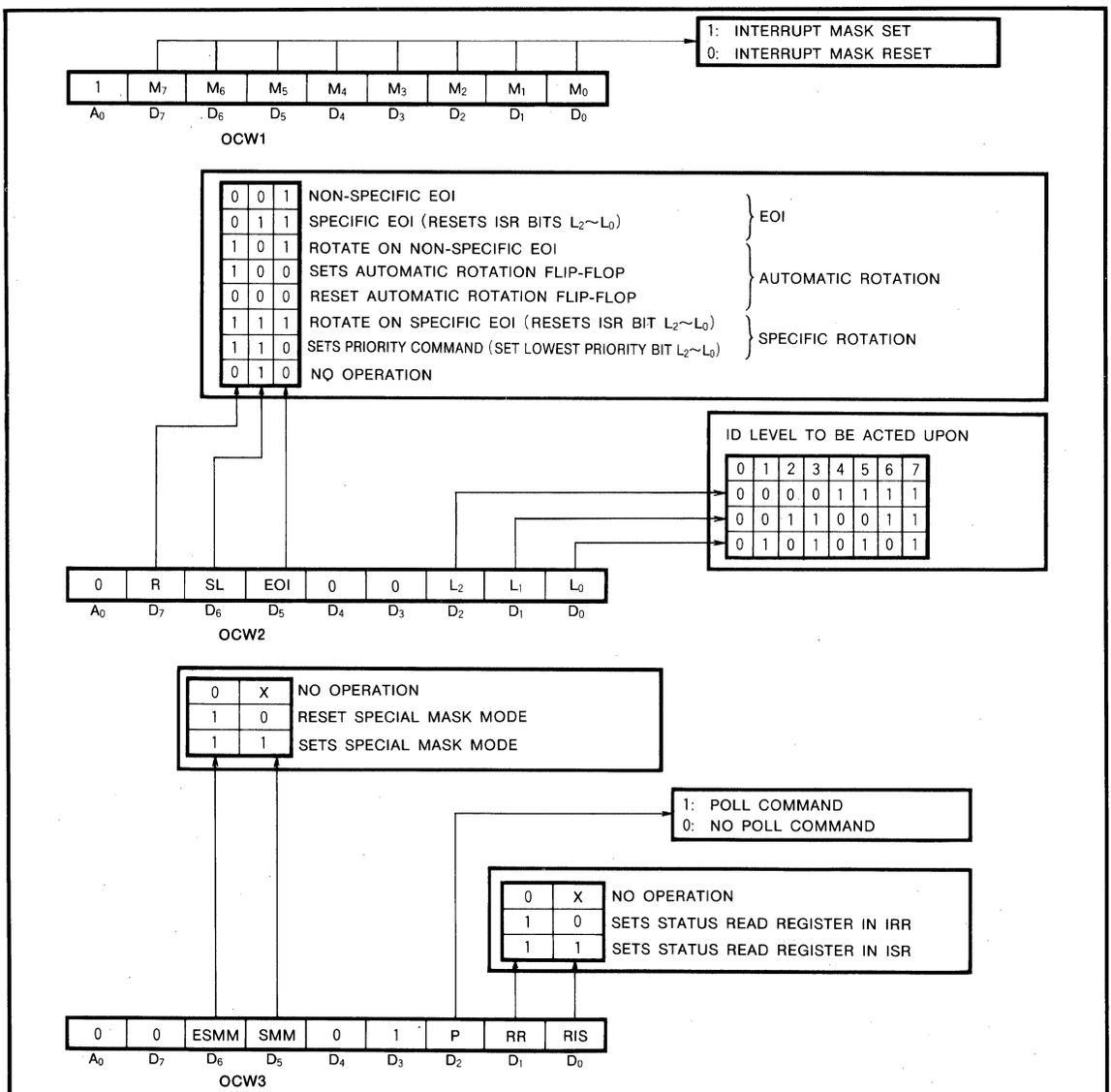


Fig. 4 Operation command word format

**PROGRAMMABLE INTERRUPT CONTROLLER**

**FUNCTION OF COMMAND**

**Interrupt masks**

The mask register contains a mask for each individual interrupt request. These interrupt masks can be changed by programming using OCW1.

**Special mask mode**

When an interrupt request is acknowledged and the ISR bit corresponding to the interrupt request is not reset by EOI command (which means an interrupt service routine is executing) lower priority interrupt requests are ignored.

In special mask mode interrupt requests received at interrupt request inputs which are masked by OCW1 are disabled, but interrupts at all levels that are not masked are possible. This means that in the mask mode all level of interrupts are possible or individual inputs can be selectively programmed so all interrupts at the selected inputs are disabled. The masks are stored in IMR and special mask is set/reset by executing OCW3.

**Buffered mode**

The buffered mode will structure the M5L8259AP to send an enable signal on SP/EN to enable the data bus buffer, when the data bus requires the data bus buffer or when cascading mode is used. In this mode, when data bus output of the M5L8259AP is enabled, the SP/EN output becomes low-level. This allows the M5L8259AP to be programmed whether it is a master or a slave by software. The buffered mode is set/reset by executing ICW4.

**Fully nested mode**

The fully nested mode is the mode when no mode is specified and is the usual operational mode. In this mode, the priority of interrupt request terminals is fixed from the lowest IR<sub>7</sub> to the highest IR<sub>0</sub>. When an interrupt request is acknowledged the CALL instruction and vectored address are released onto the data bus. At the same time the ISR bit corresponding to the accepted interrupt request is set. This ISR bit remains set until it is reset by the input of an EOI command or until the trailing edge of last INTA pulse in AEOL mode. While an interrupt service routine is being executed, interrupt requests of same or lower priority are disabled while the bit of ISR remains set. The priorities can be changed by OCW2.

**Special fully nested mode**

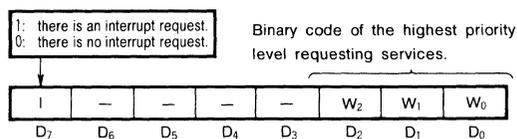
The special fully nested mode will be used when cascading is used and this mode will be programmed to the master by ICW4. The special fully nested mode is the same as the fully nested mode with the following two exceptions.

1. When an interrupt from a certain slave is being serviced, this slave is not locked out from the master priority logic. Higher priority interrupts within the slave will be recognized by the master and the master will initiate an interrupt request to the CPU. In general in the normal fully nested mode, a serviced slave is locked out from the master's priority, and so higher priority interrupts from the same slave are not serviced.

2. When an interrupt from a certain slave is being serviced the software must check ISR to determine if there are additional interrupts requests to be serviced. If the ISR bit is 0 the EOI command may be sent to the master too. But if it is not 0 the EOI command should not be sent to the master.

**Poll mode**

The poll mode is useful when the internal enable flip-flop of the microprocessor is reset, and interrupt input is disabled. Service to the device is achieved by a programmer initiative using a poll command. In the poll mode the M5L8259AP at the next RD pulse puts 8 bits on the data bus which indicates whether there is an interrupt request and reads the priority level. The format of the information on the data bus is as shown below.



When I=0 (no interrupt request), W<sub>2</sub>~W<sub>0</sub> is 111. The poll is valid from WR to RD and interrupt is frozen. This mode can be used for processing common service routines for interrupts from more than one line and does not require any INTA sequence. Poll command is issued by setting P=1 in OCW3.

**End of interrupt (EOI) and specific EOI (SEOI)**

An EOI command is required by the M5L8259AP to reset the ISR bit. So an EOI command must be issued to the M5L8259AP before returning from an interrupt service routine.

When AEOL is selected in ICW4, the ISR bit can be reset at the trailing edge of the last INTA pulse. When AEOL is not selected the ISR bit is reset by the EOI command issued to the M5L8259AP before returning from an interrupt service routine. When programmed in the cascade mode the EOI command must be issued to the master once and to corresponding slave once.

There are two forms of EOI command, specific EOI and non-specific EOI. When the M5L8259AP is used in the fully nested mode, the ISR bit being serviced is reset by the EOI command. When the non-specific EOI is issued the M5L8259AP will automatically reset the highest ISR bit of those that are set. Other ISR bits are reset by a specific EOI and the bit to be reset is specified in the EOI by the program. The SEOI is useful in modes other than fully nested mode. When the M5L8259AP is in special mask mode ISR bits masked in IMR are not reset by EOI. EOI and SEOI are selected when OCW2 is executed.

PROGRAMMABLE INTERRUPT CONTROLLER

**Automatic EOI (AEOI)**

In the AEOI mode the M5L8259AP executes non-specific EOI command automatically at the trailing edge of the last INTA pulse. When AEOI=1 in ICW4, the M5L8259AP is put in AEOI mode continuously until reprogrammed in ICW4.

The AEOI mode can only be used in a master M5L8259AP and not a slave.

**Automatic rotation**

The automatic rotation mode is used in applications where many interrupt requests of the same level are expected such as multichannel communication systems. In this mode when an interrupt request is serviced, that request is assigned the lowest priority so that if there are other interrupt requests they will have higher priorities. This means that the next request on the interrupt request being serviced must wait until the other interrupt requests are serviced (worst case is waiting for all 7 of the other controllers to be serviced). The priority and serving status are rotated as shown in Fig. 5.

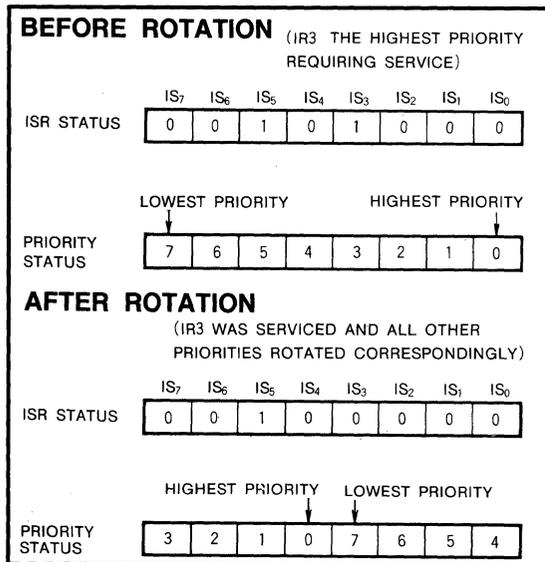


Fig. 5 An example of priority rotation

In the non-specific EOI command automatic rotation mode is selected when R=1, EOI=1, SL=0 in OCW2. The internal priority status is changed by EOI or AEOI commands. The rotation priority A flip-flop is set by R=1, EOI=0 and SL=0 which is useful when the M5L8259AP is used in the AEOI mode.

**Specific rotation**

Specific rotation gives the user versatile capabilities in interrupt controlled operations. It serves in those applications in which a specific device's interrupt priority must be altered. As opposed to automatic rotation which automatically sets priorities, specific rotation is completely user controlled.

That is, the user selects the interrupt level that is to receive lowest or highest priority. Priority changes can be executed during an EOI command.

**Level triggered mode/Edge triggered mode**

Selection of level or edge triggered mode of the M5L8259AP is made by ICW1. When using edge triggered mode not only is a transition from low to high required, but the high-level must be held until the first INTA. If the high-level is not held until the first INTA, the interrupt request will be treated as if it were input on IR<sub>7</sub>, except that the ISR bit is not set. When level triggered mode is used the functions are the same as edge triggered mode except that the transition from low to high is not required to trigger the interrupt request.

In the level triggered mode and using AEOI mode together, if the high-level is held too long the interrupt will occur immediately. To avoid this situation interrupts should be kept disabled until the end of the service routine or until the IR input returns low. In the edge triggered mode this type of mistake is not possible because the interrupt request is edge triggered.

**Reading the M5L8259AP internal status**

The contents of IRR and ISR can be read by the CPU with status read. When an OCW3 is issued to the M5L8259AP and an RD pulse issued the contents of IRR or ISR can be released onto the data bus. A special command is not required to read the contents of IMR. The contents of IMR can be released onto the data bus by issuing an RD pulse when A<sub>0</sub>=1. There is no need to issue a read register command every time the IRR or ISR is to be read. Once a read register command is received by the M5L8259AP, it remains valid until it is changed. Remember that the programmer must issue a poll command every time to check whether there is an interrupt request and read the priority level. Polling overrides status read when P=1, RR=1 in OCW3.

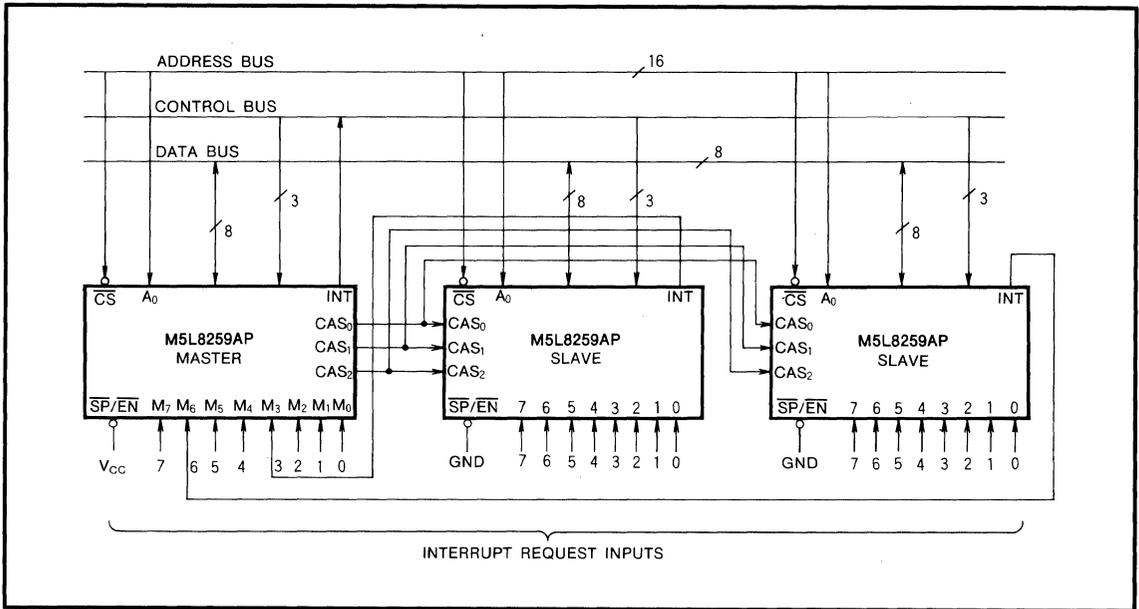
**Cascading**

The M5L8259AP can be interconnected in a system of one master with up to eight slaves to handle up to 64 priority levels. A system of three units that can be used with the 8085A is shown in Fig. 6.

The master can select a slave by outputting its identification code through the three cascade lines. The INT output of each slave is connected to the master interrupt request inputs. When an interrupt request of one of the slaves is to be serviced the master outputs the identification code of the slave through the cascade lines, so the slave will release the vectored address on the next INTA pulse.

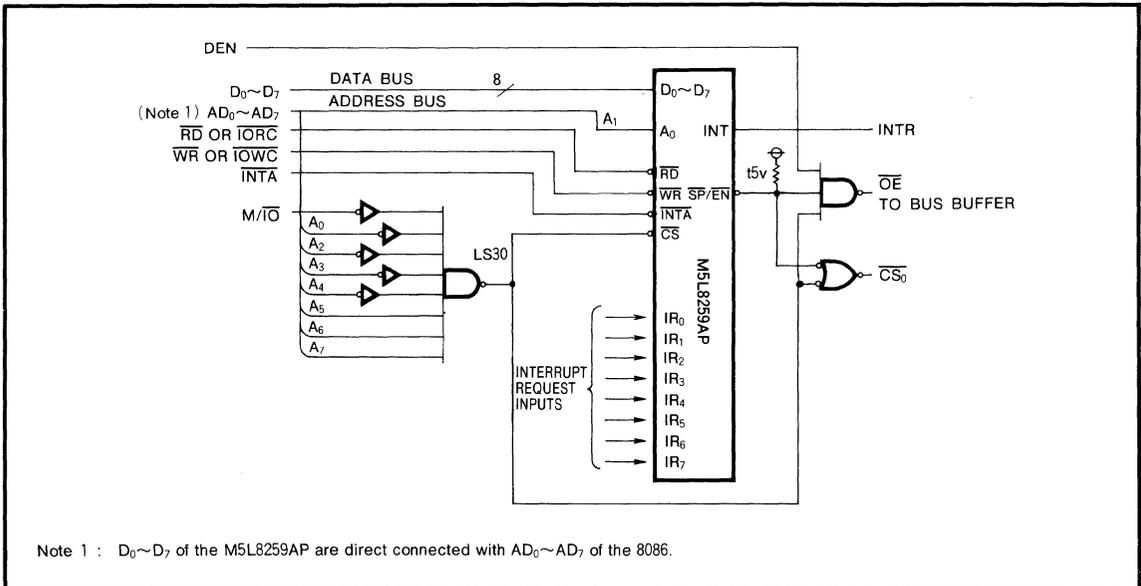
The cascade lines of the master are normally low, and will contain the slave identification code from the leading edge of the first INTA pulse to the trailing edge of the last INTA pulse. The master and slave can be programmed to work in different modes. ICWs must be issued for each device, and EOI commands must be issued twice: once for the master and once for the corresponding slave. Each CS of the M5L8259AP requires an address decoder.

**PROGRAMMABLE INTERRUPT CONTROLLER**



**4**

Fig. 6 Cascading the M5L8259AP



Note 1 : D<sub>0</sub>~D<sub>7</sub> of the M5L8259AP are direct connected with AD<sub>0</sub>~AD<sub>7</sub> of the 8086.

Fig. 7 Example of interface with the 8086

PROGRAMMABLE INTERRUPT CONTROLLER

INSTRUCTION SET

Item Number	Mnemonic	Instruction code									Function			
		A <sub>0</sub>	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>	ICW4 required?	Interval	Single	Trigger
1	ICW1 A	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	1	1	0	N	4	Y	E
2	ICW1 B	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	1	1	0	N	4	Y	L
3	ICW1 C	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	1	0	0	N	4	N	L
4	ICW1 D	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	1	0	0	N	4	N	L
5	ICW1 E	0	A <sub>7</sub>	A <sub>6</sub>	0	1	0	0	1	0	N	8	Y	L
6	ICW1 F	0	A <sub>7</sub>	A <sub>6</sub>	0	1	1	0	1	0	N	8	Y	L
7	ICW1 G	0	A <sub>7</sub>	A <sub>6</sub>	0	1	0	0	0	0	N	8	N	L
8	ICW1 H	0	A <sub>7</sub>	A <sub>6</sub>	0	1	1	0	0	0	N	8	N	L
9	ICW1 I	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	1	1	1	Y	4	Y	L
10	ICW1 J	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	1	1	1	Y	4	Y	L
11	ICW1 K	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	1	0	1	Y	4	N	L
12	ICW1 L	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	1	0	1	Y	4	N	L
13	ICW1 M	0	A <sub>7</sub>	A <sub>6</sub>	0	1	0	0	1	1	Y	8	Y	L
14	ICW1 N	0	A <sub>7</sub>	A <sub>6</sub>	0	1	1	0	1	1	Y	8	Y	L
15	ICW1 O	0	A <sub>7</sub>	A <sub>6</sub>	0	1	0	0	0	1	Y	8	N	L
16	ICW1 P	0	A <sub>7</sub>	A <sub>6</sub>	0	1	1	0	0	1	Y	8	N	L
17	ICW2	1	A <sub>15</sub>	A <sub>14</sub>	A <sub>13</sub>	A <sub>12</sub>	A <sub>11</sub>	A <sub>10</sub>	A <sub>9</sub>	A <sub>8</sub>	8-bit vectored address			
18	ICW3 M	1	S <sub>7</sub>	S <sub>6</sub>	S <sub>5</sub>	S <sub>4</sub>	S <sub>3</sub>	S <sub>2</sub>	S <sub>1</sub>	S <sub>0</sub>	Slave connections (master mode)			
19	ICW3 S	1	0	0	0	0	0	ID <sub>2</sub>	ID <sub>1</sub>	ID <sub>0</sub>	Slave identification code (slave mode)			
											SFNM	BUF	AEOI	8086
20	ICW4 A	1	0	0	0	0	0	0	0	0	N	N	N	N
21	ICW4 B	1	0	0	0	0	0	0	0	1	N	N	N	Y
22	ICW4 C	1	0	0	0	0	0	0	1	0	N	N	Y	N
23	ICW4 D	1	0	0	0	0	0	0	1	1	N	N	Y	Y
24	ICW4 E	1	0	0	0	0	0	1	0	0	N	N	N	Y
25	ICW4 F	1	0	0	0	0	0	1	0	1	N	N	N	Y
26	ICW4 G	1	0	0	0	0	0	1	1	0	N	N	Y	Y
27	ICW4 H	1	0	0	0	0	0	1	1	1	N	N	Y	Y
28	ICW4 I	1	0	0	0	0	1	0	0	0	N	Y S	N	N
29	ICW4 J	1	0	0	0	0	1	0	0	1	N	Y S	N	Y
30	ICW4 K	1	0	0	0	0	1	0	1	0	N	Y S	N	Y
31	ICW4 L	1	0	0	0	0	1	0	1	1	N	Y S	Y	Y
32	ICW4 M	1	0	0	0	0	1	1	0	0	N	Y M	N	Y
33	ICW4 N	1	0	0	0	0	1	1	0	1	N	Y M	N	Y
34	ICW4 O	1	0	0	0	0	1	1	1	0	N	Y M	Y	Y
35	ICW4 P	1	0	0	0	0	1	1	1	1	N	Y M	Y	Y
36	ICW4 NA	1	0	0	0	1	0	0	0	0	Y	N	N	Y
37	ICW4 NB	1	0	0	0	1	0	0	0	1	Y	N	N	Y
38	ICW4 NC	1	0	0	0	1	0	0	1	0	Y	N	Y	Y
39	ICW4 ND	1	0	0	0	1	0	0	1	1	Y	N	Y	Y
40	ICW4 NE	1	0	0	0	1	0	1	0	0	Y	N	N	Y
41	ICW4 NF	1	0	0	0	1	0	1	0	1	Y	N	N	Y
42	ICW4 NG	1	0	0	0	1	0	1	1	0	Y	N	Y	Y
43	ICW4 NH	1	0	0	0	1	0	1	1	1	Y	N	Y	Y
44	ICW4 NI	1	0	0	0	1	1	0	0	0	Y	Y S	N	Y
45	ICW4 NJ	1	0	0	0	1	1	0	0	1	Y	Y S	N	Y
46	ICW4 NK	1	0	0	0	1	1	0	1	0	Y	Y S	Y	Y
47	ICW4 NL	1	0	0	0	1	1	0	1	1	Y	Y S	Y	Y
48	ICW4 NM	1	0	0	0	1	1	1	0	0	Y	Y M	N	Y
49	ICW4 NN	1	0	0	0	1	1	1	0	1	Y	Y M	N	Y
50	ICW4 NO	1	0	0	0	1	1	1	1	0	Y	Y M	Y	Y
51	ICW4 NP	1	0	0	0	1	1	1	1	1	Y	Y M	Y	Y
52	OCW1	1	M <sub>7</sub>	M <sub>6</sub>	M <sub>5</sub>	M <sub>4</sub>	M <sub>3</sub>	M <sub>2</sub>	M <sub>1</sub>	M <sub>0</sub>	Interrupt mask			
53	OCW2 E	0	0	0	1	0	0	0	0	0	EOI			
54	OCW2 SE	0	0	1	1	0	0	L <sub>2</sub>	L <sub>1</sub>	L <sub>0</sub>	SEOI			
55	OCW2 RE	0	1	0	1	0	0	0	0	0	Rotate on Non-Specific EOI command (Automatic rotation)			
56	OCW2 RSE	0	1	1	1	0	0	L <sub>2</sub>	L <sub>1</sub>	L <sub>0</sub>	Rotate on Specific EOI command (Specific rotation)			
57	OCW2 R	0	1	0	0	0	0	0	0	0	Rotate in AEOI Mode (SET)			
58	OCW2 CR	0	0	0	0	0	0	0	0	0	Rotate in AEOI Mode (CLEAR)			
59	OCW2 RS	0	1	1	0	0	0	L <sub>2</sub>	L <sub>1</sub>	L <sub>0</sub>	Set priority without EOI			
60	OCW3 P	0	0	0	0	0	1	1	0	0				
61	OCW3 RIS	0	0	0	0	0	1	0	1	1				
62	OCW3 RR	0	0	0	0	0	1	0	1	0				
63	OCW3 SM	0	0	1	1	0	1	0	0	0				
64	OCW3 RSM	0	0	1	0	0	1	0	0	0				

Note : Y: yes, N: no, E: edge, L: level, M: master, S: slave

PROGRAMMABLE INTERRUPT CONTROLLER

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
V <sub>CC</sub>	Supply voltage	With respect to V <sub>SS</sub>	-0.5~7	V
V <sub>I</sub>	Input voltage		-0.5~7	V
V <sub>O</sub>	Output voltage		-0.5~7	V
P <sub>d</sub>	Power dissipation	T <sub>a</sub> =25°C	1000	mW
T <sub>opr</sub>	Operating free-air temperature range		-20~75	°C
T <sub>stg</sub>	Storage temperature range		-65~150	°C

RECOMMENDED OPERATING CONDITIONS (T<sub>a</sub>=-20~75°C, unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
V <sub>CC</sub>	Supply voltage	4.5	5	5.5	V
V <sub>SS</sub>	Supply voltage		0		V
V <sub>IH</sub>	High-level input voltage	2		V <sub>CC</sub> +0.5	V
V <sub>IL</sub>	Low-level input voltage	-0.5		0.8	V

ELECTRICAL CHARACTERISTICS (T<sub>a</sub>=-20~75°C, V<sub>CC</sub>=5V±10%, V<sub>SS</sub>=0V, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
V <sub>OH</sub>	High-level output voltage	I <sub>OH</sub> =-400μA	2.4			V
V <sub>OH(INT)</sub>	High-level output voltage, interrupt request output	I <sub>OH</sub> =-100μA I <sub>OH</sub> =-400μA	3.5 2.4			V
V <sub>OL</sub>	Low-level output voltage	I <sub>OL</sub> =2.2mA			0.45	V
I <sub>CC</sub>	Supply current from V <sub>CC</sub>				85	mA
I <sub>IH</sub>	High-level input current	V <sub>I</sub> =V <sub>CC</sub>	-10		10	μA
I <sub>IL</sub>	Low-level input current	V <sub>I</sub> =0V	-10		10	μA
I <sub>OZ</sub>	Off-state output current	V <sub>SS</sub> =0, V <sub>I</sub> =0.45~5.5V	-10		10	μA
I <sub>IH(IR)</sub>	High-level input current, interrupt request inputs	V <sub>I</sub> =V <sub>CC</sub>			10	μA
I <sub>IL(IR)</sub>	Low-level input current, interrupt request inputs	V <sub>I</sub> =0V	-300			μA
C <sub>i</sub>	Output capacitance	V <sub>CC</sub> =V <sub>SS</sub> , f=1MHz, 25mVrms, T <sub>a</sub> =25°C			10	pF
C <sub>i/O</sub>	Input/output capacitance	V <sub>CC</sub> =V <sub>SS</sub> , f=1MHz, 25mVrms, T <sub>a</sub> =25°C			20	pF

TIMING REQUIREMENTS (T<sub>a</sub>=-20~75°C, V<sub>CC</sub>=5V±10%, V<sub>SS</sub>=0V, unless otherwise noted)

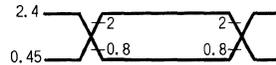
Symbol	Parameter	Alternative Symbol	Limits			Unit
			Min	Typ	Max	
t <sub>w(W)</sub>	Write pulse width	t <sub>WLWH</sub>	290			ns
t <sub>SU(A-W)</sub>	Address setup time before write	t <sub>AHWL</sub>	0			ns
t <sub>H(W-A)</sub>	Address hold time after write	t <sub>WHAX</sub>	0			ns
t <sub>SU(DQ-W)</sub>	Data setup time before write	t <sub>DVWH</sub>	240			ns
t <sub>H(W-DQ)</sub>	Data hold time after write	t <sub>WHDX</sub>	0			ns
t <sub>w(R)</sub>	Read pulse width	t <sub>RLRH</sub>	235			ns
t <sub>SU(A-R)</sub>	Address setup time before read	t <sub>AHRL</sub>	0			ns
t <sub>H(R-A)</sub>	Address hold time after read	t <sub>RHAX</sub>	0			ns
t <sub>w(IR)</sub>	Interrupt request input width, low-level time, edge triggered mode	t <sub>IJLH</sub>	100			ns
t <sub>SU(CAS-INTA)</sub>	Cascade setup time after INTA (slave)	t <sub>CVIAL</sub>	55			ns
t <sub>rec(W)</sub>	Write recovery time	t <sub>WHRL</sub>	190			ns
t <sub>rec(R)</sub>	Read recovery time	t <sub>RHRL</sub>	160			ns
t <sub>d(RW)</sub>	End of command to next command (Not same command type)	t <sub>CHCL</sub>	500			ns
	End of INTA sequence to next INTA sequence		625			ns

PROGRAMMABLE INTERRUPT CONTROLLER

SWITCHING CHARACTERISTICS (T<sub>a</sub>=-20~75°C, V<sub>CC</sub>=5V±10%, V<sub>SS</sub>=0V, unless otherwise noted)

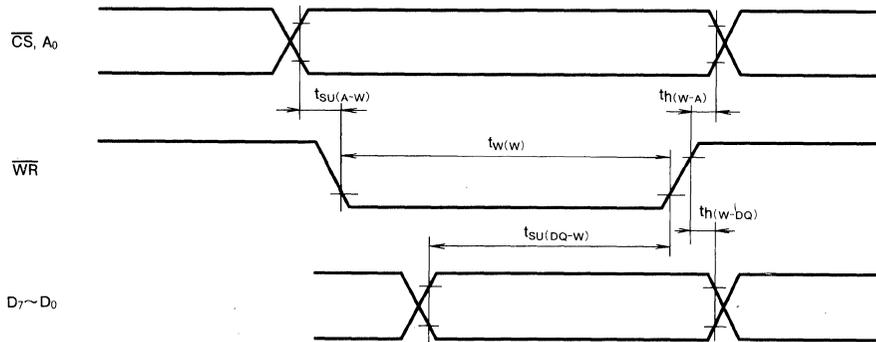
Symbol	Parameter	Alternative Symbol	Limits			Unit
			Min	Typ	Max	
t <sub>PZV(R-DQ)</sub>	Data output enable time after read	t <sub>RLDV</sub>			200	ns
t <sub>PVZ(R-DQ)</sub>	Data output disable time after read	t <sub>RHDZ</sub>	10		100	ns
t <sub>PZV(A-DQ)</sub>	Data output enable time after address	t <sub>AHDV</sub>			200	ns
t <sub>PHL(R-EN)</sub>	Propagation time from read to enable signal output	t <sub>RLEL</sub>			125	ns
t <sub>PLH(R-EN)</sub>	Propagation time from read to disable signal output	t <sub>RHEH</sub>			150	ns
t <sub>PLH(IR-INT)</sub>	Propagation time from interrupt request input to interrupt request output	t <sub>JHIH</sub>			350	ns
t <sub>PLV(INTA-CAS)</sub>	Propagation time from INTA to cascade output (master)	t <sub>ALCV</sub>			565	ns
t <sub>PZV(CAS-DQ)</sub>	Data output enable time after cascade output (slave)	t <sub>CVDV</sub>			300	ns

Note 1 : INTA signal is considered read signal  
 CS signal is considered address signal  
 Input pulse level 0.45~2.4V  
 Input pulse rise time 20ns  
 Input pulse fall time 20ns  
 Reference level input V<sub>IH</sub>=2V, V<sub>IL</sub>=0.8V  
 output V<sub>OH</sub>=2V, V<sub>OL</sub>=0.8V  
 Load capacitance C<sub>L</sub>=100pF, where SP/EN pin is 15pF

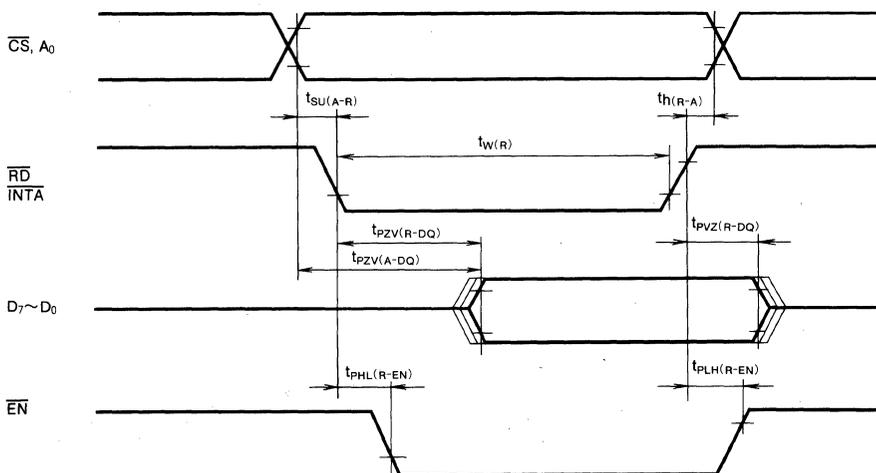


TIMING DIAGRAM

Write Mode

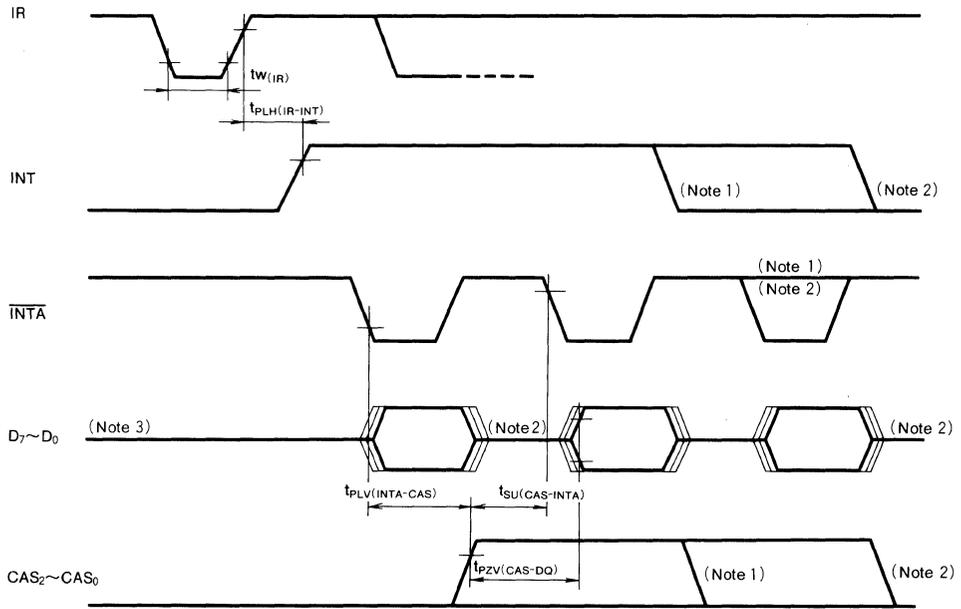


Read Mode

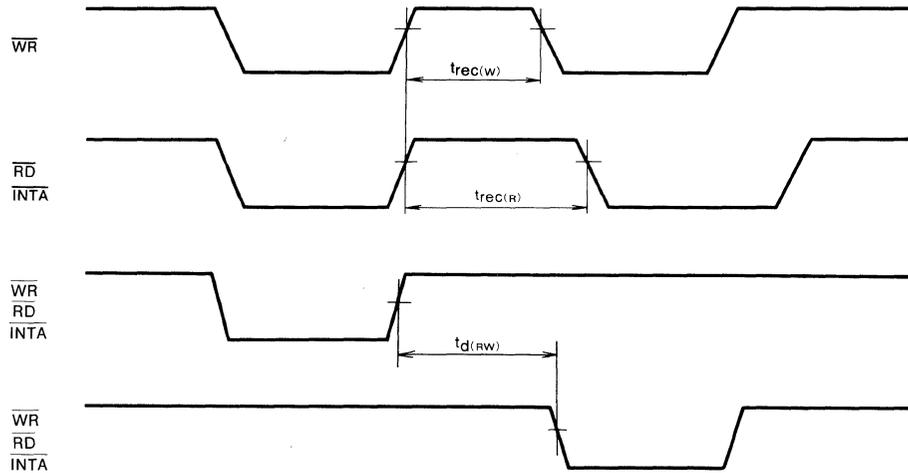


**PROGRAMMABLE INTERRUPT CONTROLLER**

**Interrupt Sequence**



**Other Timing**



- Note 1 : 8086, 8088 mode
- 2 : 8085A mode
- 3 : 8086, 8088 mode is in high-impedance state, pointer is released during the next INTA. When in single 8085A mode, data is released by all INTAs. When master, CALL instruction is released during the first INTA, high impedance state during the second and third INTA. When slave, high impedance state during the first INTA, vectored address is released during the second and third INTA.

**PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE**

**DESCRIPTION**

The M5L8279P-5 is a programmable keyboard and display interface device that is designed to be used in combination with an 8-bit/16-bit microprocessor. This device is fabricated with N-channel silicon-gate ED-MOS process technology and is packed in a 40-pin DIL package. It needs only single 5V power supply.

**FEATURES**

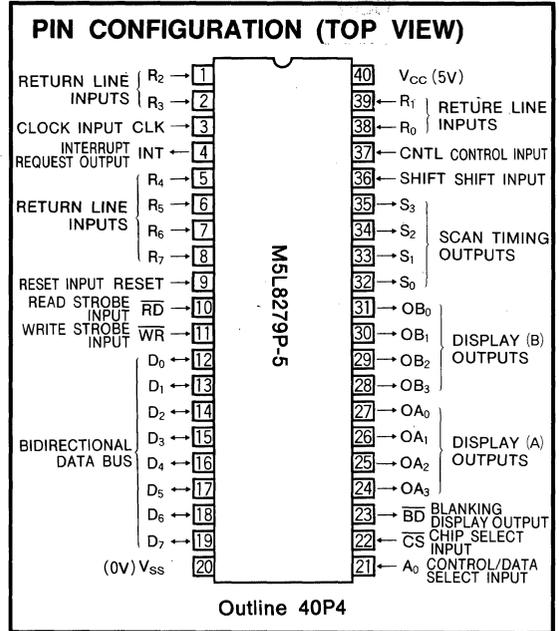
- Single 5V supply voltage
- Keyboard mode
- Sensor matrix mode
- Strobed mode
- Internally provided key bounce protection circuit
- Programmable debounce time
- 2-key lockout/N-key rollover
- 8-character keyboard FIFO
- Internally contained 16 × 8-bit display RAM
- Programmable right and left entry

**APPLICATIONS**

- Microcomputer I/O device
- 64 contact key input device for such items as electronic cash registers
- Dual 8- or single 16-alphanumeric display

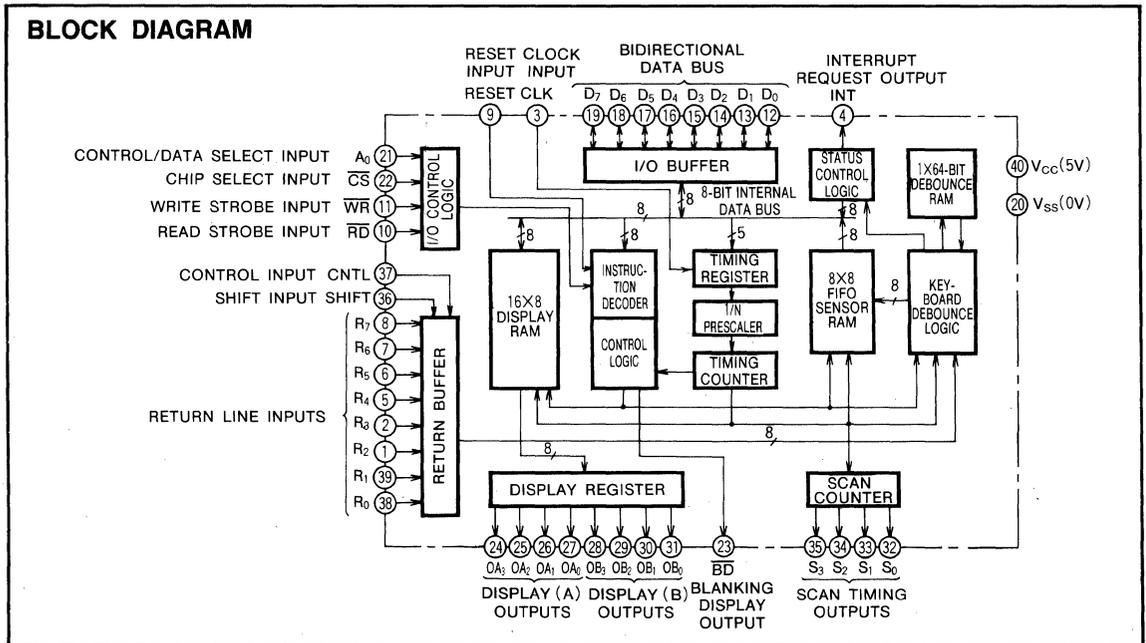
**FUNCTION**

The total chip, consisting of a keyboard interface and a display interface, can be programmed by eight 8-bit commands. The keyboard portion is provided with a 64-bit key



debounce buffer and an 8 × 8-bit FIFO/SENSOR RAM. It operates in any one of the scanned keyboard mode, scanned sensor matrix mode or strobed entry mode. The display portion is provided with a 16 × 8-bit display RAM that can be organized into a dual 16 × 4 configuration. Also, an 8-digit display configuration is possible by means of programming.

**BLOCK DIAGRAM**



**PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE**

**PIN DIScription**

pin	Name	Input or output	Functions
R <sub>0</sub> ~R <sub>7</sub>	Return line inputs	In	These are the return lines which are connected with the scan lines through the keys or sensor switches, and are used for 8-bit input in the strobed entry mode. They are provided with internal pullups to maintain them high until a switch closure pulls one low. They become active at low-level.
CLK	Clock input	in	Clock signal from the system which is used to generate internal timing.
INT	Interrupt request output	Out	When there is any data in the FIFO during the keyboard mode or the strobed mode, this signal turns high-level so as to request interrupt to the CPU. It turns low each time data is read, but if any data remains in the FIFO it will turn high again and request interrupt to the CPU. End interrupt command resets INT signal.
RESET	Reset input	In	Resets the chip when this signal is high. After the reset it assumes 16-digit, left-entry, encode display and 2-key lockout mode, and the prescale value of the clock becomes 31. The display RAM, however, is not cleared.
$\overline{RD}$	Read strobe input	In	Functions to control data transfer to the data bus.
$\overline{WR}$	Write strobe input	In	Functions to control command/data transfer from the data bus.
D <sub>0</sub> ~D <sub>7</sub>	Bidirectional data bus	In/out	All data and commands between the CPU and the chip are transferred through these lines.
A <sub>0</sub>	Control/data select input	In	When this signal is high, it indicates that the signals in and out are either command (in) or status (out). When low, it indicates they are data (in/out).
CS	Chip select input	In	Chip select is enabled when this signal is low.
$\overline{BD}$	Blanking display output	Out	This signal is used in preventing overlapped display during digit swiching. It also may be brought to low-level by display blanking command.
OA <sub>0</sub> ~OA <sub>3</sub> OB <sub>0</sub> ~OB <sub>3</sub>	Display (A) and (B) outputs	Out	These output ports can be used either as a dual 4-bit port or a single 8-bit port depending on an application, and the contents of the display RAM are output synchronizing with the scan timing signals. These two 4-bit ports may be blanked independently. Blanking may be activated with either high- or low-level signal by means of clear command.
S <sub>0</sub> ~S <sub>3</sub>	Scan timing outputs	Out	These signals are used to scan the key switch, the sensor matrix or the display digit. They can be either decoded or encoded, but it requires an external decoder in the encode mode. Signals S <sub>0</sub> ~S <sub>3</sub> are all turned to low-level when RESET is high.
SHIFT	Shift input	In	In the keyboard mode, the shift input becomes the second highest bit of the key input information and is stored in the FIFO. This input is ignored in the other modes. It is constantly kept at high-level by an internal pull resistor. The signal is active at high-level.
CNTL	Control input	In	In the keyboard mode, the control input becomes the most significant bit of the key input information and is stored in the FIFO. The signal is active at high-level. In the strobed entry mode, it becomes the strobe signal and stores the return input data in the FIFO at the rising edge of the input. It affects nothing internal in the sensor mode. It is constantly kept at high-level by an internal pullup resistor.

**4**

**OPERATION**

One of the three operating modes, the keyboard mode is the most common, and allows programmed 2-key lockout and N-key rollover. Encoded timing signals corresponding with key input are stored in the FIFO through the key-bounce logic, and the debouncing time of the key is also programmable. In the sensor mode, the contents of the 8 × 8 key contacts are constantly stored in the FIFO/sensor RAM, generating an interrupt signal to the CPU each time there is a change in the contents. In the strobed entry mode, the CNTL input signal is used as a strobe for storing the 8 return line inputs to the FIFO/sensor RAM.

The display portion is provided with a 16 × 8-bit display RAM that can be organized into a dual 16 × 4-bit configura-

tion. Also, an 8-digit display configuration is possible by means of programming. Input to the register can be performed by either left or right entry modes. In the auto increment mode, read and write can be carried out after designating the starting address only.

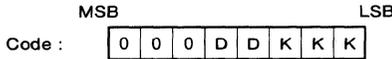
Both the keyboard and display sections are scanned by common scan timing signals that are derived from the basic clock pulse. This frequency-dividing ratio is changeable by means of programming. There are decode and encode modes for the scanning mode; timing signals that are decoded from the lower 2 bits of the scan counter are output in the decode mode, while the 4-bit binary output from the scan counter is decoded externally in the encode mode.

PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE

COMMAND DESCRIPTION

There are eight commands provided for programming the operating modes of the M5L8279P-5. These commands are sent on the data bus with the signal  $\overline{CS}$  in low-level and the signal  $A_0$  in high-level and are stored in the M5L8279P-5 at the rising edge of the signal  $\overline{WR}$ . The order of the command execution is arbitrary.

1. Mode Set Command



DD (Display mode set command)

- 0 0 8—8-bit character display—left entry
- 0 1 16—8-bit character display—left entry<sup>1</sup>
- 1 0 8—8-bit character display—right entry
- 1 1 16—8-bit character display—right entry

KKK (Keyboard mode set command)

- 0 0 0 Encoded display keyboard mode — 2-key lockout<sup>1</sup>
- 0 0 1 Decoded display keyboard mode — 2-key lockout
- 0 1 0 Encoded display keyboard mode — N-key rollover
- 0 1 1 Decoded display keyboard mode — N-key rollover
- 1 0 0 Encoded display, sensor mode
- 1 0 1 Decoded display, sensor mode
- 1 1 0 Encoded display, strobed entry mode
- 1 1 1 Decoded display, strobed entry mode

Note 1 : Default after reset.

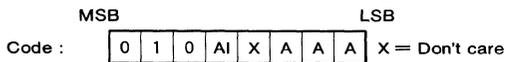
2. Program Clock Command



The external clock is divided by the prescaler value P P P P P designated by this command to obtain the basic internal frequency.

When the internal clock is set to 100kHz, it will give a 5.1ms keyboard scan time and a 10.3ms debounce time. The prescale value that can be specified by P P P P P is from 2 to 31. In case P P P P P is 00000 or 00001, the prescale is set to 2. Default after a reset pulse is 31, but the prescale value is not cleared by the clear command.

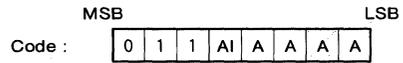
3. Read FIFO Command



This command is used to specify that the following data readout ( $\overline{CS} \cdot \overline{A_0} \cdot \overline{RD}$ ) is from the FIFO. As long as data is to be read from the FIFO, no additional commands are necessary.

AI and AAA are used only in the sensor mode. AAA designates the address of the FIFO to be read, and AI is the auto-increment flag. Turning AI to "1" makes the address automatically incremented after the second read operation. This auto-increment bit does not affect the auto-increment of the display RAM.

4. Read Display RAM Command

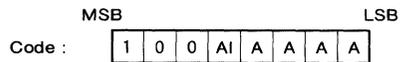


This command is used to specify that the following data readout ( $\overline{CS} \cdot \overline{A_0} \cdot \overline{RD}$ ) is from the display RAM. As long as data is to be read from the display RAM, no additional commands are necessary.

The data AAAA is the value with which the display RAM read/write counter is set, and it specifies the address of the display RAM to be read or written next.

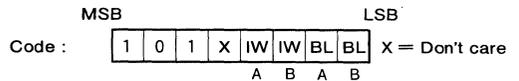
AI is the auto-increment flag. Turning AI to "1" makes the address automatically incremented after the second read/write operation. This auto-increment bit does not affect the auto-increment of FIFO readout in the sensor mode.

5. Write Display RAM Command



With this command, following display RAM read/write addressing is achieved without changing the data readout source (FIFO or display RAM). Meaning of AI and AAAA are identical with read display RAM command.

6. Display Write inhibit/Blanking Command

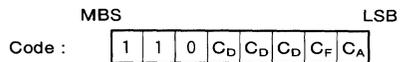


The IW is a write inhibit bit to the display RAM that corresponds with the output A or B. Inhibit is activated by turning the IW "1".

The BL is used in blanking the out A or B. Blanking is activated by turning the BL "1". Setting both BL flags makes the signal BD low so that it can be used in 8-bit display mode.

Resetting the flags makes all IW and BL turn "0".

7. Clear Command



C<sub>D</sub>: Clears the display RAM.

C <sub>D</sub>	C <sub>D</sub>	C <sub>D</sub>	
0	X	X	No specific performance
1	0	X	Entire contents of the display RAM are turned "0".
1	1	0	The contents of the display RAM are turned 20H (00100000 = 0A <sub>3</sub> 0A <sub>2</sub> 0A <sub>1</sub> 0A <sub>0</sub> 0B <sub>3</sub> 0B <sub>2</sub> 0B <sub>1</sub> 0B <sub>0</sub> ).
1	1	1	Entire contents of the display RAM are turned "1".

**PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE**

$C_F$  : Clears the status word and resets the interrupt signal (INT).

$C_A$  : Clears the display RAM and the status word and resets the interrupt signal (INT).

Clearing condition of the display RAM is determined by the lower 2 bits of the  $C_D$ .

Clearing the display RAM needs some time (~ 160  $\mu$  second) and causes the display-unavailable status (DU) in the status word to be "1". The display RAM is not accessible for the duration of this time, even if the display mode was in 8-digit display mode or a decoded mode.

As both  $C_F$  and  $C_A$  function to reset the internal keydebounce counter, the key input under counting is ignored, and the internal FIFO counter is reset to make the interrupt signal low-level.

$C_A$  resets the internal timing counter, forcing  $S_0 \sim S_3$  to start from  $S_3S_2S_1S_0 = 0000$  after the execution of the command.

**8. End Interrupt/Error Mode Set Command**



In the sensor matrix mode, an interrupt signal is generated at the beginning of the next key scan time to inhibit further writing to the FIFO when there is a change in the sensor switch. The interrupt request output INT is reset when the sensor RAM is read with the Auto-increment flag "0", or the execution of this command.

When E is kept in "0", depression of any sensor makes the second highest bit of the status word "1". When E is kept in "1", the status is kept "0" all the time.

When E is programmed to "1" in the N-key rollover mode, the execution of this command makes the chip operate in special error mode, during which time depression of more than two keys in a key debounce time causes an error and sets the second highest bit of the status word "1".

**Status word**



**NNN:** Indicates the number of characters in the FIFO during the keyboard and strobed entry modes.

**F:** Indicates that the FIFO is filled up with 8 characters.

The number of characters existing in the FIFO ( 0 ~ 8 characters) can be known by means of the bits NNN and F (FNNN = 0000~FNNN = 1000).

**U:** Underrun error flag

This flag is set when a master CPU tries to read an empty FIFO.

**O:** Overrun error flag

This flag is set when another character is strobed into a full FIFO.

The bits U and O cannot be cleared by status read. They will be cleared by the clear command.

**S/E:** Sensor closure/multiple error flag

When "111EXXXX" is executed by turning E = 0 , the bit S/E in the status word is set when there is at least one sensor closure.

When "111EXXXX" is executed by turning E = 1 (special error mode) , the bit S/E is set when there are more than two key depressions made in a key scan time.

**DU:** Display unavailable

This flag is set when a clear display command is executed, and announces that the display RAM is not accessible.

Note 2 : The underrun, overrun and special error flags are reset by either executing clear command (CF= 1) or reading status word.

PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE

CPU INTERFACE

1. Command Write

A command is written on the rising edge of the signal  $\overline{WR}$  with  $\overline{CS}$  low and  $A_0$  high.

2. Data Write

Data is written to the display RAM on the rising edge of the signal  $\overline{WR}$  with  $\overline{CS}$  and  $A_0$  low.

The address of the display RAM is also incremented on the rising edge of the signal  $\overline{WR}$  if  $A_1$  is set for the display RAM.

3. Status Read

The status word is read when  $\overline{CS}$  and  $\overline{RD}$  are low and  $A_0$  is high. The status word appears on the data bus as long as the signal  $\overline{RD}$  is low.

4. Data Read

Data is read from either the FIFO or the display RAM with  $\overline{CS} = \overline{RD} = 0$  and  $A_0 = 0$ . The source of the data (FIFO or display RAM) is decided by the latest command (read display or read FIFO). The data read appears on the data bus as long as the signal  $\overline{RD}$  is low.

The trailing edge of the signal  $\overline{RD}$  increments the address of the FIFO or the display RAM when  $A_1$  is set. After the reset, data will be read from the FIFO, however.

$\overline{CS}$	$A_0$	$\overline{RD}$	$\overline{WR}$	Operation
0	1	1	0	Command write
0	0	1	0	Data write
0	1	0	1	Status read
0	0	0	1	Data read
1	X	X	X	No operation

KEYBOARD INTERFACE

Keyboard interface is done by the scan timing signals ( $S_0 \sim S_3$ ), the return line inputs ( $R_0 \sim R_7$ ), the SHIFT and the CNTRL inputs.

In the decoded mode, the low order of two bits of the internal scan counter are decoded and come out on the timing pins ( $S_0 \sim S_3$ ). In the encoded mode, the four binary bits of the scan counter are directly output on the timing pins, thus a 3-to-8 decoder must be employed to generate keyboard scan timing.

The return line inputs ( $R_0 \sim R_7$ ), the SHIFT and the CNTRL inputs are pulled up high by internal pullup transistors until a switch closure pulls one low.

The internal key debounce logic works for a 64-key matrix that is obtained by combining the return line inputs with the scan timing.

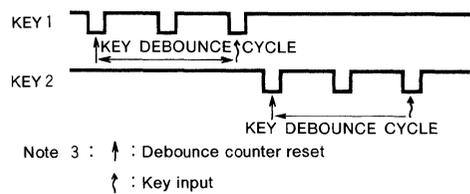
For the keyboard interface, M5L8279P-5 has four distinctive modes that allow various kinds of applications. In the following explanation, a "key scan cycle" is the time needed to scan a 64-key matrix, and a "key debounce cycle" needs a duration of two "key scan" cycles. (In the decoded mode 32 keys, unlike 64 keys in the encoded mode, can be employed

for a maximum key matrix due to the limit of timing signals. However, both the key scan cycle and the key debounce cycle are the same as in the encoded mode.)

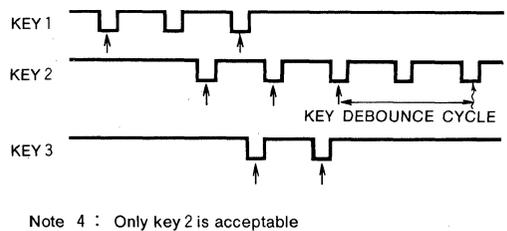
1. 2-Key Lockout (Scanned Keyboard mode)

The detection of a new key closure resets the internal debounce counter and starts counting. At the end of a key debounce cycle, the key is checked and entered into the FIFO if it is still down. An entry in the FIFO sets the INT output high. If any other keys are depressed in a key debounce cycle, the internal key debounce counter is reset each time it encounters a new key. Thus only a single-key depression within a key debounce duration is accepted, but all keys are ignored when more than two keys are depressed at the same time.

Example 1 : Accepting two successive key depressions



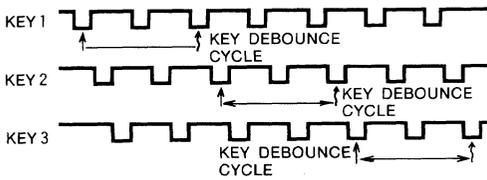
Example 2 : Overlapped depression of three keys



**PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE**

**2. N-Key Rollover (Scanned Keyboard Mode)**

Each key depression is treated independently from all others so as to allow overlapped key depression. Detection of a new key depression makes the internal key debounce counter reset and start to count in a same manner as in the case of 2-key lockout. But, in N-key rollover, other key closures are entirely ignored within a key debounce cycle so that depression of any other keys would not reset the key debounce counter. In this way, overlapped key depression is allowed so as to enable the following key input:

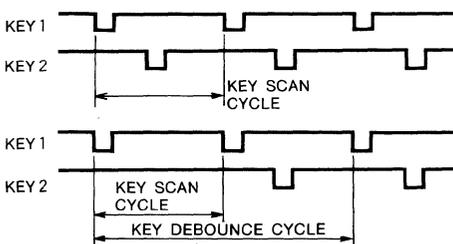


The scanned key input signal does not always reflect the actual key depressing action, as the key matrix is scanned by the timing signal.

With N-key rollover, there is a mode provided with which error is caused when there are more than two key inputs in a key debounce cycle, which can be programmed by using the end interrupt/error mode set command. In this mode (special error mode), recognition of the above error sets the INT signal to "1" and sets the bit S/E in the status word.

In case two key entries are made separately in more than a debounce cycle, there would be no problem, as key depression is clearly identified. And no problem exists for 2-key lockout, as the both keys are recognized invalid.

**Example of error (Special error mode)**



**3. Sensor Matrix Mode**

The key debounce logic is disabled in this mode. As the image of the sensor switch is kept in the FIFO, any change in this status is reported to the CPU by means of the interrupt signal INT. Although a debounce circuit is not used in this mode, it has an advantage in that the CPU is able to know how long and when the sensor was depressed.

In the sensor matrix mode with the bit E = 0 of the end interrupt/error mode set command, the second most significant bit of the status word (S/E bit) is set to "1" when any sensor switch is depressed.

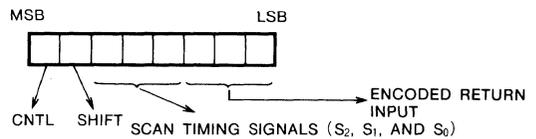
Any sensor change detected by the M5L8279P-5 in one key scan cycle causes only once INT generation at the first timing of the next scan cycle.

**4. Strobe Mode**

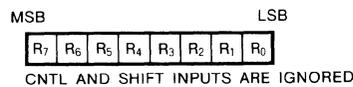
The data is entered into the FIFO from the return lines (R<sub>0</sub>~R<sub>7</sub>) at the rising edge of a CNTL pulse. The INT goes high while any data exists in the FIFO, in the same manner as in the keyboard mode. The key debounce circuit will not operate.

Formats of data entered into the FIFO in each of the above modes are described in the following:

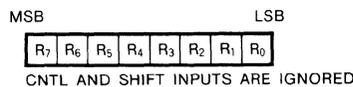
**Keyboard matrix**



**Sensor matrix mode**



**Strobe mode**



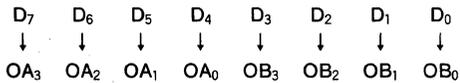
**4**

**PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE**

**DISPLAY INTERFACE**

The display interface is done by eight display outputs ( $OA_0 \sim OA_3, OB_0 \sim OB_3$ ), a blanking signal ( $\overline{BD}$ ), and scan timing outputs ( $S_0 \sim S_3$ ).

The relation between the data bus and the display outputs is as shown below:

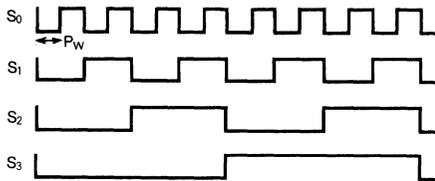


Clearing the display RAM is not achieved by the reset signal (9-pin) but requires the execution of the clear command.

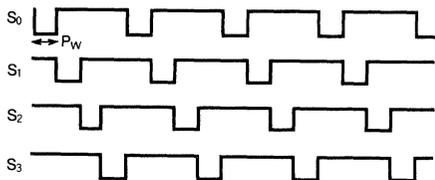
The timing diagrams for both the encoded and decoded modes are shown below.

For the encoded mode, a 3-to-8 or 4-to-16 decoder is required, according to whether eight or sixteen digit display used.

**(1) Encoded mode**

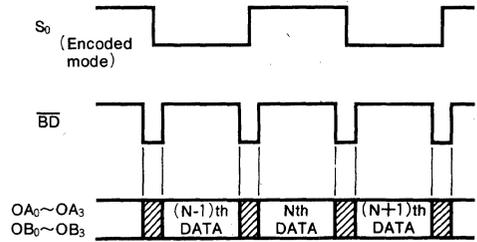


**(2) Decoded mode**



Note 5 : Here P<sub>w</sub> is 640μs if the internal clock frequency is set to 100kHz.

Timing relations of S<sub>0</sub>,  $\overline{BD}$ , and display outputs ( $OA_0 \sim OA_3, OB_0 \sim OB_3$ ) are shown below.



Note 6 : Values of the output data shown in the slanted line areas are decided upon the clear command executed last to become the value of the display RAM after the reset. The values in the slanted areas after reset will go low. In the same manner, the values OA<sub>0</sub>~OA<sub>3</sub>, OB<sub>0</sub>~OB<sub>3</sub> are dependent on the clear command executed last. When the both A and B are blanked, the signal  $\overline{BD}$  will be in low-level.

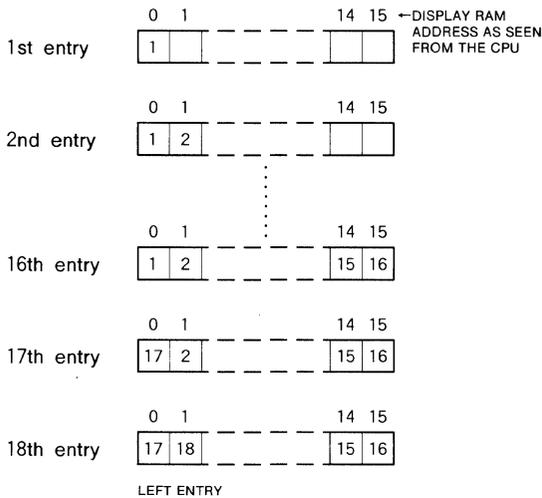
**PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE**

**KEY ENTRY METHODS**

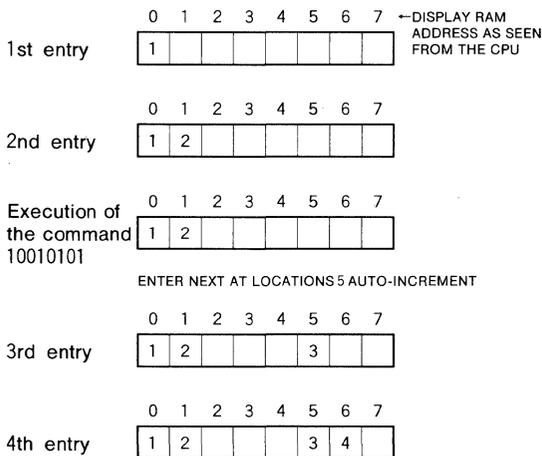
**1. Left Entry**

Address 0 in the display RAM corresponds to the leftmost position ( $S_3S_2S_1S_0 = 0000$ ) of a display and address 15 (or address 7 in 8-character display) to the rightmost position ( $S_3S_2S_1S_0 = 1111$  or  $S_2S_1S_0 = 111$ ). The 17th (9th) character is entered back into the leftmost position.

**Auto-increment mode**



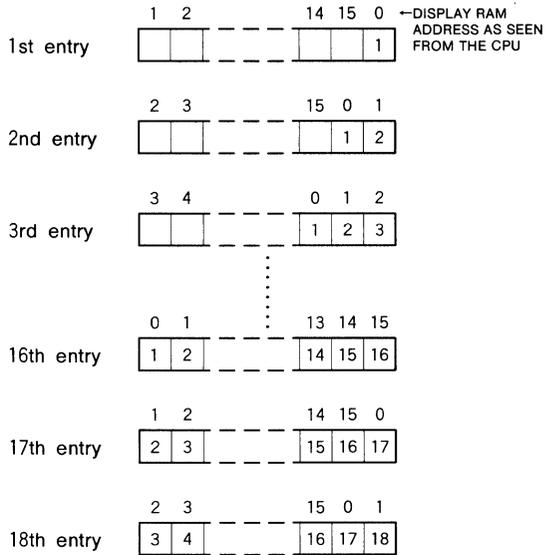
**Auto-increment mode**



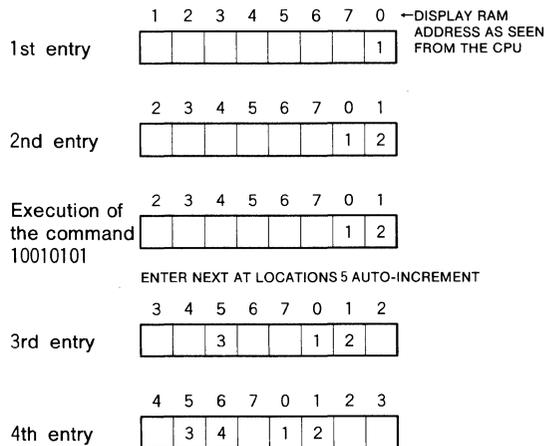
**2. Right Entry**

The first data is entered in the rightmost position of a display. From the next entry, the display is shifted left one character and the new data is placed in the rightmost position. A display position and a register address as viewed from the CPU change each time and do not correspond.

**Auto-increment mode**



**Auto-increment mode**



**4**

**PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE**

**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage	With respect to $V_{SS}$	-0.5~7	V
$V_I$	Input voltage		-0.5~7	V
$V_O$	Output voltage		-0.5~7	V
$P_d$	Maximum power dissipation	$T_a=25^{\circ}C$	1000	mW
$T_{opr}$	Operating free-air temperature range		-20~75	$^{\circ}C$
$T_{stg}$	Storage temperature range		-60~150	$^{\circ}C$

**RECOMMENDED OPERATING CONDITIONS** ( $T_a=-20\sim75^{\circ}C$ , unless otherwise noted.)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.5	5	5.5	V
$V_{SS}$	Supply voltage		0		V
$V_{IH(RL)}$	High-level input voltage, for return line inputs	2.2			V
$V_{IH}$	High-level input voltage, all others	2			V
$V_{IL(RL)}$	Low-level input voltage, for return line inputs	$V_{SS}-0.5$		1.4	V
$V_{IL}$	Low-level input voltage, all others	$V_{SS}-0.5$		0.8	V

**ELECTRICAL CHARACTERISTICS** ( $T_a=-20\sim75^{\circ}C$ ,  $V_{CC}=5V\pm 10\%$ ,  $V_{SS}=0V$ , unless otherwise noted.)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{OH}$	High-level output voltage	$I_{OH}=-400\mu A$	2.4			V
$V_{OH(INT)}$	Low-level output voltage, interrupt request output	$I_{OH}=-400\mu A$	3.5			V
$V_{OL}$	Low-level output voltage	$I_{OL}=2.2mA$			0.45	V
$I_{CC}$	Supply current from $V_{CC}$				120	mA
$I_{I(RL)}$	Input current, return line inputs, shift input and control input	$V_I=V_{CC}$			10	$\mu A$
		$V_I=0V$	-100			$\mu A$
$I_I$	Input current, all others	$V_I=V_{CC}\sim 0V$	-10		10	$\mu A$
$I_{OZ}$	Off-state output current	$V_I=V_{CC}\sim 0V$	-10		10	$\mu A$
$C_I$	Input capacitance	$V_I=V_{CC}$	5		10	pF
$C_O$	Output capacitance	$V_O=V_{CC}$	10		20	pF

PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE

**TIMING REQUIREMENTS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted.)

**Read Cycle**

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{C(R)}$	Read cycle time	$t_{RCY}$	(Note 7)	1000			ns
$t_{W(R)}$	Read pulse width	$t_{RR}$		250			ns
$t_{SU(A-R)}$	Address setup time before RD	$t_{AR}$		0			ns
$t_{H(R-A)}$	Address setup time after RD	$t_{RA}$		0			ns

**Write Cycle**

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$T_{C(W)}$	Write cycle time	$t_{WCY}$	(Note 7)	1000			ns
$T_{W(W)}$	Write pulse width	$t_{WW}$		250			ns
$t_{SU(A-W)}$	Address setup time before WR	$t_{AW}$		0			ns
$t_{H(W-A)}$	Address hold time after WR	$t_{WA}$		0			ns
$t_{SU(DQ-W)}$	Data input setup time before WR	$t_{DW}$		150			ns
$t_{H(W-DQ)}$	Data input hold time after WR	$t_{WD}$		0			ns

**Other Timing**

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{C(\neq)}$	Clock cycle time	$t_{CY}$	(Note 7)	320			ns
$t_{W(\neq)}$	Clock pulse width	$t_{\neq W}$		120			ns

For an internal clock frequency of 100kHz

- Key scan cycle time:  $\sim 5.1\text{ms}$
- Key debounce cycle time:  $\sim 10.3\text{ms}$
- Single-key scan time:  $80\mu\text{s}$
- Display scan time:  $\sim 10.3\text{ms}$
- Single digit display time:  $490\mu\text{s}$
- Blanking time:  $150\mu\text{s}$
- Internal clock cycle:  $10\mu\text{s}$

Note 7 : Test conditions.  
 Input pulse level:  $0.45 \sim 24V$   
 Input pulse rise time:  $20\text{ns}$   
 Input pulse fall time:  $20\text{ns}$   
 High-level input reference level:  $2V$   
 Low-level input reference level:  $0.8V$   
 $C_L = 150\text{pF}$

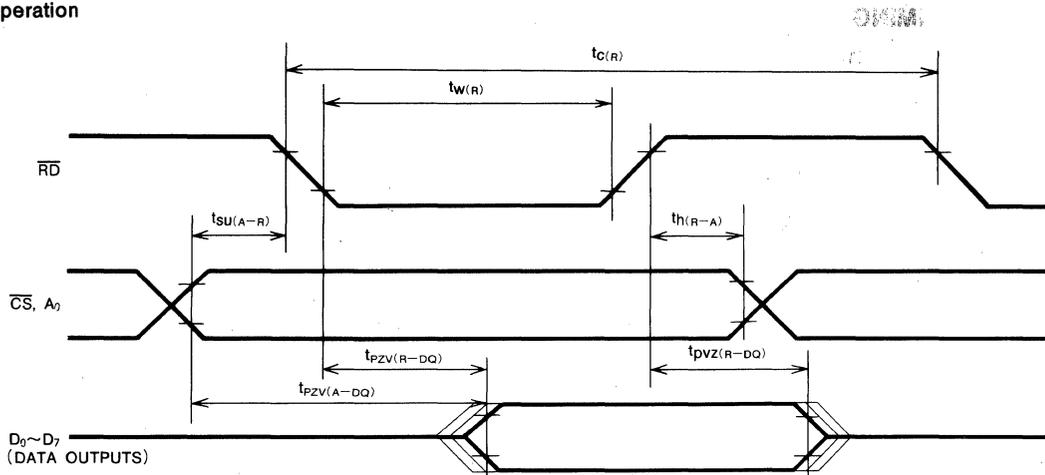
**SWITCHING CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted.)

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{PZV(R-DQ)}$	Output enable time after read	$t_{RD}$	(Note 8)			150	ns
$t_{PZV(A-DQ)}$	Output enable time after address	$t_{AD}$				250	ns
$t_{PVZ(R-DQ)}$	Output disable time after read	$t_{DF}$		10		100	ns

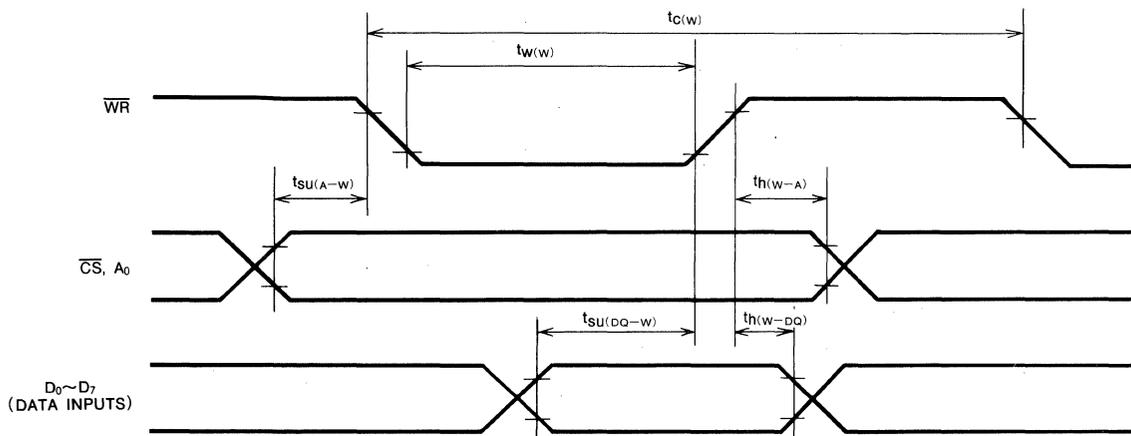
Note 8 : Test conditions.  
 Input pulse level:  $0.45 \sim 2.4V$   
 Input pulse rise time:  $20\text{ns}$   
 Input pulse fall time:  $20\text{ns}$   
 High-level input reference voltage:  $2V$   
 Low-level input reference voltage:  $0.8V$   
 High-level output reference voltage:  $2V$   
 Low-level output reference voltage:  $0.8V$   
 $C_L = 150\text{pF}$

**PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE**

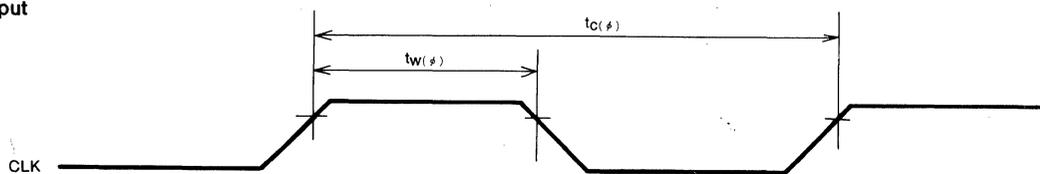
**Read operation**



**Write operation**



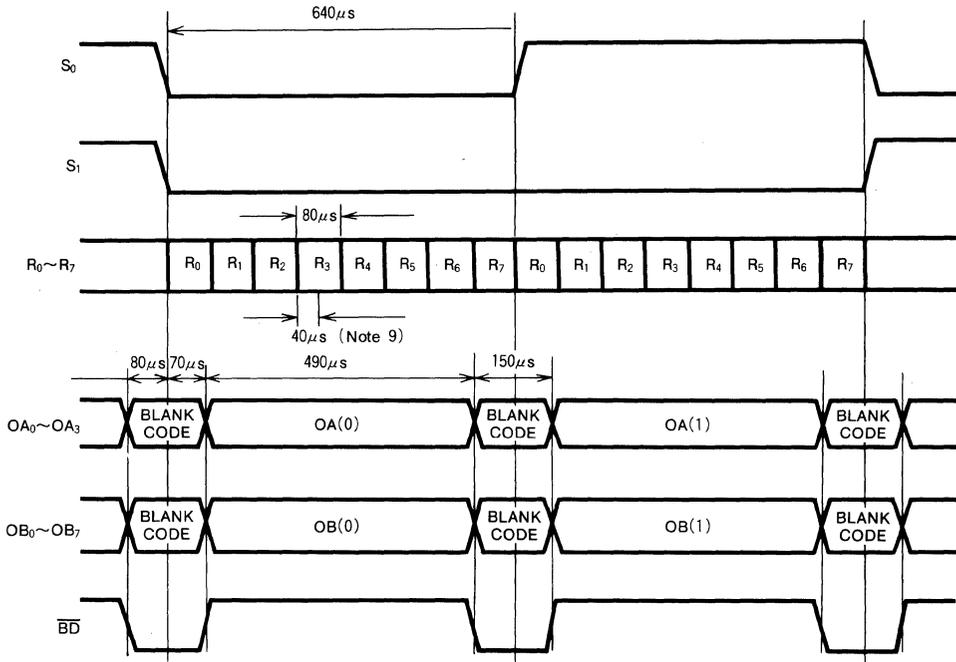
**Clock input**



**PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE**

**DISPLAY TIMING**

(This example is encoded display, left entry mode with internal clock cycle  $10\mu\text{scc}$ . Scan timing output  $S_2, S_3$  are not shown.)

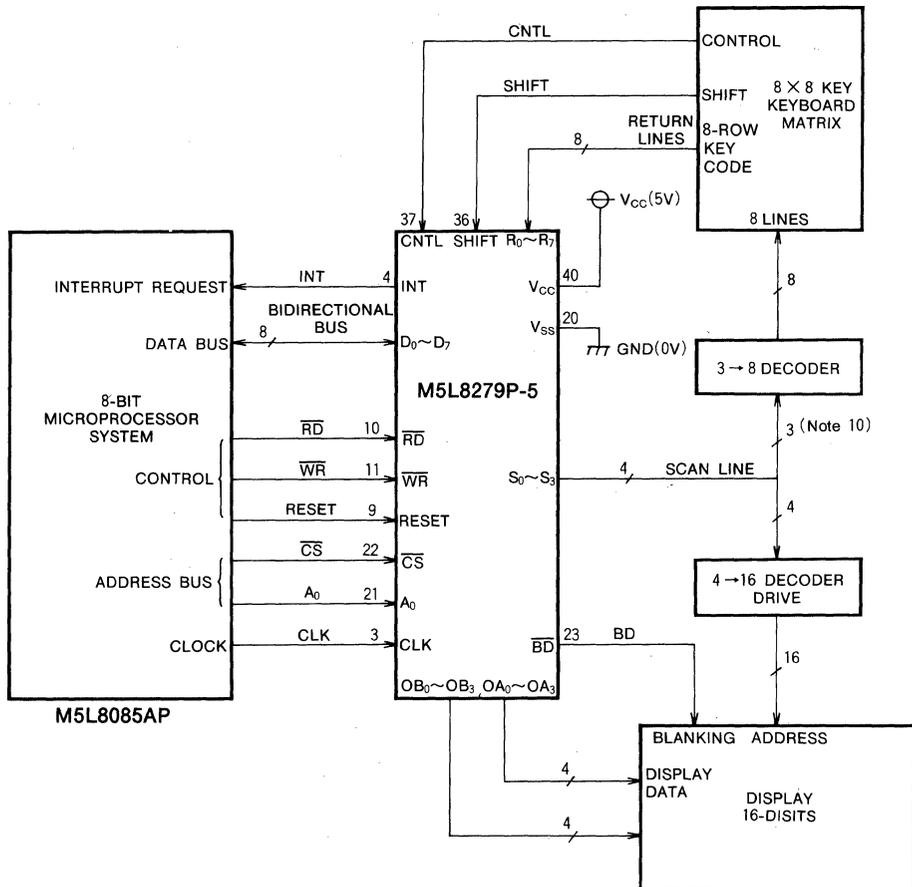


Note 9 : The scanned data on the return line is sampled serially from  $R_0$  to  $R_7$ . Each data is latched in the middle of the each sampling period.

**4**

**PROGRAMMABLE KEYBOARD/DISPLAY INTERFACE**

**APPLICATION EXAMPLE**



Note 10 : When using an 8-bit character display of more than 9 digits for the decoder display, it is necessary to provide two decoders for example 4 → 10 decoder, 4 → 16 decoder and key scan 3 → 8 decoder. Only S<sub>0</sub>, S<sub>1</sub> and S<sub>2</sub> may be used as inputs to the key scan 3 → 8 decoder. (Don't drive the keyboard decoder with the MSB of the scan line.)

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# CMOS PERIPHERAL CIRCUITS

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# MITSUBISHI LSIs

## M58990P,-1

### 8-BIT 8-CHANNEL A-D CONVERTER

#### DESCRIPTION

The M58990P A-D converter is used to convert analog signals to 8-bit digital values.

The A-D converter is fabricated using silicon-gates and CMOS technology. The M58990P can selectively multiplex 8 channels of analog input.

#### FEATURES

Type No.	Linearity error (Max) (LSB)	Absolute accuracy (Max) (LSB)
M58990P	$\pm 1/2$	$\pm 1$
M58990P-1	$\pm 1$	$\pm 1/2$

- Single 5V supply voltage
- The I/O pins can be connected directly to TTL circuits
- Conversion resolution of 8 bits
- Multiplex 8 channels of analog input
- Broad range of analog input voltages:  $0V \sim V_{CC}$
- Conversion time:  $60\mu s$
- Conversion by successive approximation
- Can be used online through the data bus of a micro-processor

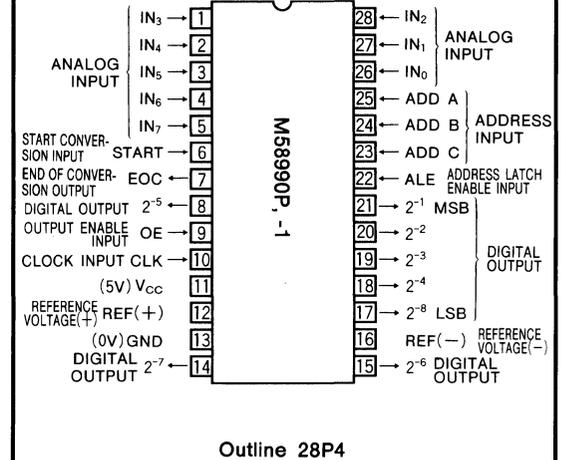
#### APPLICATION

Used with microcomputers to control analog systems.

#### FUNCTION

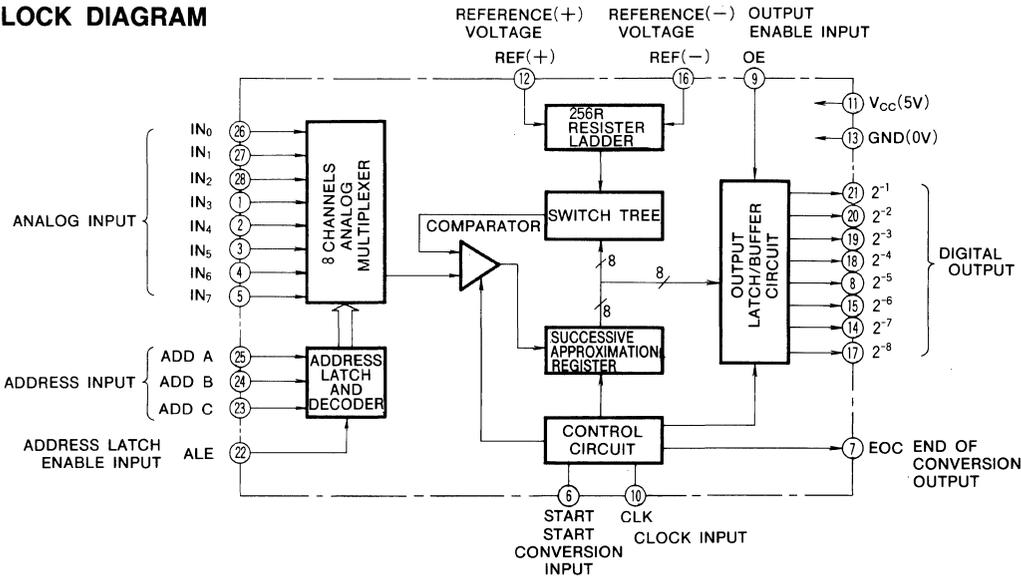
The M58990P has eight analog input terminals that are selected by the input signals to the 3 address terminals (ADD A ~ ADD C). The address signals of these terminals

#### PIN CONFIGURATION (TOP VIEW)



are read and latched in the internal address latches by the ALE signal. When the OE terminal is at low-level, the output terminals  $2^{-1} \sim 2^{-8}$  are in a floating state so they can be connected directly to the data bus of a microcomputer. The input terminal START is used to call for the start of an analog to digital conversion and a signal is output through terminal EOC when the conversion is completed.

#### BLOCK DIAGRAM



8-BIT 8-CHANNEL A-D CONVERTER

PIN DESCRIPTIONS

Pin	Name	Input or Output	Functions
IN <sub>0</sub> } IN <sub>7</sub>	Analog signal	Input	These are analog signal input pins. Which of the 8 inputs is selected, is determined by ADD A~ADD C. An analog voltage applied at the selected pin is converted to a digital value in the range of 2 <sup>-1</sup> ~2 <sup>-8</sup> and output.
ADD A } ADD C	Address signal	Input	The input is used for selecting which of the 8 terminals IN <sub>0</sub> ~IN <sub>7</sub> is to be converted from analog to digital. The address input through ADD A~ADD C is read to the address latch by the rising edge of ALE.
ALE	Address latch enable signal	Input	This is the strobe signal which causes the address signal input through ADD A~ADD C to be read and latched for use as an internal address.
REF(+)	Reference voltage(+)	Input	This is one of the input terminals for the reference voltage that is applied to the 256R resistor ladder circuit. The other terminal is REF(-) and the voltage levels of these two inputs must meet the condition: REF(+)>REF(-).
REF(-)	Reference voltage(-)	Input	This is one of the input terminals for the reference voltage that is applied to the 256R resistor ladder circuit. The other terminal is REF(+), and the voltage levels of these two inputs must meet the condition: REF(+)>REF(-).
OE	Output enable signal	Input	The signal at this pin controls the digital output. When the signal is low-level, pins 2 <sup>-1</sup> ~2 <sup>-8</sup> are in a floating state. When it is high-level, the data is output.
2 <sup>-1</sup> } 2 <sup>-8</sup>	Digital signal	Output	The analog signal, which was input through IN <sub>0</sub> ~IN <sub>7</sub> , is converted to digital data and is output from these terminals. When OE is low-level, these terminals are floating. When OE is high-level, the converted digital data is output. The MSB is 2 <sup>-1</sup> and the LSB is 2 <sup>-8</sup> .
EOC	End of conversion signal	Output	This terminal is used to indicate the completion of an analog to digital conversion. It is reset by a START signal (high-level to low-level) and is set on completion of the conversion (low-level to high-level). This output is normally used to generate an interrupt request for the CPU.
START	Start conversion signal	Input	The input signal at this terminal is used to start a conversion cycle by setting the successive approximation register. The successive approximation register is reset by rising from low-level to high-level and conversion is started after being set by falling from high-level to low-level.
CLK	Clock input	Input	The signal at this terminal is the basic clocking signal used to determine internal timing.

**8-BIT 8-CHANNEL A-D CONVERTER**

**Basic Function Blocks**  
**8-channel Multiplexer**

The M58990P has eight input pins ( $IN_0 \sim IN_7$ ) used for entering analog signals. When analog signals are present at  $IN_0 \sim IN_7$ , the 8-channel multiplexer selects one of those signals and converts it into a digital signal.

The address decoder contains an input latch circuit which functions to hold the input signal present at pins ADD A ~ ADD C. This circuit is illustrated in Fig. 1, while timing of the address latch is shown in Fig. 2.

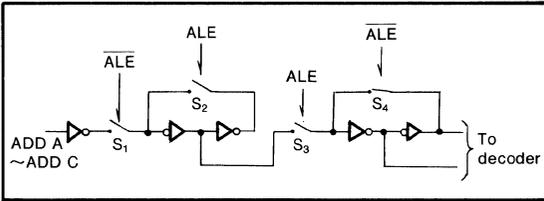


Fig.1 Address latch circuit

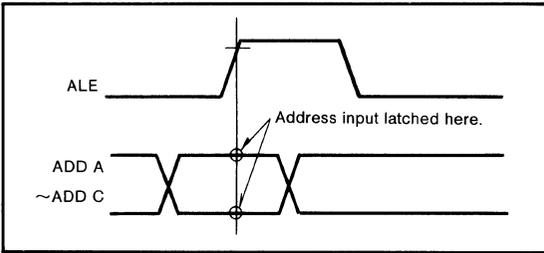


Fig.2 Address latch timing

When the ALE signal is "L",  $S_1$  and  $S_4$  (Fig. 1) are closed, and  $S_2$  and  $S_3$  are open. At this time, external input is inhibited at  $S_3$ , and the previous data is sent to the decoder. When ALE transits from "L" to "H",  $S_1$  and  $S_4$  open, and  $S_2$  and  $S_3$  close. This simultaneously latches the address data, and enables output to the decoder. At this point, the new data arriving at ADD A ~ ADD C is blocked at  $S_1$ . Subsequent transition of ALE from "H" to "L" does not produce a change; the latched data remains held.

The method for determining selection of the analog input at  $IN_0 \sim IN_7$  is by reading the value of the latched address signal. Value allocations are shown in Table 1.

**Table 1 Address signals as related to selected analog signal pin**

ADD C	ADD B	ADD A	Analog input
0	0	0	$IN_0$
0	0	1	$IN_1$
0	1	0	$IN_2$
0	1	1	$IN_3$
1	0	0	$IN_4$
1	0	1	$IN_5$
1	1	0	$IN_6$
1	1	1	$IN_7$

**256R Ladder Network And Switch Tree**

Fig. 3 shows the 256R resistor ladder and switch tree circuit. The 256R ladder network is created in the diffusion process by forming 256 individual resistors into the substrate. 254 of these resistors have the same value  $R$ , while the resistor on each end of the ladder carries the value  $3/2R$  and  $1/2R$  respectively. The reference voltage source is applied to both ends of the ladder, and the reference voltage used to compare analog input voltages is output at each of the steps.

The reason for using different resistance values on the ends of the ladder network is illustrated in Fig. 9 (a) showing the I/O characteristics of the A-D converter. The different resistance values provide symmetry between the zero point and full scale point in the output characteristics transfer curve. As noted in this diagram, the width of the horizontal axis of each step is determined by the potential difference created by each ladder resistor. The step widths for the zero and full scale points are respectively  $1/2$  and

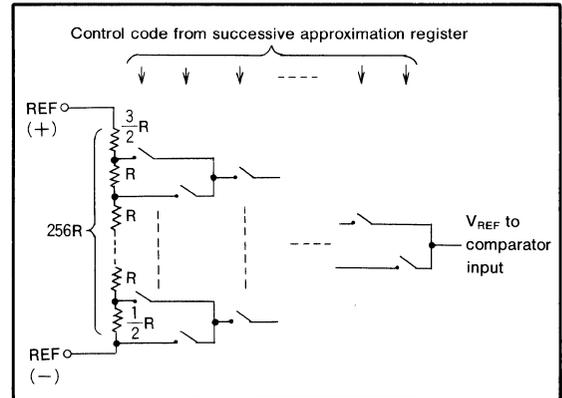


Fig.3 256R ladder network and switch tree

$3/2$ -times that of the intermediate steps.

The switch tree is an analog switch network made up of 510 MOSFETs, and is used to output the ladder step voltage selected by successive approximation register (S.A.R.) code to the comparator. The output voltage obtained from the 256R ladder and switch tree is increased or decreased in accordance with the S. A. R. code, with the monotonicity of the 256R ladder.

**8-BIT 8-CHANNEL A-D CONVERTER**

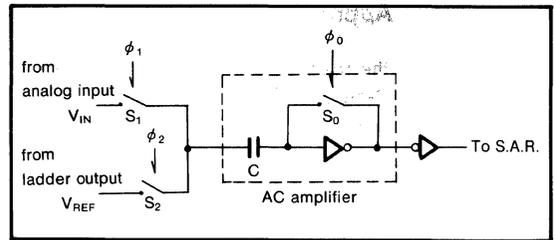
**Comparator**

The comparator used in M58990P has a chopper type amplifier used to minimize input offset voltage and drift. This circuit is illustrated in Fig. 4. Fig. 6 shows the operational timing of the comparator.

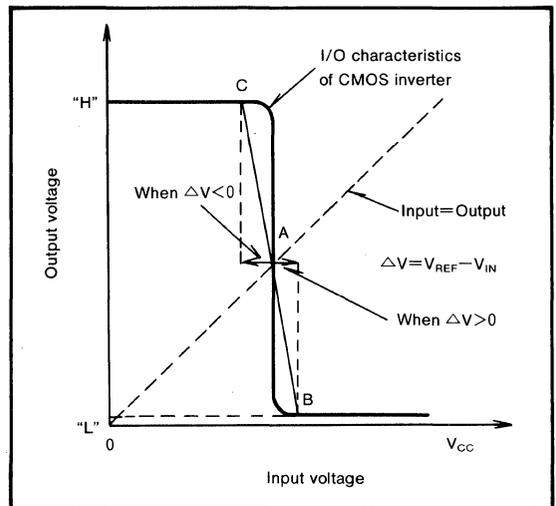
At the start of the comparing cycle,  $S_0$  and  $S_1$  close on the positive edge of  $\phi_0$  and  $\phi_1$ . Analog input voltage  $V_{IN}$  is then sent to the comparator. At the same time, the input of the AC amplifier is biased at point A shown in the I/O characteristics curve of Fig. 6.

When  $S_0$  and  $S_1$  open,  $S_2$  closes on the positive edge of  $\phi_2$ , and the difference voltage  $\Delta V$  derived from comparing analog input voltage  $V_{IN}$  and reference voltage  $V_{REF}$  from the ladder appears at AC amplifier input. Amplification of this difference voltage causes a voltage saturated at "H" or "L" level to appear at output. (This is shown as point B or C in Fig. 5.)

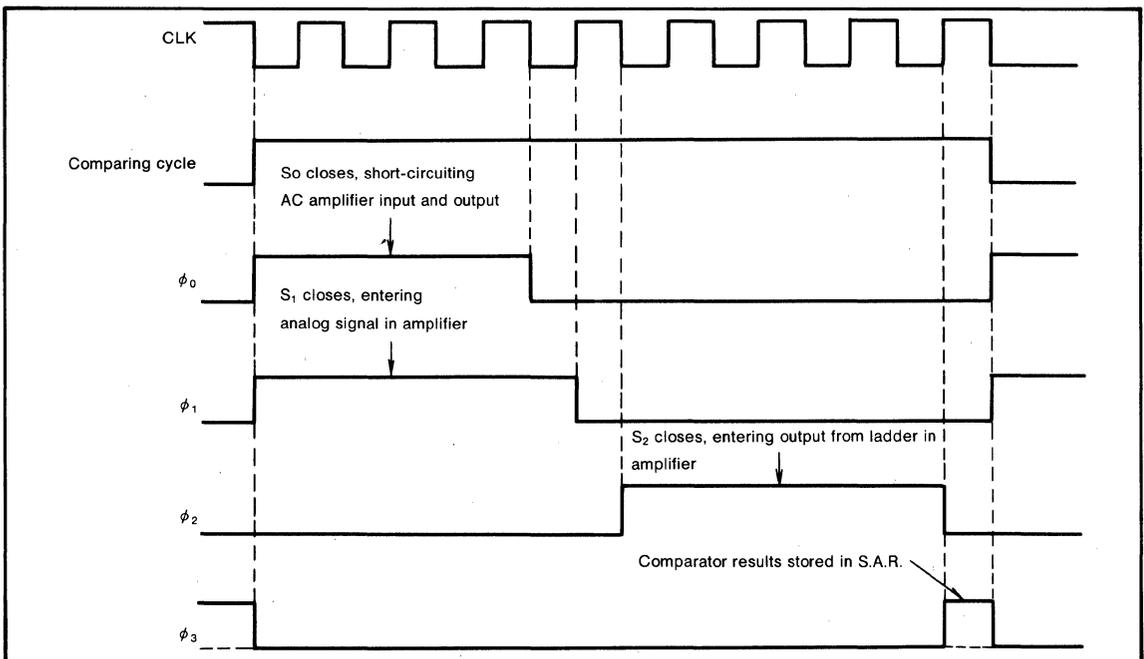
Offset and drift are blocked by the AC amplifier. The comparator results are stored in the successive approximation register at the end of the comparing cycle.



**Fig.4 Comparator**



**Fig.5 AC amplifier I/O characteristics**



**Fig.6 Comparing cycle timing**

8-BIT 8-CHANNEL A-D CONVERTER

Successive Approximation Register (S.A.R.)

The S.A.R. takes the results from the comparator and converts them to an 8-bit binary code for use in determining the reference voltage value that should be used in the next input comparison. The relationship between reference voltage  $V_{REF}$  and the binary code is as follows:

$$V_{REF} = (2^7 C_7 + 2^6 C_6 + \dots + 2^0 C_0) \times \frac{V_{FSR}}{256} + REF(-) - \frac{V_{FSR}}{512} \dots(1)$$

Where  $C_7 + C_6 + \dots + C_0 \neq 0$ .

When  $C_7 = C_6 = \dots = C_0 = 0$ ,  $V_{REF} = REF(-)$

Here,  $V_{FSR}$  stands for full scale range of analog voltage, which indicates the range between minimum and maximum value, or

$$V_{FSR} = REF(+)-REF(-) \dots(2)$$

$C_7, C_6 \dots C_0$  are each represented by a 0 or 1 digit in the binary code, with  $C_7$  the MSB and  $C_0$  the LSB. Consequently, from equation (1), we have:

$$V_{REF} = \left(\frac{1}{2} C_7 + \frac{1}{2^2} C_6 + \dots + \frac{1}{2^8} C_0\right) \times V_{FSR} + REF(-) - \frac{V_{FSR}}{512} \dots(3)$$

When each digit (bit) in the right half of equation (3) is weighted from  $1/2$  to  $1/2^8$ , the value relative to full scale can be obtained. With the successive comparator method, successive approximations are made from MSB to LSB until reference voltage  $V_{REF}$  is as close to  $V_{IN}$  as it can get. The following explanation provides more specifics.

When the start pulse entered at the START pin transitions from "L" to "H", the S.A.R. sets only the MSB "1", the other bits being reset to "0". As a result, the voltage selected for reference voltage  $V_{REF}$  is approximately one-half of  $V_{FSR}$ , and this is used to compare with analog input  $V_{IN}$ .

The conversion is started when the start pulse transition from "H" to "L", and the first comparing cycle is entered. At this time, should  $V_{IN}$  be smaller than  $V_{REF}$ , MSB will be reset to "0". If larger, the MSB will remain "1" and the next comparing cycle will be entered. For this cycle, the bit next to MSB,  $C_6$  will be set, and the previous results will be carried up. In other words, taking the next selected reference voltage as  $V_{REF}$ , when

$V_{IN} > V_{REF}$ , then:

$$V_{REF}' = \left(\frac{1}{2} + \frac{1}{4}\right) V_{FSR} - \frac{V_{FSR}}{512} + REF(-)$$

5

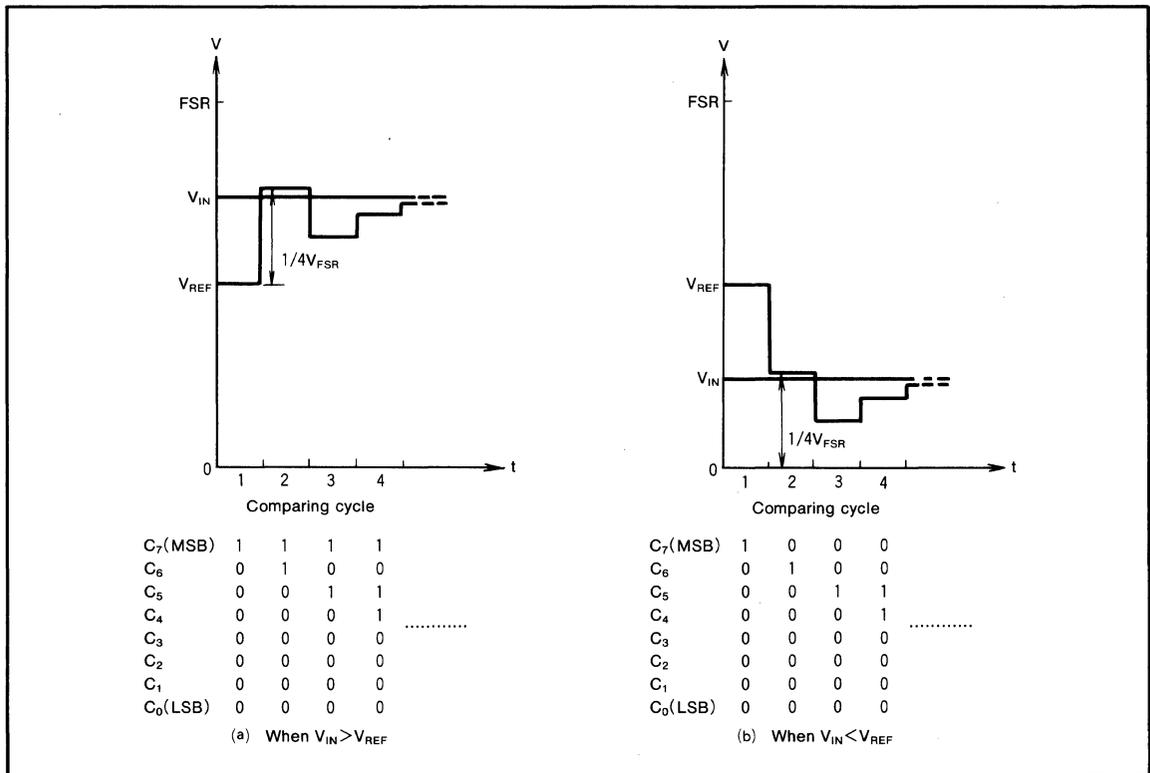


Fig.7 Changing reference voltage during A-D conversion

8-BIT 8-CHANNEL A-D CONVERTER

And when  $V_{IN} < V_{REF}$ ,

$$V_{REF} = \frac{1}{4} V_{FSR} = \frac{V_{FSR}}{512} \text{ REF (-)}$$

In the second comparing cycle,  $V_{IN}$  is compared with  $V_{REF}$ , and the results for  $C_6$  are obtained. From there, the comparator cycles are repeated until the value for  $C_0$  is obtained. This process is illustrated in Fig. 7.

There are eight comparing cycles for each conversion cycle, and one comparing cycle requires eight clocks. This means that each conversion cycle requires 64 clocks, and since clock frequency is 640kHz, each conversion cycle requires 100μs. (Note 1)

When the comparison has been made, results are latched in the output circuit, and the EOC signal is sent. The EOC signal is reset to "L" by the start pulse, then set "H" when the conversion is completed.

The EOC signal has interrupt capability with regards to the CPU, and can be tied to the start pulse for continuous conversion.

If a new start signal is entered during conversion, the S.A.R. is reset and starts over from that point.

Note 1 : Conversion time  $t_c$ , a characteristic value that will be converted later, is defined as the time between the positive edge of the start pulse and the positive edge of EOC. Consequently,  $t_c$  is a combination value of conversion cycle time, EOC delay time (1 to 8 clocks), and latch cycle time applied to the output circuit (1 clock).

EOC delay time is determined by the state of the internal circuitry and start pulse timing. Consequently, if continuous conversions are to be run at a fixed conversion time, the start pulse must be applied synchronized with the positive edge of EOC.

**Output Circuit**

As illustrated in Fig. 8, the output circuit consists of a D latch and a 3-state buffer. At the end of a conversion cycle, the converted data is latched in the D latch. Then when OE transits "H", the latched data is output to pins  $2^{-1} \sim 2^{-8}$ . When OE is "L", pins  $2^{-1} \sim 2^{-8}$  are in a floating state. During the conversion cycle, the previous data is held in the D latch.

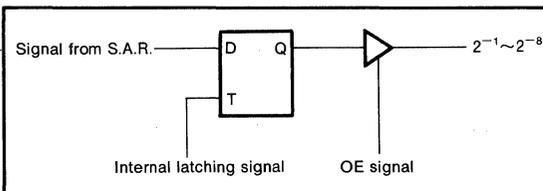


Fig.8 Output circuit

**Errors And Accuracy Of The A-D Converter Resolution**

The analog input voltage range over which conversion operations are possible is referred to as the full scale range (FSR), and resolution defines the number of "steps" that FSR can be broken down into. In general, n-bits of resolution indicates that FSR can be resolved into  $1/2^n$  steps. Also, resolution can be arrived at by taking FSR divided by  $2^n$  as the size of the LSB.

Consequently, for 8-bits, FSR is divided into 256 steps, and if FSR is referenced to 5.12V, then the LSB will be 20mV.

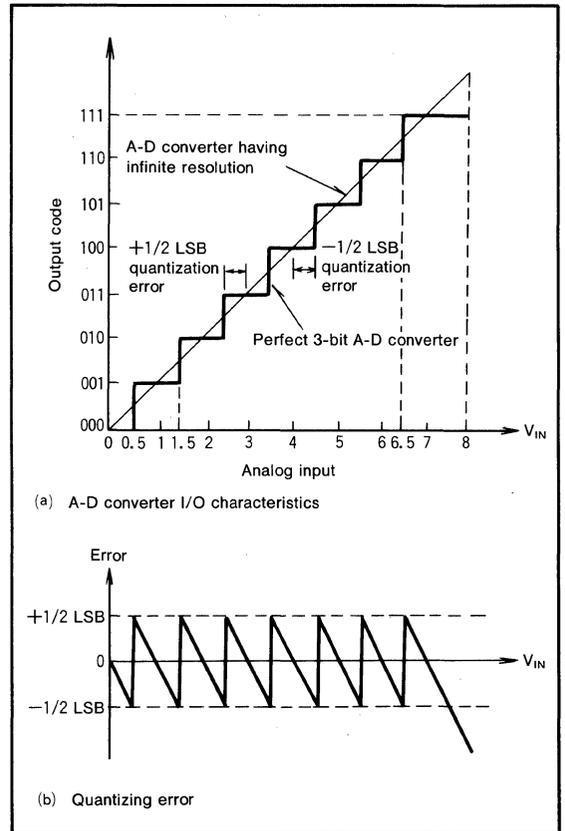


Fig.9 A-D converter I/O characteristics and quantizing errors

**Quantizing Error**

An inherent error in the A-D conversion process develops due to the fact that analog input values of less than the LSB must be rounded off. Figure 9 shows the quantizing errors occurring in a 3-bit A-D converter. The I/O characteristics of a perfect 3-bit A-D converter are illustrated in Fig. 9 (a). Where FSR is 8 and LSB is 1, as shown in the diagram, analog input voltage  $V_{IN}$  is rounded off to n in the range of

$$n - \frac{1}{2} \text{ LSB} \leq V_{IN} < n + \frac{1}{2} \text{ LSB} \quad (0 < n \leq 7).$$

8-BIT 8-CHANNEL A-D CONVERTER

In this case, a quantization error of  $\pm 1/2$  LSB is produced on one of the two ends of the step.

Fig. 9 (b) shows how quantization errors are produced. Each step is shown like the tooth of a saw, centered on 0. An input of full scale becomes  $-1$  LSB. This is because output codes can only be produced up to  $111_2 = 7_{10}$ , so when using the converter near full scale should be took care. In order to reduce quantization errors, resolution must be increased.

**Non-linearity Errors**

Non-linearity error is the portion of A-D converter I/O characteristics that indicate the amount of deviation from the ideal line. These errors can be expressed as total linearity, or for only a portion of the scale, as differential nonlinearity. This is shown in Fig. 10.

Linearity indicates the amount of deviation from a straight line drawn from the start to the end of a step. Differential linearity indicates the amount that an actual step differs from 1 LSB of perfect step width. Monotonicity is the term used to express the fact that rises and falls in output follow rises and falls in input, and monotonicity cannot be assured unless differential nonlinearity is less than  $1/2$  LSB.

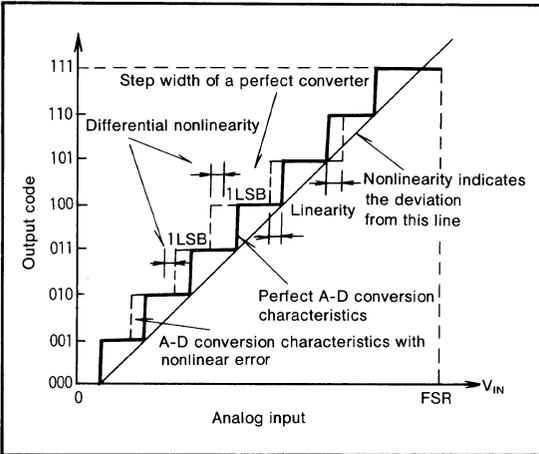


Fig.10 Nonlinearity in A-D conversion characteristics

**Zero Error And Full Scale Error**

Zero error is the error relative to the input voltage required to bring the output code to all 0s, and full scale error is the error relative to the input voltage required to bring the output code to all 1s. These errors are expressed as the amount of deviation from the perfect A-D conversion curve, and are illustrated in Fig. 11.

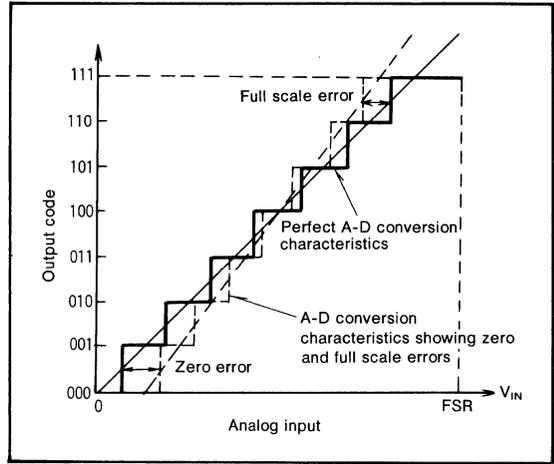


Fig.11 Zero and full scale error

**Absolute Accuracy**

Absolute accuracy accounts for the various errors occurring in the A-D conversion, and indicate how closely the output code represents the analog input. Where the output code is  $N$ ,

$$\text{absolute accuracy} = N - \frac{V_{IN}}{\text{LSB}}$$

This is shown in Fig. 12.

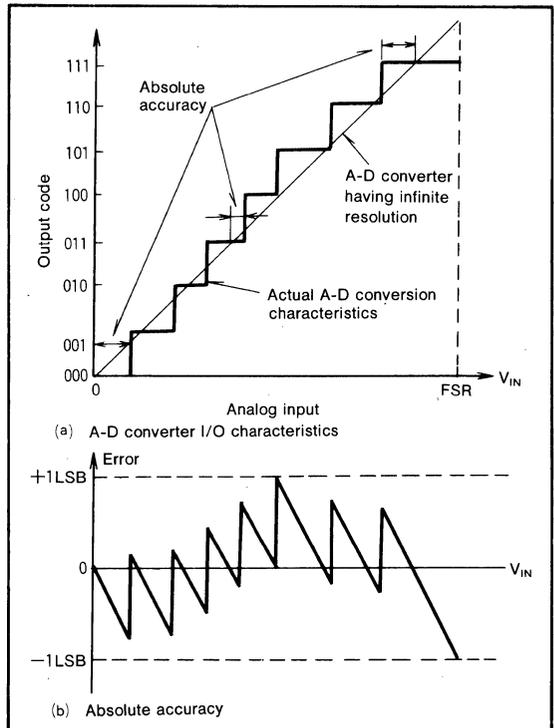


Fig.12 A-D converter absolute accuracy

5

**8-BIT 8-CHANNEL A-D CONVERTER**

**Precautions Regarding Reference Voltage Power Supplies**

Fig. 13 shows a portion of the 256R ladder network and switch tree, and Fig. 14 illustrates the turn-on resistance characteristics for MOSFETs.

As Fig. 14 shows, where drain potential  $V_D$  approaches  $V_{CC}$ , the turn-on resistance of n-channel MOSFETs increases. On the other hand, when  $V_D$  approaches GND, turn-on resistance for p-channel MOSFETs increases.

Where threshold voltage for the two transistor types is taken as  $V_{thN}$  and  $V_{thP}$  respectively, when  $V_D$  is between GND and  $V_{thN}$ , p-channel MOSFETs will not turn on, and when  $V_D$  is in the range  $V_{CC} - V_{thP} \sim V_{CC}$ , n-channel MOSFETs will not turn on. Due to this fact, the border formed by  $(REF(+)+REF(-))/2$  in the switch tree of Fig. 13 is an operating limit for MOSFETs. Above this line, p-channel devices are used, and below this line n-channel devices are used.

For ladder network and switch tree structures like this, the following precautions should be observed in the design of the reference voltage supply.

1. REF (+) potential must not exceed  $V_{CC}$ .
2. REF (-) potential must not go below GND.
3. The value for  $(REF(+)+REF(-))/2$  must not differ greatly from the value of  $V_{CC}/2$ .
4.  $REF(+)>REF(-)$  must be observed.

The reason for 1 and 2 is that for MOS switches located near the  $V_{REF}$  pin, their sources and substrate PN junctions are likely to forward bias, with the resulting current flow changing ladder potentials.

In 3,  $(REF(+)+REF(-))/2$  is the potential for the center of the ladder, and as shown in Fig. 13, this is the borderline between p-channel and n-channel switch operations. Consequently, if this potential varies greatly from  $V_{CC}/2$ , turn-on resistance of the n-channel switches near the center of the ladder will increase. (See Fig. 14.) On the other hand, if this value is smaller than  $V_{CC}/2$ , the turn-on resistance of the p-channel switches will increase.

Where turn-on resistance is high, the required settling time after fully charging the comparator's input capacitor becomes too long, and accuracy cannot be maintained.

In 4, if  $REF(+)<REF(-)$ , the up-down transients of the control signals from the S.A.R. will be reversed relative to the up-down transients of the reference voltage from ladder to comparator. In this case, instead of the approximations converging, the bits will diverge all 0s or all 1s. Also, as noted previously, where  $REF(+)$  and  $REF(-)$  approach GND and  $V_{CC}$  respectively, the switches will not turn on.

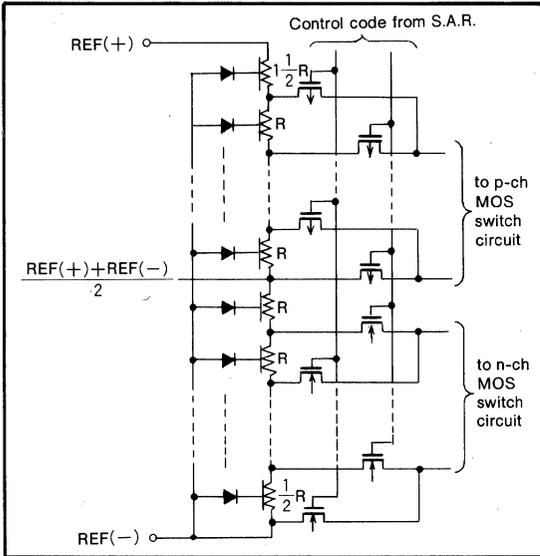


Fig.13 256R ladder network and switch tree

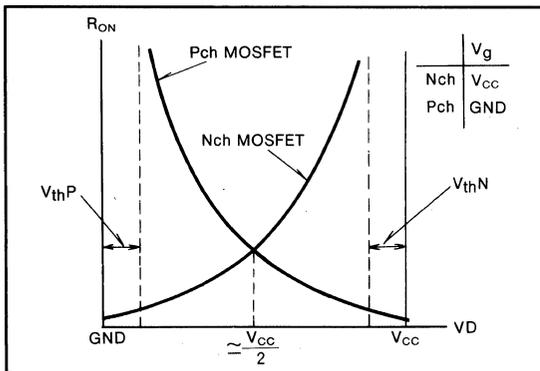


Fig.14 MOS switch turn-on resistance

8-BIT 8-CHANNEL A-D CONVERTER

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage	With respect to GND	-0.3~7	V
$V_I$	Input voltage		-0.3~ $V_{CC}+0.3$	V
$V_O$	Output voltage		0~ $V_{CC}$	V
$P_d$	Maximum power dissipation	$T_a=25^\circ\text{C}$	500	mW
$T_{opr}$	Operating free-air temperature range		0~70	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		-65~150	$^\circ\text{C}$

RECOMMENDED OPERATING CONDITIONS ( $T_a=0\sim 70^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.75	5	5.25	V
GND	Supply voltage		0		V
$V_{IH}$	High-level input voltage	2		$V_{CC}$	V
$V_{IL}$	Low-level input voltage	-0.3		0.8	V
$V_{REF(+)}$	Max of reference voltage(+)		$V_{CC}$	$V_{CC}+0.1$	V
$V_{REF(-)}$	Min of reference voltage(-)	-0.1	0		V
$\frac{V_{REF(+)}+V_{REF(-)}}{2}$		$\frac{V_{CC}}{2}-0.1$	$\frac{V_{CC}}{2}$	$\frac{V_{CC}}{2}+0.1$	V
$\Delta V_{REF}$	Differential of reference voltage		5.12	5.25	V
$V_{I(IN)}$	Analog input voltage	0		$V_{REF(+)}$	V

5

ELECTRICAL CHARACTERISTICS ( $T_a=0\sim 70^\circ\text{C}$ ,  $V_{CC}=5\text{V} \pm 5\%$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit	
				Min	Typ	Max		
$V_{IH}$	High-level input voltage	$V_{IN(1)}$	$V_{CC}=5\text{V}$	2			V	
$V_{IL}$	Low-level input voltage	$V_{IN(0)}$				0.8	V	
$V_{OH}$	High-level output voltage	$V_{OUT(1)}$	$I_{OH}=-360\mu\text{A}$ , $T_a=70^\circ\text{C}$	$V_{CC}-0.4$			V	
$V_{OL}$	Low-level output voltage, 2 <sup>-1</sup> ~2 <sup>-8</sup> output	$V_{OUT(0)}$	$I_{OL}=1.6\text{mA}$			0.45	V	
$V_{OL(EOC)}$	Low-level output voltage, EOC output	$V_{OUT(0)}$	$I_{OL}=1.2\text{mA}$			0.45	V	
$I_{IH}$	High-level input current	$I_{IN(1)}$	$V_{IH}=5.25\text{V}$			1.0	$\mu\text{A}$	
$I_{IL}$	Low-level input current	$I_{IN(0)}$	$V_{IL}=0\text{V}$			-1.0	$\mu\text{A}$	
$I_{OZH}$	Off-state (high-impedance state) output current, 2 <sup>-1</sup> ~2 <sup>-8</sup> output	$I_{OUT}$	$V_O=5\text{V}$			3	$\mu\text{A}$	
$I_{OZL}$	Off state (high-impedance state) output current, 2 <sup>-1</sup> ~2 <sup>-8</sup> output	$I_{OUT}$	$V_O=0\text{V}$			-3	$\mu\text{A}$	
$I_{CC}$	Supply current from $V_{CC}$ input		$f_{C(\phi)}=500\text{kHz}$ , $T_a=70^\circ\text{C}$			1000	$\mu\text{A}$	
$I_{IZ}$	Off-state input current, (IN <sub>0</sub> ~IN <sub>7</sub> input)	$I_{OFF(+)}$	$V_{CC}=5\text{V}$ , $V_I=5\text{V}$			200	nA	
$I_{IZ}$	Off-state input current, (IN <sub>0</sub> ~IN <sub>7</sub> input)	$I_{OFF(-)}$	$V_{CC}=5\text{V}$ , $V_I=0\text{V}$			-200	nA	
	Conversion resolution			8			Bits	
	Linearity error	M58990P	$V_{CC}=V_{REF(+)}=5.12\text{V}$ $V_{REF(-)}=\text{GND}$		$\pm \frac{1}{4}$	$\pm \frac{1}{2}$	LSB	
		M58990P-1			$\pm \frac{1}{2}$	$\pm 1$	LSB	
	Zero error				$\pm \frac{1}{4}$	$\pm \frac{1}{2}$	LSB	
	Full-scale error				$\pm \frac{1}{4}$	$\pm \frac{1}{2}$	LSB	
	Absolute accuracy	M58990P					$\pm 1$	LSB
		M58990P-1					$\pm 1 \frac{1}{2}$	LSB
$R_{LADDER}$	Ladder resistances			$V_{CC}=5\text{V}$	1			k $\Omega$
$C_I$	Input capacitance	$C_{IN}$		$V_I=\text{GND}$ , $V_O=25\text{mVrms}$ , $f=1\text{MHz}$			8	pF
$C_O$	Output capacitance	$C_{OUT}$		$V_O=\text{GND}$ , $V_I=25\text{mVrms}$ , $f=1\text{MHz}$			12	pF

Note 1 : Current flowing into an IC is positive, and Min and Max show the absolute limit.

**8-BIT 8-CHANNEL A-D CONVERTER**

**TIMING REQUIREMENTS** ( $T_a=25^{\circ}\text{C}$ ,  $V_{CC}=V_{REF(+)}=5\text{V}$ ,  $V_{REF(-)}=\text{GND}$  unless otherwise noted)

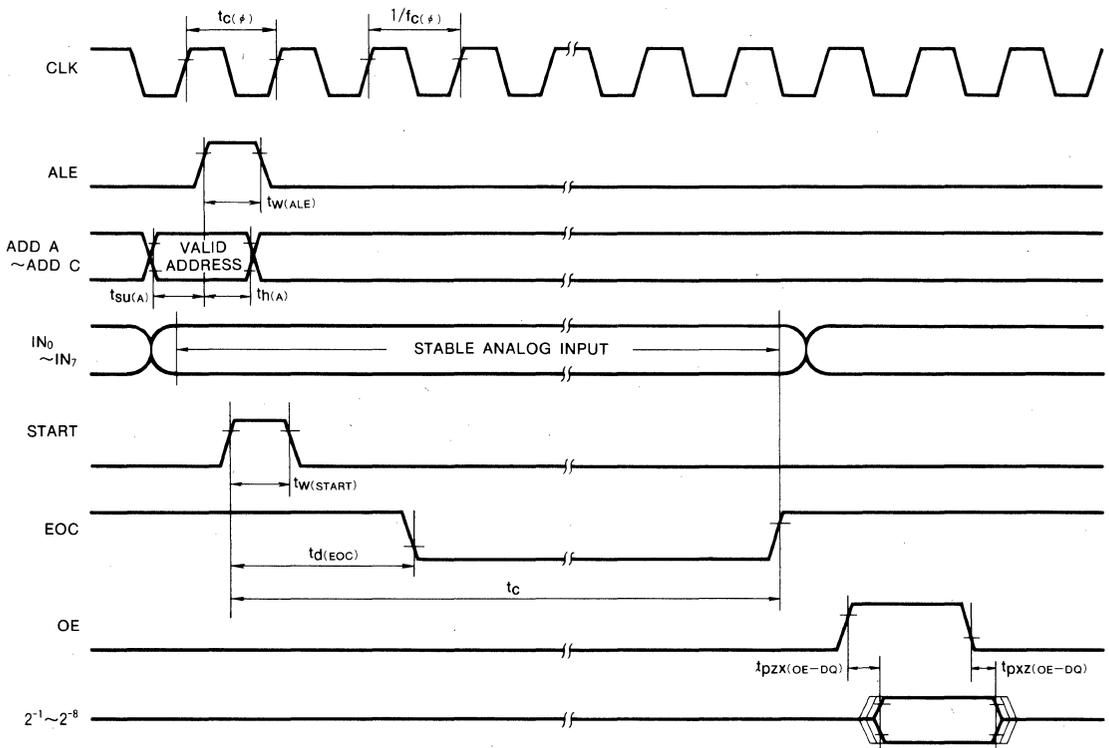
Symbol	Parameter	Alternative Symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{W(\text{START})}$	Start pulse width	$t_{ws}$		200			ns
$t_{W(\text{ALE})}$	ALE pulse width	$t_{wALE}$		200			ns
$t_{SU(A)}$	Address setup time	$t_s$		50			ns
$t_{H(A)}$	Address hold time	$t_H$		50			ns
$f_{C(\phi)}$	Clock frequency	$f_c$		10	640	1200	$\text{kHz}$
$t_{C(\phi)}$	Clock cycle	—		100	1.56	0.83	$\mu\text{s}$

Note 2 : Input voltage level is  $V_{IL}=0.8\text{V}$ ,  $V_{IH}=2\text{V}$

**SWITCHING CHARACTERISTICS** ( $T_a=25^{\circ}\text{C}$ ,  $V_{CC}=V_{REF(+)}=5\text{V}$ ,  $V_{REF(-)}=\text{GND}$ , unless otherwise noted)

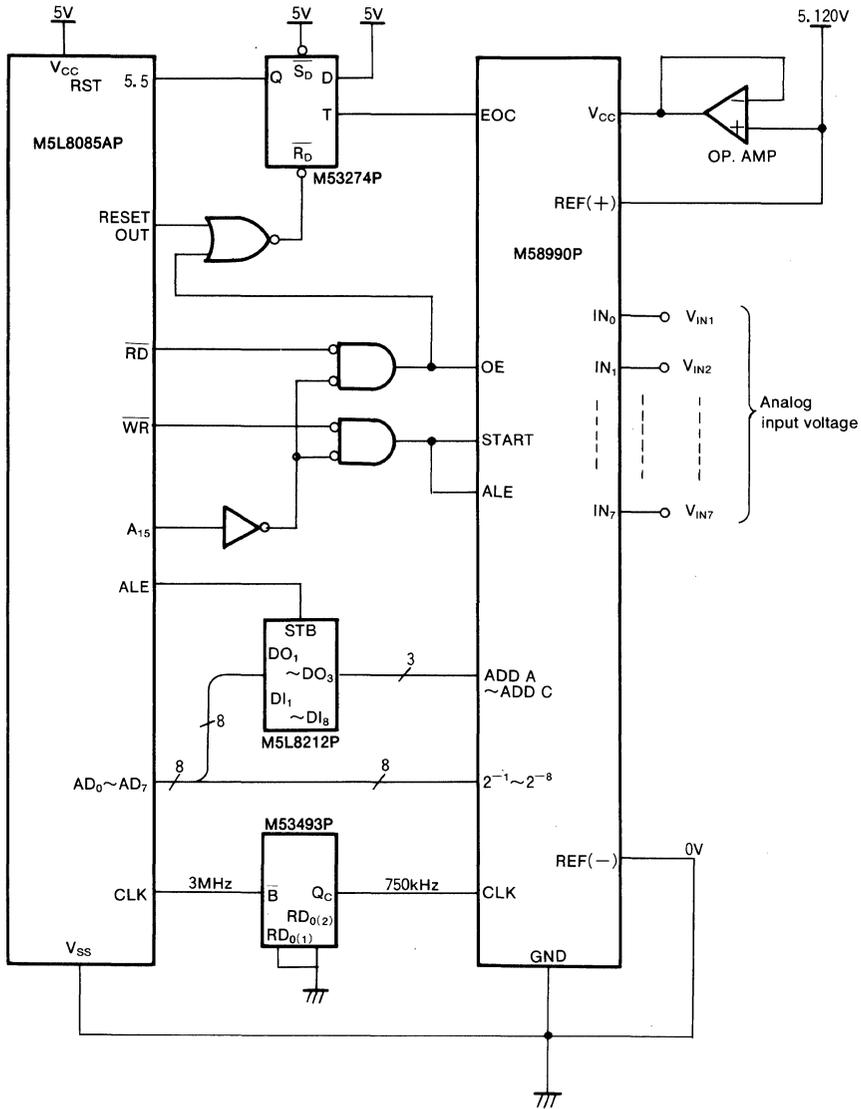
Symbol	Parameter	Alternative Symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{PZ(\text{OE-DQ})}$	Propagation time from OE to output	$t_{Hl}$ , $t_{HO}$	$C_L=50\text{pF}$			250	ns
$t_{PZ(\text{OE-DQ})}$	Propagation time from OE to output floating	$t_{Hl}$ , $t_{OH}$				250	ns
$t_C$	Cycle time	$t_c$	$f_{C(\phi)}=640\text{kHz}$			114	ns
$t_{D(\text{EOC})}$	EOC delay time	$t_{EOC}$		1		8	Clock cycle time

**TIMING DIAGRAM**



**8-BIT 8-CHANNEL A-D CONVERTER**

**APPLICATION EXAMPLE**



**5**

**PRELIMINARY**  
 Notice: This is not a final specification. Some  
 parametric limits are subject to change.

MITSUBISHI LSIs

# M5M82C37AP, -4, -5

## CMOS PROGRAMMABLE DMA CONTROLLER

### DESCRIPTION

The M5M82C37AP is a programmable 4-channel DMA (Direct Memory Access) controller. This device is specially designed to simplify data transfer at high transfer rate for microcomputer systems.

Fabricated using the silicon-gate CMOS technology, the M5M82C37AP operates using a single 5V power supply.

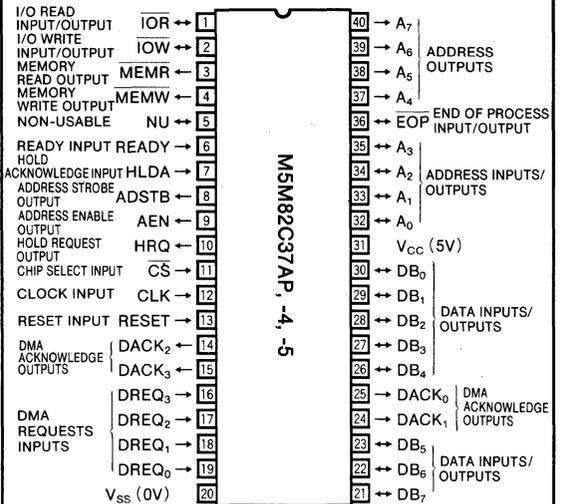
### FEATURES

- 5V single supply, single TTL clock
- Four channel DMA controls with priority DMA request acknowledge functions
- DMA enable/disable, automatic initialization enable/disable, address increment/decrement programmability for each channel
- Programmable DREQ input and DACK output logic polarity
- Direct connecting permits easy DMA channel expansion.
- Memory to memory data transfer
- EOP input/output permits DMA operation completion check as well as forcibly completing DMA operation.

### APPLICATION

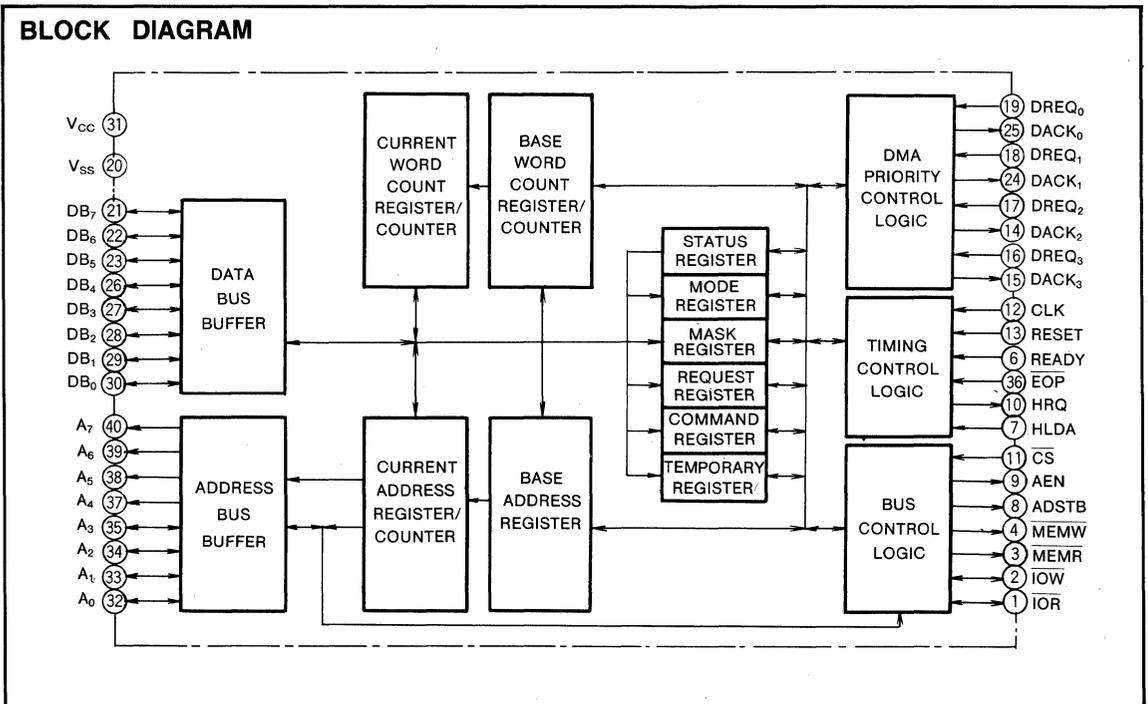
- DMA control of peripheral equipment such as floppy diskettes and CRT terminals that require high-speed data transfer.

### PIN CONFIGURATION (TOP VIEW)



Outline 40P4

### BLOCK DIAGRAM



## FUNCTION

M5M82C37AP is a programmable DMA controller LSI used in microprocessor systems.

This device basically consists of a DMA request control block for acknowledging DMA requests, a CPU interface for exchanging data and commands with the CPU, a timing control circuit for controlling each of the various types of timing, and a register for holding and counting DMA addresses and number of transfer words.

After setting the transfer mode, starting address, and byte number in each of the registers and when a DMA request is made to an unmasked channel, the M5M82C37AP requires use of the bus to the CPU. When the HLDA signal is received from the CPU, the DMA acknowledge signal is sent to DMA requesting channel with the highest priority and begins DMA operation.

During DMA operation, the contents of the low-byte of the transfer memory address are output through  $A_7 \sim A_0$ . Every time a change in the high-order 8-bit values is necessitated immediately after DMA operation has begun or due to borrowing or decrement during DMA operation, the change is output via pins  $DB_7 \sim DB_0$  to the externally mounted latch circuit. After the address is transmitted, read and write signals are sent to the memories and peripherals activating DMA transfer.

## PIN DESCRIPTION

### IOR input/output (I/O read input/output)

The function of this pin differs depending on the state of the M5M82C37AP.

During DMA operation, the  $\overline{\text{IOR}}$  outputs low-level pulses providing read timing to the peripheral devices.

In the cascade mode DMA, this pin becomes high impedance. In non-DMA mode,  $\overline{\text{IOR}}$  is an input to read the contents of the registers in the M5M82C37AP.

### IOW input/output (I/O write input/output)

The function of this pin differs depending on the state of the M5M82C37AP. In DMA operation, IOW outputs a low-level pulse to denote the write timing to peripheral devices.

In cascade mode DMA, this pin becomes high impedance. In non-DMA mode,  $\overline{\text{IOW}}$  is input to write data to the registers of the M5M82C37AP.

### MEMR output (Memory read output)

In DMA mode, this pin outputs a low-level pulse to denote the memory read timing.

In cascade mode DMA or in non-DMA operation this pin becomes high impedance.

### MEMW output (memory write output)

In DAM mode, this pin outputs a low-level pulse to denote the memory write timing.

In cascade mode DMA or in non-DMA operation, this pin becomes high impedance.

### NU pin (Non-usable)

Pin 5 is a non-usable pin. This pin should be tied to  $V_{CC}$ , or it should be left open.

### READY input (ready input)

This input is used to extend the read or write pulse in the DMA operation. As long as low-level is input, the DMA transfer period is extended. If no timing extension is needed, this input should be tied to  $V_{CC}$ .

Note : The ready input level must be stable near the falling edge of the clock input. If the minimum READY setup time from clock or the minimum READY hold time after clock is violated, M5M82C37AP might go into illegal DMA operations.

### HLDA input (hold acknowledge input)

This input means that the CPU acknowledges the use of the bus. If M5M82C37AP sets the HRQ output high-level and the HLDA input goes to high-level the M5M82C37AP begins DMA operation.

Note : (i) When HLDA is high-level,  $\overline{\text{CS}}$  input is disabled and unexpected read or write operation to M5M82C37AP is prevented.

(ii) At least 1 clock period is required from HRQ rising edge to HLDA rising edge

### **ADSTB output (address strobe output)**

This pin outputs a high-level pulse when the higher 8 bits of the transfer address is output through data bus at the DMA operation. This pulse is used as the strobe pulse for the external address latch circuit.

In non-DMA mode or in cascade mode DMA this output remains low-level.

### **AEN output (address enable output)**

AEN is an output which denotes that the bus control signal address output etc. from the M5M82C37AP are valid. When AEN output is high-level, they are valid output, so AEN is used as a control input for an external three-state bus buffer.

### **HRQ output (hold request output)**

This output denotes that the M5M82C37AP requests the use of the bus to the CPU. The M5M82C37AP sets HRQ high in response to the DMA request.

### **$\overline{CS}$ input (chip select input)**

This input is a chip select signal which is set to low-level when the CPU reads or writes data to the M5M82C37AP. When HLDA is high-level, this input is masked and the M5M82C37AP is not selected.

### **CLK input (clock input)**

The master clock for the M5M82C37AP is input.

### **RESET input (reset input)**

When a high-level pulse is input from RESET, the M5M82C37AP is set to the initial state.

### **DACK0, DACK1, DACK2, DACK3 output (DMA acknowledge output)**

DMA acknowledge is the signals which shows a peripheral device whether DMA operation for its channel is under execution.

By resetting, they become active low outputs, but they can be made into high-active outputs by altering the contents of the command register.

### **DREQ0, DREQ1, DREQ2, DREQ3**

DREQ is an input which shows that a peripheral device requests DMA service. By resetting, they become active high inputs but they can be made into active low inputs by altering the contents of the command register. DREQ should keep in active until the DACK output returns.

### **$V_{SS}$**

$V_{SS}$  is connected to system ground.

### **$DB_7 \sim DB_0$ inputs/outputs (data bus inputs/outputs)**

In non-DMA mode, the contents of the registers of the M5M82C37AP are read out or written through  $DB_7 \sim DB_0$ .

In DMA mode, the higher 8 bits of the transfer address are output through  $DB_7 \sim DB_0$  in the  $S_1$  state. In the memory to memory DMA mode, data to be transferred between memories via the temporary register are read and written by the M5M82C37AP through  $DB_7 \sim DB_0$ .

### **$V_{CC}$**

The 5V power supply is connected through  $V_{CC}$ .

### **$A_7 \sim A_0$ input/output (address input/output)**

In the DMA mode, the lower 8 bits of the transfer address are output through  $A_7 \sim A_0$ .

In cascade mode DMA, they become high impedance. In the non-DMA mode,  $A_3 \sim A_0$  become register select address inputs, while  $A_7 \sim A_4$  become high impedance.

### **$\overline{EOP}$ input/output (end of process input/output)**

$\overline{EOP}$  is an N-channel open drain input/output. When the word count register reaches count-up, a low-level pulse is output from  $\overline{EOP}$ . (This is called internal  $\overline{EOP}$ .)  $\overline{EOP}$  may be pulled down to low-level. If  $\overline{EOP}$  is pulled down during DMA operation, the DMA operation is forcibly terminated. (This is called external  $\overline{EOP}$ .)

Note : In cascade mode DMA, the  $\overline{EOP}$  pulse is not output, and external  $\overline{EOP}$  cannot terminate cascade mode DMA operation.

## OPERATION

The unit of operation of the M5M82C37AP is one clock period long and is called a 'state'. The M5M82C37AP has seven kinds of states.

The following is the description of the basic DMA operation. When the M5M82C37AP is DMA disabled or no DMA request comes for unmasked DMA channel, the M5M82C37AP is in stand-by condition. At this time the M5M82C37AP repeats  $S_1$  (Inactive state) until a valid DMA request comes. When the M5M82C37AP is enabled and a valid DMA request arrives, the M5M82C37AP sets HRQ output high and waits until the use of the bus is acknowledged. This state is called so state. The M5M82C37AP repeats  $S_0$  state as long as the HLDA input is low. When HLDA goes to high, the M5M82C37AP begins DMA operation.

Care must be taken because the M5M82C37AP requires at least 1 clock period from the HRQ rising edge to the HLDA rising edge. (I.e.  $S_0$  state must be repeated at least twice.) In DMA operation, the M5M82C37AP normally executes four (or three) states per one word transfer.

These four states are called  $S_1$ ,  $S_2$ ,  $S_3$  and  $S_4$  state in sequence.

In  $S_1$  state, AEN is set to high (if AEN is low), the lower 8 bits of data of the transfer address are output through  $A_7 \sim A_0$  and the higher 8 bits of address data are output through  $DB_7 \sim DB_0$ . The higher address data are output only in the  $S_1$  state, so the strobe pulse for the external address latch circuit is output from ADSTB. The  $S_1$  state is not executed if the higher 8 bits of address data are not changed in demand mode DMA or block mode DMA.

In the  $S_2$  state, MEMR or IOR output is set to low. If the  $S_1$  state is not executed, address outputs  $A_7 \sim A_0$  are changed at the  $S_2$  state also.

In the  $S_3$  state, MEMW or IOW output goes down to low. The  $S_4$  state is the last state of a word transfer. MEMR (or IOR) and IOR (or MEMW) outputs rise up to high. And the contents of the current address register and the current word counter are updated.

If DMA continues in demand mode or block mode, the  $S_1$  or  $S_2$  state follows after the  $S_4$  state.

If not the  $S_1$  state follows after  $S_4$ . (In single mode DMA,  $S_1$  always follows after  $S_4$ .)

When the M5M82C37AP returns to the  $S_1$  state, the HRQ and AEN outputs are reset,  $A_7 \sim A_4$ ,  $DB_7 \sim DB_0$ , MEMR, MEMW are set to high impedance and  $A_3 \sim A_0$ , IOR, IOW are set to inputs.

If the read or write pulse width is not sufficient for the memories or the peripherals, the transfer time can be extended by setting the READY input to low. Until READY goes up to high, wait states ( $S_w$ ) are inserted before  $S_4$  and read, write, and address outputs are hold.

The M5M82C37AP has four type of DMA transfers.

### ● READ TRANSFER

This is the transfer operation from memories to peripheral. Low-level pulses are output from MEMR and IOW, while MEMW, IOR remain high.

### ● WRITE TRANSFER

This is the transfer operation from peripheral to memories. Low-level pulses are output from MEMW and IOR, while MEMR and IOW remain high.

### ● VERIFY TRANSFER

This is the dummy transfer, MEMR, MEMW, IOR and IOW all remain high. (not high impedance). Low-level input to READY is ignored. AEN, ADSTB, DACK and address information are normally output.

### ● MEMORY-TO-MEMORY TRANSFER

This is the transfer from the memory address designated by channel 0 to the memory address designated by channel 1. In this transfer, the channel 0 address and channel 1 address are alternately output. when the channel 0 address is active, the MEMR pulse is output at the same time and the memory data are read and written to the temporary register when the channel 1 address is active, the MEMW pulse is output and the contents of the temporary register are output from the data bus.

Accordingly,  $\phi 1$  byte memory transfer is executed by two operations a read operation which consists of  $S_{11}$ ,  $S_{12}$ ,  $S_{13}$  and  $S_{14}$  states and write operation which consists of  $S_{21}$ ,  $S_{22}$ ,  $S_{23}$  and  $S_{24}$  states).

In memory to memory DMA, The transfer type assignment of ch 0, ch 1 mode register (read, write or verify) is ignored.

**CMOS PROGRAMMABLE DMA CONTROLLER**

**Notes for memory-to-memory transfer**

Observe the following points when programming memory-to-memory DMA.

- The contents of the word count register of channel 0 and 1 must be programmed identically.
- The transfer mode of channel 0 and 1 must be set to the block transfer mode.
- All the mask bits must be set to inhibit external DMA request input. (Memory-to-memory DMA is started by software DMA request to channel 0.)
- In memory-to-memory DMA operation, all the DACK outputs are inactive. (but AEN is set during transfer.)

**PRIORITY**

Two kinds of DMA priority can be programmed for the M5M82C37AP. (Command register bit 4) If plural channels request DMA at the same time, DMA is acknowledged for the channel which has the highest priority. (Table 1)

(1) Fixed Priority (bit 4=0)

The DMA channel which has the highest priority is channel 0. Channel 1 has the second, channel 2 has the third and channel 3 has the lowest priority.

(2) Rotating Priority (bit 4=1)

This priority mode is that the channel which has serviced the DMA request, has the lowest priority at the next DMA operation. (Just after reset the lowest priority channel is channel 3)

For example, just after channel 1 DMA is executed, channel 2 has the highest priority, channel 3 has the second highest, channel 0 has the third and channel 1 has the lowest priority.

**Table 1 DMA priority for the M5M82C37AP**

Priority type	DMA channel serviced	DMA priority for next transfer			
		Highest	2nd	3rd	Lowest
Fixed priority	-----	ch0	ch1	ch2	ch3
Rotating priority	ch0	ch1	ch2	ch3	ch0
	ch1	ch2	ch3	ch0	ch1
	ch2	ch3	ch0	ch1	ch2
	ch3	ch0	ch1	ch2	ch3

**CMOS PROGRAMMABLE DMA CONTROLLER**

**Description Of The Transfer Mode**

The following is the description of the transfer mode of the M5M82C37AP

(1) Single mode DMA transfer

In single mode DMA, the M5M82C37AP executes only one word transfer when the bus control is acknowledged by the CPU, and when the S<sub>4</sub> state is ended, the M5M82C37AP reset HRQ output and releases the bus.

If the DMA request input continues at active level, at least one S<sub>i</sub> state is executed since the HLDA input falls down to low, and HRQ is kept low. Accordingly, 8085 CPU etc. can execute at least one instruction between DMA transfer.

(2) Block mode DMA transfer

In the block mode, once the DMA request is acknowledged, the DMA is executed continuously until the terminal count (TC) occurs.

TC means that

(i) The contents of the current word count register are about to be counted down from 0000<sub>16</sub> to FFFF<sub>16</sub> or that

(ii) an external  $\overline{EOP}$  pulse is input before the S<sub>2</sub> state.

The DREQ input should be kept active until the DACK output is made active, but once DMA is acknowledged, DMA transfer continues until TC occurs even when DMA request becomes inactive.

When DMA is executed continuously, the S<sub>1</sub> or S<sub>2</sub> state follows directly after S<sub>4</sub>. If the contents of the higher 8 bits of the address are not changed at the following word transfer, the S<sub>1</sub> state is skipped and the S<sub>2</sub> state is executed just after S<sub>4</sub>.

(3) Demand mode DMA transfer

In the demand mode, DMA is executed continuously while the DMA request is active.

Once the DMA is acknowledged to the channel which is programmed for the demand mode, DMA operation is executed continuously until TC occurs or the DMA request becomes inactive.

If DMA stops due to an inactive DREQ before TC, the rest of the DMA will be resumed when DREQ becomes active and the DMA is acknowledged again.

The operation during DMA is almost the same as in the block mode DMA.

(4) Cascade mode DMA transfer

This mode is used for DMA channel expansion by cascade connection when more than 4 channels are required. (See fig. 1)

If the DMA request for the channel which is programmed in the cascade mode occurs and the request is acknowledged, only the DACK output becomes active.

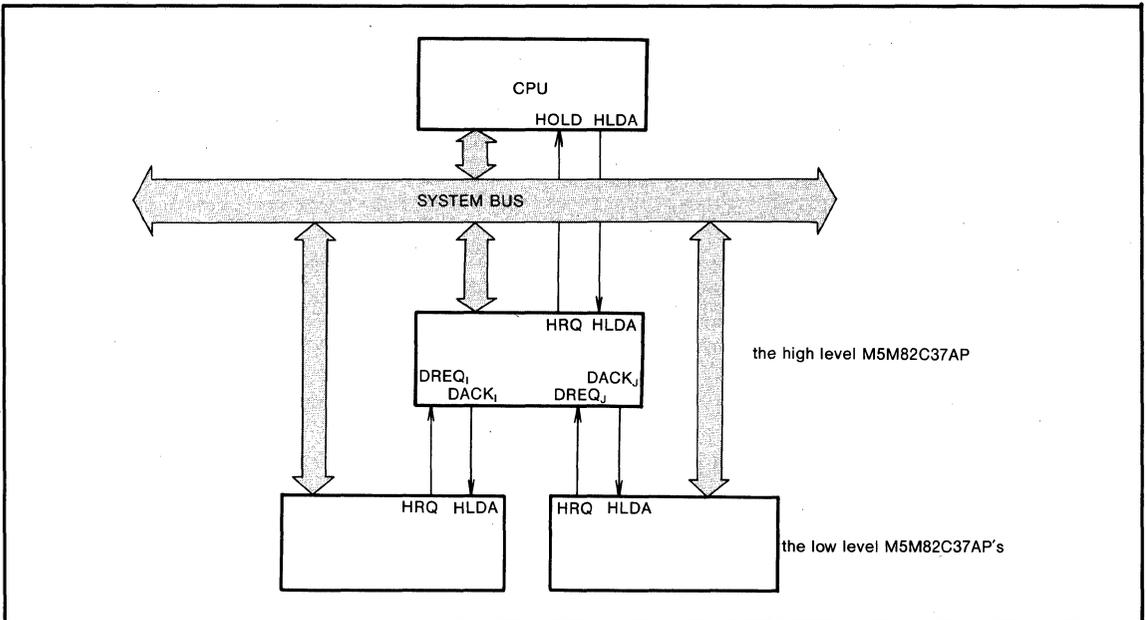
(IOR, IOW, MEMR, MEMW, DB<sub>7</sub>~DB<sub>0</sub>, A<sub>7</sub>~A<sub>0</sub> become floating. AEN, ADSTB outputs stay at low. CS and READY inputs are ignored.)

Accordingly the cascade mode DMA operation of the M5M82C37AP is only that it requests a bus hold request for the CPU instead of the low-level M5M82C37AP and transmits the bus acknowledgement signal by setting DACK active.

Note :

- The contents of the base and current address/word count registers of channels programmed in the cascade mode are invalid and change unpredictably.
- A software DMA request for the channel which is programmed in cascade mode may cause the system of hangup.
- When cascaded M5M82C37AP's are connected as shown in fig. 1, the high level M5M82C37AP should be initialized first and the DACK output set 'high active' in order to initialize the low level M5M82C37AP's because the registers of the M5M82C37AP cannot be read or written when HLDA input is high.
- An external  $\overline{EOP}$  cannot terminate cascade mode DMA operation.

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**Fig.1 Example of a DMA system using a cascade connection**

- (5) Auto initialization feature (mode register bit 4=1)  
 When bit 4 of the mode register is set to '1', the programmed channel enters the auto initialization mode. Auto initialization is performed when TC occurs and the contents of the base address/word count registers are loaded in the current address/word count registers. (The contents of the base address/word count registers are programmed to the same value as the current registers, at the same time.)  
 Note : If a channel is programmed for auto initialization the mask register bit for that channel is not set after TC. If it is not programmed for auto initialization, the mask register bit is set after TC, so the mask register bit must be reset to set this channel to DMA-enable.
- (6) Extended write feature (command register bit 5=1)  
 In normal DMA operation, the write pulse MEMW (or IOW) falls down to low in the  $S_3$  state. But, if extended write is programmed, the write pulse falls at the  $S_2$  state and the width can be extended for one clock period.
- (7) Compressed timing DMA feature (command register bit 3=1)  
 In normal DMA, the transfer for one word consists of three or four states.  
 If the compressed timing DMA is programmed, the  $S_3$  state is not executed and the one word transfer consists of two or three states. In this mode, the write output (IOW, MEMW) falls to low in the  $S_2$  state as well as the read output (IOR, MEMR). In memory-to-memory DMA operation, the compressed timing assignment is ignored.

**REGISTERS**

The following is a description of the registers of M5M82C37AP.

- (1) Address registers  
 The M5M82C37AP has two 16-bit address registers for each DMA channel.  
 One is called the current address register. It holds the contents of the memory address at which DMA operation is performed and the contents are incremented (or decremented) at every word transfer. This register is read/write enabled when in the inactive state. The other is the base address register. This register is a write-only register and is written at the same time the current address register is programmed. The contents of the base address register are loaded into the current address register when the channel has reached TC if the channel is programmed in the auto initialize mode.  
 The registers of the M5M82C37AP are read or written through an 8-bit data bus so the address register must be accessed twice, first the lower 8 bits, second the higher 8 bits. The M5M82C37AP has a first/last flip-flop which is toggled when the 16-bit register is accessed. It selects the lower or higher byte.
- (2) Word count registers  
 The M5M82C37AP has two 16-bit word count registers for each DMA channel.  
 One is called the current word count register. It holds the number of DMA transfer words, and the contents are decremented at the end of every word transfer. TC occurs when the contents of the word counter about to

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decrement from  $0000_{16}$  to  $FFFF_{16}$ .

The other is the base word counter, a write only register that is used for auto initialization like the base address register.

The read/write operation for the word count register is the same as for the address registers.

(3) Mode registers

The M5M82C37AP has four 6-bit length registers to select the DMA modes and types for the 4 DMA channels. They are write only registers.

To program one of these registers, the channel selection is done by the 2 LSBs of the written data allowing all four registers to assigned at the same address. The other 6 bits are written to one of the four registers. The bit assignment is shown in figure 2.

(4) Command register

This register is an 8-bit write only register used to define common operations for the four DMA channels. The bit assignment is shown in figure 3.

Command register is set  $00_{16}$  by reset.

(5) Mask register

This register is a 4-bit register with one mask bit for each DMA channel.

The four bits of this register can be programmed simultaneously (fig. 4) or can be set or reset 1 bit at a time (fig. 5). All bits can be cleared by the clear mask register command.

After reset, the 4 mask bits are all set to '1'.

(6) Request register

This register is 4-bit register with one software request bit for each DMA channel.

One request bit can be set or reset at a time. (fig. 6)

Note : All the request bits are reset after the DMA operation of one channel. So, when the DMA is started by software request, other external DMA requests must be masked by setting all the mask register bits. (Software requests are not masked by the mask register.) All the request bits are set to '0' after reset.

(7) Status register

This register is an 8-bit read only register. The 4 MSBs show the status of the four DREQs. '1' means that the DREQ input is active.

The other four bits are the TC bits which are set to '1' when TC occurs. The lower 4 bits are reset after the status registers are read or after reset.

The relation between these bits and the channels is shown in fig. 7

(8) Temporary Register

This register is an 8-bit read only register.

It is used to store temporary data read during the first part of the memory-to-memory DMA operation.

When the CPU reads this register, the register contents are the data which were transferred in memory-to-memory transfer DMA immediately prior to the CPU read.

**5**

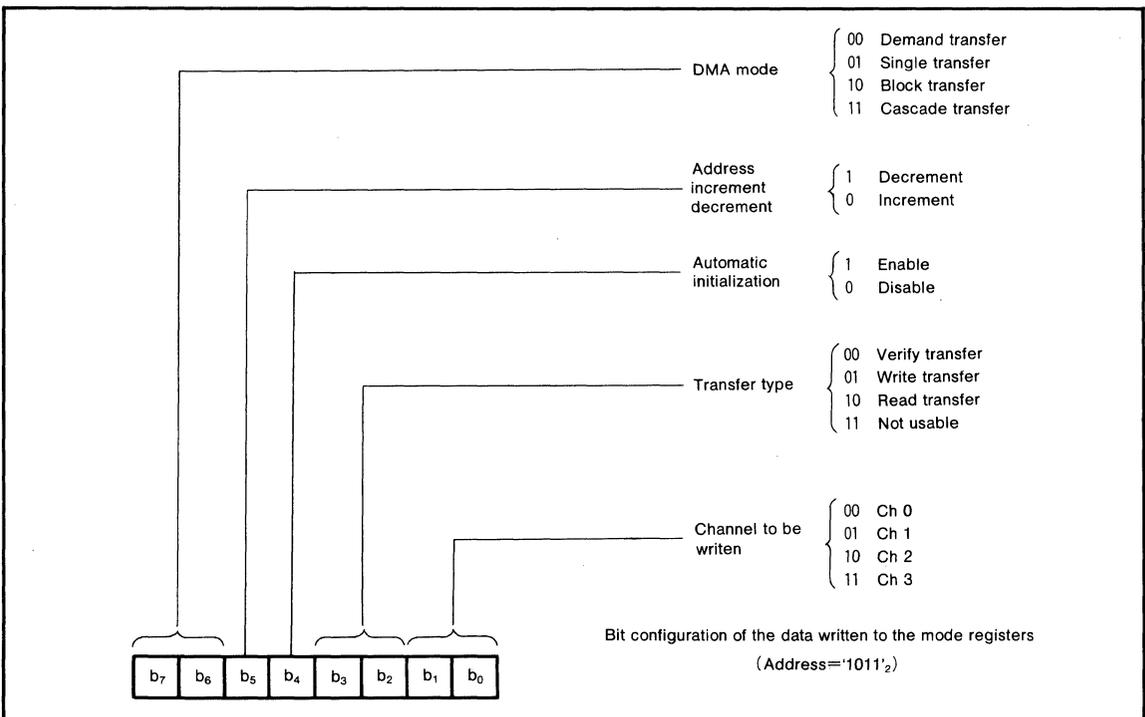
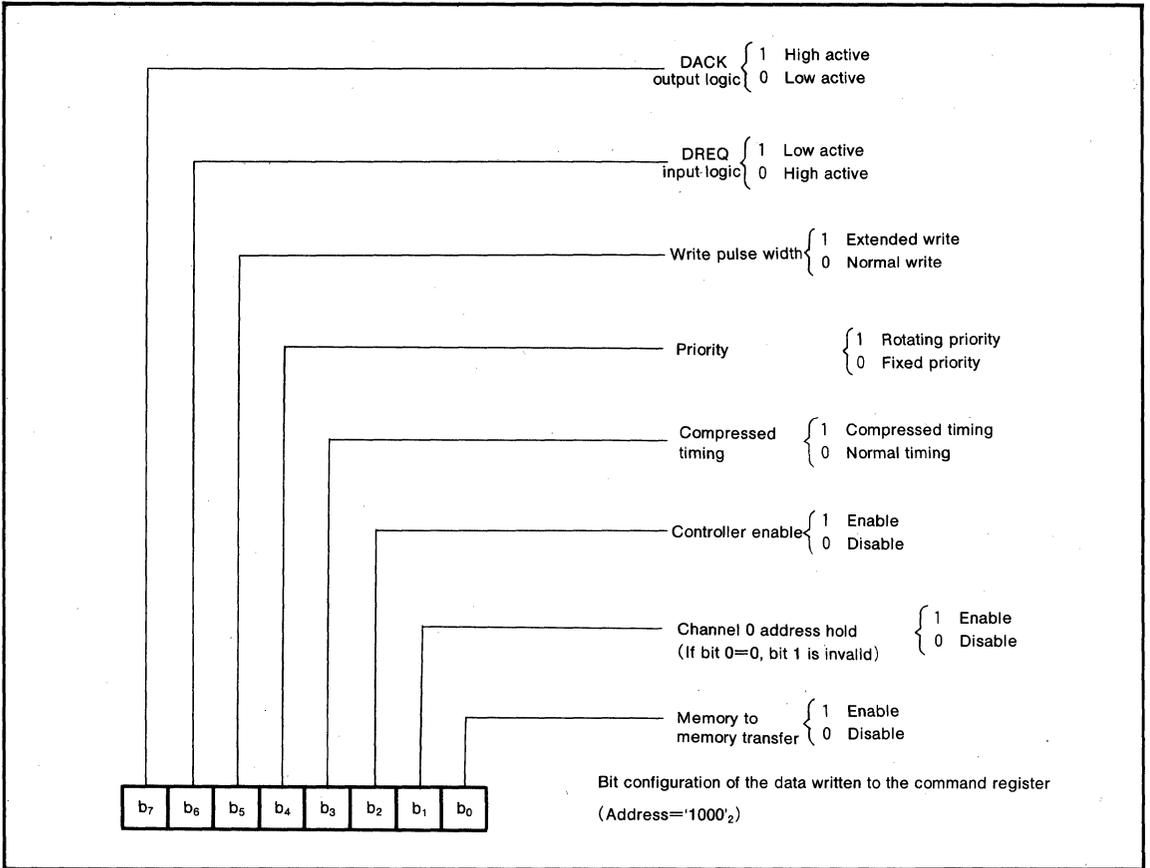
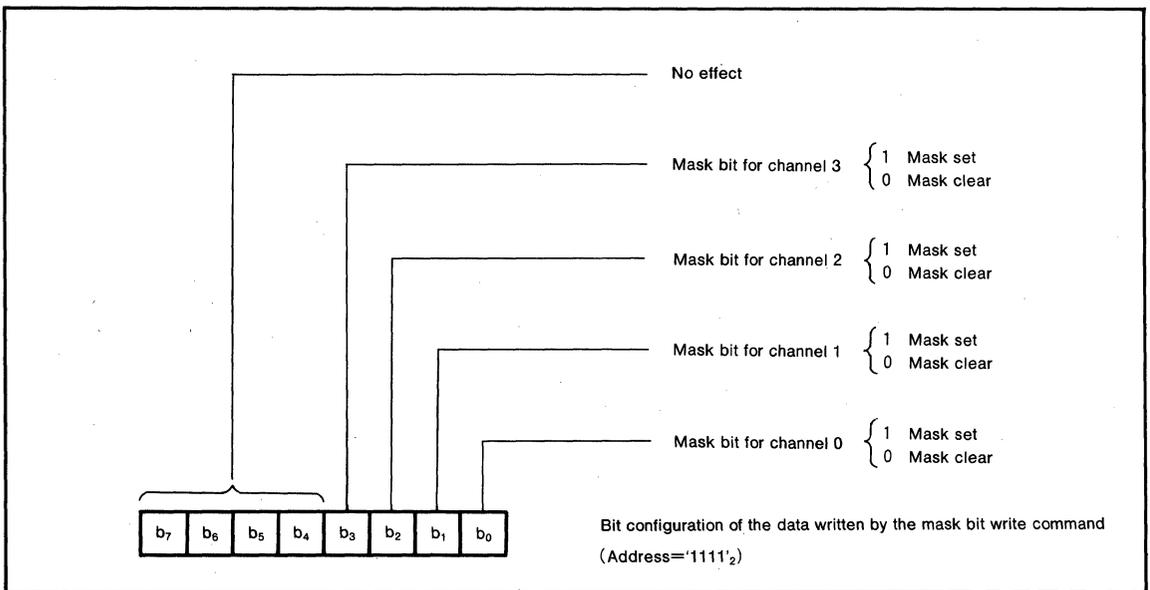


Fig.2 Mode registers

**CMOS PROGRAMMABLE DMA CONTROLLER**



**Fig.3 Command register**



**Fig.4 Mask register (write all bit)**

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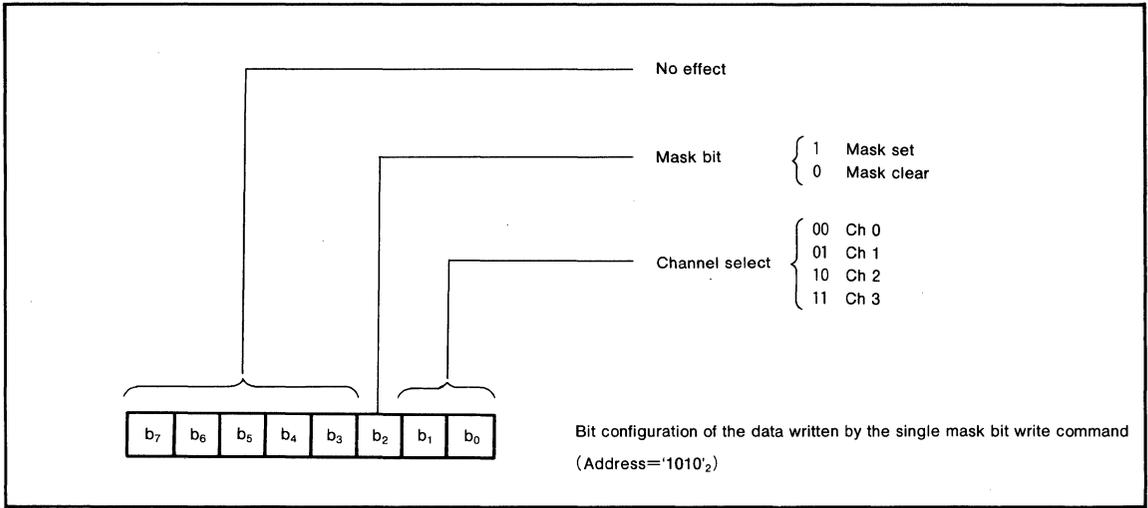


Fig.5 Mask register (write single bit)

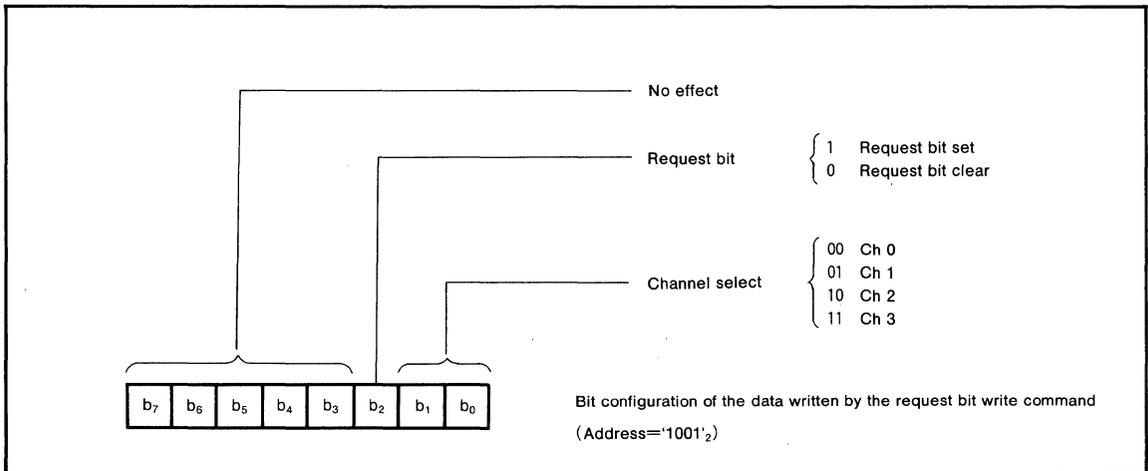


Fig.6 Request register

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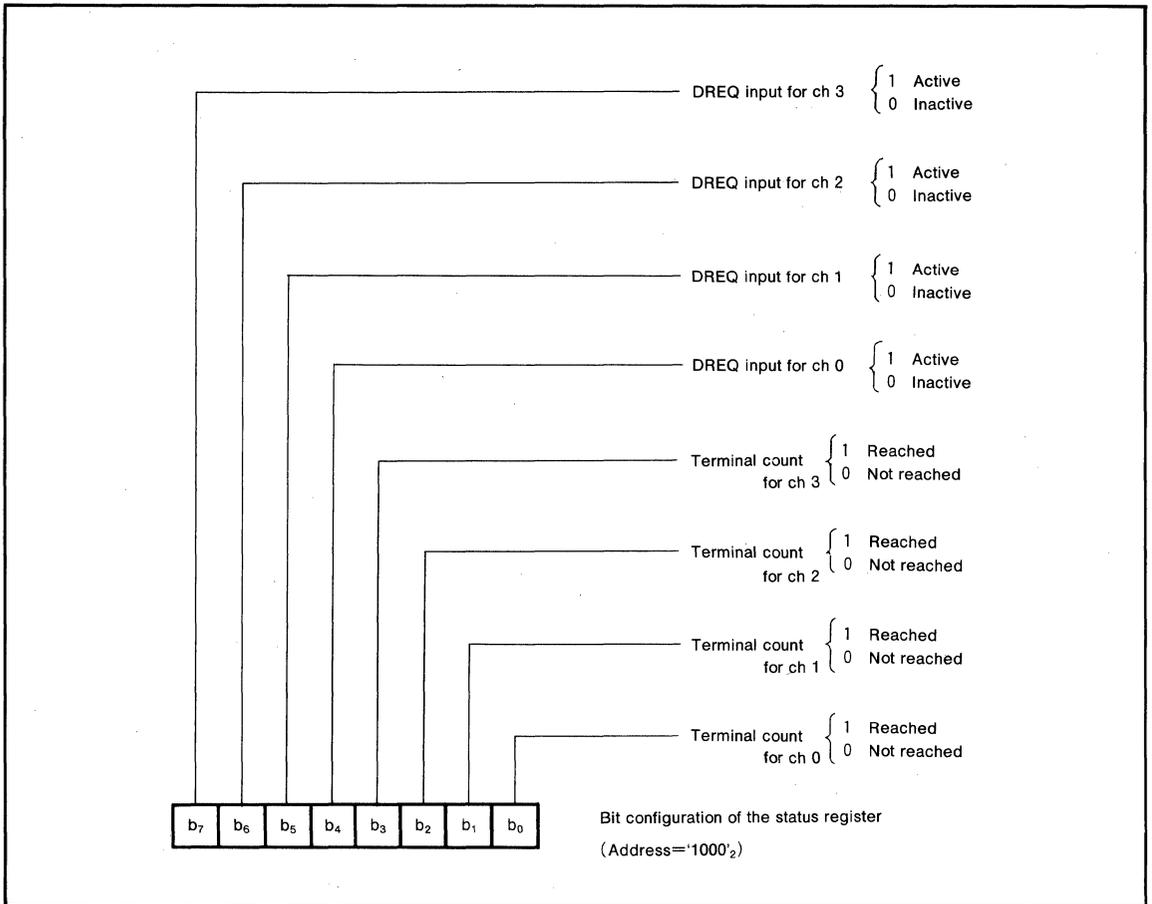


Fig.7 Status register

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**PROGRAMMING**

The registers in the M5M82C37AP can be read or written when CS and HLDA inputs are low.

The address assignment is shown in fig. 8 and 9. Some of the write operations in these figures do not, in fact, write in any registers. They are called software commands. The following is a description of the software commands.

**Clear first/last F/F**

In reading or writing a 16-bit register, the higher and lower 8 bits are accessed separately. Selection is done by a first/last flip-flop which toggles when ever one of the 16-bit registers is accessed. This command clears the first/last flip-flop, so after this command is executed, the next access of the 16-bit register is begins at the lower 8 bits.

**Master clear**

This command executes a software reset.

Note : The following are the effects of the software reset for the M5M82C37AP.

- Mask bits are set for all the DMA channels.
- The command register is cleared to '00<sub>16</sub>'. (Note that bit 2 is '0'.)
- The temporary register is cleared.
- The 4 TC bits of the status register are cleared.
- The first/last flip flop is reset.
- Software DMA request bits are cleared.

(When the hardware reset is performed, together with the above effects, DMA operation is terminated and the M5M82C37AP returns to the S<sub>1</sub> state.)

**Clear mask register**

This command clears all the mask bits and enable DMA for all the channels.

Table 2 Read operation with the M5M82C37AP

A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>	$\overline{\text{CS}}$	HLDA	$\overline{\text{RD}}$	First Last F/F	REGISTER READ
0	0	0	0	0	0	0	0	CH0 Current address register bit7~bit0
0	0	0	0	0	0	0	1	CH0 Current address register bit15~bit8
0	0	0	1	0	0	0	0	CH0 Current word count register bit7~bit0
0	0	0	1	0	0	0	1	CH0 Current word count register bit15~bit8
0	0	1	0	0	0	0	0	CH1 Current address register bit7~bit0
0	0	1	0	0	0	0	1	CH1 Current address register bit15~bit8
0	0	1	1	0	0	0	0	CH1 Current word count register bit7~bit0
0	0	1	1	0	0	0	1	CH1 Current word count register bit15~bit8
0	1	0	0	0	0	0	0	CH2 Current address register bit7~bit0
0	1	0	0	0	0	0	1	CH2 Current address register bit15~bit8
0	1	0	1	0	0	0	0	CH2 Current word count register bit7~bit0
0	1	0	1	0	0	0	1	CH2 Current word count register bit15~bit8
0	1	1	0	0	0	0	0	CH3 Current address register bit7~bit0
0	1	1	0	0	0	0	1	CH3 Current address register bit15~bit8
0	1	1	1	0	0	0	0	CH3 Current word count register bit7~bit0
0	1	1	1	0	0	0	1	CH3 Current word count register bit15~bit8
1	0	0	0	0	0	0	X	Status register
1	0	0	1	0	0	0	X	Invalid
1	0	1	0	0	0	0	X	Invalid
1	0	1	1	0	0	0	X	Invalid
1	1	0	0	0	0	0	X	Invalid
1	1	0	1	0	0	0	X	Temporary register
1	1	1	0	0	0	0	X	Invalid
1	1	1	1	0	0	0	X	Invalid
X	X	X	X	1	X	X	X	Read operation is not executed.
X	X	X	X	X	1	X	X	Read operation is not executed.

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Table 3 Write operation with the M5M82C37AP

A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>	$\overline{CS}$	HLDA	$\overline{WR}$	First Last F/F	REGISTER WRITTEN
0	0	0	0	0	0	0	0	CH0 base and current address register bit7~bit0
0	0	0	0	0	0	0	1	CH0 base and current address register bit15~bit8
0	0	0	1	0	0	0	0	CH0 base and current word count register bit7~bit0
0	0	0	1	0	0	0	1	CH0 base and current word count register bit15~bit8
0	0	1	0	0	0	0	0	CH1 base and current address register bit7~bit0
0	0	1	0	0	0	0	1	CH1 base and current address register bit15~bit8
0	0	1	1	0	0	0	0	CH1 base and current word count register bit7~bit0
0	0	1	1	0	0	0	1	CH1 base and current word count register bit15~bit8
0	1	0	0	0	0	0	0	CH2 base and current address register bit7~bit0
0	1	0	0	0	0	0	1	CH2 base and current address register bit15~bit8
0	1	0	1	0	0	0	0	CH2 base and current word count register bit7~bit0
0	1	0	1	0	0	0	1	CH2 base and current word count register bit15~bit8
0	1	1	0	0	0	0	0	CH3 base and current address register bit7~bit0
0	1	1	0	0	0	0	1	CH3 base and current address register bit15~bit8
0	1	1	1	0	0	0	0	CH3 base and current word count register bit7~bit0
0	1	1	1	0	0	0	1	CH3 base and current word count register bit15~bit8
1	0	0	0	0	0	0	X	Command register
1	0	0	1	0	0	0	X	Request register
1	0	1	0	0	0	0	X	Single mask bit write
1	0	1	1	0	0	0	X	Mode register
1	1	0	0	0	0	0	X	Clear first/last flip-flop software commands
1	1	0	1	0	0	0	X	Master clear software commands
1	1	1	0	0	0	0	X	Clear all mask register bits software commands
1	1	1	1	0	0	0	X	Write all mask bits software commands
X	X	X	X	1	X	X	X	Write is not executed.
X	X	X	X	X	1	X	X	Write is not executed.

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**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage	With respect to $V_{SS}$	-0.3~7	V
$V_I$	Input voltage		-0.3~ $V_{CC}+0.3$	V
$V_O$	Output voltage		-0.3~ $V_{CC}+0.3$	V
$T_{opr}$	Operating free-air temperature range		-20~75	°C
$T_{stg}$	Storage temperature		-65~150	°C

**RECOMMENDED OPERATING CONDITIONS** ( $T_a = -20 \sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Typ	Max	
$V_{CC}$	Supply voltage	4.5	5	5.5	V
$V_{SS}$	Supply voltage(GND)		0		V

**ELECTRICAL CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{IH}$	High-level input voltage		2.0		$V_{CC}+0.3$	V
$V_{IL}$	Low-level input voltage		-0.3		0.8	V
$V_{OH}$	High-level output voltage	$I_{OH} = -200\mu\text{A}$	2.4			V
		$I_{OH} = -100\mu\text{A}$ (HRQ only)	3.2			V
$V_{OL}$	Low-level output voltage	$I_{OL} = 2.0\text{mA}$ (data bus) $I_{OL} = 3.2\text{mA}$ (other outputs)			0.45	V
$I_I$	Input current	$V_I = 0 \sim V_{CC}$	-10		+10	$\mu\text{A}$
$I_{OZ}$	Off-state output current	$V_I = 0 \sim V_{CC}$	-10		+10	$\mu\text{A}$
$I_{CC}$	Supply current	$V_{IH} = V_{CC}$ , $V_{IL} = V_{SS}$ , $f_{CLK} = 1/t_c(\phi)$ min.			15	mA

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**CMOS PROGRAMMABLE DMA CONTROLLER**

**TIMING REQUIREMENTS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

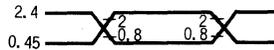
**(i) SLAVE MODE**

Symbol	Parameter	Alternate symbol	Limits						Unit
			M5M82C37AP		M5M82C37AP-4		M5M82C37AP-5		
			Min	Max	Min	Max	Min	Max	
$t_{SU(CS-R)}$ $t_{SU(A-R)}$	Address setup time before read	$T_{AR}$	50		50		50 [0]		ns
$t_{SU(CS-W)}$	$\overline{CS}$ setup time before write	$T_{CW}$	200		150		150		ns
$t_{SU(A-W)}$	Address setup time before write	$T_{AW}$	200		150		150		ns
$t_{SU(DQ-W)}$	Data setup time before write	$T_{DW}$	200		150		100		ns
$t_h(R-CS)$ $t_h(R-A)$	Address hold time after read	$T_{RA}$	0		0		0		ns
$t_h(W-CS)$	$\overline{CS}$ hold time after write	$T_{WC}$	20		20		20 [0]		ns
$t_h(W-A)$	Address hold after write	$T_{WA}$	20		20		20 [0]		ns
$t_h(W-DQ)$	Data hold after write	$T_{WD}$	30		30		30 [0]		ns
$t_w(R)$	Read pulse width	$T_{RW}$	300		250		200		ns
$t_w(W)$	Write pulse width	$T_{WWS}$	200		200		160		ns
$t_w(RESET)$	Reset pulse width	$T_{RSTW}$	300		300		300		ns
$t_{SU}(V_{CC}-RESET)$	$V_{CC}$ setup time before to reset	$T_{RSTD}$	500		500		500		ns
$t_{SU}(RESET-R)$	Reset setup time before read	$T_{RSTS}$	$2t_C(\neq)$		$2t_C(\neq)$		$2t_C(\neq)$		ns
$t_{SU}(RESET-W)$	Reset setup time before Write								

**(ii) DMA MODE**

Symbol	Parameter	Alternate symbol	Limits						Unit
			M5M82C37AP		M5M82C37AP-4		M5M82C37AP-5		
			Min	Max	Min	Max	Min	Max	
$t_w(\neq)$	Clock high-level pulse width	$T_{CH}$	120		100		80		ns
$t_w(\neq)$	Clock low-level pulse width	$T_{CL}$	150		110		68		ns
$t_C(\neq)$	Clock period	$T_{CY}$	320		250		200		ns
$t_{SU}(EOP-\neq)$	External $\overline{EOP}$ setup time before clock	$T_{EPS}$	60		45		40		ns
$t_w(EOP)$	External $\overline{EOP}$ pulse width	$T_{EPW}$	300		225		220		ns
$t_{SU}(DREQ-\neq)$	DREQ setup time before clock	$T_{QS}$	0		0		0		ns
$t_{SU}(READY-\neq)$	READY setup time before clock	$T_{RS}$	100		60		60		ns
$t_h(\neq-READY)$	READY hold time before clock	$T_{RH}$	20		20		20		ns
$t_{SU}(HLDA-\neq)$	HLDA setup time before clock	$T_{HS}$	100		75		75		ns
$t_{SU}(DQ-MEMR)$	Data setup time before MEMR	$T_{IDS}$	250		190		170		ns
$t_h(MEMR-DQ)$	Data hold time after MEMR	$T_{IDH}$	0		0		0		ns

Note : A.C Testing waveform  
 Input pulse level 0.45~2.4V  
 Input pulse rise time 10ns  
 Input pulse fall time 10ns  
 Reference level input  $V_{IH}=2V$ ,  $V_{IL}=0.8V$   
 Output  $V_{OH}=2V$ ,  $V_{OL}=0.8V$



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**SWITCHING CHARACTERISTIC** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

**(i) SLAVE MODE**

Symbol	Parameter	Alternate symbol	Limits						Unit
			M5M82C37AP		M5M82C37AP-4		M5M82C37AP-5		
			Min	Max	Min	Max	Min	Max	
$t_{PZV(R-DQ)}$	Data enable time after read	$T_{RDE}$		200		200		140	ns
$t_{PVZ(R-DQ)}$	Data disable time after read	$T_{RDF}$	0	100	0	100	0	70	ns

**(ii) DMA MODE**

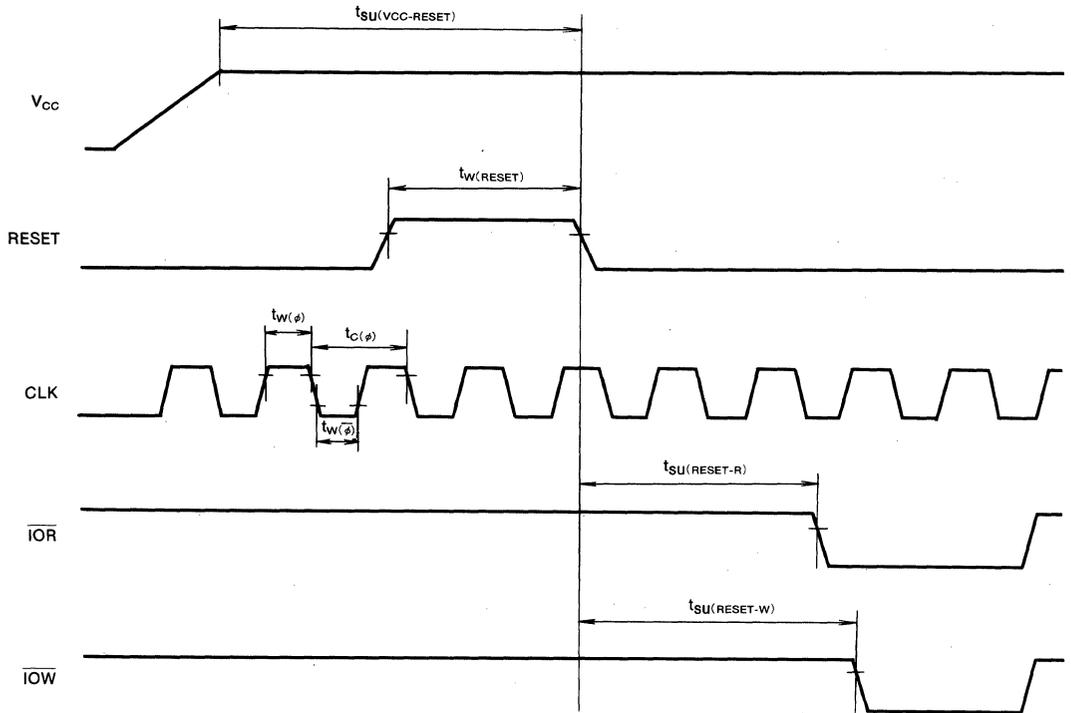
Symbol	Parameter	Alternate symbol	Limits						Unit
			M5M82C37AP		M5M82C37AP-4		M5M82C37AP-5		
			Min	Max	Min	Max	Min	Max	
$t_{PLH}(\phi-AEN)$	Propagation time from clock to AEN	$T_{AEL}$		300		225		200	ns
$t_{PHL}(\phi-AEN)$	Propagation time from clock to AEN	$T_{AET}$		200		150		130	ns
$t_{PZV}(\phi-A)$	Propagation time from clock to address active	$T_{FAAB}$		250		190		170	ns
$t_{PHL}(\phi-A)$	Propagation time from clock to address stable	$T_{ASM}$		250		190		170	ns
$t_{PVZ}(\phi-A)$	Propagation time from clock to address floating	$T_{AFAB}$		150		120		90	ns
$t_{PZV}(\phi-DQ)$	Propagation time from clock to data bus	$T_{FADB}$		300		225		200	ns
$t_{PVZ}(\phi-DQ)$	Propagation time from clock to data bus	$T_{AFDB}$		250		190		170	ns
$t_{PLH}(\phi-ADSTB)$	Propagation time from clock to ADSTB	$T_{STL}$		200		150		130	ns
$t_{PHL}(\phi-ADSTB)$	Propagation time from clock to ADSTB	$T_{STT}$		140		110		90	ns
$t_{SU}(OB-ADSTB)$	Data output setup time before ADSTB	$T_{ASS}$	100		100		100		ns
$t_h(ADSTB-DQ)$	Data output hold time before ADSTB	$T_{AHS}$	50		40		30		ns
$t_{PZV}(\phi-R)$	Propagation time from clock to read or write active	$T_{FAC}$		200		150		150	ns
$t_{PZV}(\phi-W)$									
$t_{PHL}(\phi-R)$	Propagation time from clock to read or write	$T_{DCL}$		270		200		190	ns
$t_{PHL}(\phi-W)$									
$t_{PLH}(\phi-R)$	Propagation time from clock to read	$T_{DCTR}$		270		210		190	ns
$t_{PLH}(\phi-W)$	Propagation time from clock to write	$T_{DCTW}$		200		150		130	ns
$t_{PZV}(\phi-R)$	Propagation time from clock to read or write floating	$T_{AFC}$		150		120		120	ns
$t_{PVZ}(\phi-W)$									
$t_h(R-A)$	Address output hold time after read	$T_{AHR}$	$t_{C(\phi)}-100$		$t_{C(\phi)}-100$		$t_{C(\phi)}-100$		ns
$t_h(W-A)$	Address output hold time after write	$T_{AHW}$	$t_{C(\phi)}-50$		$t_{C(\phi)}-50$		$t_{C(\phi)}-50$		ns
$t_{SU}(DQ-MEMW)$	Data output setup time before MEMW	$T_{ODV}$	200		125		125		ns
$t_h(MEMW-DQ)$	Data output hold time after MEMW	$T_{ODH}$	20		20		10		ns
$t_{PLH}(\phi-DACK)$	Propagation time from clock to DACK	$T_{AK}$		250		220		170	ns
$t_{PHL}(\phi-EOP)$	Propagation time from clock to $\overline{EOP}$	$T_{AK}$		250		190		170	ns
$t_{PLH}(\phi-EOP)$	Propagation time from clock to EOP	$T_{AK}$		250		190		170	ns
$t_{PLH}(\phi-HRQ)$	Propagation time from clock to HRQ	$T_{DQ}$	"H"2.0V	160		120		120	ns
$t_{PHL}(\phi-HRQ)$			"H"3.3V	250		190		120	

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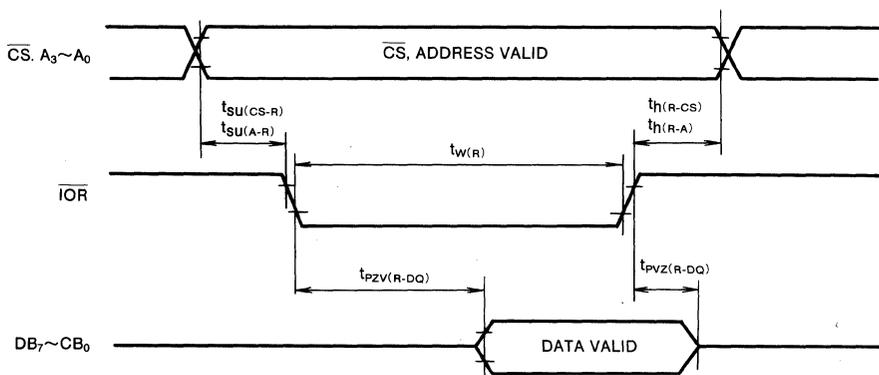
**CMOS PROGRAMMABLE DMA CONTROLLER**

**TIMING DIAGRAMS**

Reset timing

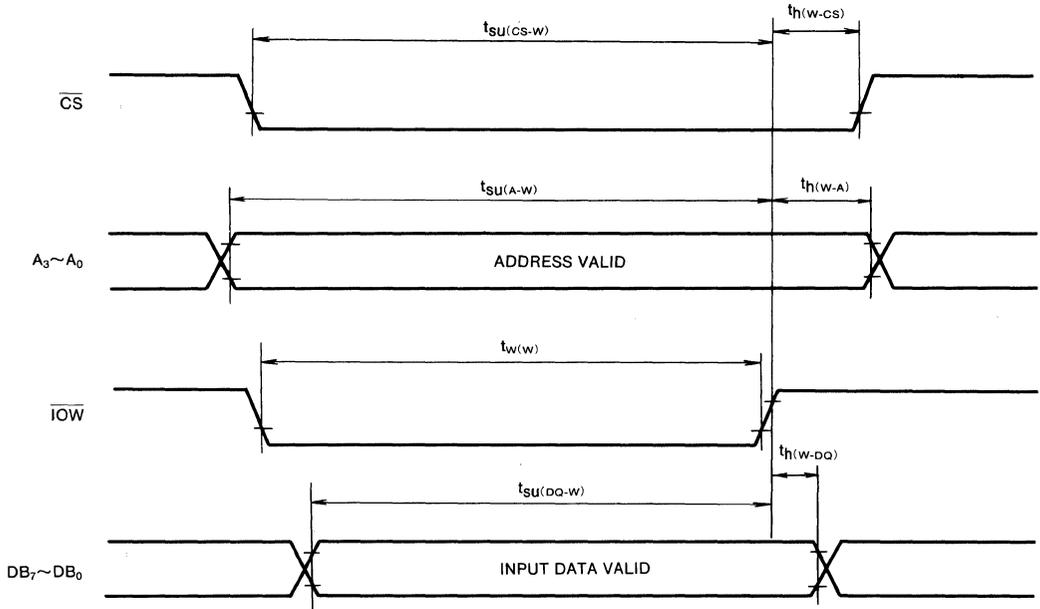


Slave mode timing (READ)



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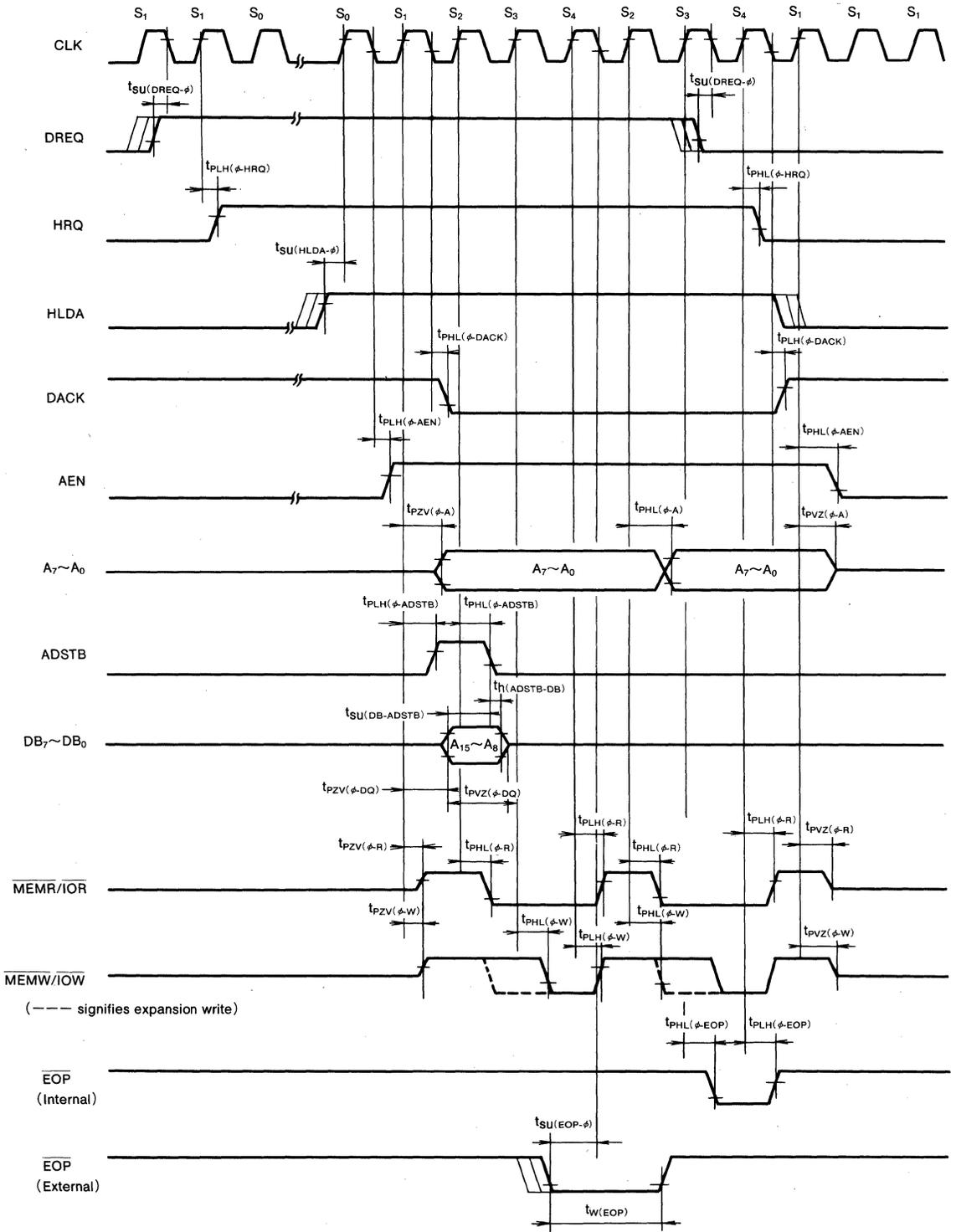
Slave mode timing (WRITE)



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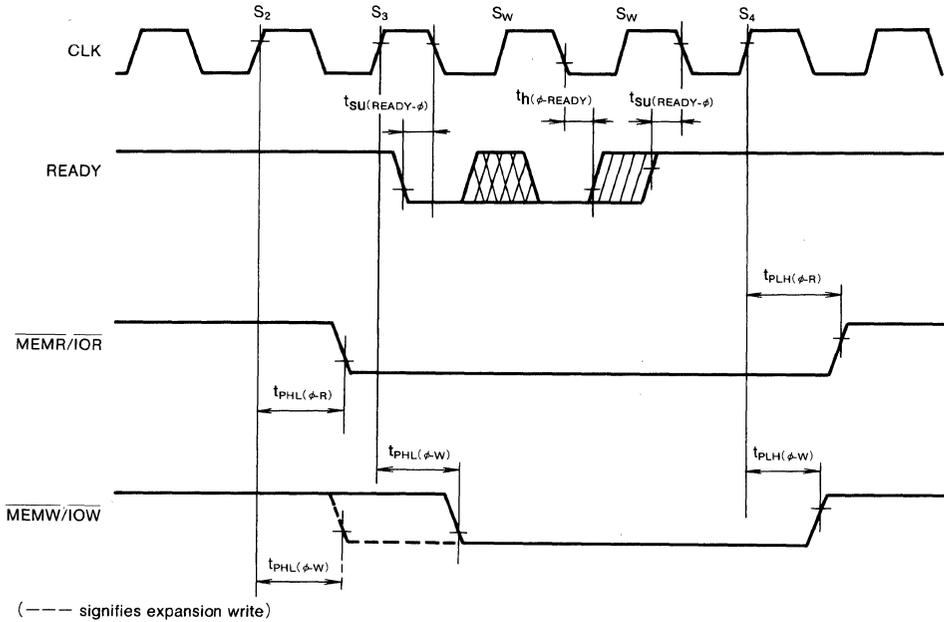
**CMOS PROGRAMMABLE DMA CONTROLLER**

**DMA transmit timing**

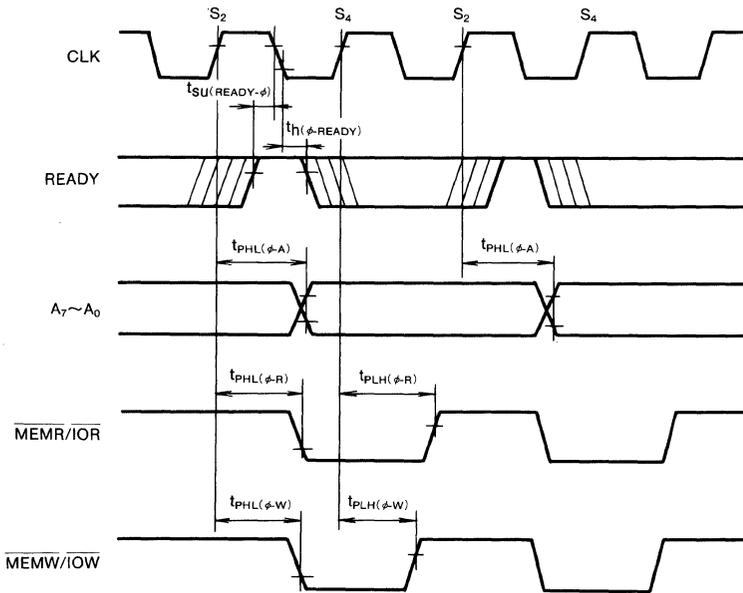


**CMOS PROGRAMMABLE DMA CONTROLLER**

READY input timing

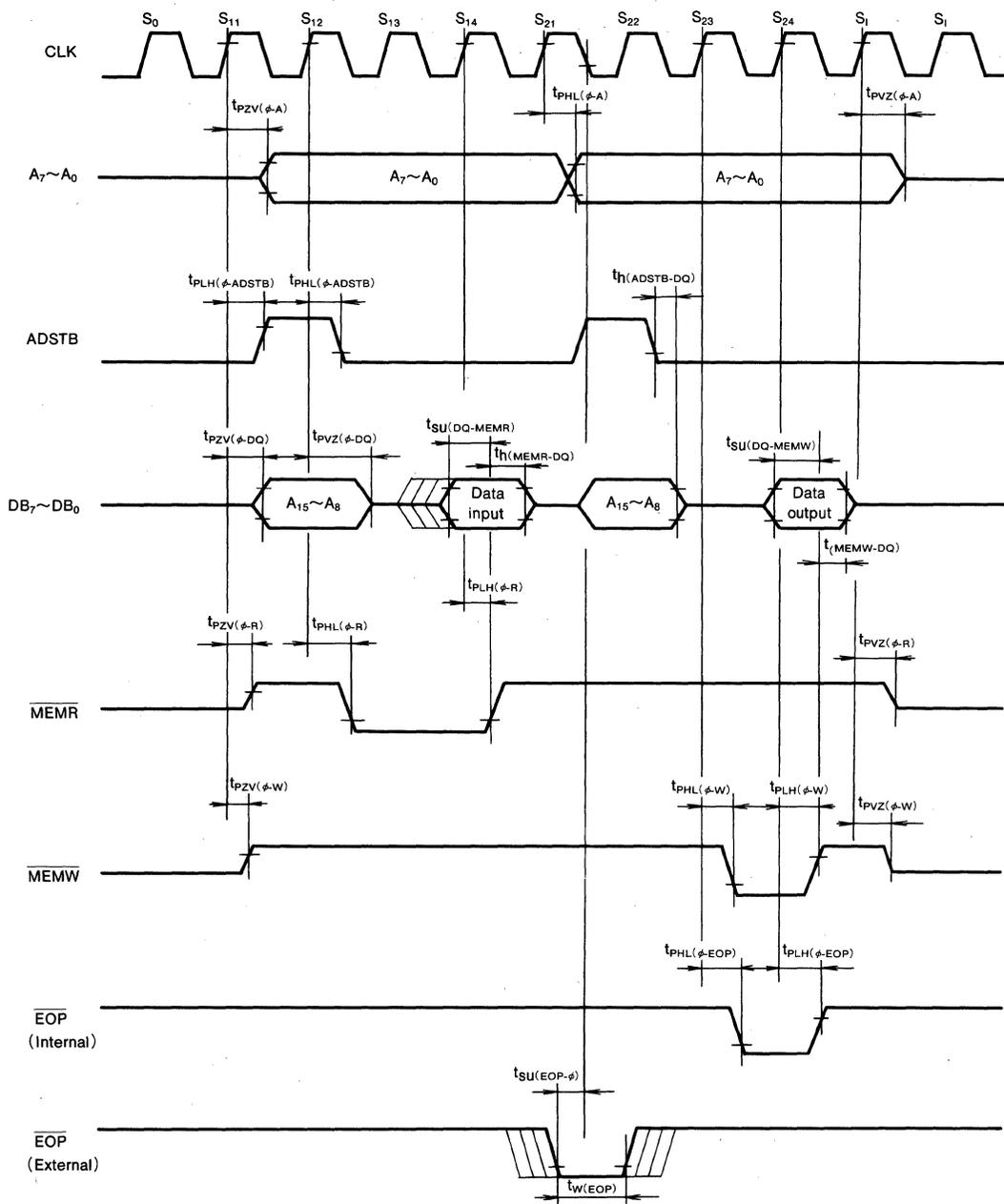


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**CMOS PROGRAMMABLE DMA CONTROLLER**

**Inter-memory transmission**



**PRELIMINARY**  
 Notice: This is not a final specification. Some  
 parameter limits are Subject to change.

# MITSUBISHI LSIs

## M5M82C37AFP,-4,-5

### CMOS PROGRAMMABLE DMA CONTROLLER

#### DESCRIPTION

The M5M82C37AFP is a programmable 4-channel DMA (Direct Memory Access) controller. This device is specially designed to simplify data transfer at high transfer rate for microcomputer systems.

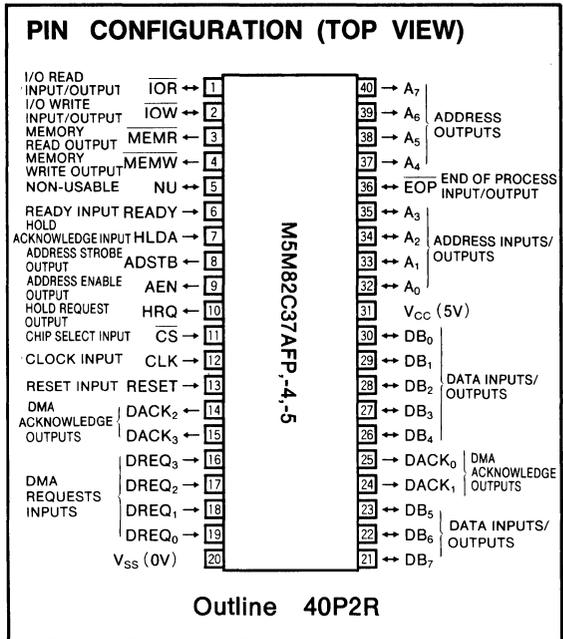
Fabricated using the silicon-gate CMOS technology, the M5M82C37AFP operates using a single 5V power supply.

#### FEATURES

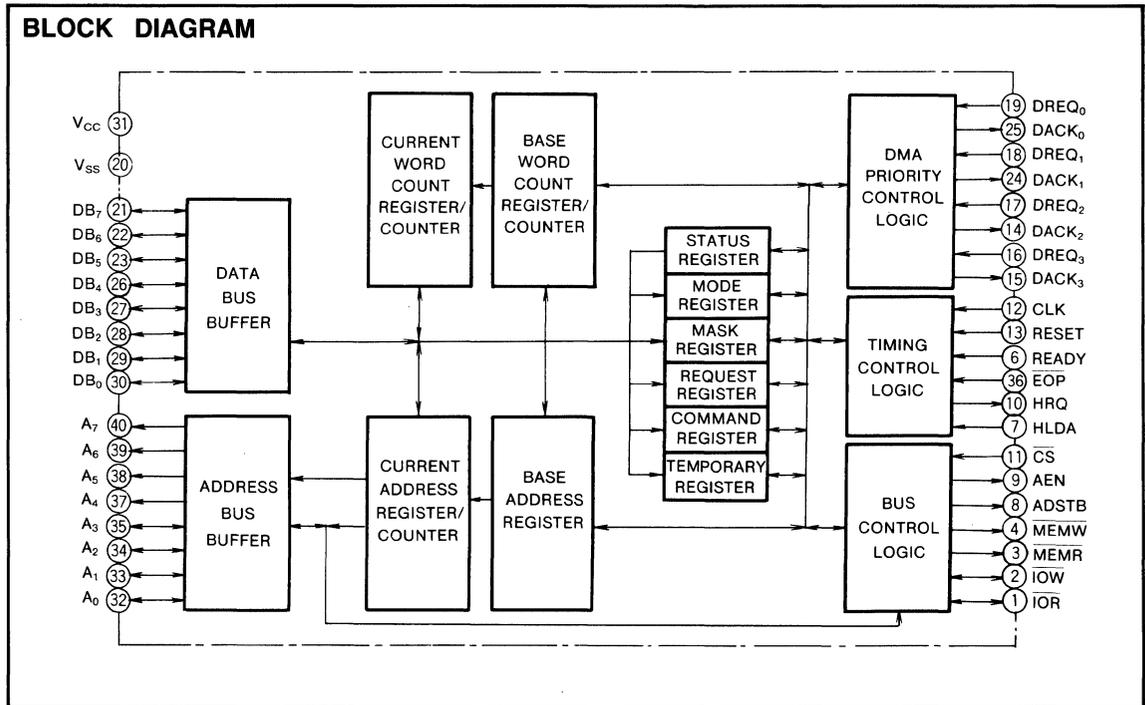
- 5V single supply, single TTL clock
- Four channel DMA controls with priority DMA request acknowledge functions
- DMA enable/disable, automatic initialization enable/disable, address increment/decrement programmability for each channel
- Programmable DREQ input and DACK output logic polarity
- Direct connecting permits easy DMA channel expansion.
- Memory to memory data transfer
- EOP input/output permits DMA operation completion check as well as forcibly completing DMA operation.

#### APPLICATION

- DMA control of peripheral equipment such as floppy diskettes and CRT terminals that require high-speed data transfer.



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# M5M82C37AFP,-4,-5

## CMOS PROGRAMMABLE DMA CONTROLLER

### FUNCTION

M5M82C37AFP is a programmable DMA controller LSI used in microprocessor systems.

This device basically consists of a DMA request control block for acknowledging DMA requests, a CPU interface for exchanging data and commands with the CPU, a timing control circuit for controlling each of the various types of timing, and a register for holding and counting DMA addresses and number of transfer words.

After setting the transfer mode, starting address, and byte number in each of the registers and when a DMA request is made to an unmasked channel, the M5M82C37AFP requires use of the bus to the CPU. When the HLDA signal is

received from the CPU, the DMA acknowledge signal is sent to DMA requesting channel with the highest priority and begins DMA operation.

During DMA operation, the contents of the low-byte of the transfer memory address are output through  $A_7 \sim A_0$ . Every time a change in the high-order 8-bit values is necessitated immediately after DMA operation has begun or due to borrowing or decrement during DMA operation, the change is output via pins  $DB_7 \sim DB_0$  to the externally mounted latch circuit. After the address is transmitted, read and write signals are sent to the memories and peripherals activating DMA transfer.

### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage	With respect to $V_{SS}$	-0.3~7	V
$V_i$	Input voltage		-0.3~ $V_{CC}+0.3$	V
$V_o$	Output voltage		-0.3~ $V_{CC}+0.3$	V
$T_{opr}$	Operating free-air temperature range		-20~75	°C
$T_{stg}$	Storage temperature		-65~150	°C

### RECOMMENDED OPERATING CONDITIONS ( $T_a = -20 \sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Typ	Max	
$V_{CC}$	Supply voltage	4.5	5	5.5	V
$V_{SS}$	Supply voltage(GND)		0		V

### ELECTRICAL CHARACTERISTICS ( $T_a = -20 \sim 75^\circ\text{C}$ , $V_{CC} = 5V \pm 10\%$ , $V_{SS} = 0V$ , unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{IH}$	High-level input voltage		2.0		$V_{CC}+0.3$	V
$V_{IL}$	Low-level input voltage		-0.3		0.8	V
$V_{OH}$	High-level output voltage	$I_{OH} = -200\mu\text{A}$	2.4			V
		$I_{OH} = -100\mu\text{A}(\text{HRQ only})$	3.2			V
$V_{OL}$	Low-level output voltage	$I_{OL} = 2.0\text{mA}(\text{data bus})$ $I_{OL} = 3.2\text{mA}(\text{other outputs})$			0.45	V
$I_i$	Input current	$V_i = 0 \sim V_{CC}$	-10		+10	$\mu\text{A}$
$I_{OZ}$	Off-state output current	$V_i = 0 \sim V_{CC}$	-10		+10	$\mu\text{A}$
$I_{CC}$	Supply current	$V_{IH} = V_{CC}, V_{IL} = V_{SS}, f_{CLK} = 1/t_c(\phi)\text{min.}$			15	mA

**MITSUBISHI LSIs**  
**M5M82C37AFP,-4,-5**

**CMOS PROGRAMMABLE DMA CONTROLLER**

**TIMING REQUIREMENTS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

**(i) SLAVE MODE**

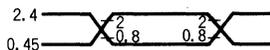
Symbol	Parameter	Alternate symbol	Limits						Unit
			M5M82C37AFP		M5M82C37AFP-4		M5M82C37AFP-5		
			Min	Max	Min	Max	Min	Max	
$t_{SU(CS-R)}$ $t_{SU(A-R)}$	Address setup time before read	$T_{AR}$	50		50		50 [0]		ns
$t_{SU(CS-W)}$	$\overline{CS}$ setup time before write	$T_{CW}$	200		150		150		ns
$t_{SU(A-W)}$	Address setup time before write	$T_{AW}$	200		150		150		ns
$t_{SU(DQ-W)}$	Data setup time before write	$T_{DW}$	200		150		100		ns
$t_{h(R-CS)}$ $t_{h(R-A)}$	Address hold time after read	$T_{RA}$	0		0		0		ns
$t_{h(W-CS)}$	$\overline{CS}$ hold time after write	$T_{WC}$	20		20		20 [0]		ns
$t_{h(W-A)}$	Address hold after write	$T_{WA}$	20		20		20 [0]		ns
$t_{h(W-DQ)}$	Data hold after write	$T_{WD}$	30		30		30 [0]		ns
$t_{W(R)}$	Read pulse width	$T_{RW}$	300		250		200		ns
$t_{W(W)}$	Write pulse width	$T_{WWS}$	200		200		160		ns
$t_{W(RESET)}$	Reset pulse width	$T_{RSTW}$	300		300		300		ns
$t_{SU(VCC-RESET)}$	$V_{CC}$ setup time before to reset	$T_{RSTD}$	500		500		500		ns
$t_{SU(RESET-R)}$ $t_{SU(RESET-W)}$	Reset setup time before read Reset setup time before Write	$T_{RSTS}$	$2t_C(\neq)$		$2t_C(\neq)$		$2t_C(\neq)$		ns

**(ii) DMA MODE**

Symbol	Parameter	Alternate symbol	Limits						Unit
			M5M82C37AFP		M5M82C37AFP-4		M5M82C37AFP-5		
			Min	Max	Min	Max	Min	Max	
$t_{W(\neq)}$	Clock high-level pulse width	$T_{CH}$	120		100		80		ns
$t_{W(\overline{\neq})}$	Clock low-level pulse width	$T_{CL}$	150		110		68		ns
$t_C(\neq)$	Clock period	$T_{CY}$	320		250		200		ns
$t_{SU(EOP-\neq)}$	External EOP setup time before clock	$T_{EPS}$	60		45		40		ns
$t_{W(EOP)}$	External EOP pulse width	$T_{EPW}$	300		225		220		ns
$t_{SU(DREQ-\neq)}$	DREQ setup time before clock	$T_{QS}$	0		0		0		ns
$t_{SU(READY-\neq)}$	READY setup time before clock	$T_{RS}$	100		60		60		ns
$t_{h(\neq-READY)}$	READY hold time before clock	$T_{RH}$	20		20		20		ns
$t_{SU(HLDA-\neq)}$	HLDA setup time before clock	$T_{HS}$	100		75		75		ns
$t_{SU(DQ-MEMR)}$	Data setup time before MEMR	$T_{IDS}$	250		190		170		ns
$t_{h(MEMR-DQ)}$	Data hold time after MEMR	$T_{IDH}$	0		0		0		ns

Note : A.C Testing waveform

Input pulse level                    0.45~2.4V  
 Input pulse rise time                10ns  
 Input pulse fall time                 10ns  
 Reference level input                 $V_{IH}=2V, V_{IL}=0.8V$   
 Output                                     $V_{OH}=2V, V_{OL}=0.8V$



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**CMOS PROGRAMMABLE DMA CONTROLLER**

**SWITCHING CHARACTERISTIC** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

**(i) SLAVE MODE**

Symbol	Parameter	Alternate symbol	Limits						Unit
			M5M82C37AFP		M5M82C37AFP-4		M5M82C37AFP-5		
			Min	Max	Min	Max	Min	Max	
$t_{PZV}(R-DQ)$	Data enable time after read	$T_{RDE}$		200		200		140	ns
$t_{PVZ}(R-DQ)$	Data disable time after read	$T_{RDF}$	0	100	0	100	0	70	ns

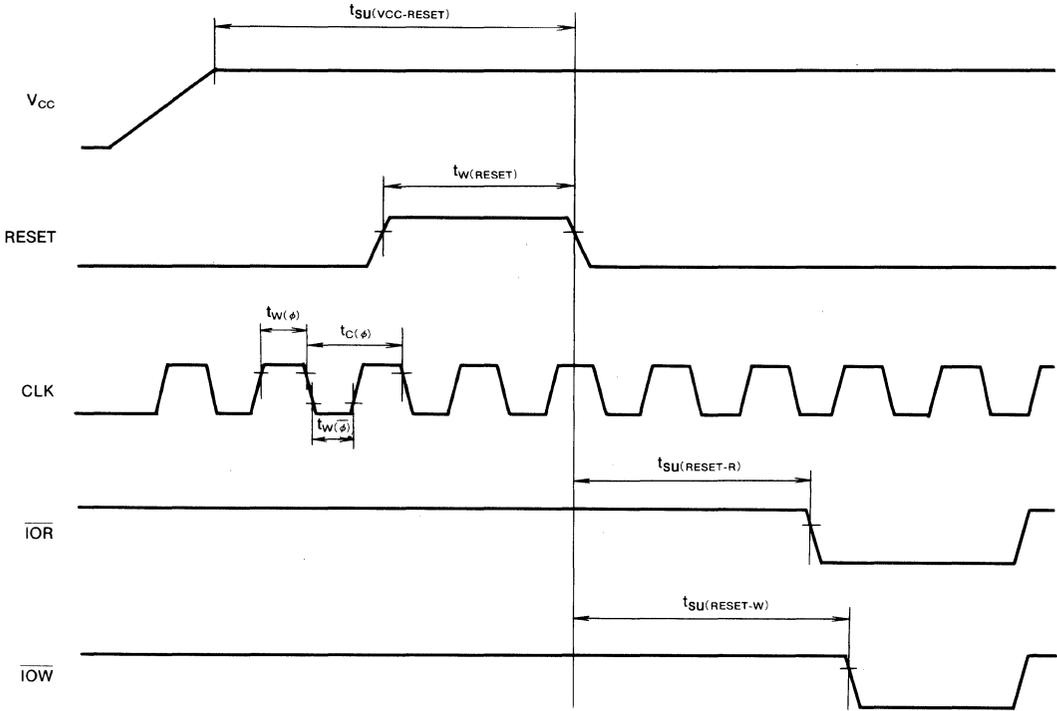
**(ii) DMA MODE**

Symbol	Parameter	Alternate symbol	Limits						Unit
			M5M82C37AFP		M5M82C37AFP-4		M5M82C37AFP-5		
			Min	Max	Min	Max	Min	Max	
$t_{PLH}(\#-AEN)$	Propagation time from clock to AEN	$T_{AEL}$		300		225		200	ns
$t_{PHL}(\#-AEN)$	Propagation time from clock to AEN	$T_{AET}$		200		150		130	ns
$t_{PZV}(\#-A)$	Propagation time from clock to address active	$T_{FAAB}$		250		190		170	ns
$t_{PHL}(\#-A)$	Propagation time from clock to address stable	$T_{ASM}$		250		190		170	ns
$t_{PVZ}(\#-A)$	Propagation time from clock to address floating	$T_{AFAB}$		150		120		90	ns
$t_{PZV}(\#-DQ)$	Propagation time from clock to data bus	$T_{FADB}$		300		225		200	ns
$t_{PVZ}(\#-DQ)$	Propagation time from clock to data bus	$T_{AFDB}$		250		190		170	ns
$t_{PLH}(\#-ADSTB)$	Propagation time from clock to ADSTB	$T_{STL}$		200		150		130	ns
$t_{PHL}(\#-ADSTB)$	Propagation time from clock to ADSTB	$T_{STT}$		140		110		90	ns
$t_{SU}(DB-ADSTB)$	Data output setup time before ADSTB	$T_{ASS}$	100		100		100		ns
$t_h(ADSTB-DQ)$	Data output hold time before ADSTB	$T_{AHS}$	50		40		30		ns
$t_{PZV}(\#-R)$	Propagation time from clock to read or write active	$T_{FAC}$		200		150		150	ns
$t_{PVZ}(\#-W)$									
$t_{PHL}(\#-R)$	Propagation time from clock to read or write	$T_{DCL}$		270		200		190	ns
$t_{PHL}(\#-W)$									
$t_{PLH}(\#-R)$	Propagation time from clock to read	$T_{DCTR}$		270		210		190	ns
$t_{PLH}(\#-W)$	Propagation time from clock to write	$T_{DCTW}$		200		150		130	ns
$t_{PZV}(\#-R)$	Propagation time from clock to read or write floating	$T_{AFC}$		150		120		120	ns
$t_{PVZ}(\#-W)$									
$t_h(R-A)$	Address output hold time after read	$T_{AHR}$	$t_{C(\#)}-100$		$t_{C(\#)}-100$		$t_{C(\#)}-100$		ns
$t_h(W-A)$	Address output hold time after write	$T_{AHW}$	$t_{C(\#)}-50$		$t_{C(\#)}-50$		$t_{C(\#)}-50$		ns
$t_{SU}(DQ-MEMW)$	Data output setup time before MEMW	$T_{ODV}$	200		125		125		ns
$t_h(MEMW-DQ)$	Data output hold time after MEMW	$T_{ODH}$	20		20		10		ns
$t_{PLH}(\#-DACK)$	Propagation time from clock to DACK	$T_{AK}$		250		220		170	ns
$t_{PHL}(\#-EOP)$	Propagation time from clock to EOP	$T_{AK}$		250		190		170	ns
$t_{PLH}(\#-EOP)$	Propagation time from clock to EOP	$T_{AK}$		250		190		170	ns
$t_{PLH}(\#-HRQ)$	Propagation time from clock to HRQ	$T_{DQ}$	"H"2.0V	160		120		120	ns
$t_{PHL}(\#-HRQ)$			"H"3.3V	250		190		120	

**CMOS PROGRAMMABLE DMA CONTROLLER**

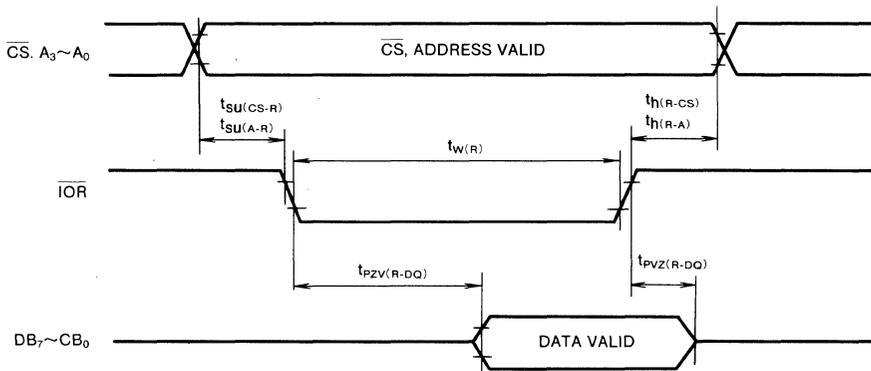
**TIMING DIAGRAMS**

Reset timing



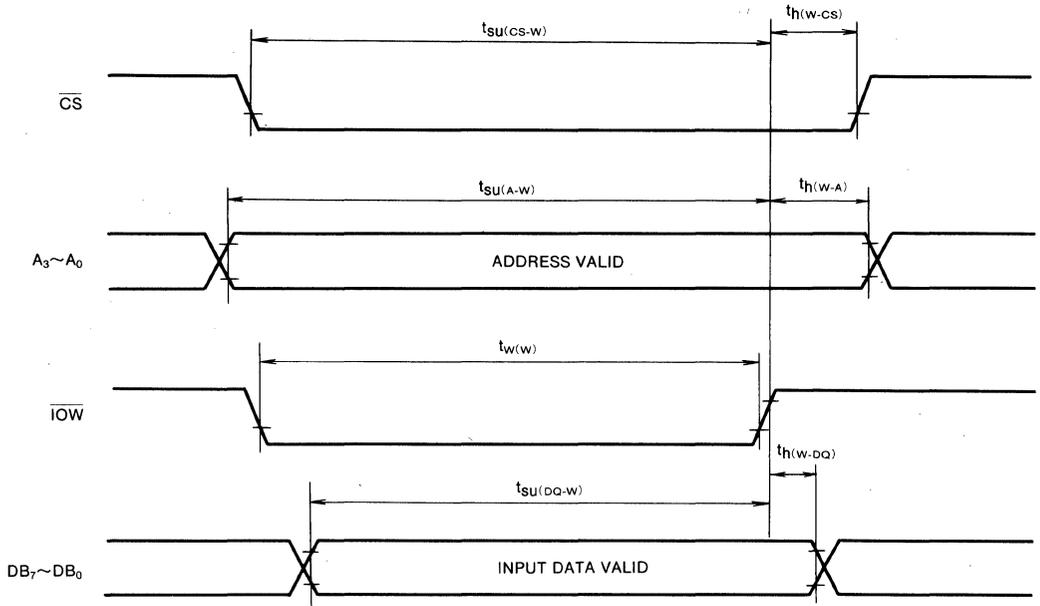
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Slave mode timing (READ)



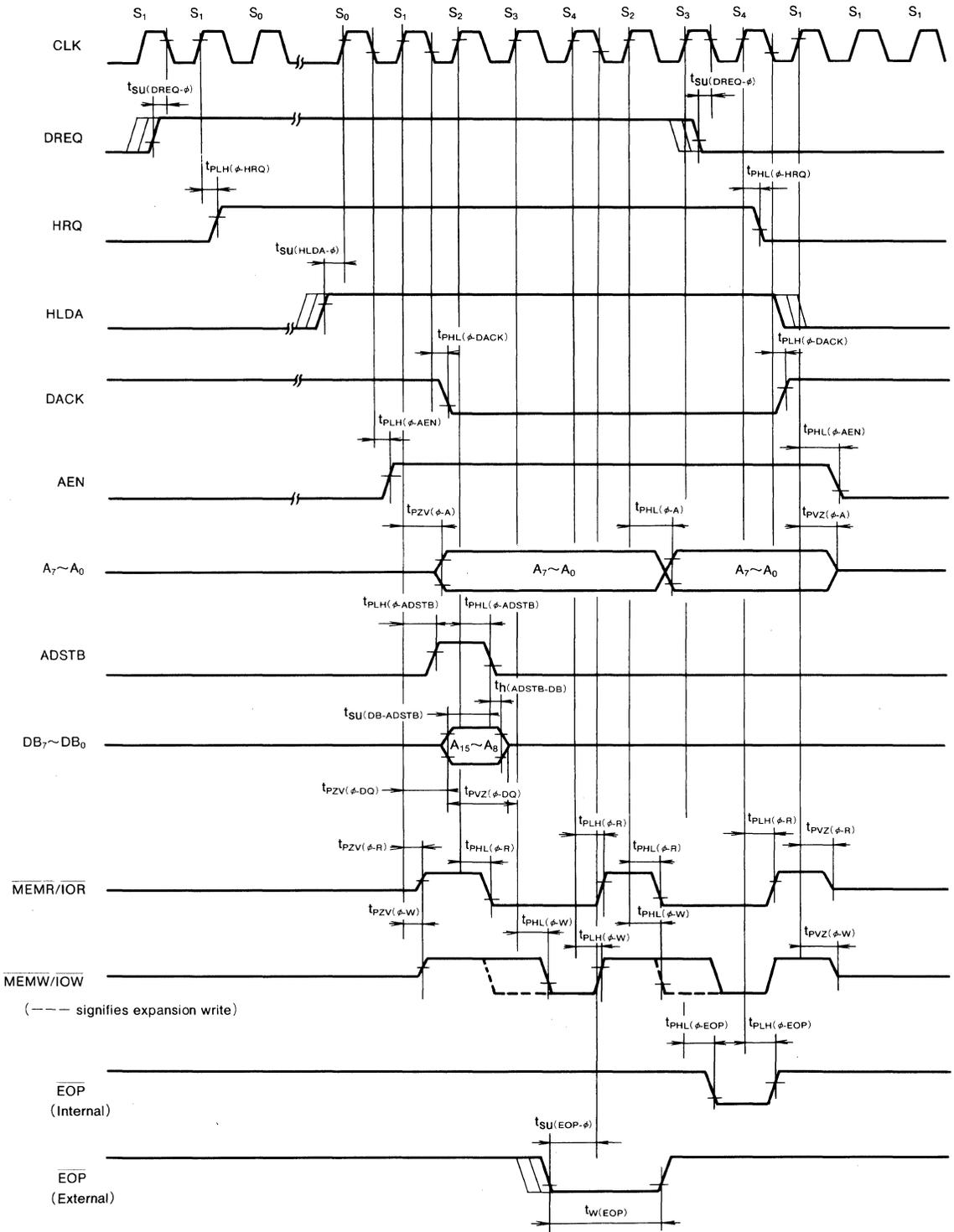
**CMOS PROGRAMMABLE DMA CONTROLLER**

Slave mode timing (WRITE)



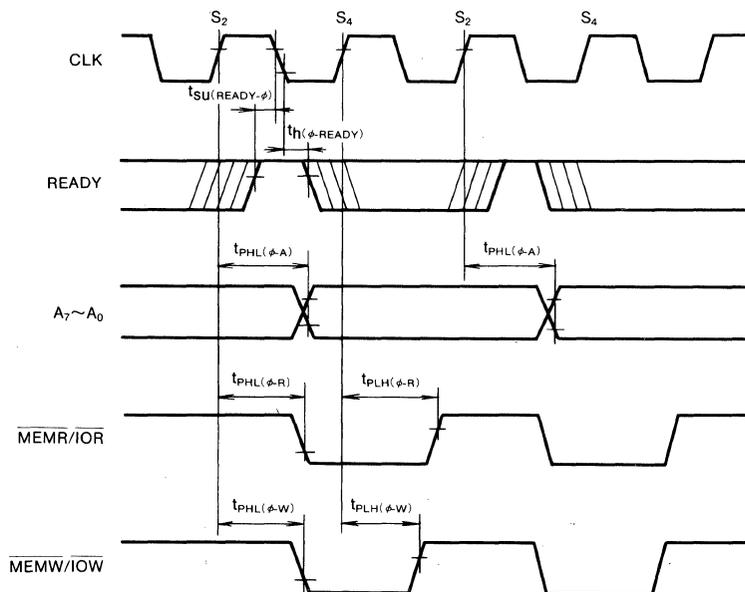
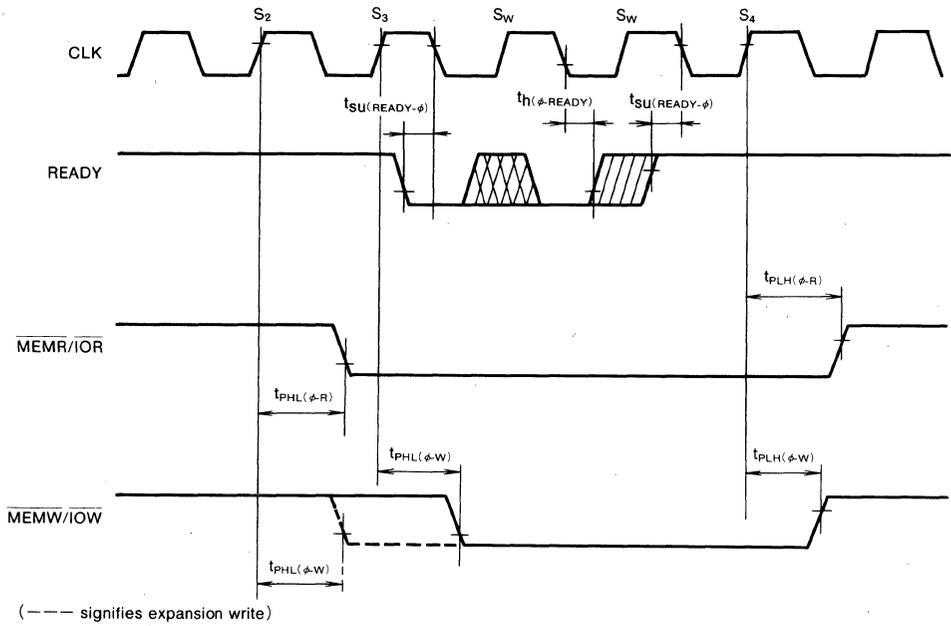
**CMOS PROGRAMMABLE DMA CONTROLLER**

**DMA transmit timing**



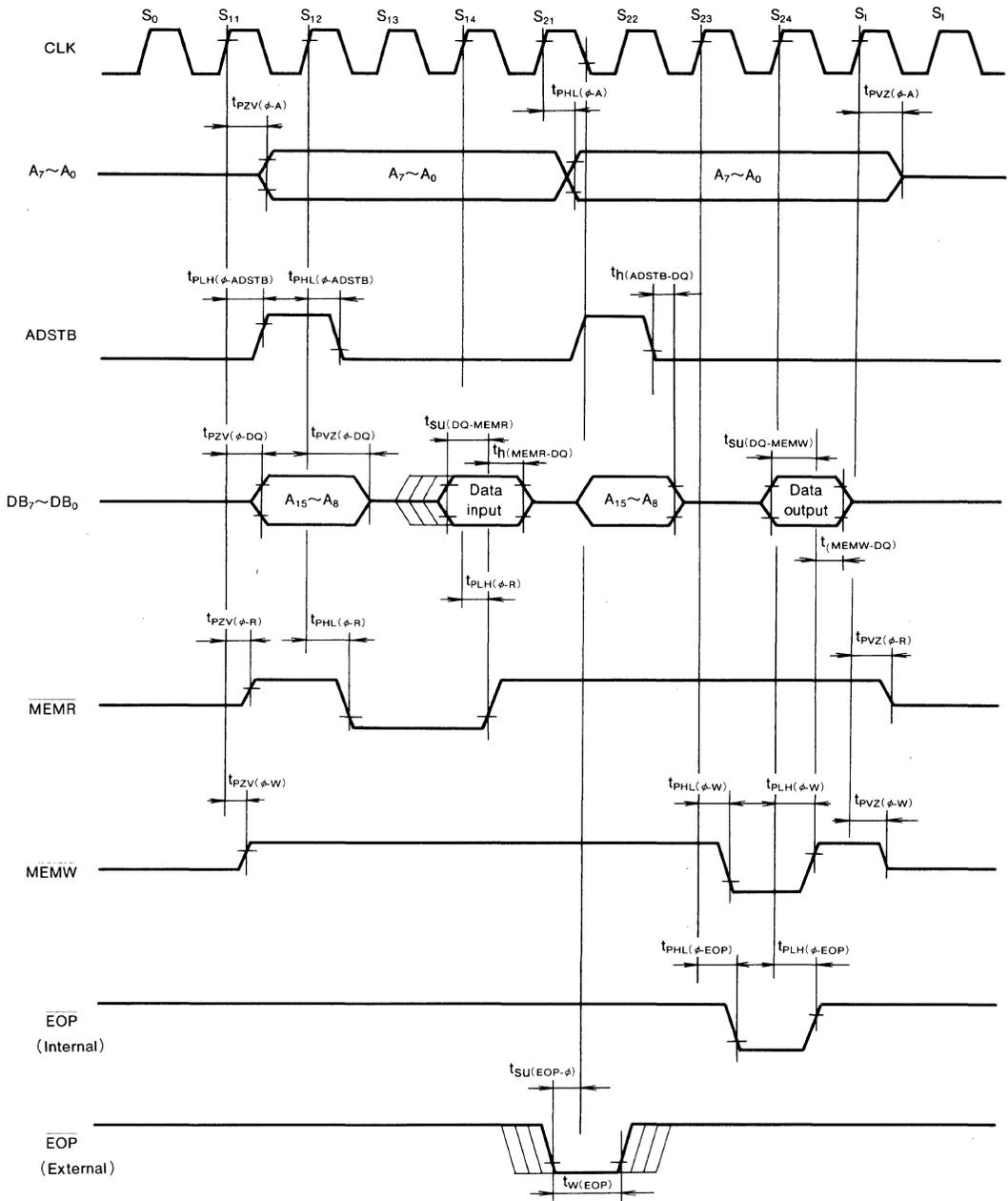
CMOS PROGRAMMABLE DMA CONTROLLER

READY input timing



**CMOS PROGRAMMABLE DMA CONTROLLER**

Inter-memory transmission



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# M5M82C51AP

## CMOS PROGRAMMABLE COMMUNICATION INTERFACE

### DESCRIPTION

The M5M82C51AP is a universal synchronous/asynchronous receiver/transmitter (USART) IC chip designed for data communications use. It is produced using the silicon-gate CMOS process and is mainly used in combination with 8-bit microprocessors.

### FEATURES

- Single 5V supply voltage
- TTL compatible
- Synchronous and asynchronous operation
  - Synchronous:
    - 5~8-bit characters
    - Internal or external synchronization
    - Automatic SYNC character insertion
  - Asynchronous system:
    - 5~8-bit characters
    - Clock rate—1, 16 or 64 times the baud rate
    - 1, 1½, or 2 stop bits
    - False-start-bit detection
    - Automatic break-state detection
- Baud rate: DC~64K-baud
- Full duplex, double-buffered transmitter/receiver
- Error detection: parity, overrun, and framing

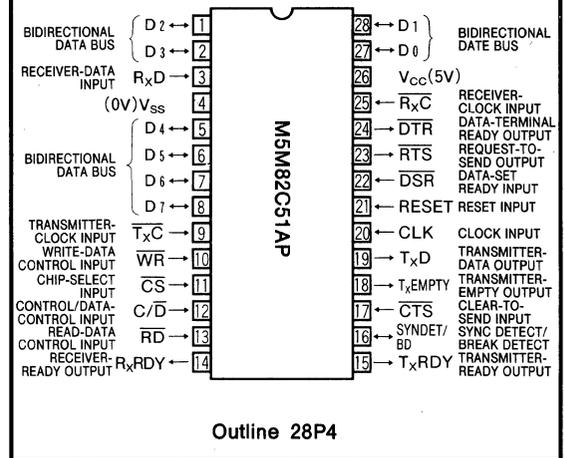
### APPLICATIONS

- Modem control of data communications using micro-computers
- Control of CRT, TTY and other terminal equipment

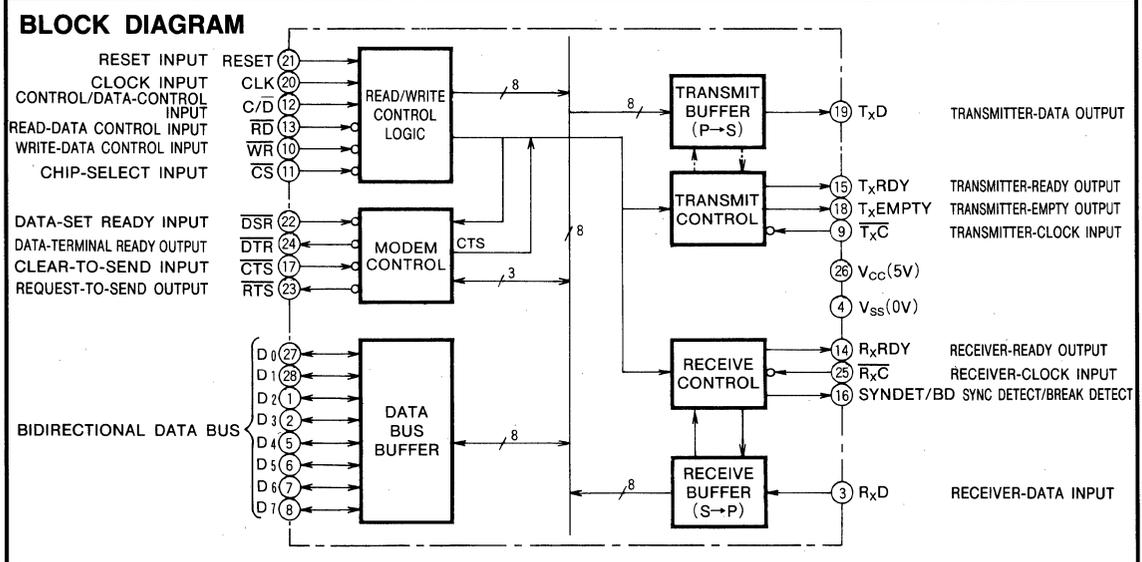
### FUNCTION

The M5M82C51AP is used in the peripheral circuits of a CPU. It permits assignments, by means of software, of operations in all the currently used serial-data transfer systems

### PIN CONFIGURATION (TOP VIEW)



including IBM's 'bi-sync'. The M5M82C51AP receives parallel-format data from the CPU, converts it into a serial format, and then transmits via the TxD pin. It also receives data sent in via the RxD pin from the external circuit, and converts it into a parallel format for sending to the CPU. On receipt of parallel-format data for transmission from the CPU or serial data for the CPU from external devices, the M5M82C51AP informs the CPU using the TxRDY or RxRDY pin. In addition, the CPU can read the M5M82C51AP status at any time. The M5M82C51AP can detect the data received for errors and inform the CPU of the presence of errors as status information. Errors include parity, overrun and frame errors.



**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

**OPERATION**

The M5M82C51AP interfaces with the system bus as shown in Fig.1, positioned between the CPU and the modem or terminal equipment, and offers all the functions required for data communication.

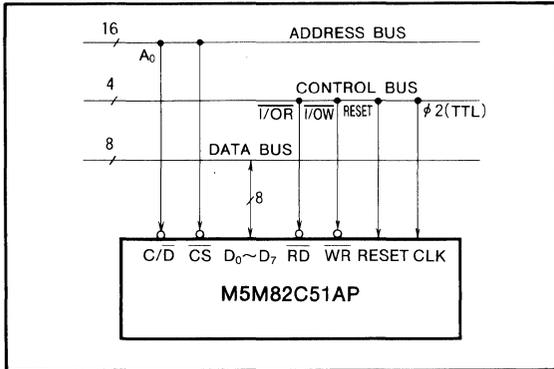


Fig. 1 M5M82C51AP interface to 8080A standard system bus

When using the M5M82C51AP, it is necessary to program, as the initial setting, assignments for synchronous/asynchronous mode selection, baud rate, character length, parity check, and even/odd parity selection in accordance with the communication system used. Once programming is completed, functions appropriate to the communication system can be carried out continuously.

When initial setting of the USART is completed, data communication becomes possible. Though the receiver is always in the enable state, the transmitter is placed in the transmitter-enable state (TxEN) by a command instruction, and the application of a low-level signal to the CTS pin prompts data-transfer start-up. Until this condition is satisfied, transmission is not executed. On receiving data, the receiver informs the CPU that reading for the receiver data in the USART by the CPU has become possible (the RxRDY terminal has turned to '1'). Since data reception and the entry of the CPU into the data-readable state are output as status information, the CPU can assess USART status without accessing the RxRDY terminal.

During receiving operation, the USART checks errors and gives out status information. There are three types of errors: parity, overrun, and frame. Even though an error occurs, the USART continues its operations, and the error state is retained until error reset (ER) is effected by a command instruction. The M5M82C51AP access methods are listed in Table 1.

Table 1 M5M82C51AP Access Methods

C/D	RD	WR	CS	Function
L	L	H	L	Data bus ← Data in USART
L	H	L	L	USART ← Data bus
H	L	H	L	Data bus ← Status
H	H	L	L	Control ← Data bus
X	H	H	L	3-State ← Data bus
X	X	X	H	3-State ← Data bus

**Read/Write Control Logic**

This logic consists of a control word register and command word register. It receives signals from the CPU control bus and generates internal-control signals for the elements.

**Modem Control Circuit**

This is a general-purpose control-signal circuit designed to simplify the interface to the modem. Four types of control signal are available: output signals DTR and RTS are controlled by command instructions, input signal DSR is given to the CPU as status information and input signal CTS controls direct transmission.

**Data-Bus Buffer**

This is an 8-bit 3-state bidirectional bus through which control words, command words, status information, and transfer data are transferred. Fig. 2 shows the structure of the data-bus buffer.

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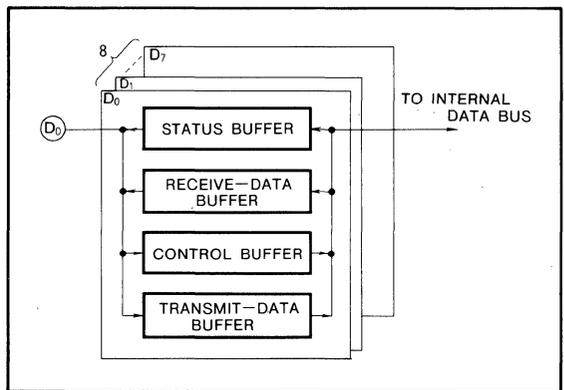


Fig. 2 Data-bus-buffer structure

**Transmit Buffer**

This buffer converts parallel-format data given to the data-bus buffer in to serial data with addition of a start bit, stop bits and a parity bit, and sends out the converted data through the TxD pin based on the control signal.

**Transmit-Control Circuit**

This circuit carries out all the controls required for serial data transmission. It controls transmitter data and outputs the signals required by external devices in accordance with the instructions of the read/write control logic.

**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

**Receive Control Circuit**

This circuit offers all the controls required for normal reception of the input serial data. It controls receiver data and outputs signals for the external devices in accordance with the instructions of the read/write control logic.

**Receive Buffer**

This buffer converts serial data given via the  $R_xD$  pin into a parallel format, checks the bits and characters in accordance with the communication format designated by mode setting, and transfers the assembled characters to the CPU via the data-bus buffer.

**Receiver-Data Input ( $R_xD$ )**

Serial characters sent from another device are input to this pin and converted to a parallel-character format to serve as data for the CPU. Unless the '1' state is detected after a chip-master reset procedure (this resetting is carried out to prevent spurious operation such as that due to faulty connection of the  $R_xD$  to the line in a break state), the serial characters are not received. This applies to only the asynchronous mode. When the  $R_xD$  line enters the low state instantaneously because of noise, etc, the mis-start prevention function starts working. That is, the start bit is detected by its falling edge but in order to make sure that it is the correct start bit, the  $R_xD$  line is strobed at the middle of the start bit to reconfirm the low state. If it is found to be high a faulty-start judgment is made.

**Transmitter-Clock Input ( $T_xC$ )**

This clock controls the baud rate for character transmission from the  $T_xD$  pin. Serial data is shifted by the falling edge of the  $T_xC$  signal. In the synchronous mode, the  $T_xC$  frequency is equal to the actual baud rate. In the asynchronous mode, the frequency is specified as 1, 16, or 64 times the baud rate by the mode setting.

Example When the baud rate is 110 bauds:

$$\overline{T_xC} = 110\text{Hz}(1X)$$

$$\overline{T_xC} = 1.76\text{kHz}(16X)$$

$$\overline{T_xC} = 7.04\text{kHz}(64X)$$

**Write-Data Control Input ( $\overline{WR}$ )**

Data and control words output from the CPU by the lowlevel input are written in the M5M82C51AP. This terminal is usually used in a form connected with the control bus  $\overline{I/O\overline{W}}$  of the CPU.

**Chip-Select Input ( $\overline{CS}$ )**

This is a device-select signal that enables the USART by a low-level input. Usually, it is connected to the address bus directly or via the decoder. When this signal is in the high state, the M5M82C51AP is disabled.

**Control/Data Control Input (C/D)**

This signal shows whether the information on the USART data bus is in the form of data characters or control words, or in the form of status information, in accordance with the  $\overline{RD}$  and  $\overline{WR}$  inputs while the CPU is accessing the M5M82C51AP. The high level identifies control words or status information, and the low level, data characters.

**Read-Data Control Input ( $\overline{RD}$ )**

Receiver data and status information are output from the CPU by a low-level input for the CPU data bus.

**Receiver-Ready Output ( $R_xRDY$ )**

This signal indicates that the received characters have entered the receiver buffer, and further, the receiver-data buffer in the data-bus buffer shown in Fig.2. It is possible to confirm the  $R_xRDY$  status by using this signal as an interruption signal for the CPU or by allowing the CPU to read the  $D_1$  bit of the status information by polling. The  $R_xRDY$  is automatically reset when a character is read by the CPU. Even in the break state in which the  $R_xD$  line is held at low, the  $R_xRDY$  remains active. It can be masked by making the  $R_xE(D_2)$  of the command instruction 0.

**Transmitter-Ready ( $T_xRDY$ )**

This signal shows that the data is ready for transmission. It is possible to confirm the status of serial-data transmission by using it as an interruption signal for the CPU or by allowing the CPU to read the  $D_0$  bit of the status information by polling. Since the  $T_xRDY$  signal shows that the data buffer is empty, it is automatically reset when a transmission character is loaded by the CPU. The  $T_xRDY$  bit of the status information means that the transmit-data buffer shown in Fig.2 has become empty, while the  $T_xRDY$  pin enters the high-level state only when the transmit-data buffer is empty,  $T_xEN$  equals '1', and a lowlevel input has been applied to the CTS pin.

Status ( $D_0$ ): When transmit-data buffer (TDB) is empty, it becomes '1'.

$T_xRDY$  terminal: When (TDB is empty) · ( $T_xEN=1$ ) · (CTS =0)=1 or resetting, it becomes active.

**Sync Detect/Break Detect Output-Input (SYNDET/BD)**

In the synchronous mode this pin is used for input and output operations. When it is specified for the internal synchronous mode by mode setting, this pin works as an output terminal. It enters the high state when a SYNC character is received through the  $R_xD$  pin. If the M5M82C51AP has been programmed for double SYNC characters (bi-sync), a high is entered in the middle of the last bit of the second SYNC character. This signal is automatically reset by reading the status information.

On designation of the M5M82C51AP to the external synchronous mode, this pin begins to serve for input operations. Applying a high signal to this pin prompts the M5M82C51AP to begin assembling data characters at the next rising edge of the  $\overline{R_xC}$ . For the width of a high-level signal to be input, a minimum  $R_xC$  period is required.

Designation of the asynchronous mode causes this pin to function as a BD (output) pin. When the start, data, and parity bits and stop bits are all in the low state for two characters period, a high is entered. The BD (break detect) signal can also be read as the  $D_6$  bit of the status information. This signal is reset by resetting the chip master or by the  $R_xD$  line's recovering the high state.

**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

**Clear-To-Send Input ( $\overline{\text{CTS}}$ )**

When the  $T_x\text{EN}$  bit ( $D_0$ ) of the command instruction has been set to '1' and the  $\overline{\text{CTS}}$  input is low serial data is sent out from the  $T_x\text{D}$  pin. Usually this is used as a clear-to-send signal for the modem.

Note: CTS indicates the modem status as follows:  
 ON means data transmission is possible;  
 OFF means data transmission is impossible.

**Transmitter-Empty Output ( $T_x\text{EMPTY}$ )**

When no transmission characters are left in the transmit buffer, this pin enters the high state. In the asynchronous mode, the following transmission character is shifted to the transmit buffer when it is loaded from the CPU. Thus, it is automatically reset. In the synchronous mode, a SYNC character is loaded automatically on the transmit buffer when no transfer-data characters are left. In this case, however, the  $T_x\text{EMPTY}$  does not enter the low state when a SYNC character has been sent out, since  $T_x\text{EMPTY} = \text{H}$  denotes the state in which there is no transfer character and one or two SYNC characters are being transferred or the state in which a SYNC character is being transferred as a filler.  $T_x\text{EMPTY}$  is unrelated to the  $T_x\text{EN}$  bit of the command instruction.

**Transmission-Data Output ( $T_x\text{D}$ )**

Parallel-format transmission characters loaded on the M5M82C51AP by the CPU are assembled into the format designated by the mode instruction and sent in serial-data form via the  $T_x\text{D}$  pin. Data is output, however, only in cases where the  $D_0$  bit ( $T_x\text{EN}$ ) of the command instruction is '1' and the CTS terminal is in the low state. Once reset, this pin is kept at the mark status (high level) until the first character is sent.

**Clock Input (CLK)**

This system-clock input is required for internal-timing generation and is usually connected to the clock-output (CLK) pin of the 8085A. Although there is no direct relation with the data-transfer baud rate, the clock-input (CLK) frequency is more than 30 times the  $\overline{T_x\text{C}}$  or  $R_x\text{C}$  input frequency in the case of the synchronous system and more than 4.5 times in the case of the asynchronous system.

**Reset Input (RESET)**

Once the USART is shifted to the idle mode by a high-level input, this state continues until a new control word is set. Since this is a master reset, it is always necessary to load a control word following the reset process. The reset input requires a minimum 6-clock pulse width.

**Data-Set Ready Input ( $\overline{\text{DSR}}$ )**

This is a general-purpose input signal, but is usually used as a data-set ready signal to test modem status. Its status can be known from the status reading process. The  $D_7$  bit of the status information equals '1' when the  $\overline{\text{DSR}}$  pin is in the low state, and '0' when in the high state.

$\overline{\text{DSR}} = \text{L} \rightarrow D_7$  bit of status information = 1  
 $\overline{\text{DSR}} = \text{H} \rightarrow D_7$  bit of status information = 0

Note: DSR indicates modem status as follows:

ON means the modem can transmit and receive;  
 OFF means it cannot.

**Request-To-Send Output ( $\overline{\text{RTS}}$ )**

This is a general-purpose output signal but is used as a request-to-send signal for the modem. The RTS terminal is controlled by the  $D_5$  bit of the command instruction. When  $D_5$  is equal to '1',  $\overline{\text{RTS}} = \text{L}$ , and when  $D_5$  is 0,  $\overline{\text{RTS}} = \text{H}$ .

Command register  $D_5 = 1 \rightarrow \overline{\text{RTS}} = \text{L}$   
 Command register  $D_5 = 0 \rightarrow \overline{\text{RTS}} = \text{H}$

Note: RTS controls the modem transmission carrier as follows:

ON means carrier dispatch;  
 OFF means carrier stop.

**Data-Terminal Ready Output ( $\overline{\text{DTR}}$ )**

This is a general-purpose output signal, but is usually used as a data-terminal ready or rate-select signal to the modem. The  $\overline{\text{DTR}}$  pin is controlled by the  $D_1$  bit of the command instruction; if  $D_1 = 1$ ,  $\overline{\text{DTR}} = \text{L}$ , and if  $D_1 = 0$ ,  $\overline{\text{DTR}} = \text{H}$ .

$D_1$  of the command register = 1  $\rightarrow \overline{\text{DTR}} = \text{L}$   
 $D_1$  of the command register = 0  $\rightarrow \overline{\text{DTR}} = \text{H}$

**Receiver-Clock Input ( $R_x\text{C}$ )**

This clock signal controls the baud rate for the sending in of characters via the  $R_x\text{D}$  pin. The data is shifted in by the rising edge of the  $R_x\text{C}$  signal. In the synchronous mode, the  $R_x\text{C}$  frequency is equal to the actual baud rate. In the asynchronous mode, the frequency is specified as 1, 16, or 64 times the baud rate by mode setting. This relationship is parallel to that of  $\overline{T_x\text{C}}$ , and in usual communication-line systems the transmission and reception baud rates are equal. The  $\overline{T_x\text{C}}$  and  $R_x\text{C}$  terminals are, therefore, used connected to the same baud-rate generator.

**PROGRAMMING**

It is necessary for the M5M82C51AP to have the control word loaded by the CPU prior to data transfer. This must always be done following any resetting operation (by external RESET pin or command instruction IR). There are two types of control words: mode instructions specifying general operations required for communications and command instructions to control the M5M82C51AP actual operations.

Following the resetting operation, a mode instruction must be set first. This instruction sets the synchronous or asynchronous system to be used. In the synchronous system, a SYNC character is loaded from the CPU. In the case of the bi-sync system, however, a second SYNC character must be loaded in succession.

Loading a command instruction makes data transfer possible. This operation after resetting must be carried out for initializing the M5M82C51AP. The USART command instruction contains an internal-reset IR instruction ( $D_6$  bit) that makes it possible to return the M5M82C51AP to its reset state. The initialization flowchart is shown in Fig. 3 and the mode-instruction and command-instruction formats are shown in Figs. 4 and 5.

**5**

**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

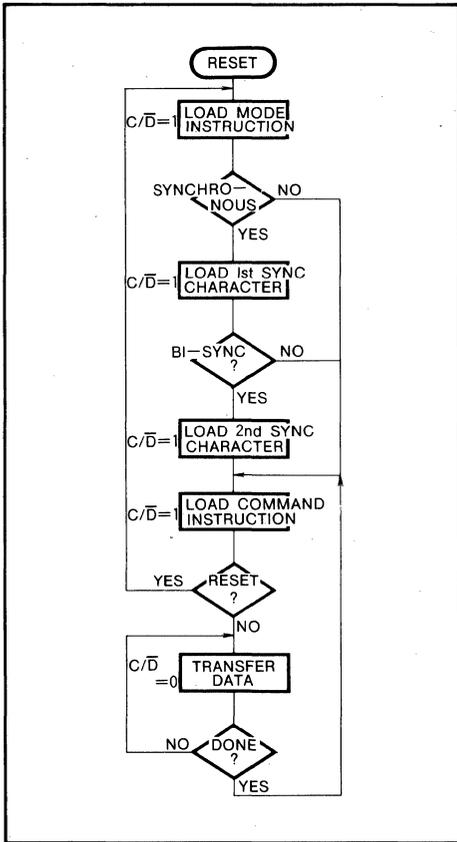


Fig. 3 Initialization flow chart

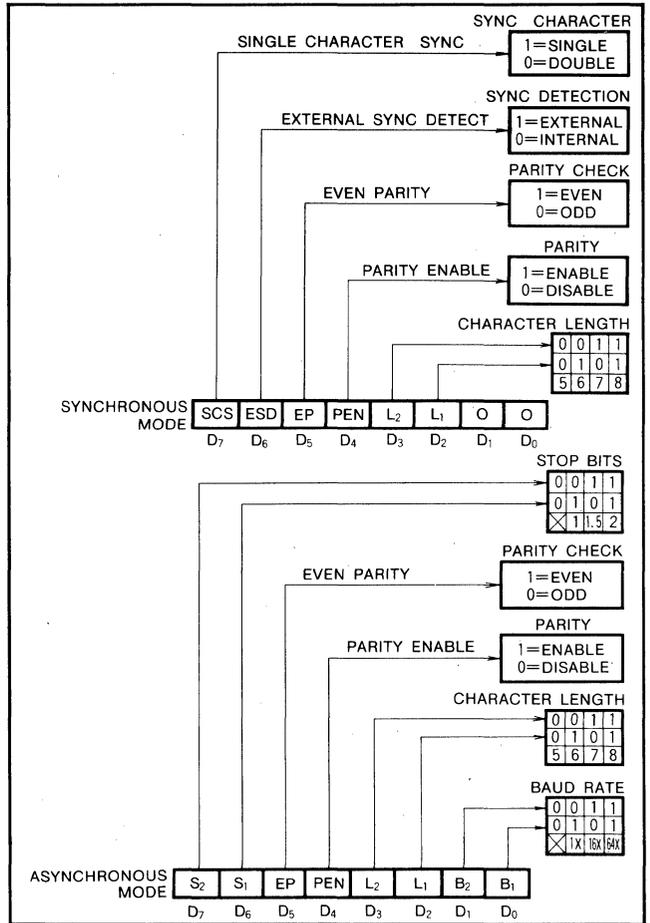


Fig. 4 Mode-instruction format (C/D=1, WR=0)

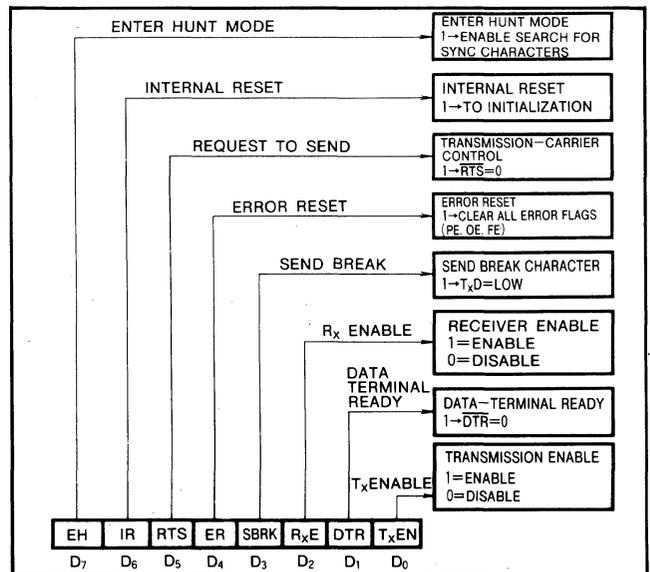


Fig. 5 Command-instruction format (C/D=1, WR=0)

**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

**Asynchronous Transmission Mode**

When data characters are loaded on the M5M82C51AP after initial setting, the USART automatically adds a start bit (low), an odd or even parity bit specified by the mode instruction during initialization, and a specified number of stop bits (high). After that, the assembled data characters are transferred as serial data via the  $T_xD$  pin if, transfer is enabled ( $T_xEN = 1 \cdot \overline{CTS} = L$ ). In this case, the transfer data (baud rate) is shifted by the mode instruction at a rate of 1X, 1/16X, or 1/64X the  $\overline{T_xC}$  period.

If the data characters are not loaded on the M5M82C51AP, the  $T_xD$  pin enters a mark state (high). When SBRK is programmed by the command instruction, break characters (low) are output continuously through the  $T_xD$  pin.

**Asynchronous Reception Mode**

The  $R_xD$  line usually starts operations in a mark state (high), triggered by the falling edge of a low-level pulse when it comes to this line. This signal is again strobed at the middle of the bit to confirm that it is a perfect start bit. The detection of a second low indicates the validity of the start bit (restrobing is carried out only in the case of 16X and 64X). After that, the bit counter inside the M5M82C51AP starts operating; each bit of the serial information on the  $R_xD$  line is shifted in by the rising edge of  $R_xC$ , and the data bit, parity bit (when necessary), and stop bit are sampled at the middle position.

The occurrence of a parity error causes the setting of a parity-error flag. If the stop bit is in the low state, a frame error flag is set. Attention should be paid to the fact that the receiver requires only one stop bit even though the program has designated 1½ or 2 stop bits.

Reception up to the stop bit means reception of a complete character. This character is then transferred to the receiver-data buffer shown in Fig.2, and the  $R_xRDY$  becomes active. In cases where this character is not read by the CPU

and where the next character is transferred to the receiver-data buffer, the preceding character is destroyed and an overrun-error flag is set.

These error flags can be read as the M5M82C51AP status information. The occurrence of an error does not stop USART operations. The error flags are cleared by the ER(D<sub>4</sub> bit) of the command instruction.

The asynchronous-system transfer formats are shown in Figs. 6 and 7.

**Synchronous Transmission Mode**

In this mode the  $T_xD$  pin remains in the high state until initial setting by the CPU is completed. After initialization, the state of  $\overline{CTS} = L$  and  $T_xEN = 1$  enables serial transmission of characters through the  $T_xD$  pin. Then, data characters are sent out and shifted by the falling edge of the  $\overline{T_xC}$  signal. The transmission rate equals the  $\overline{T_xC}$  rate.

Thus, once data-character transfer starts, it must continue through the  $T_xD$  pin at the same rate as that of  $\overline{T_xC}$ . Unless data characters are provided from the CPU before the transmitter buffer becomes empty, one or two SYNC characters are automatically output from the  $T_xD$  pin. In this case, it should be noted that the  $T_xEMPTY$  pin enters the high state when there are no data characters left in the M5M82C51AP to be transferred, and that the low state is not entered until the USART is provided with the next data character from the CPU. Care should also be taken over the fact that merely setting a command instruction does not effect SYNC-character insertion, because the SYNC character insertion is enabled after sending out the first data character.

In this mode, too, break characters are sent out in succession from the  $T_xD$  pin when SBRK is designated ( $D_3 = 1$ ) by a command instruction.

**5**

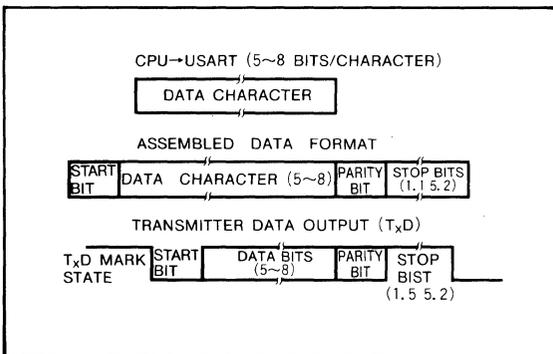


Fig. 6 Asynchronous transmission format I (transmission)

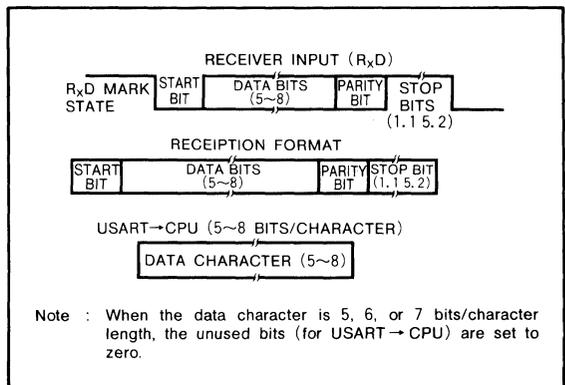


Fig. 7 Asynchronous transmission format II (reception)

**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

**Synchronous Reception Mode**

Character synchronization in this mode is carried out internally or externally by initial-setting designation.

Programming in the internal synchronous mode requires that an EH instruction ( $D_7=1$ , enter hunt mode) is included in the first command instruction. Data on the  $R_xD$  pin is sampled by the rising  $\bar{R}_x\bar{C}$  signal, and the receiver-buffer contents are compared with the SYNC character each time a bit is input. Comparison continues until an agreement is reached. When the M5M82C51AP has been programmed in the bi-sync mode, data received in further succession is compared. The detection of two SYNC characters in succession makes the USART end the hunt mode, setting the SYNDET pin to the high state. This reset operation is prompted by the reading of the status information. When the parity has been programmed, SYNDET is not set in the middle of the last data bit but in the middle of the parity bit.

In the external synchronous mode, the M5M82C51AP gets out of the hunt mode when a high synchronization signal is given to the SYNDET pin. The high signal requires a minimum duration of one  $R_x\bar{C}$  cycle. In the asynchronous mode, however, the EH signal does not affect the operation at all.

Parity and overrun errors are checked in the same way as in the asynchronous system. During hunt-mode operations the parity bit is not checked, but parity checking is carried out even when the receiver is disabled.

The CPU can command the receiver to enter the hunt mode, if synchronization is lost. This prevents the SYNC character from erroneously becoming equal to the received data when all the data in the receiver buffer is set to '1'. Attention should be paid to the fact that the SYNDET F/F is reset each time status information is read irrespective of the synchronous mode's being internal or external. This, howev-

er, does not return the M5M82C51AP to the hunt mode. Synchronism detection is carried out even though it is not the hunt mode. The synchronous transfer formats are shown in Figs. 8 and 9.

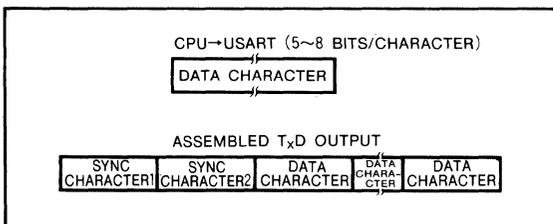
**Command Instruction**

This instruction defines actual operations in the communication mode designated by mode setting. Command instructions include transmitter/receiver enable error-reset, internal-reset, modem-control, enter-hunt and break transmission instructions.

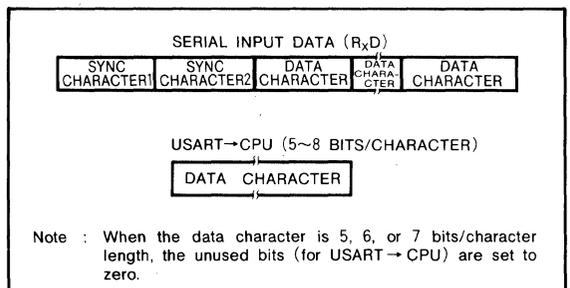
The mode is set following the reset operation. A SYNC character is set as required, and the writing of high-level signals on the control/data pin ( $C/D$ ) that follows it is regarded as a command instruction. When the mode is set all over again from the beginning, the M5M82C51AP can be reset by using inputting via the reset terminal or by internal resetting based on the command instruction.

Note 1: The command error reset (ER), internal reset (IR) and enter-hunt-mode (EH) operations are only effective when the command instruction is loaded, so that these bits need not be returned to '0'.

- 2: When a break character is sent out by a command, the  $T_xD$  enters the low state immediately irrespective of whether or not the USART has sent out data.
- 3: Operations of the USART's receiver section which is always in the enable state cannot be inhibited. The command instruction  $R_xE=0$  does not mean that data reception via the  $R_xD$  pin is inhibited; it means that the  $R_xRDY$  is masked and error flags are inhibited.



**Fig. 8 Synchronous transmission format I (transmission)**



**Fig. 9 Synchronous transmission format II (reception)**

**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

**Status Information**

The CPU can always read USART status by setting the  $\overline{C/D}$  to '1' and  $\overline{RD}$  to '0'.

The status information format is shown in Fig. 10. In this format  $R_xRDY$ ,  $T_xEMPTY$  and  $SYNDET$  have the same definitions as those of the pins. This means that these three pieces of status information become '1' when each pin is in the high state. The other status information is defined as follows:

**DSR:** When the  $\overline{DSR}$  pin is in the low state, status information DSR becomes '1'.

- FE:** The occurrence of a frame error in the receiver section makes the status information FE '1'.
- OE:** The occurrence of an overrun error in the receiver section makes the status information OE '1'.
- PE:** The occurrence of a parity error in the receiver section makes this status information PE '1'.
- $T_xRDY$ :** This information becomes '1' when the transmit data buffer is empty. Be careful because this has a different meaning from the  $T_xRDY$  pin that enters the high state only when the transmitter buffer is empty, when the  $\overline{CTS}$  pin is in the low state, and when  $T_xEN$  is '1'.

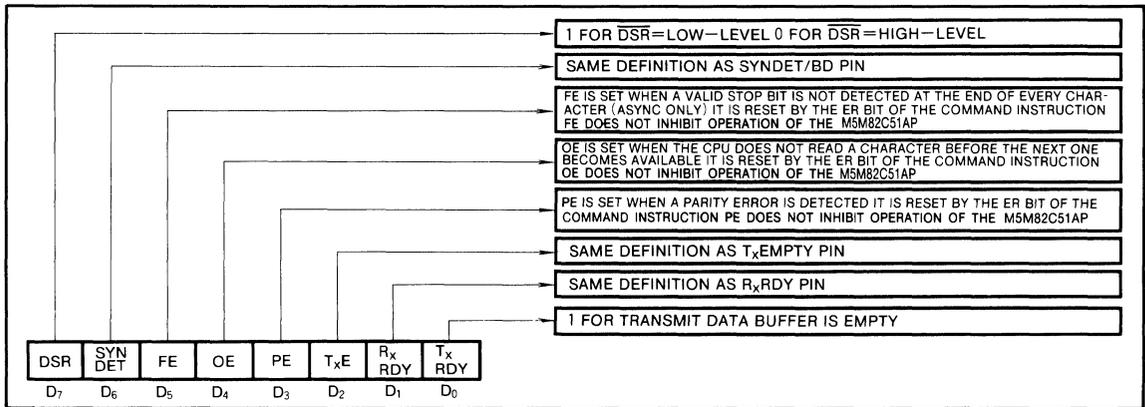


Fig. 10 Status information ( $\overline{C/D}$ =1,  $\overline{RD}$ =0)

**APPLICATION EXAMPLES**

Fig. 11 shows an application example for the M5M82C51AP in the asynchronous mode. When the port addresses of the M5M82C51AP are assumed to be 00 # and 01 # in this figure, initial setting in the asynchronous mode is carried out in the following manner:

```

MVI    A, B6 #    Mode setting
OUT    01 #
MVI    A, 27 #    Command instruction
OUT    01 #
    
```

In this case, the following are set by mode setting:

- Asynchronous mode
- 6 bits/character
- Parity enable (even)
- 1½ stop bits
- Baud rate: 16X

Command instructions set the following

```

RTS=1 →  $\overline{RTS}$  pin=L
 $R_xE$ =1
DTR=1 →  $\overline{DTR}$  pin=L
 $T_xEN$ =1
    
```

When the initial setting is complete, transfer operations are allowed. The  $\overline{RTS}$  pin is initially set to the low-level by setting RTS to '1', and this serves as a CTS input with  $T_xEN$

being equal to '1'. For this reason the same definition applies to the status and pin of  $T_xRDY$ , and '1' is assigned when the transmit-data buffer is empty. Actual transfer of data is carried out in the following way:

```

IN      01 #    Status read
    
```

The IN instruction prompts the CPU to read the USART's status. The result is; if the  $T_xRDY$  equals '1' transmitter data is sent from the CPU and written on the M5M82C51AP. Transmitter data is written in the M5M82C51AP in the following manner:

```

MVI    A, 2D #    2D16 is an example of transmitter data.
OUT    00 #    USART←(A)
    
```

Receiver data is read in the following manner:

```

IN      00 #    (A)←USART
    
```

In the above example, the status information is read and as a result, the transmitter data is written and read. Interruption processing by using the  $T_xRDY$  and  $R_xRDY$  pins is also possible.

Fig. 12 shows the status of the  $T_xD$  pin when data written in the USART is transferred from the CPU. When the data shown in Fig.12 enters the  $R_xD$  pin, data sent from the M5M82C51AP to the CPU becomes 2D<sub>16</sub> and bits D<sub>6</sub> and D<sub>7</sub> are treated as '0'.

**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

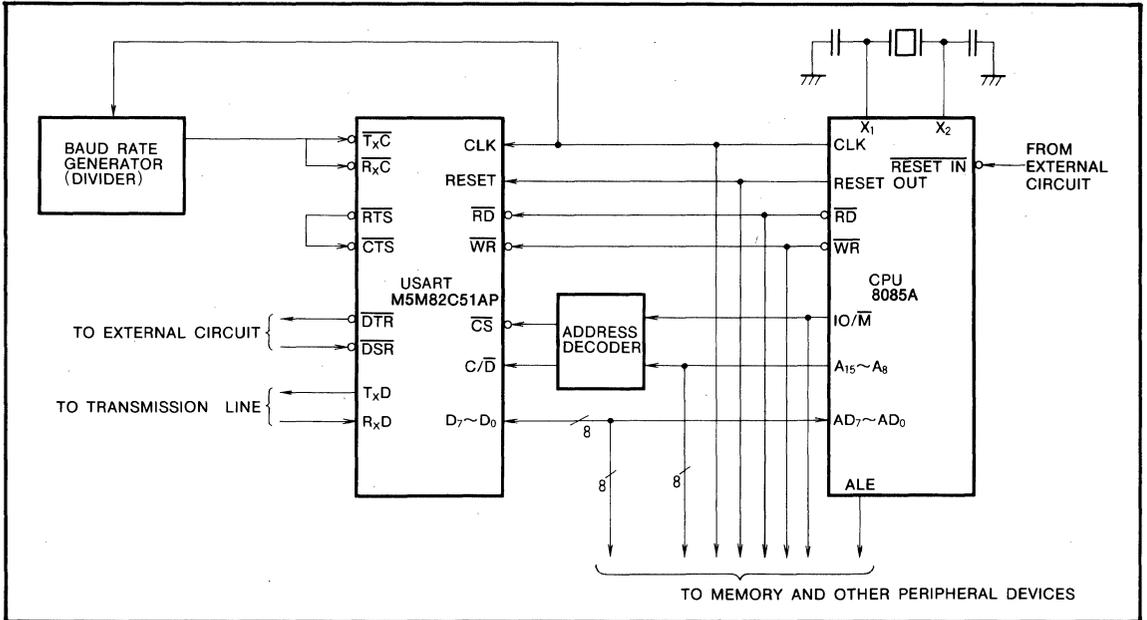


Fig. 11 Example of circuit using the asynchronous mode

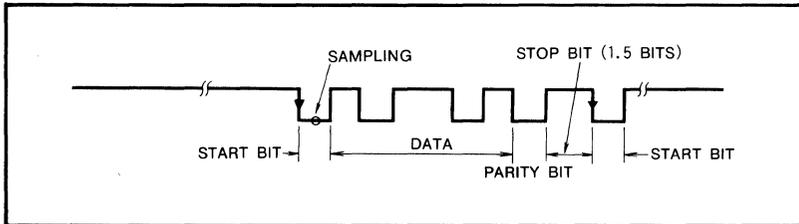


Fig. 12 Example of data transmission

CMOS PROGRAMMABLE COMMUNICATION INTERFACE

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Power-supply voltage	With respect to $V_{SS}$	-0.3~7	V
$V_I$	Input voltage		-0.3~ $V_{CC}+0.3$	V
$V_O$	Output voltage		-0.3~ $V_{CC}+0.3$	V
$T_{opr}$	Operating free-air temperature range		-20~75	°C
$T_{stg}$	Storage temperature range		-65~150	°C

RECOMMENDED OPERATING CONDITIONS ( $T_a = -20 \sim 75^\circ\text{C}$ , unless otherwise noted.)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.5	5	5.5	V
$V_{SS}$	Power-supply voltage		0		V

ELECTRICAL CHARACTERISTICS ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted.)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{IH}$	High-level input voltage		2		$V_{CC}+0.3$	V
$V_{IL}$	Low-level input voltage		-0.3		0.8	V
$V_{OH}$	High-level output voltage	$I_{OH} = -400\mu\text{A}$	2.4			V
$V_{OL}$	Low-level output voltage	$I_{OL} = 2.2\text{mA}$			0.45	V
$I_{CC}$	Supply current from $V_{CC}$				5	mA
$I_{IH}$	High-level input current	$V_I = V_{CC}$	-10		10	$\mu\text{A}$
$I_{IL}$	Low-level input current	$V_I = 0V$	-10		10	$\mu\text{A}$
$I_{OZ}$	Off-state input current	$V_{SS} = 0V$ , $V_I = 0V \sim V_{CC}$	-10		10	$\mu\text{A}$
$C_I$	Input capacitance	$V_{CC} = V_{SS}$ , $f = 1\text{MHz}$ , $25\text{mV}_{rms}$ , $T_a = 25^\circ\text{C}$			10	pF
$C_{I/O}$	Input/output capacitance	$V_{CC} = V_{SS}$ , $f = 1\text{MHz}$ , $25\text{mV}_{rms}$ , $T_a = 25^\circ\text{C}$			20	pF

5

CMOS PROGRAMMABLE COMMUNICATION INTERFACE

TIMING REQUIREMENTS ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted.)

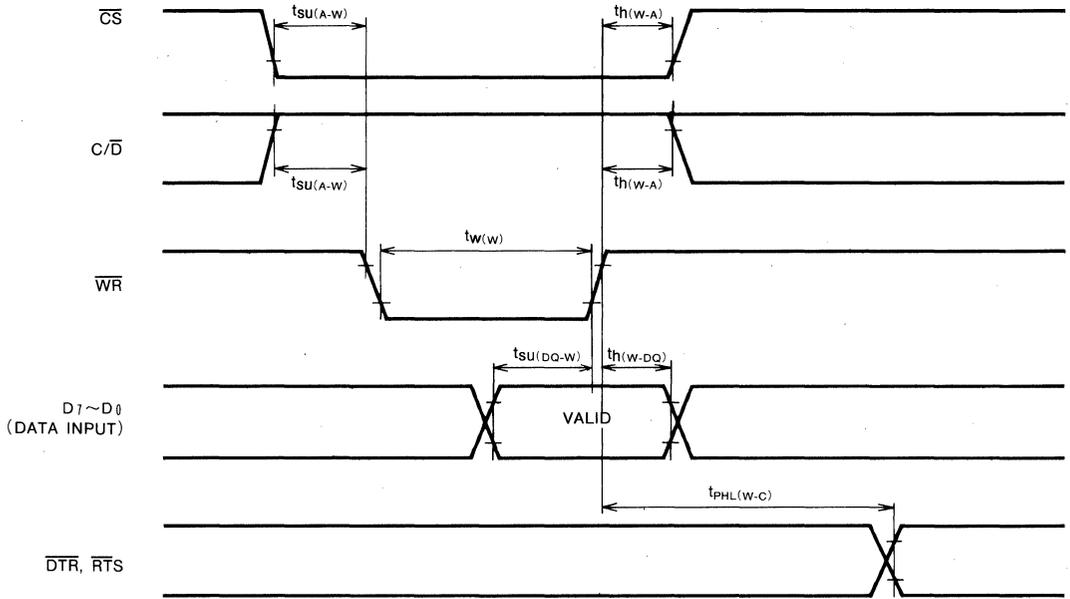
Symbol	Parameter		Alternative Symbol	Test conditions	Limits			Unit
					Min	Typ	Max	
$t_{C(\phi)}$	Clock cycle time (Notes 1, 2)		$t_{CY}$		320		1350	ns
$t_{W(\phi)}$	Clock high pulse width		$t_{\phi}$		120		$t_{C(\phi)} - 90$	ns
$t_{\overline{W}(\phi)}$	Clock low pulse width		$t_{\overline{\phi}}$		90			ns
$t_r$	Clock rise time		$t_r$				20	ns
$t_f$	Clock fall time		$t_f$				20	ns
$f_{TX}$	Transmitter input clock frequency	1X baud rate	$f_{TX}$		DC		64	KHz
		16X baud rate	$f_{TX}$		DC		310	KHz
		64X baud rate	$f_{TX}$		DC		615	KHz
$t_{W(TPWL)}$	Transmitter input clock low pulse width	1X baud rate	$t_{TPW}$		12			$t_{C(\phi)}$
		16X, 64X baud rate	$t_{TPW}$		1			$t_{C(\phi)}$
$t_{W(TPWH)}$	Transmitter input clock high pulse width	1X baud rate	$t_{TPD}$		15			$t_{C(\phi)}$
		16X, 64X baud rate	$t_{TPD}$		3			$t_{C(\phi)}$
$f_{RX}$	Receiver input clock frequency	1X baud rate	$f_{RX}$		DC		64	KHz
		16X baud rate	$f_{RX}$		DC		310	KHz
		64X baud rate	$f_{RX}$		DC		615	KHz
$t_{W(RPWL)}$	Receiver input clock low pulse width	1X baud rate	$t_{RPW}$		12			$t_{C(\phi)}$
		16X, 64X baud rate	$t_{RPW}$		1			$t_{C(\phi)}$
$t_{W(RPWH)}$	Receiver input clock high pulse width	1X baud rate	$t_{RPO}$		15			$t_{C(\phi)}$
		16X, 64X baud rate	$t_{RPO}$		3			$t_{C(\phi)}$
$t_{SU(A-R)}$	Address setup time before read ( $\overline{CS}$ , C/D) (Note 3)		$t_{AR}$		0			ns
$t_{H(R-A)}$	Address hold time after read ( $\overline{CS}$ , C/D) (Note 3)		$t_{RA}$		0			ns
$t_{W(R)}$	Read pulse width		$t_{RR}$		250(200)			ns
$t_{SU(A-W)}$	Address setup time before write		$t_{AW}$		0			ns
$t_{H(W-A)}$	Address hold time after write		$t_{WA}$		0			ns
$t_{W(W)}$	Write pulse width		$t_{WW}$		250(200)			ns
$t_{SU(DO-W)}$	Data setup time before write		$t_{DW}$		150(100)			ns
$t_{H(W-DO)}$	Data hold time after write		$t_{WO}$		20(0)			ns
$t_{SU(ESO-AxC)}$	ESYNDET setup time before $R_xC$		$t_{ES}$		18			$t_{C(\phi)}$
$t_{SU(C-R)}$	Control setup time before read		$t_{CR}$		20			$t_{C(\phi)}$
$t_{RV}$	Write recovery time between writes (Note 4)		$t_{RV}$		6			$t_{C(\phi)}$
$t_{SU(RxD-IS)}$	$R_xD$ setup time before internal sampling pulse		$t_{SRx}$		2			$\mu\text{s}$
$t_{H(IS-RxD)}$	$R_xD$ hold time after internal sampling pulse		$t_{HRx}$		2			$\mu\text{s}$

- Note 1 : The  $T_xC$  and  $R_xC$  frequencies have the following limitations with respect to CLK.  
 For 1X baud rate  $f_{TX}$ ,  $f_{RX} \leq 1/(30t_{C(\phi)})$ . For 16X, 64X baud rate  $f_{TX}$ ,  $f_{RX} \leq 1/(4.5t_{C(\phi)})$   
 2 : Reset pulse width =  $6t_{C(\phi)}$  minimum. System clock must be running during reset.  
 3 :  $\overline{CS}$ , C/D are considered as address.  
 4 : This recovery time is for mode initialization only. Write data is allowed only when  $T_xRDY=1$ . Recovery time between writes for asynchronous mode is  $8t_{C(\phi)}$ , and that for synchronous mode is  $16t_{C(\phi)}$ .

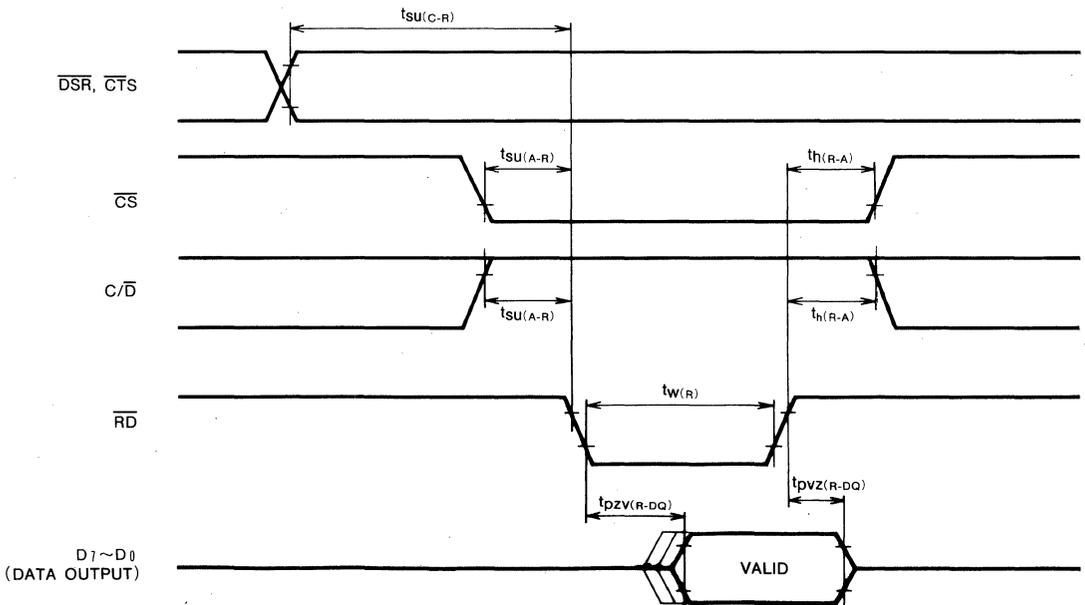


**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

**Write control cycle (CPU→USART)**

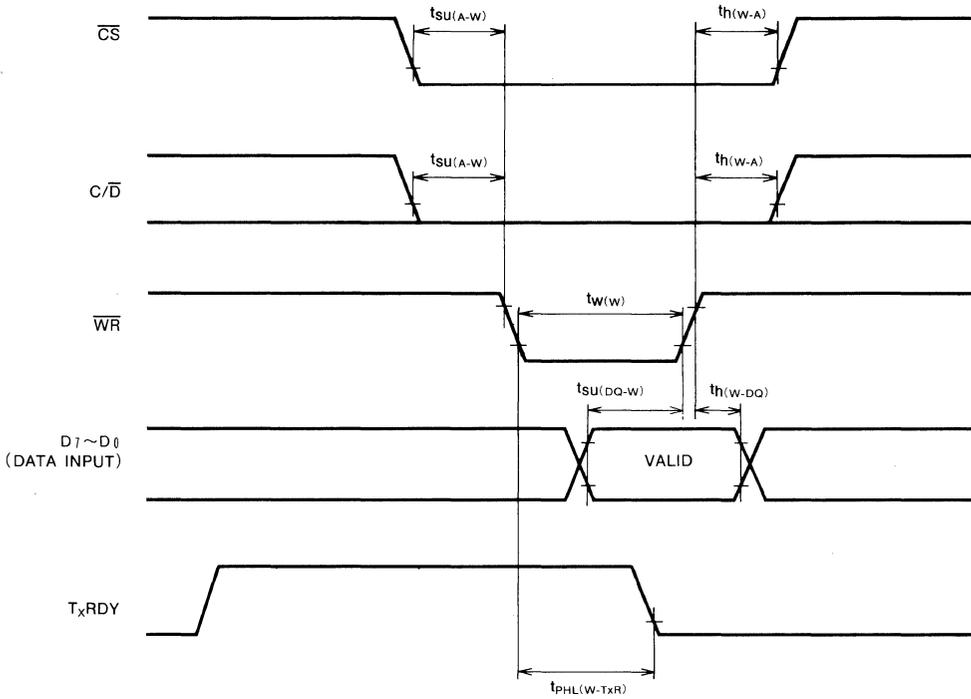


**Read control cycle (USART→CPU)**

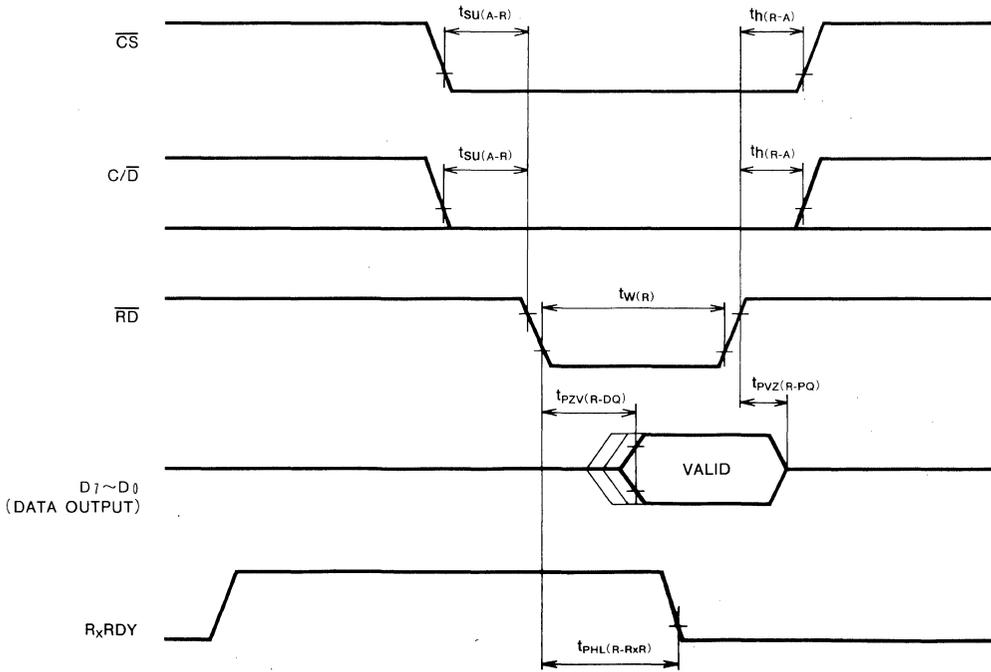


**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

**Write data cycle (CPU→USART)**



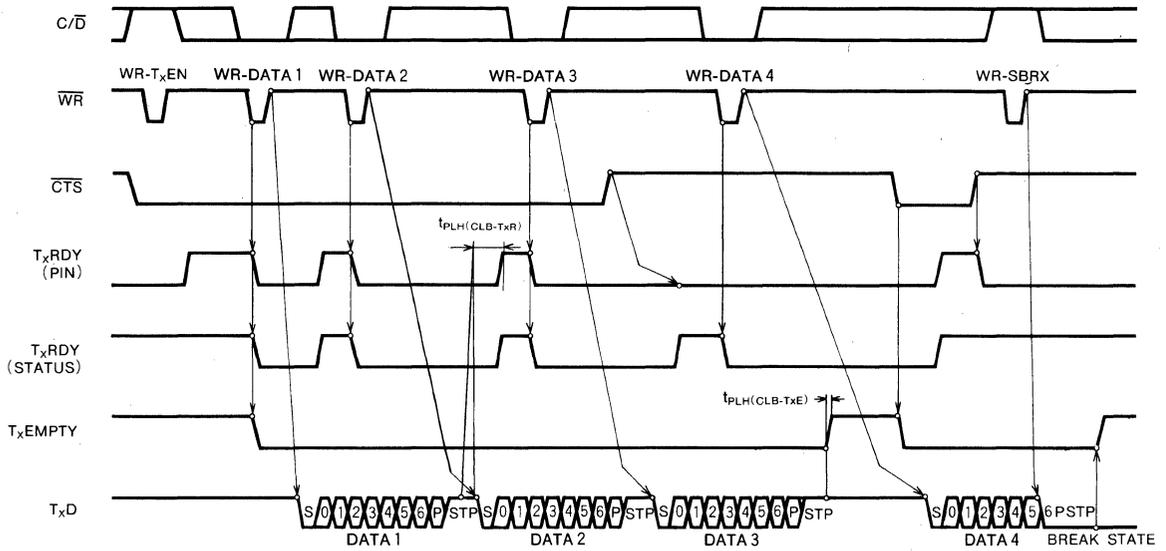
**Read data cycle (USART→CPU)**



5

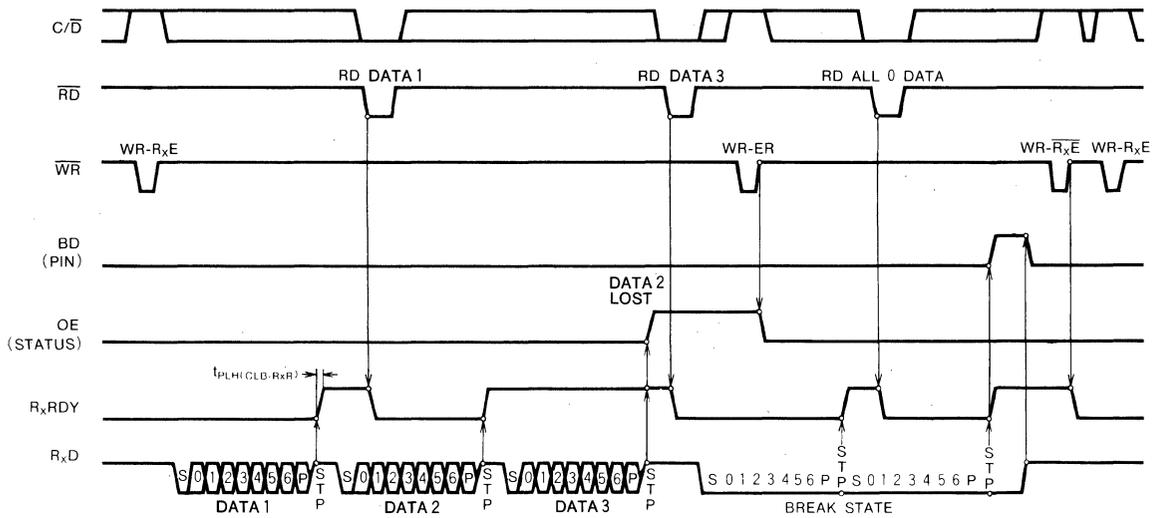
**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

**Transmitter control & flag timing (async mode)**



- Note 8: Example format = 7 bits/character with parity & 2 stop bits  
 9: TxRDY(pin) = 1 ← (Transmit-data buffer is empty) · (TxEN = 1) · (CTS = 0) = 1  
 10: TxRDY(status) = 1 ← (Transmit-data buffer is empty) = 1

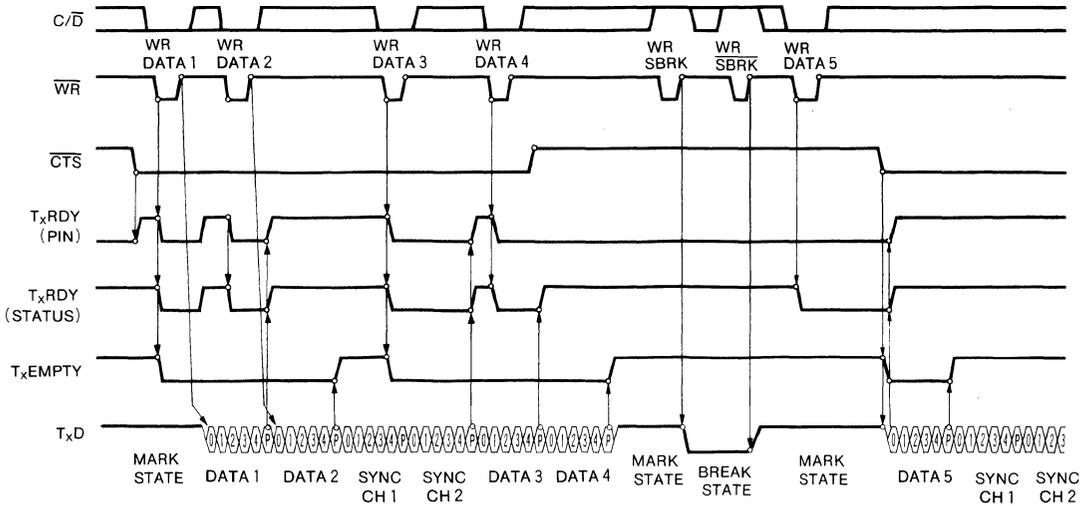
**Receiver control & flag timing (async mode)**



- Note11: Example format = 7 bits/character with parity

**CMOS PROGRAMMABLE COMMUNICATION INTERFACE**

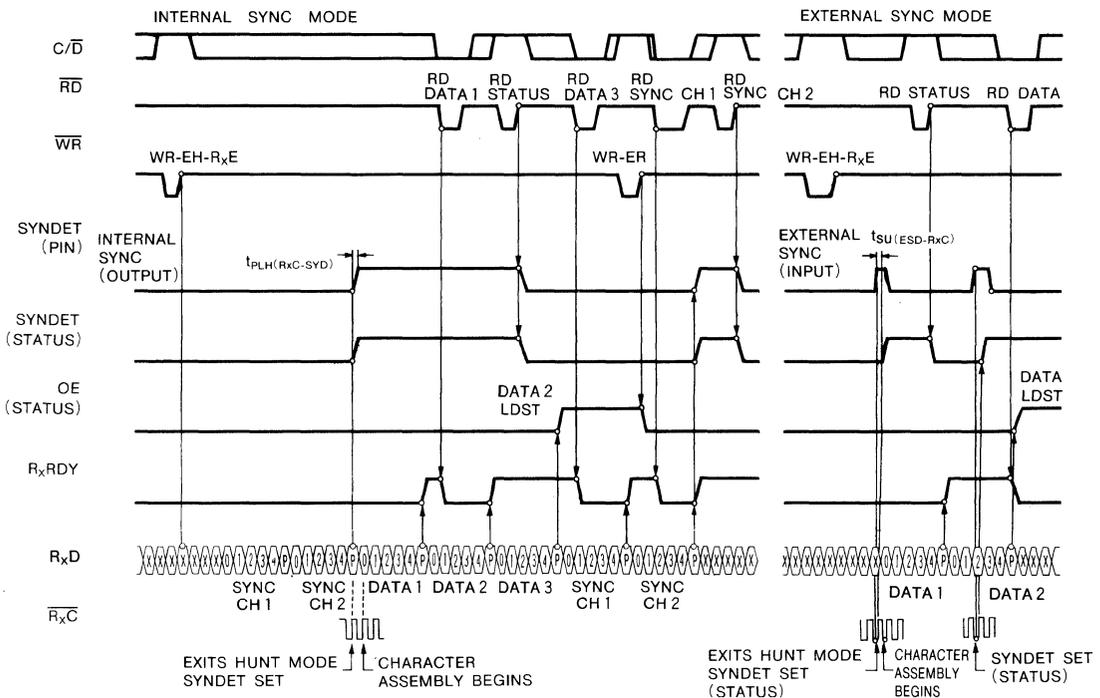
**Transmitter control & flag timing (sync mode)**



Note12: Example format = 5 bits/character with parity, bi-sync characters.

**5**

**Receiver control & flag timing (sync mode)**



Note13: Example format = 5 bits/character with parity, bi-sync characters.

**PRELIMINARY**  
 Notice: This is not a final specification. Some parametric limits are Subject to change.

MITSUBISHI LSIs

# M5M82C51AFP

## CMOS PROGRAMMABLE COMMUNICATION INTERFACE

### DESCRIPTION

The M5M82C51AFP is a universal synchronous/asynchronous receiver/transmitter (USART) IC chip designed for data communications use. It is produced using the silicon-gate CMOS process and is mainly used in combination with 8-bit microprocessors.

### FEATURES

- Single 5V supply voltage
- TTL compatible
- Synchronous and asynchronous operation
  - Synchronous:
    - 5~8-bit characters
    - Internal or external synchronization
    - Automatic SYNC character insertion
  - Asynchronous system:
    - 5~8-bit characters
    - Clock rate—1, 16 or 64 times the baud rate
    - 1, 1½, or 2 stop bits
    - False-start-bit detection
    - Automatic break-state detection
- Baud rate: DC~64K-baud
- Full duplex, double-buffered transmitter/receiver
- Error detection: parity, overrun, and framing

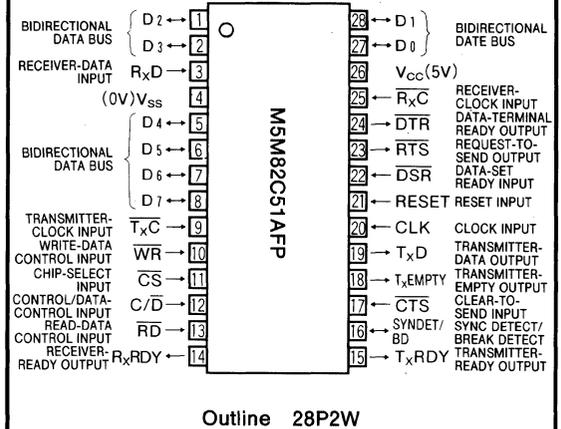
### APPLICATIONS

- Modem control of data communications using micro-computers
- Control of CRT, TTY and other terminal equipment

### FUNCTION

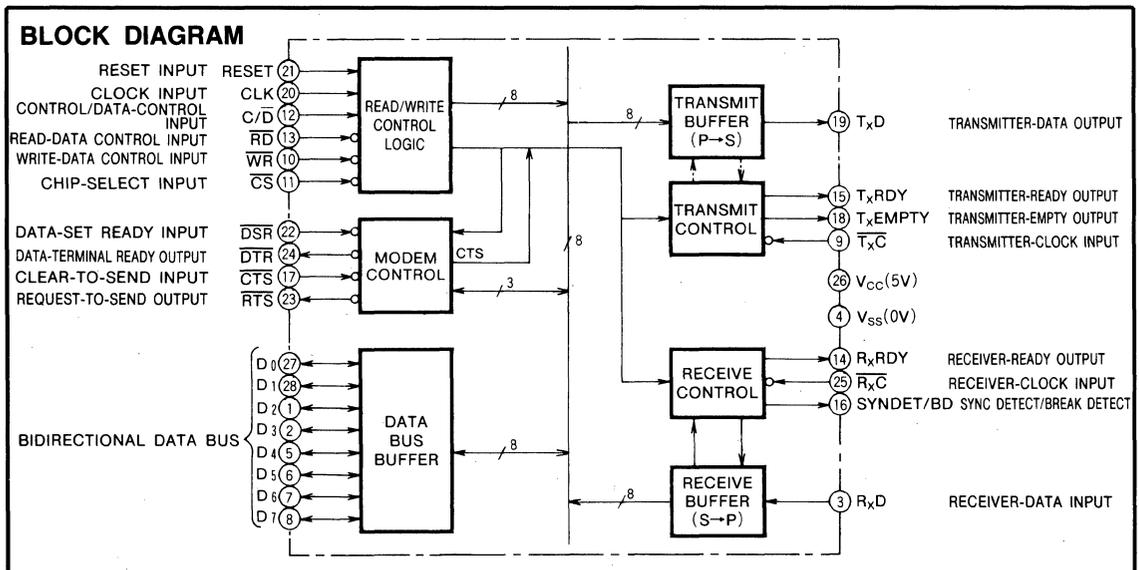
The M5M82C51AFP is used in the peripheral circuits of a CPU. It permits assignments, by means of software, of operations in all the currently used serial-data transfer systems including IBM's 'bi-sync'. The M5M82C51AFP receives para-

### PIN CONFIGURATION (TOP VIEW)



llel-format data from the CPU, converts it into a serial format, and then transmits via the TxD pin. It also receives data sent in via the RxD pin from the external circuit, and converts it into a parallel format for sending to the CPU. On receipt of parallel-format data for transmission from the CPU or serial data for the CPU from external devices, the M5M82C51AFP informs the CPU using the TxD RDY or RxD RDY pin. In addition, the CPU can read the M5M82C51AFP status at any time. The M5M82C51AFP can detect the data received for errors and inform the CPU of the presence of errors as status information. Errors include parity, overrun and frame errors.

M5M82C51AFP is different from M5M82C51AP only in the package outline. Refer to the M5M82C51AP for more details.



**PRELIMINARY**  
 Notice: This is not a final specification. Some parameter limits are subject to change.

**MITSUBISHI LSIs**  
**M5M82C54P,-6**

**CMOS PROGRAMMABLE INTERVAL TIMER**

**DESCRIPTION**

The M5M82C54P is a programmable general-purpose timer device developed by using the silicon-gate CMOS process. It offers counter and timer functions in systems using an 8-bit parallel-processing CPU. The use of the M5M82C54P frees the CPU from the execution of looped programs, count-operation programs and other simple processing involving many repetitive operations, thus contributing to improved system throughputs. The M5M82C54P works on a single power supply, and both its input and output can be connected to a TTL circuit.

Parameter	M5M82C54P	M5M82C54P-6
Clock high pulse width	60ns	55ns
Clock low pulse width	60ns	110ns
Clock cycle time	125ns	165ns
Propagation time from read to output	120ns	170ns

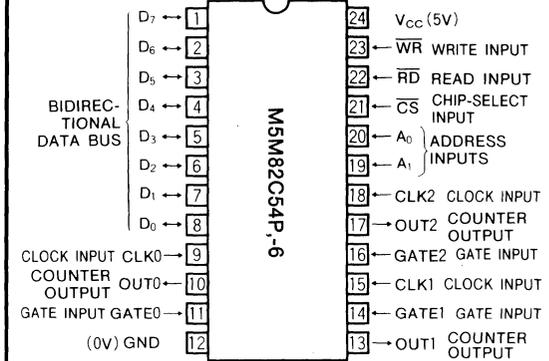
**FEATURES**

- Single 5V supply voltage
- TTL compatible
- Pin connection compatible with M5L8253P-5
- Clock period : M5M82C54P-6 ..... DC~6MHz  
 M5M82C54P ..... DC~8MHz
- 3 independent built-in 16-bit down counters
- 6 counter modes freely assignable for each counter
- Binary or decimal counts
- Read-back command for monitoring the count and status

**APPLICATION**

Delayed-time setting, pulse counting and rate generation in microcomputers.

**PIN CONFIGURATION (TOP VIEW)**



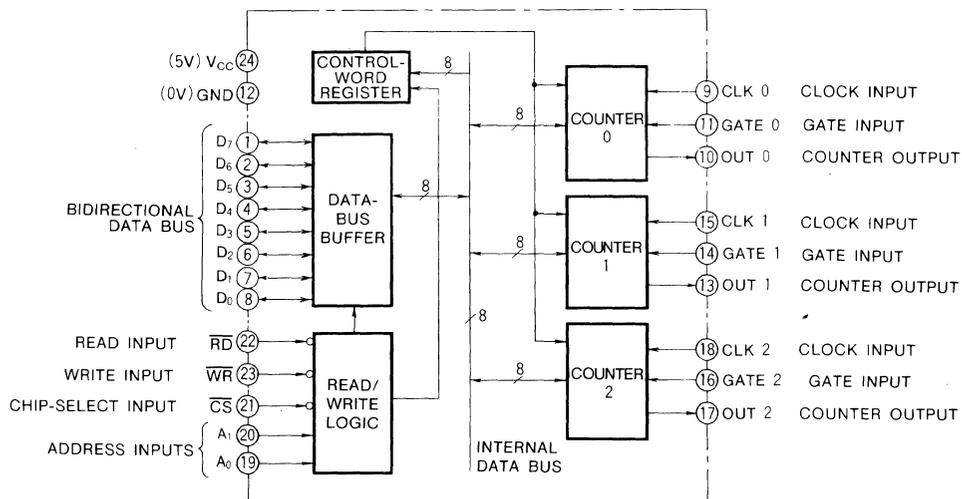
Outline 24P4

**FUNCTION**

Three independent 16-bit counters allow free programming based on mode-control instructions from the CPU. When roughly classified, there are 6 modes (0~5). Mode 0 is mainly used as an interruption timer and event counter, mode 1 as a digital one-shot, modes 2 and 3 as rate generators, mode 4 for a software triggered strobe, and mode 5 for a hardware triggered strobe.

The count can be monitored and set at any time. Besides the count, the status of the counter can be monitored by Read-back command. The counter operates with either the binary or BCD system.

**BLOCK DIAGRAM**



**5**

## DESCRIPTION OF FUNCTIONS

### Data-Bus Buffer

This 3-state, bidirectional, 8-bit buffer is used to interface the M5M82C54P to the system-side data bus. Transmission and reception of all the data including control words for mode designation and values written in, and read from, the counters are carried out through this buffer.

### Read/Write Logic

The read/write logic accepts control signals ( $\overline{RD}$ ,  $\overline{WR}$ ) from the system and generates control signals for each counter. It is enabled or disabled by the chip-select signal ( $\overline{CS}$ ); if  $\overline{CS}$  is at the high-level the data-bus buffer enters a floating (high-impedance) state.

### Read Input ( $\overline{RD}$ )

The count of the counter designated by address inputs  $A_0$  and  $A_1$  on the low-level is output to the data bus.

### Write Input ( $\overline{WR}$ )

Data on the data bus is written in the counter or controlword register designated by address inputs  $A_0$  and  $A_1$  on the low-level.

### Address Inputs ( $A_0, A_1$ )

These are used for selecting one of the 3 internal counters and either of the control-word registers.

### Chip-Select Input ( $\overline{CS}$ )

A low-level on this input enables the M5M82C54P. Changes in the level of the  $\overline{CS}$  input have no effect on the operation of the counters.

### Control-Word Register

This register stores information required to give instructions about operational modes and to select binary or BCD counting. Unlike the counters, it allows no reading, only writing.

### Counters 0,1 and 2

These counters are identical in operation and independent of each other. Each is a 16-bit, presetable, down counter, and has clock-input, gate-input and output pins. The counter can operate in either binary or BCD using the falling edge of each clock. The mode of counter operation and the initial value from which to start counting can be designated by software. The count can be read by input instruction at any time, and there is a "read-on-the-fly" function which enables stable reading by latching each instantaneous count to the registers by a special counter-latch instruction.

## CONTROL WORD AND INITIAL-VALUE LOADING

The function of the M5M82C54P depends on the system software. The operational mode of the counters can be specified by writing control words ( $A_0, A_1 = 1, 1$ ) into the control-word registers.

The programmer must write out to the M5M82C54P the programmed number of count register bytes (1 or 2) prior to actually using the selected counter.

Table 2 shows control-word format, which consists of 4 fields. Only the counter selected by the  $D_7$  and  $D_6$  bits of the control word is set for operation. Bits  $D_5$  and  $D_4$  are used for specifying operations to read values in the counter and to initialize. Bits  $D_3 \sim D_1$  are used for mode designation, and  $D_0$  for specifying binary or BCD counting. When  $D_0 = 0$ , binary counting is employed, and any number from  $0000_{16}$  to  $FFFF_{16}$  can be loaded into the count register. The counter is counted down for each clock. The counting of  $0000_{16}$  causes the transmission of a time-out signal from the count-output pin.

The maximum number of counts is obtained when  $0000_{16}$  is set as the initial value. When  $D_0 = 1$ , BCD counting is employed, and any number from  $0000_{10}$  to  $9999_{10}$  can be loaded on the counter.

Neither system resetting nor connecting to the power supply sets the control word to any specific value. Thus to bring the counters into operation, the above-mentioned control words for mode designation must be given to each counter, and then 1~2 byte initial counter values must be set. The following is an example of this programming step.

To designate mode 0 for counter 1, with initial value  $8253_{16}$  set by binary count, the following program is used:

```

MVI  A, 7016   Control word 7016
OUT  n1        n1 is control-word-register address
MVI  A, 5316   Low-order 8 bits
OUT  n2        n2 is counter 1 address
MVI  A, 8216   High-order 8 bits
OUT  n2        n2 is counter 1 address
    
```

Thus, the program generally has the following sequence:

- (1) Control-word output to counter  $i$  ( $i=0, 1, 2$ ).
- (2) Initialization of low-order 8 counter bits
- (3) Initialization of high-order 8 counter bits

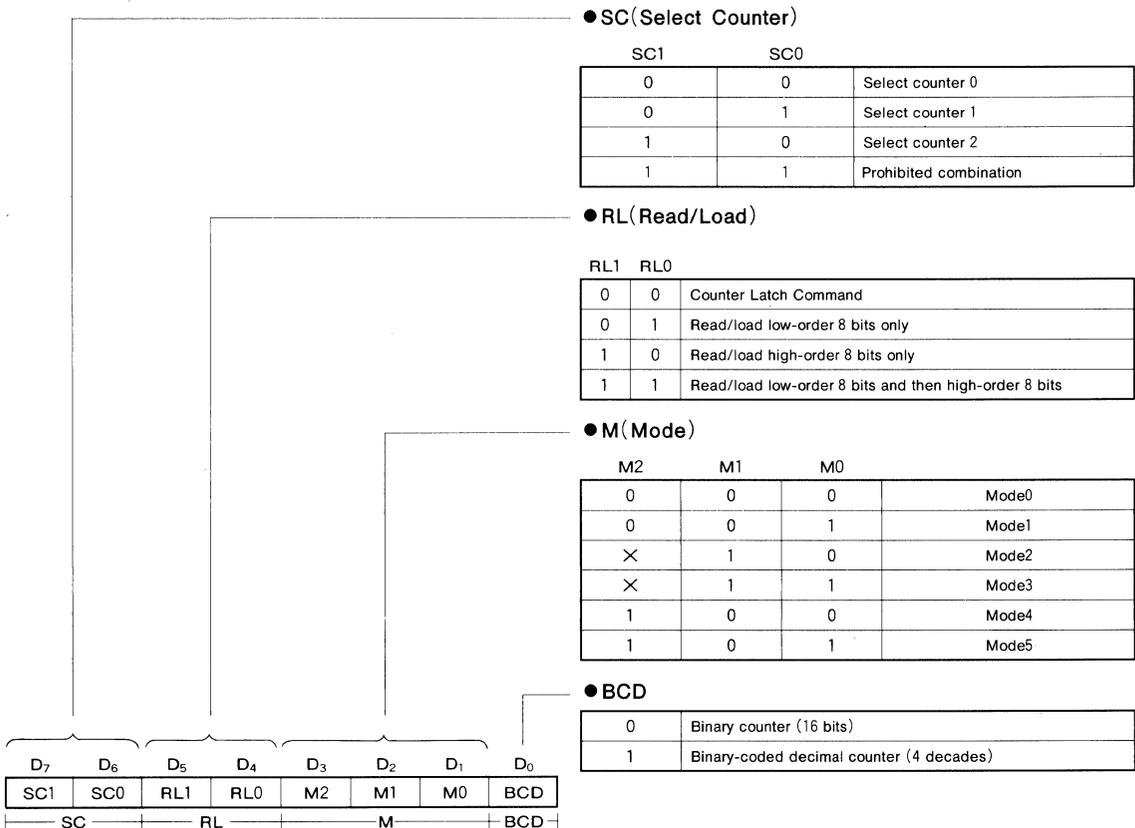
The three counters can be executed in any sequence. It is possible, for instance, to designate the mode of each counter and then load initial values in a different order. Initialization of the counters designated by RL 1 and RL 0 must be executed in the order of the low-order 8 bits and then the high-order 8 bits for the counter in question.

**CMOS PROGRAMMABLE INTERVAL TIMER**

Table 1 Basic Functions

$\overline{CS}$	$\overline{RD}$	$\overline{WR}$	$A_1$	$A_0$	Function
0	1	0	0	0	Data bus→Counter 0
0	1	0	0	1	Data bus→Counter 1
0	1	0	1	0	Data bus→Counter 2
0	1	0	1	1	Data bus→Control-word register
0	0	1	0	0	Data bus←Counter 0
0	0	1	0	1	Data bus←Counter 1
0	0	1	1	0	Data bus←Counter 2
0	0	1	1	1	3-state
1	X	X	X	X	3-state
0	1	1	X	X	3-state

Table 2 Control-Word Format



5

**CMOS PROGRAMMABLE INTERVAL TIMER**

**MODE DEFINITION**

**Mode 0 (Interrupt on Terminal Count)**

Mode set and initialization cause the counter output to go low-level (see Fig. 1). When the counter is loaded with an initial value, it will start counting the clock input. When the terminal count is reached, the output will go high and remain high until the selected count register is reloaded with the mode. This mode can be used when the CPU is to be interrupted after a certain period or at the time of counting up.

Fig. 1 shows a setting of 4 as the initial value. If gate input goes low, counting is inhibited for the duration of the low-level period.

Reloading of the initial value during count operation will stop counting by the loading of the first byte and start the new count by the loading of the second byte.

**Mode 1 (Programmable One-Shot)**

The gate input functions as a trigger input. A gate-input rising edge causes the generation of low-level one-shot output with a predetermined clock length starting from the next clock. Fig. 2 shows an initial setting of 4. While the counter output is at the low-level (during one-shot), loading of a new value does not change the one-shot pulse width, which has already been output. The current count can be read at any time without affecting the width of the one-shot pulse being output. This mode permits retriggering.

**Mode 2 (Rate Generator)**

Low-level pulses during one clock operation are generated from the counter output at a rate of one per  $n$  clock inputs (where  $n$  is the value initially set for the counter). When a new value is loaded during the counter operation, it is reflected on the output after the pulses by the current count have been output. In the example shown in Fig. 3,  $n$  is given as 4 at the outset and is then changed to 3.

In this mode, the gate input provides a reset function. While it is on the low-level, the output is maintained high; the counter restarts from the initial value, triggered by a rising gate-input edge. This gate input, therefore, makes possible external synchronization of the counter by hardware.

After the mode is set, the counter does not start counting until the rate  $n$  is loaded into the count register, with the counter output remaining at the high-level.

**Mode 3 (Square Rate Generator)**

This is similar to Mode 2 except that it outputs a square wave with the half count of the set rate. When the set value  $n$  is odd, the square-wave output will be high for  $(n+1)/2$  clock-input counts and low for  $(n-1)/2$  counts. When a new rate is reloaded into the count register during its operation, it is immediately reflected on the count directly following the output transition (high-to-low or low-to-high) of the current count. Gate-input operations are exactly the same as in Mode 2. Fig. 4 shows an example of Mode 3 operation.

**Mode 4 (Software Triggered Strobe)**

After the mode is set, the output will be high. By loading a

number on the counter, however, clock-input counts can be started and on the terminal count, the output will go low for one input-clock period and then will go high again. Mode 4 differs from Mode 2 in that pulses are not output repeatedly with the same set count. The pulse output is delayed one clock period in Mode 2, as shown in Fig. 5. When a new value is loaded into the count register during its count operation, it is reflected on the next pulse output without affecting the current count. The count will be inhibited while the gate input is low-level.

**Mode 5 (Hardware Triggered Strobe)**

This is a variation of Mode 1. The gate input provides a trigger function, and the count is started by its rising edge. On the terminal count, the counter output goes low for on one clock period and then goes high. As in Mode 1, retriggering by the gate input is possible. An example of timing in Mode 5 is shown in Fig. 6.

As mentioned above, the gate input plays different roles according to the mode. The functions are summarized in Table 3.

**Table 3 Gate Operations**

Gate Mode	Low or going low	Rising	High
0	Disables counting		Enables counting
1		(1) Initiates counting (2) Resets output after next clock	
2	(1) Disables counting (2) Sets output high immediately	(1) Reloads counter (2) Initiates counting	Enables counting
3	(1) Disables counting (2) Sets output high immediately	(1) Reloads counter (2) Initiates counting	Enables counting
4	Disables counting		Enables counting
5		Initiates counting	

**CMOS PROGRAMMABLE INTERVAL TIMER**

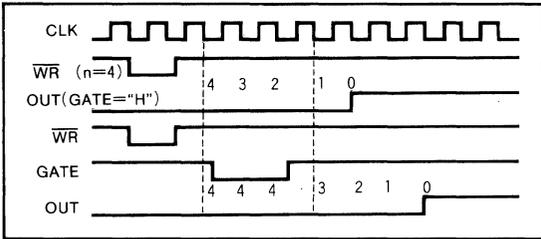


Fig. 1 Mode 0

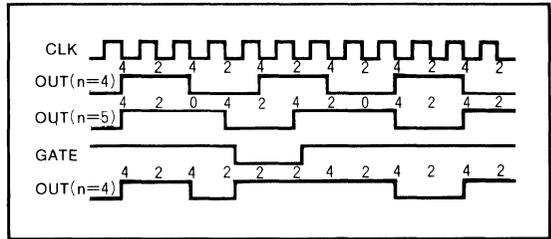


Fig. 4 Mode 3

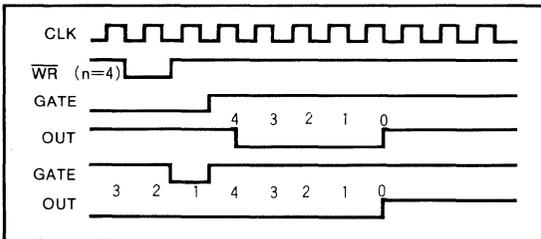


Fig. 2 Mode 1

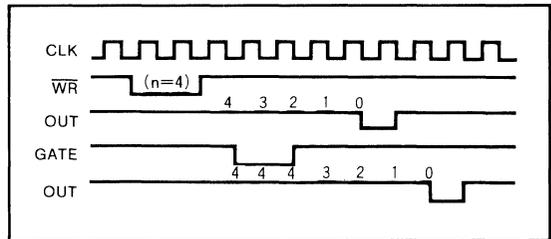


Fig. 5 Mode 4

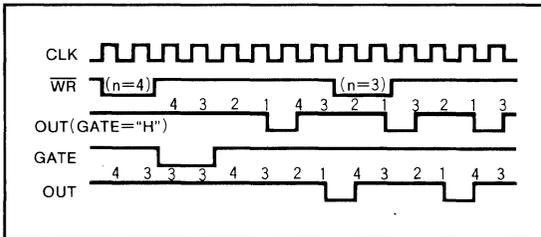


Fig. 3 Mode 2

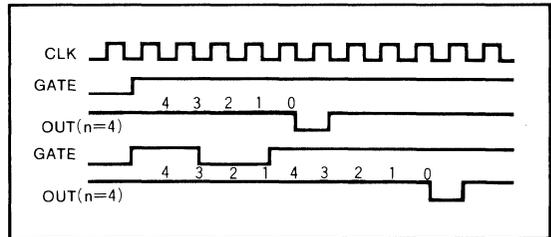


Fig. 6 Mode 5

**COUNTER MONITORING**

Sometimes the counter must be monitored by reading its count or using it as an event counter. The M5M82C54P offers the following two methods for count reading:

**Read Operation**

The count can be read by designating the address of the counter to be monitored and executing a simple I/O read operation. In order to ensure correct reading of the count, it is necessary to cause the clock input to pause by external logic or prevent a change in the count by gate input. An example of a program to read the counter 1 count is shown below. If RL1, RL0=1, 1 has been specified in the control word, the first IN instruction enables the low-order 8 bits to be read and the second IN instruction enables the highorder 8 bits.

```
IN    n2 ... n2 is the counter 1 address
MOV   D, A
IN    n2
MOV   E, A
```

The IN instruction should be executed once or twice by the RL1 and RL0 designations in the control-word register.

**Read-on-the-Fly Operation**

This method makes it possible to read the current count without affecting the count operation at all. A special counter-latch command is first written in the control-word register. This causes latching of all the instantaneous counts to the register, allowing retention of stable counts. An example of a program to execute this operation for counter 2 is given below.

```
MVI   A, 1000XXXX ... D5=D4=0 designates counter latching
OUT   n1 ... n1 is the control-word-register address
IN    n3 ... n3 is the counter 2 address
MOV   D, A
IN    n3
MOV   E, A
```

In this example, the IN instruction is executed twice. Due to the internal logic of the M5M82C54P it is absolutely essential to complete the entire reading procedure. If two bytes are programmed to be read, then two bytes must be read before any OUT instruction can be executed to the same counter.

### Read Back Command

M5M82C54P has a function of reading not only the count but also status (Read Back Command). The read back command enables the next four functions.

- (1) read the current count "on the fly"
- (2) monitor the current state of the OUT pin
- (3) monitor the current state of the counter element (whether the count is loaded into the counter element or not)
- (4) read the control word

Read back operation can be specified by writing read back command into the control word registers ( $A_0, A_1 = 1, 1$ ). Fig. 7 shows the format of read back command.

Bits  $D_7$  and  $D_6$  are used for specifying read back command and fixed 1 ( $D_7 = 1, D_6 = 1$ ). Respectively bits  $D_5$  (count) and  $D_4$  (status) are used for reading the count and the status of the counter selected by the  $D_3 \sim D_1$  bits. Bit  $D_0$  must be fixed 0.

Only the count can be read "on the fly" by setting  $D_5 = 0$  and  $D_4 = 1$  as well as counter latch command above mentioned. If  $D_3 \sim D_1$  are set 1 all, the counts of three counters are simultaneously latched by one read back command. (By counter latch command, it must be latched for each counter.) Next, by read operation, the latched count is read out.

Only the status can be latched by setting  $D_5 = 1$  and  $D_4 = 0$ . By read operation, the status shown in Fig. 8 can be

read.

BIT  $D_7$  gives the current state of OUT pin. When  $D_7 = 1$ ,  $OUT = "H"$ , and when  $D_7 = 0$ ,  $OUT = "L"$ . Bit  $D_6$  indicates the current state of counter element. When  $D_6 = 1$ , the initial counter value has not been loaded to counter element. This state is following.

- (1) The control word is written, but the initial counter value is not loaded
- (2) The initial counter value is written to count register, and the CLK inputs are not.

When  $D_6 = 0$ , the initial counter value has already been loaded. It is the state when the CLK falls following the rising edge after the initial value is written. Bits  $D_5 \sim D_0$  show the current state of the control word register.

It is possible to read both the count and the status. By setting  $D_5 = 0$  and  $D_4 = 0$ , the status can be read first, and the count next.

The count and/or the status are unlatched when read, so by the next read operation the current counting value can be read. And they are unlatched too when the control word is set, so the read back command must be set on all such occasions.

If multiple read back commands are written before the read operation, only the first one is valid.

Thus, the read of the status is effective when the state of output and the timing of count reading can be monitored by software.

**CMOS PROGRAMMABLE INTERVAL TIMER**

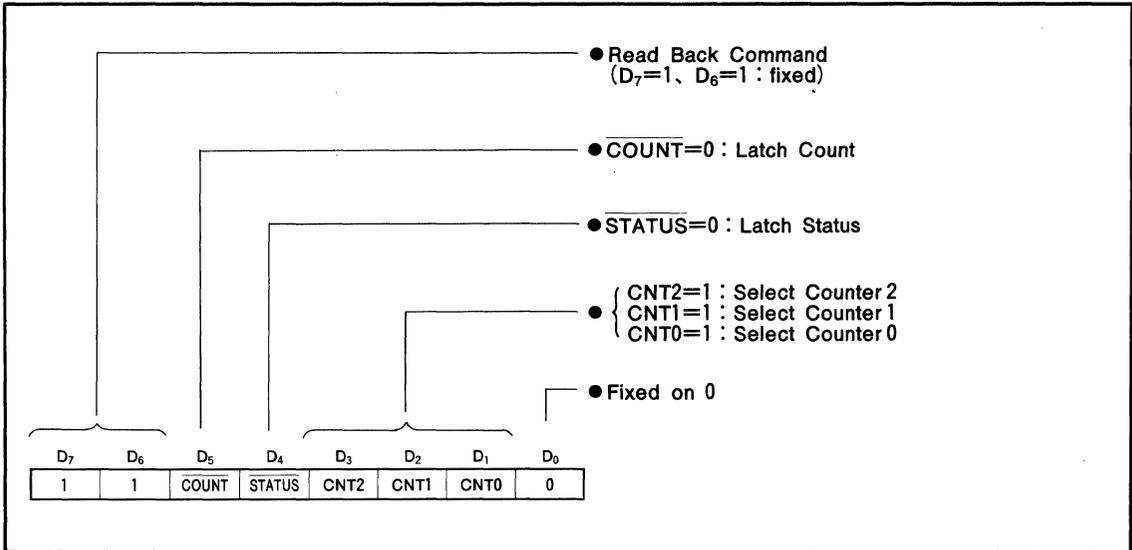


Fig. 7 Read Back Command Format

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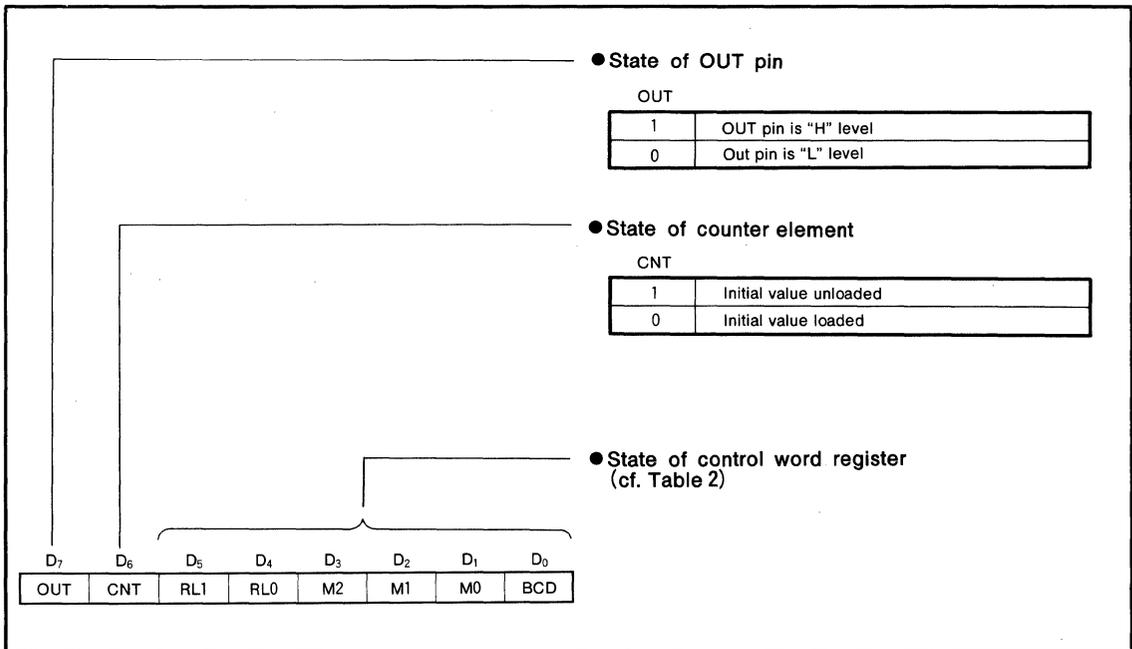


Fig. 8 Status Byte

**CMOS PROGRAMMABLE INTERVAL TIMER**

**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Power supply voltage	With respect to GND	-0.3~7	V
$V_I$	Input voltage		-0.3~ $V_{CC}+0.3$	V
$V_O$	Output voltage		-0.3~ $V_{CC}+0.3$	V
$T_{opr}$	Operating free-air temperature range		-20~75	°C
$T_{stg}$	Storage temperature range		-65~150	°C

**RECOMMENDED OPERATING CONDITIONS** ( $T_a = -20 \sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Power supply voltage	4.50	5	5.50	V
$V_{SS}$	Supply voltage (GND)		0		V

**ELECTRICAL CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ , unless otherwise noted)

Symbol	Parameter	Test condition	Limits			Unit
			Min	Typ	Max	
$V_{IH}$	High-level input voltage		2.0		$V_{CC}+0.3$	V
$V_{IL}$	Low-level input voltage		-0.3		0.8	V
$V_{OH}$	High-level output voltage	$V_{SS}=0V, I_{OH}=-400\mu A$	2.4			V
$V_{OL}$	Low-level output voltage	$V_{SS}=0V, I_{OL}=2.0mA$			0.45	V
$I_{IH}$	High-level input current	$V_{SS}=0V, V_I=5.50V$			$\pm 10$	$\mu A$
$I_{IL}$	Low-level input current	$V_{SS}=0V, V_I=0V$			$\pm 10$	$\mu A$
$I_{OZ}$	Off-state output current	$V_{SS}=0V, V_I=0 \sim V_{CC}$			$\pm 10$	$\mu A$
$I_{CC}$	Power supply current	M5M82C54P			10	mA
		M5M82C54P-6			10	mA
$I_{CC}$	Power supply current during STAND BY	$V_{SS}=0V$ , other inputs are $V_{SS}$ or $V_{CC}$			10	$\mu A$
$C_i$	Input capacitance	$V_{IL}=V_{SS}, f=1MHz, 25mVrms, T_a=25^\circ C$			10	pF
$C_{i/O}$	Input/output capacitance	$V_{i/O}=V_{SS}, f=1MHz, 25mVrms, T_a=25^\circ C$			20	pF

**CMOS PROGRAMMABLE INTERVAL TIMER**

**TIMING REQUIREMENTS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

**Read cycle**

Symbol	Parameter	Alternative symbol	Test condition	Limits			Unit
				Min	Typ	Max	
$t_{w(R)}$	Read pulse width	$t_{RR}$	$C_L = 150\text{pF}$	150			ns
$t_{SU(S-R)}$	$\overline{CS}$ setup time before read	$t_{SR}$		0			ns
$t_{SU(A-R)}$	Address setup time before read	$t_{AR}$		45			ns
$t_{h(R-A)}$	Address hold time after read	$t_{RA}$		0			ns
$t_{reC(R)}$	Read recovery time	$t_{RV}$		200			ns

**Write cycle**

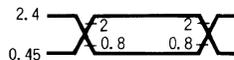
Symbol	Parameter	Alternative symbol	Test condition	Limits			Unit
				Min	Typ	Max	
$t_{w(W)}$	Write pulse width	$t_{WW}$	$C_L = 150\text{pF}$	150			ns
$t_{SU(S-W)}$	$\overline{CS}$ setup time before write	$t_{SW}$		0			ns
$t_{SU(A-W)}$	Address setup time before write	$t_{AW}$		0			ns
$t_{h(W-A)}$	Address hold time after write	$t_{WA}$		0			ns
$t_{SU(D-W)}$	Data setup time before write	$t_{DW}$		120 [100]	(Note 1)		ns
$t_{h(W-D)}$	Data hold time after write	$t_{WD}$		0			ns
$t_{reC(W)}$	Write recovery time	$t_{RV}$		200			ns

Note 1 : M5M82C54P/P-6 is also invested with the extended specification showed in the bracket.

**Clock and gate timing**

Symbol	Parameter		Alternative symbol	Test condition	Limits			Unit
					Min	Typ	Max	
$t_{w(\phi H)}$	Clock high pulse width	M5M82C54P	$t_{PWH}$	$C_L = 150\text{pF}$	60			ns
		M5M82C54P-6			55			
$t_{w(\phi L)}$	Clock low pulse width	M5M82C54P	$t_{PWL}$		60			ns
		M5M82C54P-6			110			
$t_{C(\phi)}$	Clock cycle time	M5M82C54P	$t_{CLK}$		125			ns
		M5M82C54P-6			165			
$t_r(\phi)$	Clock rise time		$t_R$				25	ns
$t_f(\phi)$	Clock fall time		$t_F$				25	ns
$t_{w(GH)}$	Gate high pulse width		$t_{GW}$		50			ns
$t_{w(GL)}$	Gate low pulse width		$t_{GL}$		50			ns
$t_{SU(G-\phi)}$	Gate setup time before clock		$t_{GS}$	50			ns	
$t_{h(\phi-G)}$	Gate hold time after clock		$t_{GH}$	50			ns	

Note 2 : A.C Testing waveform  
 Input pulse level 0.45~2.4V  
 Input pulse rise time 10ns  
 Input pulse fall time 10ns  
 Reference level input  $V_{IH} = 2V$ ,  $V_{IL} = 0.8V$   
 Output  $V_{OH} = 2V$ ,  $V_{OL} = 0.8V$



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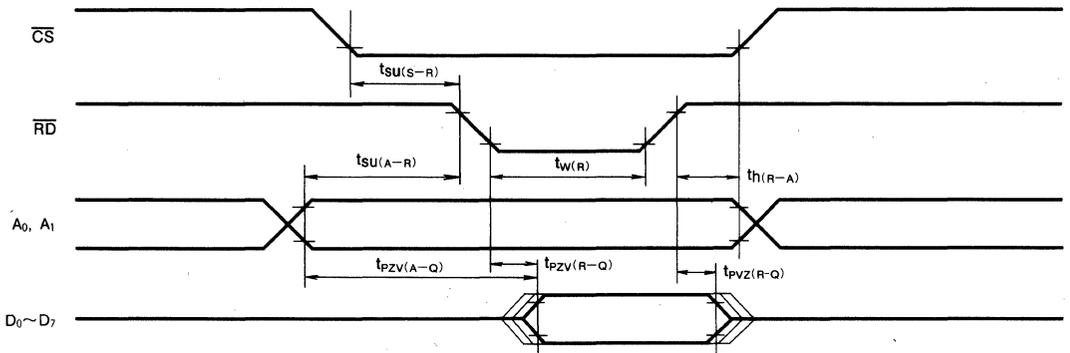
**CMOS PROGRAMMABLE INTERVAL TIMER**

**SWITCHING CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

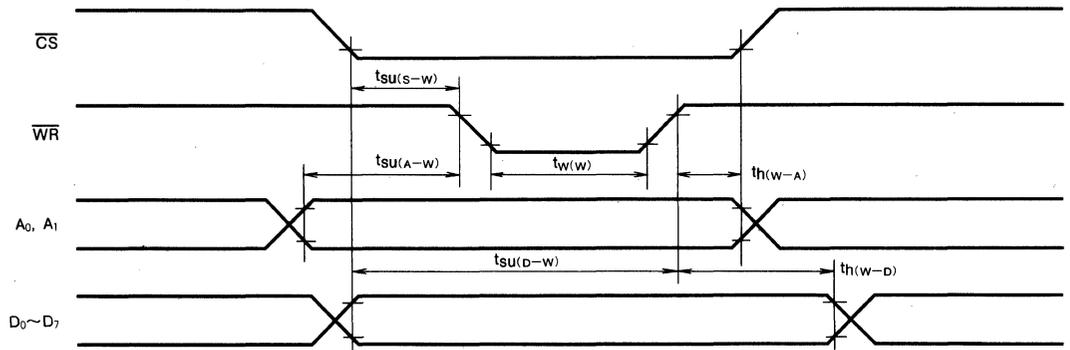
Symbol	Parameter	Alternative symbol	Test condition	Limits			Unit	
				Min	Typ	Max		
$t_{PZV(A-Q)}$	Propagation time from address to output	$t_{AD}$	$C_L = 150\text{pF}$			220	ns	
$t_{PZV(R-Q)}$	Propagation time from read to output	M5M82C54P		$t_{RD}$			120	ns
		M5M82C54P-6					170	
$t_{PVZ(R-Q)}$	Propagation time from read to output floating	$t_{DF}$			5	90	ns	
$t_{PXV(G-Q)}$	Propagation time from gate to output	$t_{ODG}$				120	ns	
$t_{PXV(\phi-Q)}$	Propagation time from clock to output	$t_{OD}$				150	ns	

**TIMING DIAGRAMS** (Reference voltage : High=2.0V, Low=0.8V)

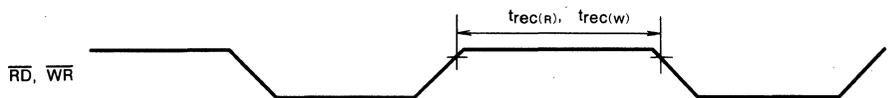
**Read cycle**



**Write cycle**

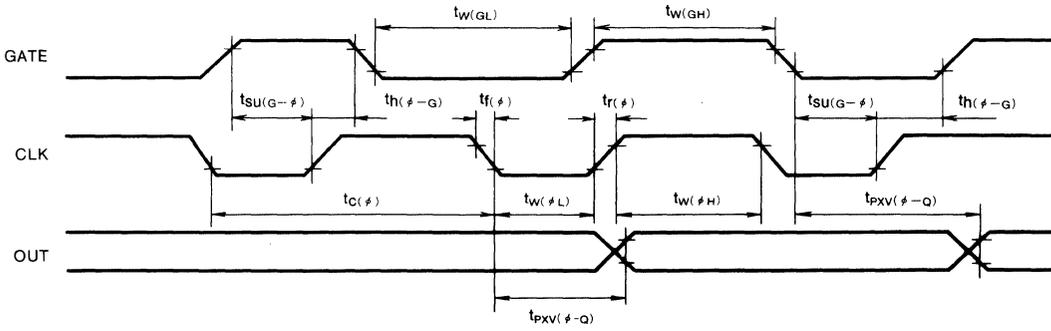


**(Recovery time)**



**CMOS PROGRAMMABLE INTERVAL TIMER**

Clock and gate cycle



# M5M82C54FP,-6

## CMOS PROGRAMMABLE INTERVAL TIMER

### DESCRIPTION

The M5M82C54FP is a programmable general-purpose timer device developed by using the silicon-gate CMOS process. It offers counter and timer functions in systems using an 8-bit parallel-processing CPU. The use of the M5M82C54FP frees the CPU from the execution of looped programs, count-operation programs and other simple processing involving many repetitive operations, thus contributing to improved system throughputs. The M5M82C54FP works on a single power supply, and both its input and output can be connected to a TTL circuit.

Parameter	M5M82C54FP	M5M82C54FP-6
Clock high pulse width (Min.)	60ns	55ns
Clock low pulse width (Min.)	60ns	110ns
Clock cycle time (Min.)	125ns	165ns
Access time (Max.)	120ns	170ns

### FEATURES

- Single 5V supply voltage
- TTL compatible
- Pin connection compatible with M5L8253P-5
- Clock period : M5M82C54FP-6 ..... DC~6MHz  
M5M82C54FP ..... DC~8MHz
- 3 independent built-in 16-bit down counters
- 6 counter modes freely assignable for each counter
- Binary or decimal counts
- Read-back command for monitoring the count and status
- Package in flat small outline package

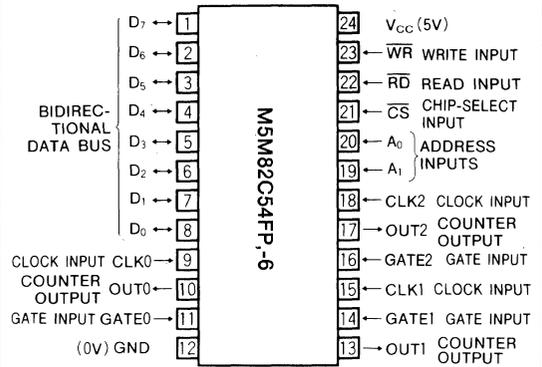
### APPLICATION

Delayed-time setting, pulse counting and rate generation in microcomputers.

### FUNCTION

Three independent 16-bit counters allow free programming

### PIN CONFIGURATION (TOP VIEW)



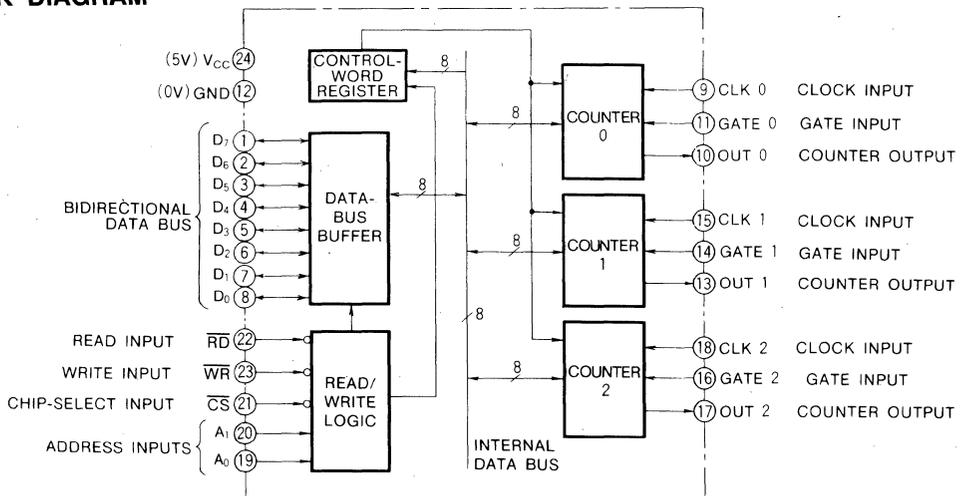
Outline 24P2W

based on mode-control instructions from the CPU. When roughly classified, there are 6 modes (0~5). Mode 0 is mainly used as an interruption timer and event counter, mode 1 as a digital one-shot, modes 2 and 3 as rate generators, mode 4 for a software triggered strobe, and mode 5 for a hardware triggered strobe.

The count can be monitored and set at any time. Besides the count, the status of the counter can be monitored by Read-back command. The counter operates with either the binary or BCD system.

Refer to M5M82C54P/P-6 for detail information. M5M82C54FP/FP-6's specification are fully compatible with M5M82C54P/P-6. Only package outline is different.

### BLOCK DIAGRAM



# MITSUBISHI LSIs

## M5M82C55AP-5

### CMOS PROGRAMMABLE PERIPHERAL INTERFACE

#### DESCRIPTION

This is a family of general-purpose programmable input/output devices designed for use with the 8/16-bit parallel CPU as input/output ports.

This device is fabricated using silicon-gate CMOS technology for a single supply voltage. This LSI is a simple input and output interface for TTL circuits, having 24 input/output pins which correspond to three 8-bit input/output ports.

#### FEATURES

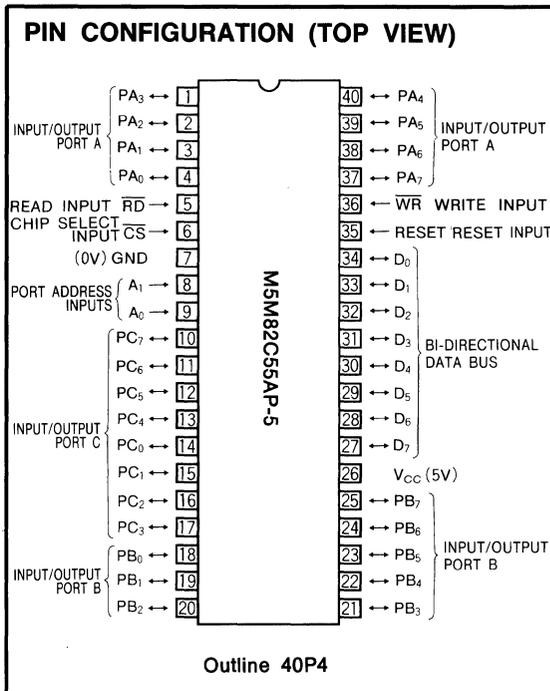
- Single 5 V supply voltage
- TTL compatible
- Improved DC driving capability
- Improved timing characteristics
- 24 programmable I/O pins
- Direct bit set/reset capability

#### APPLICATION

Input/output ports for MELPS85, MELPS86, MELPS88 microprocessor

#### FUNCTION

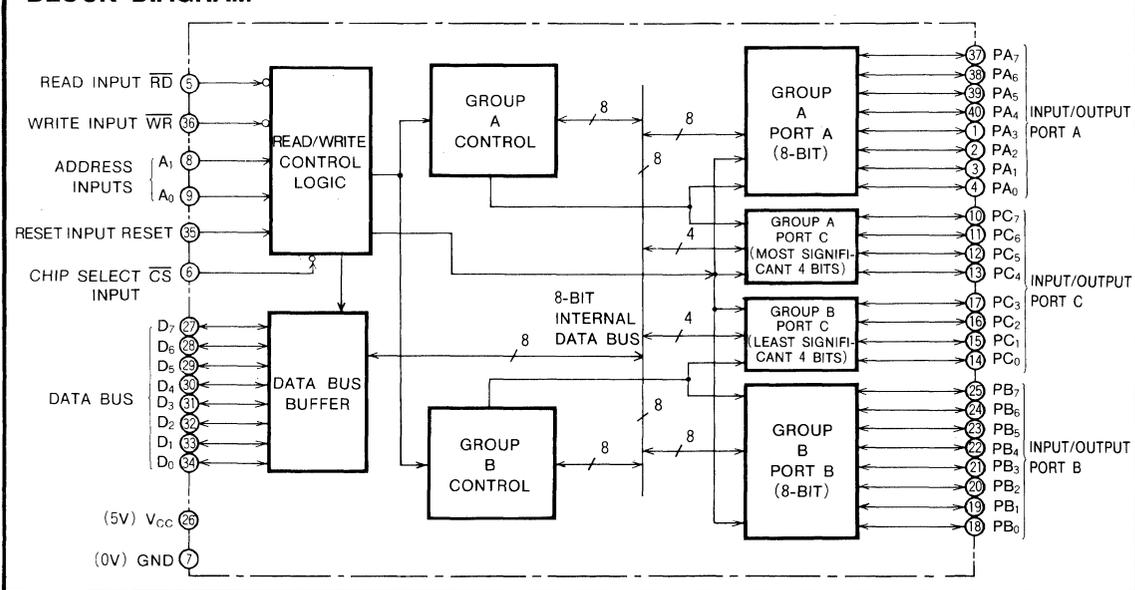
These PPIs have 24 input/output pins which may be individually programmed in two 12-bit groups A and B with mode control commands from a CPU. They are used in three major modes of operation, mode 0, mode 1 and mode 2. Operating in mode 0, each group of 12 pins may be programmed in sets of 4 to be inputs or outputs. In mode 1, the 24 I/O terminals may be programmed in two 12-bit groups, group A and group B. Each group contains one 8-bit data port, which may be programmed to serve as input or output, and one 4-bit control port used for handshaking and interrupt



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control signals. Mode 2 is used with group A only, as one 8-bit bidirectional bus port and one 5-bit control port. Bit set/reset is controlled by CPU. A high-level reset input (RESET) clears control register, and all ports are set to the input mode (high-impedance state).

#### BLOCK DIAGRAM



**CMOS PROGRAMMABLE PERIPHERAL INTERFACE**

**FUNCTIONAL DESCRIPTION**

**RD (Read) Input**

At low-level, the status or the data at the port is transferred to the CPU from the PPI. In essence, it allows the CPU to read data from the PPI.

**WR (Write) Input**

At low-level, the data or control words are transferred from the CPU and written in the PPI.

**A<sub>0</sub>, A<sub>1</sub> (Port address) Input**

These input signals are used to select one of the three ports: port A, port B, and port C, or the control register. They are normally connected to the least significant two bits of the address bus.

**RESET (Reset) Input**

At high-level, the control register is cleared. Then all ports are set to the input mode (high-impedance state).

**CS (Chip-Select) Input**

At low-level, the communication between the PPI and the CPU is enabled. While at high-level, the data bus is kept in the high-impedance state, so that commands from the CPU are ignored. Then the previous data is kept at the output port.

**Read/Write Control Logic**

The function of this block is to control transfers of both data and control words. It accepts the address signals (A<sub>0</sub>, A<sub>1</sub>, CS), I/O control signals (RD, WR) and RESET signal, and then issues commands to both of the control groups in the PPI.

**Data Bus Buffer**

This three-state, bidirectional, eight-bit buffer is used to transfer the data when an input or output instruction is executed by the CPU. Control words and status information are also transferred through the data bus buffer.

**Group A and Group B Control**

Accepting commands from the read/write control logic, the control blocks (Group A, Group B) receive 8-bit control words from the internal data bus and issue the proper commands for the associated ports. Control group A is associated with port A and the four high-order bits of port C. Control group B is associated with port B and the four low-order bits of port C. The control register, which stores control words, can only be written into.

**Port A, Port B and Port C**

The PPI contains three 8-bit ports whose modes and input/output settings are programmed by the system software.

Port A has an output latch/buffer and an input latch. Port B has an I/O latch/buffer and an input buffer. Port C has an output latch/buffer and an input buffer. Port C can be divided into two 4-bit ports which can be used as ports for control signals for port A and port B.

The basic operations are shown in Table 1.

Table 1 Basic Operations

A <sub>1</sub>	A <sub>0</sub>	CS	RD	WR	Operation
0	0	0	0	1	Data bus ← Port A
0	1	0	0	1	Data bus ← Port B
1	0	0	0	1	Data bus ← Port C
0	0	0	1	0	Port A ← Data bus
0	1	0	1	0	Port B ← Data bus
1	0	0	1	0	Port C ← Data bus
1	1	0	1	0	Control register ← Data bus
X	X	1	X	X	Data bus is in high-impedance state
1	1	0	0	1	illegal condition

Where, "0" indicates low level  
 "1" indicates high-level

**Bit Set/Reset**

When port C is used as an output port, any one bit of the eight bits can be set (high) or reset (low) by a control word from the CPU. This bit set/reset can be operated in the same way as the mode set, but the control word format is different. This operation is also used for INTE set/reset in mode 1 and mode 2.

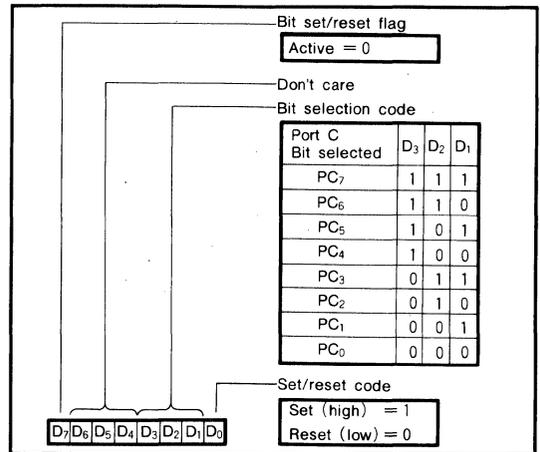


Fig. 1 Control word format for port C set/reset

**CMOS PROGRAMMABLE PERIPHERAL INTERFACE**

**BASIC OPERATING MODES**

The PPI can operate in any one of three selected basic modes.

- Mode 0: Basic input/output (group A, group B)
- Mode 1: Strobed input/output (group A, group B)
- Mode 2: Bidirectional bus (group A only)

The mode of both group A and group B can be selected independently. The control word format for mode set is shown in Fig. 2.

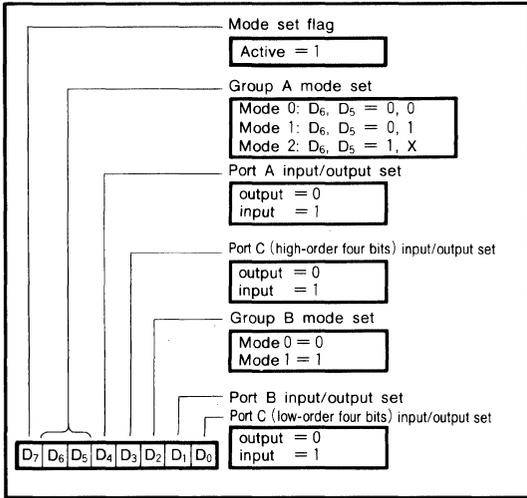
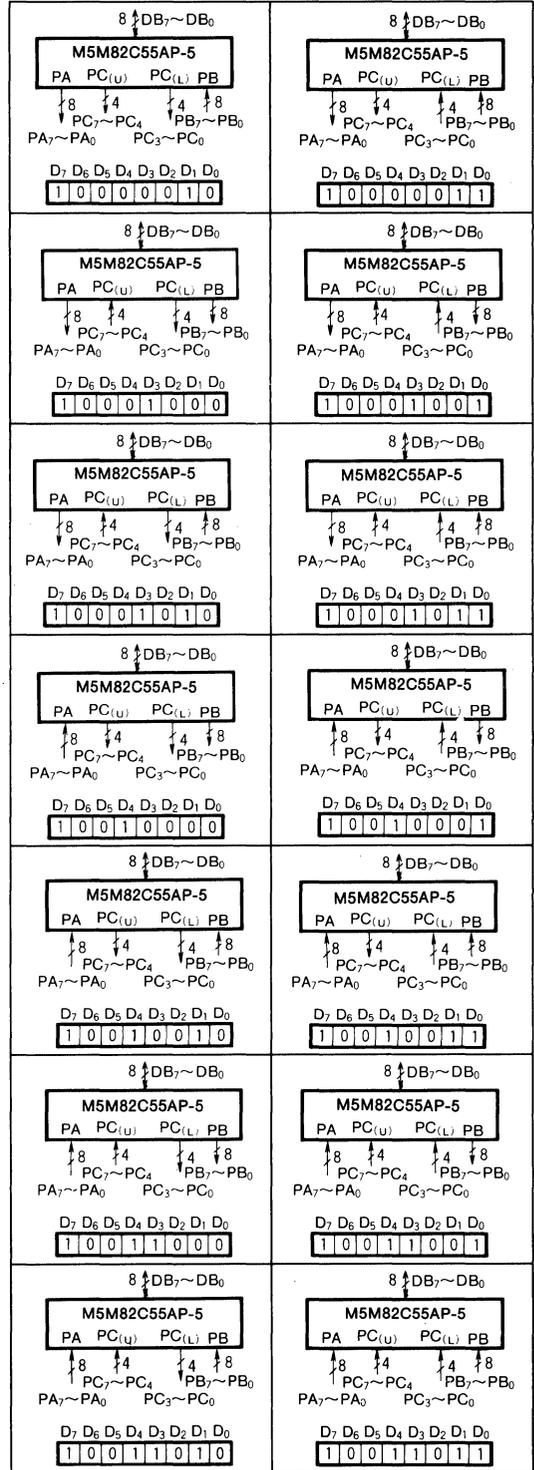
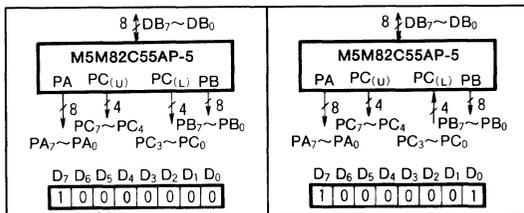


Fig. 2 Control word format for mode set.

**1. Mode 0 (Basic Input/Output)**

This functional configuration provides simple input and output operations for each of the three ports. No "handshaking" is required; data is simply written in, or read from, the specified port. Output data from the CPU to the port can be held, but input data from the port to the CPU cannot be held. Any one of the 8-bit ports and 4-bit ports can be used as an input port or an output port. The diagrams following show the basic input/output operating modes.



**CMOS PROGRAMMABLE PERIPHERAL INTERFACE**

**2. Mode 1 (Strobed Input/Output)**

This function can be set in both group A and B. Both groups are composed of one 8-bit data port and one 4-bit control data port. The 8-bit port can be used as an input port or an output port. The 4-bit port is used for control and status signals affecting the 8-bit data port. The following shows operations in mode 1 for using input ports.

**STB (Strobe Input)**

A low-level on this input latches the output data from the terminal units into the input register of the port. In short, this is a clock for data latching. The data from the terminal units can be latched by the PPI independent of the control signal from the CPU. This data is not sent to the data bus until the instruction IN is executed.

**IBF (Input Buffer Full Flag Output)**

A high-level on this output indicates that the data from the terminal units has been latched into the input register. IBF is set to high-level by the falling edge of the  $\overline{STB}$  input, and is reset to low-level by the rising edge of the  $\overline{RD}$  input.

**INTR (Interrupt Request Output)**

This can be used to interrupt the CPU when an input device is requesting service. When INTE (interrupt enable flag) of the PPI is high-level, INTR is set to high-level by the rising edge of the  $\overline{STB}$  input and is reset to low-level by the falling edge of  $\overline{RD}$  input.

$INTE_A$  of group A is controlled by bit setting of  $PC_4$ .  $INTE_B$  of group B is controlled by bit setting of  $PC_2$ .

Mode 1 input state is shown in Fig. 3, and the timing chart is shown in Fig. 4.

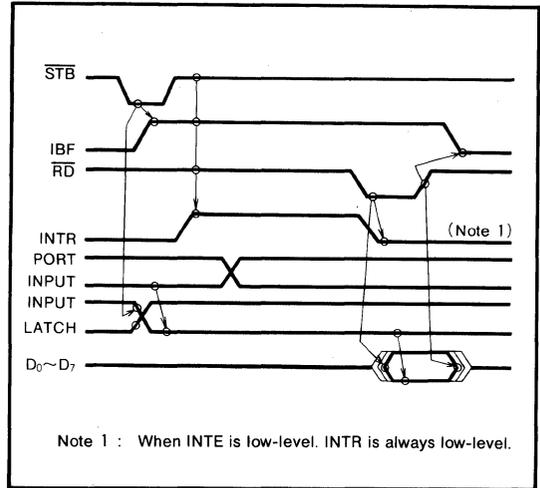


Fig. 4 Timing chart

The following shows operations using mode 1 for output ports.

**OBF (Output Buffer Full Flag Output)**

This is reset to low-level by the rising edge of the  $\overline{WR}$  signal and is set to high-level by the falling edge of the  $\overline{ACK}$  (acknowledge input). In essence, the PPI indicates to the terminal units by the  $\overline{OBF}$  signal that the CPU has sent data to the port.

**ACK (Acknowledge Input)**

Receiving this signal from a terminal unit can indicate to the PPI that the terminal unit has accepted data from a port.

**INTR (Interrupt Request)**

When a peripheral unit is accepting data from the CPU, setting INTR to high-level can be used to interrupt the CPU. When INTE (interrupt enable flag) is high and  $\overline{OBF}$  is set to high-level by the rising edge of an  $\overline{ACK}$  signal, then INTR will also be set to high-level by the rising edge of the  $\overline{ACK}$  signal. Also, INTR is reset to low-level by the falling edge of the  $\overline{WR}$  signal when the PPI has been receiving data from the CPU.

$INTE_A$  of group A is controlled by bit setting of  $PC_6$ .

$INTE_B$  of group B is controlled by bit setting of  $PC_2$ .

Mode 1 output state is shown in Fig. 5, and the timing chart is shown in Fig. 6.

Combinations for using port A and port B as input or output in mode 1 are shown in Fig. 7 and Fig. 8.

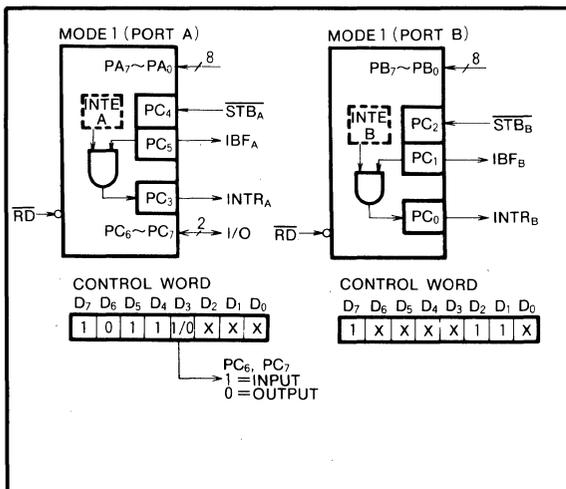


Fig. 3 An example of mode 1 input state

**CMOS PROGRAMMABLE PERIPHERAL INTERFACE**

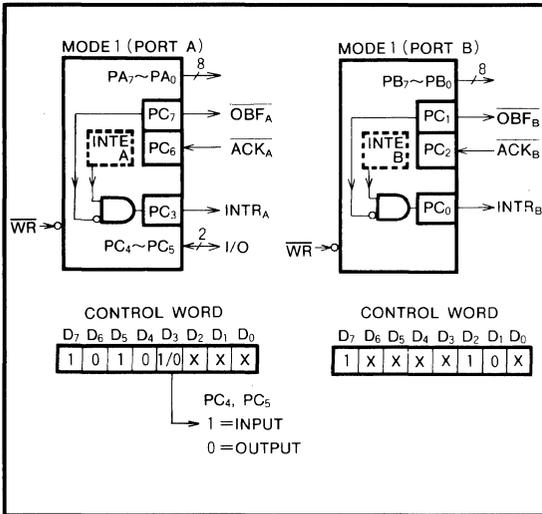


Fig. 5 Mode 1 output example

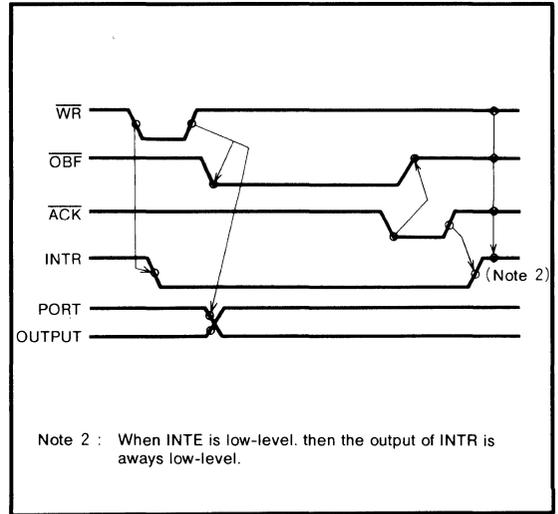


Fig. 6 Timing diagram

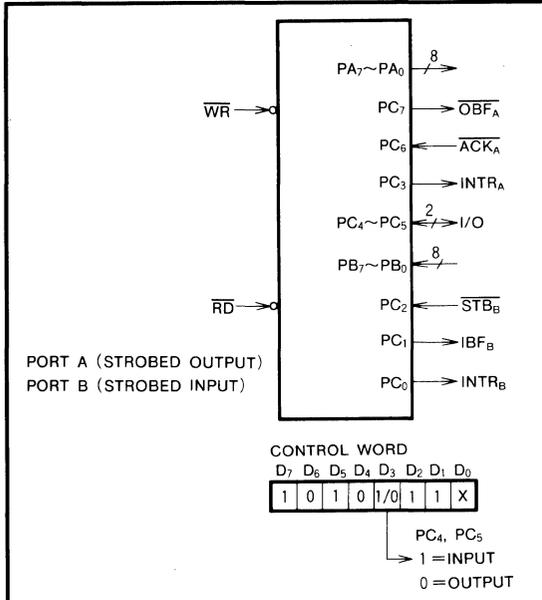


Fig. 7 Mode 1 port A and port B I/O example

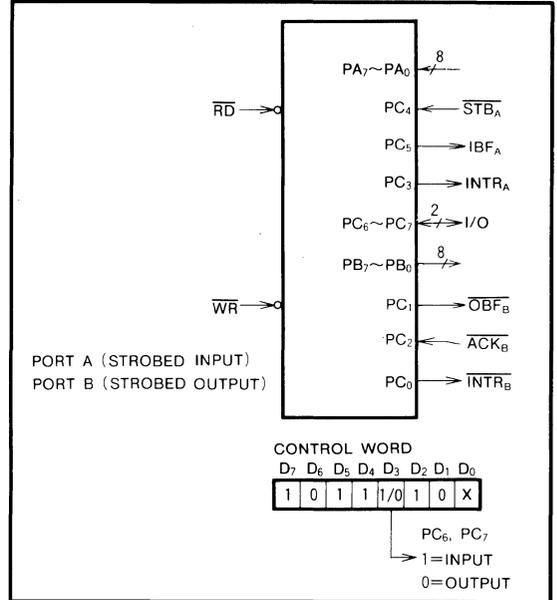


Fig. 8 Mode 1 port A and port B I/O example

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**CMOS PROGRAMMABLE PERIPHERAL INTERFACE**

**3. Mode 2 (Strobed Bidirectional Bus Input/Output)**

Mode 2 can provide bidirectional operations, using one 8-bit bus for communicating with terminal units. Mode 2 is only valid with group A and uses one 8-bit bidirectional bus port (port A) and a 5-bit control port (high-order five bits of port C). The bus port (port A) has two internal registers, one for input and the other for output. On the other hand, the control port (port C) is used for communicating control signals and bus-status signals. These control signals are similar to mode 1 and can also be used to control interruption of the CPU. When group A is programmed as mode 2, group B can be programmed independently as mode 0 or mode 1. When group A is in mode 2, the following five control signals can be used.

**OBF (Output Buffer Full Flag Output)**

The  $\overline{\text{OBF}}$  output will go low-level to indicate that the CPU has sent data to the internal register of port A. This signal lets the terminal units know that the data is ready for transfer from the CPU. When this occurs, port A remains in the floating (high-impedance) state.

**ACK (Acknowledge Input)**

A low-level  $\overline{\text{ACK}}$  input will cause the data of the internal register to be transferred to port A. For a high-level  $\overline{\text{ACK}}$  input, the output buffer will be in the floating (high-impedance) state.

**STB (Strobe Input)**

When the  $\overline{\text{STB}}$  input is low-level, the data from terminal units will be held in the internal register, and the data will be sent to the system data bus with an  $\overline{\text{RD}}$  signal to the PPI.

**IBF (Input Buffer Full Flag Output)**

When data from terminal units is held on the internal register,  $\overline{\text{IBF}}$  will be high level.

**INTR (Interrupt Request Output)**

This output is used to interrupt the CPU and its operations the same as in mode 1. There are two interrupt enable flags that correspond to  $\overline{\text{INTE}}_A$  for mode 1 output and mode 1 input.

$\overline{\text{INTE}}_1$  is used in generating  $\overline{\text{INTR}}$  signals in combination with  $\overline{\text{OBF}}$  and  $\overline{\text{ACK}}$ .  $\overline{\text{INTE}}_1$  is controlled by bit setting of  $\text{PC}_6$ .

$\overline{\text{INTE}}_2$  is used in generating  $\overline{\text{INTR}}$  signals in combination with  $\overline{\text{IBF}}$  and  $\overline{\text{STB}}$ .  $\overline{\text{INTE}}_2$  is controlled by bit setting of  $\text{PC}_4$ .

Fig. 9 shows the timing diagram of mode 2, and Fig. 10 is an example of mode 2 operation.

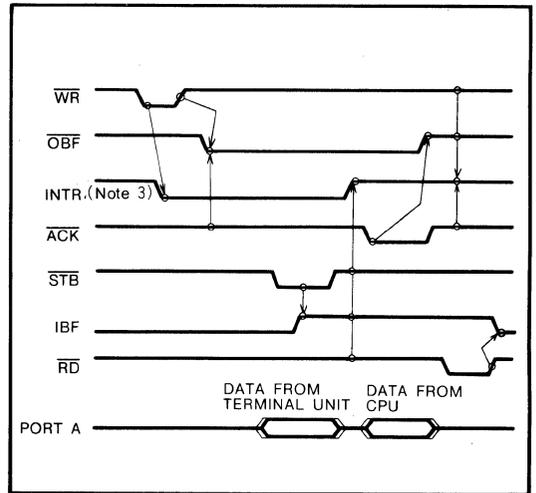


Fig. 9 Mode 2 timing diagram

Note 3 :  $\overline{\text{INTR}} = \overline{\text{IBF}} \cdot \overline{\text{MASK}} \cdot \overline{\text{STB}} \cdot \overline{\text{RD}} + \overline{\text{OBF}} \cdot \overline{\text{MASK}} \cdot \overline{\text{ACK}} \cdot \overline{\text{WR}}$

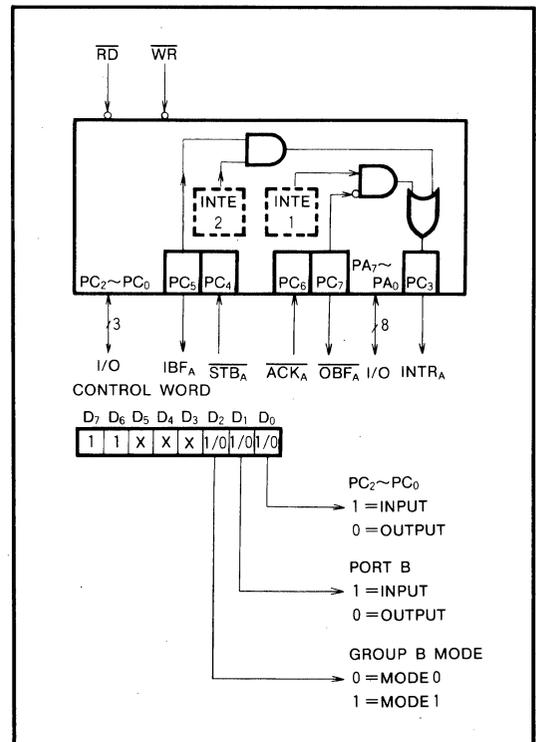


Fig. 10 An example of mode 2 operation

CMOS PROGRAMMABLE PERIPHERAL INTERFACE

4. Control Signal Read

In mode 1 or mode 2 when using port C as a control port, by CPU execution of an IN instruction, each control signal and bus status from port C can be read.

5. Control Word Tables

Control word formats and operation details for mode 0, mode 1, mode 2 and set/reset control of port C are given in Tables 3, 4, 5 and 6, respectively.

Table 2 Read-out control signals

Data Mode	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
Mode 1, input	I/O	I/O	IBF <sub>A</sub>	INTE <sub>A</sub>	INTR <sub>A</sub>	INTE <sub>B</sub>	IBF <sub>B</sub>	INTR <sub>B</sub>
Mode 1, output	$\overline{\text{OBF}}_A$	INTE <sub>A</sub>	I/O	I/O	INTR <sub>A</sub>	INTE <sub>B</sub>	$\overline{\text{OBF}}_B$	INTR <sub>B</sub>
Mode 2	$\overline{\text{OBF}}_A$	INTE <sub>1</sub>	IBF <sub>A</sub>	INTE <sub>2</sub>	INTR <sub>A</sub>	By group B mode		

Table 3 Mode 0 control words

Control words									Group A		Group B		
D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>	Hexadecimal	Port A	Port C (high order 4 bits)	Port C (low order 4 bits)		Port B
1	0	0	0	0	0	0	0	80	OUT	OUT	OUT		OUT
1	0	0	0	0	0	0	1	81	OUT	OUT	IN		OUT
1	0	0	0	0	0	1	0	82	OUT	OUT	OUT		IN
1	0	0	0	0	0	1	1	83	OUT	OUT	IN		IN
1	0	0	0	1	0	0	0	88	OUT	IN	OUT		OUT
1	0	0	0	1	0	0	1	89	OUT	IN	IN		OUT
1	0	0	0	1	0	1	0	8A	OUT	IN	OUT		IN
1	0	0	0	1	0	1	1	8B	OUT	IN	IN		IN
1	0	0	1	0	0	0	0	90	IN	OUT	OUT		OUT
1	0	0	1	0	0	0	1	91	IN	OUT	IN		OUT
1	0	0	1	0	0	1	0	92	IN	OUT	OUT		IN
1	0	0	1	0	0	1	1	93	IN	OUT	IN		IN
1	0	0	1	1	0	0	0	98	IN	IN	OUT		OUT
1	0	0	1	1	0	0	1	99	IN	IN	IN		OUT
1	0	0	1	1	0	1	0	9A	IN	IN	OUT		IN
1	0	0	1	1	0	1	1	9B	IN	IN	IN		IN

Note 4 : OUT indicates output port, and IN indicates input port.

Table 4 Mode 1 control words

Control words								Group A					Group B					
D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>	Hexadecimal	Port A	Port C				Port C			Port B	
										PC <sub>7</sub>	PC <sub>6</sub>	PC <sub>5</sub>	PC <sub>4</sub>	PC <sub>3</sub>	PC <sub>2</sub>	PC <sub>1</sub>	PC <sub>0</sub>	
1	0	1	0	0	1	0	X	A4 A5	OUT	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	OUT	INTR <sub>A</sub>	$\overline{\text{ACK}}_B$	$\overline{\text{OBF}}_B$	INTR <sub>B</sub>	OUT	
1	0	1	0	0	1	1	X	A6 A7	OUT	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	OUT	INTR <sub>A</sub>	$\overline{\text{STB}}_B$	IBF <sub>B</sub>	INTR <sub>B</sub>	IN	
1	0	1	0	1	1	0	X	AC AD	OUT	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	IN	INTR <sub>A</sub>	$\overline{\text{ACK}}_B$	$\overline{\text{OBF}}_B$	INTR <sub>B</sub>	OUT	
1	0	1	0	1	1	1	X	AE AF	OUT	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	IN	INTR <sub>A</sub>	$\overline{\text{STB}}_B$	IBF <sub>B</sub>	INTR <sub>B</sub>	IN	
1	0	1	1	0	1	0	X	B4 B5	IN	OUT	IBF <sub>A</sub>	$\overline{\text{STB}}_A$	INTR <sub>A</sub>	$\overline{\text{ACK}}_B$	$\overline{\text{OBF}}_B$	INTR <sub>B</sub>	OUT	
1	0	1	1	0	1	1	X	B6 B7	IN	OUT	IBF <sub>A</sub>	$\overline{\text{STB}}_A$	INTR <sub>A</sub>	$\overline{\text{STB}}_B$	IBF <sub>B</sub>	INTR <sub>B</sub>	IN	
1	0	1	1	1	1	0	X	BC BD	IN	IN	IBF <sub>A</sub>	$\overline{\text{STB}}_A$	INTR <sub>A</sub>	$\overline{\text{ACK}}_B$	$\overline{\text{OBF}}_B$	INTR <sub>B</sub>	OUT	
1	0	1	1	1	1	1	X	BE BF	IN	IN	IBF <sub>A</sub>	$\overline{\text{STB}}_A$	INTR <sub>A</sub>	$\overline{\text{STB}}_B$	IBF <sub>B</sub>	INTR <sub>B</sub>	IN	

Note 5 : Mode of group A and group B can be programmed independently.

6 : It is not necessary for both group A and group B to be in mode 1.

5

CMOS PROGRAMMABLE PERIPHERAL INTERFACE

Table 5 Mode 2 control words

Control words									Hexa-decimal (Ex)	Port A	Group A					Group B			Port B
D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>	Port C					PortC						
								PC <sub>7</sub>			PC <sub>6</sub>	PC <sub>5</sub>	PC <sub>4</sub>	PC <sub>3</sub>	PC <sub>2</sub>	PC <sub>1</sub>	PC <sub>0</sub>		
1	1	X	X	X	0	0	0		Bidirectional bus	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	$\text{IBF}_A$	$\overline{\text{STB}}_A$	$\text{INTR}_A$	OUT			OUT	
1	1	X	X	X	0	0	1		Bidirectional bus	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	$\text{IBF}_A$	$\overline{\text{STB}}_A$	$\text{INTR}_A$	IN			OUT	
1	1	X	X	X	0	1	0		Bidirectional bus	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	$\text{IBF}_A$	$\overline{\text{STB}}_A$	$\text{INTR}_A$	OUT			IN	
1	1	X	X	X	0	1	1		Bidirectional bus	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	$\text{IBF}_A$	$\overline{\text{STB}}_A$	$\text{INTR}_A$	IN			IN	
1	1	X	X	X	1	0	X		Bidirectional bus	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	$\text{IBF}_A$	$\overline{\text{STB}}_A$	$\text{INTR}_A$	$\overline{\text{ACK}}_B$	$\overline{\text{OBF}}_B$	$\text{INTR}_B$	OUT	
1	1	X	X	X	1	1	X		Bidirectional bus	$\overline{\text{OBF}}_A$	$\overline{\text{ACK}}_A$	$\text{IBF}_A$	$\overline{\text{STB}}_A$	$\text{INTR}_A$	$\overline{\text{STB}}_B$	$\text{IBF}_B$	$\text{INTR}_B$	IN	

Table 6 Port C set/reset control words

Control words									Hexa-decimal	Port C								Remarks
D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>	PC <sub>7</sub>		PC <sub>6</sub>	PC <sub>5</sub>	PC <sub>4</sub>	PC <sub>3</sub>	PC <sub>2</sub>	PC <sub>1</sub>	PC <sub>0</sub>		
0	X	X	X	0	0	0	0								0			
0	X	X	X	0	0	0	1								1			
0	X	X	X	0	0	1	0							0				
0	X	X	X	0	0	1	1							1				
0	X	X	X	0	1	0	0						0			INTE <sub>B</sub> set/reset for mode 1 input		
0	X	X	X	0	1	0	1						1			INTE <sub>B</sub> set/reset for mode 1 output		
0	X	X	X	0	1	1	0					0						
0	X	X	X	0	1	1	1					1						
0	X	X	X	1	0	0	0				0					INTE <sub>A</sub> set/reset for mode 1 input		
0	X	X	X	1	0	0	1				1					INTE <sub>2</sub> set/reset for mode 2		
0	X	X	X	1	0	1	0			0								
0	X	X	X	1	0	1	1			1								
0	X	X	X	1	1	0	0		0							INTE <sub>A</sub> set/reset for mode 1 output		
0	X	X	X	1	1	0	1		1							INTE <sub>1</sub> set/reset for mode 2		
0	X	X	X	1	1	1	0		0									
0	X	X	X	1	1	1	1		1									

Note 7 : The terminals of port C should be programmed for the output mode, before the bit set/reset operation is executed.

8 : Also used for controlling the interrupt enable flag(INTE)

CMOS PROGRAMMABLE PERIPHERAL INTERFACE

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage	With respect to GND	-0.3~7	V
$V_I$	Input voltage		-0.3~ $V_{CC}+0.3$	V
$V_O$	Output voltage		-0.3~ $V_{CC}+0.3$	V
$T_{opr}$	Operating free-air temperature range		-20~75	°C
$T_{stg}$	Storage temperature range		-65~150	°C

RECOMMENDED OPERATING CONDITIONS ( $T_a = -20 \sim 75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.5	5	5.5	V
GND	Supply voltage		0		V

ELECTRICAL CHARACTERISTICS ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $GND = 0V$ , unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{IH}$	High-level input voltage		2.0		$V_{CC}+0.3$	V
$V_{IL}$	Low-level input voltage		-0.3		0.8	V
$V_{OH}$	Output high voltage (Note10)	$I_{OH} = -400\mu\text{A}$	2.4			V
$V_{OL}$	Output low voltage	$I_{OL} = 2.5\text{mA}$			0.45	V
$I_{CC}$	Supply current from $V_{CC}$	$GND = 0V$ . All input mode. $RESET = 0V$ . Other pins = $V_{CC}$ .			10	$\mu\text{A}$
$I_{IL}$	Input leak current	$GND = 0V$ , $V_I = 0V$ , $V_{CC}$			$\pm 10$	$\mu\text{A}$
$I_{OZ}$	Off-state output current	$GND = 0V$ , $V_I = 0 \sim V_{CC}$			$\pm 10$	$\mu\text{A}$
$C_i$	Input capacitance	$V_{IL} = GND$ , $f = 1\text{MHz}$ , $25\text{mVrms}$ , $T_a = 25^\circ\text{C}$			10	pF
$C_{i/O}$	Input/output terminal capacitance	$V_{i/OL} = GND$ , $f = 1\text{MHz}$ , $25\text{mVrms}$ , $T_a = 25^\circ\text{C}$			20	pF

Note 9 : Current flowing into an IC is positive, out is negative.  
10 :  $I_{OH}$  current must be less than -4mA for each Port pin.

TIMING REQUIREMENTS ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $GND = 0V$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{W(R)}$	Read pulse width	$t_{RR}$		300 [200]			ns
$t_{SU(PE-R)}$	Peripheral setup time before read	$t_{IR}$		0			ns
$t_{H(R-PE)}$	Peripheral hold time after read	$t_{HR}$		0			ns
$t_{SU(A-R)}$	Address setup time before read	$t_{AR}$		0			ns
$t_{H(R-A)}$	Address hold time after read	$t_{RA}$		0			ns
$t_{W(W)}$	Write pulse width	$t_{WW}$		300 [200]			ns
$t_{SU(DQ-W)}$	Data setup time before write	$t_{DW}$		100			ns
$t_{H(W-DQ)}$	Data hold time after write	$t_{WD}$		30 [ 0 ]			ns
$t_{SU(A-W)}$	Address setup time before write	$t_{AW}$		0			ns
$t_{H(W-A)}$	Address hold time after write	$t_{WA}$		20 [ 0 ]			ns
$t_{W(ACK)}$	Acknowledge pulse width	$t_{AK}$		300			ns
$t_{W(STB)}$	Strobe pulse width	$t_{ST}$		500 [350]			ns
$t_{SU(PE-STB)}$	Peripheral setup time before strobe	$t_{PS}$		0			ns
$t_{H(STB-PE)}$	Peripheral hold time after strobe	$t_{PH}$		180 [150]			ns
$t_{C(RW)}$	Read/write cycle time	$t_{RV}$		850			ns

Note 11 : M5M82C55AP-5 is also invested with the extended specification showed in the brackets.

**CMOS PROGRAMMABLE PERIPHERAL INTERFACE**

**SWITCHING CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ , unless otherwise noted)

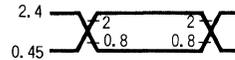
Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{PVZ(R-DQ)}$	Propagation time from read to data output	$t_{RD}$	$C_L = 150\text{pF}$			200(170)	ns
$t_{PZV(R-DQ)}$	Propagation time from read to data floating (Note13)	$t_{DF}$		10		100	ns
$t_{PHL(W-PE)}$	Propagation time from write to output	$t_{WB}$				350	ns
$t_{PLH(W-PE)}$						300	ns
$t_{PLH(STB-IBF)}$	Propagation time from strobe to IBF flag	$t_{SIB}$				300	ns
$t_{PLH(STB-INTR)}$	Propagation time from strobe to interrupt	$t_{SIT}$				300	ns
$t_{PHL(R-INTR)}$	Propagation time from read to interrupt	$t_{RIT}$				400	ns
$t_{PHL(R-IBF)}$	Propagation time from read to IBF flag	$t_{RIB}$				300	ns
$t_{PHL(W-INTR)}$	Propagation time from write to interrupt	$t_{WIT}$				450	ns
$t_{PHL(W-OBF)}$	Propagation time from write to OBF flag	$t_{WOB}$				650	ns
$t_{PLH(ACK-OBF)}$	Propagation time from acknowledge to OBF flag	$t_{AOB}$				350	ns
$t_{PLH(ACK-INTR)}$	Propagation time from acknowledge to interrupt	$t_{AIT}$				350	ns
$t_{PVZ(ACK-PE)}$	Propagation time from acknowledge to data output	$t_{AD}$				300	ns
$t_{PZV(ACK-PE)}$	Propagation time from acknowledge to data floating (Note13)	$t_{KD}$		20		250	ns

Note 12 : M5M82C55AP-5 is also invested with the extended specification showed in the brackets.

13 : Test conditions are not applied.

14 : A.C Testing waveform

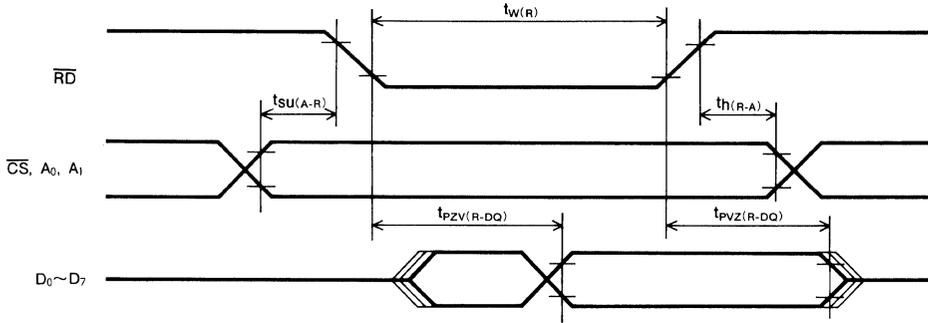
Input pulse level            0.45~2.4V  
 Input pulse rise time        10ns  
 Input pulse fall time        10ns  
 Reference level input         $V_{IH} = 2V$ ,  $V_{IL} = 0.8V$   
 Output                          $V_{OH} = 2V$ ,  $V_{OL} = 0.8V$



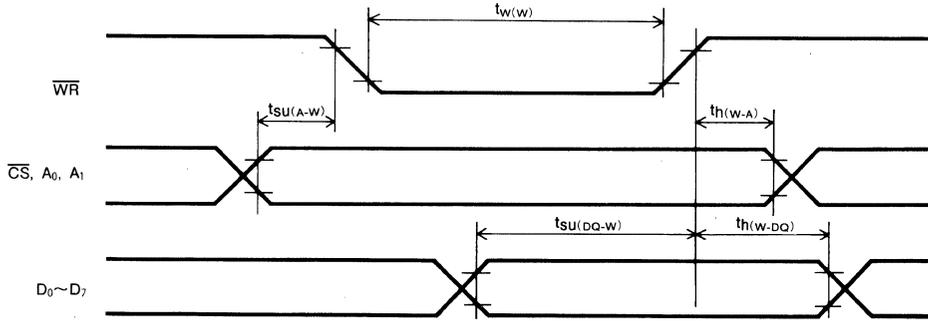
**CMOS PROGRAMMABLE PERIPHERAL INTERFACE**

**TIMING DIAGRAM**

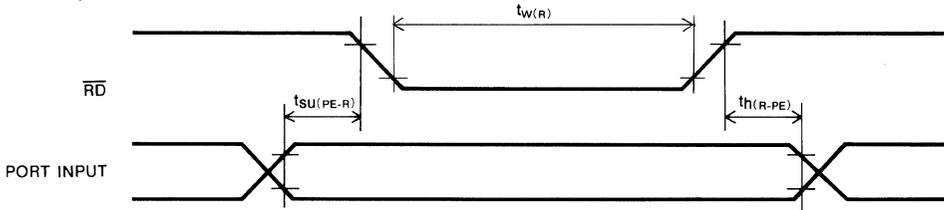
Data bus read operation



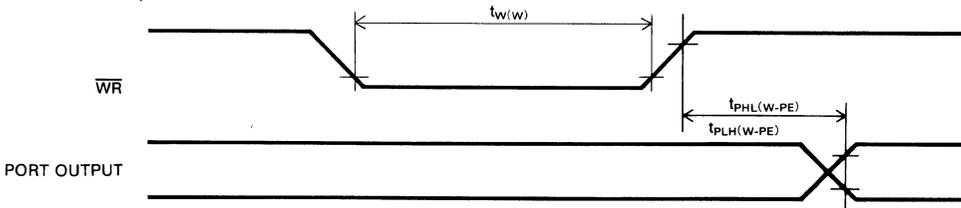
Data bus write operation



Mode 0 Port input



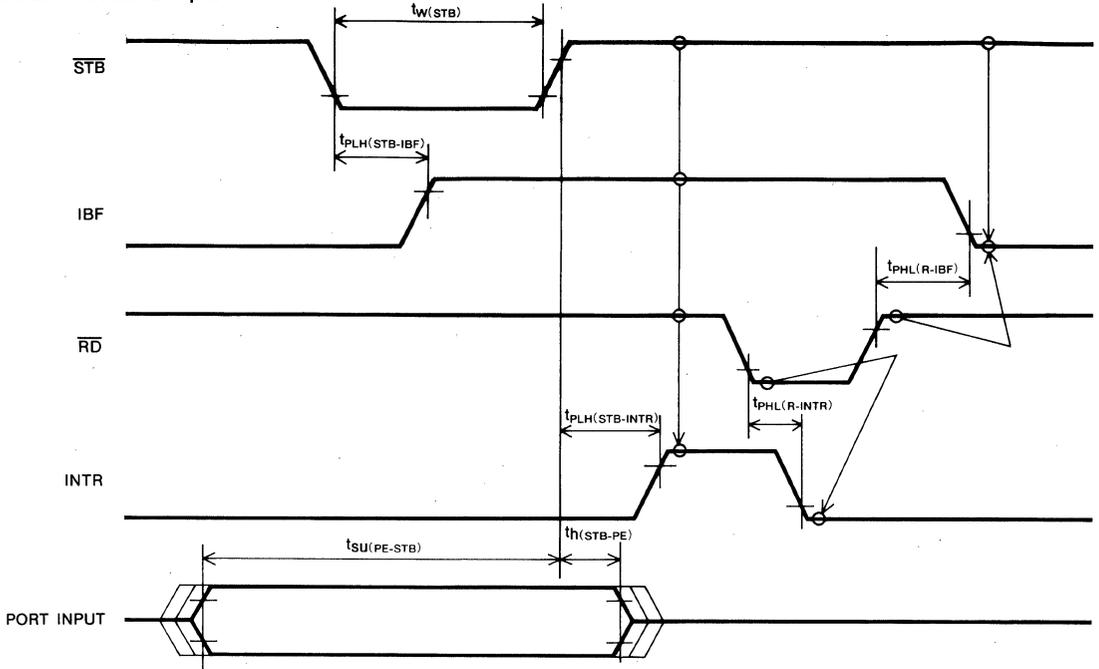
Mode 0, 1 Port output



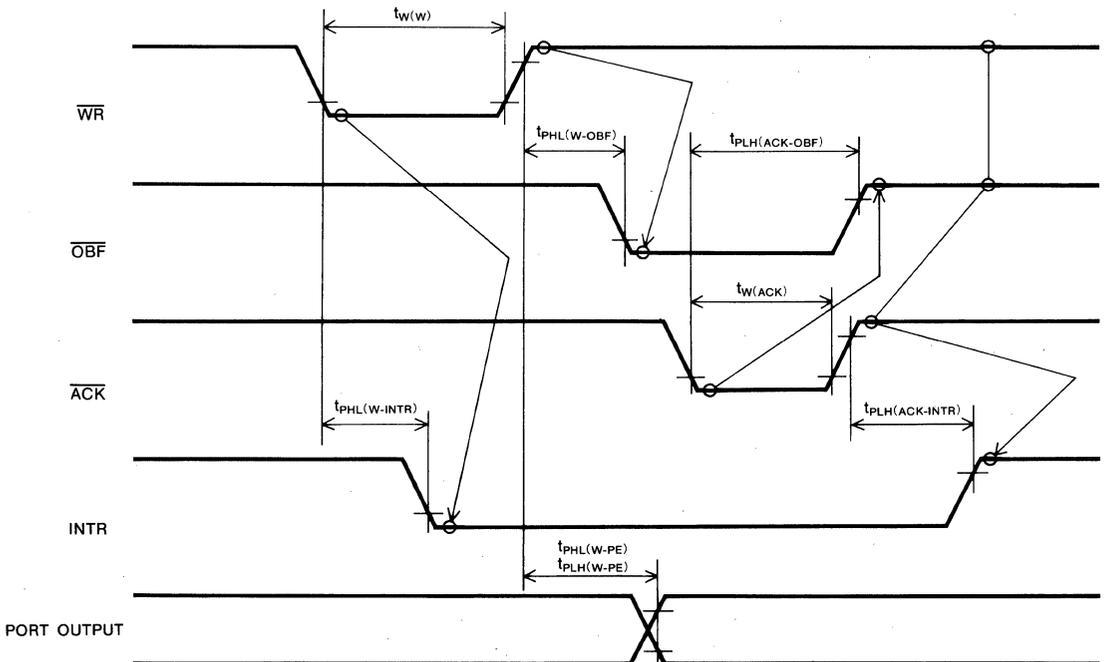
**5**

**CMOS PROGRAMMABLE PERIPHERAL INTERFACE**

**Mode 1 Strobed input**

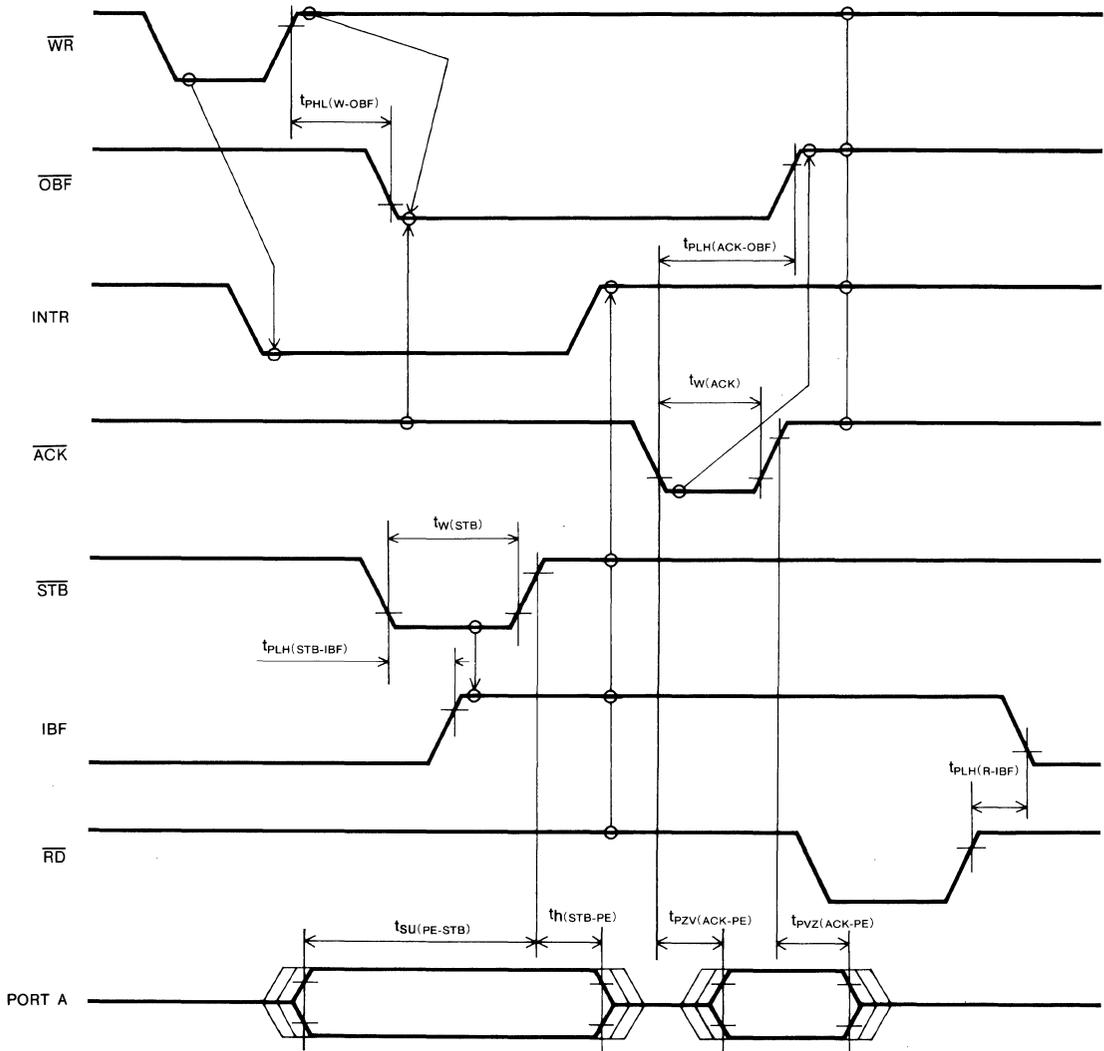


**Mode 1 Strobed output**



**CMOS PROGRAMMABLE PERIPHERAL INTERFACE**

**Mode 2 Bidirectional**



**5**

Note 5:  $INTR = IBF \cdot \overline{MASK} \cdot \overline{STB} \cdot \overline{RD} + \overline{OBF} \cdot \overline{MASK} \cdot \overline{ACK} \cdot \overline{WR}$

# M5M82C55AFP-5

## CMOS PROGRAMMABLE PERIPHERAL INTERFACE

### DESCRIPTION

This is a family of general-purpose programmable input/output devices designed for use with the 8/16-bit parallel CPU as input/output ports.

This device is fabricated using silicon-gate CMOS technology for a single supply voltage. This LSI is a simple input and output interface for TTL circuits, having 24 input/output pins which correspond to three 8-bit input/output ports.

### FEATURES

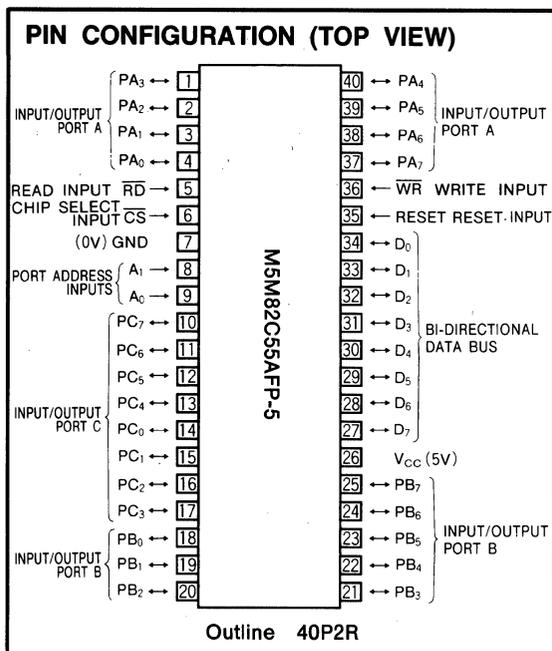
- Single 5V supply voltage
- TTL compatible
- Improved DC driving capability
- Improved timing characteristics
- 24 programmable I/O pins
- Direct bit set/reset capability
- Packaged in flat small outline package

### APPLICATION

Input/output ports for MELPS85, MELPS86, MELPS88 microprocessor

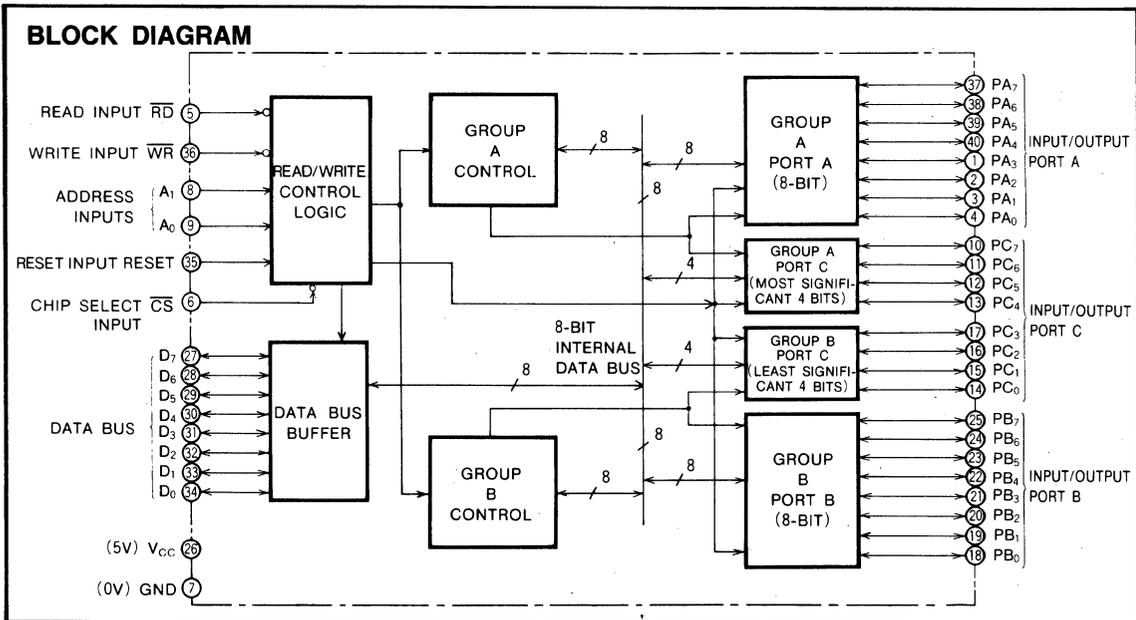
### FUNCTION

These PPIs have 24 input/output pins which may be individually programmed in two 12-bit groups A and B with mode control commands from a CPU. They are used in three major modes of operation, mode 0, mode 1 and mode 2. Operating in mode 0, each group of 12 pins may be programmed in sets of 4 to be inputs or outputs. In mode 1, the 24 I/O terminals may be programmed in two 12-bit groups, group A and group B. Each group contains one 8-bit data port, which may be programmed to serve as input or output, and one 4-bit control port used for handshaking and interrupt



control signals. Mode 2 is used with group A only, as one 8-bit bidirectional bus port and one 5-bit control port. Bit set/reset is controlled by CPU. A high-level reset input (RESET) clears the control register, and all ports are set to the input mode (high-impedance state).

Refer to M5M82C55AP-5 for detail information. M5M82C55AFP-5's specifications are fully compatible with M5M82C55AP-5. Only package outline is different.



MITSUBISHI LSIs  
**M5M82C59AP**

**CMOS PROGRAMMABLE INTERRUPT CONTROLLER**

**DESCRIPTION**

The M5M82C59AP is a programmable LSI for interrupt control. It is fabricated using silicon-gate CMOS technology and is designed to be used easily in connection with an 8085A, 8086 or 8088.

**FEATURES**

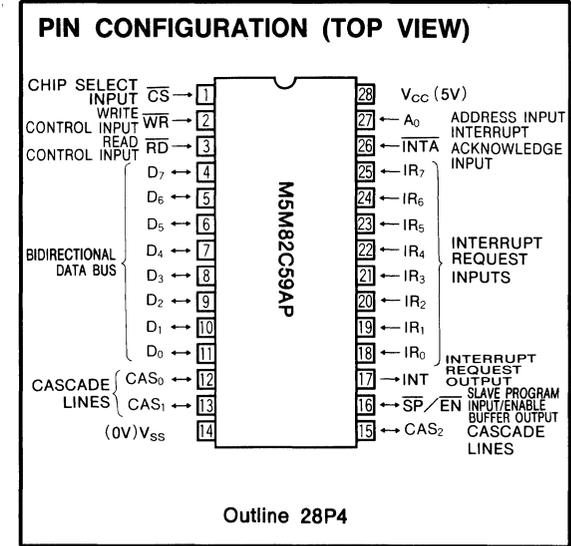
- Single 5V supply voltage
- TTL compatible
- M5M82C59AP is compatible with M5L8259AP in pin connection.
- CALL instruction to the CPU is generated automatically
- Priority, interrupt mask and vectored address for each interrupt request input are programmable
- Up to 64 levels of interrupt requests can be controlled by cascading with M5M82C59AP
- Polling functions

**APPLICATION**

The M5M82C59AP can be used as an interrupt controller for CPUs 8085A, 8086 and 8088

**FUNCTION**

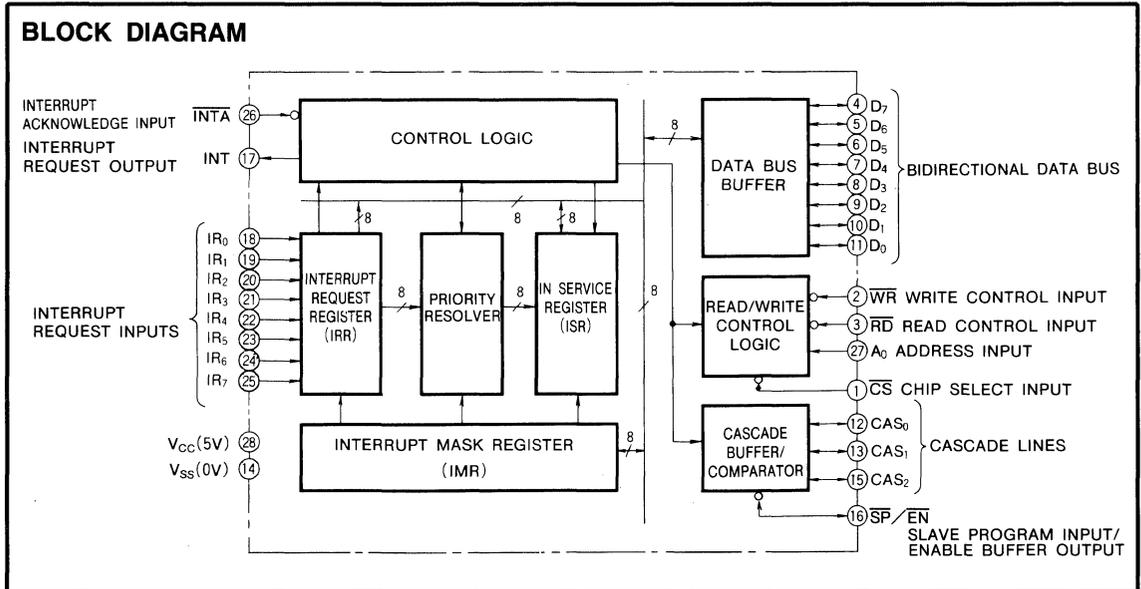
The M5M82C59AP is a device specifically designed for use in real time, interrupt driven microcomputer systems. It manages eight level requests and has built-in features for expandability to other M5M82C59AP's. The priority and interrupt mask can be changed or reconfigured at any time by the main program.



When an interrupt is generated because of an interrupt request at 1 of the pins, the M5M82C59AP based on the mask and priority will output an INT to the CPU. After that, when an  $\overline{INTA}$  signal is received from the CPU or the system controller, a CALL instruction and a programmed vector address is released onto the data bus.

**5**

**BLOCK DIAGRAM**



**CMOS PROGRAMMABLE INTERRUPT CONTROLLER**

**PIN DESCRIPTION**

Symbol	Pin name	Input or output	Functional significance
$\overline{CS}$	Chip select input	Input	This input is active at low-level, but may be at high-level during interrupt request input and interrupt processing.
$\overline{WR}$	Write control input	Input	Command write control input from the CPU
$\overline{RD}$	Read control input	Input	Data read control input for the CPU
$D_7 \sim D_0$	Bidirectional data bus	Input/output	Data and commands are transmitted through this bidirectional data bus to and from the CPU.
$CAS_2 \sim CAS_0$	Cascade lines	Input/output	These pins are outputs for a master and inputs for a slave. And these pins of the master will be able to address each individual slave. The master will enable the corresponding slave to release the device routine address during bytes 2 and 3 of INTA.
$\overline{SP/EN}$	Slave program input/Enable buffer output	Input/output	SP: In normal mode, a master is designated when $\overline{SP/EN}=1$ and a slave is designated when $\overline{SP/EN}=0$ . EN: In the buffered mode, whenever the M5M82C59AP's data bus output is enabled, its SP/EN pin will go low.
INT	Interrupt request output	Output	This pin goes high whenever a valid interrupt is asserted.
$IR_7 \sim IR_0$	Interrupt request input	Input	The asynchronous interrupt inputs are active at high-level. The interrupt mask and priority of each interrupt input can be changed at any time. When using edge triggered mode, the rising edge (low to high) of the interrupt request and the high-level must be held until the first INTA. For level triggered mode, the high-level must be held until the first INTA.
$\overline{INTA}$	Interrupt acknowledge input	Input	When an interrupt acknowledge ( $\overline{INTA}$ ) from the CPU is received, the M5M82C59AP releases a CALL instruction or vectored address onto the data bus.
$A_0$	$A_0$ address input	Input	This pin is normally connected to one of the address lines and acts in conjunction with the the CS, WR and RD when writing commands or reading status registers.

**OPERATION**

The M5M82C59AP is interfaced with a standard system bus as shown in Fig. 1 and operates as an interrupt controller.

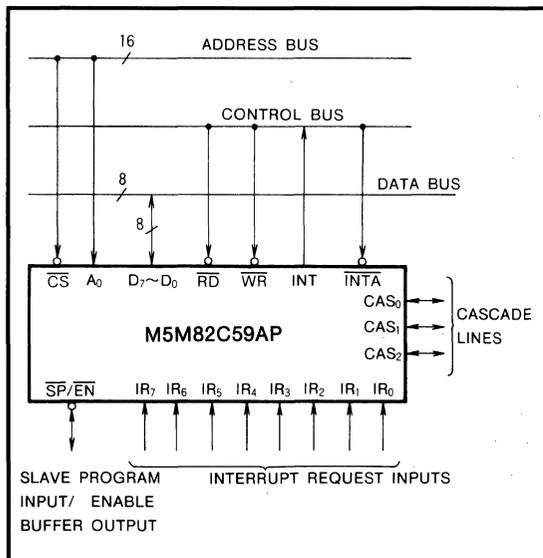


Fig. 1 The M5M82C59AP interfaces to standard system bus.

Table 1 M5M82C59AP basic operation

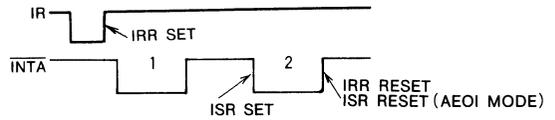
$A_0$	$D_4$	$D_3$	$\overline{RD}$	$\overline{WR}$	$\overline{CS}$	Input operation (read)
0			0	1	0	IRR, ISR or interrupting level→data bus
1			0	1	0	IMR→Data bus
						Output operation (write)
0	0	0	1	0	0	Data bus→OCW2
0	0	1	1	0	0	Data bus→OCW3
0	1	X	1	0	0	Data bus→ICW1
1	X	X	1	0	0	Data bus→OCW1, ICW2, ICW3, ICW4
						Disable function
X	X	X	1	1	0	Data bus→High-impedance
X	X	X	X	X	1	Data bus→High-impedance

**CMOS PROGRAMMABLE INTERRUPT CONTROLLER**

**Interrupt Sequence**

1. When the CPU is an 8085A:

- (1) When one or more of the interrupt request inputs are raised high, the corresponding IRR bit(s) for the high-level inputs will be set.
- (2) Mask state and priority levels are considered and, if appropriate, the M5M82C59AP sends an INT signal to the CPU.
- (3) The acknowledgement of the CPU to the INT signal, the CPU issues an  $\overline{\text{INTA}}$  pulse to the M5M82C59AP.
- (4) Upon receiving the first  $\overline{\text{INTA}}$  pulse from the CPU, a CALL instruction is released onto the data bus.
- (5) A CALL is a 3-byte instruction, so additional two  $\overline{\text{INTA}}$  pulses are issued to the M5M82C59AP from the CPU.
- (6) These two  $\overline{\text{INTA}}$  pulses allow the M5M82C59AP to release the program address onto the data bus. The low-order 8-bit vectored address is released at the second  $\overline{\text{INTA}}$  pulse and the high-order 8-bit vectored address is released at the third  $\overline{\text{INTA}}$  pulse. The ISR bit corresponding to the interrupt request input is set upon receiving the third  $\overline{\text{INTA}}$  pulse from the CPU, and the corresponding IRR bit is reset.
- (7) This completes the 3-byte CALL instruction and the interrupt routine will be serviced. The ISR bit is reset at the trailing edge of the third  $\overline{\text{INTA}}$  pulse in the AEOI mode. In the other modes the ISR bit is not reset until an EOI command is issued.



The interrupt request input must be held at high-level until the first  $\overline{\text{INTA}}$  pulse is issued. If it is allowed to return to low-level before the first  $\overline{\text{INTA}}$  pulse is issued, an interrupt request in  $\text{IR}_7$  is executed. However, in this case the ISR bit is not set.

This is a function for a noise countermeasure of interrupt request inputs. In the interrupt routine of  $\text{IR}_7$ , if ISR is checked by software either the interrupt by noise or real interrupt can be acknowledged. In the state of edge trigger mode normally the interrupt request inputs hold high-level and its input low-level pulse in the case of interrupt.

**Interrupt sequence outputs**

1. When the CPU is an 8085A:

A CALL instruction is released onto the data bus when the first  $\overline{\text{INTA}}$  pulse is issued. The low-order 8 bits of the vectored address are released when the second  $\overline{\text{INTA}}$  pulse is issued, and the high-order 8 bits are released when the third  $\overline{\text{INTA}}$  pulse is issued. The format of these three outputs is shown in Table 2.

**Table 2 Formats of interrupt CALL instruction and vectored address**

First  $\overline{\text{INTA}}$  pulse (CALL instruction)

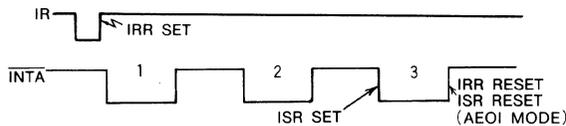
D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
1	1	0	0	1	1	0	1

Second  $\overline{\text{INTA}}$  pulse (low-order 8-bit of vectored address)

IR	Interval= 4							
	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
$\text{IR}_0$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	0	0	0	0	0
$\text{IR}_1$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	0	0	1	0	0
$\text{IR}_2$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	0	1	0	0	0
$\text{IR}_3$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	0	1	1	0	0
$\text{IR}_4$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	0	0	0
$\text{IR}_5$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	1	0	0
$\text{IR}_6$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	0	0	0
$\text{IR}_7$	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	1	0	0

2. When the CPU is an 8086 or 8088:

- (1) When one or more of the interrupt request inputs are raised high, the corresponding IRR bit(s) for the high-level inputs will be set.
- (2) Mask state and priority levels are considered and if appropriated, the M5M82C59AP sends an INT signal to the CPU.
- (3) As an acknowledgement to the INT signal, the CPU issues an  $\overline{\text{INTA}}$  pulse to the M5M82C59AP.
- (4) Upon receiving the first  $\overline{\text{INTA}}$  pulse from the CPU, the M5M82C59AP does not drive the data bus, and the data bus keeps high-impedance state.
- (5) When the second  $\overline{\text{INTA}}$  pulse is issued from the CPU, an 8-bit pointer is released onto the data bus.
- (6) This completes the interrupt cycle and the interrupt routine will be serviced. The ISR bit is reset at the trailing edge of the second  $\overline{\text{INTA}}$  pulse in the AEOI mode. In the other modes the ISR bit is not reset until an EOI command is issued from the CPU.



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IR	Interval=8							
	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
IR <sub>0</sub>	A <sub>7</sub>	A <sub>6</sub>	0	0	0	0	0	0
IR <sub>1</sub>	A <sub>7</sub>	A <sub>6</sub>	0	0	1	0	0	0
IR <sub>2</sub>	A <sub>7</sub>	A <sub>6</sub>	0	1	0	0	0	0
IR <sub>3</sub>	A <sub>7</sub>	A <sub>6</sub>	0	1	1	0	0	0
IR <sub>4</sub>	A <sub>7</sub>	A <sub>6</sub>	1	0	0	0	0	0
IR <sub>5</sub>	A <sub>7</sub>	A <sub>6</sub>	1	0	1	0	0	0
IR <sub>6</sub>	A <sub>7</sub>	A <sub>6</sub>	1	1	0	0	0	0
IR <sub>7</sub>	A <sub>7</sub>	A <sub>6</sub>	1	1	1	0	0	0

Third INTA pulse (high-order 8 bits of vectored address)

D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
A <sub>15</sub>	A <sub>14</sub>	A <sub>13</sub>	A <sub>12</sub>	A <sub>11</sub>	A <sub>10</sub>	A <sub>9</sub>	A <sub>8</sub>

2. When the CPU is a 8086 or 8088:

The data bus keeps a high-impedance state when the first INTA pulse is issued. Then the pointer T<sub>7</sub>~T<sub>0</sub> is released when the next INTA pulse is issued. The content of the pointer T<sub>7</sub>~T<sub>0</sub> is shown in Table 3. The T<sub>2</sub>~T<sub>0</sub> are a binary code corresponding to the interrupt request level, A<sub>10</sub> ~ A<sub>5</sub> are unused and ADI mode control is ignored.

Table 3 Contents of interrupt pointer  
Second INTA pulse (8-bit pointer)

	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>
IR <sub>0</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	0	0	0
IR <sub>1</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	0	0	1
IR <sub>2</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	0	1	0
IR <sub>3</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	0	1	1
IR <sub>4</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	1	0	0
IR <sub>5</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	1	0	1
IR <sub>6</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	1	1	0
IR <sub>7</sub>	T <sub>7</sub>	T <sub>6</sub>	T <sub>5</sub>	T <sub>4</sub>	T <sub>3</sub>	1	1	1

**Interrupt Request Register (IRR), In-service Register (ISR)**

As interrupt requests are received at inputs IR<sub>7</sub>~IR<sub>0</sub>, the corresponding bits of IRR are set and as an interrupt request is serviced the corresponding bit of ISR is set. The IRR is used to store all the interrupt levels which are requesting service, and the ISR is used to store all the interrupt levels which are being serviced. The status of these two registers can be read. These two registers are connected through the priority resolver.

An interrupt request received by IR<sub>n</sub> is acknowledged on the leading edge when in the edge triggered mode or it is acknowledged on the level when in the level triggered mode. After that an INT signal is released and the interrupt

request signal is latched in the corresponding IRR bit if the high-level is held until the first INTA pulse is issued. It is important to remember that the interrupt request signal must be held at high-level until the first INTA pulse is issued.

The interrupt request latching in the IRR causes a signal to be sent to the priority resolver unless it is masked out. When the priority resolver receives the signals it selects the highest priority interrupt request latched in IRR. The ISR is set when the last INTA pulse is issued while the corresponding bit of IRR is reset and the other bits of IRR are unaffected.

The bit of ISR that was set is not reset during the interrupt routine, but is reset at the end of the routine by the EOI command (end of interrupt) or by the trailing edge of the last INTA pulse in AEIOI mode.

**Priority Resolver**

The priority resolver examines all of the interrupt requests set in IRR to determine and selects the highest priority. The ISR bit corresponding to the selected (highest priority) request is set by the last INTA pulse.

**Interrupt Mask Register (IMR)**

The contents of the interrupt mask register are used to mask out (disable) interrupt requests of selected interrupt request pins. Each terminal is independently masked so that masking a high priority interrupt does not influence the lower or higher priority interrupts. Therefore the contents of IMR selectively enable reading.

**Interrupt Request Output (INT)**

The interrupt request output connects directly to the interrupt input of the CPU. The output level is compatible with the input level required for the CPUs.

**Interrupt Acknowledge Input (INTA)**

The CALL instruction and vectored address are released onto the data bus by the INTA pulse.

**Data Bus Buffer**

The data bus buffer is a 3-state bidirectional data bus buffer that is used to interface with the system bus. Write commands to the M5M82C59AP, CALL instructions, vectored addresses, status information, etc. are transferred through the data bus buffer.

**Read/Write Control Logic**

The read/write control logic is used to control functions such as receiving commands from the CPU and supplying status information to the data bus.

**Chip Select (CS)**

The M5M82C59AP is selected (enabled) when CS is at low-level, but during interrupt request input or interrupt processing it may be high-level.

**Write Control Input (WR)**

When WR goes to low-level the M5M82C59AP can be written.

**Read Control Input (RD)**

When RD goes low status information in the internal register of the M5M82C59AP can be read through the data bus.

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**Address Input (A<sub>0</sub>)**

The address input is normally connected with one of the address lines and is used along with  $\overline{WR}$  and  $\overline{RD}$  to control write commands and reading status information.

**Cascade Buffer/Comparator**

The cascade buffer/comparator stores or compares identification codes. The three cascade lines are output when the M5M82C59AP is a master or input when it is a slave. The identification code on the cascade lines select it as master or slave.

**PROGRAMMING THE M5M82C59AP**

The M5M82C59AP is programmed through the Initialization Command Word (ICW) and the operation command word (OCW). The following explains the functions of these two commands.

**Initialization Command Words (ICW<sub>s</sub>)**

The initialization command word is used for the initial setting of the M5M82C59AP. There are four commands in this group and the following explains the details of these four commands.

**ICW1**

The meaning of the bits of ICW1 is explained in Fig. 3 along with the functions. ICW1 contains vectored address bits A<sub>7</sub>~A<sub>5</sub>, a flag indicating whether interrupt input is edge triggered or level triggered, CALL address interval, whether a single M5M82C59AP or the cascade mode is used, and whether ICW4 is required or not.

Whenever a command is issued with A<sub>0</sub>=0 and D<sub>4</sub>=1,

this is interpreted as ICW1 and the following will automatically occur.

- (a) The interrupt mask register (IMR) is cleared.
- (b) The interrupt request input IR<sub>7</sub> is assigned the lowest priority.
- (c) The special mask mode is cleared and the status read is set to the interrupt request register (IRR).
- (d) When IC4=0 all bits in ICW4 are set to zero.

**ICW2**

ICW2 contains vectored address bits A<sub>15</sub>~A<sub>8</sub> or interrupt type T<sub>7</sub>~T<sub>3</sub>, and the format is shown in Fig. 3.

**ICW3**

When SNGL=1 it indicates that only a single M5M82C59AP is used in the system, in which case ICW3 is not valid. When SNGL=0, ICW3 is valid and indicates cascade connections with other M5M82C59AP devices. In the master mode, a "1" is set for each slave.

When the CPU is an 8085A the CALL instruction is released from the master at the first  $\overline{INTA}$  pulse and the vectored address is released onto the data bus from the slave at the second and third  $\overline{INTA}$  pulses.

When the CPU is a 8086 the master and slave are in high-impedance at the first  $\overline{INTA}$  pulse and the pointer is released onto the data bus from the slave at the second  $\overline{INTA}$  pulse.

The master mode is specified when  $\overline{SP/EM}$  pin is high-level or BUF=1 and M/S=1 in ICW4, and slave mode is specified when  $\overline{SP/EM}$  pin is low-level or BUF=1 and M/S

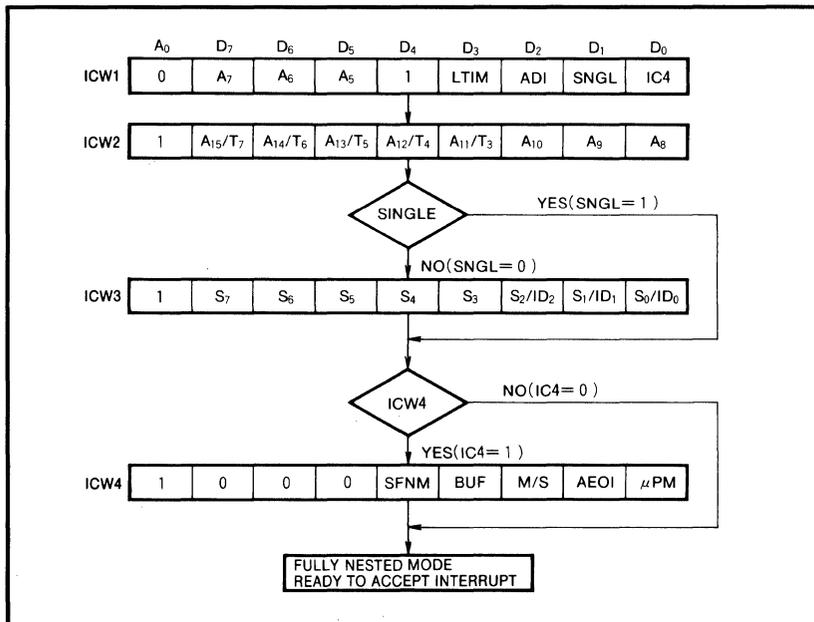


Fig. 2 Initialization sequence

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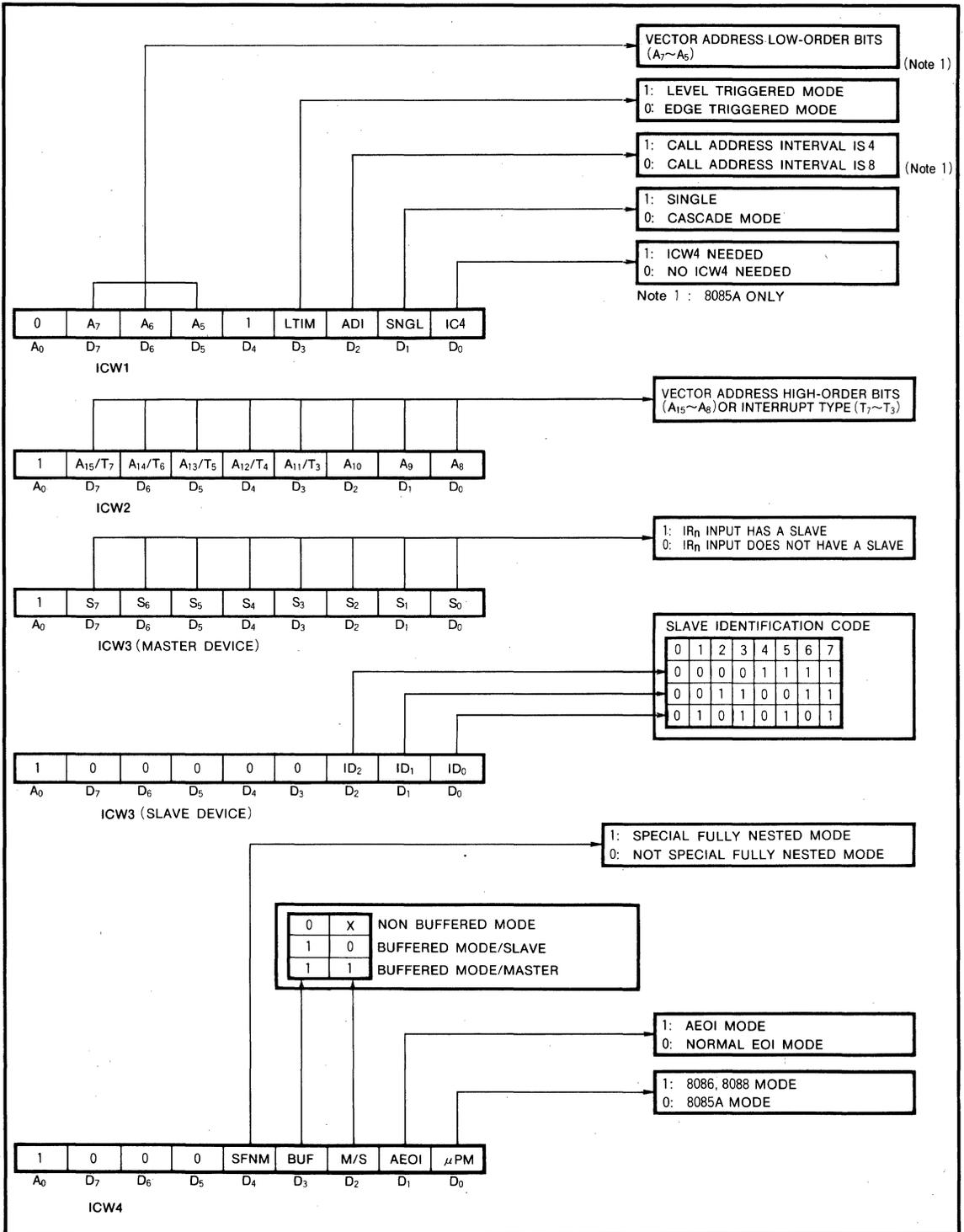


Fig. 3 Initialization command word format

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=0 in ICW4. In the slave mode, three bits  $ID_2 \sim ID_0$  identify the slave. And then when the slave code released on the cascade lines from the master, matches the assigned ID code, the vectored address is released by it onto the data bus at the next  $\overline{INTA}$  pulse.

**ICW4**

Only when  $IC4=1$  in ICW1 is ICW4 valid. Otherwise all bits are set to zero. When ICW4 is valid it specifies special fully nested mode, buffer mode master/slave, automatic EOI and microprocessor mode. The format of ICW4 is shown in Fig. 3.

**Operation Command Words (OCW<sub>s</sub>)**

The operation command words are used to change the contents of IMR, the priority of interrupt request inputs and the special mask. After the ICW are programmed into the

M5M82C59AP, the device is ready to accept interrupt requests. There are three types of OCW<sub>s</sub>; explanation of each follows, and the format of OCW<sub>s</sub> is shown in Fig. 4.

**OCW1**

The meaning of the bits of OCW1 are explained in Fig. 4 along with their functions. Each bit of IMR can be independently changed (set or reset) by OCW1.

**OCW2**

The OCW2 is used for issuing EOI commands to the M5M82C59AP and for changing the priority of the interrupt request inputs.

**OCW3**

The OCW3 is used for specifying special mask mode, poll mode and status register read.

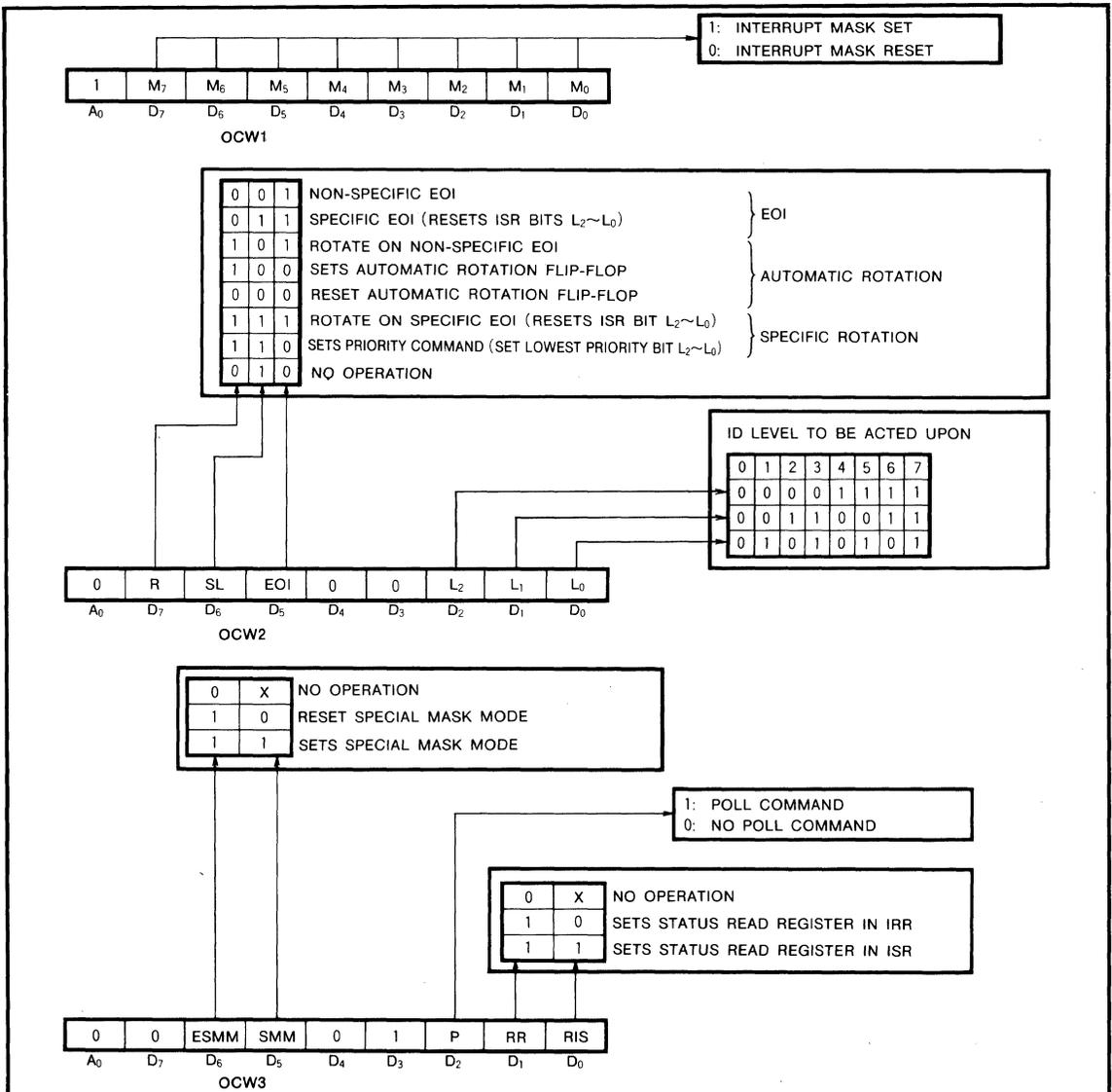


Fig. 4 Operation command word format

**CMOS PROGRAMMABLE INTERRUPT CONTROLLER**

**FUNCTION OF COMMAND**

**Interrupt masks**

The mask register contains a mask for each individual interrupt request. These interrupt masks can be changed by programming using OCW1.

**Special mask mode**

When an interrupt request is acknowledged and the ISR bit corresponding to the interrupt request is not reset by EOI command (which means an interrupt service routine is executing) lower priority interrupt requests are ignored.

In special mask mode interrupt requests received at interrupt request inputs which are masked by OCW1 are disabled, but interrupts at all levels that are not masked are possible. This means that in the mask mode all level of interrupts are possible or individual inputs can be selectively programmed so all interrupts at the selected inputs are disabled. The masks are stored in IMR and special mask is set/reset by executing OCW3.

**Buffered mode**

The buffered mode will structure the M5M82C59AP to send an enable signal on  $\overline{SP/EN}$  to enable the data bus buffer, when the data bus requires the data bus buffer or when cascading mode is used. In this mode, when data bus output of the M5M82C59AP is enabled, the  $\overline{SP/EN}$  output becomes low-level. This allows the M5M82C59AP to be programmed whether it is a master or a slave by software. The buffered mode is set/reset by executing ICW4.

**Fully nested mode**

The fully nested mode is the mode when no mode is specified and is the usual operational mode. In this mode, the priority of interrupt request terminals is fixed from the lowest  $IR_7$  to the highest  $IR_0$ . When an interrupt request is acknowledged the CALL instruction and vectored address are released onto the data bus. At the same time the ISR bit corresponding to the accepted interrupt request is set. This ISR bit remains set until it is reset by the input of an EOI command or until the trailing edge of last  $\overline{INTA}$  pulse in AEIOI mode. While an interrupt service routine is being executed, interrupt requests of same or lower priority are disabled while the bit of ISR remains set. The priorities can be changed by OCW2.

**Special fully nested mode**

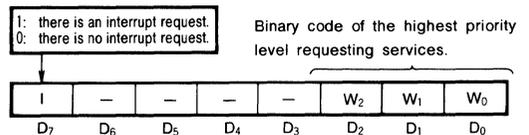
The special fully nested mode will be used when cascading is used and this mode will be programmed to the master by ICW4. The special fully nested mode is the same as the fully nested mode with the following two exceptions.

1. When an interrupt from a certain slave is being serviced, this slave is not locked out from the master priority logic. Higher priority interrupts within the slave will be recognized by the master and the master will initiate an interrupt request to the CPU. In general in the normal fully nested mode, a serviced slave is locked out from the master's priority, and so higher priority interrupts from the same slave are not serviced.

2. When an interrupt from a certain slave is being serviced the software must check ISR to determine if there are additional interrupts requests to be serviced. If the ISR bit is 0 the EOI command may be sent to the master too. But if it is not 0 the EOI command should not be sent to the master.

**Poll mode**

The poll mode is useful when the internal enable flip-flop of the microprocessor is reset, and interrupt input is disabled. Service to the device is achieved by a programmer initiative using a poll command. In the poll mode the M5M82C59AP at the next  $\overline{RD}$  pulse puts 8 bits on the data bus which indicates whether there is an interrupt request and reads the priority level. The format of the information on the data bus is as shown below.



When  $I=0$  (no interrupt request),  $W_2 \sim W_0$  is 111. The poll is valid from  $\overline{WR}$  to  $\overline{RD}$  and interrupt is frozen. This mode can be used for processing common service routines for interrupts from more than one line and does not require any  $\overline{INTA}$  sequence. Poll command is issued by setting  $P=1$  in OCW3.

**End of interrupt (EOI) and specific EOI (SEOI)**

An EOI command is required by the M5M82C59AP to reset the ISR bit. So an EOI command must be issued to the M5M82C59AP before returning from an interrupt service routine.

When AEIOI is selected in ICW4, the ISR bit can be reset at the trailing edge of the last  $\overline{INTA}$  pulse. When AEIOI is not selected the ISR bit is reset by the EOI command issued to the M5M82C59AP before returning from an interrupt service routine. When programmed in the cascade mode the EOI command must be issued to the master once and to corresponding slave once.

There are two forms of EOI command, specific EOI and non-specific EOI. When the M5M82C59AP is used in the fully nested mode, the ISR bit being serviced is reset by the EOI command. When the non-specific EOI is issued the M5M82C59AP will automatically reset the highest ISR bit of those that are set. Other ISR bits are reset by a specific EOI and the bit to be reset is specified in the EOI by the program. The SEOI is useful in modes other than fully nested mode. When the M5M82C59AP is in special mask mode ISR bits masked in IMR are not reset by EOI. EOI and SEOI are selected when OCW2 is executed.

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**Automatic EOI (AEOI)**

In the AEOI mode the M5M82C59AP executes non-specific EOI command automatically at the trailing edge of the last  $\overline{INTA}$  pulse. When AEOI=1 in ICW4, the M5M82C59AP is put in AEOI mode continuously until reprogrammed in ICW4.

**Automatic rotation**

The automatic rotation mode is used in applications where many interrupt requests of the same level are expected such as multichannel communication systems. In this mode when an interrupt request is serviced, that request is assigned the lowest priority so that if there are other interrupt requests they will have higher priorities. This means that the next request on the interrupt request being serviced must wait until the other interrupt requests are serviced (worst case is waiting for all 7 of the other controllers to be serviced). The priority and serving status are rotated as shown in Fig. 5.

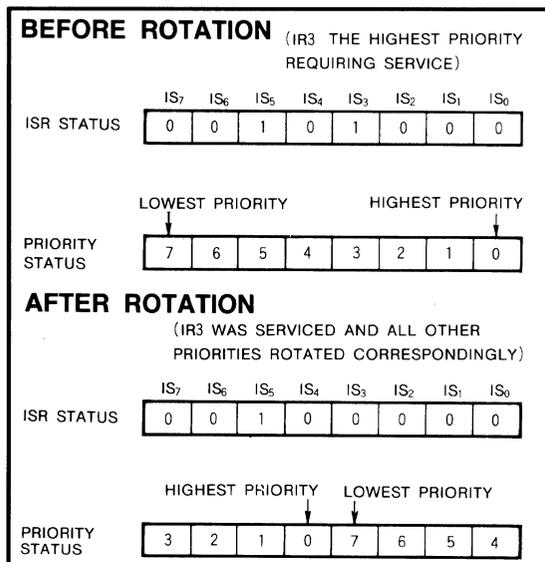


Fig. 5 An example of priority rotation

In the non-specific EOI command automatic rotation mode is selected when R=1, EOI=1, SL=0 in OCW2. The internal priority status is changed by EOI or AEOI commands. The rotation priority A flip-flop is set by R=1, EOI=0 and SL=0 which is useful when the M5M82C59AP is used in the AEOI mode.

**Specific rotation**

Specific rotation gives the user versatile capabilities in interrupt controlled operations. It serves in those applications in which a specific device's interrupt priority must be altered. As opposed to automatic rotation which automatically sets priorities, specific rotation is completely user controlled. That is, the user selects the interrupt level that is to receive

lowest or highest priority. Priority changes can be executed during an EOI command.

**Level triggered mode/Edge triggered mode**

Selection of level or edge triggered mode of the M5M82C59AP is made by ICW1. When using edge triggered mode not only is a transition from low to high required, but the high-level must be held until the first  $\overline{INTA}$ . If the high-level is not held until the first  $\overline{INTA}$ , the interrupt request will be treated as if it were input on IR<sub>7</sub>, except that the ISR bit is not set. When level triggered mode is used the functions are the same as edge triggered mode except that the transition from low to high is not required to trigger the interrupt request.

In the level triggered mode and using AEOI mode together, if the high-level is held too long the interrupt will occur immediately. To avoid this situation interrupts should be kept disabled until the end of the service routine or until the IR input returns low. In the edge triggered mode this type of mistake is not possible because the interrupt request is edge triggered.

**Reading the M5M82C59AP internal status**

The contents of IRR and ISR can be read by the CPU with status read. When an OCW3 is issued to the M5M82C59AP and an RD pulse issued the contents of IRR or ISR can be released onto the data bus. A special command is not required to read the contents of IMR. The contents of IMR can be released onto the data bus by issuing an RD pulse when A<sub>0</sub>=1. There is no need to issue a read register command every time the IRR or ISR is to be read. Once a read register command is received by the M5M82C59AP, it remains valid until it is changed. Remember that the programmer must issue a poll command every time to check whether there is an interrupt request and read the priority level. Polling overrides status read when P=1, RR=1 in OCW3.

**Cascading**

The M5M82C59AP can be interconnected in a system of one master with up to eight slaves to handle up to 64 priority levels. A system of three units that can be used with the 8085A is shown in Fig. 6.

The master can select a slave by outputting its identification code through the three cascade lines. The INT output of each slave is connected to the master interrupt request inputs. When an interrupt request of one of the slaves is to be serviced the master outputs the identification code of the slave through the cascade lines, so the slave will release the vectored address on the next  $\overline{INTA}$  pulse.

The cascade lines of the master are normally low, and will contain the slave identification code from the leading edge of the first  $\overline{INTA}$  pulse to the trailing edge of the last  $\overline{INTA}$  pulse. The master and slave can be programmed to work in different modes. ICWs must be issued for each device, and EOI commands must be issued twice: once for the master and once for the corresponding slave. Each  $\overline{CS}$  of the M5M82C59AP requires an address decoder.

5

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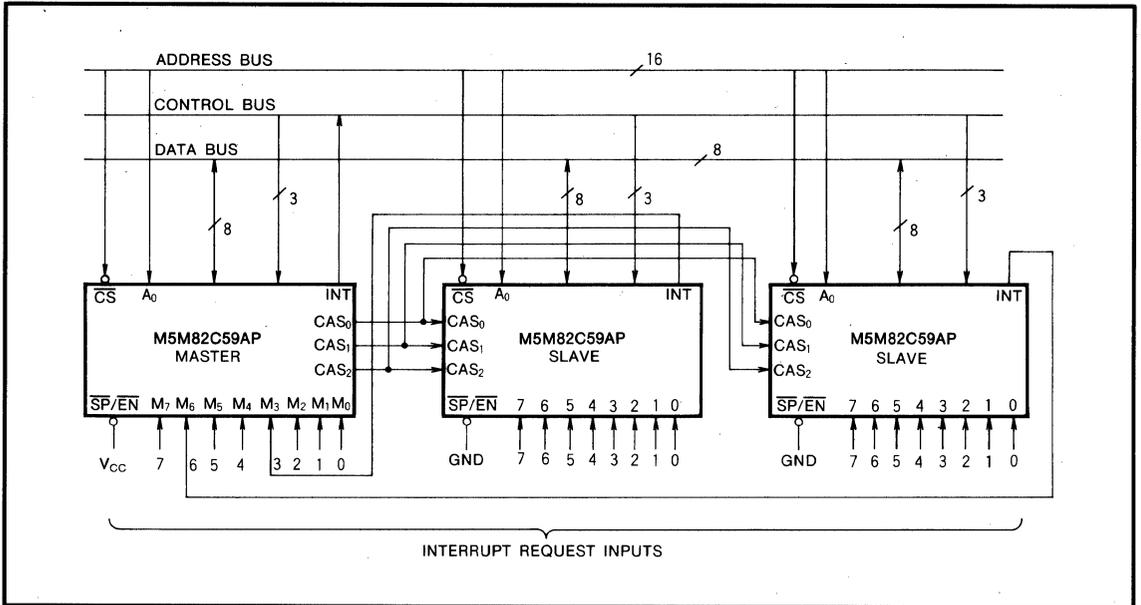
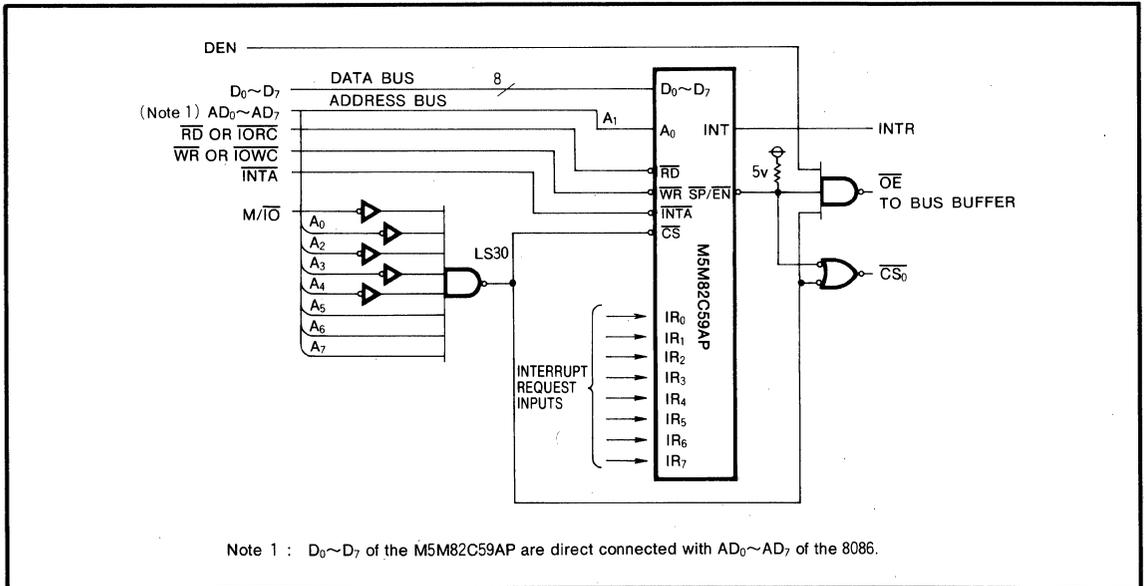


Fig. 6 Cascading the M5M82C59AP



Note 1 : D<sub>0</sub>~D<sub>7</sub> of the M5M82C59AP are direct connected with AD<sub>0</sub>~AD<sub>7</sub> of the 8086.

Fig. 7 Example of interface with the 8086

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INSTRUCTION SET

Item Number	Mnemonic	Instruction code									Function			
		A <sub>0</sub>	D <sub>7</sub>	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>	ICW4 required?	Interval	Single	Trigger
1	ICW1 A	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	1	1	0	N	4	Y	E
2	ICW1 B	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	1	1	0	N	4	Y	L
3	ICW1 C	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	1	0	0	N	4	N	E
4	ICW1 D	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	1	0	0	N	4	N	L
5	ICW1 E	0	A <sub>7</sub>	A <sub>6</sub>	0	1	0	0	1	0	N	8	Y	E
6	ICW1 F	0	A <sub>7</sub>	A <sub>6</sub>	0	1	1	0	1	0	N	8	Y	L
7	ICW1 G	0	A <sub>7</sub>	A <sub>6</sub>	0	1	0	0	0	0	N	8	N	E
8	ICW1 H	0	A <sub>7</sub>	A <sub>6</sub>	0	1	1	0	0	0	N	8	N	L
9	ICW1 I	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	1	1	1	Y	4	Y	E
10	ICW1 J	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	1	1	1	Y	4	Y	L
11	ICW1 K	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	0	1	0	1	Y	4	N	E
12	ICW1 L	0	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	1	1	1	0	1	Y	4	N	L
13	ICW1 M	0	A <sub>7</sub>	A <sub>6</sub>	0	1	0	0	1	1	Y	8	Y	E
14	ICW1 N	0	A <sub>7</sub>	A <sub>6</sub>	0	1	1	0	1	1	Y	8	Y	L
15	ICW1 O	0	A <sub>7</sub>	A <sub>6</sub>	0	1	0	0	0	1	Y	8	N	E
16	ICW1 P	0	A <sub>7</sub>	A <sub>6</sub>	0	1	1	0	0	1	Y	8	N	L
17	ICW2	1	A <sub>15</sub>	A <sub>14</sub>	A <sub>13</sub>	A <sub>12</sub>	A <sub>11</sub>	A <sub>10</sub>	A <sub>9</sub>	A <sub>8</sub>	8-bit vectored address			
18	ICW3 M	1	S <sub>7</sub>	S <sub>6</sub>	S <sub>5</sub>	S <sub>4</sub>	S <sub>3</sub>	S <sub>2</sub>	S <sub>1</sub>	S <sub>0</sub>	Slave connections (master mode)			
19	ICW3 S	1	0	0	0	0	0	ID <sub>2</sub>	ID <sub>1</sub>	ID <sub>0</sub>	Slave identification code (slave mode)			
											SFNM	BUF	AEOI	8086
20	ICW4 A	1	0	0	0	0	0	0	0	0	N	N	N	N
21	ICW4 B	1	0	0	0	0	0	0	0	1	N	N	N	Y
22	ICW4 C	1	0	0	0	0	0	0	1	0	N	N	Y	N
23	ICW4 D	1	0	0	0	0	0	0	1	1	N	N	Y	Y
24	ICW4 E	1	0	0	0	0	0	1	0	0	N	N	N	N
25	ICW4 F	1	0	0	0	0	0	1	0	1	N	N	N	Y
26	ICW4 G	1	0	0	0	0	0	1	1	0	N	N	Y	N
27	ICW4 H	1	0	0	0	0	0	1	1	1	N	N	Y	Y
28	ICW4 I	1	0	0	0	0	1	0	0	0	N	Y S	N	N
29	ICW4 J	1	0	0	0	0	1	0	0	1	N	Y S	N	Y
30	ICW4 K	1	0	0	0	0	1	0	1	0	N	Y S	Y	N
31	ICW4 L	1	0	0	0	0	1	0	1	1	N	Y S	Y	Y
32	ICW4 M	1	0	0	0	0	1	1	0	0	N	Y M	N	N
33	ICW4 N	1	0	0	0	0	1	1	0	1	N	Y M	N	Y
34	ICW4 O	1	0	0	0	0	1	1	1	0	N	Y M	Y	N
35	ICW4 P	1	0	0	0	0	1	1	1	1	N	Y M	Y	Y
36	ICW4 NA	1	0	0	0	1	0	0	0	0	Y	N	N	N
37	ICW4 NB	1	0	0	0	1	0	0	0	1	Y	N	N	Y
38	ICW4 NC	1	0	0	0	1	0	0	1	0	Y	N	Y	N
39	ICW4 ND	1	0	0	0	1	0	0	1	1	Y	N	Y	Y
40	ICW4 NE	1	0	0	0	1	0	1	0	0	Y	N	N	N
41	ICW4 NF	1	0	0	0	1	0	1	0	1	Y	N	N	Y
42	ICW4 NG	1	0	0	0	1	0	1	1	0	Y	N	Y	N
43	ICW4 NH	1	0	0	0	1	0	1	1	1	Y	N	Y	Y
44	ICW4 NI	1	0	0	0	1	1	0	0	0	Y	Y S	N	N
45	ICW4 NJ	1	0	0	0	1	1	0	0	1	Y	Y S	N	Y
46	ICW4 NK	1	0	0	0	1	1	0	1	0	Y	Y S	Y	N
47	ICW4 NL	1	0	0	0	1	1	0	1	1	Y	Y S	Y	Y
48	ICW4 NM	1	0	0	0	1	1	1	0	0	Y	Y M	N	N
49	ICW4 NN	1	0	0	0	1	1	1	0	1	Y	Y M	N	Y
50	ICW4 NO	1	0	0	0	1	1	1	1	0	Y	Y M	Y	N
51	ICW4 NP	1	0	0	0	1	1	1	1	1	Y	Y M	Y	Y
52	OCW1	1	M <sub>7</sub>	M <sub>6</sub>	M <sub>5</sub>	M <sub>4</sub>	M <sub>3</sub>	M <sub>2</sub>	M <sub>1</sub>	M <sub>0</sub>	Interrupt mask			
53	OCW2 E	0	0	0	1	0	0	0	0	0	EOI			
54	OCW2 SE	0	0	1	1	0	0	L <sub>2</sub>	L <sub>1</sub>	L <sub>0</sub>	SEOI			
55	OCW2 RE	0	1	0	1	0	0	0	0	0	Rotate on Non-Specific EOI command (Automatic rotation)			
56	OCW2 RSE	0	1	1	1	0	0	L <sub>2</sub>	L <sub>1</sub>	L <sub>0</sub>	Rotate on Specific EOI command (Specific rotation)			
57	OCW2 R	0	1	0	0	0	0	0	0	0	Rotate in AE0I Mode (SET)			
58	OCW2 CR	0	0	0	0	0	0	0	0	0	Rotate in AE0I Mode (CLEAR)			
59	OCW2 RS	0	1	1	0	0	0	L <sub>2</sub>	L <sub>1</sub>	L <sub>0</sub>	Set priority without EOI			
60	OCW3 P	0	0	0	0	0	1	1	0	0				
61	OCW3 RIS	0	0	0	0	0	1	0	1	1				
62	OCW3 RR	0	0	0	0	0	1	0	1	0				
63	OCW3 SM	0	0	1	1	0	1	0	0	0				
64	OCW3 RSM	0	0	1	0	0	1	0	0	0				

Note : Y: yes, N: no, E: edge, L: level, M: master, S: slave

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CMOS PROGRAMMABLE INTERRUPT CONTROLLER

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
V <sub>CC</sub>	Power-supply voltage	With respect to V <sub>SS</sub>	-0.3~7	V
V <sub>I</sub>	Input voltage		-0.3~V <sub>CC</sub> +0.3	V
V <sub>O</sub>	Output voltage		-0.3~V <sub>CC</sub> +0.3	V
T <sub>opr</sub>	Operating free-air temperature range		-20~75	°C
T <sub>stg</sub>	Storage temperature range		-65~150	°C

RECOMMENDED OPERATING CONDITIONS (T<sub>a</sub> = -20~75°C, unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
V <sub>CC</sub>	Supply voltage	4.5	5	5.5	V
V <sub>SS</sub>	Supply voltage		0		V

ELECTRICAL CHARACTERISTICS (T<sub>a</sub> = -20~75°C, V<sub>CC</sub> = 5V±10%, V<sub>SS</sub> = 0V, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
V <sub>IH</sub>	High-level input voltage		2		V <sub>CC</sub> +0.3	V
V <sub>IL</sub>	Low-level input voltage		-0.3		0.8	V
V <sub>OH</sub>	High-level output voltage	I <sub>OH</sub> = -400μA	2.4			V
V <sub>OH(INT)</sub>	High-level output voltage, interrupt request output	I <sub>OH</sub> = -100μA	3.5			V
		I <sub>OH</sub> = -400μA	2.4			
V <sub>OL</sub>	Low-level output voltage	I <sub>OL</sub> = 2.2mA			0.45	V
I <sub>CC</sub>	Standby supply current from V <sub>CC</sub>	V <sub>CC</sub> = 5.5V, V <sub>I</sub> = V <sub>CC</sub> or GND output open			10	μA
I <sub>IH</sub>	High-level input current	V <sub>I</sub> = V <sub>CC</sub>	-10		10	μA
I <sub>IL</sub>	Low-level input current	V <sub>I</sub> = 0V	-10		10	μA
I <sub>OZ</sub>	Off-state output current	V <sub>SS</sub> = 0, V <sub>I</sub> = 0~V <sub>CC</sub>	-10		10	μA
I <sub>IH(IR)</sub>	High-level input current, interrupt request inputs	V <sub>I</sub> = V <sub>CC</sub>			10	μA
I <sub>IL(IR)</sub>	Low-level input current, interrupt request inputs	V <sub>I</sub> = 0V	-300			μA
C <sub>i</sub>	Input capacitance	V <sub>CC</sub> = V <sub>SS</sub> , f = 1MHz, 25mVrms, T <sub>a</sub> = 25°C			10	pF
C <sub>i/O</sub>	Input/output capacitance	V <sub>CC</sub> = V <sub>SS</sub> , f = 1MHz, 25mVrms, T <sub>a</sub> = 25°C			20	pF

TIMING REQUIREMENTS (T<sub>a</sub> = -20~75°C, V<sub>CC</sub> = 5V±10%, V<sub>SS</sub> = 0V, unless otherwise noted)

Symbol	Parameter	Alternative Symbol	Limits			Unit
			Min	Typ	Max	
t <sub>W(W)</sub>	Write pulse width	t <sub>WLWH</sub>	290(200)			ns
t <sub>SU(A-W)</sub>	Address setup time before write	t <sub>AHWL</sub>	0			ns
t <sub>h(W-A)</sub>	Address hold time after write	t <sub>WHAX</sub>	0			ns
T <sub>SU(DQ-W)</sub>	Data setup time before write	t <sub>DVWH</sub>	240(100)			ns
t <sub>h(W-DQ)</sub>	Data hold time after write	t <sub>WHDX</sub>	0			ns
t <sub>W(R)</sub>	Read pulse width	t <sub>RLRH</sub>	235(200)			ns
t <sub>SU(A-R)</sub>	Address setup time before read	t <sub>AHRL</sub>	0			ns
t <sub>h(R-A)</sub>	Address hold time after read	t <sub>RHAX</sub>	0			ns
t <sub>W(IR)</sub>	Interrupt request input width, low-level time, edge triggered mode	t <sub>IJLJH</sub>	100			ns
t <sub>SU(CAS-INTA)</sub>	Cascade setup time after INTA (slave)	t <sub>CVIAL</sub>	55			ns
t <sub>rec(W)</sub>	Write recovery time	t <sub>WHRL</sub>	190			ns
t <sub>rec(R)</sub>	Read recovery time	t <sub>RHRL</sub>	160			ns
t <sub>d(RW)</sub>	End of Command to next Command (Not same Command type)	t <sub>CHCL</sub>	500			ns
	End of INTA sequence to next INTA sequence.					

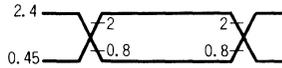
**CMOS PROGRAMMABLE INTERRUPT CONTROLLER**

**SWITCHING CHARACTERISTICS** ( $T_a = -20 \sim 75^\circ\text{C}$ ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted)

Symbol	Parameter	Alternative Symbol	Limits			Unit
			Min	Typ	Max	
$t_{PZV(R-DQ)}$	Data output enable time after read	$t_{RLDV}$			200[170]	ns
$t_{PVZ(R-DQ)}$	Data output disable time after read	$t_{RHDZ}$	10		100	ns
$t_{PZV(A-DQ)}$	Data output enable time after address	$t_{AHDV}$			200[170]	ns
$t_{PHL(R-EN)}$	Propagation time from read to enable signal output	$t_{RLEL}$			125	ns
$t_{PLH(R-EN)}$	Propagation time from read to disable signal output	$t_{RHEH}$			150	ns
$t_{PLH(IR-INT)}$	Propagation time from interrupt request input to interrupt request output	$t_{JHIH}$			350	ns
$t_{PLV(INTA-CAS)}$	Propagation time from INTA to cascade output (master)	$t_{IALCV}$			565	ns
$t_{PZV(CAS-DQ)}$	Data output enable time after cascade output (slave)	$t_{CVDV}$			300	ns

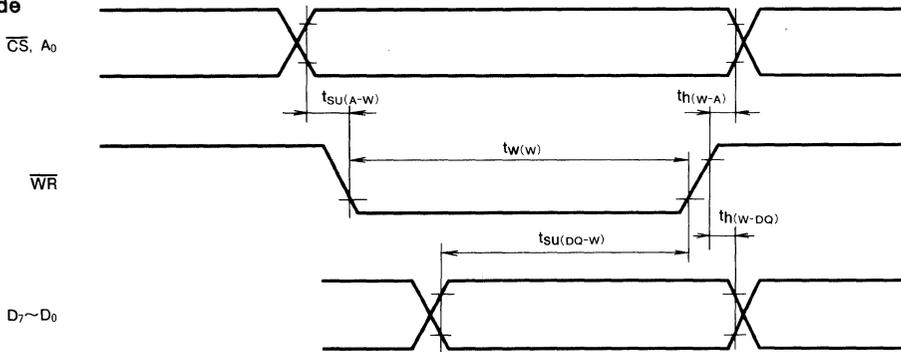
Note 1 : M5M82C59AP is also invested with the extended specification showed in the brackets.

- 2 : INTA signal is considered read signal  
 CS signal is considered address signal  
 Input pulse level 0.45~2.4V  
 Input pulse rise time 10ns  
 Input pulse fall time 10ns  
 Reference level Input  $V_{IH} = 2V$ ,  $V_{IL} = 0.8V$   
 Output  $V_{OH} = 2V$ ,  $V_{OL} = 0.8V$   
 Load capacitance  $C_L = 100\text{pF}$ , where SP/EN pin is 15pF

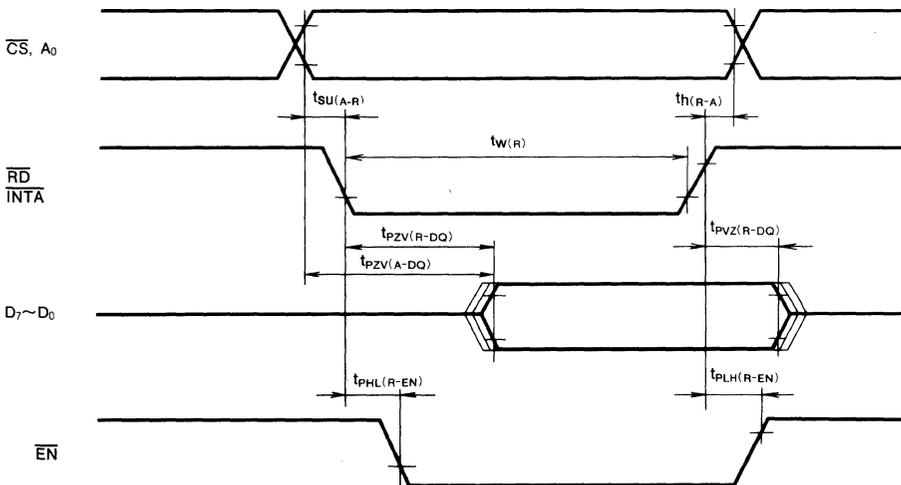


**TIMING DIAGRAM**

**Write Mode**



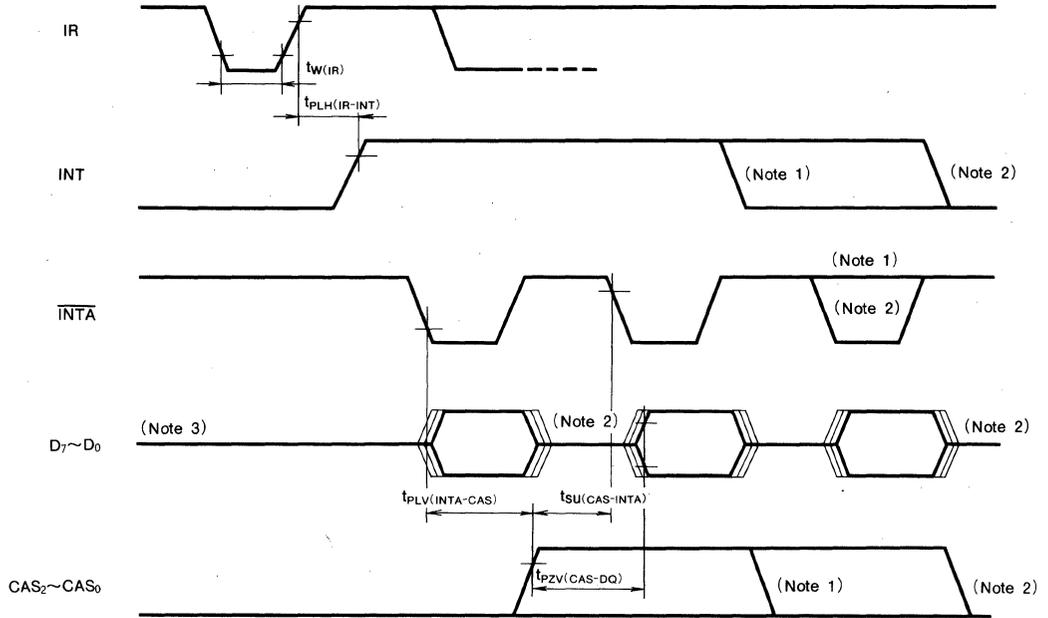
**Read Mode**



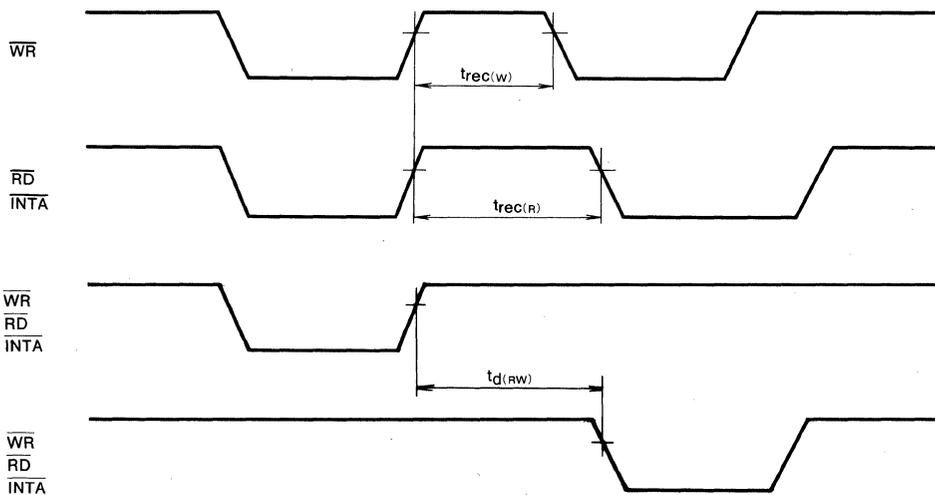
**5**

**CMOS PROGRAMMABLE INTERRUPT CONTROLLER**

**Interrupt Sequence**



**Other Timing**



- Note 1 : 8086, 8088 mode
- 2 : 8085A mode
- 3 : 8086, 8088 mode is in high-impedance state, pointer is released during the next INTA. When in single 8085A mode, data is released by all INTAs. When master, CALL instruction is released during the first INTA, high impedance state during the second and third INTA. When slave, high impedance state during the first INTA, vectored address is released during the second and third INTA.

# M5M82C59AFP

## CMOS PROGRAMMABLE INTERRUPT CONTROLLER

### DESCRIPTION

The M5M82C59AFP is a programmable LSI for interrupt control. It is fabricated using silicon-gate CMOS technology and is designed to be used easily in connection with an 8085A, 8086 or 8088.

### FEATURES

- Single 5V supply voltage
- TTL compatible
- CALL instruction to the CPU is generated automatically
- Priority, interrupt mask and vectored address for each interrupt request input are programmable
- Up to 64 levels of interrupt requests can be controlled by cascading with M5M82C59AFP
- Polling functions
- Packaged in flat small outline package

### APPLICATION

The M5M82C59AFP can be used as an interrupt controller for CPUs 8085A, 8086 and 8088

### FUNCTION

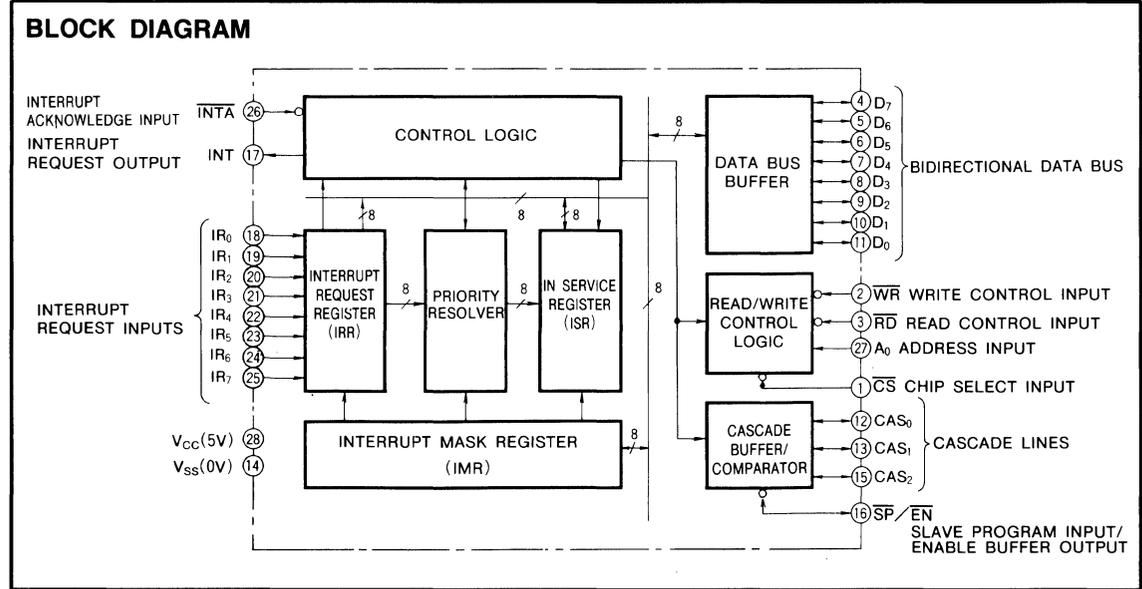
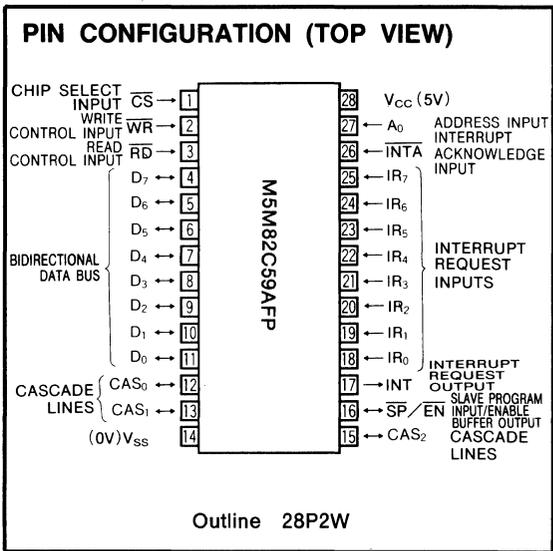
The M5M82C59AFP is a device specifically designed for use in real time, interrupt driven microcomputer systems. It manages eight level requests and has built-in features for expandability to other M5M82C59AFP's. The priority and interrupt mask can be changed or reconfigured at any time by the main program.

When an interrupt is generated because of an interrupt

request at 1 of the pins, the M5M82C59AFP based on the mask and priority will output an INT to the CPU. After that, when an INTA signal is received from the CPU or the system controller, a CALL instruction and a programmed vector address is released onto the data bus.

Refer to M5M82C59AP for detail information. M5M82C59AFP's specifications are compatible with M5M82C59AP. Only package outline is different.

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**PRELIMINARY**  
 Notice: This is not a final specification. Some  
 parameter limits are Subject to change.

**MITSUBISHI LSIs**  
**M58992P**

**CMOS CRT CONTROLLER**

**DESCRIPTION**

The M58992P is a raster scan type CRT interface device, fabricated using silicon gate CMOS technology. This LSI is a one-chip type high-performance video display generator having the timing signal generator and attribute circuits required for CRT display so as to allow system configuration with a small number of components.

**FEATURES**

- Single 5V supply voltage.
- Can generate video display using simple external circuit
- 10 programmable display modes
- Some mode conditionally allows mixed use with other mode.
- Color display is programmable to use either 8 or 16 colors.
- The R, G and B signals are provided as video output signals.
- Can superimpose on TV screen
- A 16K or 64K DRAM is used as the video RAM under control of the built-in DRAM controller.
- The video RAM area can be used concurrently for storage of display data and microprocessor program.
- Paging and scrolling are possible.
- Cursor control; blinking, blanking, underline and reverse characters are possible.
- Light pen input control function is provided.
- Various interrupts generating function is provided.

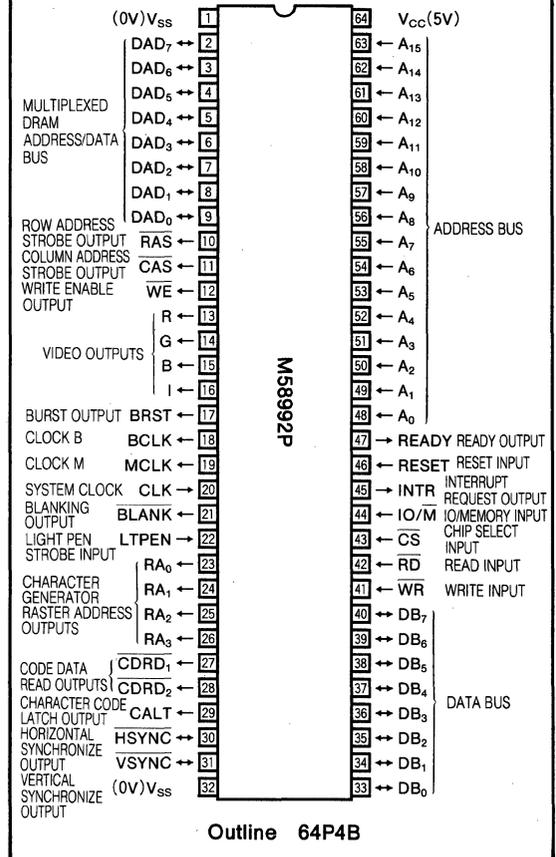
**APPLICATION**

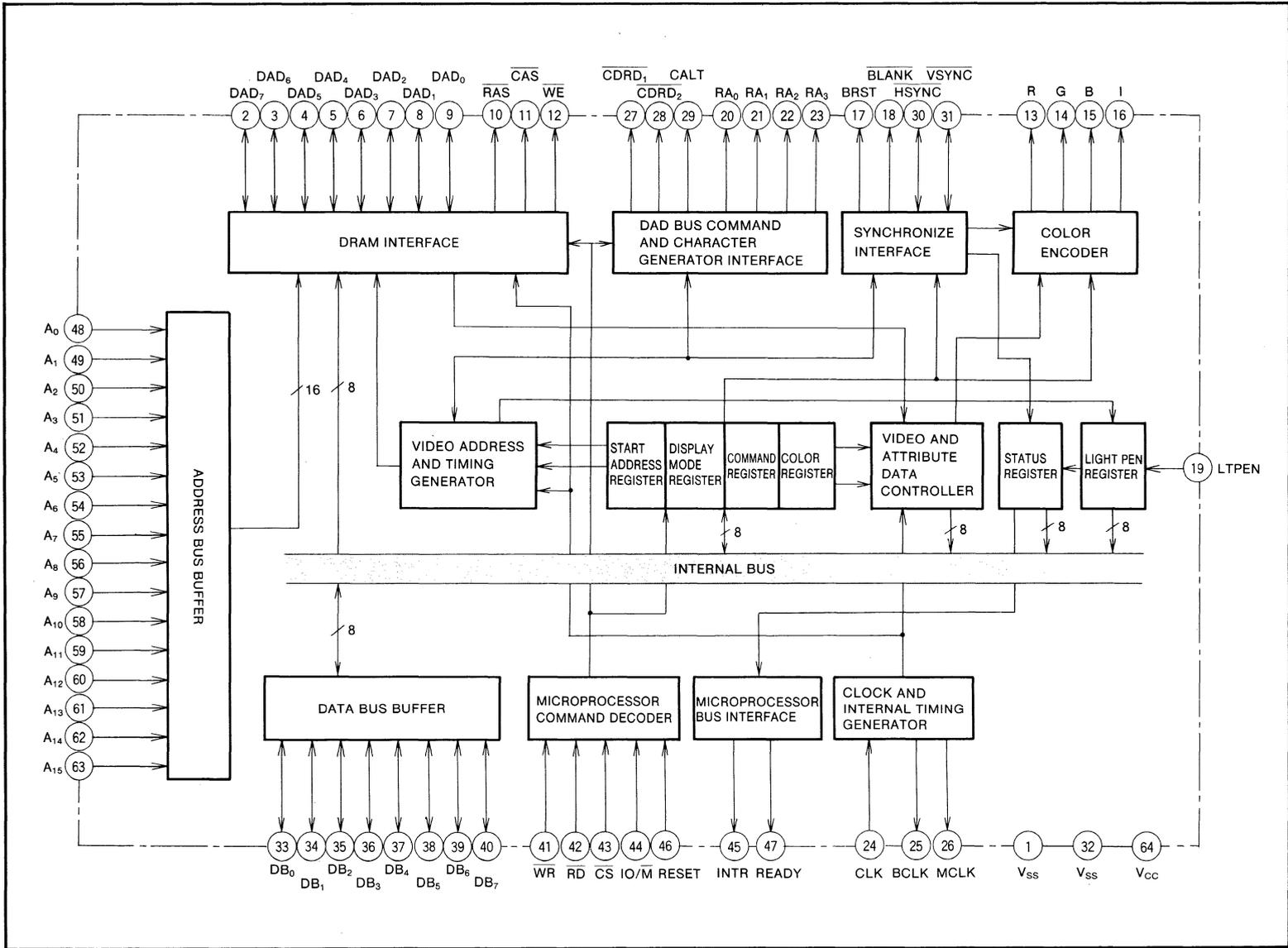
Display unit using home TV set or monitor TV set

**FUNCTION**

The information or data to be displayed on the screen is written in the video RAM by the microprocessor. The M58992P can read the video RAM in the order of the CRT scan, and can generate synchronization signal for a CRT.

**PIN CONFIGURATION (TOP VIEW)**





CMOS CRT CONTROLLER

MITSUBISHI LSIS  
M58992P

CMOS CRT CONTROLLER

PIN DESCRIPTION

Pin	Name	Input/output	Functions
DAD <sub>7</sub> ~ DAD <sub>0</sub>	Multiplexed DRAM address /data bus	Input/output	Causes data input from DRAM or data output for writing in DRAM by output of multiplexed row and column address to DRAM.
$\overline{\text{RAS}}$	Row address strobe output	Output	DRAM address input is latched at falling edge of $\overline{\text{RAS}}$ .
$\overline{\text{CAS}}$	Column address strobe output	Output	DRAM address input is latched at falling edge of $\overline{\text{CAS}}$ .
$\overline{\text{WE}}$	Write enable output	Output	Data from microprocessor is written in DRAM when this signal is "L".
R	Video output R	Output	TTL level output of video signals R, G and B.  Auxiliary output for R, G and B. By external Combination with R, G and B, up to 16 colors can be displayed. I = "H" indicates high luminance.
G	Video output G		
B	Video output B		
I	Video output luminance		
BRST	Burst output	Output	Signal to indicate color burst signal position or sub-carrier frequency phase-modulated by RGB in case of NTSC system.
BCLK	Clock B	Output	Frequency at 1/4 of clock input. Subcarrier frequency in NTSC color system.
MCLK	Clock M	Output	Internal timing clock. Indicates DRAM access by the M58992P for display when this signal is "L" in the text 1, text 2, graphic 1, graphic 2, graphic 3 or graphic 5 mode.
CLK	System clock	Input	14.31818MHz for display using NTSC system.
BLANK	Blanking output	Output	Indicates around the synchronizing pulse in horizontal or vertical blanking period of the M58992P.
LTPEN	Light pen strobe input	Input	Signal to latch internal address value.
RA <sub>3</sub> ~ RA <sub>0</sub>	Character generator raster address outputs	Output	Least significant 4 bits of address for use of character generator to be used in text mode.
$\overline{\text{CDRD1}}$ $\overline{\text{CDRD2}}$	Code data read outputs	Output	Signal to control external circuit for input of display code pattern to the M58992P. CDRD1 is the timing for direct data input from DRAM to the M58992P, and CDRD2 is the timing for input from character generator.
CALT	Character code latch output	Output	Signal to cause external latching of character generator pointer output from DRAM.
$\overline{\text{HSYNC}}$	Horizontal synchronize output	Open drain output	Setting synchronizing signal input mode by command causes no generation of internal synchronizing signal but internal counter reset by external signal.
$\overline{\text{VSYNC}}$	Vertical synchronize output		

**PIN DESCRIPTION (CONTINUED)**

Pin	Name	Input/output	Functions																														
DB <sub>7</sub> ~DB <sub>0</sub>	Data bus	Input/output	Data bus DB <sub>7</sub> : MSB																														
$\overline{WR}$	Write input	Input	<table border="1"> <thead> <tr> <th>Function</th> <th><math>\overline{CS}</math></th> <th>IO/<math>\overline{M}</math></th> <th><math>\overline{RD}</math></th> <th><math>\overline{WR}</math></th> </tr> </thead> <tbody> <tr> <td>No LSI selection</td> <td>1</td> <td>—</td> <td>—</td> <td>—</td> </tr> <tr> <td>DRAM Read</td> <td>0</td> <td>0</td> <td>0</td> <td>1</td> </tr> <tr> <td>DRAM Write</td> <td>0</td> <td>0</td> <td>1</td> <td>0</td> </tr> <tr> <td>The M58992P register read</td> <td>0</td> <td>1</td> <td>0</td> <td>1</td> </tr> <tr> <td>The M58992P register write</td> <td>0</td> <td>1</td> <td>1</td> <td>0</td> </tr> </tbody> </table> <p>The M58992P starts DRAM access or internal register read/write upon <math>\overline{CS}</math>.</p>	Function	$\overline{CS}$	IO/ $\overline{M}$	$\overline{RD}$	$\overline{WR}$	No LSI selection	1	—	—	—	DRAM Read	0	0	0	1	DRAM Write	0	0	1	0	The M58992P register read	0	1	0	1	The M58992P register write	0	1	1	0
Function	$\overline{CS}$	IO/ $\overline{M}$		$\overline{RD}$	$\overline{WR}$																												
No LSI selection	1	—		—	—																												
DRAM Read	0	0		0	1																												
DRAM Write	0	0		1	0																												
The M58992P register read	0	1	0	1																													
The M58992P register write	0	1	1	0																													
$\overline{RD}$	Read input	Input																															
$\overline{CS}$	Chip select input	Input																															
IO/ $\overline{M}$	IO/memory input	Input																															
INTR	Interrupt request output	Output	Interrupt request output generated for any of four reasons in the M58992P can be masked. The status register detects the type of interrupt. The INTR signal is reset upon status read.																														
RESET	Reset input	Input	The M58992P system reset signal to initialize various registers.																														
READY	Ready output	Output	Normally "H" signal. Goes to "L" upon selection of DRAM and returns to "H" upon completion of DRAM read/write. This signal provides synchronism with the microprocessor.																														
A <sub>15</sub> ~A <sub>0</sub>	Address bus	Input	Address input on the microprocessor side. A <sub>15</sub> is the MSB. A <sub>0</sub> to A <sub>3</sub> are used for register reading or writing.																														

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CMOS CRT CONTROLLER

Table 1 The M58992P display mode list

Mode	Screen format (60Hz specification.)	Character or dot composition	Color designation	Programming method			VRAM capacity (in bytes) (60Hz specification)	Cursor and blinking	VRAM access from micro-processor	Screen format (50Hz specification)	VRAM capacity (in bytes) (50Hz specification)
				VRAM	CLRG1	CLRG2					
Text 1	40 characters X25 lines	8X8 dots	FG : 16 colors BG : 8 colors BD : 16 colors	16 bits/ character (8 bits for character and 8 bits for color designa- tion)	Border color designation, etc.	Unused	Unused	2000	Cursor allowed. Multiple blinking positions may be dis- signed in character units.	40 characters X30 lines	2400
Text 2	40 characters X20 lines	8X10 dots									
Text 3	80 characters X25 lines	8X8 dots								80 characters X30 lines	4800
Text 4	80 characters X20 lines	8X10 dots									
Graphic 1	160H X100V	1 block : 2X2 dots	FG : 16 colors BD : 16 colors	4 bits/dot	Border color, etc.	MSB 4 bits, BG color	Unused	8000	Always Possible without flickering.	160H X120V	9600
Graphic 2	160H X200V	1 block : 2X1 dots								160H X240V	19200
Graphic 3	320H X200V	1 block : 1X1 dot	FG : Semi 16 colors BD : 16 colors	2 bits/dot	Border color, etc.	Color pallet for FG	Unused	16000	Always Possible without flickering.	320H X240V	19200
Graphic 4	320H X200V	1 block : 1X1 dot	FG : 16 colors BD : 16 colors	4 bits/dot						MSB 4 bits, BG color	Unused
Graphic 5	640H X200V	1 block : 1X1 dot	FG : One seleted color BD : 16 colors	1 bits/dot	Border color, etc.	BG and FG color de- signation	Unused	16000	Same as text 1 and 2 modes	640H X240V	
Graphic 6	640H X200V	1 block : 1X1 dot	Same as graphic 3	2 bits/dot						Border color, etc.	Color pallet for FG

FG=Foreground BG=Background BD=Border CLRG1~3=Color register

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# APPLICATION

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# NOTICE FOR CMOS PERIPHERALS

## 1. INTRODUCTION

Mitsubishi Electric's microprocessor-support CMOS peripheral LSI devices are compatible with current NMOS peripheral devices, and feature the additional advantages listed below.

- Compatibility with 8251A, 8254, 8255A, 8237A, 8259A.
- Low power dissipation
- Wide supply voltage range,  $V_{CC}=5V\pm 10\%$
- Wide operating temperature range,  $T_a=-20\sim 75^\circ\text{C}$
- Improved timing conditions

Due to these advantageous features, CMOS peripheral devices can be used to replace conventional NMOS devices in their typical applications, and can additionally be used in applications requiring low power dissipation.

The following sections describe the basic characteristics of Mitsubishi Electric's CMOS peripheral LSI devices for microprocessor support, and explain precautions and methods of use.

## 2. BASIC CIRCUITS AND CONSTRUCTION

The internal circuitry of CMOS devices consist of both p-channel and n-channel transistors.

There are two types of NMOS transistors. In the depletion-type, drain-to-source remains on even when gate-to-source voltage is 0V, and with the enhancement-type device, dropping gate-to-source voltage below the threshold voltage level turns the transistor off. CMOS devices employ the enhancement type, regardless of whether they are p-channel or n-channel devices.

Fig. 1 shows the typical inverter, which is the basis of CMOS peripherals and Fig. 2 illustrates its equivalent circuit diagram.

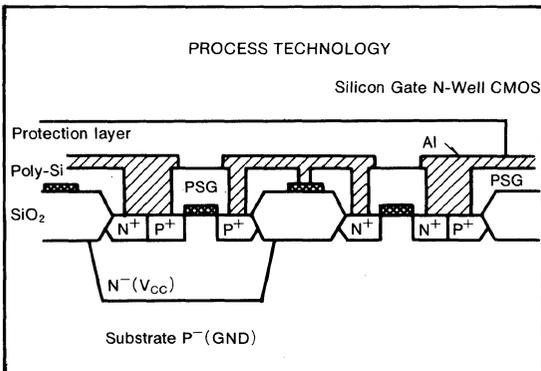


Fig.1 Single-stage inverter construction

## 3. OPERATIONAL DESCRIPTION

Fig. 3 illustrates what happens when supply voltage ( $V_{CC}$ ) is applied to the circuit shown in Fig. 2, varying input voltage from  $V_{SS}$  to  $V_{CC}$ . The  $V_O$  curve indicates the change in output voltage and supply current ( $I_{CC}$ ).

As illustrated, these characteristics depend on input voltage, so can be better understood by dividing  $V_I$  into three regions, I ~ III.

I : In this region, only the p-channel transistor  $T_2$  is on, so that the  $V_O$  output voltage becomes  $V_{CC}$ . In this condition, practically no current  $I_{CC}$  flows.

II : In this region,  $V_O$  varies in accordance with  $V_I$ . When  $V_I$  is increased from region I, the n-channel transistor  $T_1$  begins to turn on, so that  $V_O$  gradually decreases and at some point begins to decrease rapidly. The value of  $V_I$  at this point of rapid  $V_O$  decrease is known as the circuit threshold voltage.

When this voltage is exceeded, as  $V_I$  is increased,  $V_O$  approaches  $V_{SS}$ .

In the region II,  $V_O$  is determined by the ratio of the on resistances of  $T_1$  and  $T_2$ .

$I_{CC}$  is always flowing in this region, and becomes maximum when  $V_I$  is at the circuit threshold voltage.

III : In this region, since only  $T_1$  is on,  $V_O$  becomes the voltage  $V_{SS}$ . In this region, as was the case for region I, virtually no  $I_{CC}$  current flows.

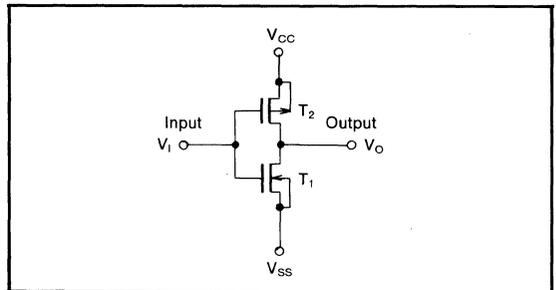


Fig.2 Single-stage inverter circuit

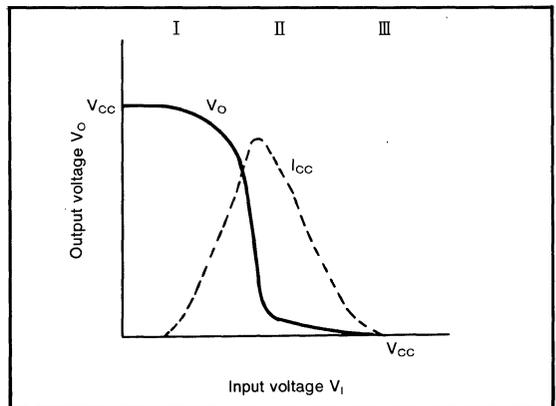


Fig.3 Single-stage inverter voltage transfer and supply current vs. input voltage characteristics

# NOTICE FOR CMOS PERIPHERALS

## 4. TRANSFER CHARACTERISTICS AND POWER DISSIPATION

For COMS devices, the circuit threshold voltage is approximately one-half of  $V_{CC}$ . Contrasted with NMOS logic, where threshold voltage is a fixed level not related to supply voltage, ideal transfer characteristics can be achieved.

In order to maintain compatibility with the conventional NMOS devices, transfer characteristics of CMOS peripherals I/O circuits have been established at TTL level.

Fig. 4 illustrates input voltage  $V_{IN}$  versus supply current  $I_{CC}$  for M5M82C55AP-5. Here, when  $V_{IN}$  reaches 1.3 to 1.5V, the resulting switch in internal circuits causes a sharp increase in  $I_{CC}$  flow.

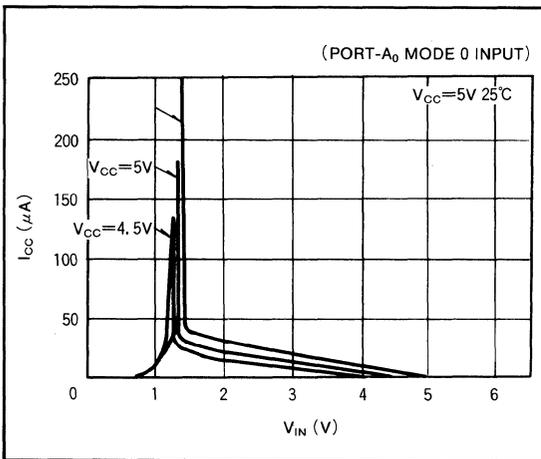


Fig.4 Input voltage vs. dissipation current  
 M5M82C55AP-5

In a CMOS circuit, since p-channel and n-channel transistors are connected in series between the  $V_{CC}$  and  $V_{SS}$ , as long as gate voltage is at the  $V_{CC}$  or  $V_{SS}$  level, one of the two transistors will be in an off state. Consequently, fixing the input pin at the  $V_{CC}$  or  $V_{SS}$  level causes the static dissipation current ( $I_{CC}$ ) flow from the  $V_{CC}$  to  $V_{SS}$  pin to consist only of p-n junction leakage current. As a consequence, the per-gate static dissipation current remains at about 50pA at  $T_a=25^\circ C$ , and will not go over more than a few nanoamperes even at  $T_a=85^\circ C$ . This is the primary reason behind CMOS devices low power dissipation.

Note however that power dissipation does increase when CMOS circuits are used in the switching mode. As was mentioned in the transfer characteristic description, transients in the input voltage cause current to flow from the  $V_{CC}$  to  $V_{SS}$ . The amount of current flow increases relative to higher  $V_{CC}$  values and operating frequency. Additionally, when capacitive loads (load capacitance also varies depending on the number of fanouts) are connected to the device, charging currents will be required, which also in-

creases power dissipation.

The M5M82C55AP-5 illustrated in Fig. 4 has parallel-connected I/O ports, and is relatively limited in switching operations. However, devices such as the programmable timer M5M82C54P are subjected to constant clock operations, and the current flow for each CMOS circuit must be added to get the total for the device. As shown in Fig. 5, current dissipation increases along with increases in operating frequency.

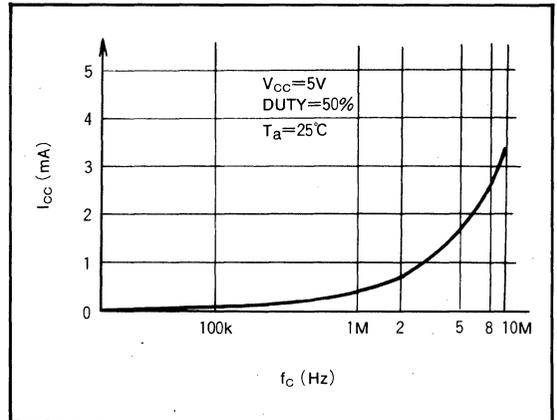


Fig.5 Operating frequency vs. power dissipation  
 M5M82C54P

The power dissipation characteristics of DMA controller M5M82C37AP are illustrated in Fig.6.

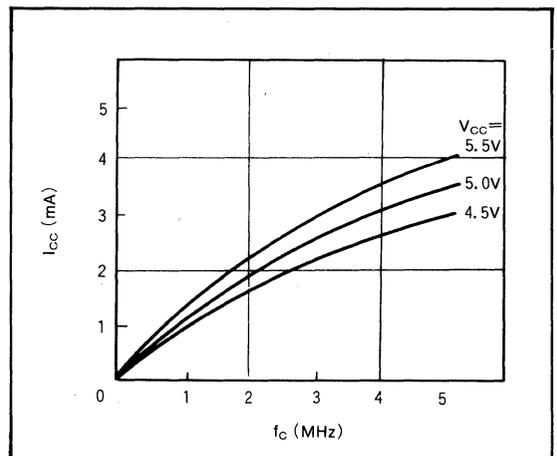


Fig.6 Operating frequency vs. power dissipation  
 M5M82C37AP

# NOTICE FOR CMOS PERIPHERALS

## 5. NOISE MARGIN

As was noted in section 4, I/O levels for CMOS peripheral LSI devices have been established for TTL interface compatibility. Fig. 7 shows a comparison of DC noise margins when CMOS peripheral devices are interfaced with other logic devices. As seen here, with CMOS-to-CMOS interfaces,  $V_{IH(MIN)}$  remains very tolerable. However, since the CMOS peripheral device standard provides for TTL interface,  $V_{OH(MIN)}$  is defined for states where  $I_{OH}$  flow is substantial ( $I_{OH} = -400\mu A$ ). When actually connected to a CMOS logic gate, the required value for  $I_{OH}$  is only the small current required to drive the gate-to-gate capaci-

ance. So  $V_{IH(MIN)}$  for a CMOS gate satisfies this requirement with room to spare. Fig. 8 shows the  $V_{OH}$  characteristics for the M5M82C55AP-5 data bus. As seen here, the margin between the standard and actual performance is substantial.

Low-speed CMOS gates have high internal propagation delay times, which further increases their noise margin. However, the CMOS gates used in peripheral devices still hold delay time to less than 1ns per stage. They are therefore capable of responding to pulses which transient at extremely high speeds, and noise margins are as good as similar type NMOS devices.

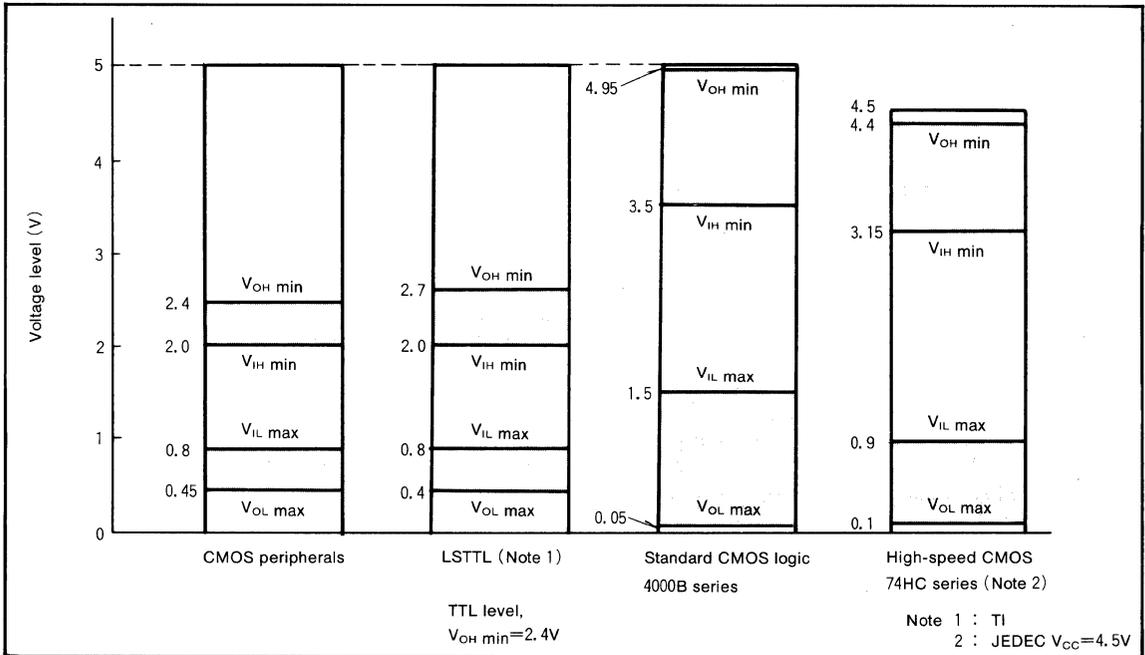


Fig.7 DC noise margin comparison ( $V_{CC}=5.0V$ )

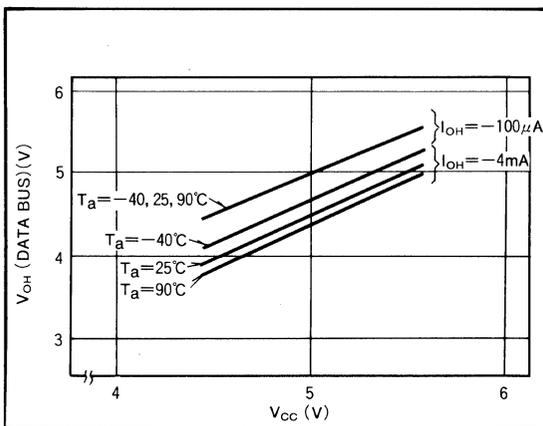


Fig.8  $V_{OH}$  characteristics M5M82C55AP-5

## 6. FANOUT

The drive capability of CMOS peripheral devices generally exceeds that of NMOS logic devices. This can be seen in Fig. 8, where drive capability at "H" level is noticeably better than NMOS. This difference between logic types provides a slight difference when actually applied to driving a load such as a transistor, and the value of the load resistance can affect fanout capability. This point will be covered in more detail later.

For reference purposes, the "L" level drive capability of M5M82C55AP-5 is illustrated in Fig. 9.

When driving a MOS-IC with a peripheral LSI, since it is only necessary to drive the input leakage current of the DC-connected IC, fanout capability is quite good. However, where devices having many components (e.g., data bus, etc.) are connected, the stray capacitance of the wiring and device input capacitance (generally about 5pF) must also

# NOTICE FOR CMOS PERIPHERALS

be driven, so signal switching response is slower. In this case, the load (s) to be driven must be divided (or allocated to several devices) as with previous devices.

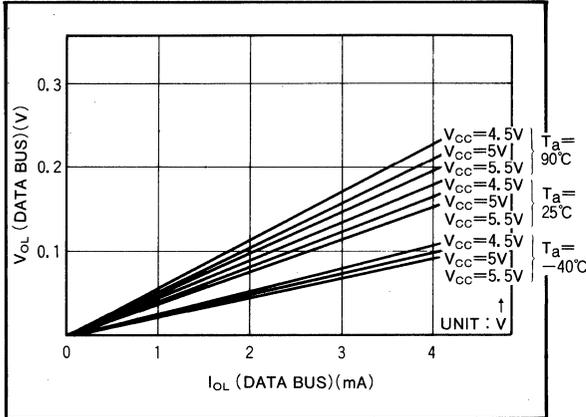


Fig.9 I<sub>OL</sub>-V<sub>OL</sub> characteristics M5M82C55AP-5

## 7. INPUT CIRCUIT

Fig. 10 shows an equivalent circuit diagram of the input circuit for CMOS peripheral devices. The gate oxide layer of the transistors is extremely thin, and high voltages applied directly to the gates are likely to rupture their insulation,

causing permanent damage to the device. To prevent gate damage, the diodes and input resistor shown in the diagram form a protection circuit.

Since threshold voltage for the input transistor is set at approximately 1.5V, as noted in section 4, input voltage becomes unstable around this level, and a through current starts to flow from V<sub>CC</sub> to V<sub>SS</sub>. In systems where low dissipation current is required, this characteristic can cause problems in the design of the power supply.

Where a data bus is left floating, through current is likely to become a particular problem, so bus lines should be fixed at a certain level with a pull-up (or pull-down) circuit having high resistance values.

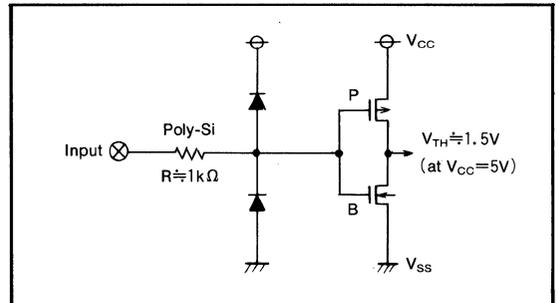


Fig.10 CMOS peripheral device input circuit (equivalent diagram)

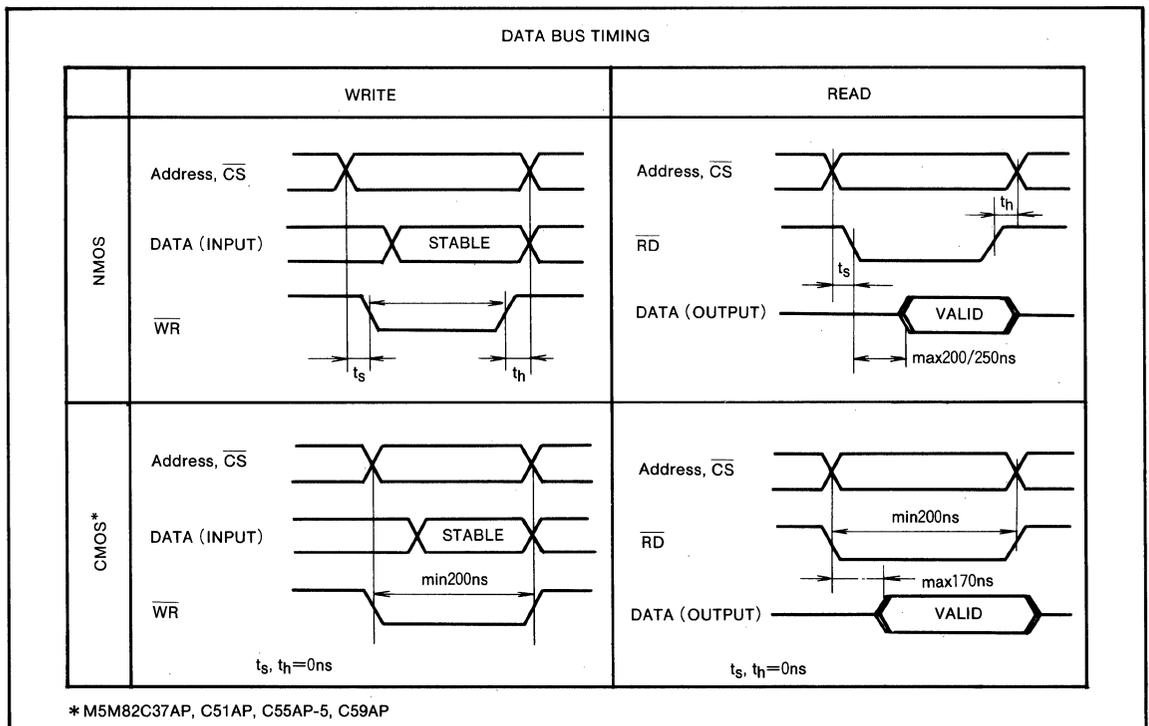


Fig.11 Bus timing characteristics

## NOTICE FOR CMOS PERIPHERALS

## 8. TIMING CHARACTERISTICS

The timing conditions between the system and CMOS peripheral LSI devices have been improved over their NMOS type counterparts. Improvements include better setup and hold times, and microprocessor interfacing is easier. Fig. 11 summarizes these differences in comparison form. Whereas NMOS devices required  $t_s$  and  $t_h$  time, these have been eliminated with CMOS peripherals by setting  $t_s$  and  $t_h$  to 0 ns.

## 9. USAGE PRECAUTIONS

## (1) Dealing with NC input pins

Leaving unused input pins open results in instability input voltage, which in turn can produce errors in output logic levels and increase current dissipation. Unused input pins should therefore be tied to  $V_{CC}$  or  $V_{SS}$ .

## (2) Voltage supply lines

Power dissipation of CMOS peripherals whose internal changes are small such as M5M82C55AP-5 and M5M82C59AP is extremely low. However, the through current spikes that occur during switching are dealt with using the traditional method applied to older ICs; by reducing power line impedance to filter the spikes. To accomplish this, each device should be fitted with a ceramic capacitor (having good high frequency characteristics and a capacitance of approx.  $0.1\mu\text{F}$ ) wired close between  $V_{CC}$  and  $V_{SS}$ . Also, when devices such as M5L82C55AP-5 are used with a high current drive circuit connected to output, power lines should be run independently from the logic system and driver circuit to reduce adverse affect on the logic system.

## (3) Latchup

The internal circuitry of CMOS devices often have parasitic bipolar transistors formed in the substrate, and these operate like thyristors, being triggered by external voltage surges, etc. When this happens, a large current flows from  $V_{CC}$  to  $V_{SS}$ , and if current flow continues, the device will be destroyed. Provision must be made to clear latchup to prevent overcurrents from destroying the device, and that can be done by dropping supply voltage below a certain level, or turning the supply off.

Latchup occurs under the five conditions listed below.

- $V_i > V_{CC} + V_F$
- $V_o > V_{CC} + V_F$
- $V_i < V_{SS} - V_F$
- $V_o < V_{SS} - V_F$
- Excessive  $V_{CC}$

$V_F$ : Forward voltage of the clamping diode used at input.

## Conditions (a) or (c)

## ● When using a dual power supply

When dual power supplies serve CMOS logic devices, differences in the rising edge of the power line signal tend to cause latchup. This can be eliminated by using a series connected resistor ( $R$ ) to limit current flow to a maximum of 10mA. (Refer to Fig. 12)

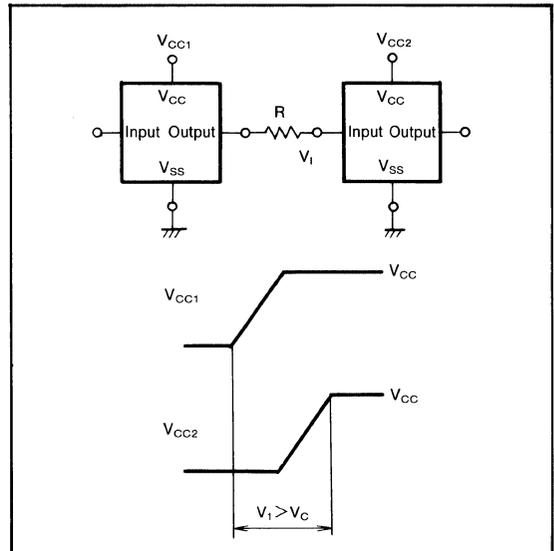


Fig.12 Preventing latchup when dual power supplies are used

## ● When using differential circuits

When differential circuits are used, it is possible for input voltage to exceed  $V_{CC}$  or  $V_{SS}$ , which could result in latchup. In this case, use a diode for voltage clamping, combined with a resistor ( $R$ ) to limit current flow. (Refer to Fig. 13)

## ● When driving large current circuits

When connecting transistors to CMOS output and operating large current circuits (e.g., relays, motors, etc.) of the same power supply as the CMOS device, coil reactance will produce voltage spikes at switching time. This causes fluctuations in the power supply voltage, which can cause the condition  $V_i > V_{CC}$ . Where possible, separate power supplies should be used. If a common power supply must be used, power supply impedance must be lowered by connecting a capacitor ( $0.01 \sim 0.22\mu\text{F}$ ) having good frequency characteristics between  $V_{CC}$  and  $V_{SS}$ .

Current should also be limited by connecting a resistor ( $R$ ) to input. (Refer to Fig. 14)

# NOTICE FOR CMOS PERIPHERALS

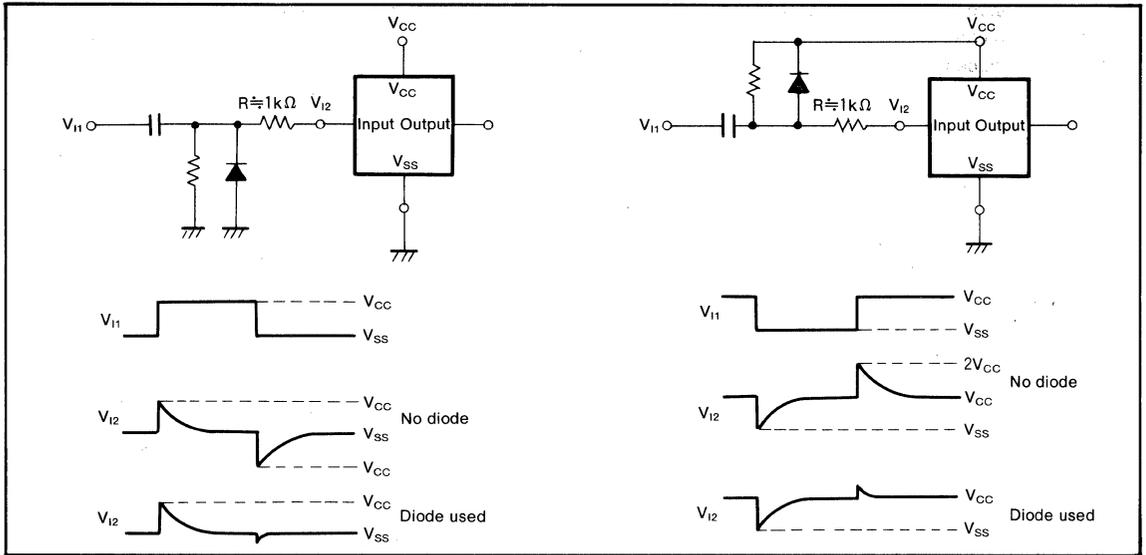


Fig.13 Preventing latchup when using differential circuits

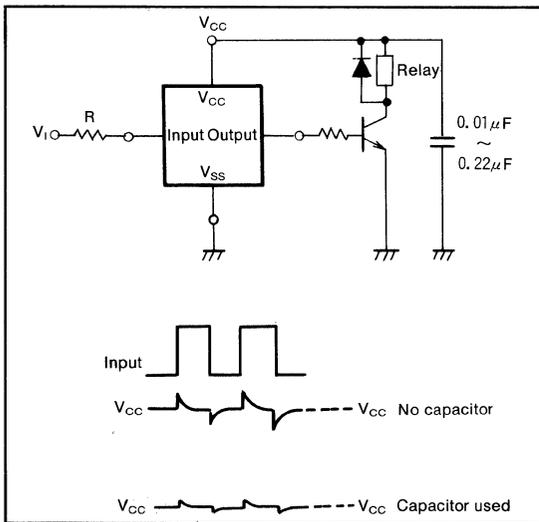


Fig.14 Preventing latchup when driving large current circuits

### Condition (e)

Condition (e) can be created by exceeding the absolute maximum voltage ratings at the  $V_{CC}$  pin. Also, even though  $V_{CC}$  is within the recommended operating conditions, device latchup can be caused by the surge voltage superimposing at power ON, or crosstalk between lines. The voltage at  $V_{CC}$  should never exceed absolute maximum rating values under any circumstances.

Provisions should be made to reduce power ON surge voltage to a minimum, and as described in section 6, a capacitor should be connected between  $V_{CC}$  and  $V_{SS}$  to reduce impedance in the power line.

### Conditions (b) or (d)

Applying a constant voltage to an output pin is not one of the normal usage configurations of a CMOS device, but a capacitor connected between output and  $V_{CC}$  (or  $V_{SS}$ ) would be a cause for latchup. This is due to the high impedance created in the power supply line, combined with the fact that switching the power supply on and off produces fluctuations in the power supply line which causes the capacitor to discharge a trigger current.

# NOTICE FOR CMOS PERIPHERALS

(4) The differences in CMOS and NMOS peripheral LSIs  
 The basic characteristics of CMOS devices allow them to be used as replacements for NMOS logic devices without significant modifications. But the fact that improvements have been made in the characteristics of CMOS devices can cause problems when these devices are used in circuits designed for NMOS. The example below shows such a case.

### Transistor drive using a parallel port

Fig. 15 (a) shows an example of an NPN transistor connected in series and being driven by parallel port 8255A. The load  $R_L$  and base resistor  $R_B$  establishes the operating point as illustrated in Fig. 15 (b).

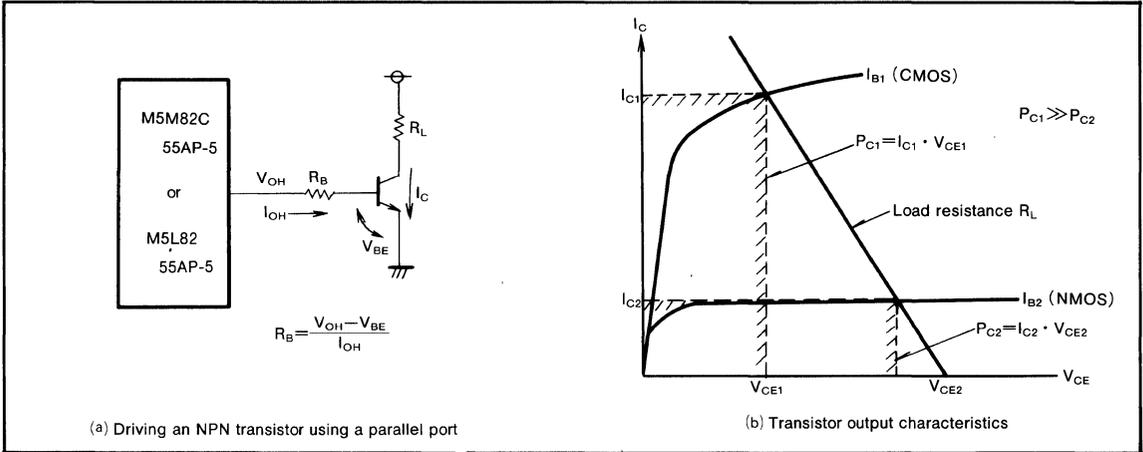


Fig. 15 Driving a transistor using M5L8255AP-5 or M5M82C55AP-5

Fig. 16 illustrates the difference in output characteristics for CMOS and NMOS 8255A devices. As noted, the CMOS 8255A has better drive capability, and provides a higher base current to the transistor. Consequently, depending on  $R_B$  and  $R_L$ , power dissipation ratings  $P_C$  of the transistor can be exceeded, or drive current may simply be higher than

its limit.

The same problem may occur when driving PNP transistors. Fig. 17 shows a comparison in  $V_{OL}$  characteristics. But here, the difference between NMOS and CMOS is smaller than for  $V_{OH}$ , so the problem should not be as great.

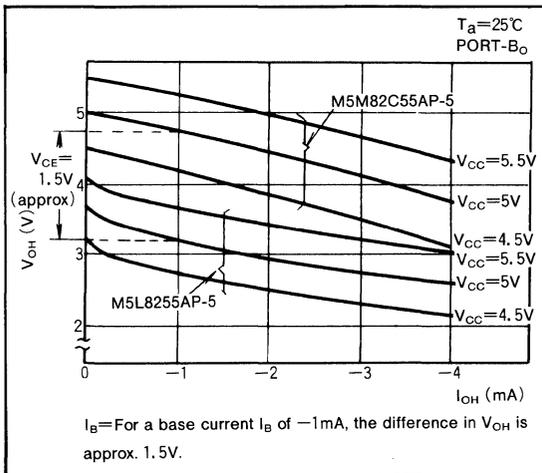


Fig. 16 M5L8255AP-5/M5M82C55AP-5  $V_{OH}$  output characteristics comparison

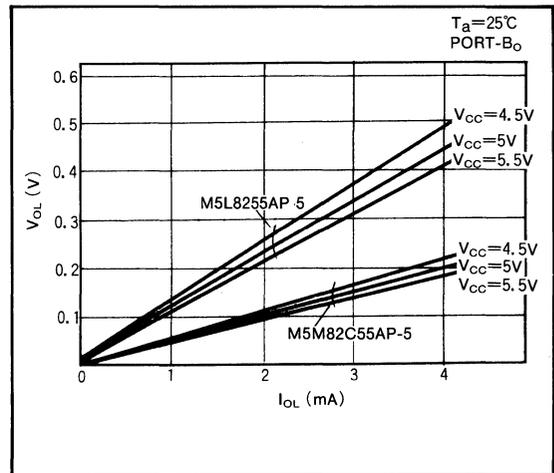


Fig. 17 M5L8255AP-5/M5M82C55AP-5  $V_{OL}$  output characteristics comparison

6

# M5W1791-02P

## FLOPPY DISK FORMATTER/CONTROLLER

### 1. DESCRIPTION

The M5W1791-02P is a floppy disk formatter/controller device which accommodates single and double density formats.

The device is designed for use with microprocessors or microcomputers.

The device is fabricated with the Nchannel silicon gate EDMOS technology is packaged in a 40-pin DIL package.

### 2. FEATURES

- Single 5V supply voltage
- Accommodate single and double density formats  
IBM 3740 single density format  
IBM system 34 double density format
- Selectable sector length (128, 256, 512 or 1024 bytes/sector)
- Side select compare
- Single/multiple sector read or write with automatic sector search
- Selectable track to track stepping time
- Write precompensation
- DMA or programmed data transfers
- Window extension

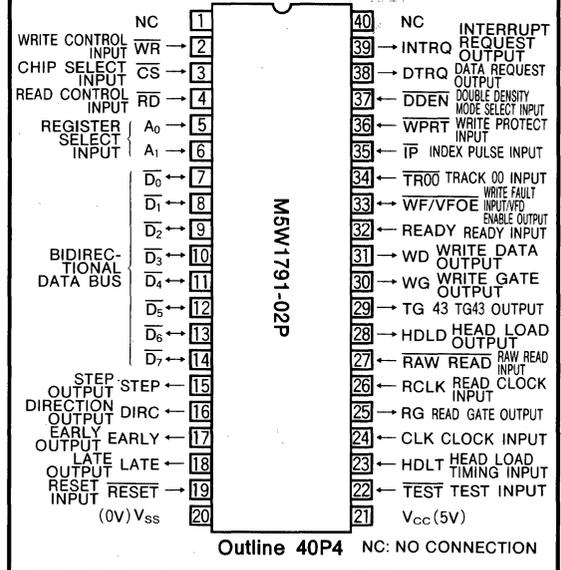
### 3. APPLICATION

- Single or double density floppy disk drive formatter/controller
- 8-inch or mini floppy disk interface

### 4. FUNCTION

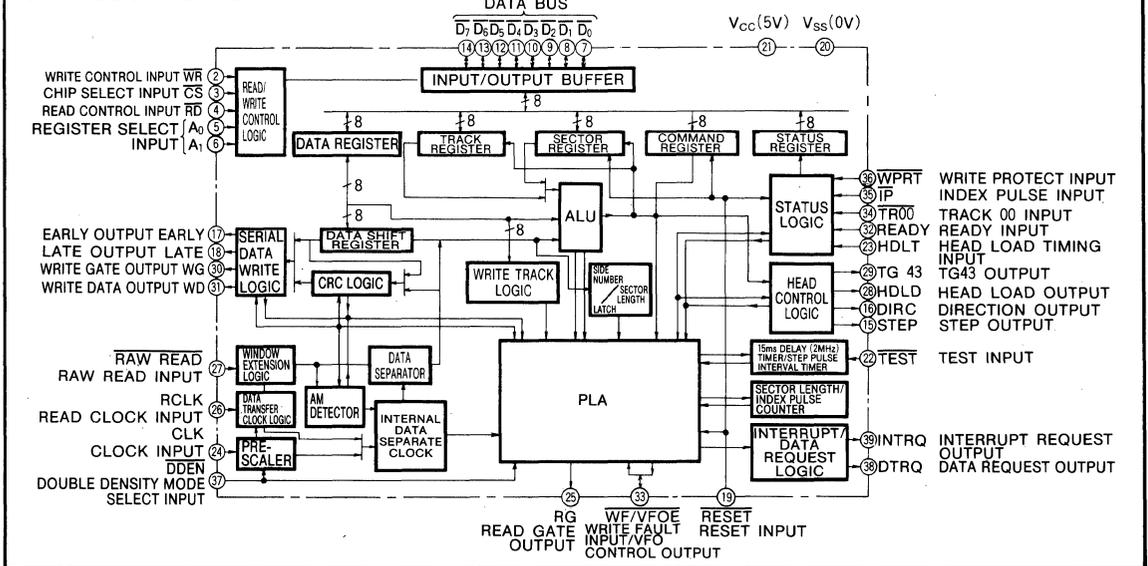
The M5W1791-02P is a floppy disk formatter/controller that can be used with most microprocessor or microcomputer

### 5. PIN CONFIGURATION (TOP VIEW)



systems. The hardware of the M5W1791-02P consists of a floppy disk interface, a CPU interface and a PLA control logic. The total chip can be programmed by eleven 8-bit commands. The floppy disk interface portion performs the communication with floppy disk drive under control of the PLA control logic. The CPU interface portion has five registers — command, data, status, track and sector register — and communicates with the CPU through the data bus. These functions are also controlled by the PLA.

### 6. BLOCK DIAGRAM



**FLOPPY DISK FORMATTER/CONTROLLER**

**7. PIN DESCRIPTION**

Pin	Name	Input or output	Functions																				
NC	No internal connection		NC(pin 1) is not internally connected																				
$\overline{WR}$	Write control input	Input	Write signal from a master CPU (Active low).																				
$\overline{CS}$	Chip select input	Input	Chip select (Active low).																				
$\overline{RD}$	Read control input	Input	Read signal from a master CPU (Active low).																				
$A_0, A_1$	Register select input	Input	<p>Register select inputs. These inputs select the register under the control of the <math>\overline{RD}</math> and <math>\overline{WR}</math>.</p> <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th><math>A_1</math></th> <th><math>A_0</math></th> <th><math>\overline{RD}</math></th> <th><math>\overline{WR}</math></th> </tr> </thead> <tbody> <tr> <td>0</td> <td>0</td> <td>STATUS REGISTER</td> <td>COMMAND REGISTER</td> </tr> <tr> <td>0</td> <td>1</td> <td>TRACK REGISTER</td> <td>TRACK REGISTER</td> </tr> <tr> <td>1</td> <td>0</td> <td>SECTOR REGISTER</td> <td>SECTOR REGISTER</td> </tr> <tr> <td>1</td> <td>1</td> <td>DATA REGISTER</td> <td>DATA REGISTER</td> </tr> </tbody> </table>	$A_1$	$A_0$	$\overline{RD}$	$\overline{WR}$	0	0	STATUS REGISTER	COMMAND REGISTER	0	1	TRACK REGISTER	TRACK REGISTER	1	0	SECTOR REGISTER	SECTOR REGISTER	1	1	DATA REGISTER	DATA REGISTER
$A_1$	$A_0$	$\overline{RD}$	$\overline{WR}$																				
0	0	STATUS REGISTER	COMMAND REGISTER																				
0	1	TRACK REGISTER	TRACK REGISTER																				
1	0	SECTOR REGISTER	SECTOR REGISTER																				
1	1	DATA REGISTER	DATA REGISTER																				
$\overline{D}_0 \sim \overline{D}_7$	Bidirectional data bus	In/Out	Three-state, inverted bidirectional data bus.																				
STEP	Step output	Output	Step pulse output (Active high).																				
DIRC	Direction output	Output	Direction output. High level means the head is stepping in and low level means the head is stepping out.																				
EARLY	Early output	Output	This signal is used for write precompensation. It indicates that the write data pulse should be shifted early.																				
LATE	Late output	Output	This signal is also used for write precompensation. It indicates that the write data pulse should be shifted late.																				
$\overline{RESET}$	Reset input	Input	Reset input (Active low). The device is reset by this signal and automatically loads "03" (hexadecimal) into the command register. The not-ready-status bit is also reset by this signal. When reset input is made to be high, the device executes restore command even unless READY is active and the device loads "01" (hexadecimal) to the sector register.																				
$\overline{TEST}$	Test input	Input	This input is only used for test purposes, so user must tie it to $V_{CC}$ or leave it open unless using voice coil actuated motors.																				
HDLT	Head load timing input	Input	When the device finds high level on this input, the device assumes that the head is engaged on the media. Active high.																				
CLK	Clock input	Input	Clock input to generate internal timing. 2MHz for 8-inch drives, 1MHz for mini drives.																				
RG	Read gate output	Output	This signal shows the external data separator that the syncfield is detected.																				
RCLK	Read clock input	Input	This signal is internally used for the data window. Phasing relation to raw read data is specified but polarity (RCLK high or low) is not important.																				
$\overline{RAW READ}$	Raw read input	Input	This input signal from the drive shall be low for each recorded flux transition.																				
HDLD	Head load output	Output	This output signal controls the loading of the head of the drive. The head must be loaded on the media by this high-level output.																				

**FLOPPY DISK FORMATTER/CONTROLLER**

Pin	Name	Input or output	Functions
TG43	TG 43 output	Output	This output is valid only during disk read/write operation and it shows the position of the head. High level on this output indicates that head is positioned between track 44 to 76.
WG	Write gate output	Output	This signal becomes active before disk write operations are to occur.
WD	Write data output	Output	This signal consists of data bits and clock bits. It becomes active for every flux transition. Active high.
READY	Ready input	Input	This signal shows the device the drive is ready. In the disk read/write operation except for TYPE 1 command operation, low level input terminates current operation and the device generates the INTRQ. In the TYPE 1 command operation, this signal is neglected. Not ready bit in the status register is the inverted form of this input.
$\overline{\text{WF/VFOE}}$	Write fault input/ VFO enable output	In/Out	This is a bidirectional signal. It becomes write fault input when WG is active. In the disk write operation, low level signal on this input terminates the write operation and makes INTRQ active. This signal also appears in the status register as the write fault bit. When WG is inactive, this signal works as VFO enable output. VFOE output is also an open drain type, so pull it up to $V_{CC}$ and never input active write fault signal when WG is inactive.
$\overline{\text{TR00}}$	Track 00 input	Input	This signal indicates that the head is located on the track 00 to the device. Active low.
$\overline{\text{IP}}$	Index pulse input	Input	This input indicates to the device that an index hole of the diskette has been encountered.
$\overline{\text{WPRT}}$	Write protect input	Input	Low level signal on this input informs the device that the drive is in the write protected state. Before disk write operations, this signal is sampled and an active low signal will terminate the current command and set INTRQ. The write protect status bit in the status register is also set.
$\overline{\text{DDEN}}$	Double density mode select input	Input	This input determines the device operation mode. When $\overline{\text{DDEN}}=0$ , double density mode is selected. When $\overline{\text{DDEN}}=1$ , single density mode is selected.
DTRQ	Data request output	Output	DTRQ is an open drain output, so pull up to $V_{CC}$ by the 10k resistor. In the disk read mode, DTRQ indicates that data is assembled in the data register. In the disk write mode, it indicates that the data register is empty. DTRQ is reset by the read data or write data operation.
INTRQ	Interrupt request output	Output	INTRQ is also an open drain output, so pull up to $V_{CC}$ by the 10k resistor. INTRQ becomes active at the completion of any command and is reset when the CPU reads the status or writes the command.
NC	No internal connection		NC (pin 40) is not internally connected.

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**8. HARDWARE CONFIGURATION**

The following explanation is based on the block diagram in Section 6.

The registers which are accessible by the CPU system through the input/output buffer of the M5W1791-02P are the command, status, track, sector and data registers. These are all 8-bit registers.

The register select inputs  $A_0$  and  $A_1$  select one register under  $\overline{RD}$ ,  $\overline{WR}$  and  $\overline{CS}$  control as described in Section 7.

**8.1 Register Descriptions**

**(1) Command Register**

This register is write-only, so the contents of the command register cannot be read onto the bi-directional data bus. The CPU system writes the command code into this register to be executed by the M5W1791-02P. Except the force interrupt command, the command register should not be loaded while the busy status bit is set.

**(2) Status Register**

This is the read-only register and holds the status information about the device and a connected floppy disk drive. The meaning of each status bit is varied by the executing command.

**(3) Track Register**

This register is bi-directional, so the CPU system can read or write the data through the data bus. The track register has the track number of the floppy disk's current head position. The type 1 commands have the update flag option according to this register. When this flag is set, the contents of the track register are updated by one for each step. They are incremented when the head is stepped in and decremented when the head is stepped out.

When the type 2 command which performs the read/write operation for the floppy disk is executed, the track address of the floppy disk's ID field and the contents of the track register are compared. If they match, M5W1791-02P continues to check whether the sector address is the one appointed by the sector register.

When the restore command is performed automatically by the  $\overline{RESET}$  input transition from "0" to "1" or when the CPU system executes the restore command, FF (HEX) is at first loaded into the track register and every time the step pulse is issued, the value of this register is decremented by one. The contents of the track register are set to 00 (HEX) when the  $\overline{TR00}$  input is activated before the 255th step pulse issued or after the step pulse was generated 255 times.

**(4) Sector Register**

This is also a bi-directional register.

For disk read or write operation, the CPU system must set the desired sector address into this register.

By forcing the  $\overline{RESET}$  input from "0" to "1", M5W1791-

02P also sets 01 (HEX) into the sector register, then begins the restore operation.

In the type 2 command execution, the sector address of the disk's ID field and the contents of the sector register are also compared as mentioned above.

When the m flag bit of the type 2 command code is set to perform the multi-sector read/write operation, the sector register value is automatically incremented by one upon completion of the read/write operation of the one sector.

When the read address command of the type 3 command has been executed, the track address which is read out from the first encountered ID field is loaded into the sector register.

**(5) Data Register**

This register is bi-directional.

During disk data read operation, the data read from the floppy disk is held in this register. During the write operation, byte of data from the CPU system is held.

Prior to seek command execution, the desired track position must be written into the data register.

By executing the restore command or the  $\overline{RESET}$  input transition from "0" to "1", M5W1791-02P automatically loads 00 (HEX) into the data register.

The hardware blocks of access to the user are only the registers mentioned above. Descriptions of inaccessible internal hardware blocks follow.

**8.2 Control Circuit**

**(1) ALU (Arithmetic Logic Unit)**

This one-bit serial ALU executes the comparisons of the serial data and is used for the modification and comparison of registers.

**(2) Status Control Logic**

The status control logic generates the status information for the status register. It is divided into two sections: one reflects the state of the M5W1791-02P and the other reflects the state of the disk system. Disk states included write protect, index pulse, track 00, ready, head load timing and write fault.

**(3) Head Control Logic**

This circuit generates the signal which controls head movement of the floppy disk. It provides the head load signal, direction signal, step signal and TG43 signal. The TG43 output controls the disk's write current.

When the type 1 command with the head load flag h at "1" is executed, the head load output is set to "1" at the beginning of the command execution. The command execution where the head load flag h is initially at "0" makes the head load output "0" whether it has been "0" or "1".

After issuing the step pulses, the M5W1791-02P checks

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the verify flag V in the command code. If V is "0", the command is terminated and the interrupt request output signal is sent. If V is "1", the head load output is set to "1" (if h = "1", HDLD is already set to "1" at the beginning of this command), and after an internal 15 ms delay (CLK = 2MHz, TEST = 1), the head load timing input HDLT is sampled until HDLD and HDLT = "1" (logic true). Then M5W1791-02P updates the TG43 output signal and commences the disk read operation. This means that during the type 1 command, the TG43 signal is not updated unless the V flag is set to "1". The TG43 output is set to "1" when the floppy disk head is positioned beyond the 43rd track.

The type 2 and 3 commands confirm the ready input logic high, and after a 15 ms delay (if flag E is set; if E = 0, no internal delay is initiated), HDLT is sampled until HDLD and HDLT = "1" as mentioned above. M5W1791-02P then updates the TG43 output signal and begins the disk read/write operation. If the ready input is low, then the command is terminated and INTRQ is generated.

The head load output which was set to "1" is reset to "0" under the following two conditions:

- If the M5W1791-02P is idle for 15 disk revolutions after the previous command terminates, the head load signal resets to "0".
- If the type 1 command is executed when h = "0", the head is also automatically disengaged.

**(4) Head Engage Timer/Step Speed Timer**

The M5W1791-02P can generate an internal 15 ms wait time (CLK = 2MHz) before the head load timing input is sampled. The HDLT signal shows M5W1791-02P that the floppy disk head is completely engaged after loading into the media. The step speed can be selected at 3 ms, 6 ms, 10 ms or 15 ms (CLK = 2MHz) by the stepping motor rate bits r<sub>1</sub> and r<sub>0</sub> in the type 1 command.

These operations are controlled by the 1 ms timer and presettable 4-bit binary counter inside the M5W1791-02P.

This 1 ms timer is disabled by setting the test input TEST to "0", which initiates step pulse intervals of about 400μs in the single-density mode and about 200μs in the double-density mode (CLK = 2MHz). The 15 ms wait time is also reduced in the two modes to about 60μs and 30μs, respectively.

The test input signal is used only for interfacing with the floppy disk drives and a voice coil motor.

Table 8.1 shows the relationship between the stepping motor rate flags and the step pulse intervals.

**Table 8.1 Step Pulse Intervals**

(unit: ms)

CLK (MHz)		2MHz		1MHz	
r <sub>1</sub>	r <sub>0</sub> / DDEN	0	1	0	1
0	0	3	3	6	6
0	1	6	6	12	12
1	0	10	10	20	20
1	1	15	15	30	30

**(5) Index Pulse Counter/Sector Counter/Step Pulse Counter**

As mentioned in Section 8.2 (3), the M5W1791-02P has an index pulse counter that returns the head load output to "0" in the idle state after command execution. This index pulse counter is used to terminate the command when the M5W1791-02P does not complete it within 5 index pulses. There are 12 reasons why the command may be terminated prematurely:

- The synchronize pattern of the ID field is not found.
- The synchronize pattern of the ID field is too short.
- AM1 of the ID field is not found.
- AM1 of the ID field is not complete.
- The ID track address is not equal to the contents of the track register.
- The ID sector address is not equal to the contents of the sector register.
- The side number of the ID field is not equal to the side select flag s in the command code when the side comparison flag C is set to "1".
- The ID field CRC error occurs.
- The synchronize pattern of the data field is not found.
- The synchronize pattern of the data field is too short.
- AM2 of the data field cannot be found.
- AM2 of the data field not complets.

When a CRC error of the data field occurs, an interrupt is generated without a retry.

The index counter is also used as the sector counter/step pulse counter. When this counter is used as a step pulse counter, it counts a maximum of 255 step pulses during the restore command as described in Section 8.1(3)

This counter is used as a sector counter in the type 2 command to count the data length of the data field for the destination sector. In this sense, it is more appropriate to call this counter the data length counter.

The M5W1791-02P allows one of four different data length configurations in one sector: 128 bytes, 256 bytes, 512 bytes and 1024 bytes. The data length of the sector to be read or written by the M5W1791-02P is decided by the "sector length" parameter at the 4th byte of the ID field. When the read/write operation is commenced for the desired data field, the M5W1791-02P uses this sector counter to generate the data request signal at specified times in accordance with the ID sector length byte.

**(6) Interrupt Request Control Logic, Data Request Control Logic**

The interrupt request output INTRQ is an open drain output that notifies the CPU of command termination.

Once set, the interrupt request output INTRQ is not reset to "0" until the status is read out from the status register or the command is written into the command register by the CPU.

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Refer to Section 11.5 concerning the response of the INTRQ during the type 4 command.

The INTRQ output is not reset by the reset input signal. This state is undefined after power is applied.

The data request control output DTRQ is also an open drain output that requests the CPU to read out the data from the data register or write the data into the data register during the disk read or write operation.

The DTRQ output is reset to "0" by writing the data into or reading the data out from the data register.

The DTRQ output is changed to "0" by the reset input.

**(7) Write Control Logic**

The M5W1791-02P provides frequency-modulated (FM) data in the single-density mode or modified FM (MFM) data in the double-density mode.

The data written into the data register from the CPU is sent to the data shift register and then it is modulated by the write control logic in accordance with the modulation type selected by the  $\overline{\text{DDEN}}$  input. This modulated data is sent to the write data output WD.

The special patterns including the missing clock required for disk formatting are also produced in the write control logic under the control of the write command control circuit.

During the disk write operation, M5W1791-02P can predict the occurrence of the peak shift, depending on the previous bit pattern, so the write control logic provides the early and late output signals for write precompensation.

**(8) Write Track Command Control Logic**

The internal PLA program controls almost all the operations of the M5W1791-02P. However, when the write track command is executed, the PLA program control speed is too slow to perform the command. Therefore, the write track command control logic implements the write track operation directly.

When the CPU writes the data into the data register for disk initialization, the contents are sent to the internal data shift register and the write track command control logic. When a special data byte is sent to the data register from the CPU, the write control logic operates under the control of the write track command control logic to provide the designated write data pattern. When the other data bytes are written into the data register, they are first sent to the data shift register, then to the write control logic serially to be modulated according to the  $\overline{\text{DDEN}}$  input.

**8.3 Internal Control Logic**

**(1) Data Shift Register**

During the disk write operation, the data bytes written into the data register from the CPU are loaded into this register in parallel. The data shift register transfers the serial data to the write control logic for modulation.

During the disk read operation, the internal data separator circuit demodulates the raw read data stream and produces the true data bit pattern. This demodulated data bit is shifted into the data shift register in series and transferred to the data register in parallel byte by byte.

**(2) CRC Logic**

The CRC (Cyclic Redundancy Check) circuit generates the cyclic redundancy check code. The polynomial is  $X^{16} + X^{12} + X^5 + 1$ .

The CRC code, generated by the CRC circuit from the write data stream, is written onto the floppy disk during the disk write operation.

During the disk read operation, the last two CRC bytes read out in the ID or data field are checked for errors by the CRC logic.

**(3) Prescaler**

A pair of internal clocks are required to drive the M5W1791-02P's logic circuitry. During the disk read operation, these clocks are derived from the read clock input RCLK from the differential circuit, the data transfer clock logic and the internal clock control logic.

At all times except for disk read operations, such as during type 1 commands or disk write operations, these two internal clocks are produced by the prescaler and the internal clock control logic from the CLK input signal.

The prescaler generates the data transfer clock and the data separator clock by dividing the CLK input clock by 2 and 4 in the double density mode and by 4 and 8 in the single density mode.

The internal PLA logic is driven by this data separator clock.

**(4) Differential Circuit, Data Transfer Clock Logic**

The differential circuit and the data transfer clock logic generate the internal data transfer clock by multiplying the PCLK clock input and shaping its waveform.

**(5) Window Extension Logic**

When disk read operations are executed in the double-density mode, the raw read input occurs in both RCLK clock windows. At this time, the window extension logic samples the raw read input at the edge of the internal data transfer clock which is derived from the RCLK input to provide that the read clock input RCLK window width is extended substantially.

**(6) AM Detector Logic**

The raw read signal input RAW READ from the floppy disk is a signal which has been modulated by either FM or MFM. M5W1791-02P should synchronize the internal data separator clock with the data bit of the input data stream. For this

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purpose, the AM detector logic is employed to detect the special patterns which contain the missing clocks from the input raw read stream.

**(7) Internal Clock Control Logic**

This logic generates the data transfer clock and data separator clock.

**(8) Data Separator**

This separates the data bit from the raw read input signal by using the data separator clock.

**(9) PLA**

This is the programmable logic array which controls the M5W1791-02P. The size of this PLA ROM is approximately  $230 \times 19$  bits.

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**9. DESCRIPTION OF COMMANDS**

There are 11 different commands. By setting  $\overline{CS}$  to "0",  $A_0$  to "0" and  $A_1$  to "0" the commands are written inside the M5W1791-02P from the data bus at the rising edge of the

$\overline{WR}$  signal.

The commands are classified into four types: type 1, type 2, type 3 and type 4.

**Table 9.1 List of Commands**

Command type	Command	MSB	Code							LSB
Type 1 commands	Restore command	0	0	0	0	h	V	$r_1$	$r_0$	
	Seek command	0	0	0	1	h	V	$r_1$	$r_0$	
	Step command	0	0	1	u	h	V	$r_1$	$r_0$	
	Step-in command	0	1	0	u	h	V	$r_1$	$r_0$	
Type 2 commands	Step-out command	0	1	1	u	h	V	$r_1$	$r_0$	
	Read sector command	1	0	0	m	S	E	C	0	
Type 3 commands	Write sector command	1	0	1	m	S	E	C	$a_0$	
	Read address command	1	1	0	0	0	E	0	0	
	Read track command	1	1	1	0	0	E	0	0	
Type 4 commands	Write track command	1	1	1	1	0	E	0	0	
	Force interrupt command	1	1	0	1	$l_3$	$l_2$	$l_1$	$l_0$	

Note 1 : Although the codes are written in TRUE form, the M5W1791-02P features a negative logic data bus. This means codes with 0 and 1 reversed are written into the M5W1791-02P.

Each command comes with a flag option. These are identified in Table 9.2.

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**Table 9.2 Flag Options**

	Flag	Description
Type 1 commands	h : Head load flag	When h =1: The head is loaded at the beginning of the command execution. When h =0: The head is loaded when the verify operation starts if the V flag is "1". It is not loaded if the V flag is "0".
	V : Verify flag	When V =1: The contents of the track register are compared with the ID track address after head positioning. The seek error status bit is set if the desired track address is not found by the time the diskette has gone through 6 rotations. When V =0: The track verification is not performed.
	r <sub>1</sub> , r <sub>0</sub> : Stepping rate flag	The stepping rate is determined by the value of these 2 bits as well as by the CLK frequency and TEST input pin.
	u : Update flag	When u = 1: The track register is updated with each step pulse: It is incremented (or decremented) by 1 for each step-in (or step-out) pulse. When u =0: Track register is not updated.
Type 2/Type3 Commands	E : 15ms delay flag(at 2MHz clock)	When E =1: Sampling of the head load timing input starts with the 15ms delay after the head load output has been set to "1". An advance is made to the next step when HDLD·HLDT = "1" is established. When E =0: Sampling of the head load timing input starts immediately after the head load output has been set to "1". An advance is made to the next step when HDLD·HLDT = "1" is established. The "next step" is the TG43 output update.
Type 2 commands	m : Multi-sector read/write flag	When m =1: Multi-sector read/write is performed. Upon completion of one sector read/write, the sector register value is incremented by 1, the next sector is sought and read/write is performed again. Upon completion of the final sector read/write operation, the next sector is not found even when sought and so at the sixth rotation of the diskette the RNF error bit is set and the operation is concluded. This command can also be concluded with the Type 4 command. When m =0: Read/write for single sector is performed.
	S : Side select flag	When S =1: "1" is compared with the ID side number when the C flag is "1". When S =0: "0" is compared with the ID side number when the C flag is "1". No comparison is performed when C =0.
	C : Side compare flag	When C =1: The S flag and ID side number are compared. When C =0: The ID side number is not compared.
	a <sub>0</sub> : Data address mark flag	When a <sub>0</sub> =1: The deleted data mark "F8" (hexadecimal) is written into the data field address mark. When a <sub>0</sub> =0: The data mark "FB" (hexadecimal) is written into the data field address mark.
Type 4 command	I : Interrupt condition flag	When i <sub>0</sub> =1: The interrupt request output is set to "H" at the ready input rising edge. When i <sub>1</sub> =1: The interrupt request output is set to "H" at the ready input falling edge. When i <sub>2</sub> =1: The interrupt request output is set to "H" with the index pulse input. When i <sub>3</sub> =1: The command being executed is terminated and the interrupt request output is set to "H" immediately. When i <sub>0</sub> = i <sub>1</sub> = i <sub>2</sub> = i <sub>3</sub> =0: No interrupt request is generated but the command being executed is terminated. This command is executed so that the interrupt request output, which has been set by the Type 4 command, is reset by the following command write or status read.

## 10. DESCRIPTION OF OPERATION

The M5W1791-02P is provided with an interface section for the CPU system and an interface section for the floppy disk system.

### 10.1 CPU System Interface Section

The CPU interface section is composed of the input/output buffer, input/output control logic, five internal registers, interrupt request control logic and data request control logic.

The CPU reads/writes the contents of the internal registers through the M5W1791-02P's data bus.

Upon the completion of each command, and interrupt to the CPU is generated by the interrupt control logic. INTRQ is reset by command register write or status register read.

The M5W1791-02P generates the data request output DTRQ for the CPU system using its data request control circuit while reading or writing floppy disk data.

The time required to transfer one byte of serial data when CLK is 2MHz is  $32\mu\text{s}$  in the single-density mode and  $16\mu\text{s}$  in the double-density mode. However, the maximum time from when DTRQ is set to "H" until the CPU system reads or writes the data is actually shorter than  $32\mu\text{s}$  (or  $16\mu\text{s}$ ) and if the service is not completed within this time, the lost data status bit is set. When the CPU system does not respond to the first data request for write sector command or write track command within the required time, the subsequent operation of the commands are terminated and the interrupt request output is set.

For instance, the service time  $T_{\text{service}}(\text{WR})$  for DTRQ when a write sector command is being executed in the single-density mode is  $23.5\mu\text{s}$  maximum. This is because it takes  $4\mu\text{s}$  for the DTRQ output to be set after the contents of the data register have been transferred to the data shift register, and  $4.5\mu\text{s}$  at most for the M5W1791-02P to transfer data into the data register which has been written in response to DTRQ. In other words, unless the data is serviced within  $23.5\mu\text{s}$  (i.e.  $32 - 4 - 4.5 = 23.5\mu\text{s}$ ), there will no longer be time to begin transfer of data from the next data register to the data shift register.

For further details, refer to the section dealing with the description of the commands.

### 10.2 Floppy Disk Interface Section

The floppy disk interface section is composed mainly of the floppy disk head control section which relates to the head positioning control and the floppy disk read/write control section which controls the serial data transfer.

#### (1) Floppy Disk Head Control Section

For details on the operation of the floppy disk head control section, refer to Section 8.2(3) on the read control circuit, Section 8.2(4) on the head load time timer/stepping rate timer, and Section 8.2(5) on the index pulse counter/sector counter/step pulse counter as well as to Table 9.2 which

lists the flag options.

#### (2) Floppy Disk Read/Write Control Section

The floppy disk read/write control section executes the disk read and disk write operations.

The disk read and disk write operations have no direct relation to the read and write commands. For instance, when a write sector command is executed, the disk read operation is performed first to find the desired ID. After the ID is found, the M5W1791-02P writes the sync pattern, data field address mark, data and CRC, after which the command is terminated.

#### Disk Read Operation

The M5W1791-02P is applicable to both the single- and double-density recording formats, and selection between these is performed by the  $\overline{\text{DDEN}}$  double-density select input.

When the disk read operation starts, the write fault input/VFOE control output  $\overline{\text{WF/VFOE}}$  is set to "L". (This pin is pulled up by a 10-kohm resistance since it serves as an open-drain output during signal output.

The pin serves as the  $\overline{\text{VFOE}}$  output when the write gate output  $\text{WG} = \text{"L"}$ .) This output is kept at "L" until the disk read operation is terminated. The  $\overline{\text{VFOE}}$  output can be used as the signal that indicates that the PLL circuit employed as the external RCLK generator should enter into lock-in operation from its free-running state.

The following description is for the single-density mode which is almost the same as the double-density mode. When the disk read operation starts and the 2-byte 00 (HEX) is found, this is treated as a sync pattern and the read gate output RG is set to "H". Address mark FE, FB or F8 (HEX) are retrieved within the 10-byte period that follows. When the address mark is not found, RG is reset to "L" and a retry is made to retrieve the 2-byte 00 (HEX). If the address mark is found on the ID field and if the ID track address and sector address (and side number also when side compare bit  $\text{C} = \text{"1"}$ ) are correct, RG is held at "H" until CRC reading is completed and checked.

Whether there is a CRC error or not, RG is then reset to "L". When there is no error, the sync pattern of the data field is retrieved. When ID is not found properly, that is, when AM1 cannot be read properly, the values of the track register and track address do not match, the values of the sector register and sector address do not match, the side select flag of the command and side number do not match (when  $\text{C} = \text{"1"}$ ), or when there is a CRC error in the ID field, RG is reset to "0" and a retry is made to retrieve the 2-byte 00 (HEX).

However, when the read address command is executed, the data is read as far as the CRC byte if the sync pattern and AM1 are found properly, and the command is terminated

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regardless of whether there is a CRC error. When the data address mark is found, RG is held at "1" until the data and the CRC are read and CRC check is performed. RG is then reset to "0" regardless of whether there is a CRC error. If the command is single sector read or if a data field CRC error occurs, the INTRQ interrupt request output is set to "1" and the command is terminated. The CRC error status bit is set with a CRC error.

The read gate output is active during reading of the valid data stream from the sync field to the CRC. It is the signal that controls the read data tracking sensitivity for the external PLL RCLK generator circuit.

Operation in the double-density mode is the same as that for the single density mode except for the following points. In the double density mode the 4-byte "00" or "FF" (HEX) is treated as the sync pattern and the address marks "A1" "A1" "A1" "FE", "A1" "A1" "A1" "FB", or "A1" "A1" "A1" "F8" (HEX) are retrieved within the following 16-byte period.

Note that the  $\overline{VFOE}$  output is active when the read track command among the type 3 commands is executed but the RG output remains at "0".

Also bear in mind the following points relating to the disk read operation.

Even during the disk read operation, TG43 is updated in accordance with the track register contents before  $\overline{VFOE}$  is made active.

During the disk read or write operations mentioned below (the execution of type 2 and 3 commands), the READY input is checked at the beginning of the command's execution and if the input is not ready, the command is terminated, the interrupt request output is set to "1" and an interrupt is generated (this does not apply to type 1 and type 4 commands). In this case, the not ready status bit is set.

### Disk Write Operation

During the disk write operation, the write gate output WG is first set to "1". This enables the user to apply the write fault input to the write fault input/ $\overline{VFOE}$  VFO control output pin. Then write data are output from output WD. If the write fault input is made active when WG = "1", the command is immediately terminated, interrupt request output INTRQ is set to "1", an interrupt is generated, and the write fault status bit is set.

When the disk write operation is about to be suspended by the type 4 command and when the type 4 command is accepted into the M5W1791-02P's command register before the data field AM2 data mark or deleted data mark is written, the command is terminated when the type 4 command is written and an interrupt is generated. The type 4 command, which is written during disk write operation for the data field subsequent to the above mark writing, is also acknowledged immediately and the disk write operation is terminated.

The CPU system must write the data into the data register during the service period mentioned at the beginning of

Section 10 dealing with the Description of Operation with data request output DTRQ during the disk write operation. When the data is not written during the same service period, the command is continued with 00 (HEX) as the data which is written. The lost data status bit is set at this time. DRTQ is not reset if it is not serviced.

During the disk write operation, the early output or the late output is made active in accordance with the write data. Both output signals are used when the user provides write pre-compensation for the write data output, and they predict late or early peak shifts of the disk write data which is output at the same time.

The TG43 output is used to control the writing current of the floppy disk system. It is "0" at the time when the track register contents are 0 to 43, while it is "1" at 44 or above (up to 255).

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**11. DESCRIPTION OR COMMANDS**

**11.1 Command Standby Condition**

After the execution of a command has been completed, the M5W1791-02P stands by for the next command to be executed. If the head load HDLD has been set to "1" by the previous command and 15 index pulses are counted in the standby condition, the head is unloaded from the media. After this the M5W1791-02P remains into the command standby condition. When a command is written in the command register, the M5W1791-02P comes into operation according to the execution flow for the command.

**11.2 Type 1 Commands**

**(1) Restore Command**

This command is used to position the head to track 00. This command is automatically executed when the reset input is set from "0" to "1". During reset, the h = "0", V = "0" and r<sub>1</sub>, r<sub>0</sub> = "1, 1" flags are set automatically.

Refer to Section 8 dealing with the hardware configuration and in particular to Section 8.1(3) on the track register for details on the execution of the command. When the V flag is "1", the verify operation is performed after the head positioning operation. 00 (HEX) is automatically set in the data register.

**(2) Seek Command**

This command is used to move the head onto the desired track. After the destination track number is written into the data register and the seek command is written into the command register, step pulses are generated until the contents of both the track register and data register match. The direction of head movement is indicated by direction output DIRC.

The contents of the track register are updated every time a step pulse is output. When the V flag = "1", the verify operation is performed after the head positioning operation.

**(3) Step Command**

This generates a single step pulse. Direction output DIRC is not changed. Therefore, the head moves toward the same direction as it did the previous time. When the update flag u is "1", the contents of the track register are updated. When the V flag is "1", the verify operation is performed after the head positioning operation.

**(4) Step-in Command**

This command sets direction output DIRC to "1" and generates a single step pulse. When the u flag is "1", the contents of the track register are incremented by 1. When the V flag is "1", the verify operation is performed after the head positioning operation.

**(5) Step-out Command**

This command sets direction output DIRC to "0" and gener-

ates a single step pulse. When the u flag is "1", the contents of the track register are decremented by 1. When the V flag is "1", the verify operation is performed after the head positioning operation.

**11.3 Type 2 Commands**

Using the type 2 commands, reading/writing the data in the disk's data field is performed. When the desired sector is found, the data is transferred into/from the CPU system using the data request output DTRQ as the data transfer timing signal.

Side number comparison and multi-sector read/write can be performed by setting the command flag.

**(1) Read Sector Command**

When the read sector command is executed, once the ID field is found properly, the data is sent from the data shift register to the data register and the M5W1791-02P requests through DTRQ that the CPU system read out the data from the data register. (For details on the service time for DTRQ, refer to Section 10 dealing with the Description of Operation.)

Unless the CPU reads out the data within the service time, the next data is written from the data shift register into the data register. The data which has not been read is destroyed and the lost data status bit is set. DTRQ is reset by the data register readout, but when the data has not been read out during the service time, DTRQ remains at "1".

The length of the data fields in each sector is indicated by the sector length of the disk ID. This value is saved inside the M5W1791-02P and DTRQ is generated for the necessary number of times in accordance with this value.

The relationship between the number of data in a single sector and the data byte length is shown below.

**Table 11.3 Data Byte Length**

Sector length of the disk ID	Bytes/sector
00H	128 bytes
01H	256 bytes
02H	512 bytes
03H	1024 bytes

When, for instance, the sector length, i.e. the 4th byte of ID is 00 (HEX), data request output DTRQ is "1" for 128 times unless lost data occurs. If, for example, lost data occurs once, DTRQ is "1" for 127 times.

For multi-sector read, refer to the section on flag option m in Table 9.2.

Depending upon the data address mark of the data field, the record type status bit can be set. When the data mark is FB (HEX), the record type status bit is set to "0" and when the deleted data mark is F8 (HEX), it is set to "1".

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**(2) Write Sector Command**

When the ID field is found properly upon execution of the write sector command and the CRC check is completed without any errors detected, the M5W1791-02P generates a single data request output DTRQ. In response to this DTRQ, the CPU must write the data into the data register during the 8-byte time (1-byte time is 32 $\mu$ s in the single-density mode and 16 $\mu$ s in the double-density mode with CLK = 2MHz).

Whether or not the service has been performed during the specified time is then determined.

When the service has not been performed in the specified time, the lost data status bit is set, the execution of the command is terminated and interrupt request output INTRQ is set to "1".

When the first service has been performed, the data is written after the sync pattern and AM2 have been written.

After a lost data check, there is a 1-byte time delay (with the single-density mode), then the write gate output WG is set to "1", the 6-byte sync field 00 (HEX) is written into the disk, and FB or F8 (HEX) is written depending on the value of the command's data address mark flag  $a_0$ . DTRQ is generated and data is written in succession until the number per sector indicated by the ID data length in that sector is reached.

In the double-density mode, the write gate output WG is set to "1" after 12-byte time delay following the lost data check, the 12-byte sync field 00 (HEX) is written, and the 3-byte A1 (HEX) is written, after which the same operation is performed as for the single-density mode.

Unless the data are written into the data register from the CPU system within the prescribed service time for the second and further DTRQ data request outputs, data 00 (HEX) is written on the disk and the lost data status bit is set. The behavior of the DTRQ output when lost data is generated is the same as that described in the section on the read sector command.

Operations for multi-sector writing are the same as those during the read sector command.

**11.4 Type 3 Commands**

Type 3 commands consist of 3 commands: read address, read track and write track.

**(1) Read Address Command**

The 6 bytes of the ID field found first are read out with the execution of the read address command. These 6 bytes in order are: 1) track number, 2) side number, 3) sector number, 4) data length and 5) 2-byte CRC. When data is sent to the data register, data request output DTRQ is generated from the M5W1791-02P and the CPU system is requested to read out the data from the data register. If DTRQ is not serviced within the service time, the lost data status bit is set and the next data is written from the data shift register into the data register as with the read sector command. When

the read address command is executed, the track number which has been read out is also written into the sector register of M5W1791-02P along with the CRC check.

**(2) Read Track Command**

The read track command serves to read out all the data of an entire track, beginning and ending upon detection of the index pulse. Unlike the read sector or read address commands, all the data including the gaps and sync pattern are read out. The data are synchronized when the index mark, ID address mark and data address mark are detected. "Data synchronization" refers to reading the data string from the floppy disk in 1-byte units. Read gate output RG, which gives notification that the sync pattern has been detected, is not output with this command.

Neither side number comparison nor CRC check is conducted with the read track command. Unless the CPU read out data within the specified service time as with the other disk read command, the data is lost.

**(3) Write Track Command**

The write track command formats the tracks on the disk. Disk formatting requires not only that the gaps, sync pattern, ID and data are written, but also that the marker including the missing clock and the CRC are written.

When this command is executed, the first data request output DTRQ is generated after the head has been loaded into the media. In response to this, the CPU must complete the writing of the data within the 3-byte time.

Unless the data are serviced during this time, the lost data status bit is set, subsequent commands are terminated the interrupt request output INTRQ is set to "1". When the data is serviced during the specified time, data write starts with the arrival of the index pulse. Then the CPU writes the data into the data register in accordance with the data request output.

When data written by the CPU are values from F5 to FE (HEX), M5W1791-02P performs special processing consisting of writing the markers and generating and writing the CRC. When other data from 00 to F4 and FF (HEX) are written into the data register, the value is modulated as it is and written onto the disk.

The write track command continues until the next index pulse input IP is detected.

If the CPU hasn't loaded the data into the data register within the service time, 00 (HEX) is written and the lost data status bit is set.

Table 11.4 shows the control bytes of the write track command.

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Table 11.4 Write Track Command Control Bytes

Data register contents	Single-density format			Double-density format		
	Function	Data pattern	Clock pattern	Function	Data written onto disk	Missing clock
00~F4	Data register values are written onto the disk without modification.	00~F4	FF	Data register values are written onto the disk without modification.	00~F4	Not generated
F5	Non-usable			Marker A1 is written. CRC is preset.	A1	Generated
F6	Non-usable			Marker C2 is written.	C2	Generated
F7	2 calculated CRC bytes are written.	2-byte CRC	FF	2 calculated CRC bytes are written.	2-byte CRC	Not generated
F8~FB	Writing as data. Used for writing data address mark. CRC is preset.	F8~FB	C7	Writing as data. Used for writing data address mark. CRC is preset.	F8~FB	Not generated
FC	Index mark FC is written.	FC	D7	Index mark FC is written.	FC	Not generated
FA	Writing as data.	FD	FF	Writing as data.	FD	Not generated
FE	ID address mark is written. CRC is preset.	FE	C7	ID address mark is written. CRC is preset.	FE	Not generated
FF	Writing as data.	FF	FF	Writing as data.	FF	Not generated

Note : Hexadecimal notation is used throughout.

### 11.5 Type 4 Commands

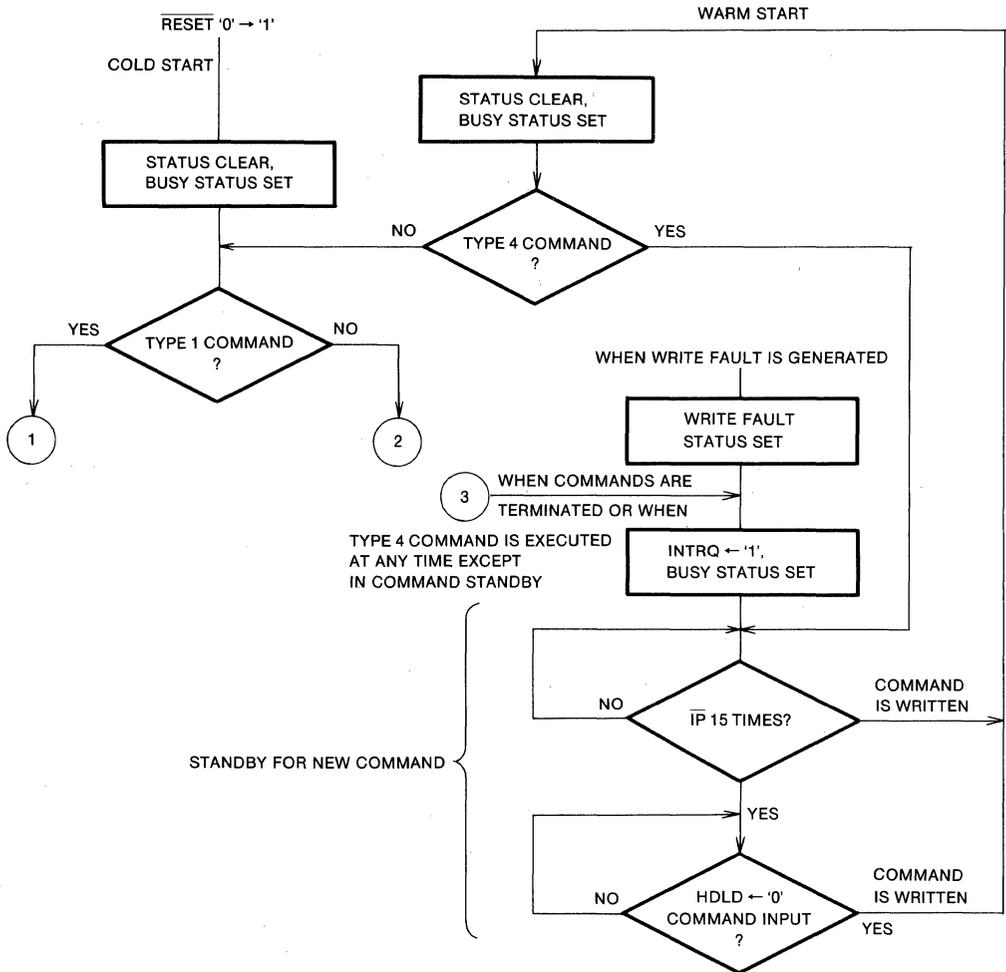
This command generates the interrupt through detection of conditions or generates the unconditional interrupt other commands may be executed only if the M5W1791-02P is in the standby condition (busy status bit is "0"), but the type 4 command may be executed at any time.

When a preceding command is being executed, it is suspended and operation is keyed to the flag bit of the type 4 command. Refer to Table 9.2 for the flag bits.

Interrupt request output INTRQ generated by the type 4 command is reset by reading the status register data or executing a command after the execution of the type 4 command with  $I_0 \sim I_3 = "0"$ .

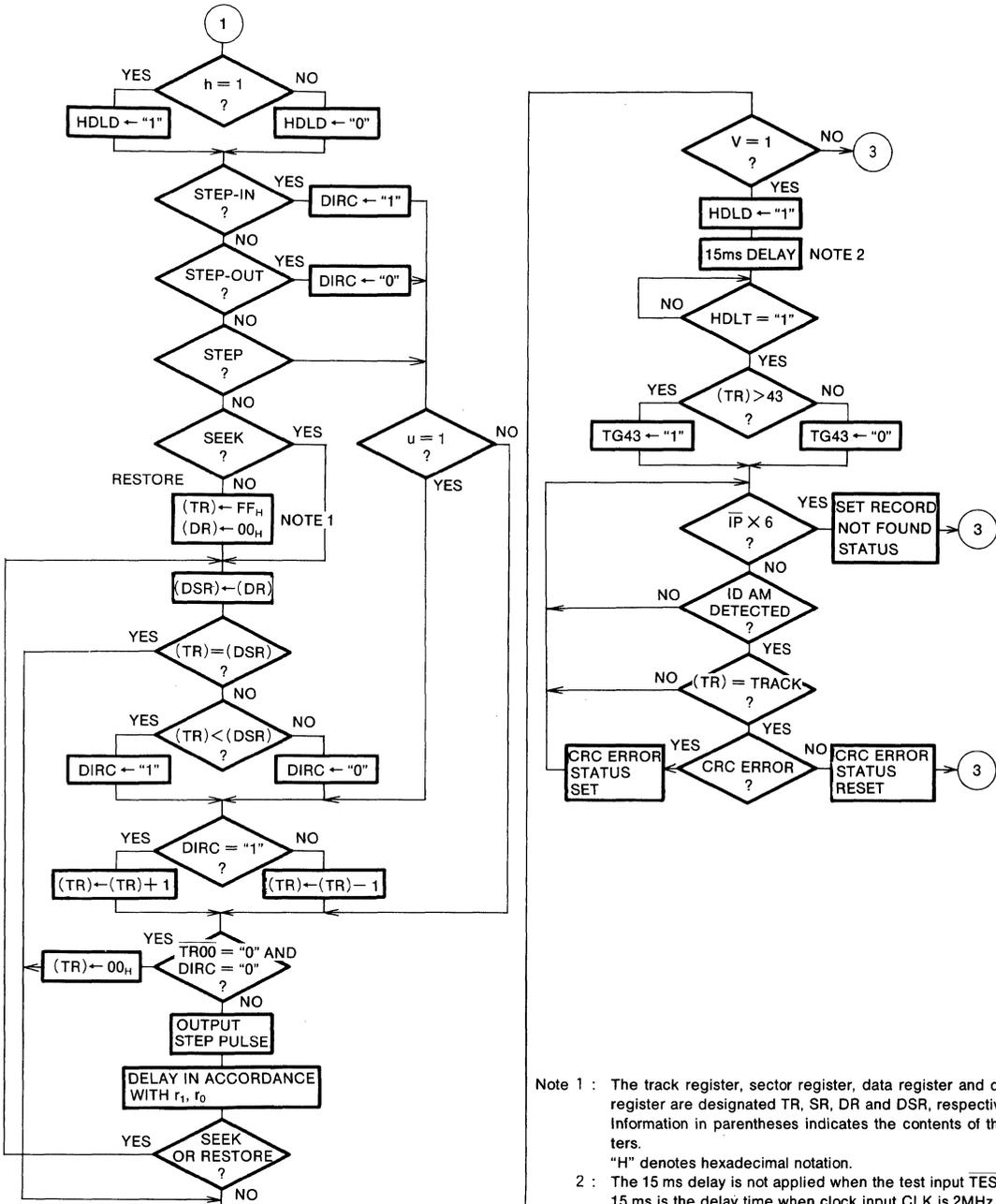
**FLOPPY DISK FORMATTER/CONTROLLER**

**COMMAND STANDBY CONDITION**



**FLOPPY DISK FORMATTER/CONTROLLER**

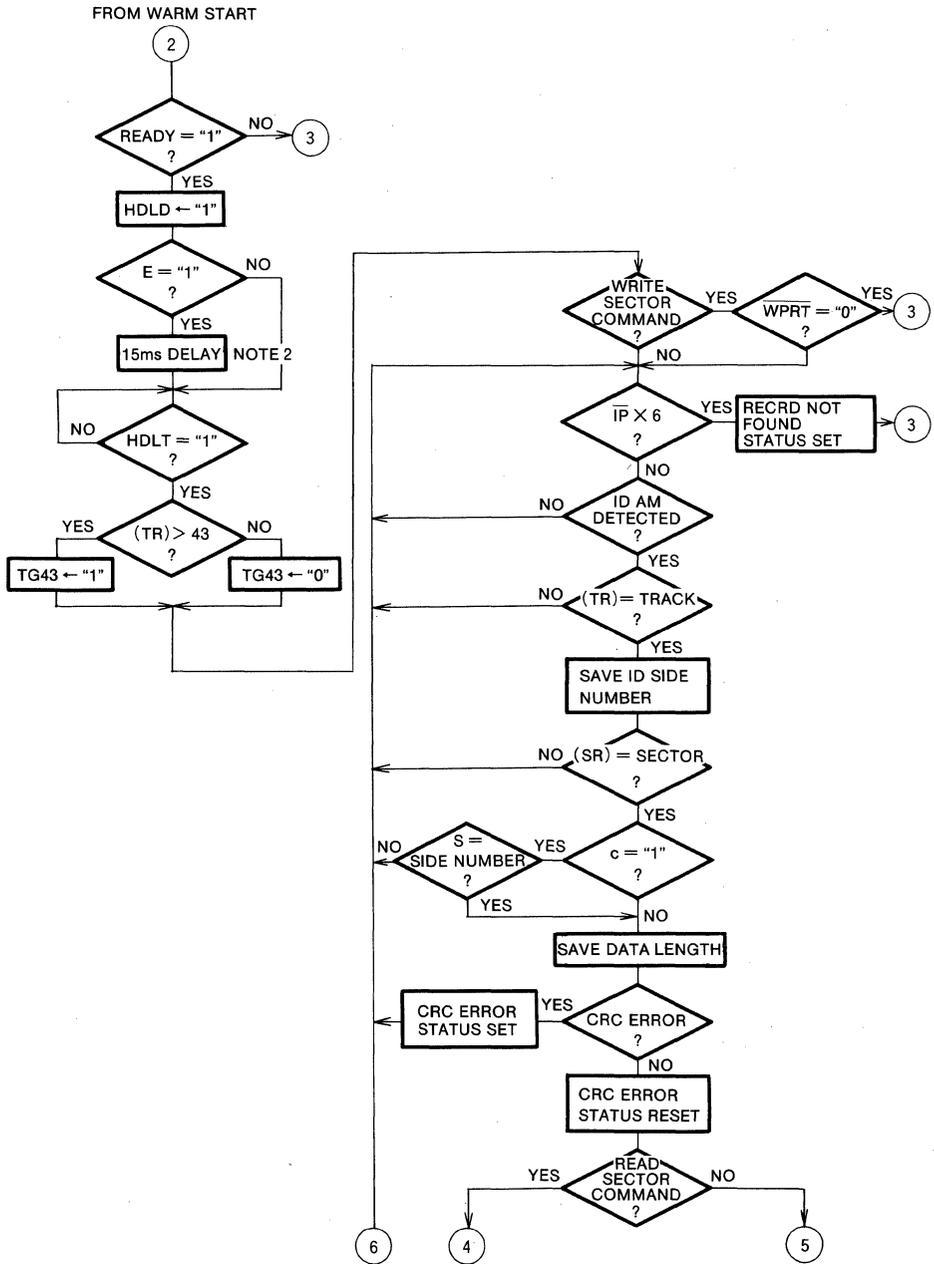
**TYPE 1 COMMAND**



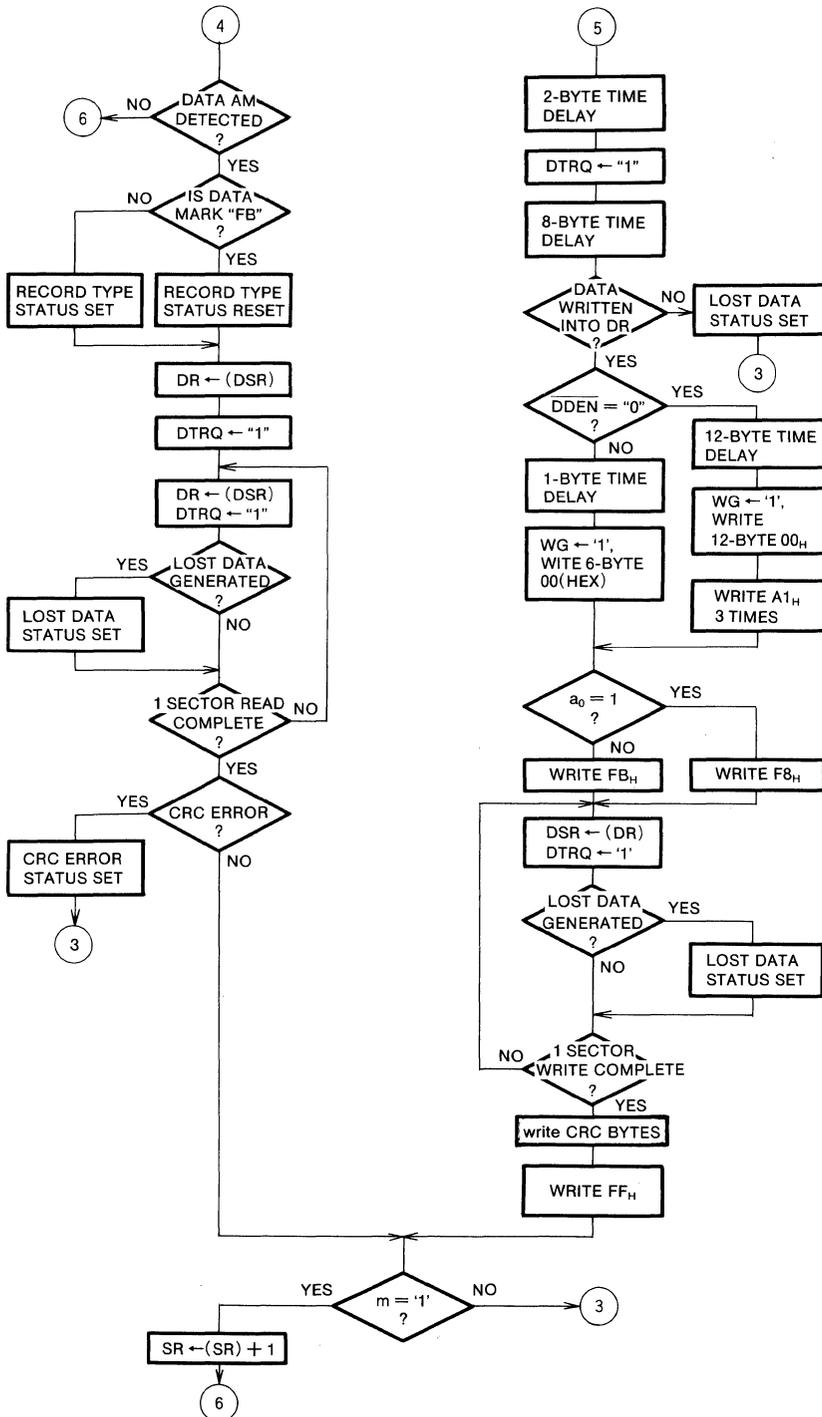
Note 1 : The track register, sector register, data register and data shift register are designated TR, SR, DR and DSR, respectively. Information in parentheses indicates the contents of the registers.  
 "H" denotes hexadecimal notation.  
 2 : The 15 ms delay is not applied when the test input TEST is "0". 15 ms is the delay time when clock input CLK is 2MHz.

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**TYPE 2 COMMAND**



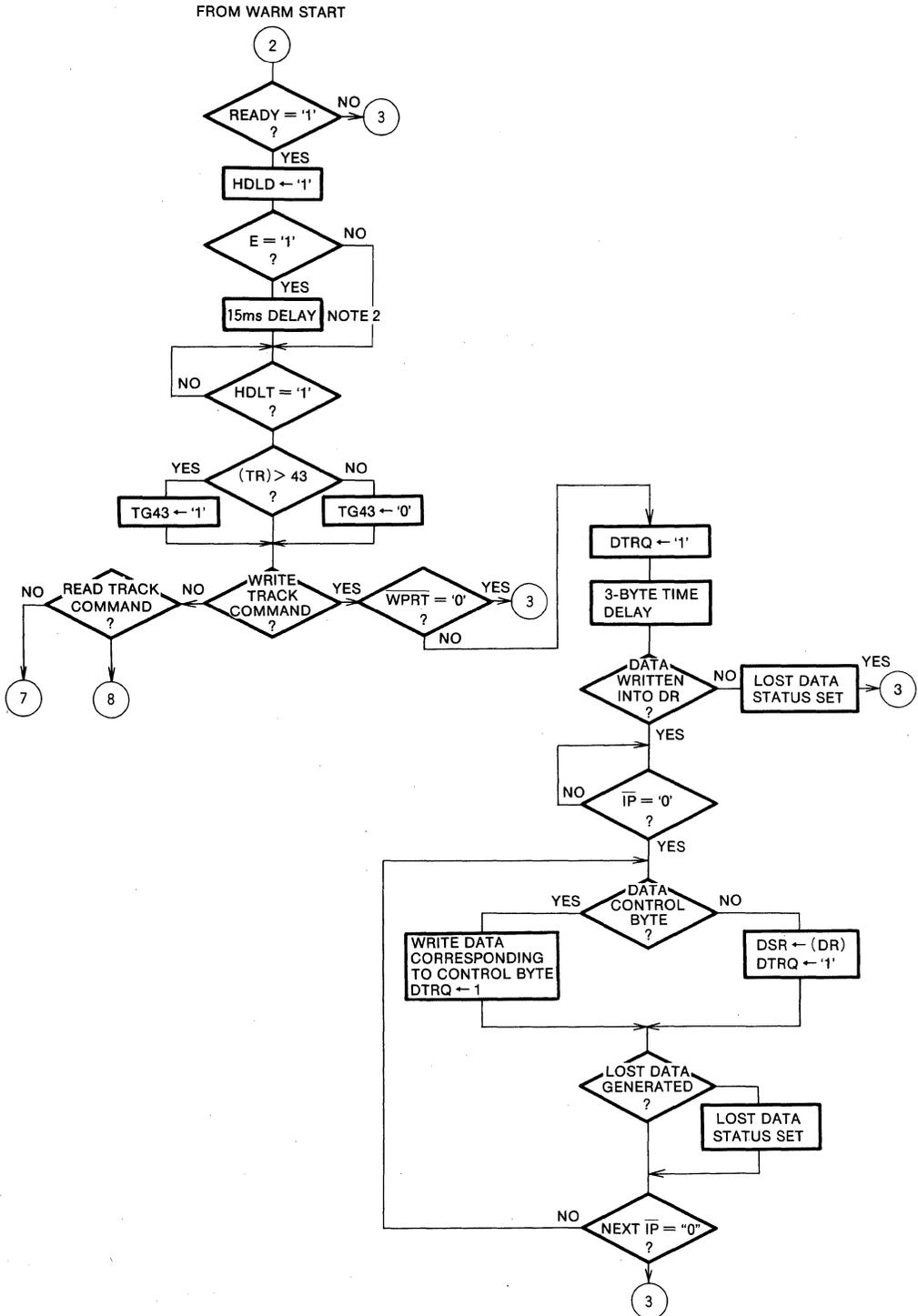
**FLOPPY DISK FORMATTER/CONTROLLER**



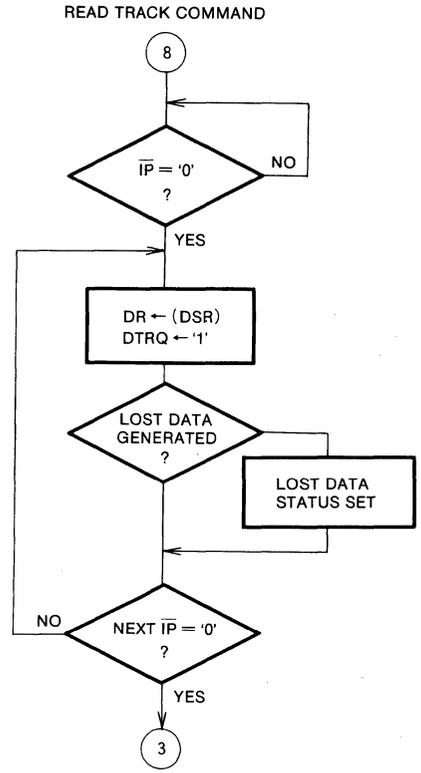
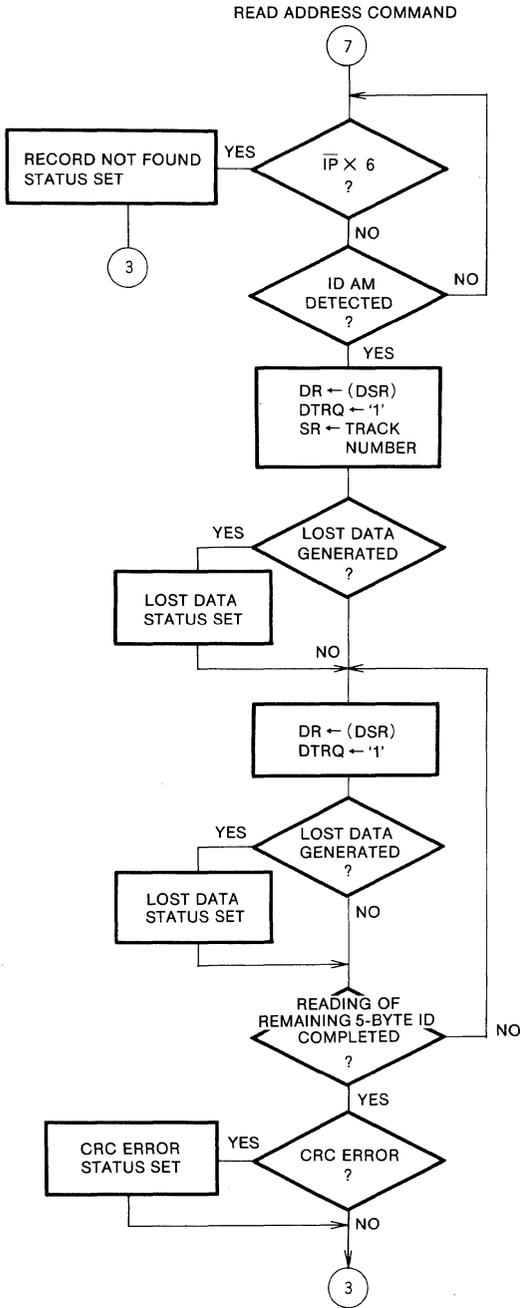
**6**

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**TYPE 3 COMMAND**



**FLOPPY DISK FORMATTER/CONTROLLER**



**6**

**FLOPP DISK FORMATTER/CONTROLLER**

**12. STATUS**

The significance of the bits in the status register differs according to the command. The bit 0 of the status register is set during type 1, 2 and 3 commands to indicate the busy status. When this bit is set, the other status bits may be reset or updated. When the type 4 command has been executed, the busy status bit is reset, but whether the remaining status bits are reset or not depends on whether the previous command is being performed or not when the type 4 command is issued. When M5W1791-02P is in standby, the remaining status bits are reset or updates according to the same status bit configuration as the type 1 command. When the type 4 command has been issued during the execution of the pervious command, the remaining status bits show the status of the previous command.

Tables 12.1 and 12.2 show the significance of each status bit.

**Tabl 12.1 Status Composition**

Status bit Command		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
		Type 1 command	Not ready	Write protect	Head loaded	Seek error	CRC error	Track 00	Index
Type 2 command	Read sector	Not ready	0	Record type	Record not found	CRC error	Lost data	Data request	Busy
	Write sector	Not ready	Write protect	Write fault	Record not found	CRC error	Lost data	Data request	Busy
Type 3 command	Read address	Not ready	0	0	Record not found	CRC error	Lost data	Data request	Busy
	Read track	Not ready	0	0	0	0	Lost data	Data request	Busy
	Write track	Not ready	write protect	Write fault	0	0	0	Data request	Busy
Type 4 command	No preceding Command	Not ready	Write protect	Head loaded	0	0	Track 00	Index	0
	Preceding command	Same as definition of status bit based on preceding command.							

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Table 12.2 Status Register Contents

Command	Status bit	Status	Status Significance
Type 1	7	Not ready	"1" denotes that the disk is not ready. This status is provided by the OR relationship between the READY input inverted signal and the RESET input inverted signal.
	6	Write protect	"1" denotes that the disk is in the write protect status. This status is the inverted signal of the write protect input WPRT.
	5	Head loaded	"1" denotes that the head has been loaded onto the disk and stabilized. This status is provided by the AND relationship between the head load output HDLD and head load timing input HDLT.
	4	Seek error	"1" denotes that the verify operation was not successful. This status is reset at the beginning of the following command execution.
	3	CRC error	"1" denotes that there is a CRC error in the ID field. This status is reset at the beginning of the next command execution. (Note 1)
	2	Track 00	"1" denotes that the head is on track 00. This status is the inverted signal of the track 00 input TR00.
	1	Index	"1" denotes that the index pulse input IP is active. This status is the inverted signal of IP.
	0	Busy	"1" denotes that the type 1 command is being executed. After the CPU has written the command, a maximum of 24 clocks for single density and 12 clocks for double-density are required for the busy status flag to be set.
Type 2/ Type 3	7	Write protect	"1" denotes that the disk is not ready. This status is produced by the OR relationship between the READY input inverted signal and the RESET input inverted signal.
	6	Write protect	"1" denotes that the disk is in the write protect status. This status is the write protect input WPRT inverted signal.
	5	Record type Write fault	The record type is set during read. "1" denotes that the address mark of the data field was the deleted data mark. "0" denotes that it was the data mark. During write operations, "1" denotes that the command has been suspended by the write fault input. This status is reset when the next command execution begins (Note 1)
	4	Record not found	"1" denotes that the designated ID has not been properly detected. This status is reset when the next command execution begins. (Note 1)
	3	CRC error	"1" denotes that a CRC error is detected in the ID field or data field. This status is reset when the following command execution begins. (Note 1)
	2	Lost data	"1" denotes that lost data have arisen. This status is reset when the following command execution begins. (Note 1)
	1	Data request	"1" denotes that reading data from writing data to the data register is requested. This status is the same as the data request output DTRQ.
	0	Busy	"1" denotes that the command is being executed. After the CPU system has written the command, a maximum of 24 clocks for single-density and 12 clocks for double-density are required until the busy status flag is set.

Note 1 : Refer to Table 12.1 for details when the type 4 command is executed.

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**13. DISK FORMATTING**

Disk formatting is performed by the write track command. Formatting examples are given below for both single-density 128 bytes/sector based on the IBM 3740 format and double-density 256 bytes/sector based on the IBM system 34 format.

**Table 13.1 Disk IBM 3740 Format**

Transfer byte number	Transfer data (HEX)	Significance of transfer bytes
40	FF	Gap 4
6	00	Sync pattern
1	FC	index mark
26	FF	Gap 1
(Note 1) 6	00	Sync Pattern
1	FE	ID address mark
1	00~4C	Track number
1	00 or 01	Side number
1	01~1A	Sector number
1	00	Data length
1	F7	2-byte CRC write
11	FF	Gap 2
6	00	Sync pattern
1	FB	Data mark
128	E5	Data
1	F7	2-byte CRC write
27	FF	Gap 3
(Note 2) 247	FF	Gap

- Note 1 : This sequence is repeated 26 times while the sector number is updated. The formatting of one track is then completed.  
 2 : This is the standard value which keeps sending the FF data until the interrupt request output INTRQ is set.

**Table 13.2 Disk IBM System 34 Format**

Transfer byte number	Transfer data (HEX)	Significance of transfer bytes
80	4E	Gap 4
12	00	Sync pattern
3	F6	index mark
1	FC	index mark
50	4E	Gap 1
(Note 1) 12	00	Sync Pattern
3	F5	ID address mark
1	FE	ID address mark
1	00~4C	Track number
1	00 or 01	Side number
1	01~1A	Sector number
1	01	Data length
1	F7	2-byte CRC write
22	4E	Gap 2
12	00	Sync pattern
3	F5	Data address mark
1	FB	Data mark
256	40	Data
1	F7	2-byte CRC write
54	4E	Gap 3
(Note 2) 598	4E	Gap 4

- Note 1 : This sequence is repeated 26 times while the sector number is updated. The formatting of one track is then completed.  
 2 : This is the standard value which keeps sending the 4E data until the interrupt request output INTRQ is set.

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**14. TRACK FORMAT**

Track format is given in Fig. 14.

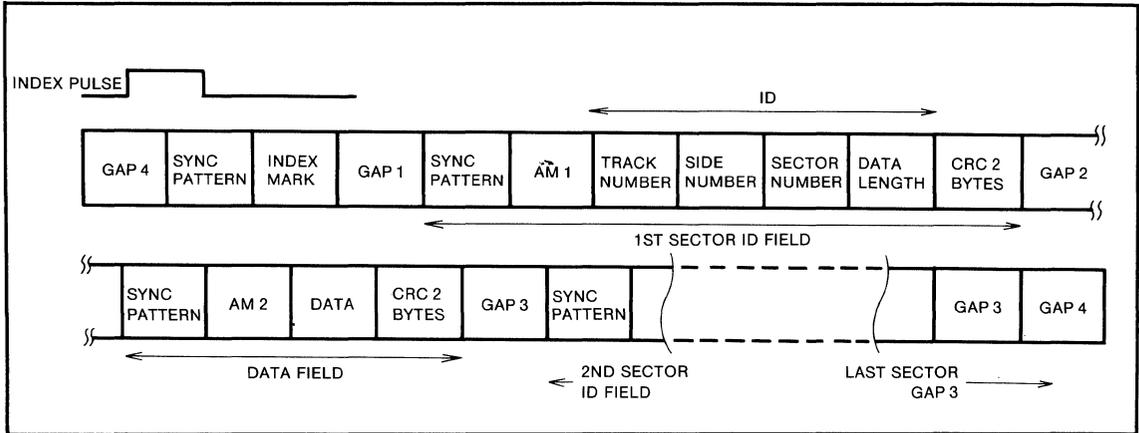


Fig. 14 Track format

**15. TYPICAL EXTERNAL READ CLOCK GENERATOR CIRCUIT**

A read clock must be applied from an external oscillator with the M5W1791-02P. Described below is an example of an external read clock generator circuit used for an 8-inch floppy disk and employing a PLL circuit.

The circuit itself is an analog PLL circuit containing a voltage-controlled oscillator (VCO) with a center frequency of 8MHz. It is applicable to both single- and double-density modes, and is composed of a phase comparator, filter and VCO. Fig. 15.1 shows the phase comparator and Fig. 15.2 shows the filter and VCO.

In Fig. 15.1 the phase of the raw data read from the floppy disk is compared with the phase of the signal produced by dividing the VCO CLOCK. If, as a result, the phases do not match, the VCO frequency is tracked by the UP or DOWN signal. When VFOE is not active, the reference clock is input.

The filter in Fig. 15.2 acquires the required frequency gain characteristics by means of the NF loop RC elements. C<sub>1</sub> is for tracking the VCO with respect to the relatively low frequency fluctuations in the form of flutter during floppy disk rotation, etc. In contrast, C<sub>2</sub> is for reducing the VCO gain in the event of relatively high frequency fluctuations.

A 74S124 is required for the VCO TTL, since the 74LS124 is not sufficient as the 8MHz voltage-controlled oscillation. R<sub>1</sub>, R<sub>2</sub> and R<sub>3</sub> determine the gain. R<sub>1</sub> and R<sub>2</sub> are resistances from 500 ohms to 3.3 kohms. R<sub>3</sub> has a resistance from 2.2 to 4.7 kohms.

C<sub>1</sub> has a capacitance of 0.047μF to 0.3μF while C<sub>2</sub> has a value of 0.001μF to 0.0033μF.

C<sub>3</sub> has a capacitance of 47pF for generating an 8MHz frequency when VR is set to its center position and the CONT input is made 1/2V<sub>CC</sub>. R<sub>4</sub> is for setting the operating point of TR<sub>1</sub> and it is provided with a resistance of 50 kohms to 1 Mohm.

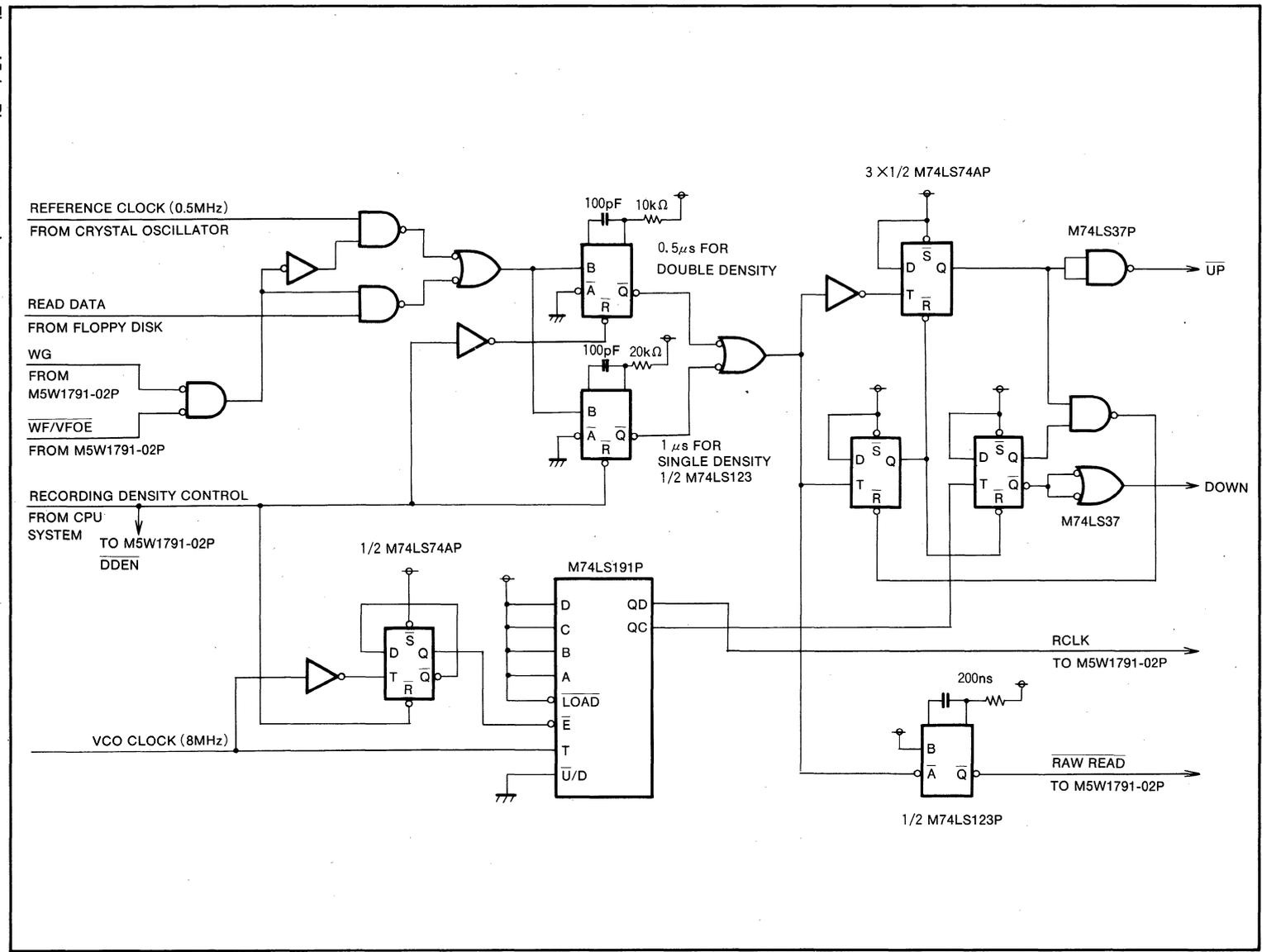
Care should be taken with parts layout and writing of the VCO circuit, especially for the power supply and ground line of the 74S124. V<sub>CC</sub> instability causes a marked deterioration in PLL response.

In the above example there is no filter or gain switching by read gate output RG.

Note: The circuit in the example given above has low sensitivity to elements value, and works stably. However, the actual circuit used should be determined with regard to the whole system, including the floppy disk system.

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Fig. 15.1 Phase comparator



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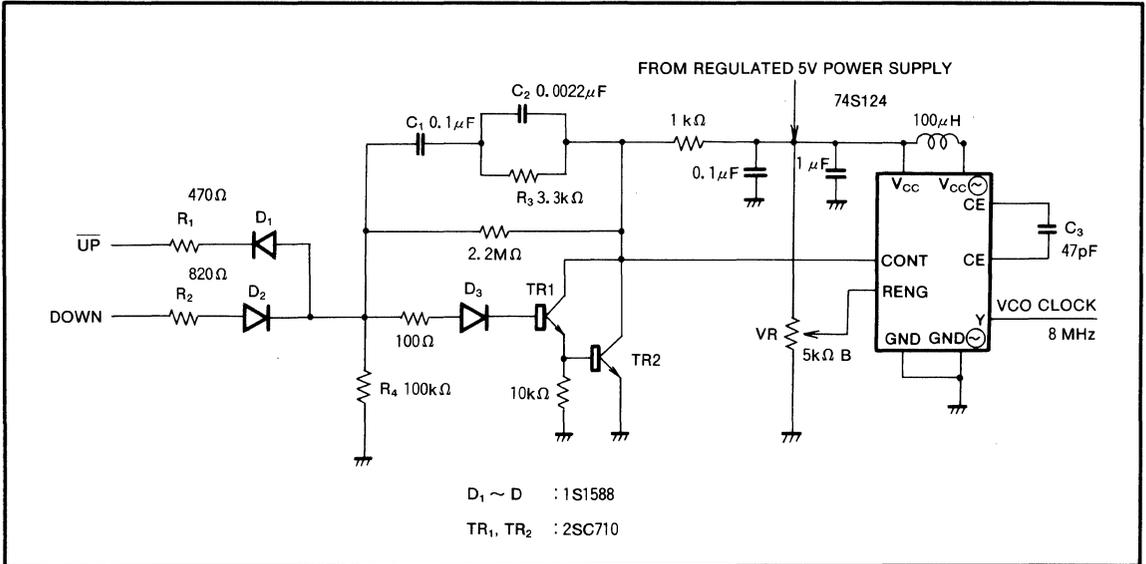


Fig. 15.2 Filter and VCO

**16. TYPICAL WRITE PRECOMPENSATION CIRCUIT**

Fig. 16 gives an example of a write precompensation circuit. The amount of compensation must be set to a value which regulated for the floppy disk system. Clock generator 74S124, for the VCO of the external read clock generator

circuit in Section 15, has 2-channel VCO's so the extra one can be used also. In this case, the write data pulse width of the M74LS153 in Fig. 16 is determined by the clock and if required, it should be converted to the write data pulse width demanded by the floppy disk system using a one-shot multi-vibrator, etc.

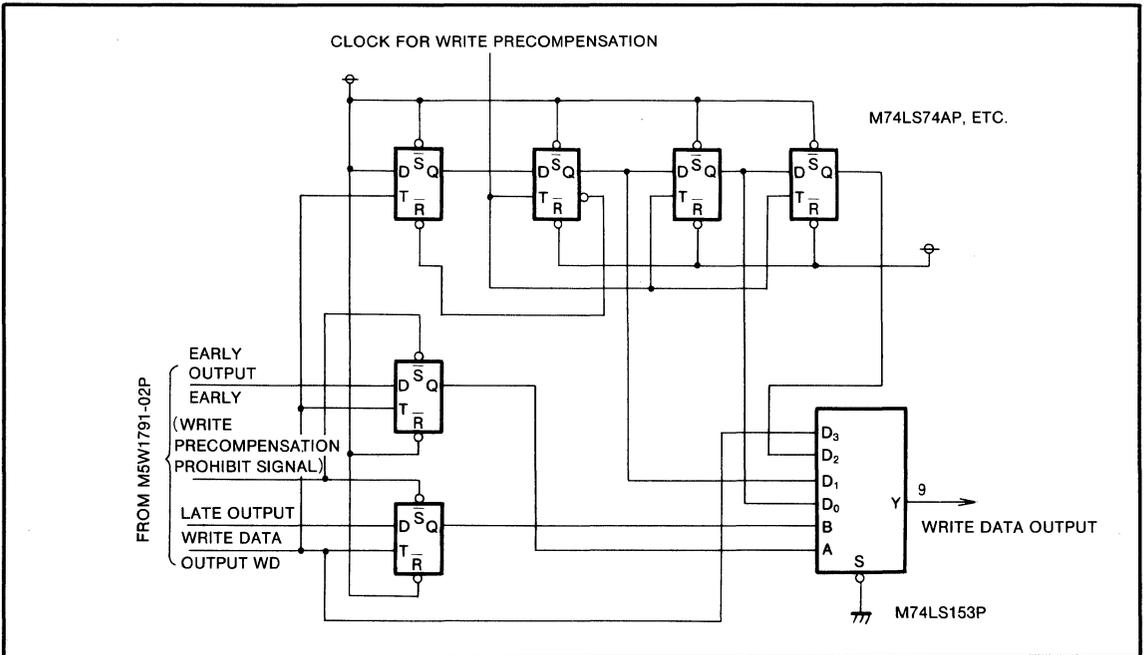


Fig. 16 Write precompensation circuit

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**17. EXAMPLE OF A WRITE GATE  
 OUTPUT AND WRITE FAULT/VFO  
 ENABLE CIRCUIT**

The WF/VFOE serves as the write fault input or VFO enable output, depending on the WG output.

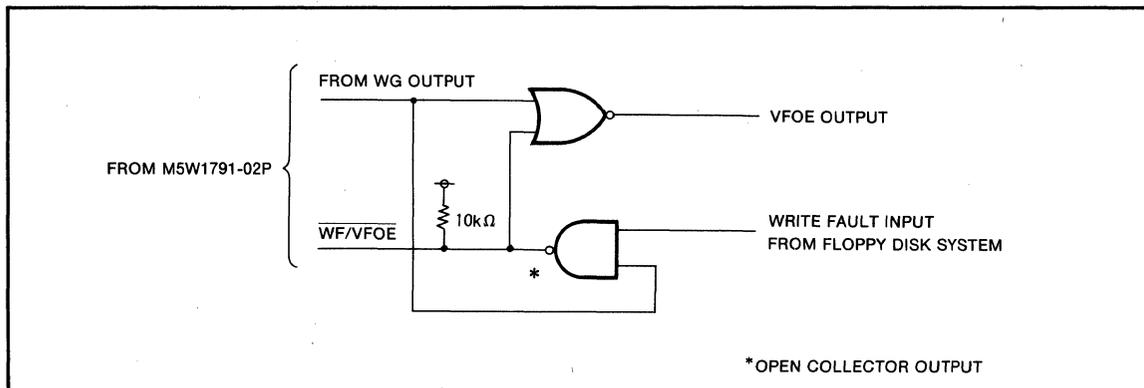
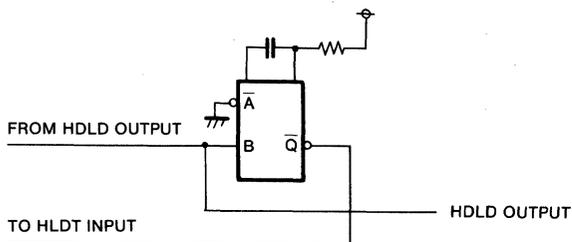


Fig. 17 Write fault/VFOE control circuit

**18. AN EXAMPLE OF THE HEAD  
 LOAD OUTPUT AND HEAD LOAD  
 TIMING CIRCUIT**

The head load timing input is made available after the setting time has elapsed from the head load output.



## FLOPP DISK FORMATTER/CONTROLLER

## 19 ELECTRICAL CHARACTERISTICS

## 19.1 ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage	With respect to $V_{SS}$	-0.5~7	V
$V_I$	Input voltage		-0.5~7	V
$V_O$	Output voltage		-0.5~7	V
$P_d$	Power dissipation	$T_a=25^\circ\text{C}$	350	mW
$T_{opr}$	Operating free-air temperature range		0~70	$^\circ\text{C}$
$T_{stg}$	Storage temperature range		-65~150	$^\circ\text{C}$

19.2 RECOMMENDED OPERATING CONDITIONS ( $T_a=0\sim 70^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.75	5	5.25	V
$V_{SS}$	Supply voltage		0		V
$V_{IH}$	High-level input voltage	2			V
$V_{IL}$	Low-level input voltage	$V_{SS}-0.5$		0.8	V

19.3 ELECTRICAL CHARACTERISTICS ( $T_a=0\sim 70^\circ\text{C}$ ,  $V_{CC}=5V\pm 5\%$ , unless otherwise noted)

Symbol	Parameter	Test condition	Limits			Unit
			Min	Typ	Max	
$V_{OH}$	High-level output voltage	$I_{OH}=-200\mu\text{A}$	2.4			V
$V_{OL}$	Low-level output voltage	$I_{OL}=1.8\text{mA}$			0.4	V
$I_{CC}$	Supply current				70	mA
$I_i$	Input current.(HDLT, TEST, WF/VFOE, WPRT, DDEN)	$V_i=V_{CC}\sim 0V$	-100		10	$\mu\text{A}$
	Input current other inputs	$V_i=V_{CC}\sim 0V$	-10		10	$\mu\text{A}$
$I_{OZ}$	Off-state output current	$V_i=V_{CC}\sim 0V$	-10		10	$\mu\text{A}$

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**19.4 TIMING REQUIREMENTS** ( $T_a=0\sim 70^{\circ}\text{C}$ ,  $V_{CC}=5V\pm 5\%$ ,  $V_{SS}=0V$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{SU(A-R)}$ $t_{SU(CS-R)}$	Address setup time before read and chip select	TSET		50			ns
$t_{H(R-A)}$ $t_{H(R-CS)}$	Address hold time after read and chip select	THLD		10			ns
$t_{W(R)}$	Read pulse width	TRE	$C_L=50\text{pF}$	280			ns
$t_{SU(A-W)}$ $t_{SU(CS-W)}$	Address setup time before write and chip select	TSET		50			ns
$t_{H(W-A)}$ $t_{H(W-CS)}$	Address hold time after write and chip select	THLD		10			ns
$t_{W(W)}$	Write pulse width	TWE		200			ns
$t_{SU(DQ-W)}$	Data setup time before write	TDS		250			ns
$t_{H(W-DQ)}$	Data hold time after write	TDH		20			ns
$t_{W(RR)}$	Raw read pulse width	$T_{PW}$	(Note 1, 2)	100		250	ns
$t_{C(RR)}$	Raw read cycle time	$T_{bc}$	(Note 3)	1600	2000		ns
$t_{W(RCLK)}$	Read clock high-level width	$T_a$	(Note 4)	800			ns
$t_{W(RCLK)}$	Read clock low-level width	$T_b$	(Note 4)	800			ns
$t_{C(RCLK)}$	Read clock cycle time	$T_c$		1600			ns
$t_{H(RCLK-RR)}$	Read clock hold time before raw read	$T_{x1}$		40			ns
$t_{H(RR-RCLK)}$	Read clock hold time after raw read	$T_{x2}$	FM	40			ns
			MFM	40			ns
$t_{W(WD)}$	Write data pulse width	$T_{wp}$	FM	450	500	550	ns
			MFM	150	200	250	ns
$t_{C(WD)}$	Write data cycle time	$T_{bc}$			2, 3, 4		$\mu\text{s}$
$t_{W(\phi)}$	Clock high-level pulse width	$TCD_1$		230	250	20000	ns
$t_{W(\bar{\phi})}$	Clock low-level pulse width	$TCD_2$		200	250	20000	ns
$t_{W(RESET)}$	Reset pulse width	TMR		50			$\mu\text{s}$
$t_{W(IP)}$	Index pulse width	TIP	(Note 5)	10			$\mu\text{s}$
$t_{W(WF)}$	Write fault pulse width	TWF	(Note 5)	10			$\mu\text{s}$

**19.5 SWITCHING CHARACTERISTICS** ( $T_a=0\sim 70^{\circ}\text{C}$ ,  $V_{CC}=5V\pm 5\%$ ,  $V_{SS}=0V$ , unless otherwise noted)

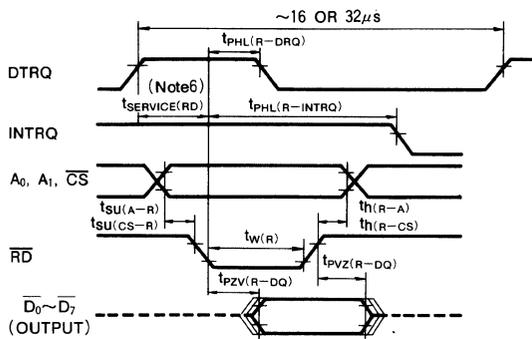
Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{PLH(WG-WD)}$	Propagation time from write gate to write data	$T_{wg}$	FM (Note 5)		2		$\mu\text{s}$
			MFM (Note 5)		1		$\mu\text{s}$
$t_{PLH(E-WD)}$ $t_{PLH(L-WD)}$	Propagation time from early or late to write data	$T_s$	MFM (Note 5)	125			ns
$t_{PHL(WD-E)}$ $t_{PHL(WD-L)}$	Propagation time from write data to early or late	$T_h$	MFM (Note 5)	125			ns
$t_{PHL(WD-WG)}$	Propagation time from write data to write gate	$T_{wt}$	FM (Note 5)		2		$\mu\text{s}$
			MFM (Note 5)		1		$\mu\text{s}$
$t_{PZV(R-DQ)}$	Output enable time after read	TDACC	$C_L=50\text{pF}$			250	ns
$t_{PZV(R-DQ)}$	Output disable time after read	TDOH	$C_L=50\text{pF}$	50		150	ns
$t_{PHL(R-DRQ)}$	Propagation time from read to DRQ	TD $RR$ (RD)				250	ns
$t_{PHL(R-INTRQ)}$	Propagation time from read to INTRQ	TIR $R$ (RD)	(Note 5)			500	ns
$t_{PHL(W-DRQ)}$	Propagation time from write to DRQ	TD $RR$ (WR)				250	ns
$t_{PHL(W-INTRQ)}$	Propagation time from write to INTRQ	TIR $R$ (WR)	(Note 5)			500	ns
$t_{W(STP)}$	Step pulse width	TSTP	(Note 5)	2or4			$\mu\text{s}$
$t_{PLH(DIR-STP)}$	Propagation time from direction to step	TDIR	(Note 5)	12			$\mu\text{s}$
$t_{V(WD-CLK)}$	Write data valid time before clock	$T_{wd1}$	CLK=1MHz MFM	200			ns
			CLK=2MHz MFM	30			ns
$t_{V(CLK-WD)}$	Write data valid time after clock	$T_{wd2}$	CLK=1MHz MFM	50			ns
			CLK=2MHz MFM	50			ns

- Note 1 : The pulse of RAW READ may be any width if pulse is entirely within RCLK. When the pulse occurs in the RCLK window, RAW READ pulse width must be less than 300 ns for MFM mode and 600 ns for FM mode at CLK=2MHz. Times double for 1MHz.  
 2 : 100 ns pulse width is recommended for the RAW READ pulse in 8 MFM mode.  
 3 : RAW READ cycle time  $T_{C(RR)}$  and WD cycle time  $T_{C(WD)}$  is normally 2 $\mu\text{s}$  in MFM and 4 $\mu\text{s}$  in FM. Times double when CLK=1MHz.  
 4 : The polarity of RCLK during RAW READ is not important.  
 5 : Times double when CLK=1MHz.

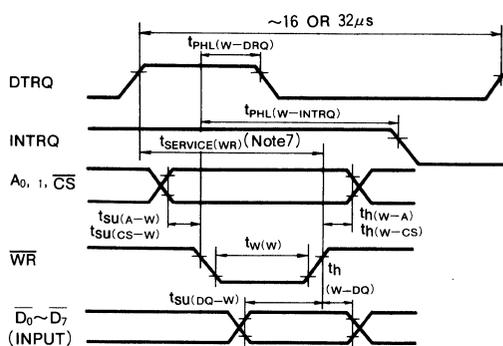
**FLOPPY DISK FORMATTER/CONTROLLER**

**19.6 TIMING DIAGRAM**

**Read**

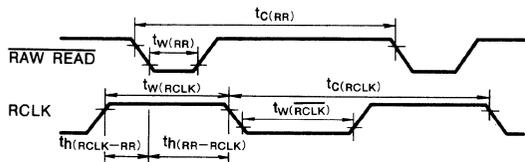


**Write**

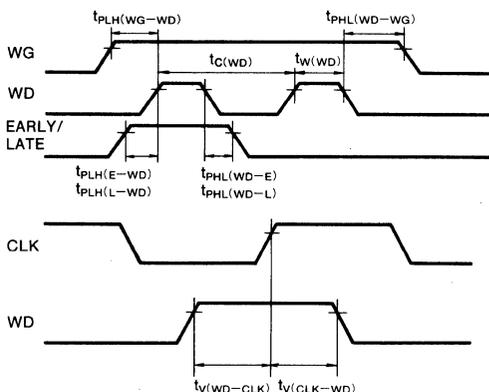


Note 6 :  $t_{SERVICE(RD)}$  maximum value, FM: 27.5 $\mu$ s, MFN: 13.5 $\mu$ s  
 Note 7 :  $t_{SERVICE(WR)}$  maximum value, FM: 23.5 $\mu$ s, MFM: 11.5 $\mu$ s

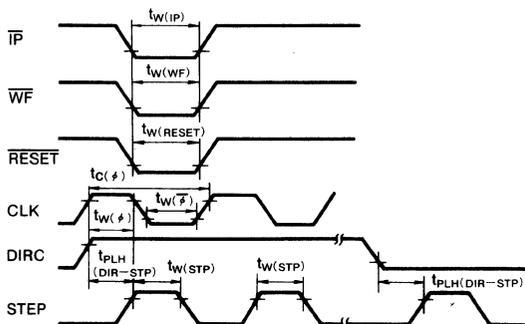
**Input data**



**Write data**



**Others**



**6**

# M5W1793-02P

## FLOPPY DISK FORMATTER/CONTROLLER

### 1. DESCRIPTION

The M5W1793-02P is a floppy disk formatter/controller device which accommodates single and double density formats.

The device is designed for use with microprocessors or microcomputers.

The device is fabricated with the N-channel silicon gate ED-MOS technology and is packaged in a 40-pin DIL package.

### 2. FEATURES

- Single 5V supply voltage
- Accommodate single and double density formats  
IBM 3740 single density format  
IBM system 34 double density format
- Selectable sector length (128, 256, 512 or 1024 bytes/sector)
- Side select compare
- Single/multiple sector read or write with automatic sector search
- Selectable track to track stepping time
- Write precompensation
- DMA or programmed data transfers
- Window extension

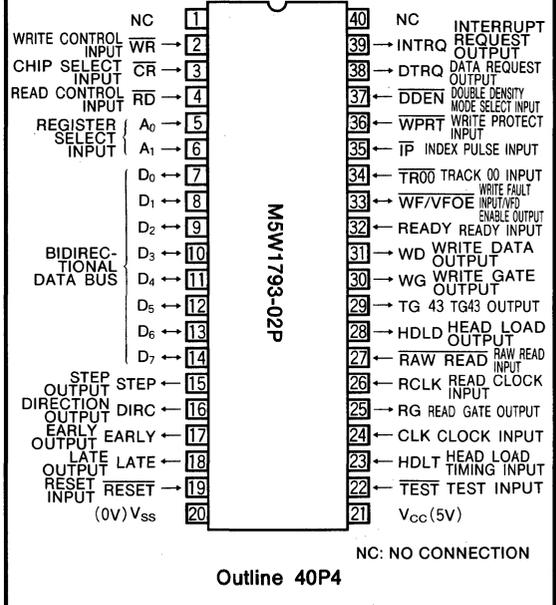
### 3. APPLICATIONS

- Single or double density floppy disk drive formatter/controller
- 8-inch or mini floppy disk interface

### 4. FUNCTION

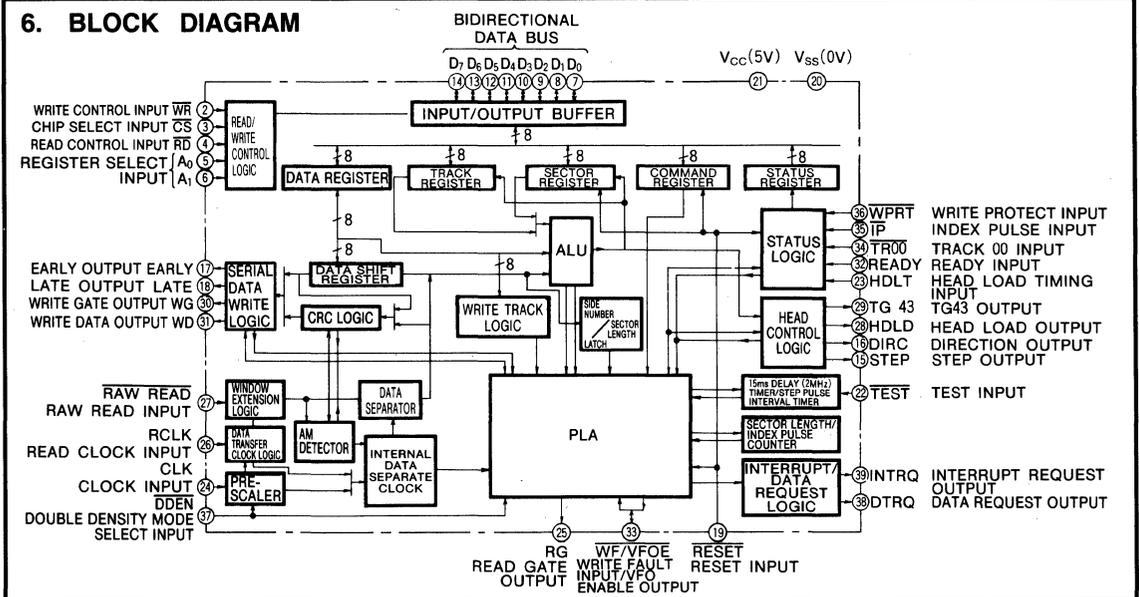
The M5W1793-02P is a floppy disk formatter/controller that can be used with most microprocessor or microcomputer

### 5. PIN CONFIGURATION (TOP VIEW)



systems. The hardware of the M5W1793-02P consists of a floppy disk interface, a CPU interface and a PLA control logic. The total chip can be programmed by eleven 8-bit commands. The floppy disk interface portion performs the communication with the floppy disk drive under control of the PLA control logic. The CPU interface portion has five registers — command, data, status, track and sector register — and communicates with the CPU through the data bus. These functions are also controlled by the PLA.

### 6. BLOCK DIAGRAM



**FLOPPY DISK FORMATTER/CONTROLLER**

**7. PIN DESCRIPTION**

Pin	Name	Input or output	Functions																				
NC	No internal connection		NC(pin 1) is not internally connected																				
$\overline{WR}$	Write control input	Input	Write signal from a master CPU (Active low).																				
$\overline{CS}$	Chip select input	Input	Chip select (Active low).																				
$\overline{RD}$	Read control input	Input	Read signal from a master CPU (Active low).																				
$A_0, A_1$	Register select input	Input	<p>Register select inputs. These inputs select the register under the control of the <math>\overline{RD}</math> and <math>\overline{WR}</math>.</p> <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th><math>A_1</math></th> <th><math>A_0</math></th> <th><math>\overline{RD}</math></th> <th><math>\overline{WR}</math></th> </tr> </thead> <tbody> <tr> <td>0</td> <td>0</td> <td>STATUS REGISTER</td> <td>COMMAND REGISTER</td> </tr> <tr> <td>0</td> <td>1</td> <td>TRACK REGISTER</td> <td>TRACK REGISTER</td> </tr> <tr> <td>1</td> <td>0</td> <td>SECTOR REGISTER</td> <td>SECTOR REGISTER</td> </tr> <tr> <td>1</td> <td>1</td> <td>DATA REGISTER</td> <td>DATA REGISTER</td> </tr> </tbody> </table>	$A_1$	$A_0$	$\overline{RD}$	$\overline{WR}$	0	0	STATUS REGISTER	COMMAND REGISTER	0	1	TRACK REGISTER	TRACK REGISTER	1	0	SECTOR REGISTER	SECTOR REGISTER	1	1	DATA REGISTER	DATA REGISTER
$A_1$	$A_0$	$\overline{RD}$	$\overline{WR}$																				
0	0	STATUS REGISTER	COMMAND REGISTER																				
0	1	TRACK REGISTER	TRACK REGISTER																				
1	0	SECTOR REGISTER	SECTOR REGISTER																				
1	1	DATA REGISTER	DATA REGISTER																				
$D_0 \sim D_7$	Bidirectional data bus	In/Out	Three-state, non-inverted bidirectional data bus.																				
STEP	Step output	Output	Step pulse output (Active high).																				
DIRC	Direction output	Output	Direction output. High level means the head is stepping in and low level means the head is stepping out.																				
EARLY	Early output	Output	This signal is used for write precompensation. It indicates that the write data pulse should be shifted early.																				
LATE	Late output	Output	This signal is also used for write precompensation. It indicates that the write data pulse should be shifted late.																				
$\overline{RESET}$	Reset input	Input	Reset input (Active low). The device is reset by this signal and automatically loads "03" (hexadecimal) into the command register. The not-ready-status bit is also reset by this signal. When reset input is made to be high, the device executes restore command even unless READY is active and the device loads "01" (hexadecimal) to the sector register.																				
$\overline{TEST}$	Test input	Input	This input is only used for test purposes, so user must tie it to $V_{CC}$ or leave it open unless using voice coil actuated motors.																				
HDLT	Head load timing input	Input	When the device finds high level on this input, the device assumes that the head is engaged on the media. Active high.																				
CLK	Clock input	Input	Clock input to generate internal timing. 2MHz for 8-inch drives, 1MHz for mini drives.																				
RG	Read gate output	Output	This signal shows the external data separator that the syncfield is detected.																				
RCLK	Read clock input	Input	This signal is internally used for the data window. Phasing relation to raw read data is specified but polarity (RCLK high or low) is not important.																				
$\overline{RAW READ}$	Raw read input	Input	This input signal from the drive shall be low for each recorded flux transition.																				
HDL D	Head load output	Output	This output signal controls the loading of the head of the drive. The head must be loaded on the media by this high-level output.																				

**FLOPPY DISK FORMATTER/CONTROLLER**

Pin	Name	Input or output	Functions
TG43	TG 43 output	Output	This output is valid only during disk read/write operation and it shows the position of the head. High level on this output indicates that head is positioned between track 44 to 76.
WG	Write gate output	Output	This signal becomes active before disk write operations are to occur.
WD	Write data output	Output	This signal consists of data bits and clock bits. It becomes active for every flux transition. Active high.
READY	Ready input	Input	This signal shows the device the drive is ready. In the disk read/write operation except for TYPE 1 command operation, low level input terminates current operation and the device generates the INTRQ. In the TYPE 1 command operation, this signal is neglected. Not ready bit in the status register is the inverted form of this input.
$\overline{\text{WF/VFOE}}$	Write fault input/ VFO enable output	In/Out	This is a bidirectional signal. It becomes write fault input when WG is active. In the disk write operation, low level signal on this input terminates the write operation and makes INTRQ active. This signal also appears in the status register as the write fault bit. When WG is inactive, this signal works as VFO enable output. VFOE output is also an open drain type, so pull it up to $V_{CC}$ and never input active write fault signal write WG is inactive.
TR00	Track 00 input	Input	This signal indicates that the head is located on the track 00 to the device. Active low.
IP	Index pulse input	Input	This input indicates to the device that an index hole of the diskette has been encountered.
$\overline{\text{WPRT}}$	Write protect input	Input	Low level signal on this input informs the device that the drive is in the write protected state. Before disk write operations, this signal is sampled and an active low signal will terminate the current command and set INTRQ. The write protect status bit in the status register is also set.
$\overline{\text{DDEN}}$	Double density mode select input	Input	This input determines the device operation mode. When $\overline{\text{DDEN}}=0$ , double density mode is selected. When $\overline{\text{DDEN}}=1$ , single density mode is selected.
DTRQ	Data request output	Output	DTRQ is an open drain output, so pull up to $V_{CC}$ by the 10k resistor. In the disk read mode, DTRQ indicates that data is assembled in the data register. In the disk write mode, it indicates that the data register is empty. DTRQ is reset by the read data or write data operation.
INTRQ	Interrupt request output	Output	INTRQ is also a open drain output, so pull up to $V_{CC}$ by the 10k resistor. INTRQ becomes active at the completion of any command and is reset when the CPU reads the status or writes the command.
NC	No internal connection		NC (pin 40) is not internally connected.

**FLOPPY DISK FORMATTER/CONTROLLER**

**8. COMMAND DESCRIPTION**

There are 11 different commands. By setting  $\overline{CS}$  to "0",  $A_0$  to "0" and  $A_1$  to "0", the commands are written into the M5W1793-02P from the data bus at the rising edge of the

$\overline{WR}$  signal.

The commands are classified into four Types : type 1, Type 2, Type 3 and Type 4.

**Table 8.1 List of Commands**

Command type	Command	MSB				Code				LSB
Type 1 commands	Restore command	0	0	0	0	h	V	$r_1$	$r_0$	
	Seek command	0	0	0	1	h	V	$r_1$	$r_0$	
	Step command	0	0	1	u	h	V	$r_1$	$r_0$	
	Step-in command	0	1	0	u	h	V	$r_1$	$r_0$	
	Step-out command	0	1	1	u	h	V	$r_1$	$r_0$	
Type 2 commands	Read sector command	1	0	0	m	S	E	C	0	
	Write sector command	1	0	1	m	S	E	C	$a_0$	
Type 3 commands	Read address command	1	1	0	0	0	E	0	0	
	Read track command	1	1	1	0	0	E	0	0	
	Write track command	1	1	1	1	0	E	0	0	
Type 4 commands	Force interrupt command	1	1	0	1	$l_3$	$l_2$	$l_1$	$l_0$	

Note 1 : The M5W1793-02P features positive logic data bus and so the codes are written into the M5W1793-02P without modification.

Each command has a flag option. Refer to these options in Table. 8.2.

**FLOPPY DISK FORMATTER/CONTROLLER**

**Table 8.2 Flag Options**

	Flag	Description
Type 1 commands	h : Head load flag	When h = 1: The head is loaded at the beginning of the command execution. When h = 0: The head is loaded when the verify operation starts if the V flag is "1". It is not loaded if the V flag is "0".
	V : Verify flag	When V = 1: The contents of the track register are compared with the ID track address after head positioning. The seek error status bit is set if the desired track address is not found by the time the diskette has gone through 6 rotations. When V = 0: The track verification is not performed.
	r <sub>1</sub> , r <sub>0</sub> : Stepping rate flag	The stepping rate is determined by the value of these 2 bits as well as by the CLK frequency and TEST input pin.
	u : Update flag	When u = 1: The track register is updated with each step pulse: It is incremented (or decremented) by 1 for each step-in (or step-out) pulse. When u = 0: Track register is not updated.
Type 2/Type3 Commands	E : 15ms delay flag (at 2MHz clock)	When E = 1: Sampling of the head load timing input starts with the 15ms delay after the head load output has been set to "1". An advance is made to the next step when HDLD·HLDT = "1" is established. When E = 0: Sampling of the head load timing input starts immediately after the head load output has been set to "1". An advance is made to the next step when HDLD·HLDT = "1" is established. The "next step" is the TG43 output update.
Type 2 commands	m : Multi-sector read/write flag	When m = 1: Multi-sector read/write is performed. Upon completion of one sector read/write, the sector register value is incremented by 1, the next sector is sought and read/write is performed again. Upon completion of the final sector read/write operation, the next sector is not found even when sought and so at the sixth rotation of the diskette the RNF error bit is set and the operation is concluded. This command can also be concluded with the Type 4 command. When m = 0: Read/write for single sector is performed.
	S : Side select flag	When S = 1: "1" is compared with the ID side number when the C flag is "1". When S = 0: "0" is compared with the ID side number when the C flag is "1". No comparison is performed when C = 0.
	C : Side compare flag	When C = 1: The S flag and ID side number are compared. When C = 0: The ID side number is not compared.
	a <sub>0</sub> : Data address mark flag	When a <sub>0</sub> = 1: The deleted data mark "F8" (hexadecimal) is written into the data field address mark. When a <sub>0</sub> = 0: The data mark "FB" (hexadecimal) is written into the data field address mark.
Type 4 command	I : Interrupt condition flag	When i <sub>0</sub> = 1: The interrupt request output is set to "H" at the ready input rising edge. When i <sub>1</sub> = 1: The interrupt request output is set to "H" at the ready input falling edge. When i <sub>2</sub> = 1: The interrupt request output is set to "H" with the index pulse input. When i <sub>3</sub> = 1: The command being executed is terminated and the interrupt request output is set to "H" immediately. When i <sub>0</sub> = i <sub>1</sub> = i <sub>2</sub> = i <sub>3</sub> = 0: No interrupt request is generated but the command being executed is terminated. This command is executed so that the interrupt request output, which has been set by the Type 4 command, is reset by the following command write or status read.

**FLOPPY DISK FORMATTER/CONTROLLER**

**9. ELECTRICAL CHARACTERISTICS**

**9.1 ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Conditions	Limits	Unit
$V_{CC}$	Supply voltage	With respect to $V_{SS}$	-0.5~7	V
$V_I$	Input voltage		-0.5~7	V
$V_O$	Output voltage		-0.5~7	V
$P_d$	Power dissipation	$T_a=25^{\circ}C$	350	mW
$T_{opr}$	Operating free-air temperature range		0~70	$^{\circ}C$
$T_{stg}$	Storage temperature range		-65~150	$^{\circ}C$

**9.2 RECOMMENDED OPERATING CONDITIONS** ( $T_a=0\sim70^{\circ}C$ , unless otherwise noted)

Symbol	Parameter	Limits			Unit
		Min	Nom	Max	
$V_{CC}$	Supply voltage	4.75	5	5.25	V
$V_{SS}$	Supply voltage		0		V
$V_{IH}$	High-level input voltage	2			V
$V_{IL}$	Low-level input voltage	$V_{SS}-0.5$		0.8	V

**9.3 ELECTRICAL CHARACTERISTICS** ( $T_a=0\sim70^{\circ}C$ ,  $V_{CC}=5V\pm5\%$ , unless otherwise noted)

Symbol	Parameter	Test condition	Limits			Unit
			Min	Typ	Max	
$V_{OH}$	High-level output voltage	$I_{OH}=-200\mu A$	2.4			V
$V_{OL}$	Low-level output voltage	$I_{OL}=1.8mA$			0.4	V
$I_{CC}$	Supply current				70	mA
$I_I$	Input current.(HDLT, TEST, WF/VFOE, WPRT, DDEN)	$V_I=V_{CC}\sim 0V$	-100		10	$\mu A$
	Input current other inputs	$V_I=V_{CC}\sim 0V$	-10		10	$\mu A$
$I_{OZ}$	Off-state output current	$V_I=V_{CC}\sim 0V$	-10		10	$\mu A$

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**FLOPPY DISK FORMATTER/CONTROLLER**

**9.4 TIMING REQUIREMENTS** ( $T_a=0\sim 70^\circ\text{C}$ ,  $V_{CC}=5V\pm 5\%$ ,  $V_{SS}=0V$ , unless otherwise noted)

Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{SU(A-R)}$ $t_{SU(CS-R)}$	Address setup time before read and chip select	TSET		50			ns
$t_{H(R-A)}$ $t_{H(R-CS)}$	Address hold time after read and chip select	THLD		10			ns
$t_{W(R)}$	Read pulse width	TRE	$C_L=50\text{pF}$	280			ns
$t_{SU(A-W)}$ $t_{SU(CS-W)}$	Address setup time before write and chip select	TSET		50			ns
$t_{H(W-A)}$ $t_{H(W-CS)}$	Address hold time after write and chip select	THLD		10			ns
$t_{W(W)}$	Write pulse width	TWE		200			ns
$t_{SU(DQ-W)}$	Data setup time before write	TDS		250			ns
$t_{H(W-DQ)}$	Data hold time after write	TDH		20			ns
$t_{W(RR)}$	Raw read pulse width	$T_{PW}$	(Note 1, 2)	100		250	ns
$t_{C(RR)}$	Raw read cycle time	$T_{bc}$	(Note 3)	1600	2000		ns
$t_{W(RCLK)}$	Read clock high-level width	$T_a$	(Note 4)	800			ns
$t_{W(RCLK)}$	Read clock low-level width	$T_b$	(Note 4)	800			ns
$t_{C(RCLK)}$	Read clock cycle time	$T_c$		1600			ns
$t_{H(RCLK-RR)}$	Read clock hold time before raw read	$T_{x1}$		40			ns
$t_{H(RR-RCLK)}$	Read clock hold time after raw read	$T_{x2}$	FM	40			ns
			MFM	40			ns
$t_{W(WD)}$	Write data pulse width	$T_{wp}$	FM	450	500	550	ns
			MFM	150	200	250	ns
$t_{C(WD)}$	Write data cycle time	$T_{bc}$			2, 3, 4	$\mu\text{s}$	
$t_{W(\neq)}$	Clock high-level pulse width	$TCD_1$		230	250	20000	ns
$t_{W(\neq)}$	Clock low-level pulse width	$TCD_2$		200	250	20000	ns
$t_{W(RESET)}$	Reset pulse width	TMR		50			$\mu\text{s}$
$t_{W(IP)}$	Index pulse width	TIP	(Note 5)	10			$\mu\text{s}$
$t_{W(WF)}$	Write fault pulse width	TWF	(Note 5)	10			$\mu\text{s}$

**9.5 SWITCHING CHARACTERISTICS** ( $T_a=0\sim 70^\circ\text{C}$ ,  $V_{CC}=5V\pm 5\%$ ,  $V_{SS}=0V$ , unless otherwise noted)

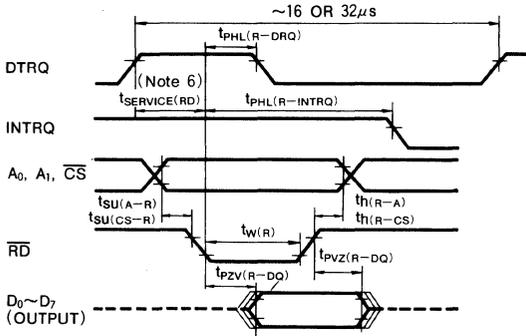
Symbol	Parameter	Alternative symbol	Test conditions	Limits			Unit
				Min	Typ	Max	
$t_{PLH(WG-WD)}$	Propagation time from write gate to write data	$T_{wg}$	FM (Note 5)		2		$\mu\text{s}$
			MFM (Note 5)		1		$\mu\text{s}$
$t_{PLH(E-WD)}$ $t_{PLH(L-WD)}$	Propagation time from early or late to write data	$T_s$	MFM (Note 5)	125			ns
$t_{PHL(WD-E)}$ $t_{PHL(WD-L)}$	Propagation time from write data to early or late	$T_h$	MFM (Note 5)	125			ns
$t_{PHL(WD-WG)}$	Propagation time from write data to write gate	$T_{wt}$	FM (Note 5)		2		$\mu\text{s}$
			MFM (Note 5)		1		$\mu\text{s}$
$t_{PZV(R-DQ)}$	Output enable time after read	TDACC	$C_L=50\text{pF}$			250	ns
$t_{PZV(R-DQ)}$	Output disable time after read	TDOH	$C_L=50\text{pF}$	50		150	ns
$t_{PHL(R-DRQ)}$	Propagation time from read to DRQ	TDRR(RD)				250	ns
$t_{PHL(R-INTRQ)}$	Propagation time from read to INTRQ	TIRR(RD)	(Note 5)			500	ns
$t_{PHL(W-DRQ)}$	Propagation time from write to DRQ	TDRR(WR)				250	ns
$t_{PHL(W-INTRQ)}$	Propagation time from write to INTRQ	TIRR(WR)	(Note 5)			500	ns
$t_{W(STP)}$	Step pulse width	TSTP	(Note 5)	2 or 4			$\mu\text{s}$
$t_{PLH(DIR-STP)}$	Propagation time from direction to step	TDIR	(Note 5)	12			$\mu\text{s}$
$t_{V(WD-CLK)}$	Write data valid time before clock	$T_{wd1}$	CLK=1MHz MFM	200			ns
			CLK=2MHz MFM	30			ns
$t_{V(CKL-WD)}$	Write data valid time after clock	$T_{wd2}$	CLK=1MHz MFM	50			ns
			CLK=2MHz MFM	50			ns

- Note 1 : The pulse of RAW READ may be any width if pulse is entirely within RCLK. When the pulse occurs in the RCLK window, RAW READ pulse width must be less than 300 ns for MFM mode and 600 ns for FM mode at CLK=2MHz. Times double for 1MHz.  
 2 : 100 ns pulse width is recommended for the RAW READ pulse in 8 MFM mode.  
 3 : RAW READ cycle time  $T_{C(RR)}$  and WD cycle time  $T_{C(WD)}$  is normally  $2\mu\text{s}$  in MFM and  $4\mu\text{s}$  in FM. Times double when CLK=1MHz.  
 4 : The polarity of RCLK during RAW READ is not important.  
 5 : Times double when CLK=1MHz.

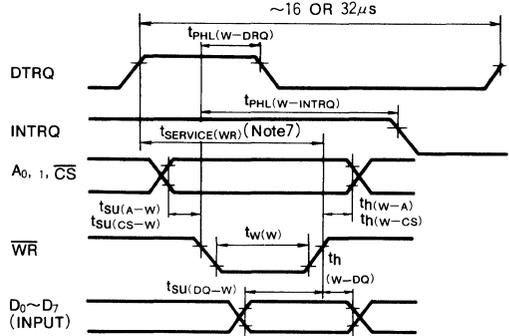
**FLOPPY DISK FORMATTER/CONTROLLER**

**9.6 TIMING DIAGRAM**

Read

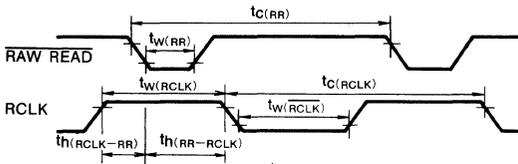


Write

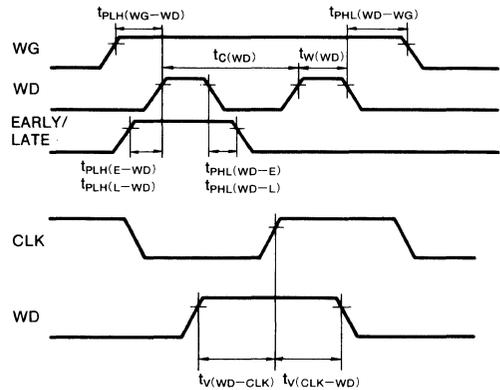


Note 6 :  $t_{SERVICE(RD)}$  maximum value; FM: 27.5  $\mu$ s, MFM: 13.5  $\mu$ s  
 7 :  $t_{SERVICE(WR)}$  maximum value; FM: 23.5  $\mu$ s, MFM: 11.5  $\mu$ s

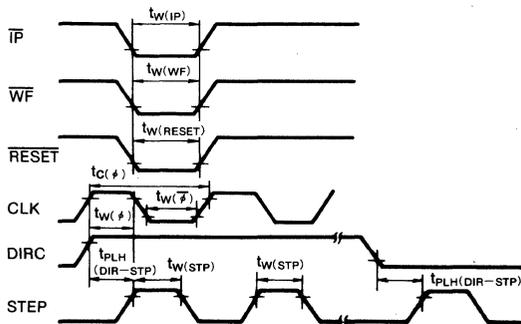
Input data



Write data



Others



**10. OTHERS**

Refer to the description of M5W1791-02P for further information.

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AND PERIPHERAL CIRCUITS**

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